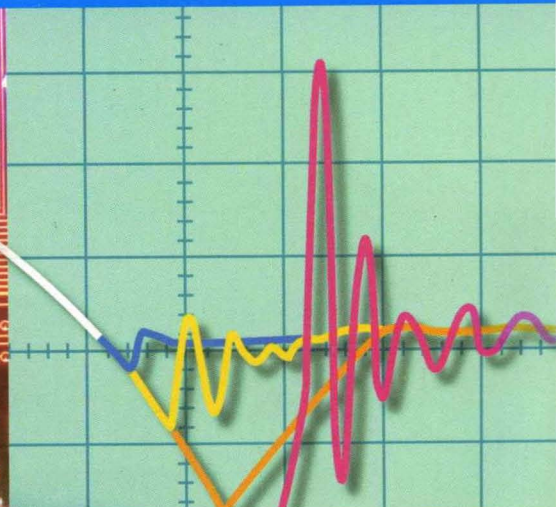
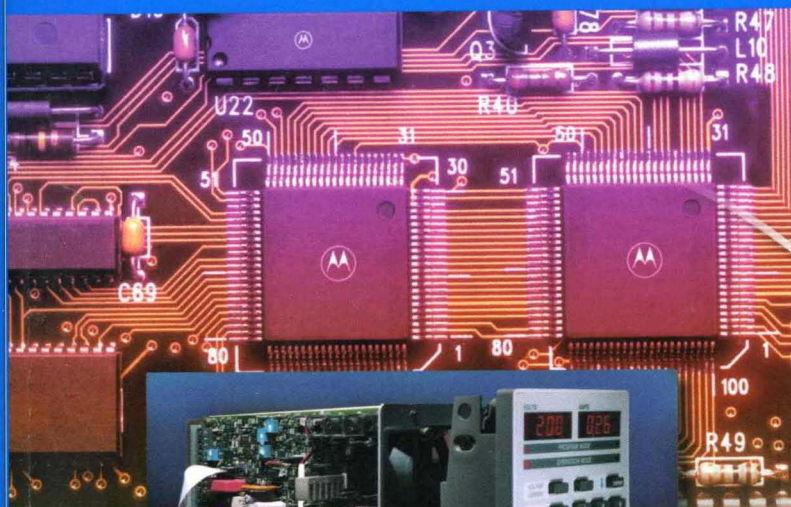


# Rectifier

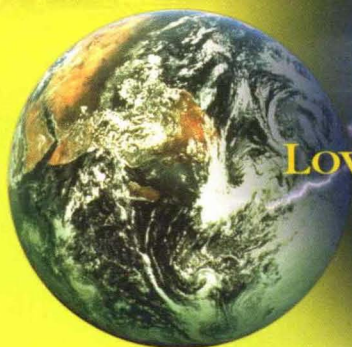
## Device Data

MOTOROLA RECTIFIER DEVICE DATA

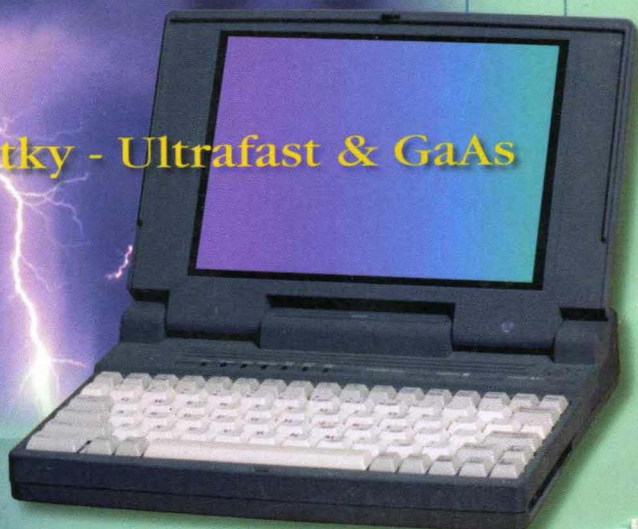


ENERGY EFFICIENCY

# A C - D C



Low VF Schottky - Ultrafast & GaAs



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# Rectifier Device Data

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This book presents technical data for Motorola's broad line of rectifiers. Complete specifications are provided in the form of data sheets and accompanying selection guides provide a quick comparison of characteristics to simplify the task of choosing the best device for a circuit.

The information in this book has been carefully checked and is believed to be accurate; however, no responsibility is assumed for inaccuracies.

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# DATA CLASSIFICATION

## PRODUCT PREVIEW

Data sheets herein contain information on a product under development. Motorola reserves the right to change or discontinue these products without notice.

## ADVANCED INFORMATION

Data sheets herein contain information on new products. Specifications and information are subject to change without notice.

## FORMAL

For a fully characterized device there must be devices in the warehouse and price authorization.

## DESIGNER'S

The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

## MOTOROLA DEVICE CLASSIFICATIONS

In an effort to provide up-to-date information to the customer regarding the status of any given device, Motorola has classified all devices into three categories: "Preferred" products, "Current" products and "Not Recommended for New Design" products.

### PREFERRED PRODUCTS

A Preferred Type is a device which is recommended as a first choice for future use. These devices are "preferred" by virtue of their performance, price, functionality, or combination of attributes which offer the overall "best" value to the customer. This category contains both advanced and mature devices which will remain available for the foreseeable future.

"Preferred Devices" are identified in the Selector Guide Section and the Data Sheet Sections.

### CURRENT PRODUCTS

Device types identified as "current" may not be a first choice for new designs, but will continue to be available because of the popularity and/or standardization or volume usage in current production designs. These products can be acceptable for new designs but the preferred types are considered better alternatives for long term usage.

Any device that has not been identified as a "preferred device" is a "current" device.

### NOT RECOMMENDED FOR NEW DESIGN PRODUCTS

Products designated as "Not Recommended for New Design" have become obsolete as dictated by poor market acceptance, or a technology or package that is reaching the end of its life cycle. Devices in this category have an uncertain future and do not represent a good selection for new device designs or long term usage.

The RF Device Data book does not contain any "Not Recommended for New Design" devices.

Designer's, MEGAHERTZ, POWERTAP, SCANSWITCH, SWITCHMODE and Surmetic are trademarks of Motorola Inc. Thermal Clad is a trademark of the Bergquist Company.

***Section 1***

**Index and Cross Reference**

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# Index and Cross Reference

The following table represents an index and cross reference guide for all rectifier devices which are either manufactured directly by Motorola or for which Motorola manufactures a suitable equivalent. Where the Motorola part number differs from the industry part number, the Motorola device is a form, fit and function replacement for the industry type number — however, subtle differences in characteristics and/or specifications may exist. The part numbers listed in this Cross Reference are in computer sort.

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10CTF20		MUR840	4-56
10CTF30		MUR840	4-56
10CTF40		MUR840	4-56
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10DL2		1N4935	5-3
10TQ030		MBR1045	3-86
10TQ035		MBR1045	3-86
10TQ040		MBR1045	3-86
10TQ045		MBR1045	3-86
11DQ03		1N5818	3-38
11DQ04		1N5819	3-38
11DQ05		MBR160	3-43
11DQ06		MBR160	3-43
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11DQ10		MBR1100	3-46
12CTQ030	MBR1545CT		3-64
12CTQ035	MBR1545CT		3-64
12CTQ040	MBR1545CT		3-64
12CTQ045	MBR1545CT		3-64
15CTO035		MBR1545CT	3-64
15CTQ045		MBR1545CT	3-64
1N2069,A	1N4003		5-2
1N2070,A	1N4004		5-2
1N2071,A	1N4005		5-2
1N3611		1N4003	5-2
1N3611GP		1N4003	5-2
1N3612		1N4004	5-2
1N3612GP		1N4004	5-2
1N3613		1N4005	5-2
1N3613GP		1N4005	5-2
1N3614		1N4006	5-2
1N3614GP		1N4006	5-2
1N3957		1N4007	5-2
1N3957GP		1N4007	5-2
1N4001	1N4001		5-2
1N4001GP		1N4001	5-2
1N4002	1N4002		5-2
1N4002GP		1N4002	5-2
1N4003	1N4003		5-2
1N4003GP		1N4003	5-2
1N4004	1N4004		5-2
1N4004GP		1N4004	5-2
1N4005	1N4005		5-2
1N4005GP		1N4005	5-2
1N4006	1N4006		5-2
1N4006GP		1N4006	5-2
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1N4007GP		1N4007	5-2
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1N4246		1N4004	5-2
1N4246GP		1N4004	5-2
1N4247		1N4005	5-2
1N4247GP		1N4005	5-2
1N4248		1N4006	5-2
1N4248GP		1N4006	5-2
1N4249		1N4007	5-2
1N4249GP		1N4007	5-2
1N4933	1N4933		5-3
1N4933GP		1N4933	5-3
1N4934	1N4934		5-3
1N4934GP		1N4934	5-3
1N4935	1N4935		5-3
1N4935GP		1N4935	5-3
1N4936	1N4936		5-3
1N4936GP		1N4936	5-3
1N4937	1N4937		5-3
1N4937GP		1N4937	5-3
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1N4943		1N4936	5-3
1N4944		1N4936	5-3
1N4944GP		1N4936	5-3
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1N4946		1N4937	5-3
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1N5186		MR852	5-6
1N5186GP		MR852	5-6
1N5187		MR852	5-6
1N5187GP		MR852	5-6
1N5188		MR856	5-6
1N5188GP		MR856	5-6
1N5189		MR856	5-6
1N5189GP		MR856	5-6
1N5190		MR856	5-6
1N5190GP		MR856	5-6
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1N5420		MR856	5-6
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1N5615GP		1N4935	5-3
1N5616		1N4004	5-2
1N5617		1N4936	5-3
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1N5809		MUR420	4-31
1N5810		MUR420	4-31
1N5811		MUR420	4-31
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1N5819	1N5819		3-38
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1N5821	1N5821		3-49
1N5822	1N5822		3-49
1N5823	1N5823		3-60
1N5824	1N5824		3-60
1N5825	1N5825		3-60
1N5826	1N5826		3-135
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1N6097	1N6097		3-156
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200CNQ020	MBRP30045CT		3-183
200CNQ030	MBRP30045CT		3-183
200CNQ035	MBRP30045CT		3-183
200CNQ040	MBRP30045CT		3-183
200CNQ045	MBRP30045CT		3-183
201CNQ020	MBRP20045CT		3-182
201CNQ030	MBRP20045CT		3-182
201CNQ035	MBRP20045CT		3-182
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20CTQ030		MBR2045CT	3-69
20CTQ035		MBR2045CT	3-69
20CTQ040		MBR2045CT	3-69
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20FQ030	MBR3545		3-148
20FQ035	MBR3545		3-148
20FQ040	MBR3545		3-148
20FQ045	MBR3545		3-148
21DQ03		1N5821	3-49
21DQ04		1N5822	3-49
21FQ030	MBR3545		3-148
21FQ035	MBR3545		3-148
21FQ040	MBR3545		3-148
21FQ045	MBR3545		3-148
28CPQ030		MBR3045PT	3-119
28CPQ040		MBR3045PT	3-119
30CTQ030	MBR2545CT		3-80
30CTQ035	MBR2545CT		3-80
30CTQ040	MBR2545CT		3-80
30CTQ045	MBR2545CT		3-80
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31DQ10		MBR3100	3-57
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40CDQ035	MBR3045CT		3-178
40CDQ040	MBR3045CT		3-178
40CDQ045	MBR3045CT		3-178
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50HQ040		MBR6045	3-164
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55HQ030		MBR7545	3-172
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60CDQ030	MBR3045CT		3-178
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CPT12050	MBRP20060CT		3-182
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CPT20045	MBRP20045CT		3-182
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# Section 2

## Selector Guide

### In Brief . . .

Continuing investment in research and development for discrete products has created a rectifier manufacturing facility that matches the precision and versatility of the most advanced integrated circuits. As a result, Motorola's silicon rectifiers span all high tech applications with quality levels capable of passing the most stringent environmental tests . . . including those for automotive under-hood applications.

#### Product Highlights:

- Surface Mount Devices — A major thrust has been the development and introduction of a broad range of power rectifiers, Schottky and Ultrafast, 1/2 amp to 25 amp, 15 to 600 volts.
- Application Specific Rectifiers —
  - MEGAHERTZ™ series for high frequency power supplies and power factor correction.
  - Schottky rectifiers having lower forward voltage drop (0.3 to 0.6 volts) for use in low voltage SMPS outputs and as "OR"ing diodes.
  - Automotive transient suppressors.
- Ultrafast rectifiers having reverse recovery times as low as 25 ns to complement the Schottky devices for higher voltage requirements in high frequency applications.
- A wide variety of package options to match virtually any potential requirement.

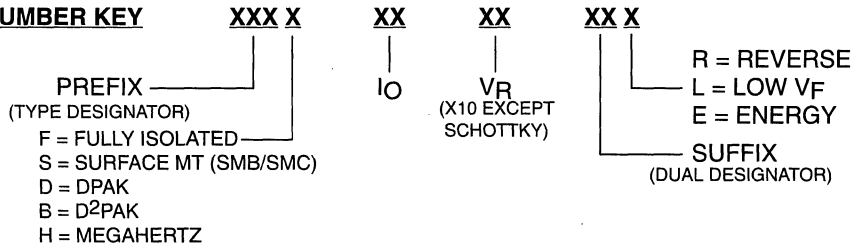
The rectifier selector section that follows has generally been arranged by package and technology. The individual tables have been sorted by voltage and current with the package types for the devices listed shown above each table. The Application Specific Rectifiers are also included in their respective tables.

Motorola's commitment to Six-Sigma is showing its worth. Refined processes no longer produce fallout as such and therefore only **Motorola Preferred Devices** are listed in the tables. The non-preferred devices will continue to be offered, but customers are encouraged to begin designing using the preferred types.

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# RECTIFIER NUMBERING SYSTEM

## PART NUMBER KEY



## PREFIX KEY

MUR = MOTOROLA ULTRA FAST RECTIFIER  
 MBR = MOTOROLA (SCHOTTKY) BARRIER RECTIFIER  
 MR = MOTOROLA STANDARD & FAST RECOVERY

## SUFFIX KEY

CT = CENTER TAP (DUAL) TO-220, TO-3, POWERTAP  
 PT = CENTER TAP (DUAL) TO-218 PACKAGE  
 WT = CENTER TAP (DUAL) TO-247 / TO-3P

<b>EXAMPLE:</b>	MUR	30	20	WT
	MOTOROLA ULTRAFAST	30 AMP	200 V	CENTER TAP (DUAL) TO-247
<b>EXAMPLE:</b>	MBR	30	45	WT
	MOTOROLA SCHOTTKY	30 AMP	45 V	CENTER TAP (DUAL) TO-247

# Application Specific Rectifiers

The focus for Rectifier Products continues to be on Schottky and Ultrafast technologies, with process and packaging improvements to achieve greater efficiency in high frequency switching power supplies, and high current

mainframe supplies. Our new product thrust is intended to be more "application specific" than in the past, while continuing to strive for broad market acceptance.

**Table 1. Low  $V_F$  Schottky Rectifiers**

State of the art geometry is used in low  $V_F$  Schottky devices for improved efficiency in low voltage, high frequency switching power supplies, free-wheeling diodes, polarity protection diodes and "OR"ing diodes.

Device	$I_O$ Amps	$V_{RRM}$ (Volts)	$V_F$ @ Rated $I_O$ and Temperature Volts (Max)	$I_R$ @ Rated $V_{RRM}$ mAmps (Max)	Package	Page
<i>MBR0520LT1</i>	0.5	20	0.33	0.25	SOD-123	3-2
<i>MBRS130LT3</i>	1	30	0.395	1	SMB	3-7
<i>MBRD835L</i>	8	35	0.41	1.4	DPAK	3-21
<i>MBRD1035CTL</i>	10	35	0.41	6	DPAK	—
<i>MBR2030CTL</i>	20	30	0.48	5	TO-220	3-66
<i>MBRB2535CTL</i>	25	35	0.41	10	D <sup>2</sup> PAK	3-34
<i>MBR2535CTL</i>	25	35	0.41	5	TO-220	3-78
<i>MBRB2515L</i>	25	15	0.42	15	D <sup>2</sup> PAK	3-32
<i>MBR2515L</i>	25	15	0.42	15	TO-220	3-77
<i>MBRB3030CTL</i>	30	30	0.58	5	D <sup>2</sup> PAK	—
<i>MBR4015LWT</i>	40	15	0.42	5	TO-247	3-129
<i>MBR5025L</i>	50	25	0.58	0.5	TO-218 TYPE	3-125
<i>MBR6030L</i>	60	30	0.38	50	DO-203AB	3-160
<i>MBRP20030CTL</i>	200	30	0.39	5	POWERTAP	3-181
<i>MBRP60035CTL</i>	600	35	0.50	10	POWERTAP	3-184

**Table 2. MEGAHERTZ Rectifiers**

MEGAHERTZ Series — This group of ultrafast rectifiers is designed to provide improved efficiency in very high frequency switching power supplies and for use in power factor correction circuits.

Device	$I_O$ Amps	$V_{RRM}$ (Volts)	Maximum		$t_{rr}$ (Nanosecond)	Page
			$V_F$ @ Rated $I_O$ and Temp. (Volts)	$I_R$ @ Rated $V_{RRM}$ (mAmps)		
<i>MURH840CT</i>	8	400	1.7	0.01	28	4-41
<i>MURH860CT</i>	8	600	2.0	0.01	28	4-44

**Table 3. SCANSWITCH Rectifiers**

These ultrafast rectifiers are designed for improved performance in very high resolution monitors and work stations where forward recovery time ( $t_{fr}$ ) and high voltage (1200–1500 volts) are primary considerations.

Device	$I_O$ Amps	$V_{RRM}$ (Volts)	Maximum		$V_{RFM}$ (6) (Volts)	Page
			$t_{fr}$ (Nanoseconds)	$t_{rr}$ (Nanoseconds)		
<i>MUR5150E</i>	5	1500	225	175	20	4-54
<i>MUR880E</i>	8	800	—	75	—	—
<i>MUR10120E</i>	10	1200	175	175	14	4-65
<i>MUR10150E</i>	10	1500	175	175	16	4-68

**Table 4. Automotive Transient Suppressors**

Automotive transient suppressors are designed for protection against over-voltage conditions in the auto electrical system including the "LOAD DUMP" phenomenon that occurs when the battery open circuits while the car is running.

Device	$I_O$ Amps	$V_{RRM}$ (Volts)	$V_{(BR)}$ (Volts)	$I_{RSM}^{(7)}$ (Amps)	T (°C)	Page
<i>MR2535L</i>	35	20	24–32	110	175	5-19

(6)  $V_{RFM}$  = Maximum Transient Overshoot Voltage.

(7) Time constant = 10 ms, Duty Cycle  $\leq$  1%,  $T_C = 25^\circ\text{C}$ .

Devices listed in bold, italic are Motorola preferred devices.

# SWITCHMODE™ Rectifiers

Schottky power rectifiers with the high speed and low forward voltage drop characteristic of Schottky's metal/silicon junctions are produced with ruggedness and temperature performance comparable to silicon-junction rectifiers. Ideal for use in low-voltage, high-frequency power supplies, and as very fast clamping diodes, these devices feature switching times less than 10 ns, and are offered in current ranges from 0.5 to 600 amperes, and reverse voltages to 200 volts.

In some current ranges, devices are available with junction temperature specifications of 125°C, 150°C and 175°C. Devices with higher T<sub>J</sub> ratings can have significantly lower leakage currents, but higher forward-voltage specifications. These parameter tradeoffs should be considered when selecting devices for applications that can be satisfied by more than one device type number.

All devices are connected cathode-to-case or cathode-to-heatsink, where applicable. Contact your

Motorola representative for more information.

There are many other standard features in Motorola Schottky rectifiers that give added performance and reliability.

1. GUARDRINGS were pioneered by Motorola and are included in all Schottky die for reverse voltage stress protection from high rates of dv/dt to virtually eliminate the need for snubber networks. The guardring also operates like a zener and avalanches when subjected to voltage transients.

2. MOLYBDENUM DISCS on both sides of the die minimize fatigue from power cycling in all metal products. Plastic encapsulated devices have a special solder formulation for the same purpose.

3. QUALITY CONTROL monitors all critical fabrication operations and performs selected stress tests to assure constant processes. Motorola's commitment to six sigma has provided significant quality improvement.

2

Case 425  
SOD-123



Cathode = Notch

Case 403A  
SMB



Cathode = Notch

Case 403  
SMC



Cathode = Notch

Table 5. Surface Mount Schottky Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Package	Page
20	0.5	T <sub>L</sub> = 105°C	<b>MBR0520LT1</b> ★	0.310 @ 0.1 A 0.385 @ 0.5 A	5	125	SOD-123	3-2
30	0.5	T <sub>L</sub> = 105°C	<b>MBR0530T1</b> ★	0.375 @ 0.1 A 0.430 @ 0.5 A	5	125	SOD-123	3-4
40	0.5	T <sub>L</sub> = 110°C	<b>MBR0540T1</b> ★	0.53 @ 0.5 A	20	150	SOD-123	3-6
30	1	T <sub>L</sub> = 120°C	<b>MBRS130LT3</b>	0.395 @ 1.0 A	40	125	SMB	3-7
40	1	T <sub>L</sub> = 115°C	<b>MBRS140T3</b>	0.6 @ 1.0 A	40	125	SMB	3-9
100	1	T <sub>L</sub> = 120°C	<b>MBRS1100T3</b>	0.75 @ 1.0 A	40	150	SMB	3-11
40	3	T <sub>L</sub> = 100°C	<b>MBRS340T3</b>	0.525 @ 3.0 A	80	125	SMC	3-13
60	3	T <sub>L</sub> = 100°C	<b>MBRS360T3</b> ★	0.74 @ 3.0 A	80	125	SMC	3-13

(1) I<sub>O</sub> is total device current capability.

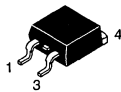
★ New Product

Devices listed in bold, italic are Motorola preferred devices.

Case 369A  
DPAK  
Style 3



Case 418B  
D<sup>2</sup>PAK  
Style 3



"CT" Suffix:



Non-"CT" Suffix:



Table 5. Surface Mount Schottky Rectifiers (continued)

V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Package	Page
40	3	T <sub>C</sub> = 125°C	<b><i>MBRD340</i></b>	0.60 @ 3.0 A	75	150	DPAK	3-15
60	3	T <sub>C</sub> = 125°C	<b><i>MBRD360</i></b>	0.60 @ 3.0 A	75	150	DPAK	3-15
40	6	T <sub>C</sub> = 130°C	<b><i>MBRD640CT</i></b>	0.70 @ 3.0 A	75	150	DPAK	3-18
60	6	T <sub>C</sub> = 130°C	<b><i>MBRD660CT</i></b>	0.70 @ 3.0 A	75	150	DPAK	3-18
35	8	T <sub>C</sub> = 100°C	<b><i>MBRD835L*</i></b>	0.40 @ 3.0 A 0.51 @ 8.0 A	100	125	DPAK	3-21
35	10	T <sub>C</sub> = 90°C	<b><i>MBRD1035CTL*</i></b>	0.49 @ 10 A	100	125	DPAK	—
45	15	T <sub>C</sub> = 105°C	<b><i>MBRB1545CT</i></b>	0.84 @ 15 A	150	150	D <sup>2</sup> PAK	3-24
60	20	T <sub>C</sub> = 110°C	<b><i>MBRB2060CT</i></b>	0.95 @ 20 A	150	150	D <sup>2</sup> PAK	3-26
100	20	T <sub>C</sub> = 110°C	<b><i>MBRB20100CT</i></b>	0.85 @ 10 A 0.95 @ 20 A	150	150	D <sup>2</sup> PAK	3-28
200	20	T <sub>C</sub> = 125°C	<b><i>MBRB20200CT*</i></b>	1.0 @ 20 A	150	150	D <sup>2</sup> PAK	3-30
15	25	T <sub>C</sub> = 90°C	<b><i>MBRB2515L*</i></b>	0.45 @ 25 A	150	100	D <sup>2</sup> PAK	3-32
35	25	T <sub>C</sub> = 110°C	<b><i>MBRB2535CTL</i></b>	0.47 @ 12.5 A 0.55 @ 25 A	150	125	D <sup>2</sup> PAK	3-34
45	25	T <sub>C</sub> = 130°C	<b><i>MBRB2545CT</i></b>	0.82 @ 30 A	150	150	D <sup>2</sup> PAK	3-36
30	30	T <sub>C</sub> = 115°C	<b><i>MBRB3030CT*</i></b>	0.51 @ 15 A 0.62 @ 30 A	300	150	D <sup>2</sup> PAK	3-190
30	30	T <sub>C</sub> = 95°C	<b><i>MBRB3030CTL*</i></b>	0.45 @ 15 A 0.51 @ 30 A	150	125	D <sup>2</sup> PAK	—
30	40	T <sub>C</sub> = 110°C	<b><i>MBRB4030*</i></b>	0.46 @ 20 A 0.55 @ 40 A	300	150	D <sup>2</sup> PAK	3-193

(1) I<sub>O</sub> is total device current capability.

\* New Product

Devices listed in bold, italic are Motorola preferred devices.



Cathode = Polarity Band



Cathode = Polarity Band

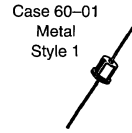
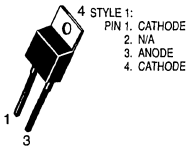


Table 6. Axial Lead Schottky Rectifiers

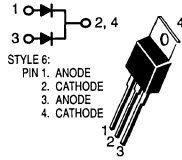
V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case	Page
20	1	T <sub>A</sub> = 55°C R <sub>θJA</sub> = 80°C/W	<b>1N5817</b>	0.45 @ 1.0 A	25	125	59-04	3-38
30	1	T <sub>A</sub> = 55°C R <sub>θJA</sub> = 80°C/W	<b>1N5818</b>	0.55 @ 1.0 A	25	125	59-04	3-38
40	1	T <sub>A</sub> = 55°C R <sub>θJA</sub> = 80°C/W	<b>1N5819</b>	0.60 @ 1.0 A	25	125	59-04	3-38
60	1	T <sub>A</sub> = 55°C R <sub>θJA</sub> = 80°C/W	<b>MBR160</b>	0.75 @ 1.0 A	25	150	59-04	3-43
100	1	T <sub>A</sub> = 120°C R <sub>θJA</sub> = 50°C/W	<b>MBR1100</b>	0.79 @ 1.0 A	50	150	59-04	3-46
20	3	T <sub>A</sub> = 76°C R <sub>θJA</sub> = 28°C/W	<b>1N5820</b>	0.457 @ 3.0 A	80	125	267-03	3-49
30	3	T <sub>A</sub> = 71°C R <sub>θJA</sub> = 28°C/W	<b>1N5821</b>	0.500 @ 3.0 A	80	125	267-03	3-49
40	3	T <sub>A</sub> = 61°C R <sub>θJA</sub> = 28°C/W	<b>1N5822</b>	0.525 @ 3.0 A	80	125	267-03	3-49
40	3	T <sub>A</sub> = 65°C R <sub>θJA</sub> = 28°C/W	<b>MBR340</b>	0.600 @ 3.0 A	80	150	267-03	3-53
60	3	T <sub>A</sub> = 65°C R <sub>θJA</sub> = 28°C/W	<b>MBR360</b>	0.740 @ 3.0 A	80	150	267-03	3-53
100	3	T <sub>A</sub> = 100°C R <sub>θJA</sub> = 28°C/W	<b>MBR3100</b>	0.79 @ 3.0 A	150	150	267-03	3-57
20	5	T <sub>A</sub> = 30°C R <sub>θJA</sub> = 25°C/W	<b>1N5823</b>	0.360 @ 5.0 A	500	125	60-01	3-60
30	5	T <sub>A</sub> = 40°C R <sub>θJA</sub> = 25°C/W	<b>1N5824</b>	0.370 @ 5.0 A	500	125	60-01	3-60
40	5	T <sub>A</sub> = 45°C R <sub>θJA</sub> = 25°C/W	<b>1N5825</b>	0.380 @ 5.0 A	500	125	60-01	3-60

Devices listed in bold, italic are Motorola preferred devices.

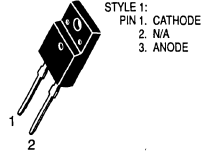
Case 221B  
(TO-220AC)



Case 221A-06  
(TO-220AB)



Case 221E



Case 221D

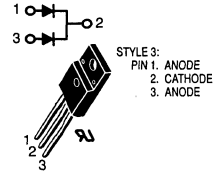


Table 7. TO-220 Type Schottky Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case	Page
45	15	T <sub>C</sub> = 105°C	<b>MBR1545CT</b>	0.84 @ 15 A	150	150	221A-06	3-64
30	20	T <sub>C</sub> = 137°C	<b>MBR2030CTL*</b>	0.52 @ 10 A 0.58 @ 20 A	150	150	221A-06	3-66
45	20	T <sub>C</sub> = 135°C	<b>MBR2045CT</b>	0.84 @ 20 A	150	150	221A-06	3-69
60	20	T <sub>C</sub> = 133°C	<b>MBR2060CT</b>	0.85 @ 10 A 0.95 @ 20 A	150	150	221A-06	3-73
100	20	T <sub>C</sub> = 133°C	<b>MBR20100CT</b>	0.85 @ 10 A 0.95 @ 20 A	150	150	221A-06	3-73
200	20	T <sub>C</sub> = 125°C	<b>MBR20200CT</b>	1.0 @ 20 A	150	150	221A-06	3-75
15	25	T <sub>C</sub> = 90°C	<b>MBR2515L*</b>	0.45 @ 25 A	150	100	221A-06	3-77
35	25	T <sub>C</sub> = 95°C	<b>MBR2535CTL*</b>	0.55 @ 25 A	150	125	221A-06	3-78
45	25	T <sub>C</sub> = 130°C	<b>MBR2545CT</b>	0.82 @ 30 A	150	150	221A-06	3-80
45	30	T <sub>C</sub> = 130°C	<b>MBR3045ST*</b>	0.76 @ 30 A	150	150	221A-06	3-82
45	7.5	T <sub>C</sub> = 105°C	<b>MBR745</b>	0.84 @ 15 A	150	150	221B	3-84
45	10	T <sub>C</sub> = 135°C	<b>MBR1045</b>	0.84 @ 20 A	150	150	221B	3-86
60	10	T <sub>C</sub> = 133°C	<b>MBR1060</b>	0.80 @ 10 A	150	150	221B	3-90
100	10	T <sub>C</sub> = 133°C	<b>MBR10100</b>	0.80 @ 10 A	150	150	221B	3-90
45	16	T <sub>C</sub> = 125°C	<b>MBR1645</b>	0.63 @ 16 A	150	150	221B	3-92
45	15	T <sub>C</sub> = 105°C	<b>MBRF1545CT*</b>	0.84 @ 15 A	150	150	ISOLATED 221D	3-94
45	20	T <sub>C</sub> = 135°C	<b>MBRF2045CT*</b>	0.84 @ 20 A	150	150	ISOLATED 221D	3-97
60	20	T <sub>C</sub> = 133°C	<b>MBRF2060CT*</b>	0.95 @ 20 A	150	150	ISOLATED 221D	3-100
100	20	T <sub>C</sub> = 133°C	<b>MBRF20100CT*</b>	0.95 @ 20 A	150	150	ISOLATED 221D	3-103
200	20	T <sub>C</sub> = 125°C	<b>MBRF20200CT*</b>	1.0 @ 20 A	150	150	ISOLATED 221D	3-106
45	25	T <sub>C</sub> = 125°C	<b>MBRF2545CT*</b>	0.82 @ 25 A	150	150	ISOLATED 221D	3-109
45	7.5	T <sub>C</sub> = 105°C	<b>MBRF745*</b>	0.84 @ 15 A	150	150	ISOLATED 221E	3-112
45	10	T <sub>C</sub> = 135°C	<b>MBRF1045*</b>	0.84 @ 20 A	150	150	ISOLATED 221E	3-115

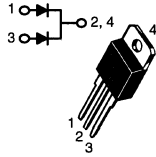
Ⓜ Indicates UL Recognized — File #E69369

\* New Product

Devices listed in bold, italic are Motorola preferred devices.



Case 340D  
(TO-218AC)



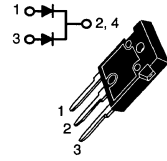
STYLE 2:  
PIN 1. ANODE 1  
2. CATHODES  
3. ANODE 2  
4. CATHODES

Case 340E  
(TO-218)



STYLE 1:  
PIN 1. CATHODE  
3. ANODE  
4. CATHODE

Case 340F  
(TO-247)



STYLE 2:  
PIN 1. ANODE 1  
2. CATHODES  
3. ANODE 2  
4. CATHODES  
(BACK HEATSINK)

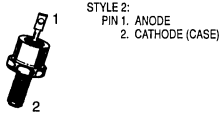
Table 8. TO-218 Types and TO-247 Schottky Rectifiers

$V_{RRM}$ (Volts)	$I_O$ (Amperes)	$I_O$ Rating Condition	Device	Max $V_F$ @ $i_F$ $T_C = 25^\circ\text{C}$ (Volts)	$I_{FSM}$ (Amperes)	$T_J$ Max ( $^\circ\text{C}$ )	Case	Page
45	30	$T_C = 105^\circ\text{C}$	<b><i>MBR3045PT</i></b>	0.76 @ 30 A	200	150	340D	3-119
45	40	$T_C = 125^\circ\text{C}$	<b><i>MBR4045PT</i></b>	0.70 @ 20 A 0.80 @ 40 A	400	150	340D	3-121
45	60	$T_C = 125^\circ\text{C}$	<b><i>MBR6045PT</i></b> *	0.62 @ 30 A 0.75 @ 60 A	500	150	340D	3-123
25	50	$T_C = 125^\circ\text{C}$	<b><i>MBR5025L</i></b> *	0.54 @ 30 A 0.62 @ 50 A	300	150	340E	3-125
45	30	$T_C = 105^\circ\text{C}$	<b><i>MBR3045WT</i></b>	0.76 @ 30 A	200	150	340F	3-127
15	40	$T_C = 125^\circ\text{C}$	<b><i>MBR4015LWT</i></b> *	0.42 @ 20 A 0.50 @ 40 A	400	150	340F	3-129
45	40	$T_C = 125^\circ\text{C}$	<b><i>MBR4045WT</i></b>	0.70 @ 20 A 0.80 @ 40 A	400	150	340F	3-131
45	60	$T_C = 125^\circ\text{C}$	<b><i>MBR6045WT</i></b> *	0.62 @ 30 A 0.75 @ 60 A	500	150	340F	3-133

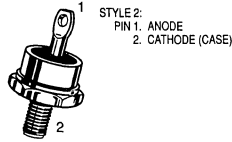
\* New Product

Devices listed in bold, italic are Motorola preferred devices.

Case 56  
(DO-203AA)



Case 257  
(DO-203AB)



Case 11-03  
(TO-204AA)

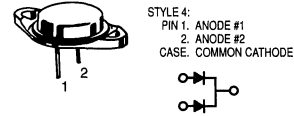
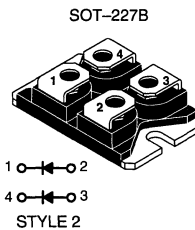
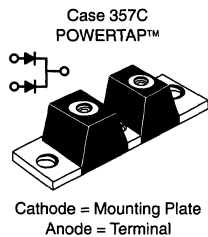


Table 9. TO-204AA (formerly TO-3), DO-203AA and DO-203AB (formerly DO-4 and DO-5)  
Schottky Rectifier Metal Packages DEVICES NOT RECOMMENDED FOR NEW DESIGN

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case	Page
20	15	T <sub>C</sub> = 85°C (V <sub>R</sub> = 4 V)	<b>1N5826</b>	0.44 @ 15 A	500	125	56	3-135
30	15	T <sub>C</sub> = 85°C (V <sub>R</sub> = 6 V)	<b>1N5827</b>	0.47 @ 15 A	500	125	56	3-135
40	15	T <sub>C</sub> = 85°C (V <sub>R</sub> = 8 V)	<b>1N5828</b>	0.50 @ 15 A	500	125	56	3-135
20	25	T <sub>C</sub> = 85°C (V <sub>R</sub> = 4 V)	<b>1N5829</b>	0.44 @ 25 A	800	125	56	3-139
30	25	T <sub>C</sub> = 85°C (V <sub>R</sub> = 6 V)	<b>1N5830</b>	0.46 @ 25 A	800	125	56	3-139
40	25	T <sub>C</sub> = 85°C (V <sub>R</sub> = 8 V)	<b>1N5831</b>	0.48 @ 25 A	800	125	56	3-139
30	25	T <sub>C</sub> = 70°C	<b>1N6095</b>	0.86 @ 78.5 A T <sub>C</sub> = 70°C	400	125	56	3-144
40	25	T <sub>C</sub> = 70°C	<b>1N6096</b>	0.86 @ 78.5 A T <sub>C</sub> = 70°C	400	125	56	3-144
45	30	T <sub>C</sub> = 105°C	<b>SD41</b>	0.55 @ 78.5 A T <sub>C</sub> = 125°C	600	150	56	3-144
45	35	T <sub>C</sub> = 110°C	<b>MBR3545</b>	0.63 @ 35 A	600	150	56	3-148
20	40	T <sub>C</sub> = 75°C (V <sub>R</sub> = 4 V)	<b>1N5832</b>	0.052 @ 40 A	800	125	257	3-152
30	40	T <sub>C</sub> = 75°C (V <sub>R</sub> = 6 V)	<b>1N5833</b>	0.55 @ 40 A	800	125	257	3-152
40	40	T <sub>C</sub> = 75°C (V <sub>R</sub> = 8 V)	<b>1N5834</b>	0.59 @ 40 A	800	125	257	3-152
30	50	T <sub>C</sub> = 70°C	<b>1N6097</b>	0.86 @ 157 A T <sub>C</sub> = 70°C	800	125	257	3-156
40	50	T <sub>C</sub> = 70°C	<b>1N6098</b>	0.86 @ 157 A T <sub>C</sub> = 70°C	800	125	257	3-156
30	60	T <sub>C</sub> = 120°C	<b>MBR6030L</b>	0.42 @ 30 A 0.48 @ 60 A	1000	150	257	3-160
45	60	T <sub>C</sub> = 90°C	<b>SD51</b>	0.70 @ 60 A	800	150	257	3-156
45	60	T <sub>C</sub> = 100°C	<b>MBR6045</b>	0.70 @ 60 A	800	150	257	3-164
45	65	T <sub>C</sub> = 120°C	<b>MBR6545</b>	0.78 @ 65 A	800	175	257	3-168
45	75	T <sub>C</sub> = 90°C	<b>MBR7545</b>	0.60 @ 60 A T <sub>C</sub> = 125°C	1000	150	257	3-172
45	80	T <sub>C</sub> = 120°C	<b>MBR8045</b>	0.72 @ 80 A	1000	175	257	3-174
45	30	T <sub>C</sub> = 105°C	<b>MBR3045CT</b>	0.76 @ 30 A	400	150	11-03	3-178
45	30	T <sub>C</sub> = 105°C	<b>SD241</b>	0.60 @ 20 A T <sub>C</sub> = 125°C	400	150	11-03	3-178

Devices listed in bold, italic are Motorola preferred devices.



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Table 10. POWERTAP II and SOT-227B Schottky Rectifiers

$V_{RRM}$ (Volts)	$I_O$ (1) (Amperes)	$I_O$ Rating Condition	Device	Max $V_F$ @ $I_F$ $T_C = 25^\circ\text{C}$ (Volts)	$I_{FSM}$ (Amperes)	$T_J$ Max ( $^\circ\text{C}$ )	Case	Page
30	200	$T_C = 125^\circ\text{C}$	<b><i>MBRP20030CTL</i></b> *	0.52 @ 100 A 0.60 @ 200 A	1500	150	357C	3-181
45	200	$T_C = 125^\circ\text{C}$	<b><i>MBRP20045CT</i></b> *	0.78 @ 100 A	1500	175	357C	3-182
60	200	$T_C = 125^\circ\text{C}$	<b><i>MBRP20060CT</i></b> *	0.800 @ 100 A	1500	175	357C	3-182
45	300	$T_C = 120^\circ\text{C}$	<b><i>MBRP30045CT</i></b> *	0.70 @ 150 A 0.82 @ 300 A	2500	175	357C	3-183
60	300	$T_C = 120^\circ\text{C}$	<b><i>MBRP30060CT</i></b> *	0.79 @ 150 A 0.89 @ 300 A	2500	175	357C	3-183
35	600	$T_C = 100^\circ\text{C}$	<b><i>MBRP60035CTL</i></b> *	0.57 @ 300 A	4000	150	357C	3-184
100	80	$T_C = 125^\circ\text{C}$	<b><i>MBR240100V</i></b> *	0.95 @ 40 A	600	150	SOT-227B Style 2	3-185
60	100	$T_C = 125^\circ\text{C}$	<b><i>MBR25060V</i></b> *	0.65 @ 50 A	800	150	SOT-227B Style 2	3-187
45	160	$T_C = 125^\circ\text{C}$	<b><i>MBR28045V</i></b> *	0.80 @ 80 A 1.0 @ 160 A	900	150	SOT-227B Style 2	3-188

(1)  $I_O$  is total device current capability.

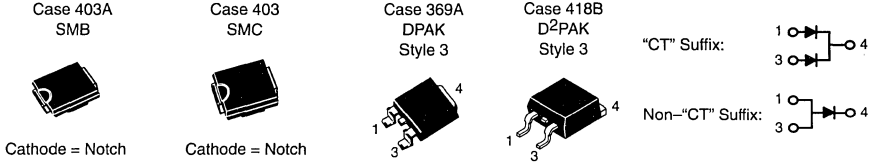
All POWERTAP devices are being converted to the new, more rugged, POWERTAP II configuration beginning January 1994. Contact your Motorola representative for more details.

All SOT-227B devices have 2500 volts isolation between the heatsink and active elements.

\* New Product

Devices listed in bold, italic are Motorola preferred devices.

# Ultrafast Rectifiers

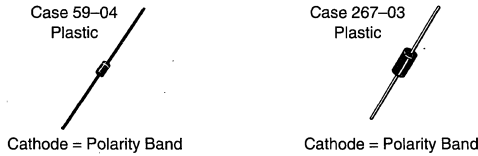


**Table 11. Surface Mount Ultrafast Rectifiers**

$V_{RRM}$ (Volts)	$I_O$ <sup>(1)</sup> (Amperes)	$I_O$ Rating Condition	Device	Max $t_{rr}$ (ns)	Max $V_F$ @ $i_F$ $T_C = 25^\circ\text{C}$ (Volts)	$I_{FSM}$ (Amperes)	$T_J$ Max ( $^\circ\text{C}$ )	Package	Page
200	1	$T_L = 155^\circ\text{C}$	<b>MURS120T3</b>	35	0.875 @ 1.0 A	40	175	SMB	4-2
600	1	$T_L = 150^\circ\text{C}$	<b>MURS160T3</b>	75	1.25 @ 1.0 A	35	175	SMB	4-2
200	3	$T_L = 140^\circ\text{C}$	<b>MURS320T3</b>	35	0.875 @ 3.0 A	75	175	SMC	4-5
600	3	$T_L = 130^\circ\text{C}$	<b>MURS360T3</b>	75	1.25 @ 3.0 A	75	175	SMC	4-5
200	3	$T_L = 158^\circ\text{C}$	<b>MURD320</b>	35	0.95 @ 3.0 A	75	175	DPAK	4-8
200	6	$T_L = 145^\circ\text{C}$	<b>MURD620CT</b>	35	1.0 @ 3.0 A	63	175	DPAK	4-11
400	8	$T_L = 120^\circ\text{C}$	<b>MURHB840CT</b> *	28	2.2 @ 4.0 A	100	175	D <sup>2</sup> PAK	4-14
200	16	$T_L = 150^\circ\text{C}$	<b>MURB1620CT</b>	35	0.975 @ 8.0 A	100	175	D <sup>2</sup> PAK	4-17
600	16	$T_L = 150^\circ\text{C}$	<b>MURB1660CT</b>	60	1.5 @ 8.0 A	100	175	D <sup>2</sup> PAK	4-20

(1)  $I_O$  is total device current capability.

\* New Product

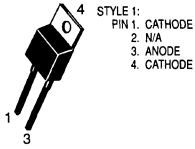


**Table 12. Axial Lead Ultrafast Rectifiers**

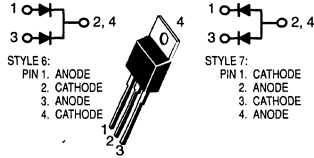
$V_{RRM}$ (Volts)	$I_O$ (Amperes)	$I_O$ Rating Condition	Device	Max $t_{rr}$ (ns)	Max $V_F$ @ $i_F$ $T_C = 25^\circ\text{C}$ (Volts)	$I_{FSM}$ (Amperes)	$T_J$ Max ( $^\circ\text{C}$ )	Case	Page
200	1	$T_A = 130^\circ\text{C}$ $R_{\theta JA} = 50^\circ\text{C/W}$	<b>MUR120</b>	25	0.875 @ 1.0 A	35	175	59-04	4-23
400	1	$T_A = 120^\circ\text{C}$ $R_{\theta JA} = 50^\circ\text{C/W}$	<b>MUR140</b>	50	1.25 @ 1.0 A	35	175	59-04	4-23
600	1	$T_A = 120^\circ\text{C}$ $R_{\theta JA} = 50^\circ\text{C/W}$	<b>MUR160</b>	50	1.25 @ 1.0 A	35	175	59-04	4-23
1000	1	$T_A = 95^\circ\text{C}$ $R_{\theta JA} = 50^\circ\text{C/W}$	<b>MUR1100E</b>	75	1.75 @ 1.0 A	35	175	59-04	4-27
200	4	$T_A = 80^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>MUR420</b>	25	0.875 @ 3.0 A	125	175	267-03	4-31
400	4	$T_A = 40^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>MUR440</b>	50	1.25 @ 3.0 A	70	175	267-03	—
600	4	$T_A = 40^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>MUR460</b>	50	1.25 @ 3.0 A	70	175	267-03	4-31
1000	4	$T_A = 35^\circ\text{C}$ $R_{\theta JA} = 28^\circ\text{C/W}$	<b>MUR4100E</b>	75	1.75 @ 3.0 A	70	175	267-03	4-35

Devices listed in bold, italic are Motorola preferred devices.

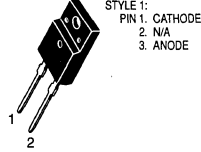
Case 221B  
(TO-220AC)



Case 221A-06  
(TO-220AB)



Case 221E



Case 221D

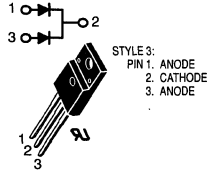




Table 13. TO-220 Type Ultrafast Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case	Page
200	6	T <sub>C</sub> = 130°C	<i>MUR620CT</i>	35	0.975 @ 3.0 A	75	175	221A-06	4-39
400	8	T <sub>C</sub> = 120°C	<i>MURH840CT</i>	28	2.0 @ 4.0 A	100	175	221A-06	4-41
600	8	T <sub>C</sub> = 120°C	<i>MURH860CT</i>	35	2.8 @ 4.0 A	100	175	221A-06	4-44
200	16	T <sub>C</sub> = 150°C	<i>MUR1620CT</i>	35	0.975 @ 8.0 A	100	175	221A-06	4-46
200	16	T <sub>C</sub> = 160°C	<i>MUR1620CTR</i>	85	1.2 @ 8.0 A	100	175	221A-06	4-51
400	16	T <sub>C</sub> = 150°C	<i>MUR1640CT</i>	60	1.30 @ 8.0 A	100	175	221A-06	4-46
600	16	T <sub>C</sub> = 150°C	<i>MUR1660CT</i>	60	1.5 @ 8.0 A	100	175	221A-06	4-46
1500	5	T <sub>C</sub> = 125°C	<i>MUR5150E</i>	175	2.4 @ 5.0 A	100	125	221B	4-54
200	8	T <sub>C</sub> = 150°C	<i>MUR820</i>	35	0.975 @ 8.0 A	100	175	221B	4-56
400	8	T <sub>C</sub> = 150°C	<i>MUR840*</i>	50	1.30 @ 8.0 A	100	175	221B	4-56
600	8	T <sub>C</sub> = 150°C	<i>MUR860*</i>	50	1.50 @ 8.0 A	100	175	221B	4-56
800	8	T <sub>C</sub> = 175°C	<i>MUR880E</i>	75	1.80 @ 8.0 A	100	175	221B	—
1000	8	T <sub>C</sub> = 150°C	<i>MUR8100E</i>	75	1.80 @ 8.0 A	100	175	221B	4-61
1200	10	T <sub>C</sub> = 125°C	<i>MUR10120E</i>	175	2.2 @ 6.5 A	100	125	221B	4-65
1500	10	T <sub>C</sub> = 125°C	<i>MUR10150E</i>	175	2.4 @ 6.5 A	100	125	221B	4-68
200	15	T <sub>C</sub> = 150°C	<i>MUR1520</i>	35	1.05 @ 15 A	200	175	221B	4-71
400	15	T <sub>C</sub> = 150°C	<i>MUR1540</i>	60	1.25 @ 15 A	150	175	221B	4-71
600	15	T <sub>C</sub> = 145°C	<i>MUR1560</i>	60	1.50 @ 15 A	150	175	221B	4-71
200	8	T <sub>C</sub> = 150°C	<i>MURF820*</i>	25	0.975 @ 8.0 A	100	150	ISOLATED 221E	4-76
200	16	T <sub>C</sub> = 150°C	 <i>MURF1620CT*</i>	25	0.975 @ 8.0 A	100	150	ISOLATED 221D	4-79
600	16	T <sub>C</sub> = 150°C	 <i>MURF1660CT*</i>	50	1.50 @ 8.0 A	100	150	ISOLATED 221D	4-82

 Indicates UL Recognized — File #E69369

\* New Product

Devices listed in bold, italic are Motorola preferred devices.

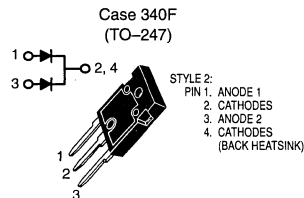
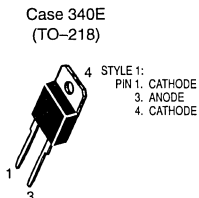
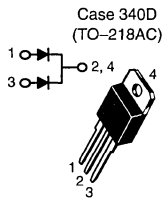


Table 14. TO-218 Types and TO-247 Ultrafast Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case	Page
200	30	T <sub>C</sub> = 145°C	<i>MUR3020WT</i>	35	1.05 @ 15 A	150	175	340F	4-85
400	30	T <sub>C</sub> = 145°C	<i>MUR3040WT</i>	60	1.25 @ 15 A	150	175	340F	4-85
600	30	T <sub>C</sub> = 145°C	<i>MUR3060WT</i>	60	1.70 @ 15 A	150	175	340F	4-85
200	30	T <sub>C</sub> = 150°C	<i>MUR3020PT</i>	35	1.12 @ 15 A	200	175	340D	4-90
400	30	T <sub>C</sub> = 150°C	<i>MUR3040PT</i>	60	1.12 @ 15 A	150	175	340D	4-90
600	30	T <sub>C</sub> = 145°C	<i>MUR3060PT</i>	60	1.20 @ 15 A	150	175	340D	4-90
400	30	T <sub>C</sub> = 70°C	<i>MUR3040 *</i>	100	1.5 @ 30 A	300	175	340E	4-95
800	30	T <sub>C</sub> = 70°C	<i>MUR3080 *</i>	110	1.90 @ 30 A	300	175	340E	4-97
400	60	T <sub>C</sub> = 70°C	<i>MUR6040</i>	100	1.50 @ 60 A	600	175	340E	4-98

\* New Product

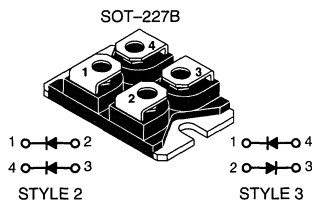
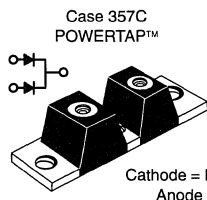


Table 15. POWER TAP II and SOT-227B Ultrafast Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (1) (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case	Page
400	60	T <sub>C</sub> = 60°C	<i>BYT230PIV-400M *</i>	100	1.5 @ 30 A	200	150	SOT-227B Style 3	4-100
1000	60	T <sub>C</sub> = 50°C	<i>BYT230PIV-1000M *</i>	165	1.9 @ 30 A	200	150	SOT-227B Style 3	4-104
400	120	T <sub>C</sub> = 80°C	<i>BYT261PIV-400M *</i>	100	1.5 @ 60 A	600	150	SOT-227B Style 2	4-108
1000	120	T <sub>C</sub> = 60°C	<i>BYT261PIV-1000M *</i>	170	1.9 @ 60 A	400	150	SOT-227B Style 2	4-112
200	200	T <sub>C</sub> = 130°C	<i>MURP20020CT *</i>	50	1.00 @ 100 A	800	175	357C	4-116
400	200	T <sub>C</sub> = 100°C	<i>MURP20040CT *</i>	50	1.30 @ 100 A	800	175	357C	4-116

(1) I<sub>O</sub> is total device current capability.

All POWER TAP devices are being converted to the new, more rugged, POWER TAP II configuration beginning January 1994. Contact your Motorola representative for more details.

All SOT-227B devices have 2500 volts isolation between the heatsink and active elements.

UL Indicates UL Recognized — File #E69369

\* New Product

Devices listed in bold, italic are Motorola preferred devices.

# Fast Recovery Rectifiers/General-Purpose Rectifiers

Axial lead Fast Recovery Rectifiers having maximum switching times of 200 ns and low cost general purpose rectifiers are listed in the table below.

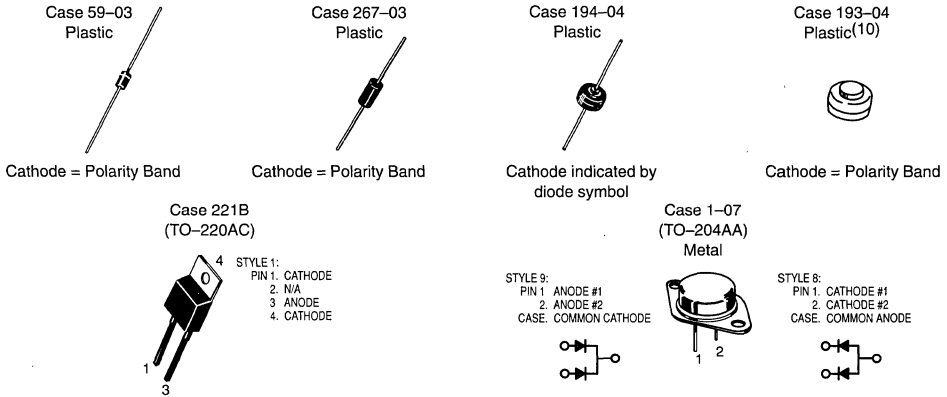


Table 16. Fast Recovery Rectifiers/General Purpose Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ I <sub>F</sub> T <sub>J</sub> = 25°C (Volts)	Max t <sub>rr</sub> (ns)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Case	Page
400	1	T <sub>A</sub> = 75°C	<b>1N4004</b>	1.1 @ 1.0 A	—	30	150	59-03(3)	5-2
1000	1	T <sub>A</sub> = 75°C	<b>1N4007</b>	1.1 @ 1.0 A	—	30	150	59-03(3)	5-2
200	1	T <sub>A</sub> = 75°C	<b>1N4935</b>	1.2 @ 3.14 A T <sub>J</sub> = 125°C	200	30	150	59-03(3)	5-3
600	1	T <sub>A</sub> = 75°C	<b>1N4937</b>	1.2 @ 3.14 A T <sub>J</sub> = 125°C	200	30	150	59-03(3)	5-3
400	3	T <sub>L</sub> = 105°C	<b>1N5404</b>	1.2 @ 9.4 A	—	200	150	267-03	5-5
600	3	T <sub>L</sub> = 105°C	<b>1N5406</b>	1.2 @ 9.4 A	—	200	150	267-03	5-5
200	3	T <sub>A</sub> = 80°C(8)	<b>MR852</b>	1.25 @ 3.0 A	200	100	150	267-03	5-6
600	3	T <sub>A</sub> = 80°C(8)	<b>MR856</b>	1.25 @ 3.0 A	200	100	150	267-03	5-6
400	6	T <sub>A</sub> = 60°C R <sub>θJA</sub> = 25°C/W	<b>MR754</b>	1.25 @ 100 A	—	400	175	194-04	5-8
1000	6	T <sub>A</sub> = 60°C R <sub>θJA</sub> = 25°C/W	<b>MR760</b>	1.25 @ 100 A	—	400	175	194-04	5-8
400	25	T <sub>C</sub> = 150°C	<b>MR2504</b>	1.18 @ 78.5 A	—	400	175	193-04	5-12
1000	25	T <sub>C</sub> = 150°C	<b>MR2510</b>	1.18 @ 78.5 A	—	400	175	193-04	5-12
100	30	T <sub>C</sub> = 125°C	<b>MR4422CTR</b>	1.2 @ 15 A	—	400	150	1-07 Style 8	5-18
100	30	T <sub>C</sub> = 125°C	<b>MR4422CT</b>	1.2 @ 15 A	—	400	150	1-07 Style 9	5-18
20	35	T <sub>C</sub> = 150°C	<b>MR2535L(11)</b>	1.1 @ 100 A	—	400	175	194-04	5-19

(3) Package Size: 0.120" max diameter by 0.260" length.

(8) Must be derated for reverse power dissipation. See data sheet.

(10) Request data sheet for mounting information.

(11) Overvoltage Transient Suppressor: 24–32 volts avalanche voltage.

Devices listed in bold, italic are Motorola preferred devices.

## ***Section 3***

# **Schottky Data Sheets**

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# Surface Mount Schottky Power Rectifier Plastic SOD-123 Package

**MBR0520LT1  
MBR0520LT3**

Motorola Preferred Devices

**SCHOTTKY BARRIER  
RECTIFIER  
0.5 AMPERES  
20 VOLTS**



**CASE 425-04, Style 1  
SOD-123**

The Schottky Power Rectifier employs the Schottky Barrier principle with a barrier metal that produces optimal forward voltage drop–reverse current tradeoff. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package provides an alternative to the leadless 34 MELF style package. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Very Low Forward Voltage (0.38 V Max @ 0.5 A, 25°C)
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

### Mechanical Characteristics

- Reel Options: MBR0520LT1 = 3,000 per 7" reel/8 mm tape.  
MBR0520LT3 = 10,000 per 13" reel/8 mm tape.
- Device Marking: B2
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> ) T <sub>L</sub> = 90°C	I <sub>F(AV)</sub>	0.5	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	5.5	Amps
Storage Temperature	T <sub>stg</sub>	-65 to +125	°C
Operating Junction Temperature	T <sub>J</sub>	-65 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	1000	V/μs

### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Ambient (1)	R <sub>θJA</sub>	340	°C/W
Thermal Resistance — Junction to Lead	R <sub>θJL</sub>	150	°C/W

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) (I <sub>F</sub> = 0.1 Amps) (I <sub>F</sub> = 0.5 Amps)	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	Volts
		0.300 0.385	0.220 0.330	
Maximum Instantaneous Reverse Current (2) (V <sub>R</sub> = 10 V) (Rated dc Voltage = 20 V)	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
		75 μA 250 μA	5 mA 8 mA	

(1) FR-4 or FR-5 = 3.5 x 1.5 inches using the Motorola minimum recommended footprint.

(2) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2%.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

# MBR0520LT1, MBR0520LT3

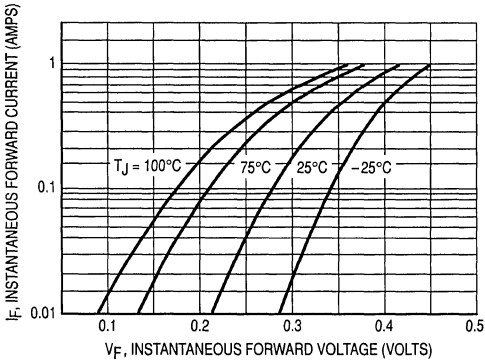


Figure 1. Typical Forward Voltage

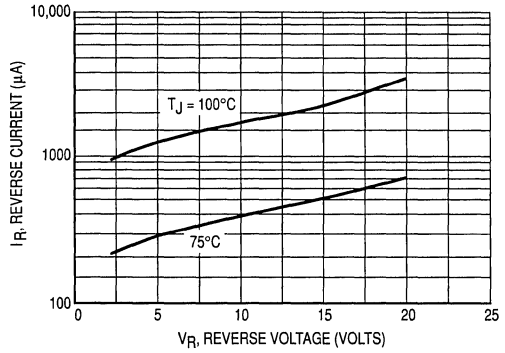


Figure 2. Typical Reverse Current

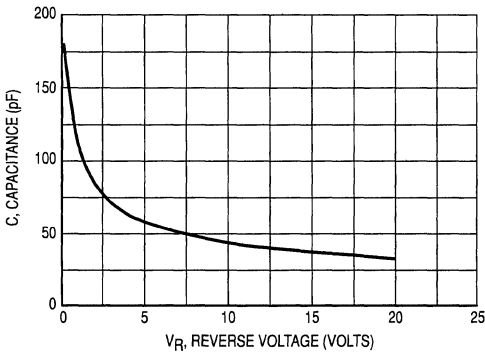


Figure 3. Typical Capacitance

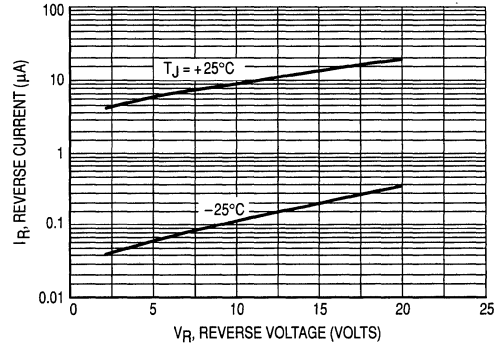


Figure 4. Typical Reverse Current

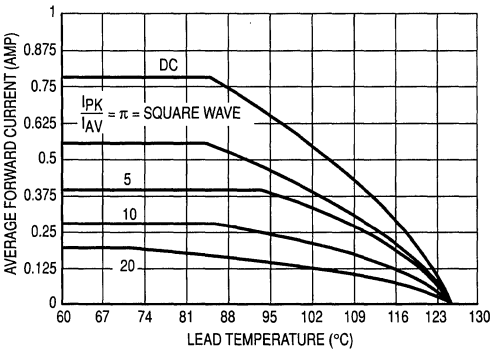


Figure 5. Current Derating (Lead)

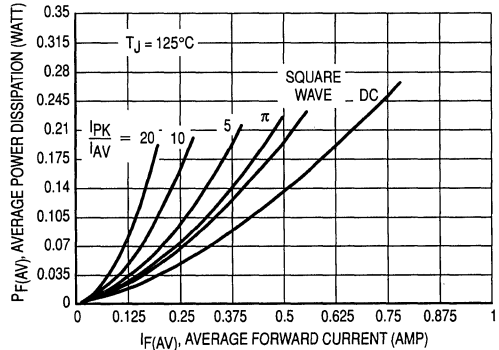


Figure 6. Power Dissipation

# Surface Mount Schottky Power Rectifier

## Plastic SOD-123 Package

**MBR0530T1**  
**MBR0530T3**

Motorola Preferred Devices

**SCHOTTKY BARRIER  
RECTIFIER**  
**0.5 AMPERES**  
**30 VOLTS**



**CASE 425-04**  
**SOD-123**

... using the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. These state-of-the-art devices have the following features:

- Guarding for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

### Mechanical Characteristics

- Reel Options: MBR0530T1 = 3,000 per 7" reel/8 mm tape  
MBR0530T3 = 10,000 per 13" reel/8 mm tape
- Device Marking: B3
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	30	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_L = 100^\circ\text{C}$	$I_{F(AV)}$	0.5	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	5.5	Amps
Storage Temperature	$T_{stg}$	-65 to +125	°C
Operating Junction Temperature	$T_J$	-65 to +125	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	V/ $\mu\text{s}$

### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Ambient (1)	$R_{\theta JA}$	340	°C/W
Thermal Resistance — Junction to Lead (1)	$R_{\theta JL}$	150	°C/W

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) ( $I_F = 0.1$ Amps, $T_J = 25^\circ\text{C}$ ) ( $I_F = 0.5$ Amps, $T_J = 25^\circ\text{C}$ )	$V_F$	0.375 0.43	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ ) ( $V_R = 15$ V, $T_C = 25^\circ\text{C}$ )	$I_R$	130 20	$\mu\text{A}$

- (1) FR-4 or FR-5 = 3.5 x 1.5 inches using the Motorola minimum recommended footprint.  
(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBR0530T1, MBR0530T3

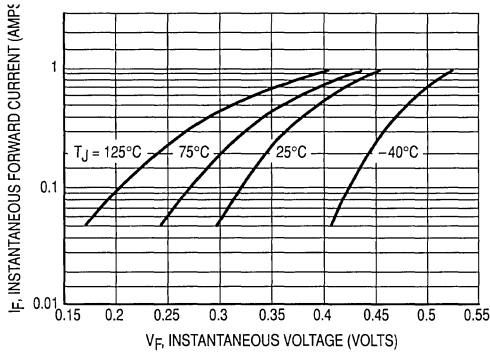


Figure 1. Typical Forward Voltage

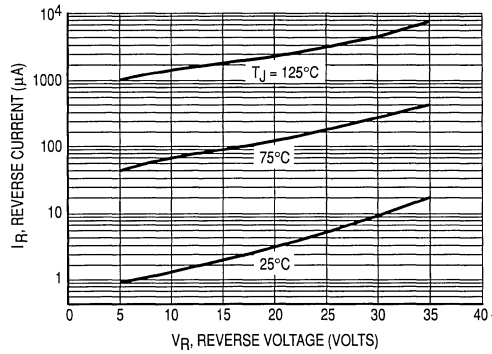


Figure 2. Typical Reverse Current

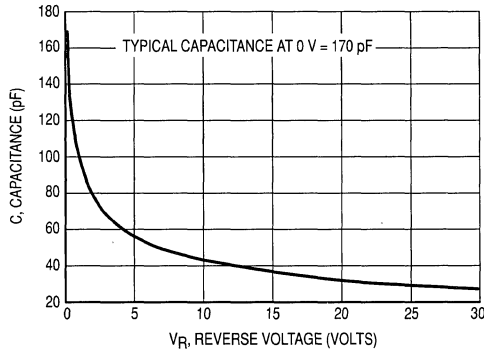


Figure 3. Typical Capacitance

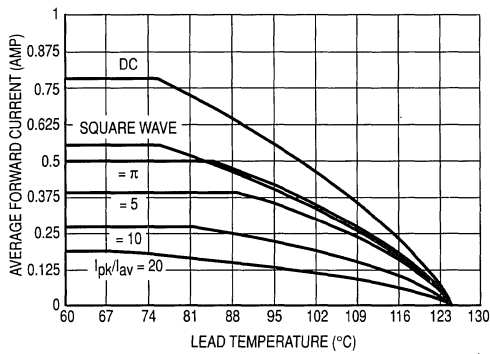


Figure 4. Current Derating (Lead)

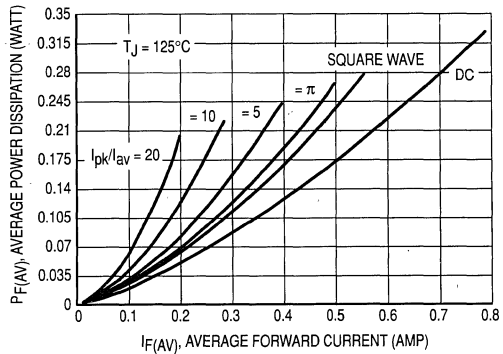


Figure 5. Power Dissipation

# Surface Mount Schottky Power Rectifier Plastic SOD-123 Package

**MBR0540T1  
MBR0540T3**

Motorola Preferred Devices

**SCHOTTKY BARRIER  
RECTIFIER  
0.5 AMPERES  
40 VOLTS**



**CASE 425-04  
SOD-123**

... using the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

### Mechanical Characteristics

- Reel Options: MBR0540T1 = 3,000 per 7" reel/8 mm tape  
MBR0540T3 = 10,000 per 13" reel/8 mm tape
- Device Marking: B4
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	40	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_L = 100^\circ\text{C}$	$I_F(AV)$	0.5	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	5.5	Amps
Storage Temperature	$T_{stg}$	-65 to +150	°C
Operating Junction Temperature	$T_J$	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	1000	V/ $\mu\text{s}$

### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Ambient (1)	$R_{\theta JA}$	340	°C/W
Thermal Resistance — Junction to Lead (1)	$R_{\theta JL}$	150	°C/W

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) ( $I_F = 0.5$ Amps, $T_J = 25^\circ\text{C}$ )	$V_F$	0.51	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ ) ( $V_R = 20$ V, $T_C = 25^\circ\text{C}$ )	$I_R$	20 10	$\mu\text{A}$

(1) FR-4 or FR-5 = 3.5 x 1.5 inches using the Motorola minimum recommended footprint.

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# Designer's™ Data Sheet

## Schottky Power Rectifier

### Surface Mount Power Package

**MBRS130LT3**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
1.0 AMPERE  
30 VOLTS**



CASE 403A-03

... Employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Very Low Forward Voltage Drop (0.395 Volts Max @ 1.0 A, T<sub>J</sub> = 25°C)
- Small Compact Surface Mountable Package with J-Bend Leads
- Highly Stable Oxide Passivated Junction
- Guardring for Stress Protection

#### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B130

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	Volts
Average Rectified Forward Current T <sub>L</sub> = 120°C T <sub>L</sub> = 110°C	I <sub>F(AV)</sub>	1.0 2.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	40	Amps
Operating Junction Temperature	T <sub>J</sub>	- 65 to +125	°C

#### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Lead (T <sub>L</sub> = 25°C)	R <sub>θJL</sub>	12	°C/W
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#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) (I <sub>F</sub> = 1.0 A, T <sub>J</sub> = 25°C) (I <sub>F</sub> = 2.0 A, T <sub>J</sub> = 25°C)	V <sub>F</sub>	0.395 0.445	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T <sub>J</sub> = 25°C) (Rated dc Voltage, T <sub>J</sub> = 100°C)	I <sub>R</sub>	1.0 10	mA

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2%.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRS130LT3

3

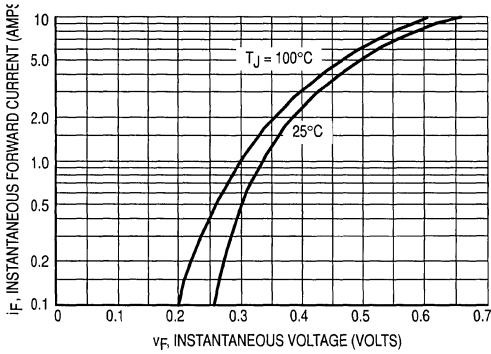


Figure 1. Typical Forward Voltage

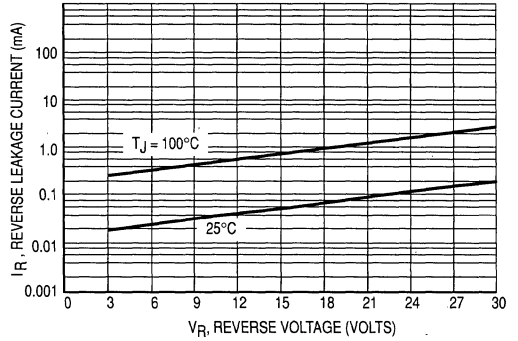


Figure 2. Typical Reverse Leakage Current

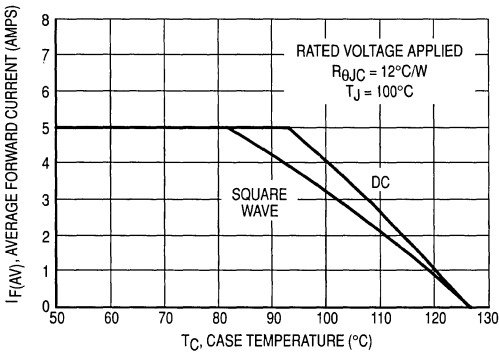


Figure 3. Current Derating (Case)

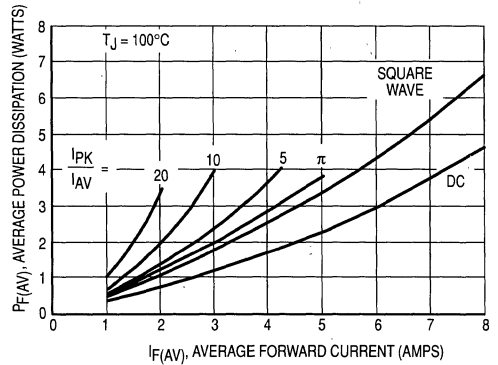


Figure 4. Typical Power Dissipation

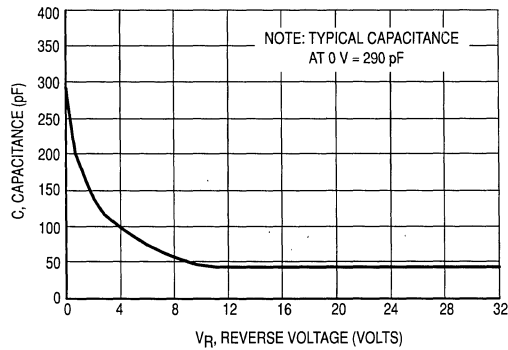


Figure 5. Typical Capacitance

# Surface Mount Schottky Power Rectifier

**MBRS140T3**

Motorola Preferred Device

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.55 Volts Max @ 1.0 A,  $T_J = 25^\circ\text{C}$ )
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

**Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes:  $260^\circ\text{C}$  Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B140

**SCHOTTKY BARRIER  
RECTIFIERS  
1.0 AMPERE  
40 VOLTS**



CASE 403A-03

3

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	40	Volts
Average Rectified Forward Current $T_L = 115^\circ\text{C}$	$I_F(AV)$	1	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	40	Amps
Operating Junction Temperature	$T_J$	-65 to +125	$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Lead ( $T_L = 25^\circ\text{C}$ )	$R_{\theta JL}$	12	$^\circ\text{C/W}$
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**ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (1) ( $I_F = 1.0\text{ A}$ , $T_J = 25^\circ\text{C}$ )	$v_F$	0.6	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 100^\circ\text{C}$ )	$i_R$	1.0 10	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .



# MBRS140T3

3

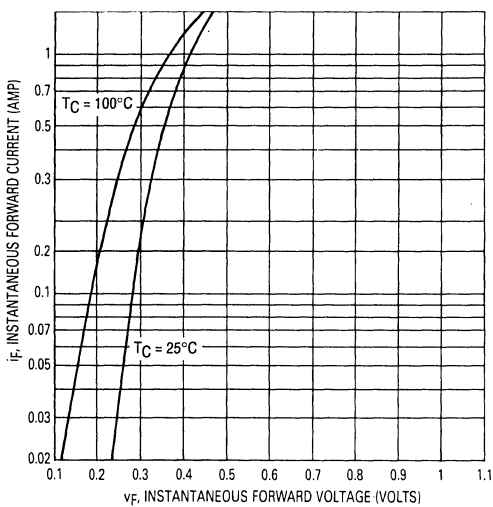


Figure 1. Typical Forward Voltage

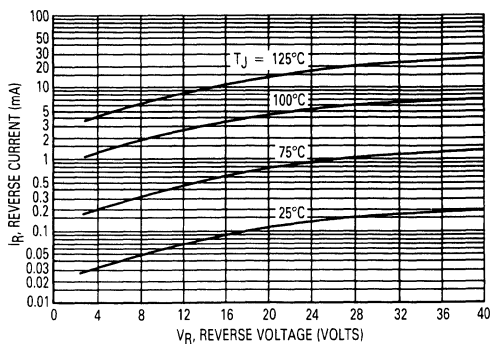


Figure 2. Typical Reverse Current

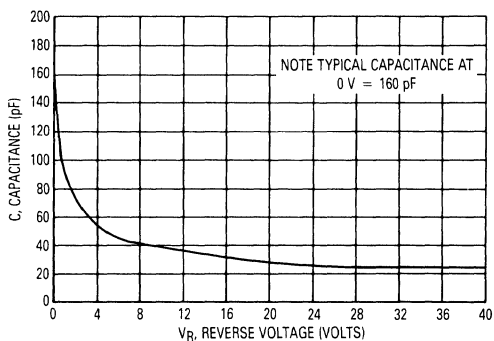


Figure 3. Typical Capacitance

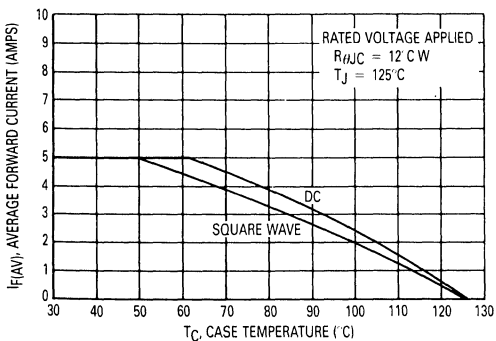


Figure 4. Current Derating (Case)

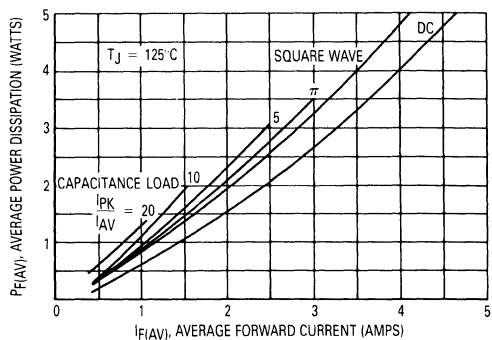


Figure 5. Power Dissipation

*Designer's™ Data Sheet*  
**Schottky Power Rectifier**  
**Surface Mount Power Package**

Schottky Power Rectifiers employ the use of the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system. These state-of-the-art devices have the following features:

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- High Blocking Voltage — 100 Volts
- 150°C Operating Junction Temperature
- Guardring for Stress Protection

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B110

**MBRS1100T3**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
1.0 AMPERE  
100 VOLTS**



CASE 403A-03

3

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	100	Volts
Average Rectified Forward Current $T_L = 120^\circ\text{C}$ $T_L = 100^\circ\text{C}$	$I_F(AV)$	1.0 2.0	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	50	Amps
Operating Junction Temperature	$T_J$	-65 to +150	°C
Voltage Rate of Change	$dv/dt$	10	V/ns

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Lead ( $T_L = 25^\circ\text{C}$ )	$R_{\theta JL}$	22	°C/W
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**ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (1) ( $I_F = 1.0\text{ A}$ , $T_J = 25^\circ\text{C}$ )	$v_F$	0.75	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 100^\circ\text{C}$ )	$i_R$	0.5 5.0	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$

Preferred devices are Motorola recommended choices for future use and best overall value.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

# MBRS1100T3

## TYPICAL ELECTRICAL CHARACTERISTICS

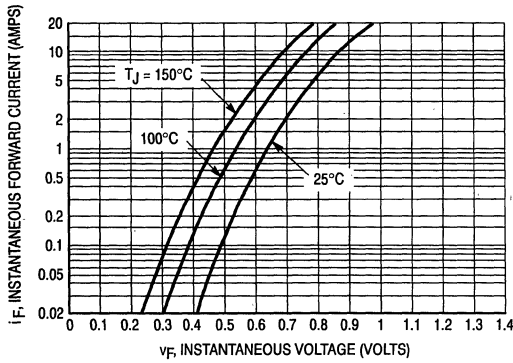


Figure 1. Typical Forward Voltage

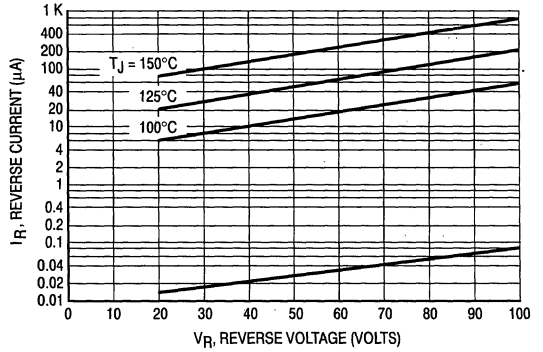


Figure 2. Typical Reverse Current

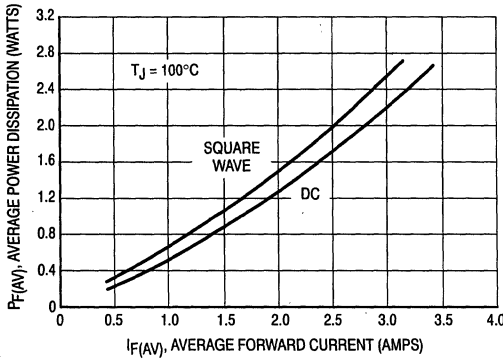


Figure 3. Power Dissipation

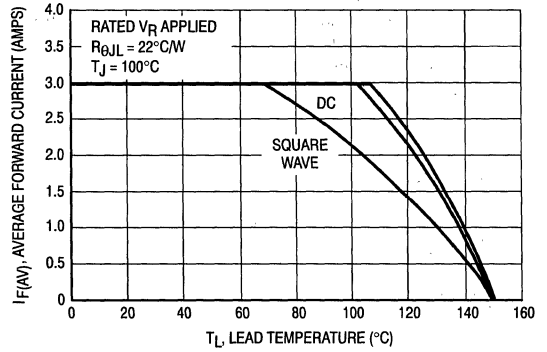


Figure 4. Current Derating, Lead

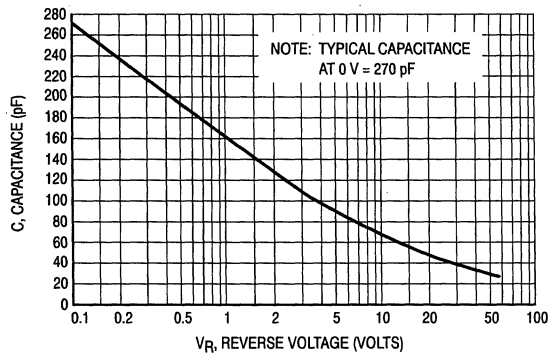


Figure 5. Typical Capacitance

# Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.5 Volts Max @ 3.0 A,  $T_J = 25^\circ\text{C}$ )
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

**Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B34, B36

**MBRS340T3**  
**MBRS360T3**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIERS  
3.0 AMPERES  
40, 60 VOLTS**



CASE 403-03

3

**MAXIMUM RATINGS**

Rating	Symbol	MBRS340T3	MBRS360T3	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	40	60	Volts
Average Rectified Forward Current	$I_{F(AV)}$	3.0 @ $T_L = 100^\circ\text{C}$ 4.0 @ $T_L = 90^\circ\text{C}$		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	80		Amps
Operating Junction Temperature	$T_J$	-65 to +125		$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Lead	$R_{\theta JL}$	11	11	$^\circ\text{C/W}$
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**ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (1) ( $I_F = 3.0\text{ A}$ , $T_J = 25^\circ\text{C}$ )	$V_F$	0.525	0.740	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 100^\circ\text{C}$ )	$I_R$	2.0 20	0.5 20	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

# MBRS340T3, MBRS360T3

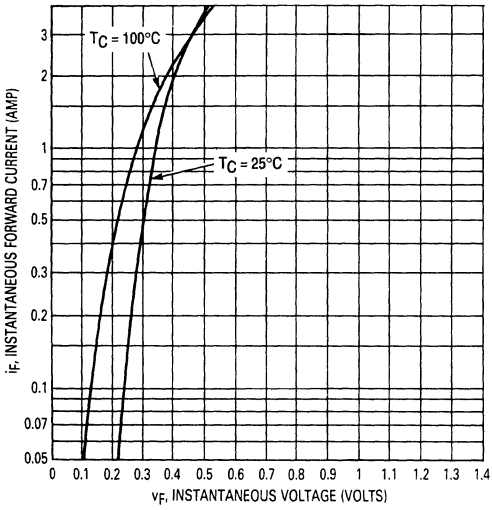


Figure 1. Typical Forward Voltage

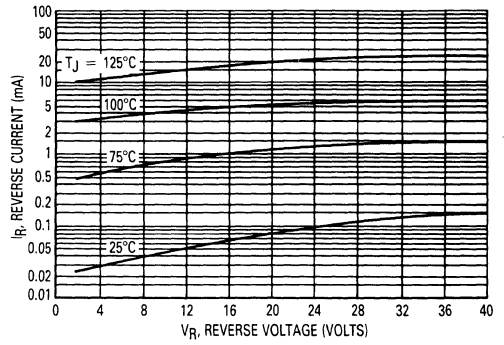


Figure 2. Typical Reverse Current

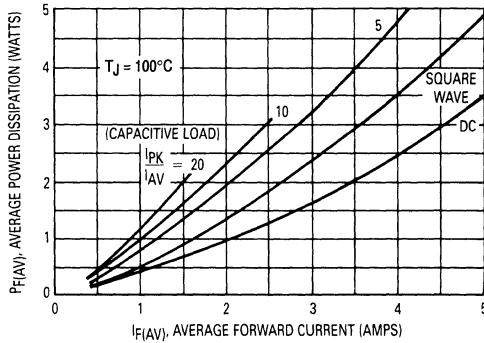


Figure 3. Power Dissipation

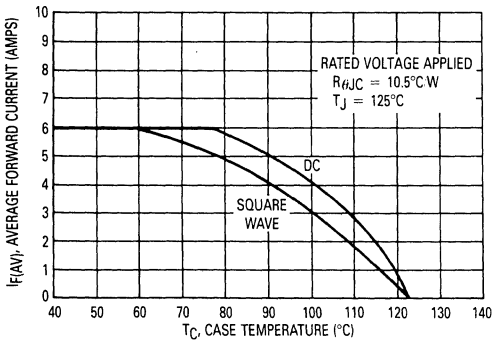


Figure 4. Current Derating (Case)

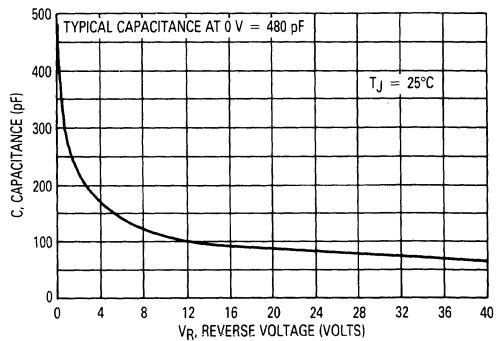


Figure 5. Typical Capacitance

## SWITCHMODE Power Rectifiers

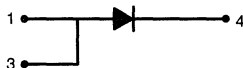
### DKAK Surface Mount Package

... designed for use as output rectifiers, free wheeling, protection and steering diodes in switching power supplies, inverters and other inductive switching circuits. These state-of-the-art devices have the following features:

- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings
- Guaranteed Reverse Avalanche

#### Mechanical Characteristics:

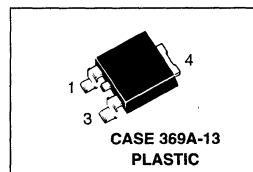
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: B320, B330, B340, B350, B360



**MBRD320**  
**MBRD330**  
**MBRD340**  
**MBRD350**  
**MBRD360**

MBRD320, MBRD340 and MBRD360 are  
 Motorola Preferred Devices

**SCHOTTKY BARRIER**  
**RECTIFIERS**  
**3 AMPERES**  
**20 TO 60 VOLTS**



**3**

#### MAXIMUM RATINGS

Rating	Symbol	MBRD					Unit
		320	330	340	350	360	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	30	40	50	60	Volts
Average Rectified Forward Current ( $T_C = +125^\circ\text{C}$ , Rated $V_R$ )	$I_{F(AV)}$	3					Amps
Peak Repetitive Forward Current, $T_C = +125^\circ\text{C}$ (Rated $V_R$ , Square Wave, 20 kHz)	$I_{FRM}$	6					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	75					Amps
Peak Repetitive Reverse Surge Current (2 $\mu\text{s}$ , 1 kHz)	$I_{RRM}$	1					Amp
Operating Junction Temperature	$T_J$	-65 to +150					$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000					$\text{V}/\mu\text{s}$

#### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	6	$^\circ\text{C}/\text{W}$
Maximum Thermal Resistance, Junction to Ambient (1)	$R_{\theta JA}$	80	$^\circ\text{C}/\text{W}$

#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2) $i_F = 3$ Amps, $T_C = +25^\circ\text{C}$ $i_F = 3$ Amps, $T_C = +125^\circ\text{C}$ $i_F = 6$ Amps, $T_C = +25^\circ\text{C}$ $i_F = 6$ Amps, $T_C = +125^\circ\text{C}$	$V_F$	0.6 0.45 0.7 0.625	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = +25^\circ\text{C}$ ) (Rated dc Voltage, $T_C = +125^\circ\text{C}$ )	$i_R$	0.2 20	mA

(1) Rating applies when surface mounted on the minimum pad size recommended.

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

TYPICAL CHARACTERISTICS

3

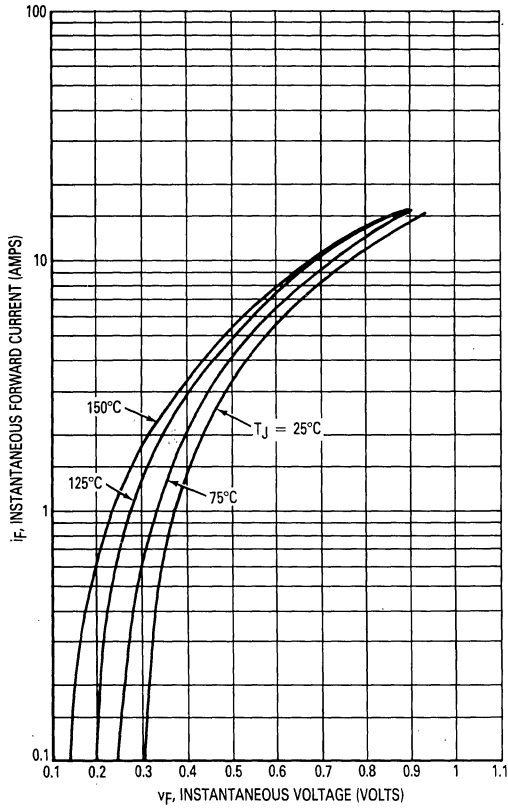
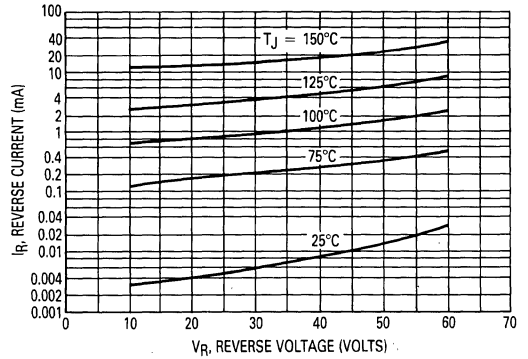


Figure 1. Typical Forward Voltage



\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if  $V_R$  is sufficient below rated  $V_R$ .

Figure 2. Typical Reverse Current

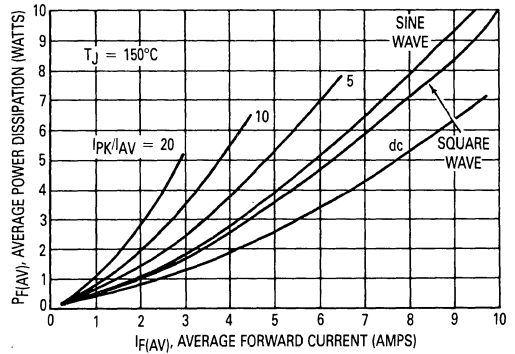


Figure 3. Average Power Dissipation

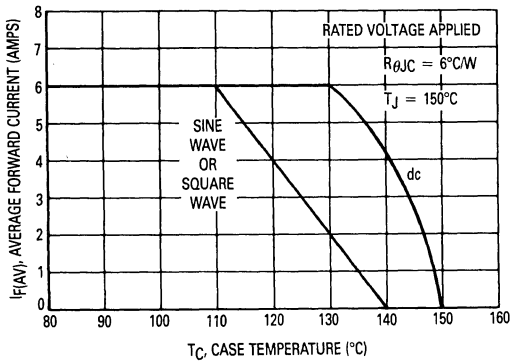


Figure 4. Current Derating, Case

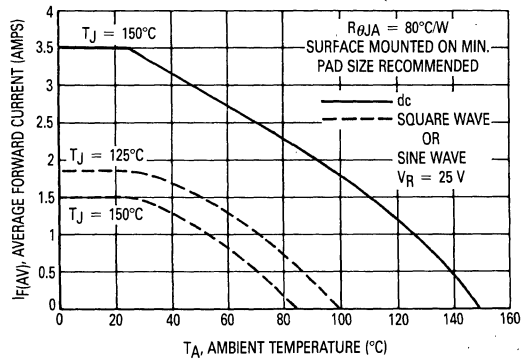


Figure 5. Current Derating, Ambient

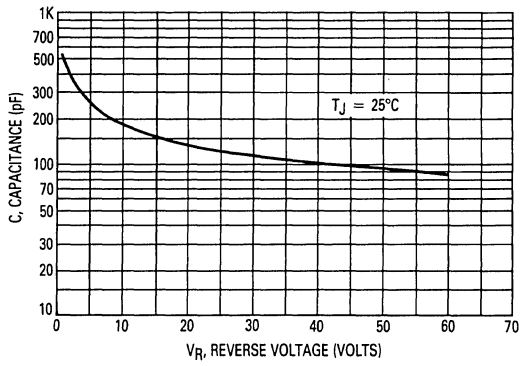


Figure 6. Typical Capacitance



## SWITCHMODE Power Rectifiers

### DPAK Surface Mount Package

... in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings
- Guaranteed Reverse Avalanche

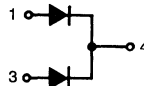
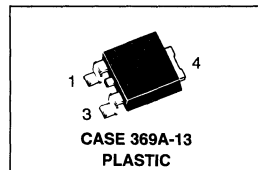
#### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: B620T, B630T, B640T, B650T, B660T

**MBRD620CT**  
**MBRD630CT**  
**MBRD640CT**  
**MBRD650CT**  
**MBRD660CT**

MBRD620CT, MBRD640CT and MBRD660CT are  
 Motorola Preferred Devices

**SCHOTTKY BARRIER  
 RECTIFIERS  
 6 AMPERES  
 20 TO 60 VOLTS**



#### MAXIMUM RATINGS

Rating	Symbol	MBRD					Unit
		620CT	630CT	640CT	650CT	660CT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	30	40	50	60	Volts
Average Rectified Forward Current $T_C = 130^\circ\text{C}$ (Rated $V_R$ )	Per Diode Per Device $I_F(AV)$	3 6					Amps
Peak Repetitive Forward Current, $T_C = 130^\circ\text{C}$ (Rated $V_R$ , Square Wave, 20 kHz) Per Diode	$I_{FRM}$	6					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	75					Amps
Peak Repetitive Reverse Surge Current (2 $\mu\text{s}$ , 1 kHz)	$I_{RRM}$	1					Amp
Operating Junction Temperature	$T_J$	-65 to +150					$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000					$\text{V}/\mu\text{s}$

#### THERMAL CHARACTERISTICS PER DIODE

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	6	$^\circ\text{C}/\text{W}$
Maximum Thermal Resistance, Junction to Ambient (1)	$R_{\theta JA}$	80	$^\circ\text{C}/\text{W}$

#### ELECTRICAL CHARACTERISTICS PER DIODE

Maximum Instantaneous Forward Voltage (2) $i_F = 3$ Amps, $T_C = 25^\circ\text{C}$ $i_F = 3$ Amps, $T_C = 125^\circ\text{C}$ $i_F = 6$ Amps, $T_C = 25^\circ\text{C}$ $i_F = 6$ Amps, $T_C = 125^\circ\text{C}$	$V_F$	0.7 0.65 0.9 0.85	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	0.1 15	mA

(1) Rating applies when surface mounted on the minimum pad size recommended.  
 (2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

# MBRD620CT, MBRD630CT, MBRD640CT, MBRD650CT, MBRD660CT

## TYPICAL CHARACTERISTICS

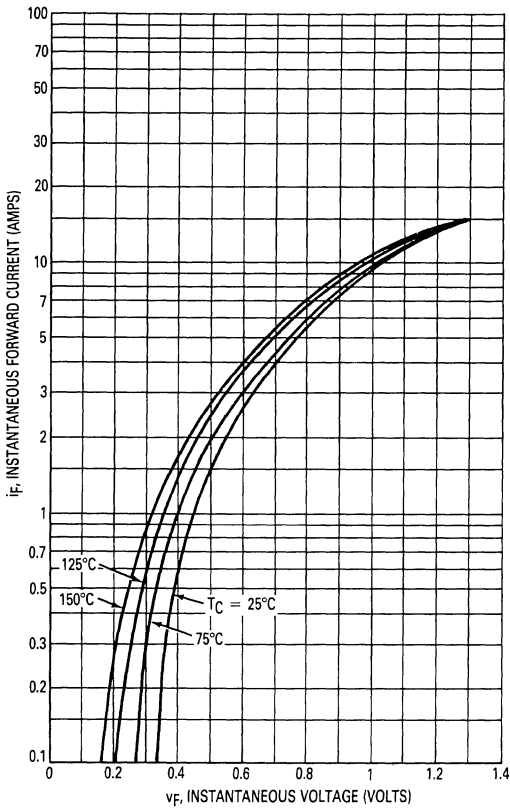
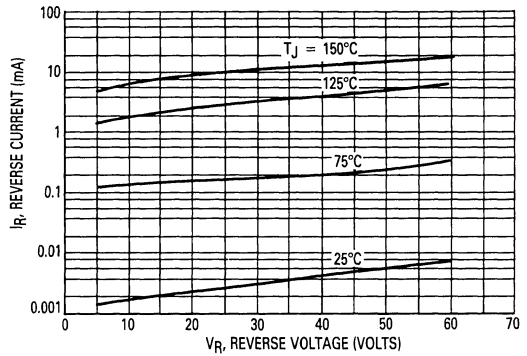


Figure 1. Typical Forward Voltage, Per Leg



\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if  $V_R$  is sufficient below rated  $V_R$ .

Figure 2. Typical Reverse Current, \* Per Leg

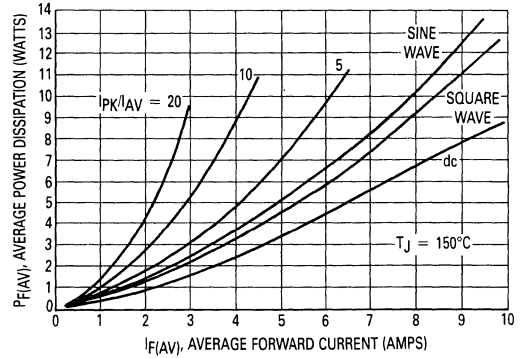


Figure 3. Average Power Dissipation, Per Leg

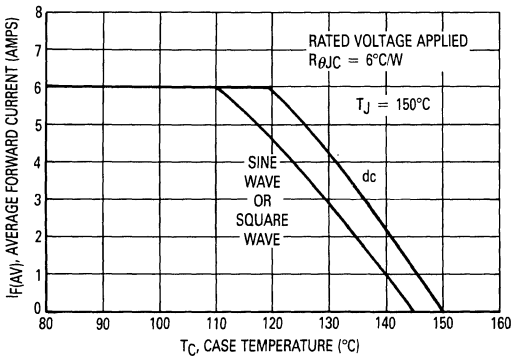


Figure 4. Current Derating, Case, Per Leg

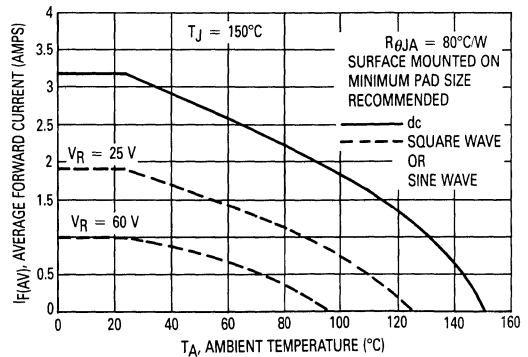


Figure 5. Current Derating, Ambient, Per Leg

3

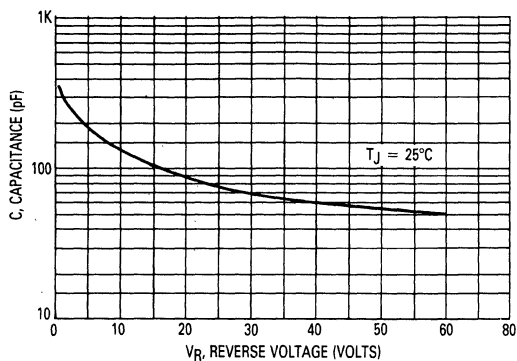


Figure 6. Typical Capacitance, Per Leg

## SWITCHMODE™ Power Rectifier

### PAK Surface Mount Package

This SWITCHMODE power rectifier which uses the Schottky Barrier principle with a proprietary barrier metal, is designed for use as output rectifiers, free wheeling, protection and steering diodes in switching power supplies, inverters and other inductive switching circuits. This state of the art device has the following features:

- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Compact Size
- Lead Formed for Surface Mount

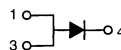
#### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per 13" reel, by adding a "T4" suffix to the part number
- Marking: B835L

**MBRD835L**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
8 AMPERES  
35 VOLTS**



**CASE 369A-13  
PAK PLASTIC, STYLE 3**

3

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	Volts
Average Rectified Forward Current (At Rated $V_R$ ) $T_C = +88^\circ\text{C}$	$I_{F(AV)}$	8	Amps
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz) $T_C = +80^\circ\text{C}$	$I_{FRM}$	16	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	75	Amps
Repetitive Avalanche Current (Current Decaying Linearly to Zero in 1 $\mu\text{s}$ , Frequency Limited by $T_{Jmax}$ )	$I_{AR}$	2	Amps
Storage Temperature	$T_{stg}$	-65 to +150	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	-65 to +125	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10,000	$\text{V}/\mu\text{s}$

#### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	6	$^\circ\text{C}/\text{W}$
Thermal Resistance — Junction to Ambient <sup>(1)</sup>	$R_{\theta JA}$	80	$^\circ\text{C}/\text{W}$

#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage <sup>(2)</sup> ( $I_F = 8$ Amps, $T_C = +25^\circ\text{C}$ ) ( $I_F = 8$ Amps, $T_C = +125^\circ\text{C}$ )	$V_F$	0.51 0.41	Volts
Maximum Instantaneous Reverse Current <sup>(2)</sup> (Rated dc Voltage, $T_C = +25^\circ\text{C}$ ) (Rated dc Voltage, $T_C = +100^\circ\text{C}$ )	$I_R$	1.4 35	mA

(1) Rating applies when surface mounted on the minimum pad size recommended.

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

TYPICAL CHARACTERISTICS

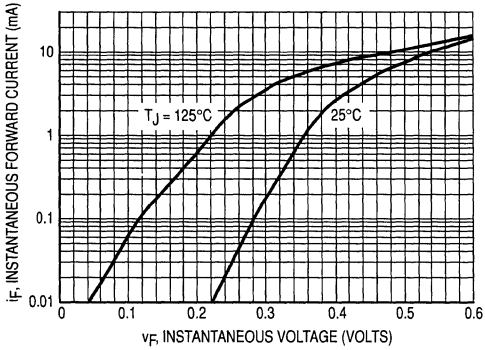


Figure 1. Maximum Forward Voltage

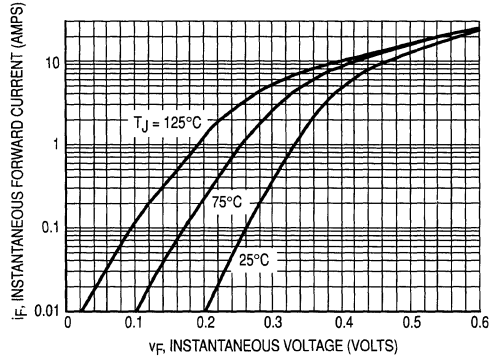


Figure 2. Typical Forward Voltage

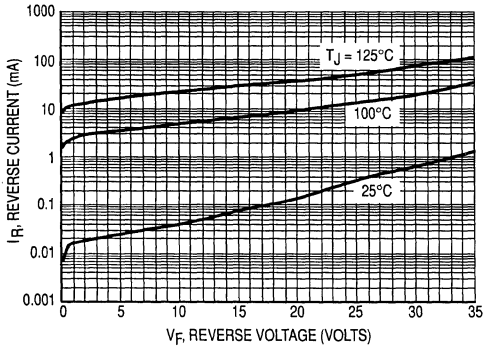


Figure 3. Maximum Reverse Current

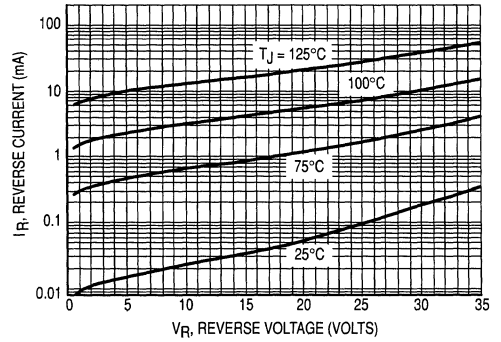


Figure 4. Typical Reverse Current

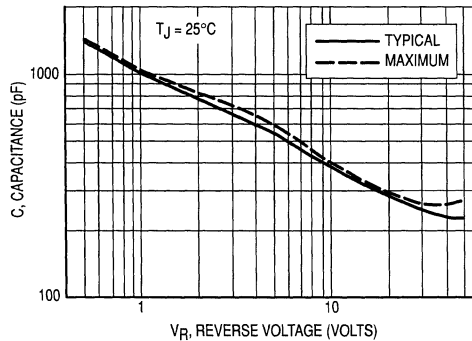


Figure 5. Maximum and Typical Capacitance

# MBRD835L

## TYPICAL CHARACTERISTICS

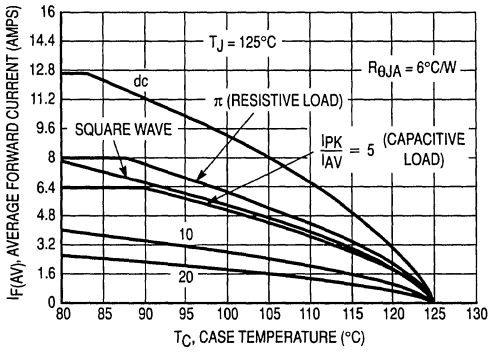


Figure 6. Current Derating, Infinite Heatsink

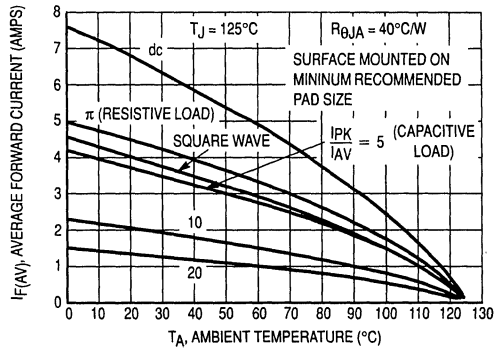


Figure 7. Current Derating

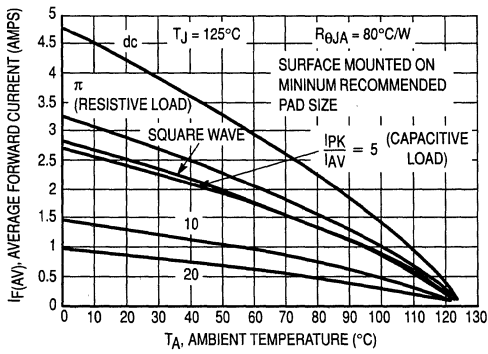


Figure 8. Current Derating, Free Air

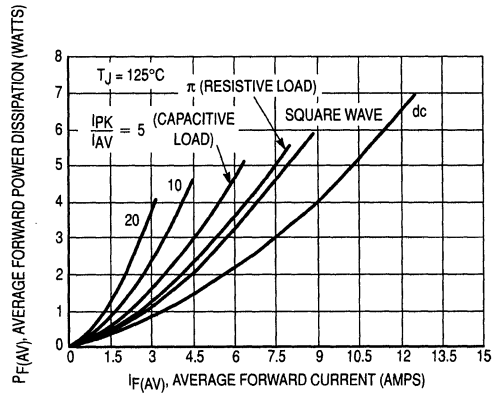


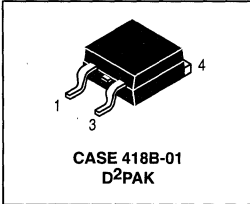
Figure 9. Forward Power Dissipation

3

*Designer's™ Data Sheet*  
**SWITCHMODE™ Power Rectifier**  
**D2PAK Surface Mount Power Package**

**MBRB1545CT**  
Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER**  
**15 AMPERES**  
**45 VOLTS**

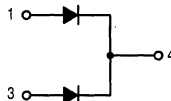


The D2PAK Power Rectifier employs the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B1545T



**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 105^\circ\text{C}$	$I_F(AV)$	7.5 15	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 105^\circ\text{C}$	$I_{FRM}$	15	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	Amp
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	V/ $\mu\text{s}$

**THERMAL CHARACTERISTICS, PER LEG**

Thermal Resistance — Junction to Case — Junction to Ambient (1)	$R_{\theta JC}$ $R_{\theta JA}$	2.0 50	$^\circ\text{C/W}$
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(1) When mounted using minimum recommended pad size on FR-4 board.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

# MBRB1545CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ( $I_F = 7.5$ Amps, $T_J = 125^\circ\text{C}$ ) ( $I_F = 15$ Amps, $T_J = 125^\circ\text{C}$ ) ( $I_F = 15$ Amps, $T_J = 25^\circ\text{C}$ )	$v_F$	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	15 0.1	mA

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

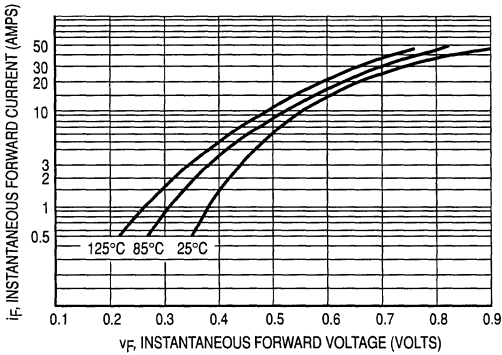


Figure 1. Typical Forward Voltage, Per Leg

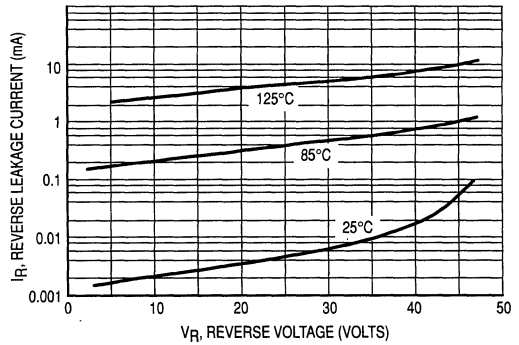


Figure 2. Typical Reverse Current, Per Leg

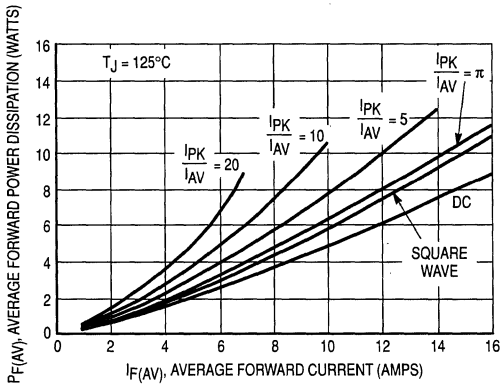


Figure 3. Typical Forward Power Dissipation

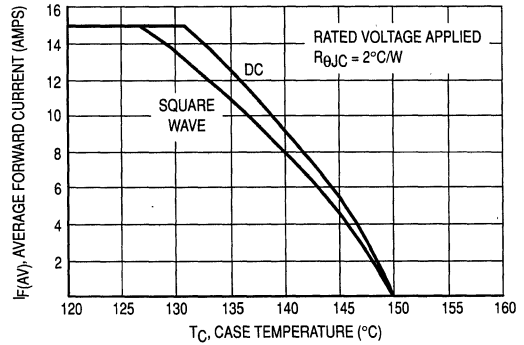


Figure 4. Current Derating, Case



*Designer's™ Data Sheet*  
**SWITCHMODE™ Power Rectifier**  
**D2PAK Surface Mount Power Package**

Employs the use of the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94,  $V_O$  at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to Industry Standard TO-220 Package

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2060T

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	60	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 110^\circ\text{C}$ Total Device	$I_{F(AV)}$	10 20	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 100^\circ\text{C}$	$I_{FRM}$	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	0.5	Amp
Storage Temperature	$T_{stg}$	-65 to +175	°C
Operating Junction Temperature	$T_J$	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	V/ $\mu\text{s}$

**THERMAL CHARACTERISTICS, PER LEG**

Thermal Resistance — Junction to Case — Junction to Ambient (2)	$R_{\theta JC}$ $R_{\theta JA}$	2.0 50	°C/W
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(2) See Chapter 7 for mounting conditions

Preferred devices are Motorola recommended choices for future use and best overall value.

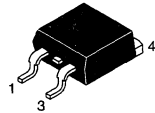
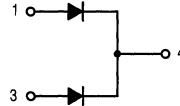
**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Rev 1

**MBRB2060CT**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
20 AMPERES  
60 VOLTS**



CASE 418B-02

# MBRB2060CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (1) ( $i_F = 20$ Amps, $T_J = 125^\circ\text{C}$ ) ( $i_F = 20$ Amps, $T_J = 25^\circ\text{C}$ )	$v_F$	0.85 0.95	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	150 0.15	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$

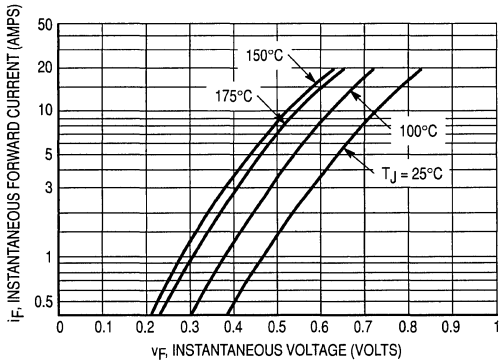


Figure 1. Typical Forward Voltage Per Diode

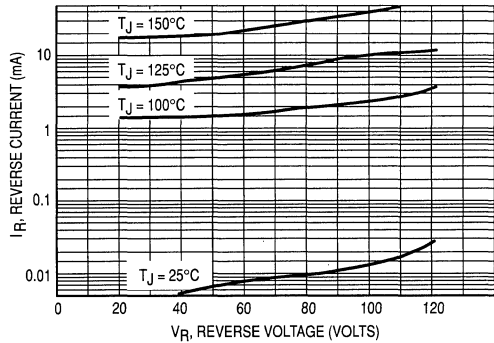


Figure 2. Typical Reverse Current Per Diode

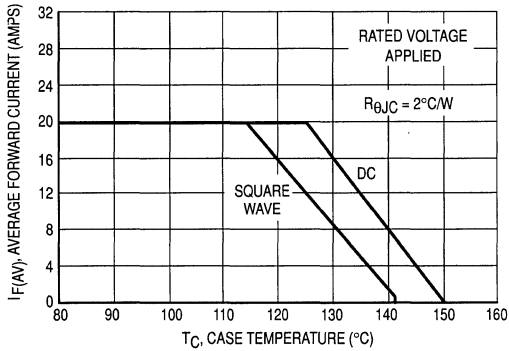


Figure 3. Typical Current Derating, Case, Per Leg

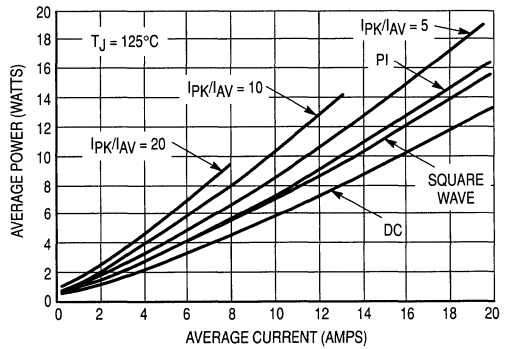


Figure 4. Average Power Dissipation and Average Current

3

*Designer's™ Data Sheet*  
**SWITCHMODE™ Power Rectifier**  
**D<sup>2</sup>PAK Surface Mount Power Package**

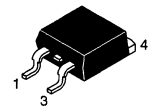
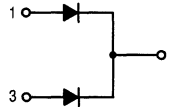
**MBRB20100CT**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
20 AMPERES  
100 VOLTS**

The D<sup>2</sup>PAK Power Rectifier employs the use of the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>0</sub> at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to Industry Standard TO-220 Package



**CASE 418B-02  
D<sup>2</sup>PAK**

3

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B20100T

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> ) T <sub>C</sub> = 110°C	I <sub>F(AV)</sub>	10 20	Amps
Total Device			
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 100°C	I <sub>FRM</sub>	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	0.5	Amp
Storage Temperature	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	T <sub>J</sub>	-65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10000	V/μs

**THERMAL CHARACTERISTICS, PER LEG**

Thermal Resistance — Junction to Case — Junction to Ambient (2)	R <sub>θJC</sub> R <sub>θJA</sub>	2.0 50	°C/W
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(2) See Chapter 7 for mounting conditions

Preferred devices are Motorola recommended choices for future use and best overall value.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Rev 1

# MBRB20100CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (1) ( $i_F = 10$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 10$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 20$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.75	Volts
		0.85	
		0.85	
		0.95	
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	6.0	mA
		0.1	

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$

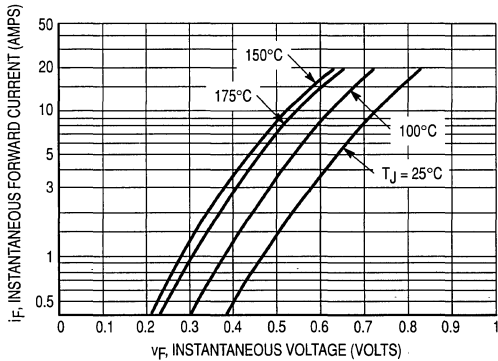


Figure 1. Typical Forward Voltage Per Diode

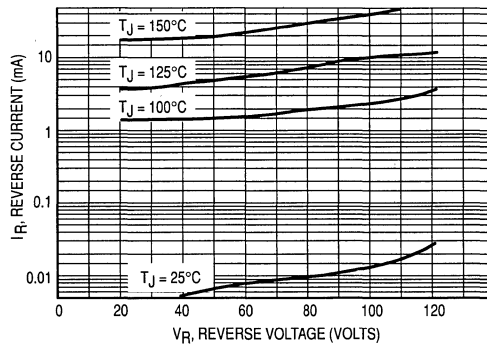


Figure 2. Typical Reverse Current Per Diode

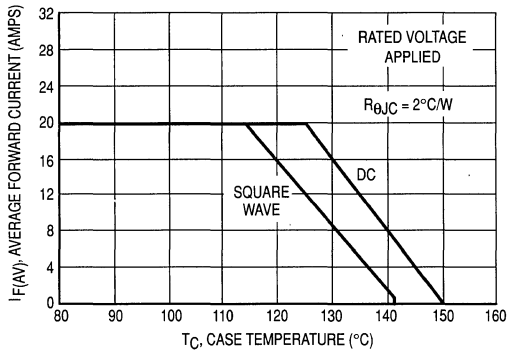


Figure 3. Typical Current Derating, Case, Per Leg

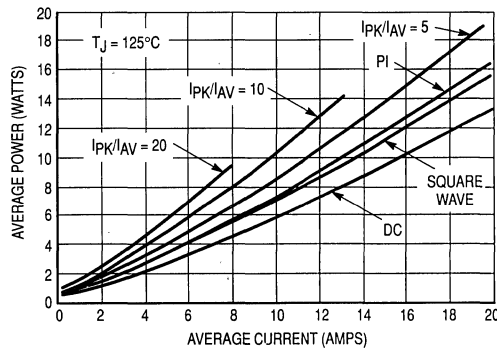


Figure 4. Average Power Dissipation and Average Current

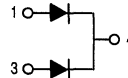
## Switchmode™ Power Dual Schottky Rectifier

... using Schottky Barrier technology with a platinum barrier metal. This state-of-the-art device is designed for use in high frequency switching power supplies and converters with up to 48 volt outputs. They block up to 200 volts and offer improved Schottky performance at frequencies from 250 kHz to 5.0 MHz.

- **200 Volt Blocking Voltage**
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (10,000 V/μs)
- Dual Diode Construction — Terminals 1 and 3 Must be Connected for Parallel Operation at Full Rating

### Mechanical Characteristics

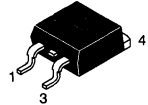
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B20200



**MBRB20200CT**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
20 AMPERES  
200 VOLTS**



CASE 418B-02

### MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	10 20	Amps Per Leg Per Package
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	$I_{FRM}$	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	$I_{RRM}$	1.0	Amp
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs

### THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
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### ELECTRICAL CHARACTERISTICS (PER LEG)

Maximum Instantaneous Forward Voltage (1) ( $I_F = 10$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 10$ Amps, $T_C = 125^\circ\text{C}$ ) ( $I_F = 20$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 20$ Amps, $T_C = 125^\circ\text{C}$ )	$V_F$	0.9 0.8 1.0 0.9	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ )	$I_R$	1.0 50	mA

### DYNAMIC CHARACTERISTICS (PER LEG)

Capacitance ( $V_R = -5.0$ V, $T_C = 25^\circ\text{C}$ , Frequency = 1.0 MHz)	$C_T$	500	pF
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(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤2.0%.

Preferred devices are Motorola recommended choices for future use and best overall value.

# MBRB20200CT

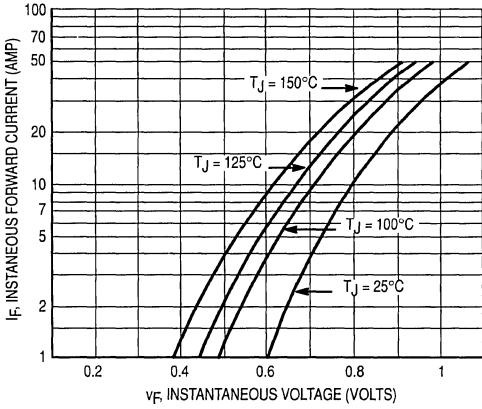


Figure 1. Typical Forward Voltage (Per Leg)

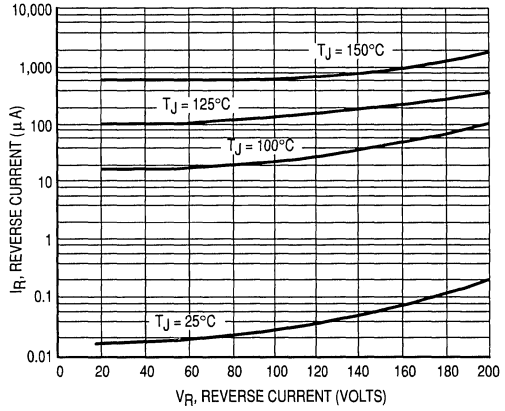


Figure 2. Typical Reverse Current (Per Leg)

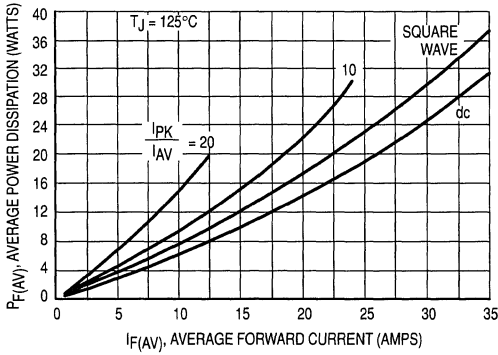


Figure 3. Forward Power Dissipation

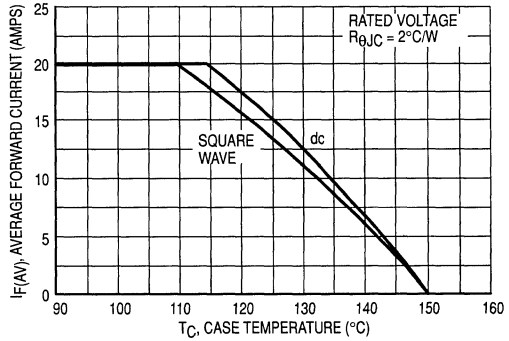


Figure 4. Current Derating, Case

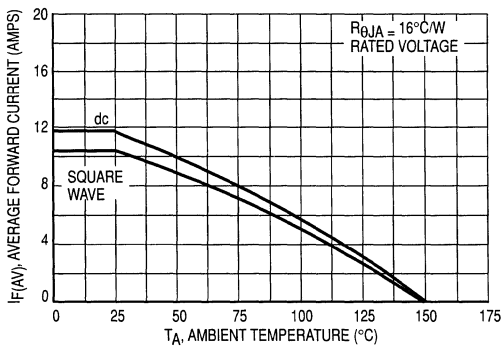


Figure 5. Current Derating, Ambient

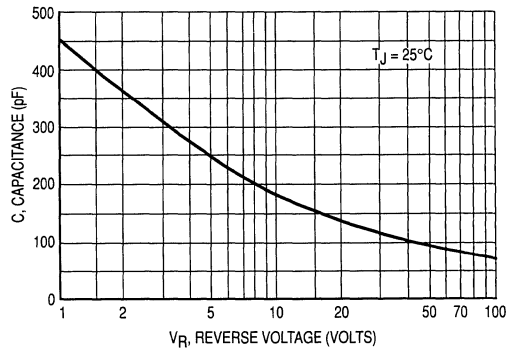


Figure 6. Typical Capacitance (Per Leg)

*Designer's™ Data Sheet*  
**SWITCHMODE™ Power Rectifier**  
**OR'ing Function Diode**  
**D<sup>2</sup>PAK Surface Mount Power Package**

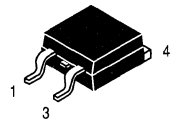
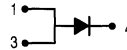
**MBRB2515L**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
25 AMPERES  
15 VOLTS**

The D<sup>2</sup>PAK Power Rectifier employs the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 100°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package



**CASE 418B-01  
D<sup>2</sup>PAK**

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2515L

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	15	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 90^\circ\text{C}$	$I_F(AV)$	25	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 100^\circ\text{C}$	$I_{FRM}$	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Storage Temperature	$T_{stg}$	-65 to +150	°C
Operating Junction Temperature	$T_J$	100	°C
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	V/ $\mu\text{s}$

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Case — Junction to Ambient (1)	$R_{\theta JC}$ $R_{\theta JA}$	1.0 50	°C/W
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(1) When mounted using minimum recommended pad size on FR-4 board.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRB2515L

## ELECTRICAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ( $I_F = 19$ Amps, $T_J = 70^\circ\text{C}$ ) ( $I_F = 25$ Amps, $T_J = 70^\circ\text{C}$ ) ( $I_F = 25$ Amps, $T_J = 25^\circ\text{C}$ )	$V_F$	0.28 0.42 0.45	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 70^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$I_R$	200 15	mA

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

3

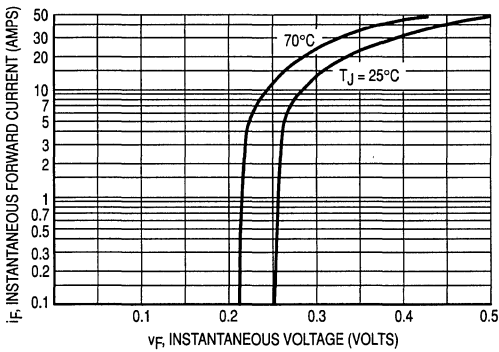


Figure 1. Typical Forward Voltage

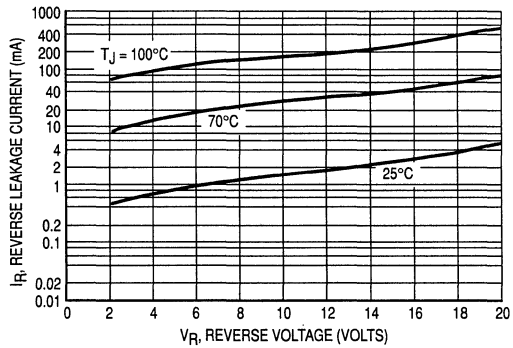


Figure 2. Typical Reverse Leakage Current

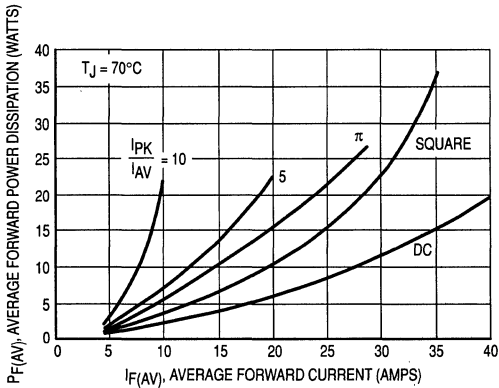


Figure 3. Typical Forward Power Dissipation

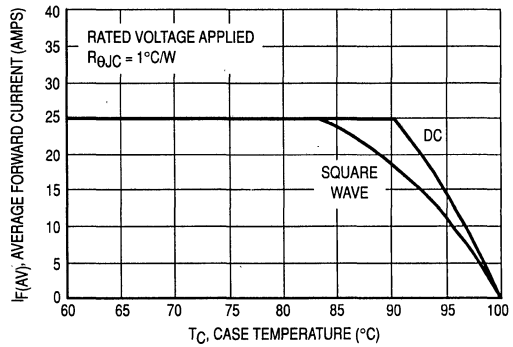


Figure 4. Current Derating, Case



# Designer's™ Data Sheet

## SWITCHMODE™ Power Rectifier

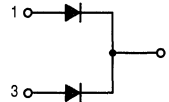
### D<sup>2</sup>PAK Surface Mount Power Package

The D<sup>2</sup>PAK Power Rectifier employs the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

#### Mechanical Characteristics

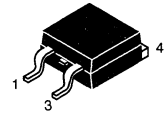
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2535L



**MBRB2535CTL**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
25 AMPERES  
35 VOLTS**



**CASE 418B-02  
D<sup>2</sup>PAK**

#### MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 110^\circ\text{C}$	$I_{F(AV)}$	12.5	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 90^\circ\text{C}$	$I_{FRM}$	25	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	Amp
Storage Temperature	$T_{stg}$	-65 to +150	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	-65 to +125	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10,000	$\text{V}/\mu\text{s}$

#### THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case — Junction to Ambient (1)	$R_{\theta JC}$ $R_{\theta JA}$	2.0 50	$^\circ\text{C}/\text{W}$
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(1) When mounted using minimum recommended pad size on FR-4 board.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRB2535CTL

## ELECTRICAL CHARACTERISTICS (PER LEG)

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ( $i_F = 25$ Amps, $T_J = 25^\circ\text{C}$ ) ( $i_F = 12.5$ Amps, $T_J = 125^\circ\text{C}$ ) ( $i_F = 12.5$ Amps, $T_J = 25^\circ\text{C}$ )	$v_F$	0.55 0.41 0.47	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	500 10	mA

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

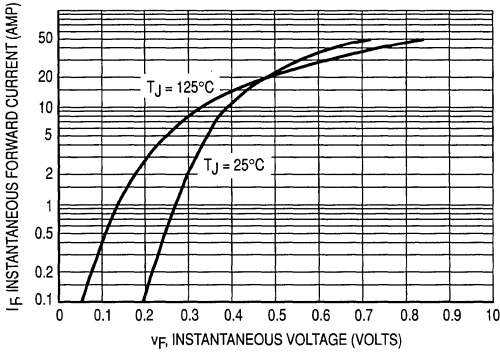


Figure 1. Typical Forward Voltage, Per Leg

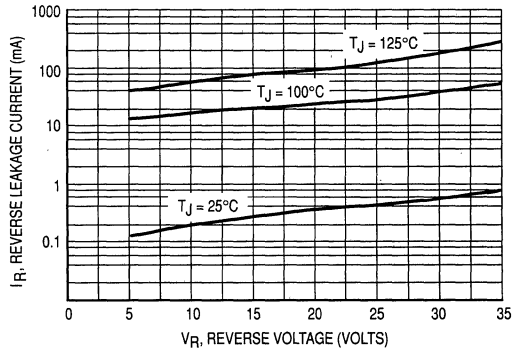


Figure 2. Typical Reverse Current, Per Leg

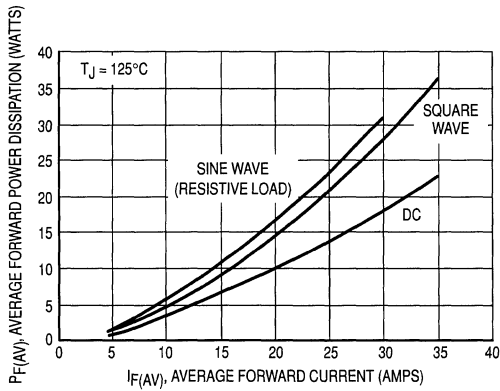


Figure 3. Typical Forward Power Dissipation

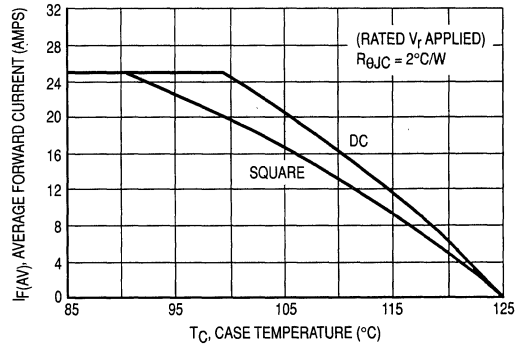


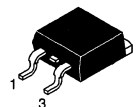
Figure 4. Current Derating, Case

*Designer's™ Data Sheet*  
**SWITCHMODE™ Power Rectifier**  
**D2PAK Surface Mount Power Package**

**MBRB2545CT**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
30 AMPERES  
45 VOLTS**



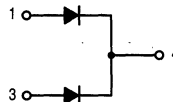
**CASE 418B-02  
D2PAK**

The D2PAK Power Rectifier employs the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Guaranteed Reverse Avalanche
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2545T



**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 130^\circ\text{C}$ Total Device	$I_{F(AV)}$	15 30	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 130^\circ\text{C}$	$I_{FRM}$	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	Amp
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	$\text{V}/\mu\text{s}$

**THERMAL CHARACTERISTICS, PER LEG**

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.5	$^\circ\text{C}/\text{W}$
— Junction to Ambient (1)	$R_{\theta JA}$	.50	

(1) When mounted using minimum recommended pad size on FR-4 board.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

# MBRB2545CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (2) ( $I_F = 30$ Amps, $T_J = 125^\circ\text{C}$ ) ( $I_F = 30$ Amps, $T_J = 25^\circ\text{C}$ )	$v_F$	0.73 0.82	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_J = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	40 0.2	mA

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

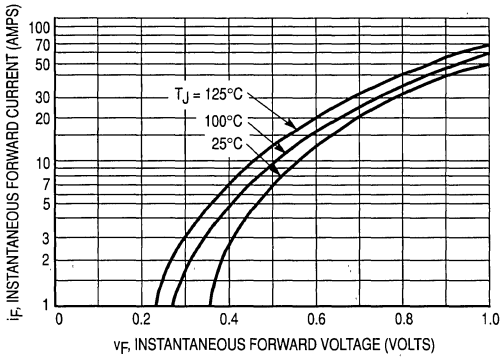


Figure 1. Typical Forward Voltage, Per Leg

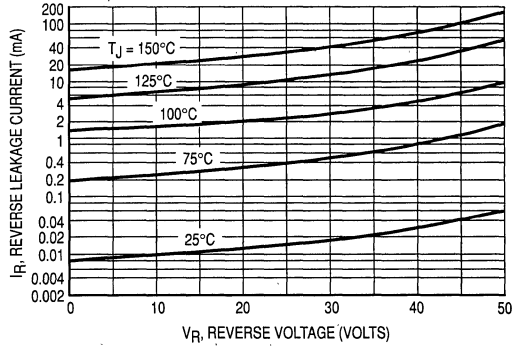


Figure 2. Typical Reverse Current, Per Leg

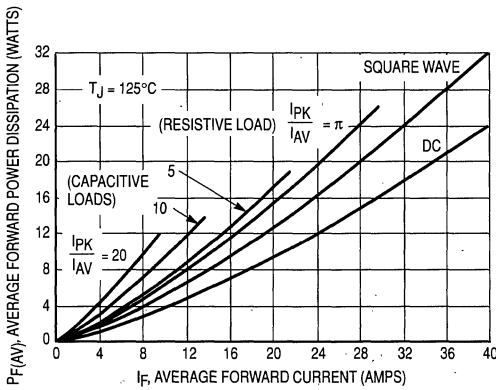


Figure 3. Typical Forward Power Dissipation

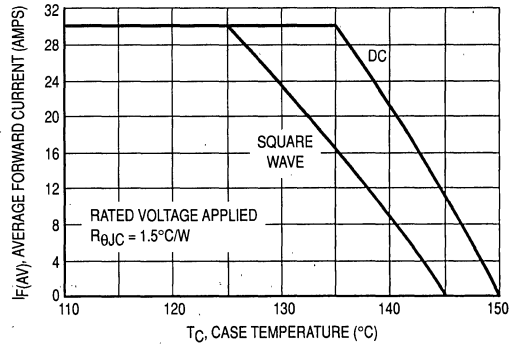


Figure 4. Current Derating, Case

## Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low  $v_f$
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency

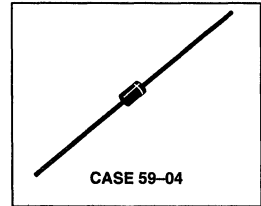
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N5817, 1N5818, 1N5819

**1N5817**  
**1N5818**  
**1N5819**

1N5817 and 1N5819 are  
Motorola Preferred Devices

**SCHOTTKY BARRIER  
RECTIFIERS**  
**1 AMPERE**  
**20, 30 and 40 VOLTS**



3

### MAXIMUM RATINGS

Rating	Symbol	1N5817	1N5818	1N5819	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	30	40	V
Non-Repertitive Peak Reverse Voltage	$V_{RSM}$	24	36	48	V
RMS Reverse Voltage	$V_R(RMS)$	14	21	28	V
Average Rectified Forward Current (2) ( $V_R(equiv) \leq 0.2 V_R(dc)$ , $T_L = 90^\circ C$ , $R_{\theta JA} = 80^\circ C/W$ , P.C. Board Mounting, see Note 2, $T_A = 55^\circ C$ )	$I_O$	1.0			A
Ambient Temperature (Rated $V_R(dc)$ , $P_{F(AV)} = 0$ , $R_{\theta JA} = 80^\circ C/W$ )	$T_A$	85	80	75	$^\circ C$
Non-Repertitive Peak Surge Current (Surge applied at rated load conditions, half-wave, single phase 60 Hz, $T_L = 70^\circ C$ )	$I_{FSM}$	25 (for one cycle)			A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	$T_J, T_{stg}$	-65 to +125			$^\circ C$
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150			$^\circ C$

### THERMAL CHARACTERISTICS (2)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	80	$^\circ C/W$

### ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ C$ unless otherwise noted) (2)

Characteristic	Symbol	1N5817	1N5818	1N5819	Unit
Maximum Instantaneous Forward Voltage (1) ( $i_F = 0.1 A$ ) ( $i_F = 1.0 A$ ) ( $i_F = 3.0 A$ )	$v_F$	0.32 0.45 0.75	0.33 0.55 0.875	0.34 0.6 0.9	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) ( $T_L = 25^\circ C$ ) ( $T_L = 100^\circ C$ )	$I_R$	1.0 10	1.0 10	1.0 10	mA

(1) Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle = 2.0%.

(2) Lead Temperature reference is cathode lead 1/32" from case.

Rev 3

# 1N5817, 1N5818, 1N5819

## NOTE 1 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above  $0.1 V_{RWM}$ . Proper derating may be accomplished by use of equation (1).

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where  $T_{A(max)}$  = Maximum allowable ambient temperature  
 $T_{J(max)}$  = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest)  
 $P_{F(AV)}$  = Average forward power dissipation  
 $P_{R(AV)}$  = Average reverse power dissipation  
 $R_{\theta JA}$  = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2).

$$T_R = T_{J(max)} - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^\circ\text{C}$ , when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the slope in the vicinity of  $115^\circ\text{C}$ . The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, that is:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The factor  $F$  is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find  $T_{A(max)}$  for 1N5818 operated in a 12-volt dc supply using a bridge circuit with capacitive filters such that  $I_{DC} = 0.4 \text{ A}$  ( $I_{F(AV)} = 0.5 \text{ A}$ ),  $I_{(FM)}/I_{(AV)} = 10$ , Input Voltage =  $10 V_{(rms)}$ ,  $R_{\theta JA} = 80^\circ\text{C/W}$ .

Step 1. Find  $V_{R(equiv)}$ . Read  $F = 0.65$  from Table 1.  
 $\therefore V_{R(equiv)} = (1.41)(10)(0.65) = 9.2 \text{ V}$ .

Step 2. Find  $T_R$  from Figure 2. Read  $T_R = 109^\circ\text{C}$   
 @  $V_R = 9.2 \text{ V}$  and  $R_{\theta JA} = 80^\circ\text{C/W}$ .

Step 3. Find  $P_{F(AV)}$  from Figure 4. \*\*Read  $P_{F(AV)} = 0.5 \text{ W}$

$$\text{@ } \frac{I_{(FM)}}{I_{(AV)}} = 10 \text{ and } I_{F(AV)} = 0.5 \text{ A.}$$

Step 4. Find  $T_{A(max)}$  from equation (3).  
 $T_{A(max)} = 109 - (80)(0.5) = 69^\circ\text{C}$ .

\*\*Values given are for the 1N5818. Power is slightly lower for the 1N5817 because of its lower forward voltage, and higher for the 1N5819.

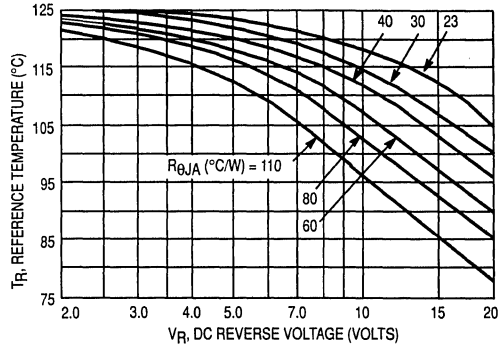


Figure 1. Maximum Reference Temperature 1N5817

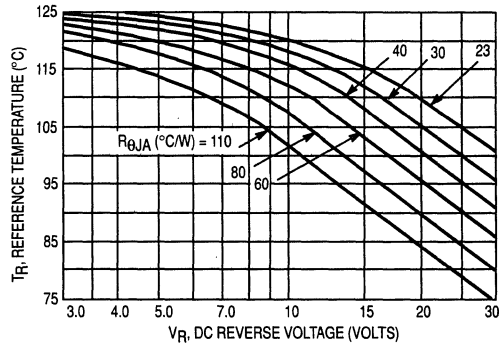


Figure 2. Maximum Reference Temperature 1N5818

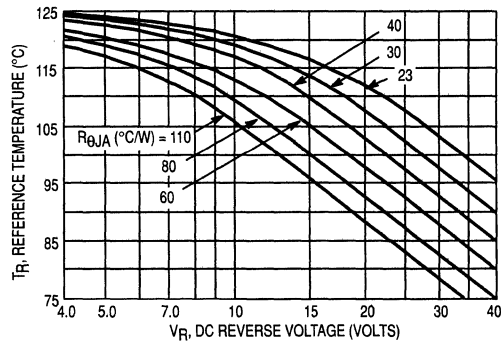


Figure 3. Maximum Reference Temperature 1N5819

Table 1. Values for Factor F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped* †	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

\*Note that  $V_{R(PK)} = 2.0 V_{in(PK)}$ .

† Use line to center tap voltage for  $V_{in}$ .

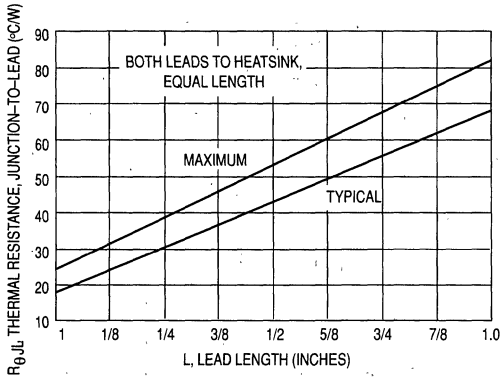


Figure 4. Steady-State Thermal Resistance

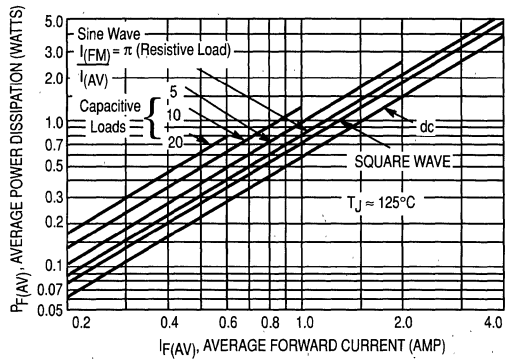


Figure 5. Forward Power Dissipation 1N5817-19

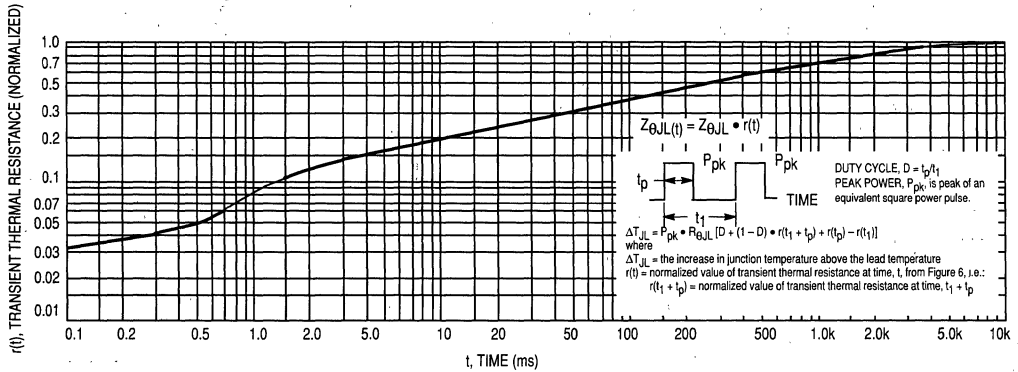


Figure 6. Thermal Response

**NOTE 2 — MOUNTING DATA**

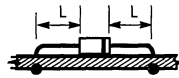
Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

**TYPICAL VALUES FOR  $R_{\theta JA}$  IN STILL AIR**

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	52	65	72	85	°C/W
2	67	80	87	100	°C/W
3	50				°C/W

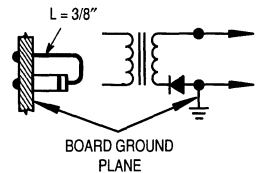
**Mounting Method 1**

P.C. Board with 1-1/2" x 1-1/2" copper surface.

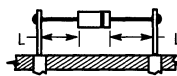


**Mounting Method 3**

P.C. Board with 1-1/2" x 1-1/2" copper surface.



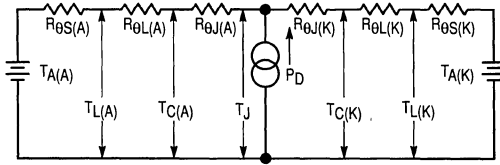
**Mounting Method 2**



VECTOR PIN MOUNTING

# 1N5817, 1N5818, 1N5819

## NOTE 3 — THERMAL CIRCUIT MODEL (For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heatsink. Terms in the model signify:

$T_A$  = Ambient Temperature     $T_C$  = Case Temperature  
 $T_L$  = Lead Temperature     $T_J$  = Junction Temperature  
 $R_{\theta S}$  = Thermal Resistance, Heatsink to Ambient  
 $R_{\theta L}$  = Thermal Resistance, Lead to Heatsink  
 $R_{\theta J}$  = Thermal Resistance, Junction to Case  
 $P_D$  = Power Dissipation

(Subscripts A and K refer to anode and cathode sides, respectively.)  
 Values for thermal resistance components are:  
 $R_{\theta L} = 100^\circ\text{C/W/in}$  typically and  $120^\circ\text{C/W/in}$  maximum  
 $R_{\theta J} = 36^\circ\text{C/W}$  typically and  $46^\circ\text{C/W}$  maximum.

3

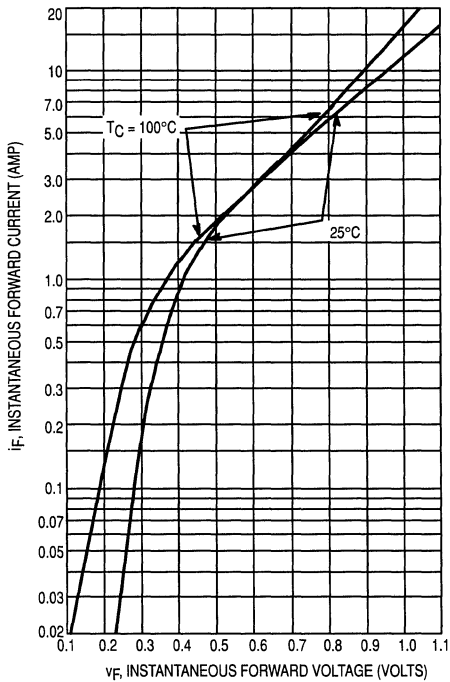


Figure 7. Typical Forward Voltage

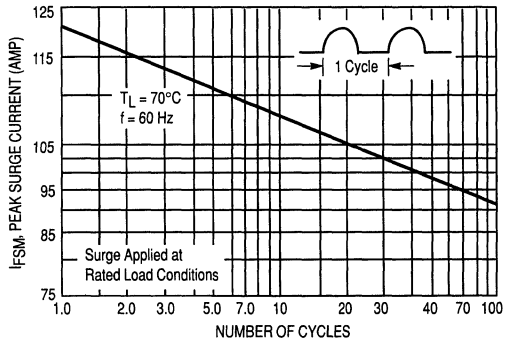


Figure 8. Maximum Non-Repetitive Surge Current

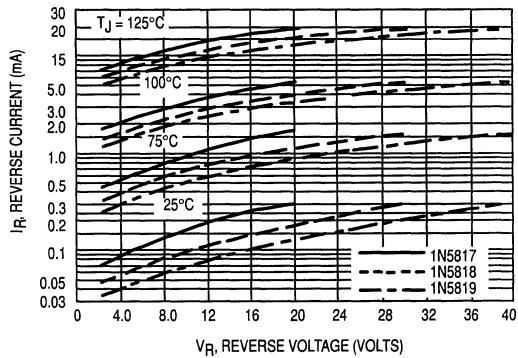


Figure 9. Typical Reverse Current



# 1N5817, 1N5818, 1N5819

## NOTE 4 — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

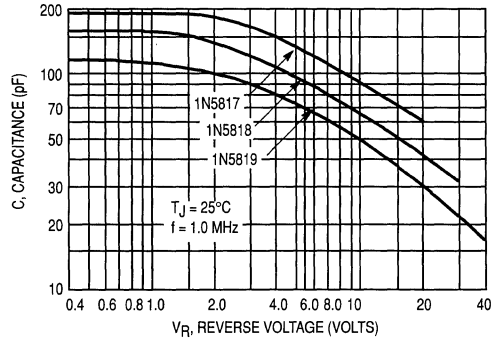


Figure 10. Typical Capacitance

## Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction

### Mechanical Characteristics:

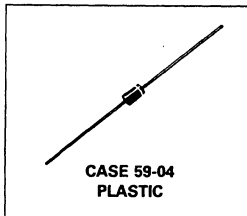
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: B150, B160

**MBR150**  
**MBR160**

MBR160 is a  
 Motorola Preferred Device

**SCHOTTKY BARRIER  
 RECTIFIERS  
 1 AMPERE  
 50, 60 VOLTS**

**3**



### MAXIMUM RATINGS

Rating	Symbol	MBR150	MBR160	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50	60	Volts
RMS Reverse Voltage	$V_R(RMS)$	35	42	Volts
Average Rectified Forward Current (2) ( $V_R(\text{equiv}) \leq 0.2 V_R(\text{dc})$ , $T_L = 90^\circ\text{C}$ , $R_{\theta JA} = 80^\circ\text{C/W}$ , P.C. Board Mounting, see Note 3, $T_A = 55^\circ\text{C}$ )	$I_O$	1		Amp
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half-wave, single phase, 60 Hz, $T_L = 70^\circ\text{C}$ )	$I_{FSM}$	25 (for one cycle)		Amps
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	$T_J, T_{stg}$	-65 to +150		°C
Peak Operating Junction Temperature (Forward Current applied)	$T_{J(pk)}$	150		°C

### THERMAL CHARACTERISTICS (Notes 3 and 4)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	80	°C/W

### ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ\text{C}$ unless otherwise noted) (2)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (1) ( $i_F = 0.1 \text{ A}$ ) ( $i_F = 1 \text{ A}$ ) ( $i_F = 3 \text{ A}$ )	$V_F$	0.550 0.750 1.000	Volt
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) ( $T_L = 25^\circ\text{C}$ ) ( $T_L = 100^\circ\text{C}$ )	$i_R$	0.5 5	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .  
 (2) Lead Temperature reference is cathode lead 1/32" from case.

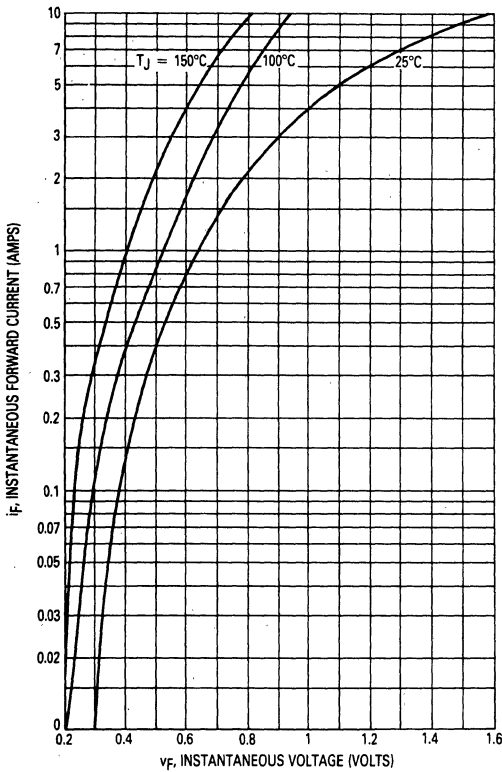


Figure 1. Typical Forward Voltage

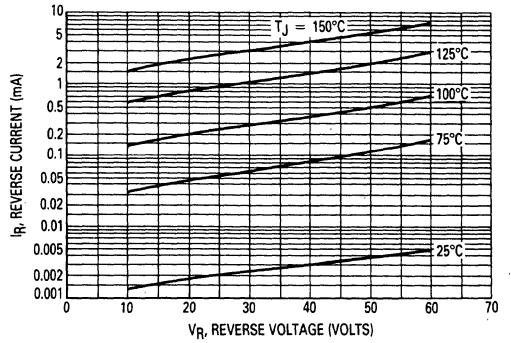


Figure 2. Typical Reverse Current\*

\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently below rated  $V_R$ .

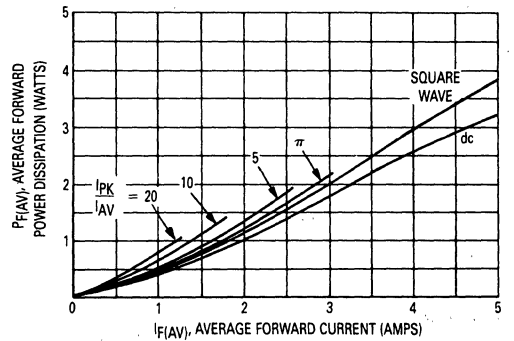


Figure 3. Forward Power Dissipation

THERMAL CHARACTERISTICS

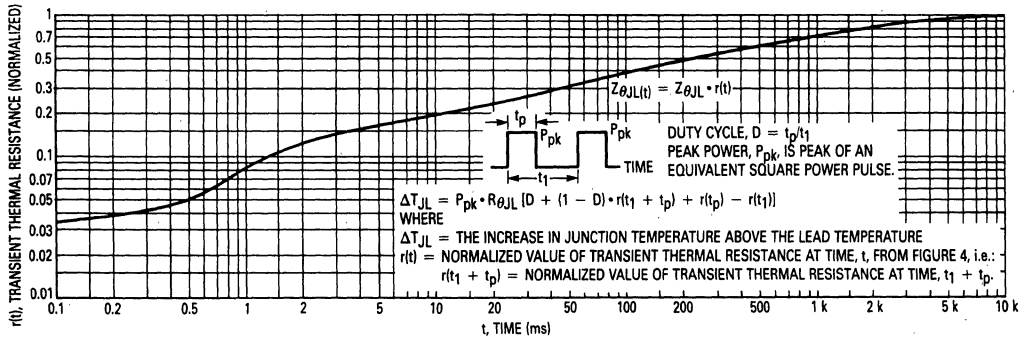


Figure 4. Thermal Response

# MBR150, MBR160

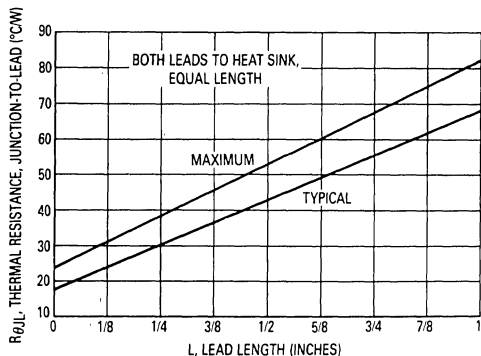


Figure 5. Steady-State Thermal Resistance

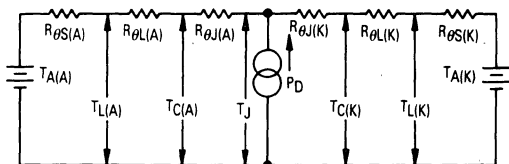
### NOTE 3 — MOUNTING DATA:

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mounting shown is to be used as a typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

Typical Values for  $R_{\theta JA}$  in Still Air

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	52	65	72	85	$^{\circ}\text{C}/\text{W}$
2	67	80	87	100	$^{\circ}\text{C}/\text{W}$
3			50		$^{\circ}\text{C}/\text{W}$

### NOTE 4 — THERMAL CIRCUIT MODEL: (For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

- $T_A$  = Ambient Temperature
- $T_L$  = Lead Temperature
- $R_{\theta S}$  = Thermal Resistance, Heat Sink to Ambient
- $R_{\theta L}$  = Thermal Resistance, Lead to Heat Sink
- $R_{\theta J}$  = Thermal Resistance, Junction to Case
- $P_D$  = Power Dissipation
- $T_C$  = Case Temperature
- $T_J$  = Junction Temperature

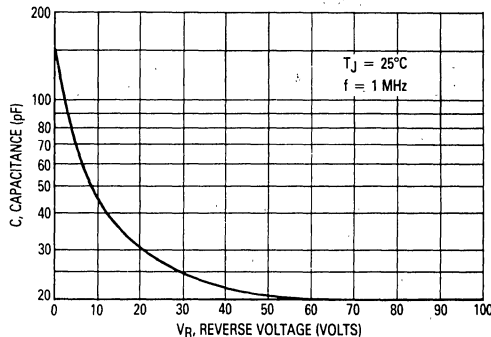
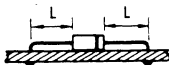
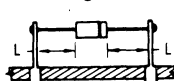


Figure 6. Typical Capacitance

**Mounting Method 1**  
P.C. Board with 1-1/2" x 1-1/2" copper surface.

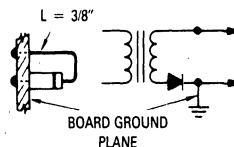


**Mounting Method 2**



VECTOR PIN MOUNTING

**Mounting Method 3**  
P.C. Board with 1-1/2" x 1-1/2" copper surface.



(Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are:  $R_{\theta L} = 100^{\circ}\text{C}/\text{W}/\text{in}$  typically and  $120^{\circ}\text{C}/\text{W}/\text{in}$  maximum.  $R_{\theta J} = 36^{\circ}\text{C}/\text{W}$  typically and  $46^{\circ}\text{C}/\text{W}$  maximum.

### NOTE 5 — HIGH FREQUENCY OPERATION:

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 6.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

## Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- High Surge Capacity

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: B170, B180, B190, B1100

### MAXIMUM RATINGS

Rating	Symbol	MBR170	MBR180	MBR190	MBR1100	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	70	80	90	100	Volts
Average Rectified Forward Current ( $V_{R(equiv)} \leq 0.2 V_R(dc)$ , $R_{\theta JA} = 50^\circ C/W$ , P.C. Board Mounting, see Note 1, $T_A = 120^\circ C$ )	$I_O$	1				Amp
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half-wave, single phase, 60 Hz)	$I_{FSM}$	50				Amps
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +150				°C
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10				V/ns

### THERMAL CHARACTERISTICS (See Note 2)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 1	°C/W

### ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ C$ unless otherwise noted)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage* ( $i_F = 1 A$ , $T_L = 25^\circ C$ ) ( $i_F = 1 A$ , $T_L = 100^\circ C$ )	$V_F$	0.79 0.69	Volt
Maximum Instantaneous Reverse Current @ Rated dc Voltage* ( $T_L = 25^\circ C$ ) ( $T_L = 100^\circ C$ )	$i_R$	0.5 5	mA

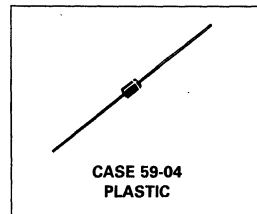
\*Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle  $\leq 2.0\%$ .

Rev 1

**MBR170**  
**MBR180**  
**MBR190**  
**MBR1100**

MBR1100 is a  
 Motorola Preferred Device

**SCHOTTKY BARRIER**  
**RECTIFIERS**  
**1 AMPERE**  
**70, 80, 90, 100 VOLTS**



# MBR170, MBR180, MBR190, MBR1100

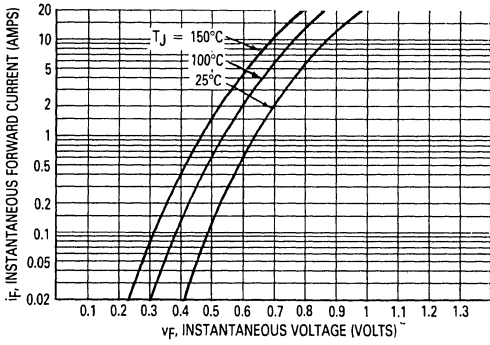


Figure 1. Typical Forward Voltage

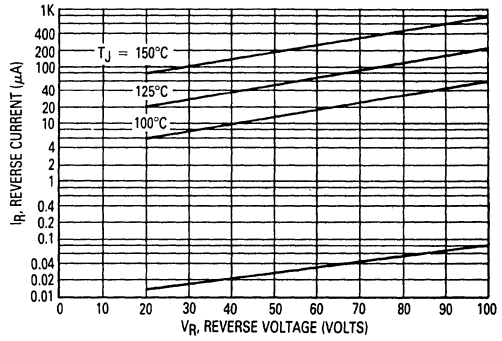


Figure 2. Typical Reverse Current\*

\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently below rated  $V_R$ .

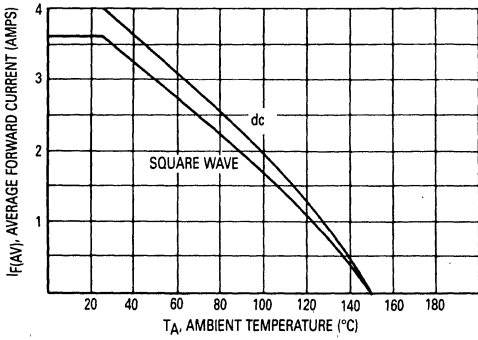


Figure 3. Current Derating  
(Mounting method 3 per note 1.)

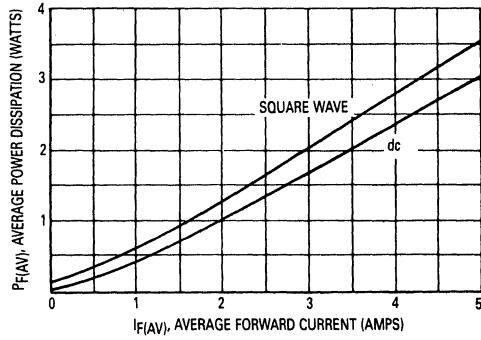


Figure 4. Power Dissipation

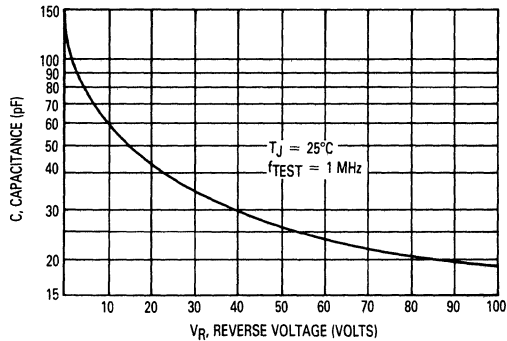


Figure 5. Typical Capacitance

# MBR170, MBR180, MBR190, MBR1100

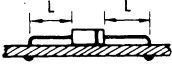
## NOTE 1 — MOUNTING DATA:

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

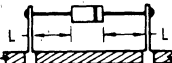
Typical Values for  $R_{\theta JA}$  in Still Air

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	52	65	72	85	$^{\circ}\text{C}/\text{W}$
2	67	80	87	100	$^{\circ}\text{C}/\text{W}$
3			50		$^{\circ}\text{C}/\text{W}$

**Mounting Method 1**  
P.C. Board with  
1-1/2" x 1-1/2"  
copper surface.

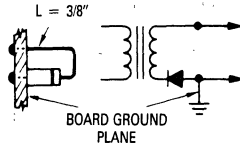


**Mounting Method 2**



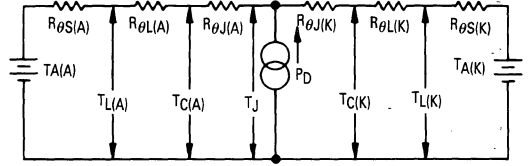
VECTOR PIN MOUNTING

**Mounting Method 3**  
P.C. Board with  
1-1/2" x 1-1/2"  
copper surface.



## NOTE 2 — THERMAL CIRCUIT MODEL:

(For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

$T_A$  = Ambient Temperature     $T_C$  = Case Temperature  
 $T_L$  = Lead Temperature         $T_J$  = Junction Temperature  
 $R_{\theta S}$  = Thermal Resistance, Heat Sink to Ambient  
 $R_{\theta L}$  = Thermal Resistance, Lead to Heat Sink  
 $R_{\theta J}$  = Thermal Resistance, Junction to Case  
 $P_D$  = Power Dissipation

(Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are:  
 $R_{\theta L}$  = 100 $^{\circ}\text{C}/\text{W}$ /in typically and 120 $^{\circ}\text{C}/\text{W}$ /in maximum.  
 $R_{\theta J}$  = 36 $^{\circ}\text{C}/\text{W}$  typically and 46 $^{\circ}\text{C}/\text{W}$  maximum.

## NOTE 3 — HIGH FREQUENCY OPERATION:

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 5.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

**1N5820**  
**1N5821**  
**1N5822**

1N5820 and 1N5822 are  
 Motorola Preferred Devices

*Designer's Data Sheet*

**Axial Lead Rectifiers**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low  $v_f$
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority Carrier Conduction

**Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N5820, 1N5821, 1N5822

**SCHOTTKY BARRIER  
 RECTIFIERS**

**3.0 AMPERES**  
**20, 30, 40 VOLTS**

**3**



Rating	Symbol	1N5820	1N5821	1N5822	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	30	40	V
Non-Repetitive Peak Reverse Voltage	$V_{RSM}$	24	36	48	V
RMS Reverse Voltage	$V_R(RMS)$	14	21	28	V
Average Rectified Forward Current (2) $V_R(\text{equiv}) \leq 0.2 V_R(\text{dc}), T_L = 95^\circ\text{C}$ ( $R_{\theta JA} = 28^\circ\text{C/W}$ , P.C. Board Mounting, see Note 2)	$I_O$	← 3.0 →			A
Ambient Temperature Rated $V_R(\text{dc})$ , $P_F(AV) = 0$ $R_{\theta JA} = 28^\circ\text{C/W}$	$T_A$	90	85	80	°C
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase 60 Hz, $T_L = 75^\circ\text{C}$ )	$I_{FSM}$	← 80 (for one cycle) →			A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	$T_J, T_{stg}$	← -65 to +125 →			°C
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	← 150 →			°C

**\*THERMAL CHARACTERISTICS (Note 2)**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	28	°C/W

**\*ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ\text{C}$  unless otherwise noted) (2)**

Characteristic	Symbol	1N5820	1N5821	1N5822	Unit
Maximum Instantaneous Forward Voltage (1) ( $i_F = 1.0$ Amp) ( $i_F = 3.0$ Amp) ( $i_F = 9.4$ Amp)	$v_f$	0.370 0.475 0.850	0.380 0.500 0.900	0.390 0.525 0.950	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) $T_L = 25^\circ\text{C}$ $T_L = 100^\circ\text{C}$	$i_R$	2.0 20	2.0 20	2.0 20	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%.

(2) Lead Temperature reference is cathode lead 1/32" from case.

\*Indicates JEDEC Registered Data for 1N5820-22.



**NOTE 1 – DETERMINING MAXIMUM RATINGS**

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1  $V_{RWM}$ . Proper derating may be accomplished by use of equation (1).

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_F(AV) - R_{\theta JA} P_R(AV) \quad (1)$$

where  $T_{A(max)}$  = Maximum allowable ambient temperature  
 $T_{J(max)}$  = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest)

$P_F(AV)$  = Average forward power dissipation  
 $P_R(AV)$  = Average reverse power dissipation  
 $R_{\theta JA}$  = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2).

$$T_R = T_{J(max)} - R_{\theta JA} P_R(AV) \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_F(AV) \quad (3)$$

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^\circ\text{C}$ , when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the

slope in the vicinity of 115°C. The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, that is:

$$V_R(\text{equiv}) = V(\text{FM}) \times F \quad (4)$$

The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find  $T_{A(max)}$  for 1N5821 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that  $I_{DC} = 2.0 \text{ A}$  ( $I_F(AV) = 1.0 \text{ A}$ ),  $I(FM)/I(AV) = 10$ , Input Voltage = 10 V (rms),  $R_{\theta JA} = 40^\circ\text{C/W}$ .

- Step 1. Find  $V_R(\text{equiv})$ . Read  $F = 0.65$  from Table 1,  $\therefore V_R(\text{equiv}) = (1.41)(10)(0.65) = 9.2 \text{ V}$ .
- Step 2. Find  $T_R$  from Figure 2. Read  $T_R = 108^\circ\text{C}$  @  $V_R = 9.2 \text{ V}$  and  $R_{\theta JA} = 40^\circ\text{C/W}$ .
- Step 3. Find  $P_F(AV)$  from Figure 6. \*\*Read  $P_F(AV) = 0.85 \text{ W}$  @  $I(FM) = 10$  and  $I_F(AV) = 1.0 \text{ A}$ .
- Step 4. Find  $T_{A(max)}$  from equation (3).  $T_{A(max)} = 108 - (0.85)(40) = 74^\circ\text{C}$ .

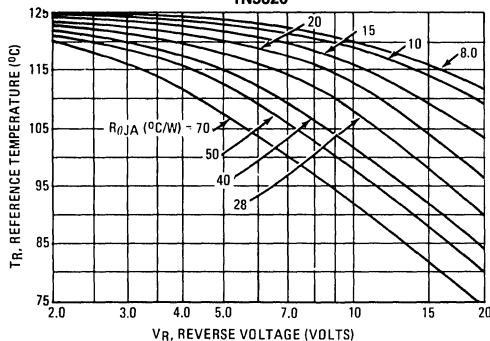
\*\*Values given are for the 1N5821. Power is slightly lower for the 1N5820 because of its lower forward voltage, and higher for the 1N5822. Variations will be similar for the MBR-prefix devices, using  $P_F(AV)$  from Figure 7.

**TABLE 1 – VALUES FOR FACTOR F**

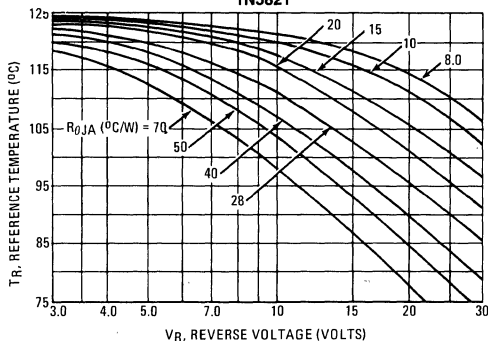
Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped*†	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

\*Note that  $V_R(PK) \approx 2.0 V_{in}(PK)$ . †Use line to center tap voltage for  $V_{in}$ .

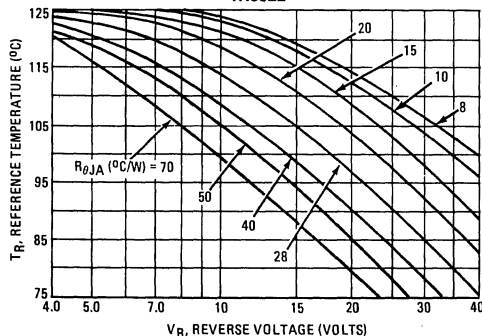
**FIGURE 1 — MAXIMUM REFERENCE TEMPERATURE 1N5820**



**FIGURE 2 — MAXIMUM REFERENCE TEMPERATURE 1N5821**



**FIGURE 3 — MAXIMUM REFERENCE TEMPERATURE 1N5822**



**FIGURE 4 — STEADY-STATE THERMAL RESISTANCE**

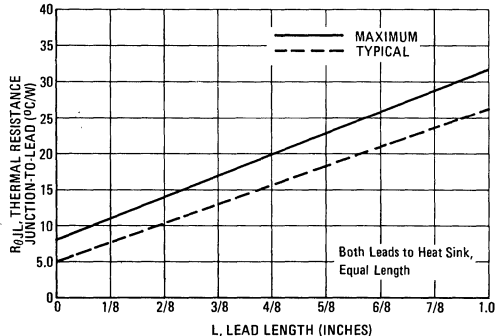


FIGURE 5 – THERMAL RESPONSE

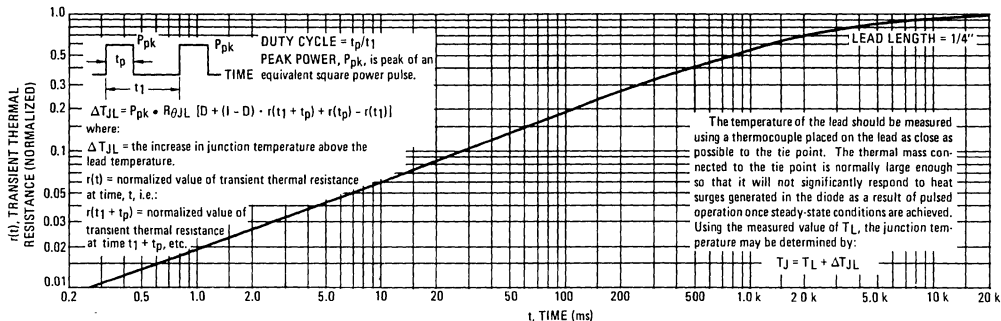
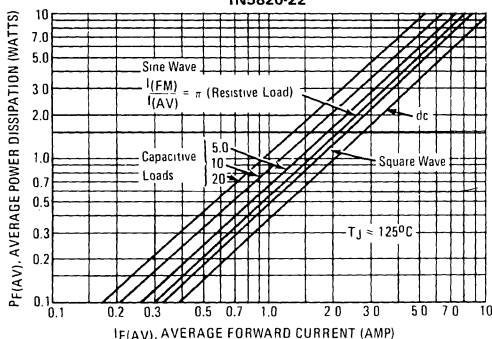


FIGURE 6 – FORWARD POWER DISSIPATION 1N5820-22



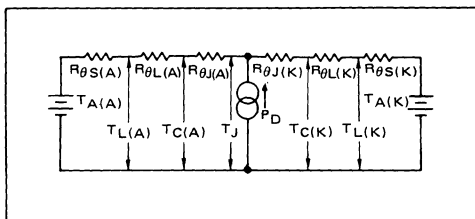
NOTE 2 – MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR  $R_{\theta JA}$  IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	50	51	52	55	$^{\circ}\text{C}/\text{W}$
2	58	59	61	63	$^{\circ}\text{C}/\text{W}$
3	28				$^{\circ}\text{C}/\text{W}$

NOTE 3 – APPROXIMATE THERMAL CIRCUIT MODEL



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

- $T_A$  = Ambient Temperature
  - $T_C$  = Case Temperature
  - $T_L$  = Lead Temperature
  - $T_J$  = Junction Temperature
  - $R_{\theta S}$  = Thermal Resistance, Heat Sink to Ambient
  - $R_{\theta L}$  = Thermal Resistance, Lead to Heat Sink
  - $R_{\theta J}$  = Thermal Resistance, Junction to Case
  - $P_D$  = Total Power Dissipation =  $P_F + P_R$
  - $P_F$  = Forward Power Dissipation
  - $P_R$  = Reverse Power Dissipation
- (Subscripts (A) and (K) refer to anode and cathode sides, respectively.) Values for thermal resistance components are:
- $R_{\theta L} = 42^{\circ}\text{C}/\text{W}/\text{in}$  typically and  $48^{\circ}\text{C}/\text{W}/\text{in}$  maximum
  - $R_{\theta J} = 10^{\circ}\text{C}/\text{W}$  typically and  $16^{\circ}\text{C}/\text{W}$  maximum

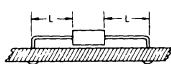
The maximum lead temperature may be found as follows:

$$T_L = T_{J(\text{max})} - \Delta T_{JL}$$

where  $\Delta T_{JL} \approx R_{\theta JL} \cdot P_D$

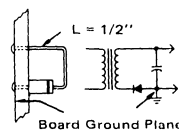
**Mounting Method 1**

P.C. Board where available copper surface is small.



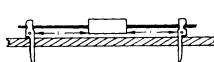
**Mounting Method 3**

P.C. Board with with 2-1/2" X 2-1/2" copper surface.



**Mounting Method 2**

Vector Push-In Terminals T-28



3

FIGURE 8 – TYPICAL FORWARD VOLTAGE

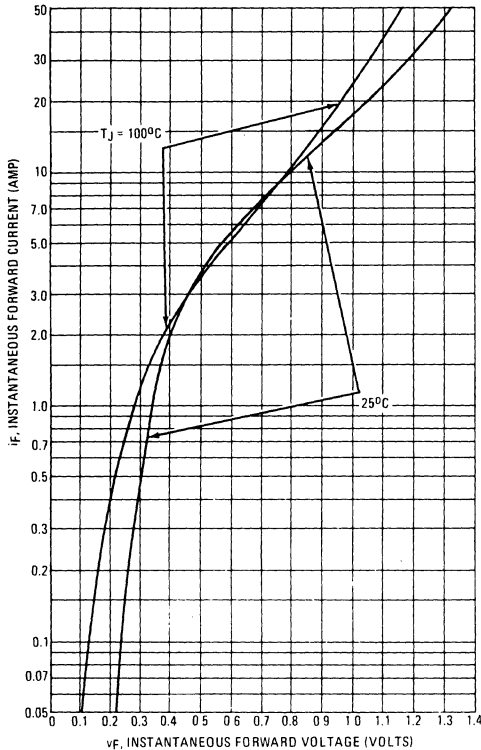


FIGURE 9 – MAXIMUM NON-REPETITIVE SURGE CURRENT

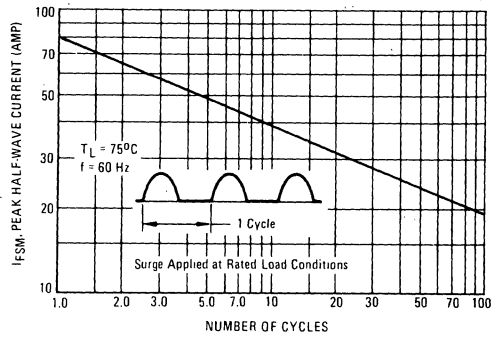


FIGURE 10 – TYPICAL REVERSE CURRENT

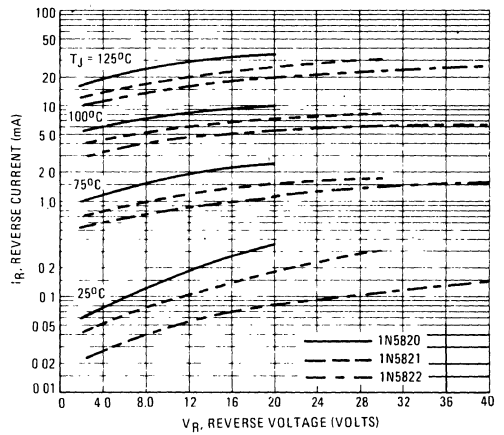
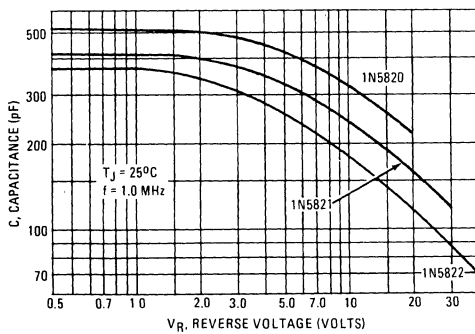


FIGURE 11 – TYPICAL CAPACITANCE



NOTE 4 – HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)

MBR340 and MBR360 are  
 Motorola Preferred Devices

## Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

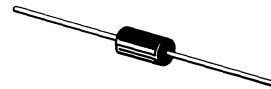
- Extremely Low  $v_f$
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Low Stored Charge, Majority Carrier Conduction

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: B320, B330, B340, B350, B360

### SCHOTTKY BARRIER RECTIFIERS

**3.0 AMPERES**  
**20, 30, 40, 50, 60 VOLTS**



**CASE 267-03**  
**PLASTIC**

### MAXIMUM RATINGS

Rating	Symbol	MBR320	MBR330	MBR340	MBR350	MBR360	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	30	40	50	60	V
Average Rectified Forward Current $T_A = 65^\circ\text{C}$ ( $R_{\theta JA} = 28^\circ\text{C/W}$ , P.C. Board Mounting, see Note 3)	$I_O$	3.0					A
Nonrepetitive Peak Surge Current (2) (Surge applied at rated load conditions, half wave, single phase 60 Hz, $T_L = 75^\circ\text{C}$ )	$I_{FSM}$	80					A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	$T_J, T_{stg}$	-65 to 150°C					°C
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	150					°C

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient, (see Note 3, Mounting Method 3)	$R_{\theta JA}$	28	°C/W

### ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ\text{C}$ unless otherwise noted ) (2)

Characteristic	Symbol	MBR320	MBR330	MBR340	MBR350	MBR360	Unit
Maximum Instantaneous Forward Voltage (1) ( $i_F = 1.0$ Amp) ( $i_F = 3.0$ Amp) ( $i_F = 9.4$ Amp)	$v_F$		0.500 0.600 0.850		0.600 0.740 1.080		V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1) $T_L = 25^\circ\text{C}$ $T_L = 100^\circ\text{C}$	$i_R$			0.60 20			mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%.

(2) Lead Temperature reference is cathode lead 1/32" from case.

MBR320, 330 AND 340

FIGURE 1 — TYPICAL FORWARD VOLTAGE

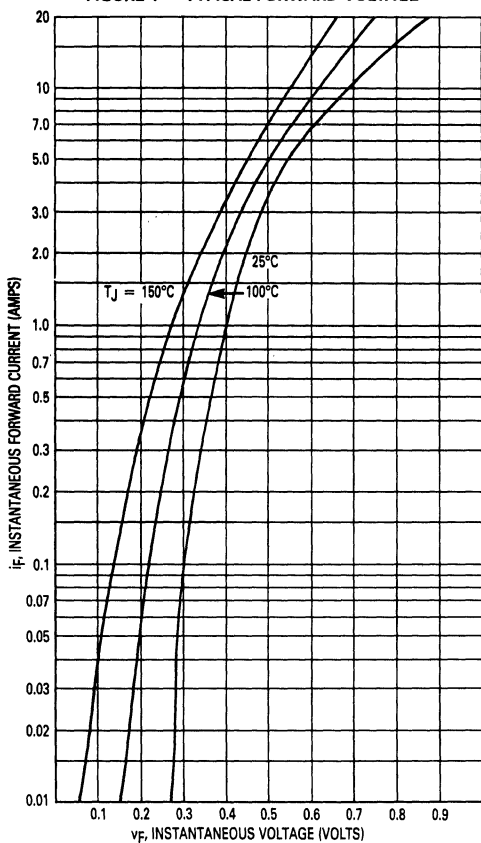
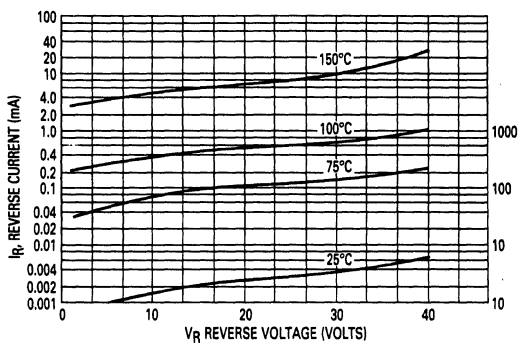


FIGURE 2 — TYPICAL REVERSE CURRENT\*



\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently below rated  $V_R$ .

FIGURE 3 — CURRENT DERATING (MOUNTING METHOD #3 PER NOTE 3)

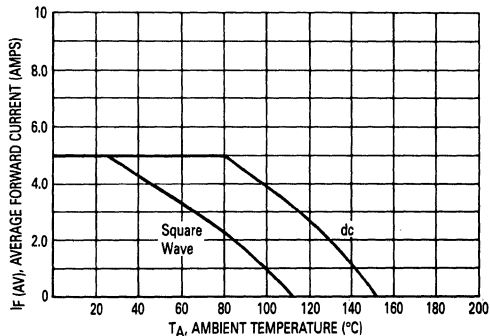


FIGURE 4 — POWER DISSIPATION

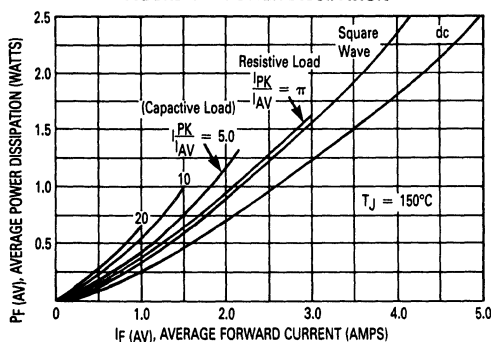
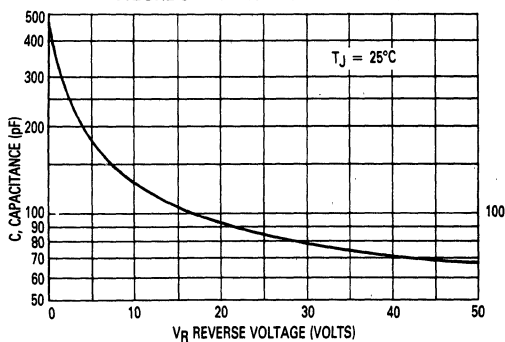


FIGURE 5 — TYPICAL CAPACITANCE



MBR350 AND 360

FIGURE 6 — TYPICAL FORWARD VOLTAGE

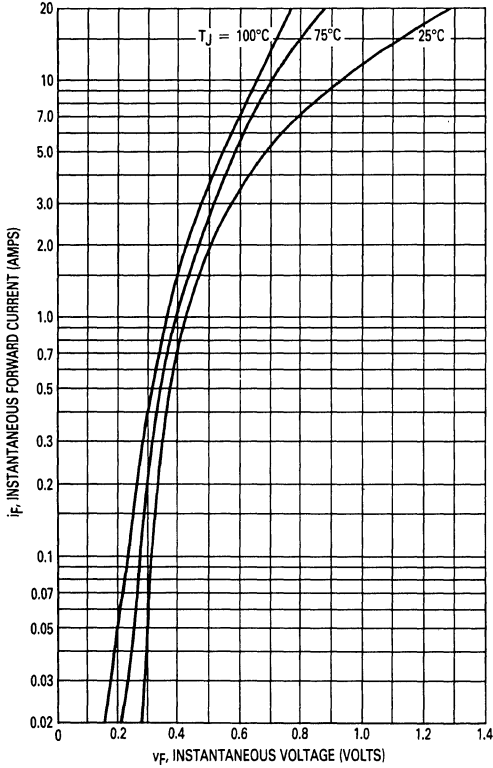


FIGURE 7 — TYPICAL REVERSE CURRENT\*

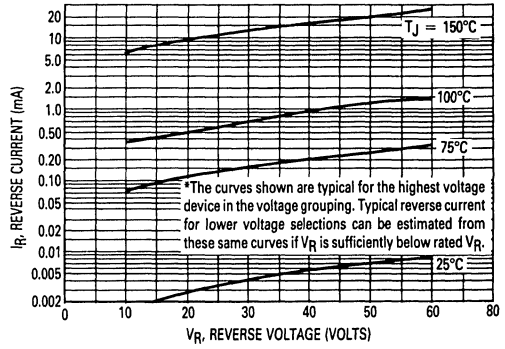


FIGURE 8 — CURRENT DERATING AMBIENT (MOUNTING METHOD #3 PER NOTE 3)

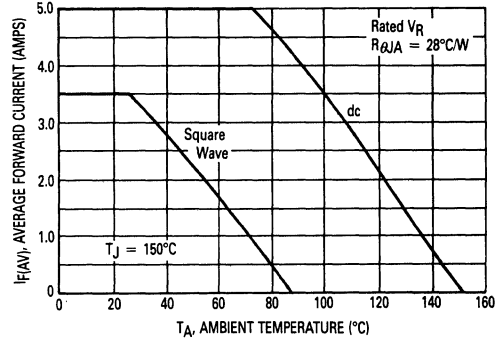


FIGURE 9 — POWER DISSIPATION

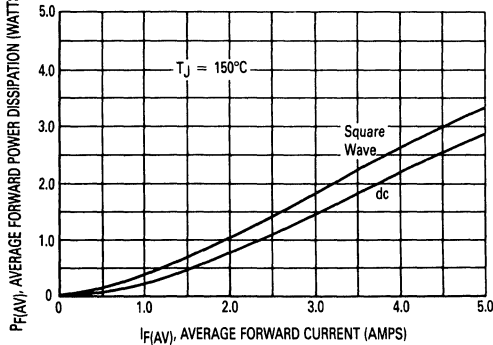
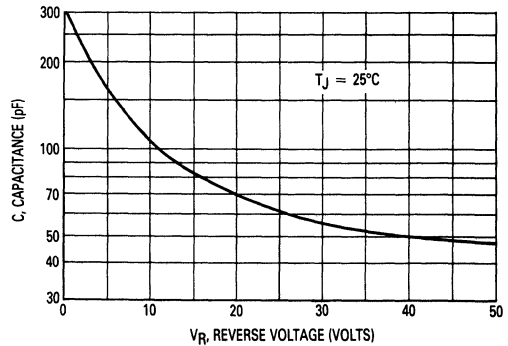


FIGURE 10 — TYPICAL CAPACITANCE



## NOTE 3 — MOUNTING DATA

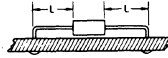
Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR  $R_{\theta JA}$  IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	50	51	53	55	$^{\circ}\text{C/W}$
2	58	59	61	63	$^{\circ}\text{C/W}$
3	28				$^{\circ}\text{C/W}$

### Mounting Method 1

P.C. Board where available copper surface is small.



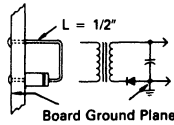
### Mounting Method 2

Vector Push-In  
Terminals T-28



### Mounting Method 3

P.C. Board with  
2-1/2" x 2-1/2"  
copper surface.



## Axial Lead Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- High Surge Capacity

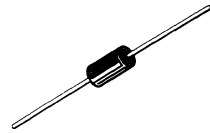
### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: B370, B380, B390, B3100

**MBR370**  
**MBR380**  
**MBR390**  
**MBR3100**

MBR3100 is a  
 Motorola Preferred Device

**SCHOTTKY BARRIER  
 RECTIFIERS**  
**3 AMPERES**  
**70, 80, 90, 100 VOLTS**



CASE 267-03  
 PLASTIC

3

### MAXIMUM RATINGS

Rating	Symbol	MBR370	MBR380	MBR390	MBR3100	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	70	80	90	100	V
Average Rectified Forward Current $T_A = 100^\circ\text{C}$ ( $R_{\theta JA} = 28^\circ\text{C/W}$ , P.C. Board Mounting, see Note 1)	$I_O$	3				A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half-wave, single phase, 60 Hz)	$I_{FSM}$	150				A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	$T_J, T_{stg}$	-65 to +150				$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10				V/ns

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (see Note 1, Mounting Method 3)	$R_{\theta JA}$	28	$^\circ\text{C/W}$

### ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage* ( $I_F = 3$ Amps, $T_L = 25^\circ\text{C}$ ) ( $I_F = 3$ Amps, $T_L = 100^\circ\text{C}$ )	$V_F$	0.79 0.69	V
Maximum Instantaneous Reverse Current ( $\alpha$ Rated dc Voltage*) ( $T_L = 25^\circ\text{C}$ ) ( $T_L = 100^\circ\text{C}$ )	$i_R$	0.6 20	mA

\*Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

Rev 1



# MBR370, MBR380, MBR390, MBR3100

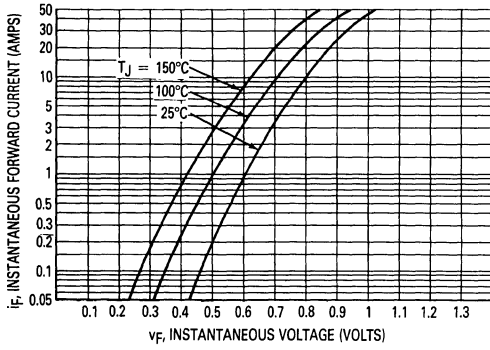


Figure 1. Typical Forward Voltage

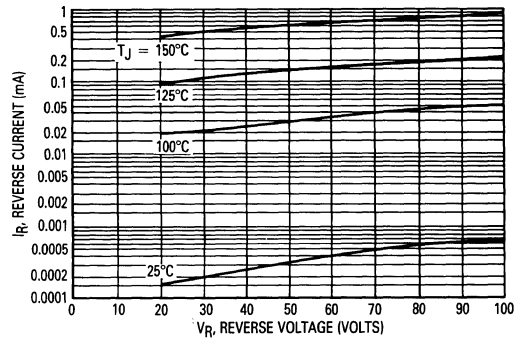


Figure 2. Typical Reverse Current\*

\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently below rated  $V_R$ .

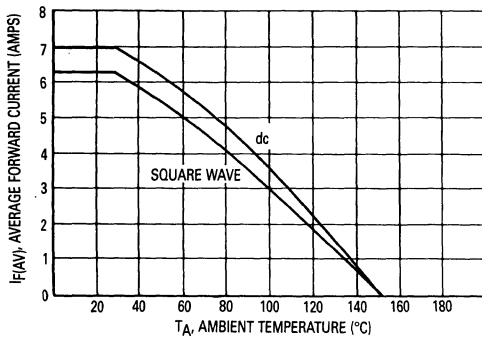


Figure 3. Current Derating  
(Mounting method 3 per note 1.)

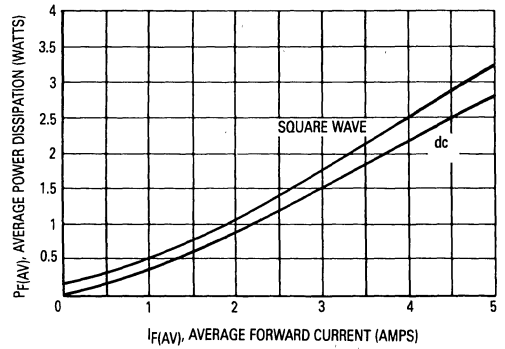


Figure 4. Power Dissipation

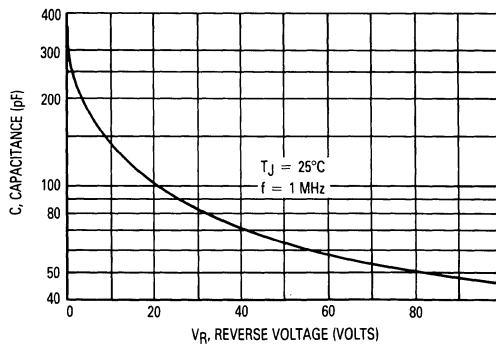


Figure 5. Typical Capacitance

# MBR370, MBR380, MBR390, MBR3100

## NOTE 1 — MOUNTING DATA:

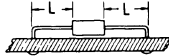
Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

Typical Values for  $R_{\theta JA}$  in Still Air

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	50	51	53	55	$^{\circ}\text{C/W}$
2	58	59	61	63	$^{\circ}\text{C/W}$
3			28		$^{\circ}\text{C/W}$

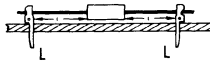
### Mounting Method 1

P.C. Board where available copper surface is small.



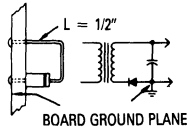
### Mounting Method 2

Vector Push-In  
Terminals T-28



### Mounting Method 3

P.C. Board with  
2-1/2" x 2-1/2" copper surface.



1N5823 and 1N5825 are  
 Motorola Preferred Devices

*Designer's Data Sheet*  
**Power Rectifiers**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

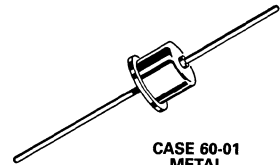
- Extremely Low  $V_F$
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority Carrier Conduction

**Mechanical Characteristics:**

- Case: Welded steel, hermetically sealed
- Weight: 2.4 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Polarity: Cathode to Case
- Shipped 50 units per tray
- Marking: 1N5823, 1N5824, 1N5825

**SCHOTTKY BARRIER  
 RECTIFIERS**

**5 AMPERE**  
**20, 30, 40 VOLTS**



**\*MAXIMUM RATINGS**

Rating	Symbol	1N5823	1N5824	1N5825	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	$V_{RSM}$	24	36	48	Volts
RMS Reverse Voltage	$V_{R(RMS)}$	14	21	28	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2 V_R (dc), T_C = 75^\circ C$ $V_{R(equiv)} \leq 0.2 V_R (dc), T_L = 80^\circ C$ $R_{\theta JA} = 25^\circ C/W, P.C. Board$ Mounting, See Note 3)	$I_O$	$\longleftrightarrow$ 15 $\longleftrightarrow$ $\longleftrightarrow$ 5.0 $\longleftrightarrow$			Amp
Ambient Temperature Rated $V_R (dc), P_F(AV) = 0$ $R_{\theta JA} = 25^\circ C/W$	$T_A$	65	60	55	$^\circ C$
Non-Repetitive <sup>1</sup> Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase 60 Hz)	$I_{FSM}$	$\longleftrightarrow$ 500 (for 1 cycle) $\longleftrightarrow$			Amp
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	$T_J, T_{stg}$	$\longleftrightarrow$ -65 to +125 $\longleftrightarrow$			$^\circ C$
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	$\longleftrightarrow$ 150 $\longleftrightarrow$			$^\circ C$

**\*THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	$^\circ C/W$

**\*ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ C$  unless otherwise noted)

Characteristic	Symbol	1N5823	1N5824	1N5825	Unit
Maximum Instantaneous Forward Voltage (1) ( $I_F = 3.0$ Amp) ( $I_F = 5.0$ Amp) ( $I_F = 15.7$ Amp)	$V_F$	0.330 0.360 0.470	0.340 0.370 0.490	0.350 0.380 0.520	Volts
Maximum Instantaneous Reverse Current @ rated dc Voltage $T_C = 25^\circ C$ $T_C = 100^\circ C$	$i_R$	10 100	10 125	10 150	mA

(1) Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle = 2.0% \*Indicates JEDEC Registered Data for 1N5823-1N5825

# 1N5823, 1N5824, 1N5825

## NOTE 1: DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above  $0.1 V_{RWM}$ . Proper derating may be accomplished by use of equation (1):

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where

$T_{A(max)}$  = Maximum allowable ambient temperature

$T_{J(max)}$  = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest).

$P_{F(AV)}$  = Average forward power dissipation

$P_{R(AV)}$  = Average reverse power dissipation

$R_{\theta JA}$  = Junction-to-ambient thermal resistance

Figures 1, 2 and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_{J(max)} - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^\circ\text{C}$ , when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2 and

3 as a difference in the rate of change of the slope in the vicinity of  $115^\circ\text{C}$ . The data of Figures 1, 2 and 3 is based upon dc conditions. For use in common rectifier circuits, Table I indicates suggested factors for an equivalent dc voltage to use for conservative design; i.e.:

$$V_R(\text{equiv}) = V_{in}(\text{PK}) \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

Example: Find  $T_{A(max)}$  for 1N5825 operated in a 12-Volt dc supply using a bridge circuit with capacitive filter such that  $I_{DC} = 10 \text{ A}$  ( $I_{F(AV)} = 5 \text{ A}$ ),  $I(\text{PK})/I(\text{AV}) = 10$ , Input Voltage =  $10 \text{ V(rms)}$ ,  $R_{\theta JA} = 10^\circ\text{C/W}$ .

Step 1: Find  $V_R(\text{equiv})$ . Read  $F = 0.65$  from Table I.

$$V_R(\text{equiv}) = (1.41)(10)(0.65) = 9.2 \text{ V}$$

Step 2: Find  $T_R$  from Figure 3. Read  $T_R = 113^\circ\text{C}$  @  $V_R = 9.2 \text{ V}$  &  $R_{\theta JA} = 10^\circ\text{C/W}$ .

Step 3: Find  $P_{F(AV)}$  from Figure 4. \*\*Read  $P_{F(AV)} = 5.5 \text{ W}$  @  $I(\text{PK}) = 10$  &  $I_{F(AV)} = 5 \text{ A}$

Step 4: Find  $T_{A(max)}$  from equation (3).  $T_{A(max)} = 113 - (10)(5.5) = 58^\circ\text{C}$ .

\*\* Value given are for the 1N5825. Power is slightly lower for the other units because of their lower forward voltage.

TABLE I - VALUES FOR FACTOR F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped *†	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

\* Note that  $V_R(\text{PK}) \approx 2 V_{in}(\text{PK})$

† Use line to center tap voltage for  $V_{in}$ .

FIGURE 1 - MAXIMUM REFERENCE TEMPERATURE - 1N5823

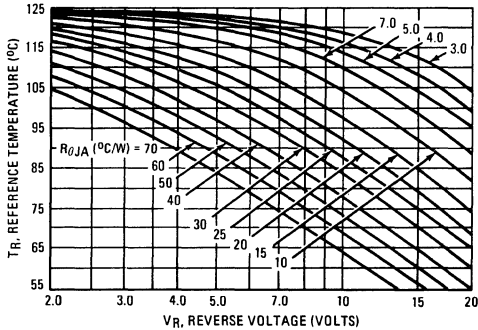


FIGURE 2 - MAXIMUM REFERENCE TEMPERATURE - 1N5824

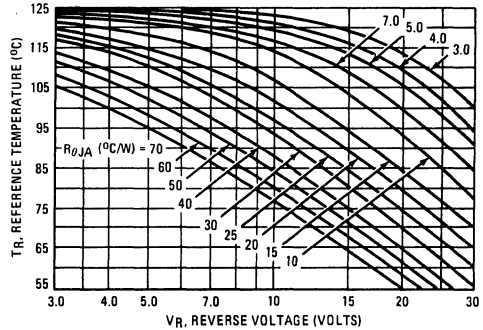


FIGURE 3 - MAXIMUM REFERENCE TEMPERATURE 1N5825 AND MBR5825H, H1

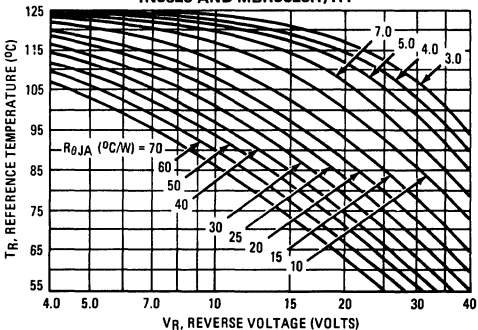
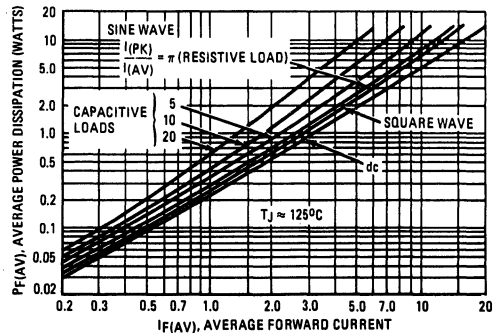


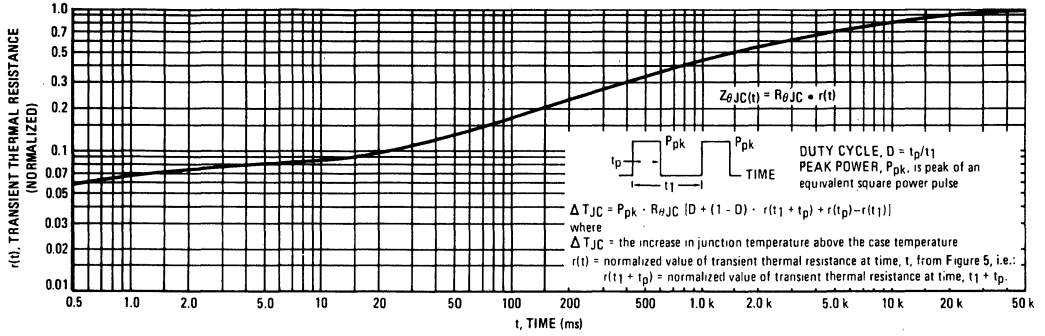
FIGURE 4 - FORWARD POWER DISSIPATION



3

THERMAL CHARACTERISTICS

FIGURE 5 – THERMAL RESPONSE



NOTE 2 – FINDING JUNCTION TEMPERATURE

DUTY CYCLE,  $D = t_p/t_1$   
 PEAK POWER,  $P_{pk}$ , is peak of an equivalent square power pulse

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:

The temperature of the case should be measured using a thermocouple placed on the case at the temperature reference point (see Note 3). The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady state conditions are achieved. Using the measured value of  $T_C$ , the junction temperature may be determined by

$$T_J = T_C + T_{JC}$$

where  $T_{JC}$  is the increase in junction temperature above the case temperature. It may be determined by

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D \cdot (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$$

where  
 $r(t)$  = normalized value of transient thermal resistance at time,  $t$ , from Figure 5  
 i.e.  
 $r(t_1 + t_p)$  = normalized value of transient thermal resistance at time  $t_1 + t_p$ .

NOTE 3 – MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering.

**TYPICAL VALUES FOR  $R_{\theta JA}$  IN STILL AIR**

MOUNTING METHOD	LEAD LENGTH, L (IN)		$R_{\theta JA}$
	1/4	1	
1	55	60	$^{\circ}\text{C}/\text{W}$
2	65	70	$^{\circ}\text{C}/\text{W}$
3	25		$^{\circ}\text{C}/\text{W}$

**MOUNTING METHOD 1**

**MOUNTING METHOD 2**

**MOUNTING METHOD 3**  
 P. C. Board with  $2\ 1/2'' \times 2\ 1/2''$  copper surface

FIGURE 6 – APPROXIMATE THERMAL CIRCUIT MODEL

Use of the above model permits calculation of average junction temperature for any mounting situation. Lowest values of thermal resistance will occur when the cathode lead is brought as close as possible to a heat dissipator; as heat conduction through the anode lead is small. Terms in the model are defined as follows:

**\*Case temperature reference is at cathode end.**

**TEMPERATURES**  
 $T_A$  = Ambient  
 $T_{AA}$  = Anode Heat Sink Ambient  
 $T_{AK}$  = Cathode Heat Sink Ambient  
 $T_{LA}$  = Anode Lead  
 $T_{LK}$  = Cathode Lead  
 $T_J$  = Junction

**THERMAL RESISTANCES**  
 $R_{\theta CA}$  = Case to Ambient  
 $R_{\theta SA}$  = Anode Lead Heat Sink to Ambient  
 $R_{\theta SK}$  = Cathode Lead Heat Sink to Ambient  
 $R_{\theta LA}$  = Anode Lead  
 $R_{\theta LK}$  = Cathode Lead  
 $R_{\theta CL}$  = Case to Cathode Lead  
 $R_{\theta LK}$  =  $40^{\circ}\text{C}/\text{W}/\text{IN}$   
 $R_{\theta SK}$   
 $R_{\theta JC}$  = Junction to Case  
 $R_{\theta JA}$  = Junction to Ambient (S bend)

# 1N5823, 1N5824, 1N5825

FIGURE 7 – TYPICAL FORWARD VOLTAGE

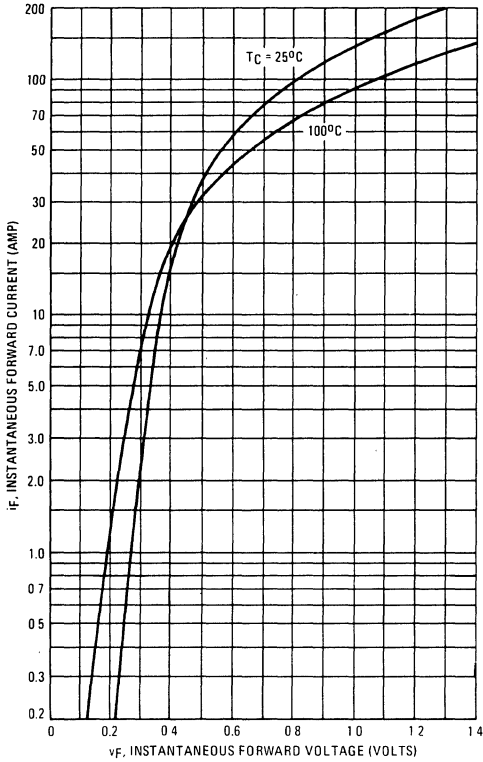


FIGURE 8 – MAXIMUM SURGE CAPABILITY

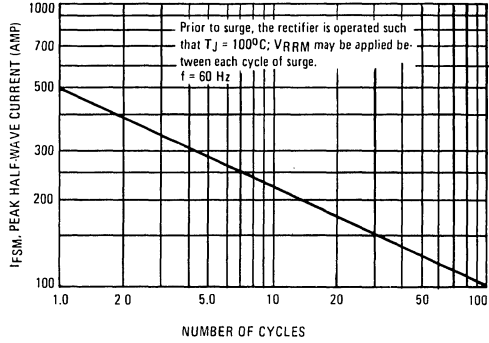


FIGURE 9 – TYPICAL REVERSE CURRENT

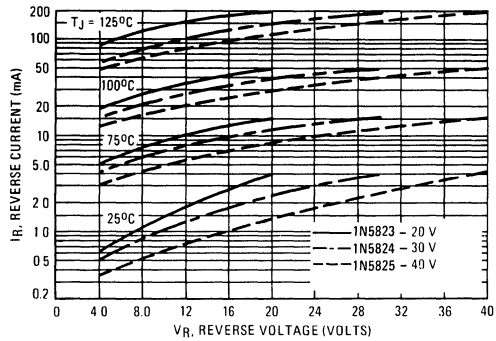
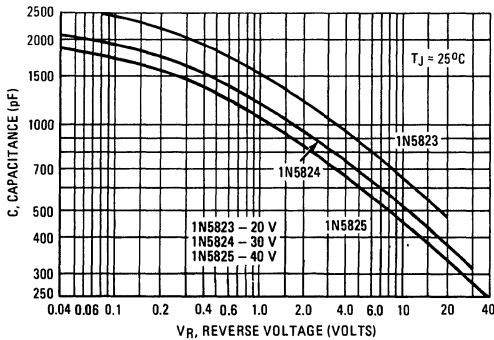


FIGURE 10 – CAPACITANCE



## NOTE 4 – HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10).

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

MBR1545CT is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

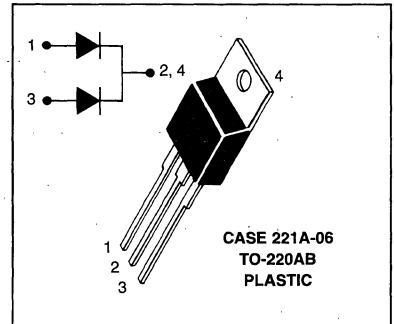
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1535, B1545

### SCHOTTKY BARRIER RECTIFIERS

15 AMPERES  
 35 and 45 VOLTS



### MAXIMUM RATINGS

Rating	Symbol	MBR1535CT	MBR1545CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWV}$ $V_R$	35	45	Volts
Average Rectified Forward Current $T_C = 105^\circ\text{C}$ (Rated $V_R$ )	Per Diode $I_{F(AV)}$ Per Device	7.5 15	7.5 15	Amps
Peak Repetitive Forward Current, $T_C = 105^\circ\text{C}$ (Rated $V_R$ , Square Wave, 20 kHz) Per Diode	$I_{FRM}$	15	15	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	1.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stj}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	1000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS PER DIODE

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	3.0	$^\circ\text{C}/\text{W}$
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	60	60	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS PER DIODE

Maximum Instantaneous Forward Voltage (1) ( $i_F = 7.5$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 15$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 15$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.57 0.72 0.84	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	15 0.1	15 0.1	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

# MBR1535CT, MBR1545CT

FIGURE 1 — TYPICAL FORWARD VOLTAGE

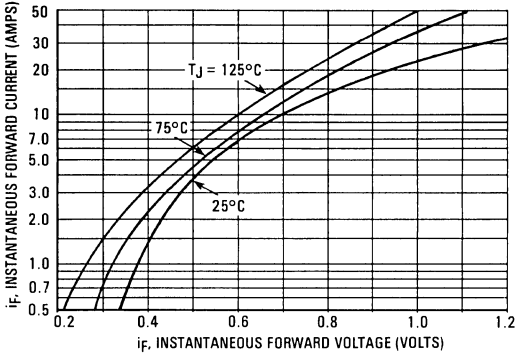


FIGURE 2 — TYPICAL REVERSE CURRENT

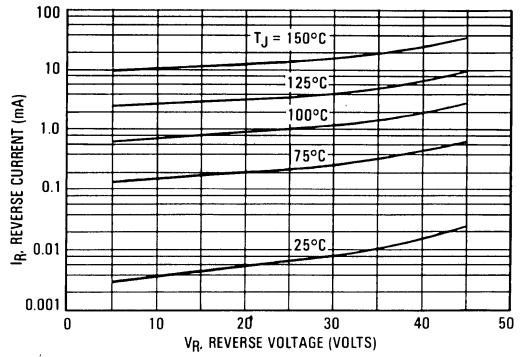


FIGURE 3 — CURRENT DERATING, CASE

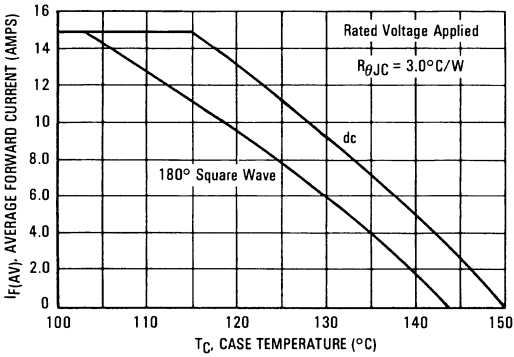


FIGURE 4 — CURRENT DERATING, AMBIENT

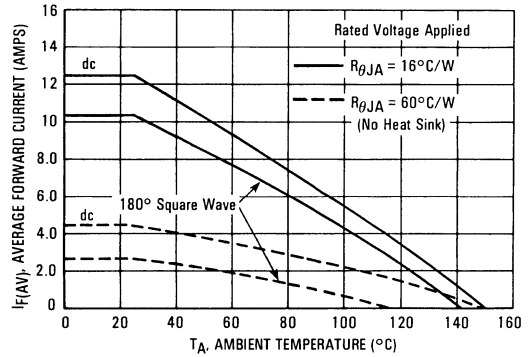
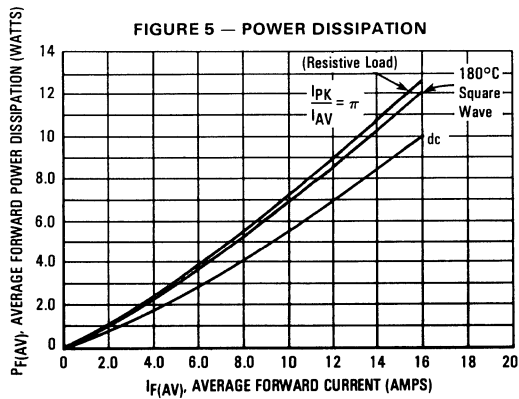


FIGURE 5 — POWER DISSIPATION





# SWITCHMODE Dual Schottky Power Rectifiers

**MBR2015CTL**  
**MBR2030CTL**

MBR2030CTL is a  
 Motorola Preferred Device

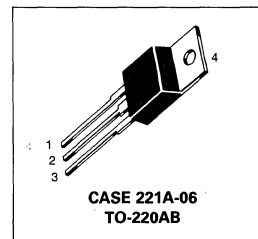
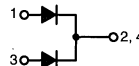
**SCHOTTKY BARRIER  
 RECTIFIERS  
 20 AMPERES  
 15 and 30 VOLTS**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.4 Max @ 10 A,  $T_C = 150^\circ\text{C}$ )
- Matched Dual Die Construction (10 A per Leg or 20 A per Package)
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"

**Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes:  $260^\circ\text{C}$  Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2015, B2030



3

**MAXIMUM RATINGS** (Per Leg)

Rating	Symbol	MBR2015CTL	MBR2030CTL	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	15	30	Volts
Average Rectified Forward Current	$I_{F(AV)}$	10		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150		Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0		Amp
Operating Junction Temperature	$T_J$	-65 to +150		$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175		$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000		V/ $\mu\text{s}$

**THERMAL CHARACTERISTICS** (Per Leg)

Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
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**ELECTRICAL CHARACTERISTICS** (Per Leg)

Maximum Instantaneous Forward Voltage (1) ( $i_F = 10$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 10$ Amp, $T_C = 150^\circ\text{C}$ ) ( $i_F = 20$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 20$ Amp, $T_C = 150^\circ\text{C}$ )	$V_F$	0.52 0.40 0.58 0.48	Volts
Maximum Instantaneous Reverse Current (1) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 100^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	5.0 40 75	mA

(1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle  $\leq 10\%$ .

Rev 2

# MBR2015CTL, MBR2030CTL

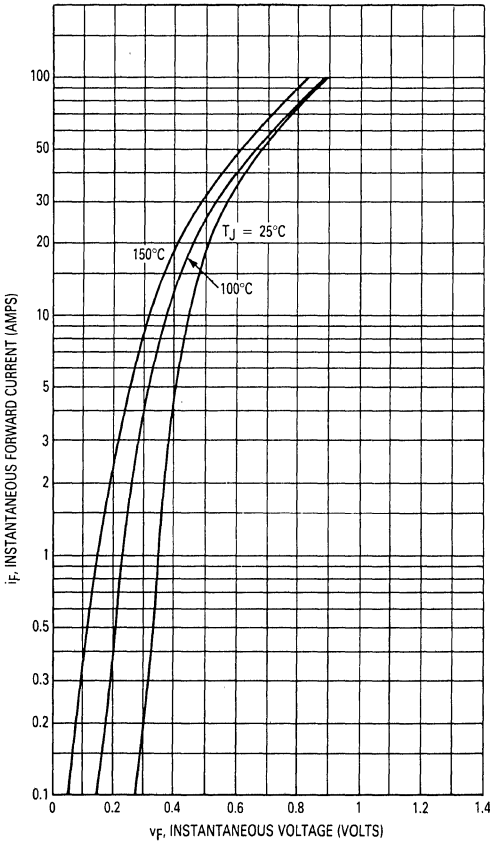


Figure 1. Typical Forward Voltage (Per Leg)

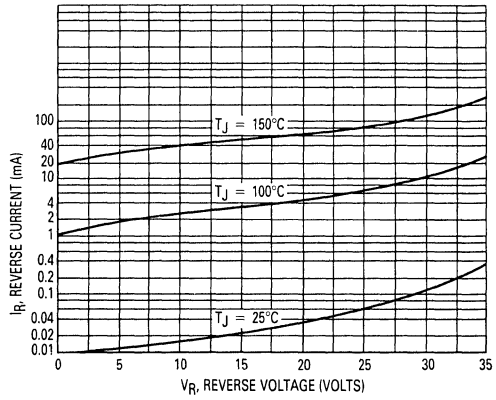


Figure 2. Typical Reverse Current (Per Leg)

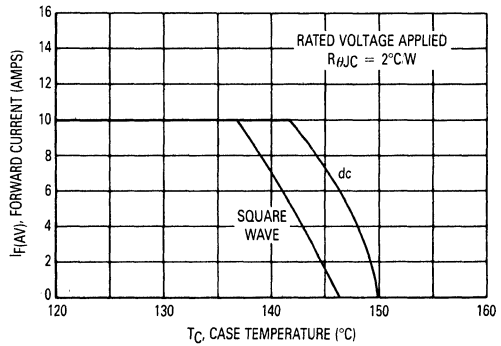


Figure 3. Current Derating, Case

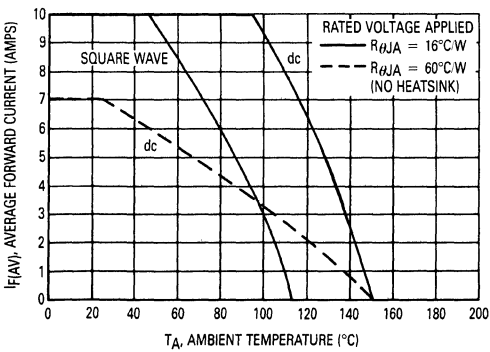


Figure 4. Current Derating, Ambient

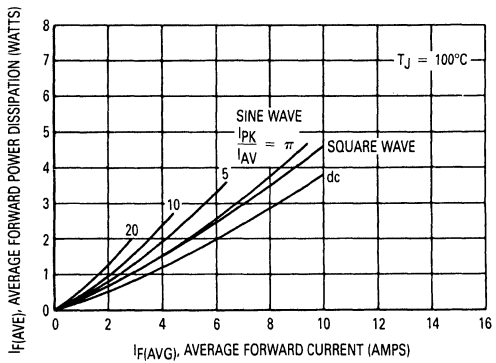


Figure 5. Forward Power Dissipation

# MBR2015CTL, MBR2030CTL

## HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 6.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

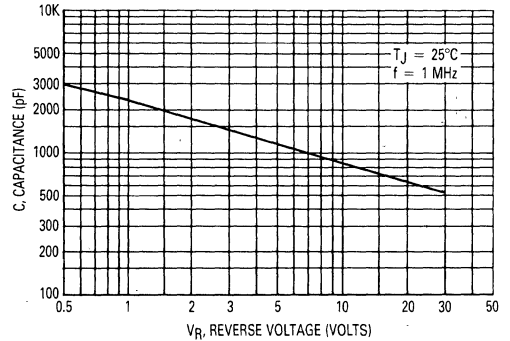


Figure 6. Typical Capacitance

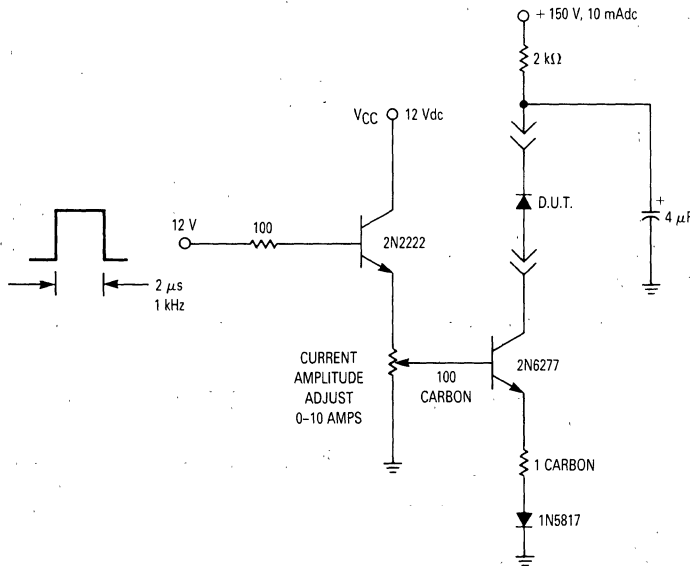


Figure 7. Test Circuit for  $dv/dt$  and Reverse Surge Current

MBR2045CT is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

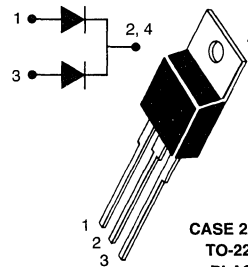
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2035, B2045

### SCHOTTKY BARRIER RECTIFIERS

20 AMPERES  
 35 and 45 VOLTS



### MAXIMUM RATINGS

Rating	Symbol	MBR2035CT	MBR2045CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 135^\circ\text{C}$	$I_{F(AV)}$	20	20	Amps
Peak Repetitive Forward Current Per Diode Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 135^\circ\text{C}$	$I_{FRM}$	20	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 11	$I_{RRM}$	1.0	1.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	1000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	2.0	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 10$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 20$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	0.57 0.72 0.84	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$I_R$	15 0.1	15 0.1	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

FIGURE 1 — MAXIMUM FORWARD VOLTAGE

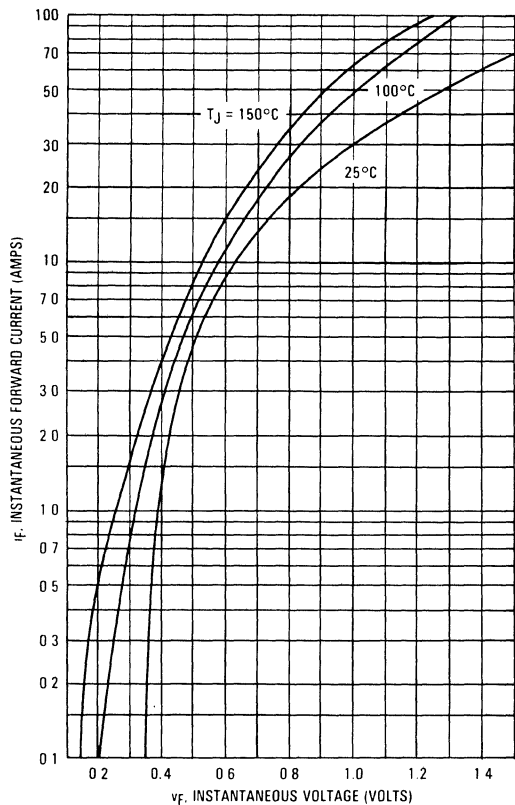


FIGURE 2 — TYPICAL FORWARD VOLTAGE

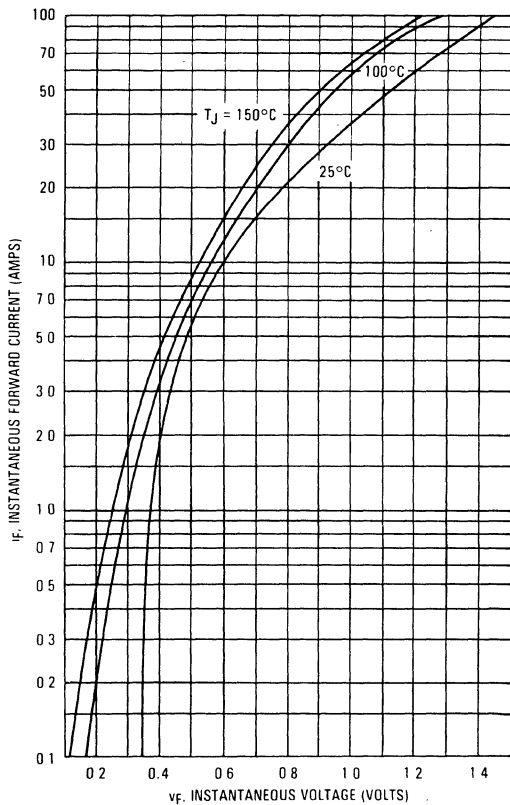


FIGURE 3 — MAXIMUM REVERSE CURRENT

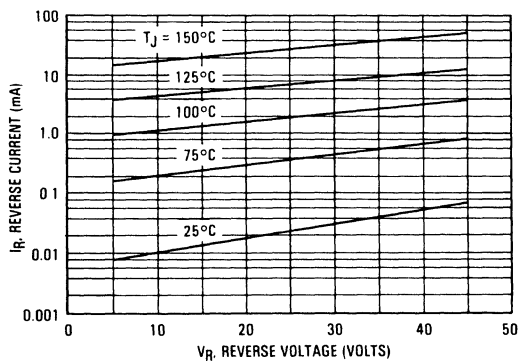
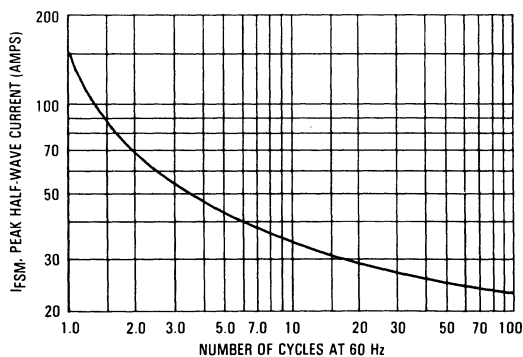


FIGURE 4 — MAXIMUM SURGE CAPABILITY



# MBR2035CT, MBR2045CT

FIGURE 5 — CURRENT DERATING, INFINITE HEATSINK

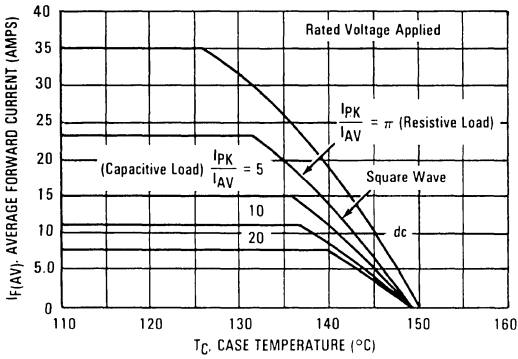


FIGURE 6 — CURRENT DERATING,  $R_{\theta JA} = 16^{\circ}C/W$

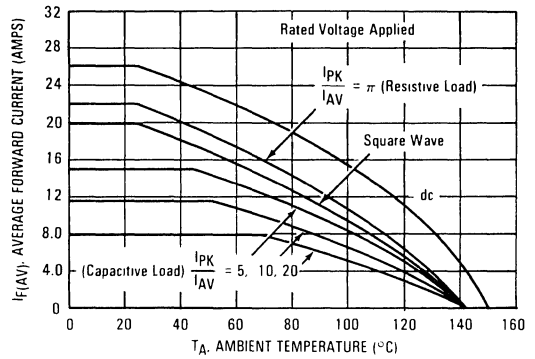


FIGURE 7 — FORWARD POWER DISSIPATION

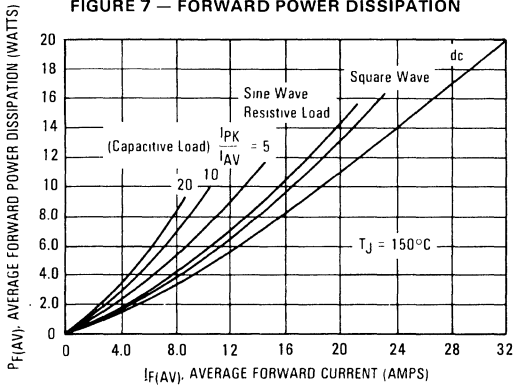


FIGURE 8 — CURRENT DERATING, FREE AIR

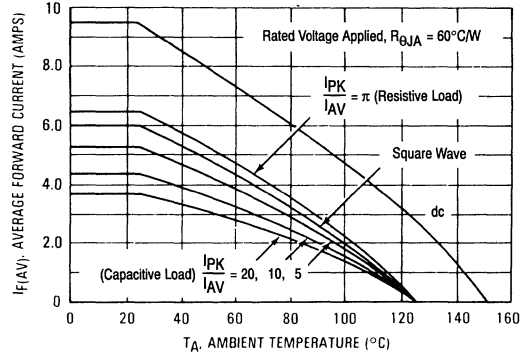
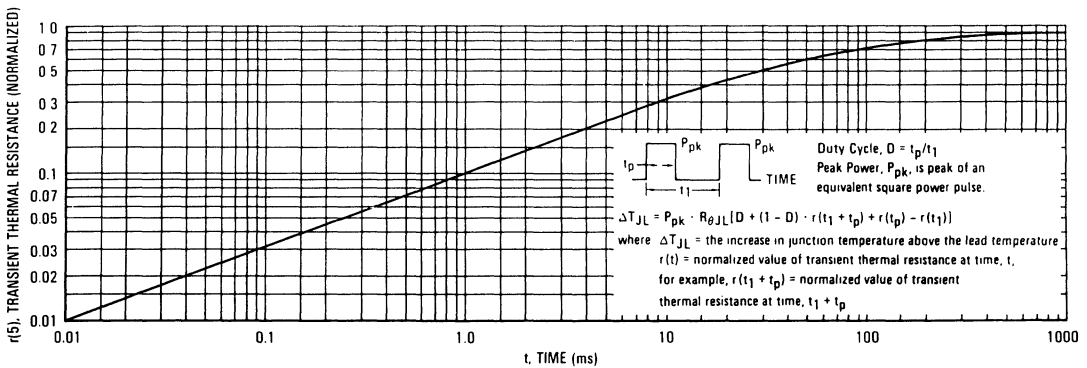


FIGURE 9 — THERMAL RESPONSE



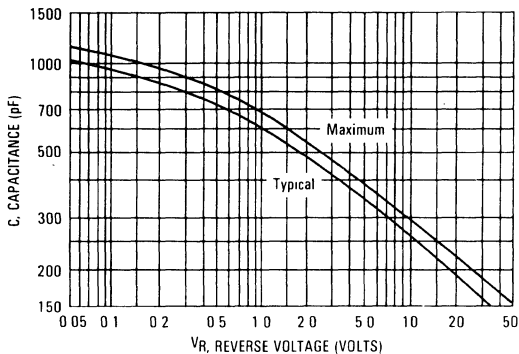
**HIGH FREQUENCY OPERATION**

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

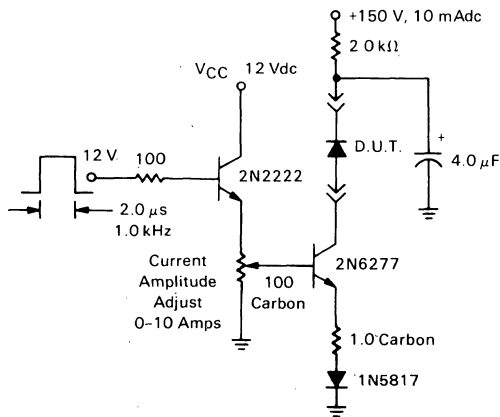
Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

3

**FIGURE 10 — CAPACITANCE**



**FIGURE 11 — TEST CIRCUIT FOR dv/dt AND REVERSE SURGE CURRENT**



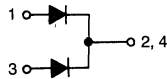
# Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- 20 Amps Total (10 Amps Per Diode Leg)
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"
- Low Power Loss/High Efficiency
- High Surge Capacity
- Low Stored Charge Majority Carrier Conduction

**Mechanical Characteristics:**

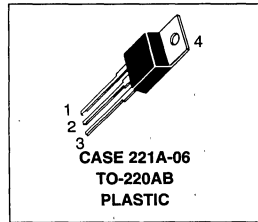
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2060, B2070, B2080, B2090, B20100



**MBR2060CT**  
**MBR2070CT**  
**MBR2080CT**  
**MBR2090CT**  
**MBR20100CT**

MBR2060CT and MBR20100CT  
are Motorola Preferred Devices

**SCHOTTKY BARRIER  
RECTIFIERS**  
**20 AMPERES**  
**60-100 VOLTS**



**MAXIMUM RATINGS PER DIODE LEG**

Rating	Symbol	MBR					Unit
		2060CT	2070CT	2080CT	2090CT	20100CT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	60	70	80	90	100	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 133^\circ\text{C}$	$I_F(AV)$	10					Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 133^\circ\text{C}$	$I_{FRM}$	20					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150					Amps
Peak Repetitive Reverse Surge Current (2 $\mu\text{s}$ , 1 kHz)	$I_{RRM}$	0.5					Amp
Operating Junction Temperature	$T_J$	-65 to +150					$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10,000					$\text{V}/\mu\text{s}$

**THERMAL CHARACTERISTICS**

Maximum Thermal Resistance — Junction to Case — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JA}$	2 60	$^\circ\text{C}/\text{W}$
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**ELECTRICAL CHARACTERISTICS PER DIODE LEG**

Maximum Instantaneous Forward Voltage (1) ( $I_F = 10$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 10$ Amp, $T_C = 25^\circ\text{C}$ ) ( $I_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 20$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.75 0.85 0.85 0.95	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	6 0.1	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .



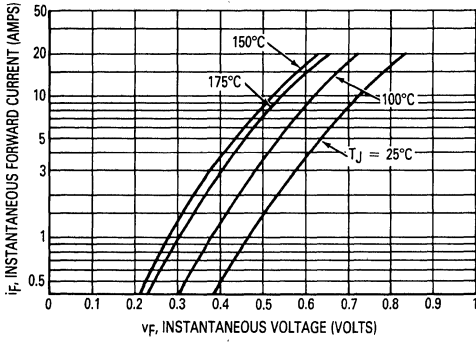


Figure 1. Typical Forward Voltage Per Diode

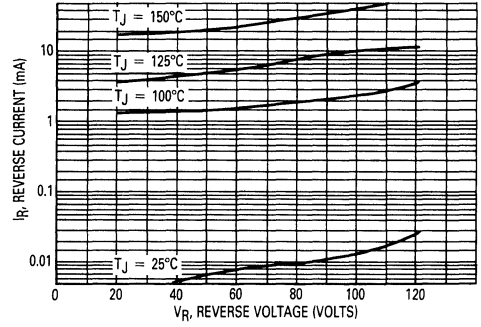


Figure 2. Typical Reverse Current Per Diode

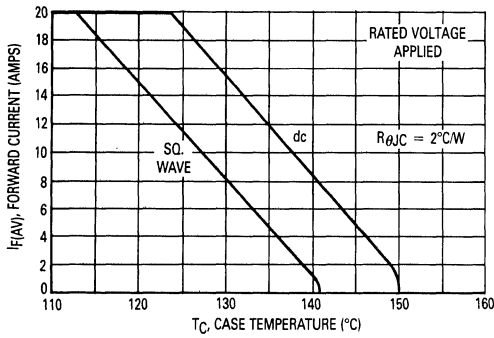


Figure 3. Current Derating, Case

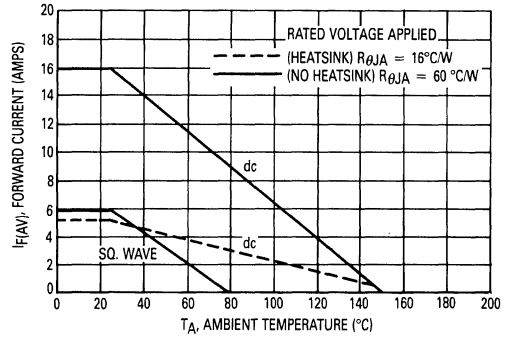


Figure 4. Current Derating, Ambient

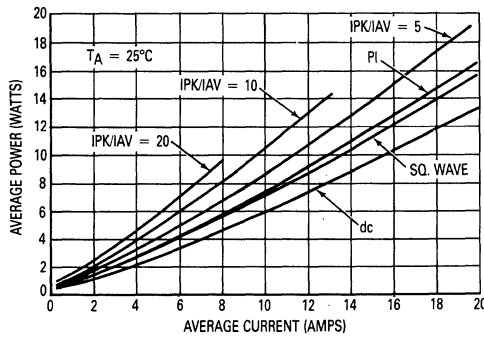


Figure 5. Average Power Dissipation and Average Current

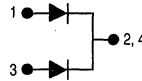
## Switchmode™ Power Dual Schottky Rectifier

...using Schottky Barrier technology with a platinum barrier metal. This state-of-the-art device is designed for use in high frequency switching power supplies and converters with up to 48 volt outputs. They block up to 200 volts and offer improved Schottky performance at frequencies from 250 kHz to 5.0 MHz.

- **200 Volt Blocking Voltage**
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (10,000 V/μs)
- Dual Diode Construction — Terminals 1 and 3 Must be Connected for Parallel Operation at Full Rating

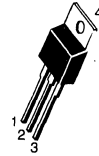
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20200



**MBR2020CT**

**SCHOTTKY BARRIER  
RECTIFIER  
20 AMPERES  
200 VOLTS**



**CASE 221A-06  
(TO-220)**

3

### MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 125^\circ\text{C}$	$I_F(AV)$	10 20	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	$I_{FRM}$	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	$I_{RRM}$	1.0	Amp
Operating Junction Temperature	$T_J$	-65 to +150	°C
Storage Temperature	$T_{stg}$	-65 to +175	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs

### THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	°C/W
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### ELECTRICAL CHARACTERISTICS (PER LEG)

Maximum Instantaneous Forward Voltage (1) ( $I_F = 10$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 10$ Amps, $T_C = 125^\circ\text{C}$ ) ( $I_F = 20$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 20$ Amps, $T_C = 125^\circ\text{C}$ )	$V_F$	0.9 0.8 1.0 0.9	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ )	$I_R$	1.0 50	mA

### DYNAMIC CHARACTERISTICS (PER LEG)

Capacitance ( $V_R = -5.0$ V, $T_C = 25^\circ\text{C}$ , Frequency = 1.0 MHz)	$C_T$	500	pF
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(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Rev 1

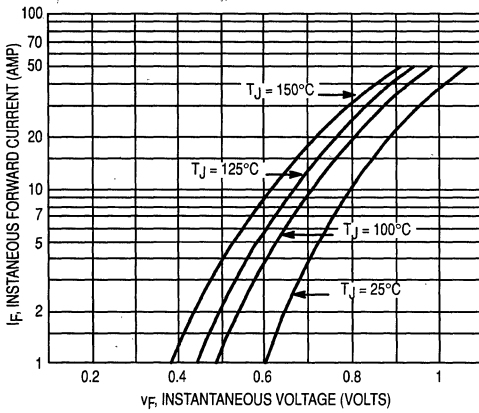


Figure 1. Typical Forward Voltage (Per Leg)

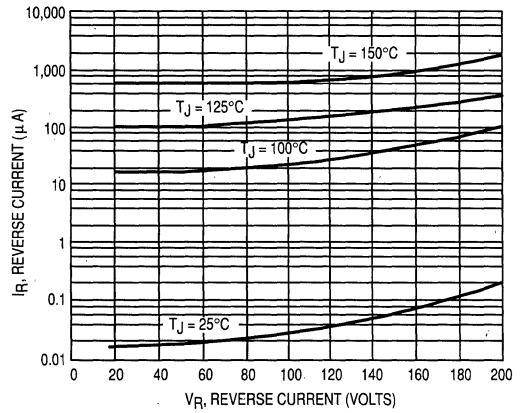


Figure 2. Typical Reverse Current (Per Leg)

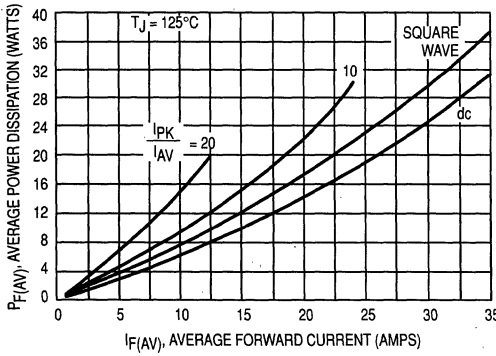


Figure 3. Forward Power Dissipation

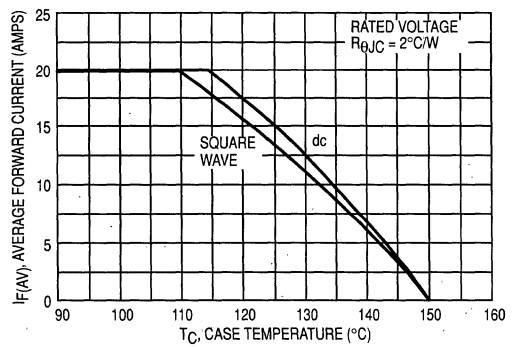


Figure 4. Current Derating, Case

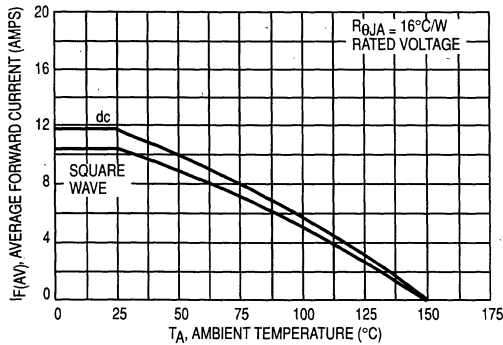


Figure 5. Current Derating, Ambient

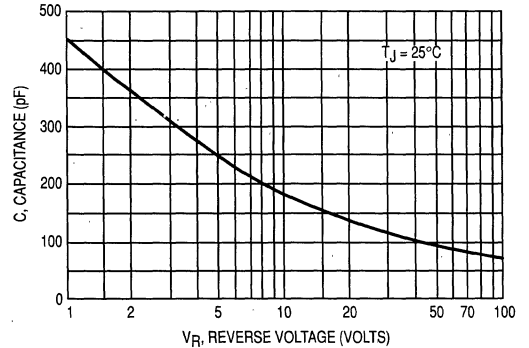


Figure 6. Typical Capacitance (Per Leg)

## Advance Information SWITCHMODE™ Power Rectifiers

... employing the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, low voltage converters, OR'ing diodes, and polarity protection devices.

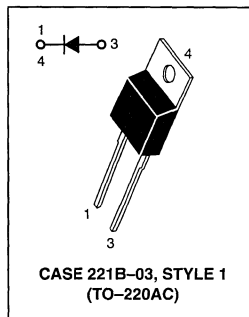
- Very Low Forward Voltage (0.28 V Maximum @ 19 Amps, 70°C)
- Guardring for Stress Protection
- Highly Stable Oxide Passivated Junction (100°C Operating Junction Temperature)
- Epoxy Meets UL94, VO at 1/8"

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube
- Marking: B2515L

**MBR2515L**

**SCHOTTKY BARRIER  
RECTIFIER  
25 AMPERES  
15 VOLTS**



3

### MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWV}$ $V_R$	15	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 90^\circ\text{C}$	$I_{F(AV)}$	25	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	$I_{FRM}$	30	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	Amps
Operating Junction Temperature	$T_J$	-65 to +100	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +125	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
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### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 25$ Amps, $T_J = 25^\circ\text{C}$ ) ( $I_F = 25$ Amps, $T_J = 70^\circ\text{C}$ ) ( $I_F = 19$ Amps, $T_J = 70^\circ\text{C}$ )	$V_F$	0.45 0.42 0.28	Volts
Maximum Instantaneous Reverse Current (1) (Rated DC Voltage, $T_J = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_J = 70^\circ\text{C}$ )	$I_R$	15 200	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

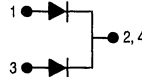
# Switchmode™ Power Rectifier

... employing the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes.

- Very Low Forward Voltage (0.55 V Maximum @ 25 Amps)
- Matched Dual Die Construction (12.5 A per Leg or 25 A per Package)
- Guardring for Stress Protection
- Highly Stable Oxide Passivated Junction (125°C Operating Junction Temperature)
- Epoxy Meets UL94, VO at 1/8"

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2535L



**MBR2535CTL**

**SCHOTTKY BARRIER  
RECTIFIER  
25 AMPERES  
35 VOLTS**



**CASE 221A-06  
(TO-220AC)**

### MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	35	Volts
Working Peak Reverse Voltage	V <sub>RWM</sub>	35	
DC Blocking Voltage	V <sub>R</sub>	35	
Average Rectified Forward Current (Rated V <sub>R</sub> ) T <sub>C</sub> = 110°C	I <sub>F(AV)</sub>	12.5	Amps
Peak Repetitive Forward Current, Per Leg (Rated V <sub>R</sub> , Square Wave, 20 kHz) T <sub>C</sub> = 95°C	I <sub>FRM</sub>	25	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	Amp
Operating Junction Temperature	T <sub>J</sub>	-65 to +125	°C
Storage Temperature	T <sub>stg</sub>	-65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs
Controlled Avalanche Energy	W <sub>aval</sub>	20	mJ

### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	R <sub>θJC</sub>	2.0	°C/W
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### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) (I <sub>F</sub> = 25 Amps, T <sub>J</sub> = 25°C) (I <sub>F</sub> = 12.5 Amps, T <sub>J</sub> = 25°C) (I <sub>F</sub> = 12.5 Amps, T <sub>J</sub> = 125°C)	V <sub>F</sub>	0.55 0.47 0.41	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T <sub>J</sub> = 25°C) (Rated dc Voltage, T <sub>J</sub> = 125°C)	I <sub>R</sub>	5.0 500	mA

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤2.0%.

Rev 1

# MBR2535CTL

3

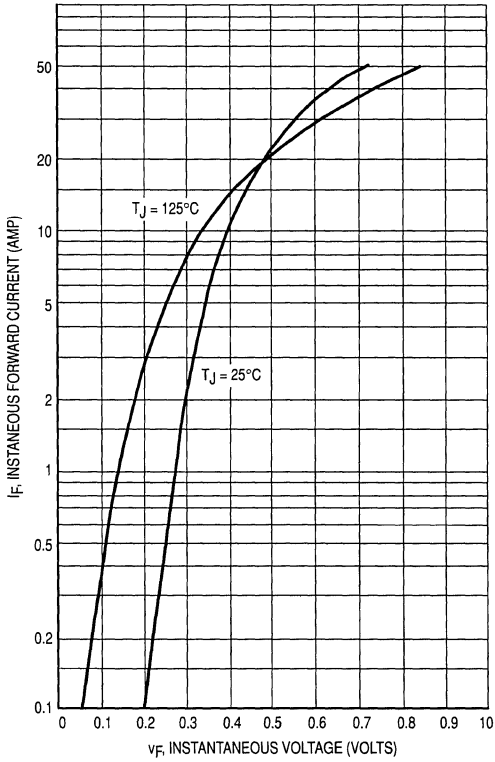


Figure 1. Typical Forward Voltage, Per Leg

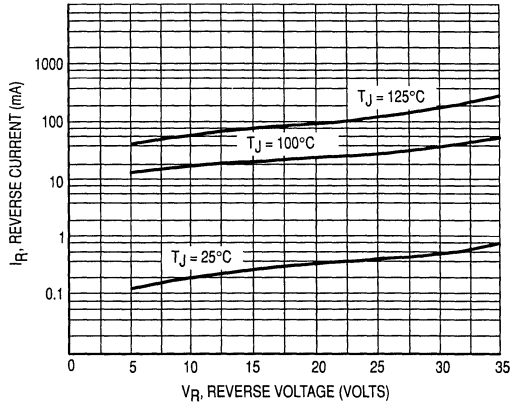


Figure 2. Typical Reverse Current, Per Leg

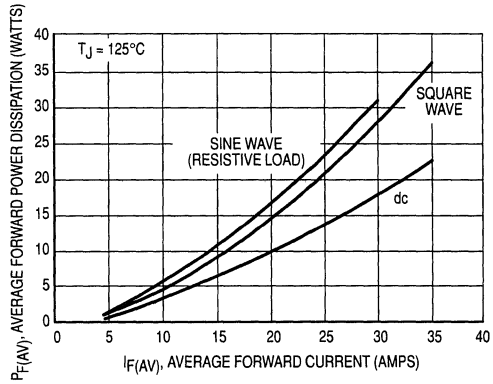


Figure 3. Forward Power Dissipation, Per Leg

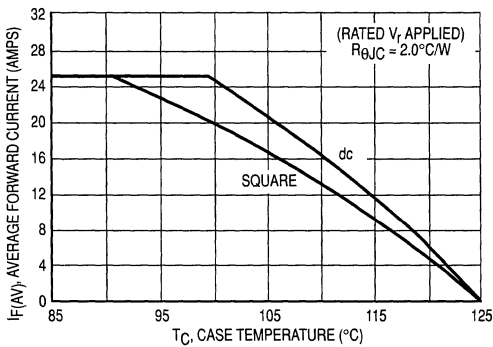


Figure 4. Current Derating

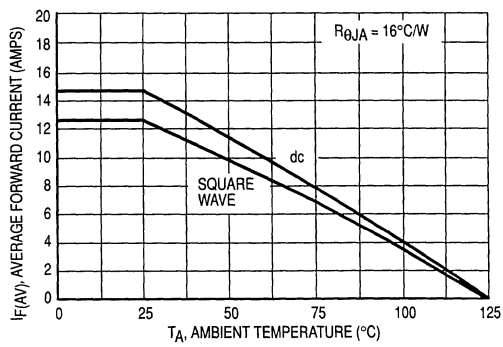


Figure 5. Current Derating Ambient, Per Leg

MBR2545CT is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

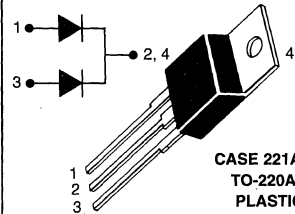
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2535, B2545

### SCHOTTKY BARRIER RECTIFIERS

**30 AMPERES**  
**35 and 45 VOLTS**



### MAXIMUM RATINGS

Rating	Symbol	MBR2535CT	MBR2545CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 130^\circ\text{C}$	$I_{F(AV)}$	30	30	Amps
Peak Repetitive Forward Current Per Diode Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 130^\circ\text{C}$	$I_{FRM}$	30	30	Amps
Nonrepetitive Peak Surge Current per Diode Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	1.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	1000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS PER DIODE LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	1.5	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS PER DIODE LEG

Maximum Instantaneous Forward Voltage (1) ( $i_F = 30$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 30$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.73 0.82	0.73 0.82	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	40 0.2	40 0.2	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 1

# MBR2535CT, MBR2545CT

FIGURE 1 — TYPICAL FORWARD VOLTAGE

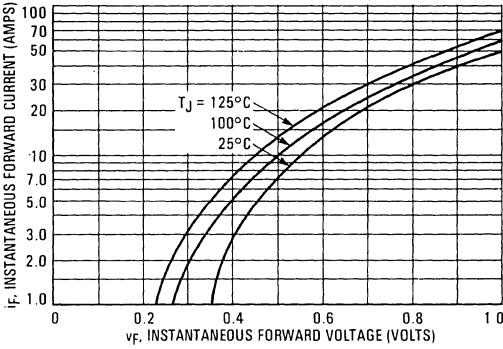


FIGURE 2 — TYPICAL REVERSE CURRENT

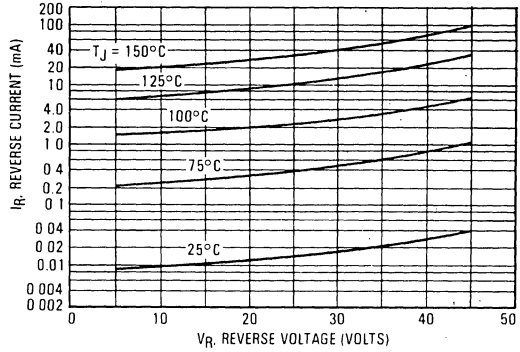


FIGURE 3 — CURRENT DERATING, CASE

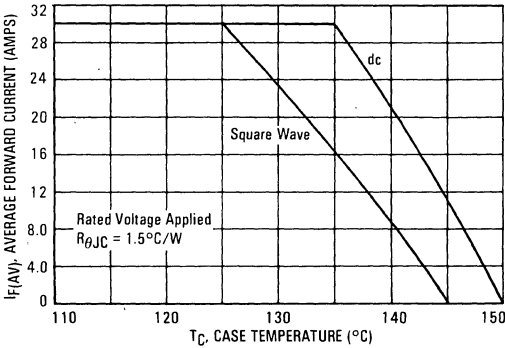


FIGURE 4 — CURRENT DERATING, AMBIENT

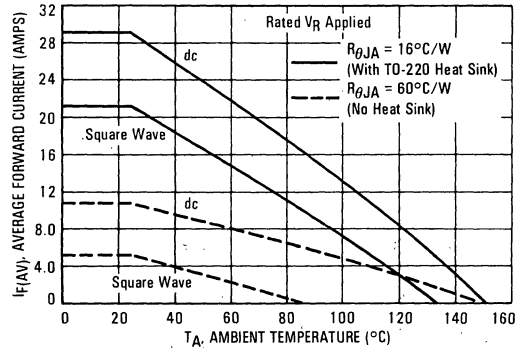
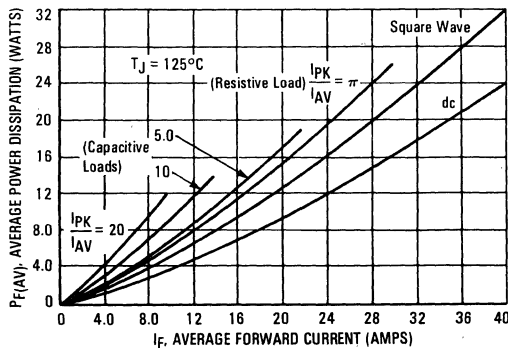


FIGURE 5 — FORWARD POWER DISSIPATION





*Advance Information*  
**SWITCHMODE™ Power Rectifier**

... using the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 V Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube
- Marking: B3045

**MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	V
Average Rectified Current Per Device $T_C = 130^\circ\text{C}$ Per Diode	$I_{F(AV)}$	30 15	A
Peak Repetitive Forward Current, Per Diode (Square Wave, $V_R = 45\text{ V}$ , 20 kHz)	$I_{FRM}$	30	A
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	A
Peak Repetitive Reverse Current, Per Diode (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	A
Operating Junction Temperature	$T_J$	-65 to +150	°C
Storage Temperature	$T_{stg}$	-65 to +175	°C
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	°C
Voltage Rate of Change (Rated $V_R$ )	$dV/dt$	10000	V/ $\mu\text{s}$

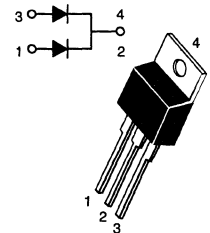
**THERMAL CHARACTERISTICS PER DIODE**

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	°C/W
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**MBR3045ST**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
30 AMPERES  
45 VOLTS**



**CASE 221A-06, STYLE 6  
(TO-220AB)**

3

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBR3045ST

## ELECTRICAL CHARACTERISTICS PER DIODE

Rating	Symbol	Max	Unit
Instantaneous Forward Voltage (1) ( $I_F = 30$ Amp, $T_C = 25^\circ\text{C}$ ) ( $I_F = 30$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 20$ Amp, $T_C = 125^\circ\text{C}$ )	$V_F$	0.76 0.72 0.60	V
Instantaneous Reverse Current (1) ( $V_R = 45$ Volts, $T_C = 25^\circ\text{C}$ ) ( $V_R = 45$ Volts, $T_C = 125^\circ\text{C}$ )	$I_R$	0.2 40	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"

### Mechanical Characteristics:

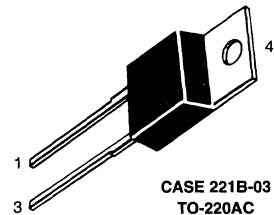
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B735, B745

**MBR735**  
**MBR745**

MBR745 is a  
 Motorola Preferred Device

**SCHOTTKY BARRIER  
 RECTIFIERS**

**7.5 AMPERES**  
**35 and 45 VOLTS**



CASE 221B-03  
 TO-220AC



### MAXIMUM RATINGS

Rating	Symbol	MBR735	MBR745	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 105^\circ\text{C}$	$I_{F(AV)}$	7.5	7.5	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 105^\circ\text{C}$	$I_{FRM}$	15	15	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	1.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	1000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	3.0	$^\circ\text{C}/\text{W}$
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	60	60	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $i_F = 7.5$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 15$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 15$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.57 0.72 0.84	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	15 0.1	15 0.1	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 1

FIGURE 1 — TYPICAL FORWARD VOLTAGE

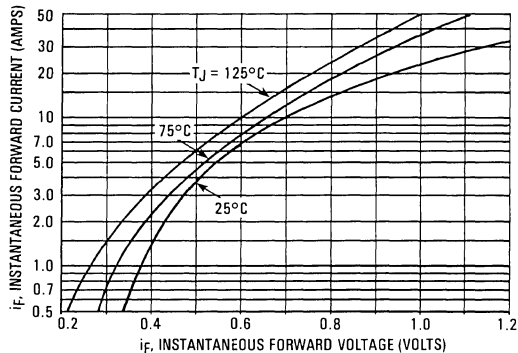


FIGURE 2 — TYPICAL REVERSE CURRENT

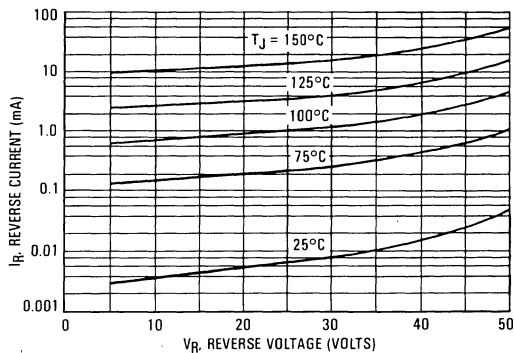


FIGURE 3 — CURRENT DERATING, CASE

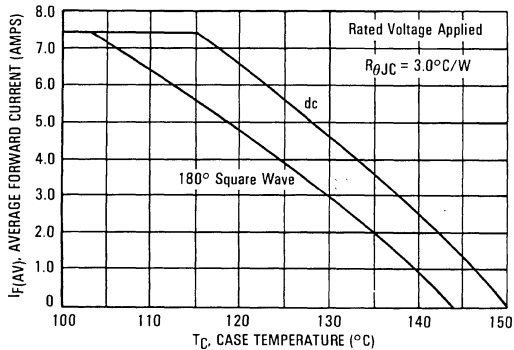


FIGURE 4 — CURRENT DERATING, AMBIENT

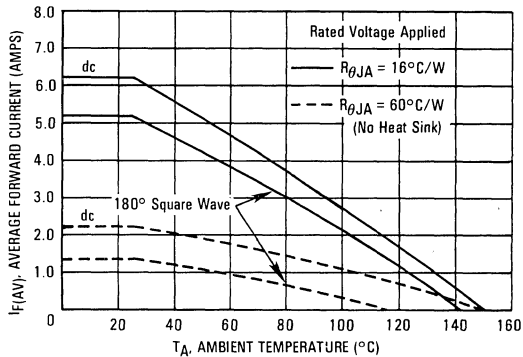
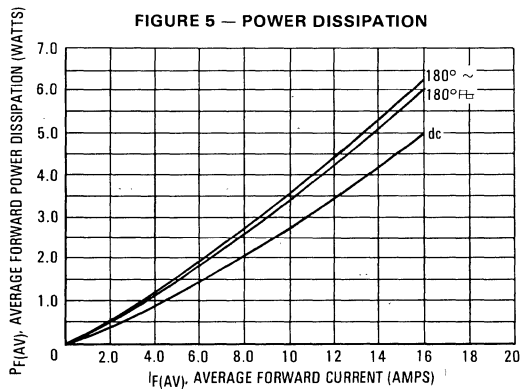


FIGURE 5 — POWER DISSIPATION



MBR1045 is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

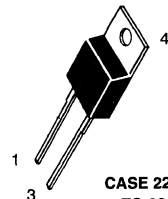
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1035, B1045

### SCHOTTKY BARRIER RECTIFIERS

**10 AMPERES**  
**20 to 45 VOLTS**



CASE 221B-03  
 TO-220AC  
 PLASTIC



### MAXIMUM RATINGS

Rating	Symbol	MBR1035	MBR1045	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 135^\circ\text{C}$	$I_{F(AV)}$	10	10	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 135^\circ\text{C}$	$I_{FRM}$	20	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 12	$I_{RRM}$	1.0	1.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	1000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	MBR1035	MBR1045	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	2.0	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	MBR1035	MBR1045	Unit
Maximum Instantaneous Forward Voltage (1) ( $I_F = 10\text{ A}$ , $T_C = 125^\circ\text{C}$ ) ( $I_F = 20\text{ A}$ , $T_C = 125^\circ\text{C}$ ) ( $I_F = 20\text{ A}$ , $T_C = 25^\circ\text{C}$ )	$V_F$	0.57 0.72 0.84	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	15 0.1	15 0.1	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 2

FIGURE 1 — MAXIMUM FORWARD VOLTAGE

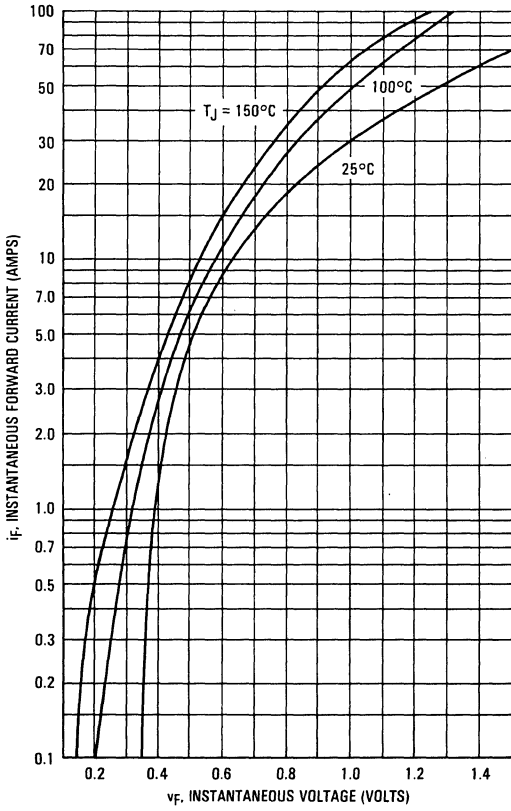


FIGURE 2 — TYPICAL FORWARD VOLTAGE

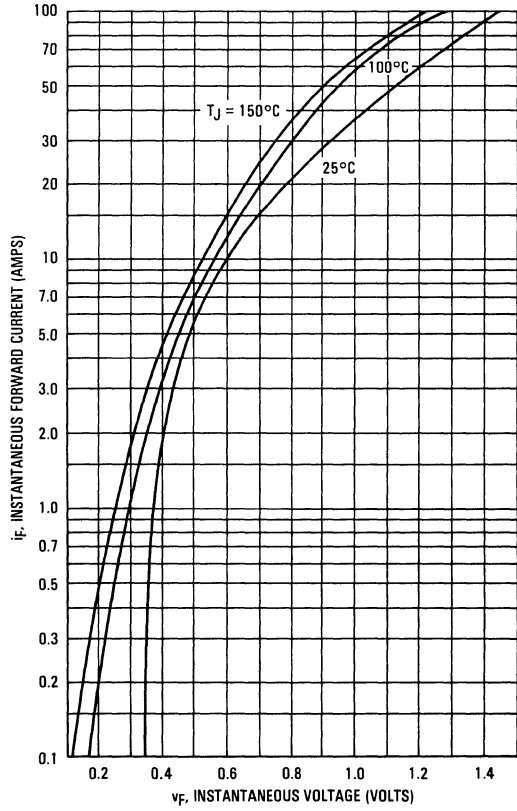


FIGURE 3 — MAXIMUM REVERSE CURRENT

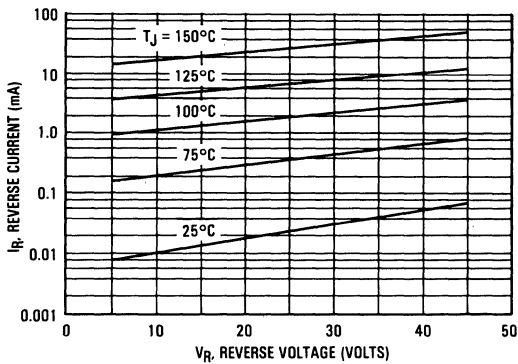


FIGURE 4 — MAXIMUM SURGE CAPABILITY

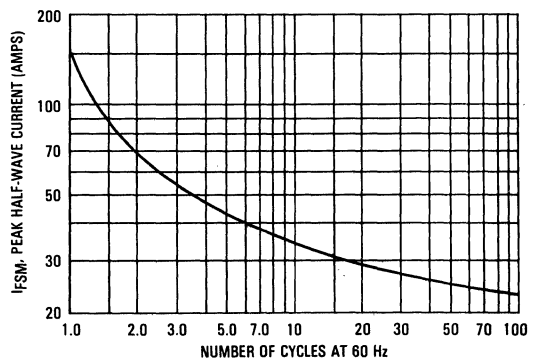


FIGURE 5 — CURRENT DERATING, INFINITE HEATSINK

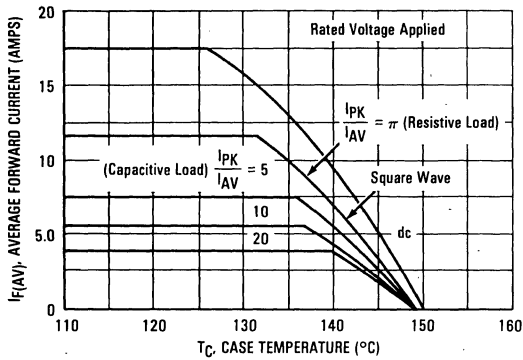


FIGURE 6 — CURRENT DERATING,  $R_{\theta JA} = 16^\circ \text{C/W}$

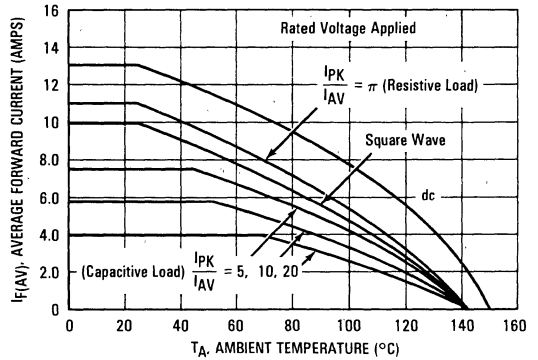


FIGURE 7 — FORWARD POWER DISSIPATION

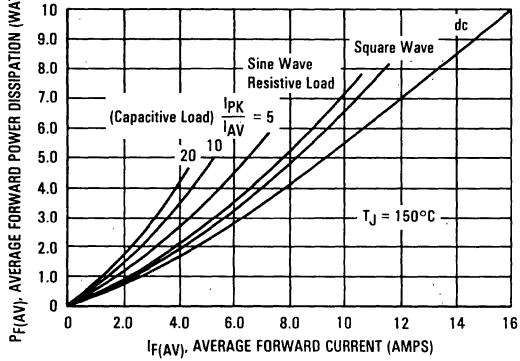


FIGURE 8 — CURRENT DERATING, FREE AIR

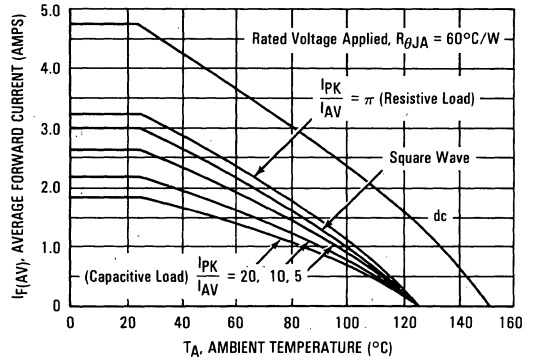
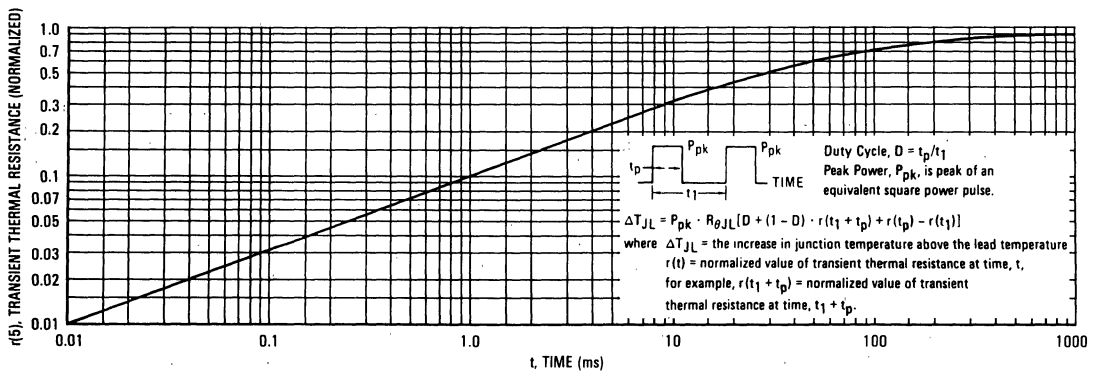


FIGURE 9 — THERMAL RESPONSE



## HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

FIGURE 10 — CAPACITANCE

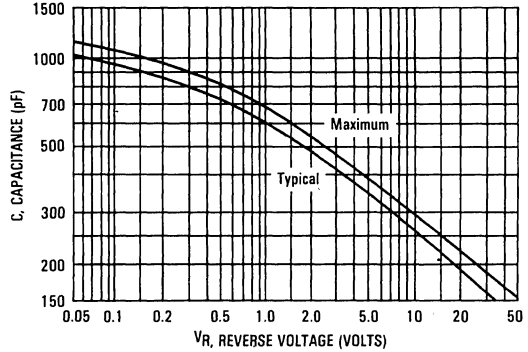
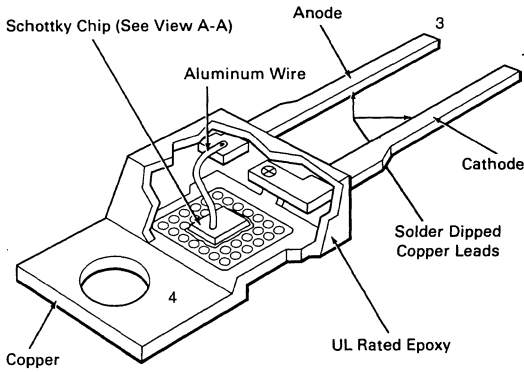
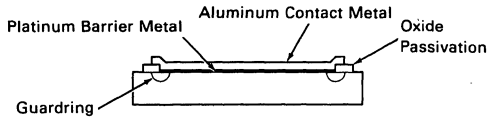


FIGURE 11 — SCHOTTKY RECTIFIER



Schottky Chip — View A-A



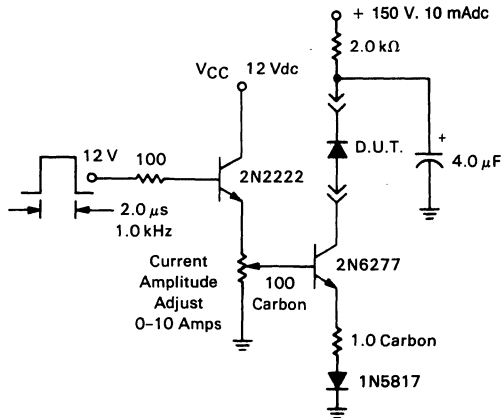
Motorola builds quality and reliability into its Schottky Rectifiers.

First is the chip, which has an interface metal between the barrier metal and aluminum-contact metal to eliminate any possible interaction between the two. The indicated guardring prevents  $dv/dt$  problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. The Schottky chip is bonded to the copper heat sink using a specially formulated solder. This gives the unit the capability of passing 10,000 operating thermal-fatigue cycles having a  $\Delta T_J$  of 100°C. The epoxy molding compound is rated per UL 94, V0 @ 1/8". Wire bonds are 100% tested in assembly as they are made.

Third is the electrical testing, which includes 100%  $dv/dt$  at 1600 V/ $\mu s$  and reverse avalanche as part of device characterization.

FIGURE 12 — TEST CIRCUIT FOR  $dv/dt$  AND REVERSE SURGE CURRENT





# Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Epoxy Meets UL94, VO at 1/8"
- Low Power Loss/High Efficiency
- High Surge Capacity
- Low Stored Charge Majority Carrier Conduction

**Mechanical Characteristics:**

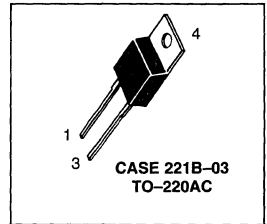
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1060, B1070, B1080, B1090, B10100



**MBR1060**  
**MBR1070**  
**MBR1080**  
**MBR1090**  
**MBR10100**

MBR1060 and MBR10100 are  
Motorola Preferred Devices

**SCHOTTKY BARRIER  
RECTIFIERS**  
**10 AMPERES**  
**60-100 VOLTS**



**MAXIMUM RATINGS**

Rating	Symbol	MBR					Unit
		1060	1070	1080	1090	10100	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	60	70	80	90	100	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 133^\circ\text{C}$	$I_{F(AV)}$	10					Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 133^\circ\text{C}$	$I_{FRM}$	20					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150					Amps
Peak Repetitive Reverse Surge Current (2 $\mu\text{s}$ , 1 kHz)	$I_{RRM}$	0.5					Amp
Operating Junction Temperature	$T_J$	-65 to +150					$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175					$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10,000					$\text{V}/\mu\text{s}$

**THERMAL CHARACTERISTICS**

Maximum Thermal Resistance — Junction to Case — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JA}$	2 60	$^\circ\text{C}/\text{W}$
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**ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (1) ( $I_F = 10$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 10$ Amp, $T_C = 25^\circ\text{C}$ ) ( $I_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 20$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	0.7 0.8 0.85 0.95	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	6.0 0.10	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

# MBR1060, MBR1070, MBR1080, MBR1090, MBR10100

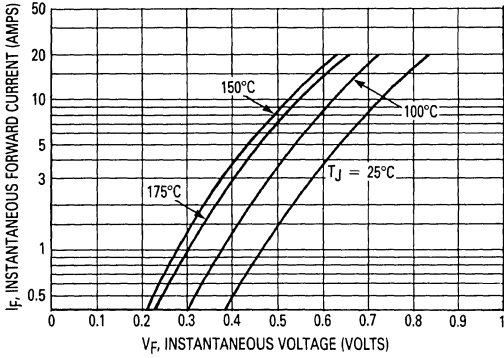


Figure 1. Typical Forward Voltage

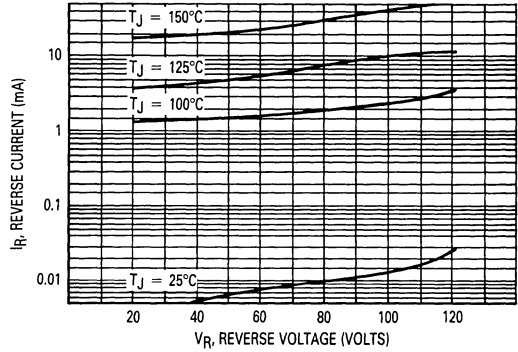


Figure 2. Typical Reverse Current

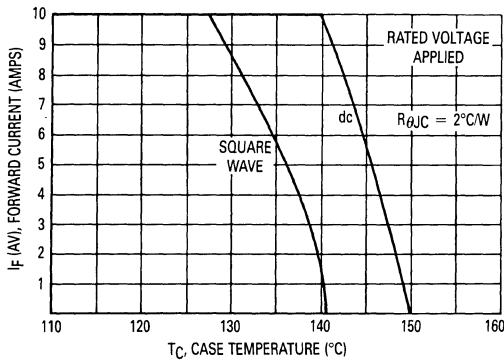


Figure 3. Current Derating, Case

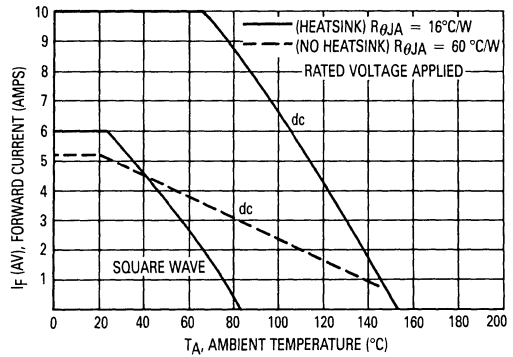


Figure 4. Current Derating, Ambient

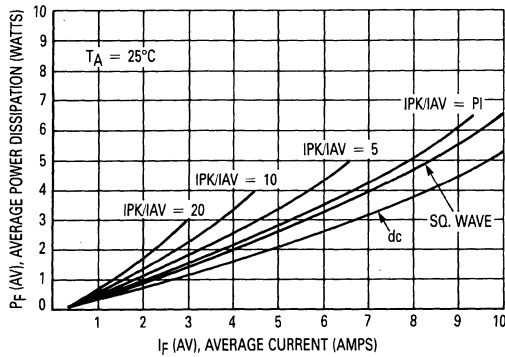


Figure 5. Forward Power Dissipation

3

MBR1645 is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

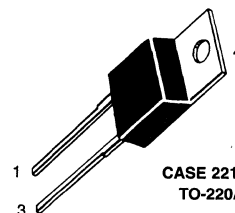
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1635, B1645

### SCHOTTKY BARRIER RECTIFIERS

**16 AMPERES**  
**35 and 45 VOLTS**



### MAXIMUM RATINGS

Rating	Symbol	MBR1635	MBR1645	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	16	16	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 125^\circ\text{C}$	$I_{FRM}$	32	32	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	1.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	1000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	1.5	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $i_F = 16$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 16$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	0.57 0.63	0.57 0.63	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	40 0.2	40 0.2	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

# MBR1635, MBR1645

FIGURE 1 — TYPICAL FORWARD VOLTAGE

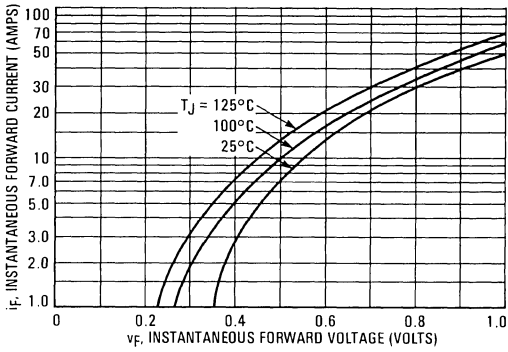


FIGURE 2 — TYPICAL REVERSE CURRENT

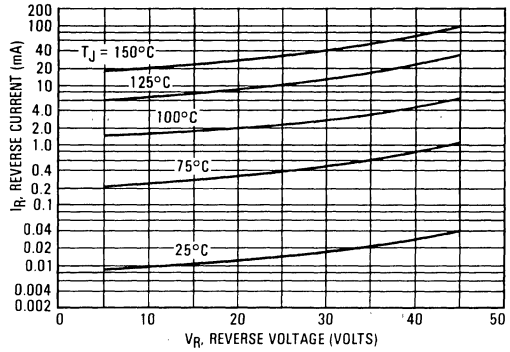


FIGURE 3 — CURRENT DERATING, CASE

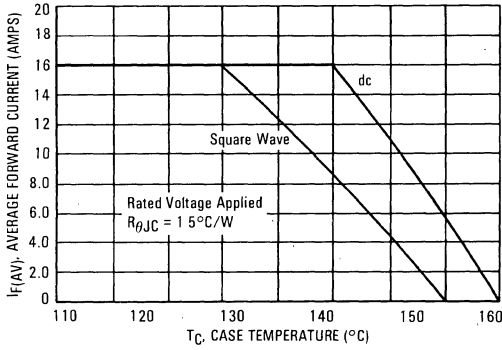


FIGURE 4 — CURRENT DERATING, AMBIENT

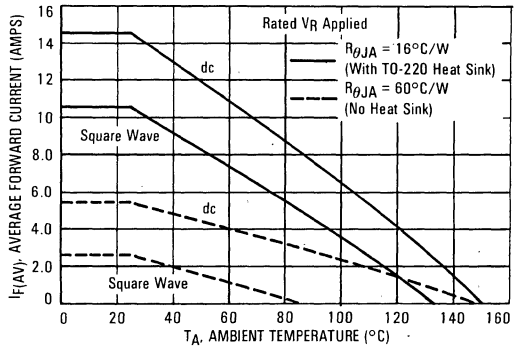
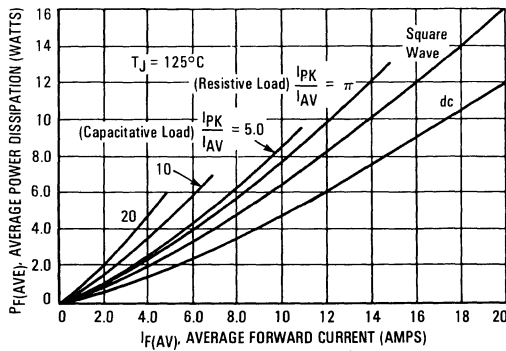


FIGURE 5 — FORWARD POWER DISSIPATION



# SWITCHMODE™ Schottky Power Rectifiers

**MBRF1545CT**

Motorola Preferred Device

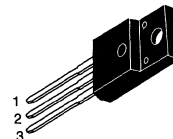
**SCHOTTKY BARRIER  
RECTIFIERS  
15 AMPERES  
45 VOLTS**

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1545



CASE 221D-02  
ISOLATED TO-220

### MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWV}$ $V_R$	45	Volts	
Average Rectified Forward Current (Rated $V_R$ ), $T_C = 105^\circ\text{C}$	$I_{F(AV)}$	7.5 15	Amps	
Total Device				
Peak Repetitive Forward Current, $T_C = 105^\circ\text{C}$ (Rated $V_R$ , Square Wave, 20 kHz) Per Diode	$I_{FRM}$	15	Amps	
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps	
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	Amp	
Operating Junction and Storage Temperature	$T_J, T_{stg}$	- 65 to +150	$^\circ\text{C}$	
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000	V/ $\mu\text{s}$	
RMS Isolation Voltage ( $t = 1$ second, R.H. $\leq 30\%$ , $T_A = 25^\circ\text{C}$ )(2)	Per Figure 3 Per Figure 4(1) Per Figure 5	$V_{iso1}$ $V_{iso2}$ $V_{iso3}$	4500 3500 1500	Volts

### THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.1	$^\circ\text{C/W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	$T_L$	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRF1545CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 15$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 15$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 7.5$ Amp, $T_C = 125^\circ\text{C}$ )	$v_F$	0.84 0.72 0.57	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	0.1 15	mA

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

3

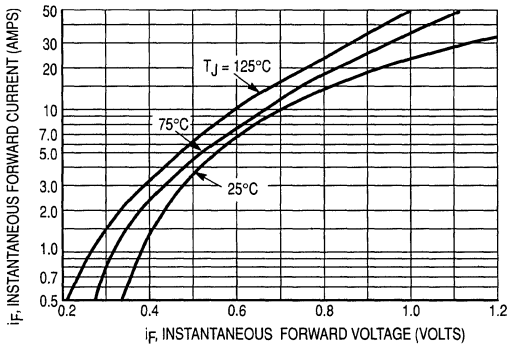


Figure 1. Typical Forward Voltage

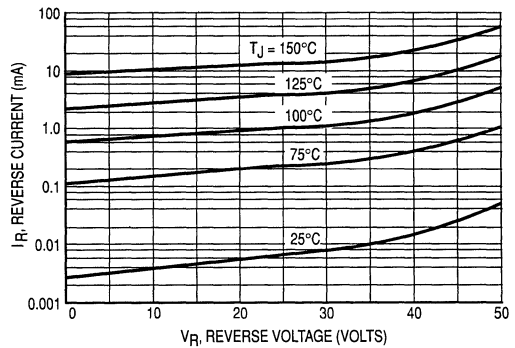
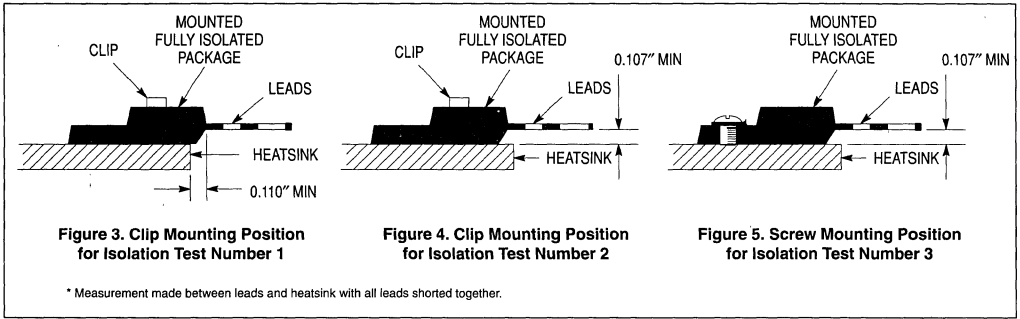
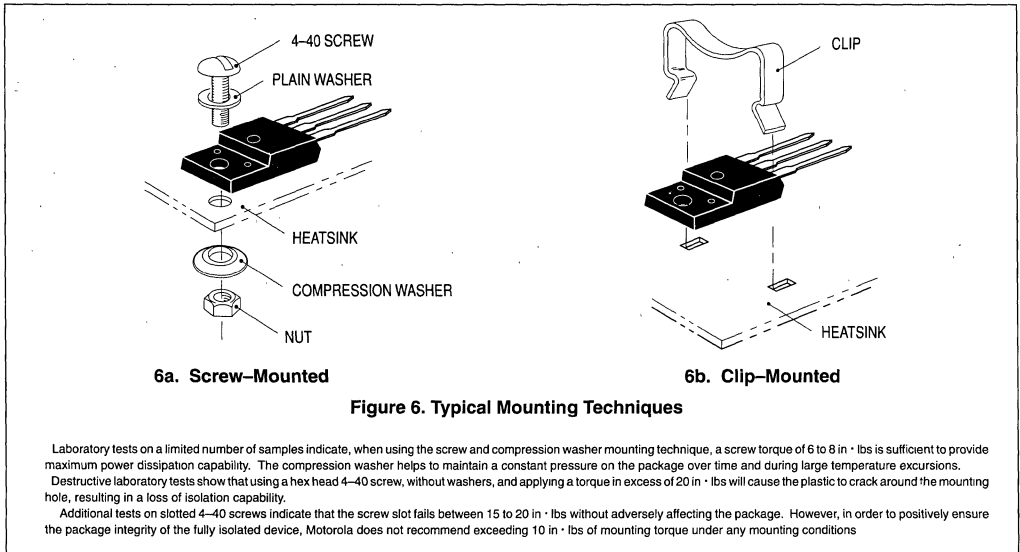


Figure 2. Typical Reverse Current



**MOUNTING INFORMATION\*\***



\*\*For more information about mounting power semiconductors see Application Note AN1040.

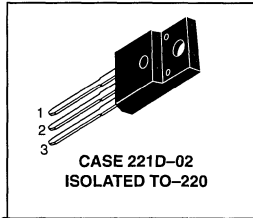
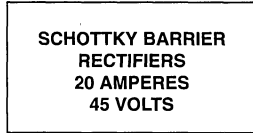
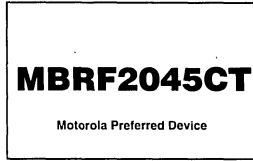
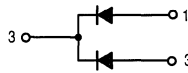
# SWITCHMODE™ Schottky Power Rectifiers

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2045



**3**

### MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	Volts	
Average Rectified Forward Current (Rated $V_R$ , $T_C = 135^\circ\text{C}$ )	$I_F(AV)$	10 20	Amps	
Peak Repetitive Forward Current Per Diode Leg (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 135^\circ\text{C}$	$I_{FRM}$	20	Amps	
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps	
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	Amp	
Operating Junction and Storage Temperature	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$	
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000	V/ $\mu\text{s}$	
RMS Isolation Voltage ( $t = 1$ second, R.H. $\leq 30\%$ , $T_A = 25^\circ\text{C}$ )(2)	Per Figure 5 Per Figure 6(1) Per Figure 7	$V_{iso1}$ $V_{iso2}$ $V_{iso3}$	4500 3500 1500	Volts

### THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.0	$^\circ\text{C/W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	$T_L$	260	$^\circ\text{C}$

(1) UL recognized mounting method is per Figure 6.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value

Rev 1



# MBRF2045CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 20$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 10$ Amp, $T_C = 125^\circ\text{C}$ )	$v_F$	0.84 0.72 0.57	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	0.1 15	mA

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

3

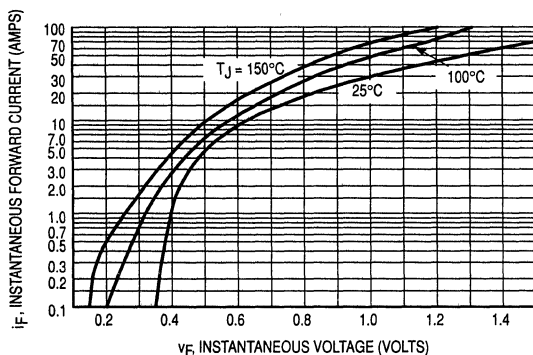


Figure 1. Maximum Forward Voltage

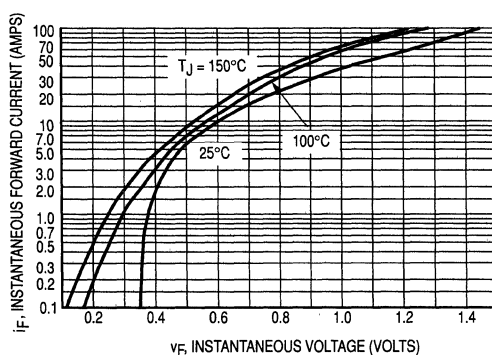


Figure 2. Typical Forward Voltage

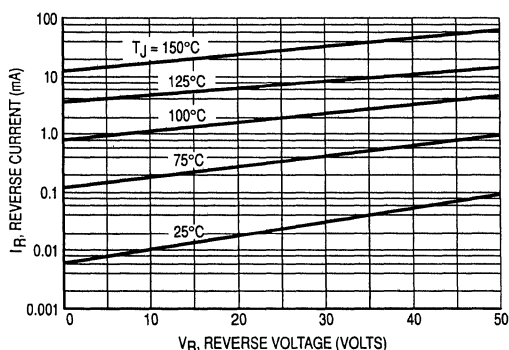


Figure 3. Maximum Reverse Current

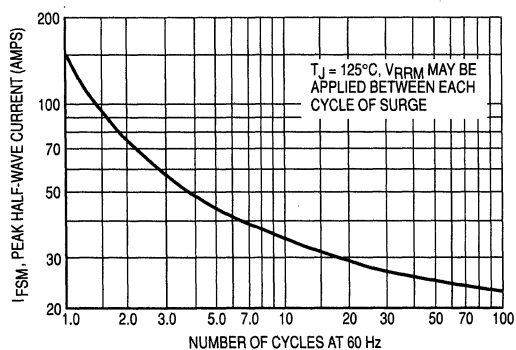
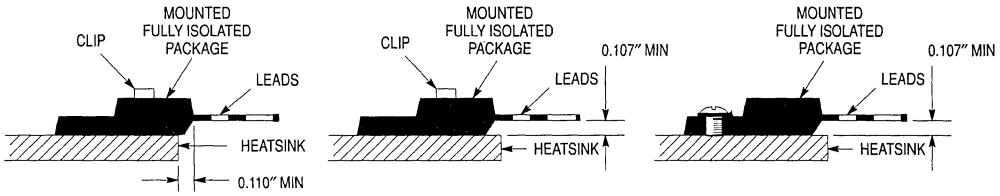


Figure 4. Maximum Surge Capability

# MBRF2045CT

## TEST CONDITIONS FOR ISOLATION TESTS\*



**Figure 5. Clip Mounting Position for Isolation Test Number 1**

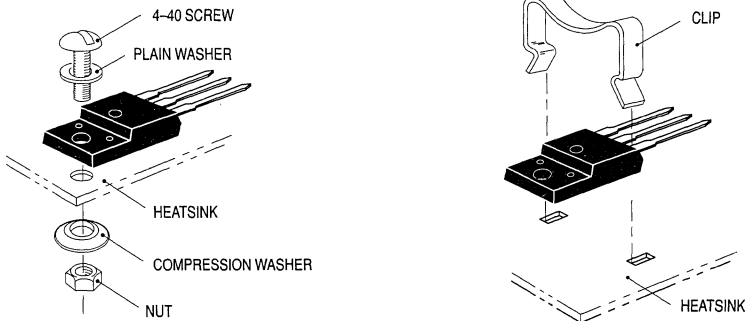
**Figure 6. Clip Mounting Position for Isolation Test Number 2**

**Figure 7. Screw Mounting Position for Isolation Test Number 3**

\* Measurement made between leads and heatsink with all leads shorted together.

3

## MOUNTING INFORMATION\*\*



**8a. Screw-Mounted**

**8b. Clip-Mounted**

**Figure 8. Typical Mounting Techniques**

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in · lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in · lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, Motorola does not recommend exceeding 10 in · lbs of mounting torque under any mounting conditions.

\*\*For more information about mounting power semiconductors see Application Note AN1040.

# SWITCHMODE™ Schottky Power Rectifiers

**MBRF2060CT**

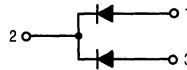
Motorola Preferred Device

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

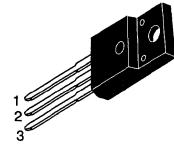
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2060



**SCHOTTKY BARRIER  
RECTIFIERS  
20 AMPERES  
60 VOLTS**



**CASE 221D-02  
ISOLATED TO-220**

### MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> ), T <sub>C</sub> = 133°C	I <sub>F(AV)</sub>	10 20	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 133°C	I <sub>FRM</sub>	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	150	Amps
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	0.5	Amp
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10000	V/μs
RMS Isolation Voltage (t = 1.0 second, R.H. ≤ 30%, T <sub>A</sub> = 25°C)(2)	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub>	4500 3500 1500	Volts

### THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	4.0	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T <sub>L</sub>	260	°C

- (1) UL Recognized mounting method is per Figure 4.  
(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRF2060CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ( $I_F = 10 \text{ Amp}$ , $T_C = 25^\circ\text{C}$ ) ( $I_F = 10 \text{ Amp}$ , $T_C = 125^\circ\text{C}$ ) ( $I_F = 20 \text{ Amp}$ , $T_C = 25^\circ\text{C}$ ) ( $I_F = 20 \text{ Amp}$ , $T_C = 125^\circ\text{C}$ )	$V_F$	0.85 0.75 0.95 0.85	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 125^\circ\text{C}$ )	$I_R$	0.15 150	mA

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\geq 2.0\%$

3

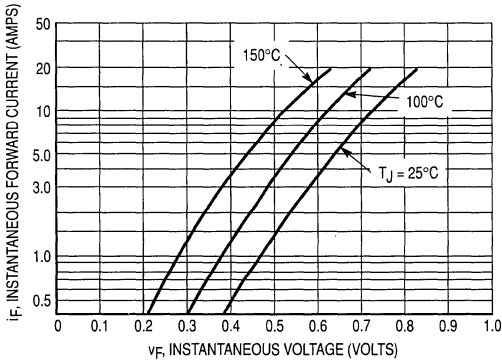


Figure 1. Typical Forward Voltage Per Diode

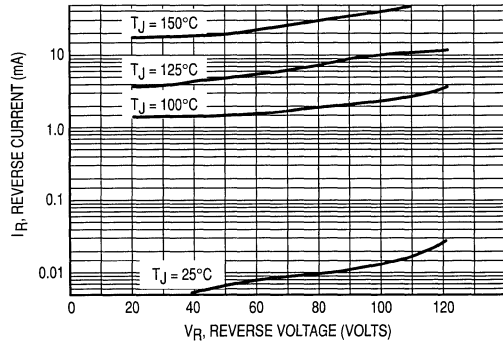
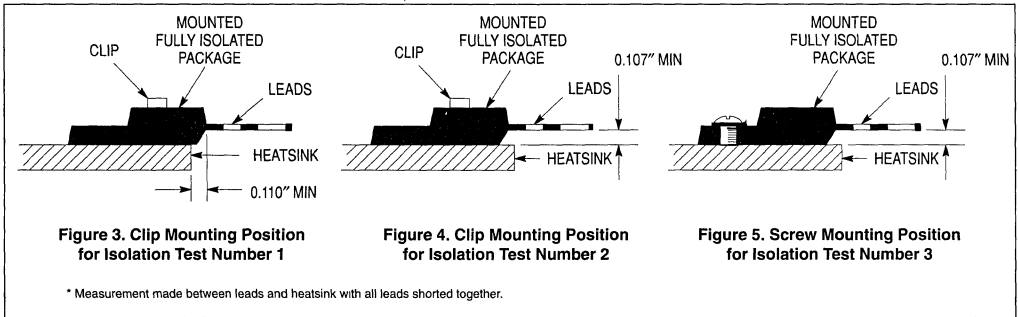


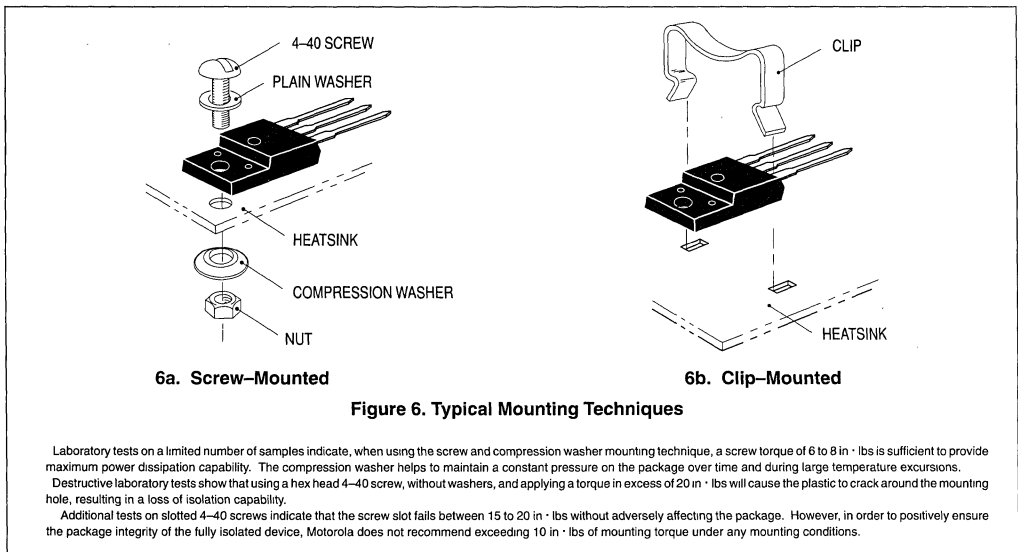
Figure 2. Typical Reverse Current Per Diode

# MBRF2060CT

## TEST CONDITIONS FOR ISOLATION TESTS\*



## MOUNTING INFORMATION\*\*



\*\*For more information about mounting power semiconductors see Application Note AN1040

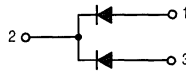
# SWITCHMODE™ Schottky Power Rectifiers

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

### Mechanical Characteristics

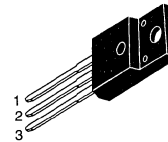
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20100



**MBRF20100CT**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIERS  
20 AMPERES  
100 VOLTS**



**CASE 221D-02  
ISOLATED TO-220**

3

### MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	100	Volts
Average Rectified Forward Current (Rated $V_R$ ), $T_C = 133^\circ\text{C}$ Total Device	$I_{F(AV)}$	10 20	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 133^\circ\text{C}$	$I_{FRM}$	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	0.5	Amp
Operating Junction and Storage Temperature	$T_J, T_{stg}$	- 65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000	V/ $\mu\text{s}$
RMS Isolation Voltage ( $t = 1.0$ second, R.H. $\leq 30\%$ , $T_A = 25^\circ\text{C}$ )(2)	Per Figure 3 Per Figure 4(1) Per Figure 5 $V_{iso1}$ $V_{iso2}$ $V_{iso3}$	4500 3500 1500	Volts

### THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance — Junction to Case	$R_{\theta JC}$	3.5	$^\circ\text{C/W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	$T_L$	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRF20100CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 10$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 10$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 20$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 20$ Amp, $T_C = 125^\circ\text{C}$ )	$V_F$	0.85 0.75 0.95 0.85	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 125^\circ\text{C}$ )	$I_R$	0.15 150	mA

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\geq 2\%$ .

3

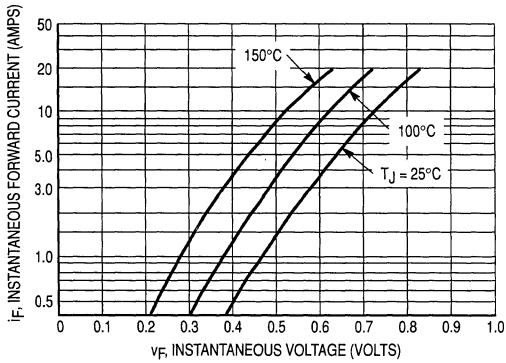


Figure 1. Typical Forward Voltage Per Diode

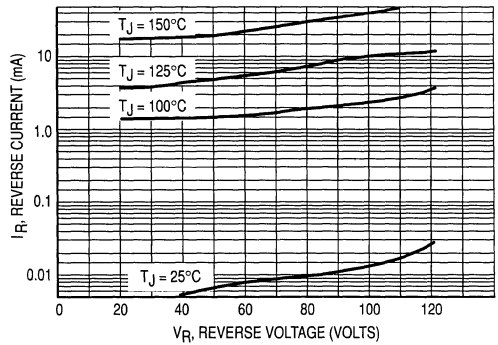
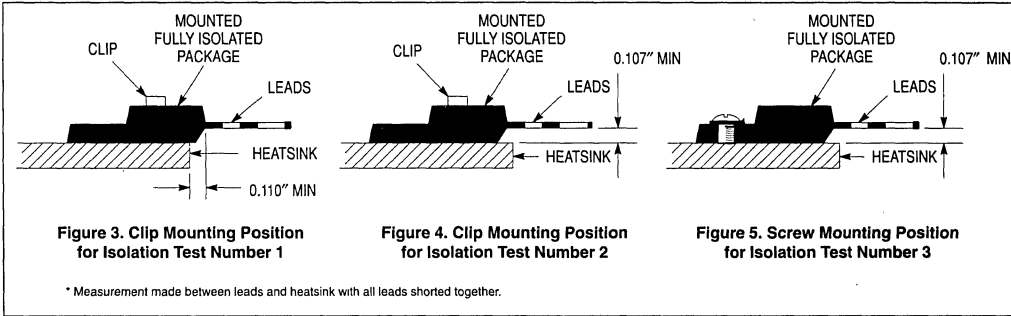


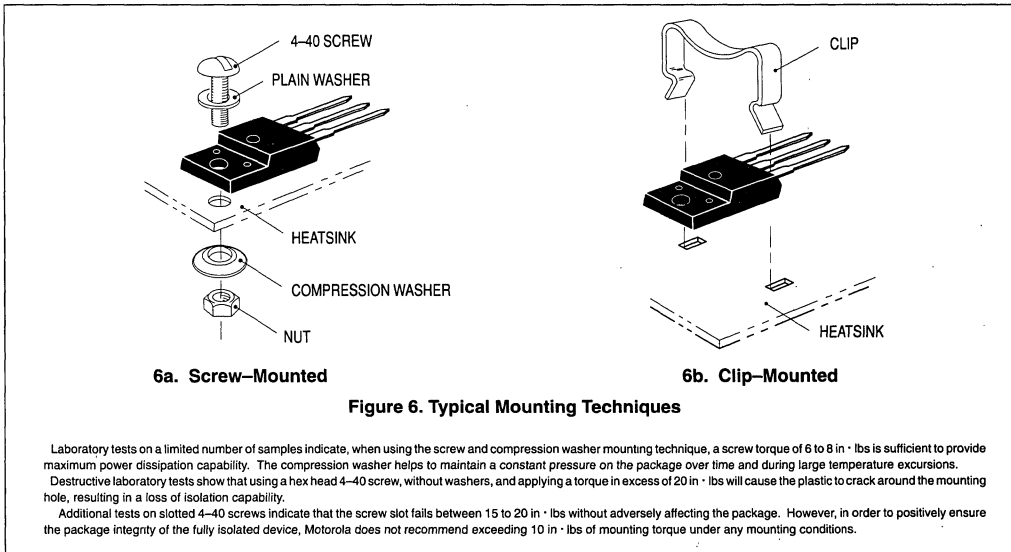
Figure 2. Typical Reverse Current Per Diode

# MBRF20100CT



3

## MOUNTING INFORMATION\*\*



\*\*For more information about mounting power semiconductors see Application Note AN1040.



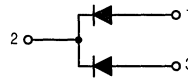
# SWITCHMODE™ Schottky Power Rectifiers

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369

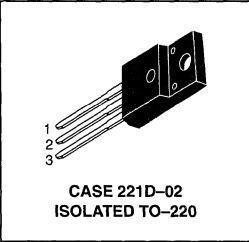
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20200



**MBRF2020CT**  
Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
20 AMPERES  
150 and 200 VOLTS**



### MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	Volts
Average Rectified Forward Current (Rated $V_F$ ) $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	10 20	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_F$ , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	$I_{FRM}$	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	Amp
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_F$ )	dv/dt	10,000	V/ $\mu\text{s}$

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRF20200CT

## THERMAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Case	$R_{\theta JC}$	3.5	$^{\circ}C/W$

## ELECTRICAL CHARACTERISTICS, PER LEG

Maximum Instantaneous Forward Voltage (1) ( $I_F = 10$ Amp, $T_C = 25^{\circ}C$ ) ( $I_F = 10$ Amp, $T_C = 125^{\circ}C$ ) ( $I_F = 20$ Amp, $T_C = 25^{\circ}C$ ) ( $I_F = 20$ Amp, $T_C = 125^{\circ}C$ )	$V_F$	0.9 0.8 1.0 0.9	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 25^{\circ}C$ ) (Rated dc Voltage, $T_C = 125^{\circ}C$ )	$I_R$	1.0 50	mA

## DYNAMIC CHARACTERISTICS, PER LEG

Capacitance ( $V_R = -5.0$ V, $T_C = 25^{\circ}C$ , Freq. = 1.0 MHz)	$C_T$	500	pF
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(1) Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2%

3

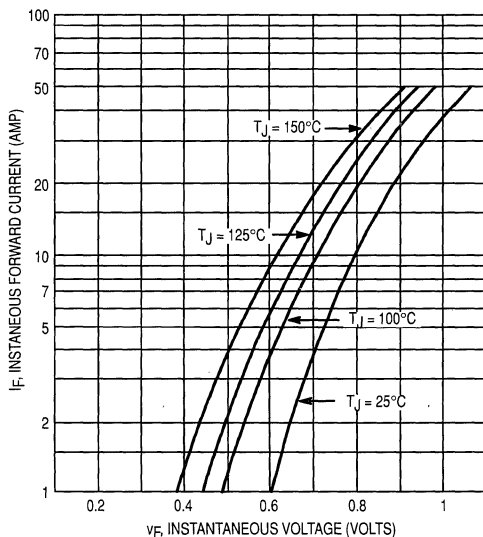


Figure 1. Typical Forward Voltage (Per Leg)

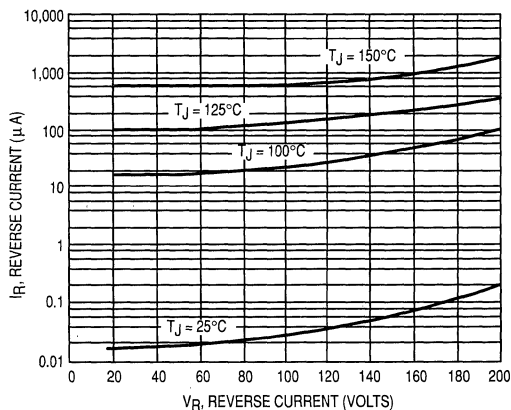
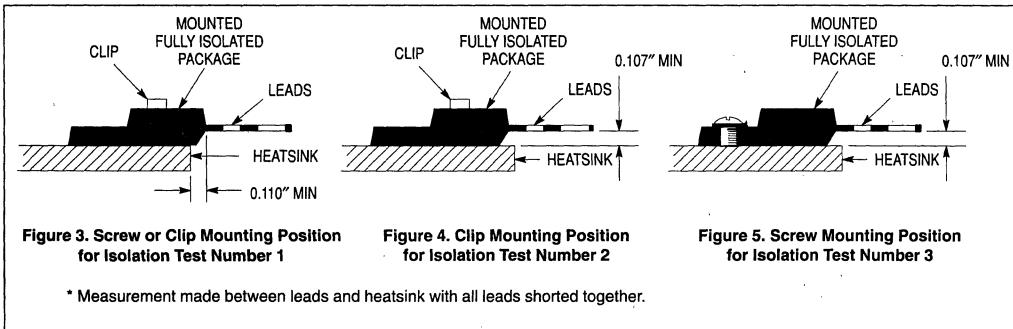
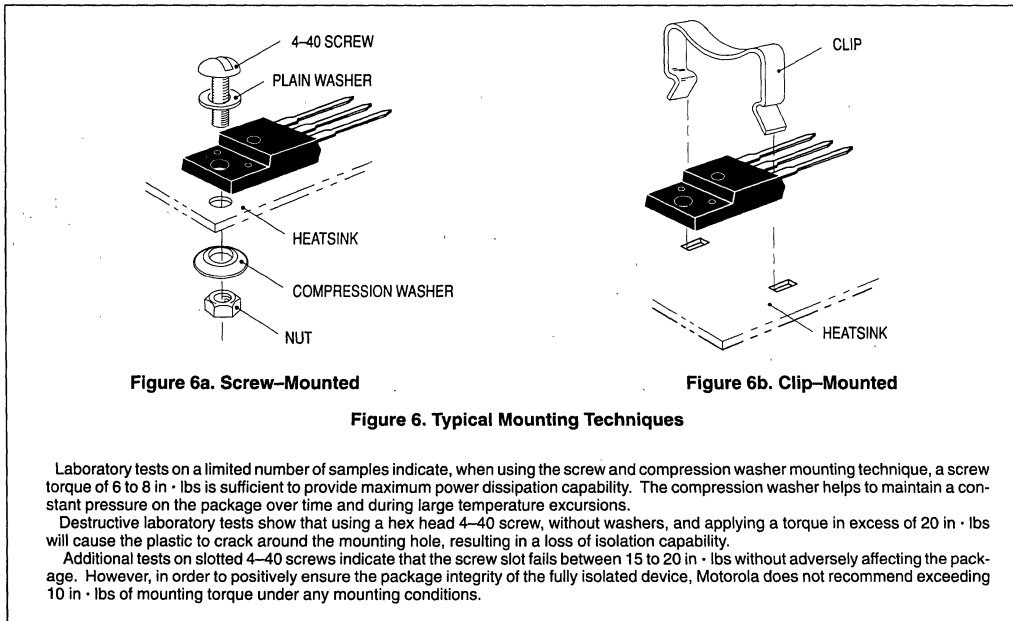


Figure 2. Typical Reverse Current (Per Leg)

TEST CONDITIONS FOR ISOLATION TESTS\*



MOUNTING INFORMATION\*\*



\*\*For more information about mounting power semiconductors see Application Note AN1040.

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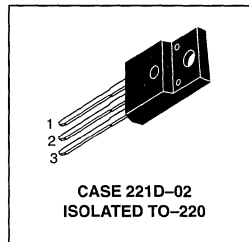
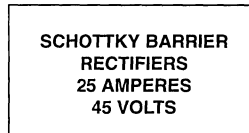
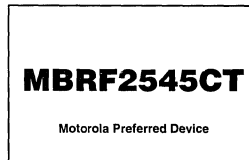
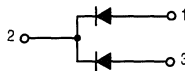
# SWITCHMODE™ Schottky Power Rectifiers

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V<sub>0</sub> at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2545



3

### MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	Volts	
Average Rectified Forward Current (Rated V <sub>R</sub> ), T <sub>C</sub> = 125°C	I <sub>F(AV)</sub>	12.5 25	Amps	
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 125°C	I <sub>FRM</sub>	25	Amps	
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	150	Amps	
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	Amp	
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C	
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10000	V/μs	
RMS Isolation Voltage (t = 1.0 second, R.H. ≤ 30%, T <sub>A</sub> = 25°C)(2)	Per Figure 3 Per Figure 4(1) Per Figure 5	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub>	4500 3500 1500	Volts

### THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	3.5	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T <sub>L</sub>	260	°C

(1) UL recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRF2545CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 12.5$ Amps, $T_C = 25^\circ\text{C}$ ) ( $i_F = 12.5$ Amps, $T_C = 125^\circ\text{C}$ )	$v_F$	0.7 0.62	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	0.2 40	mA

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

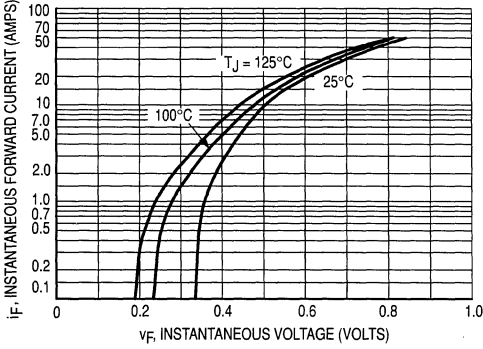


Figure 1. Typical Forward Voltage, Per Leg

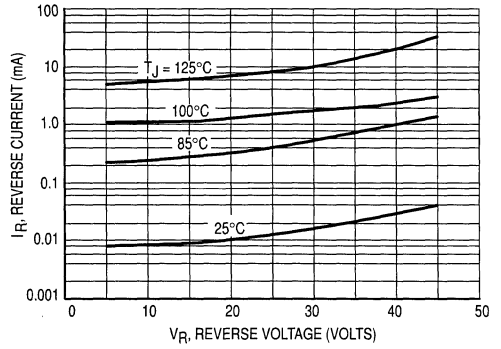
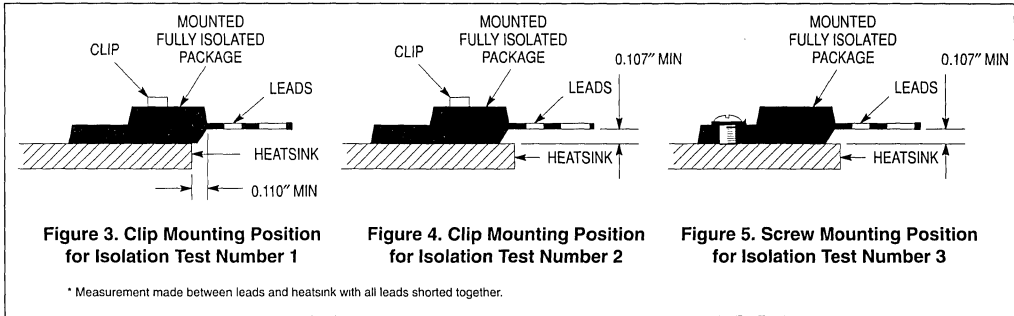


Figure 2. Typical Reverse Current, Per Leg

3

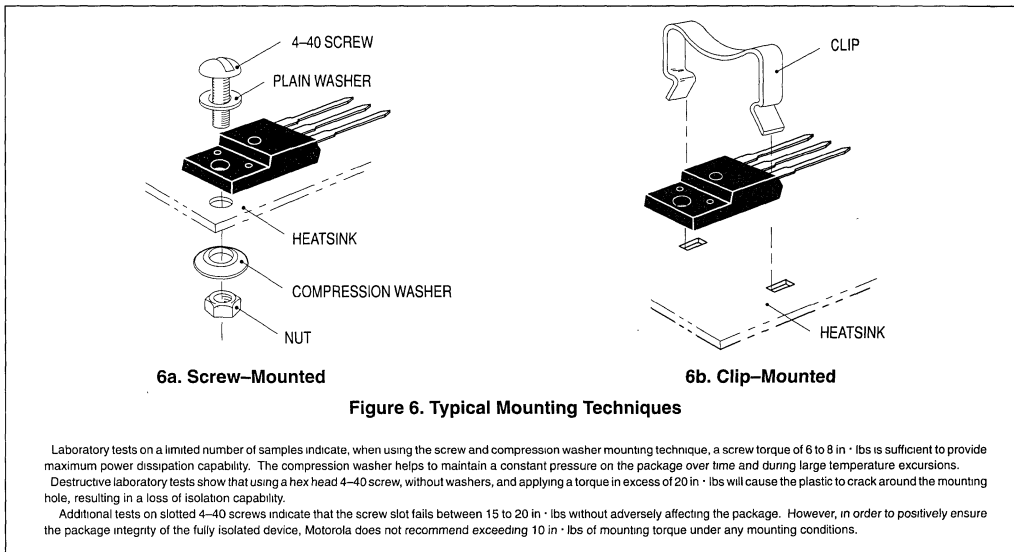
# MBRF2545CT

## TEST CONDITIONS FOR ISOLATION TESTS\*



3

## MOUNTING INFORMATION\*\*



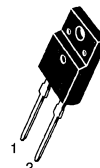
\*\*For more information about mounting power semiconductors see Application Note AN1040.

# SWITCHMODE™ Schottky Power Rectifiers

**MBRF745**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIERS  
7.5 AMPERES  
45 VOLTS**



CASE 221E-01  
ISOLATED TO-220

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B745



### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	Volts
Average Rectified Forward Current (Rated $V_R$ ), $T_C = 105^\circ\text{C}$	$I_{F(AV)}$	7.5	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 105^\circ\text{C}$	$I_{FRM}$	15	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	1.0	Amp
Operating Junction and Storage Temperature	$T_J, T_{stg}$	- 65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000	V/ $\mu\text{s}$
RMS Isolation Voltage (t = 1 second, R.H. $\leq$ 30%, $T_A = 25^\circ\text{C}$ )(2)	Per Figure 3 $V_{iso1}$ Per Figure 4(1) $V_{iso2}$ Per Figure 5 $V_{iso3}$	4500 3500 1500	Volts

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.2	$^\circ\text{C/W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	$T_L$	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MBRF745

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 15$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 15$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 7.5$ Amp, $T_C = 125^\circ\text{C}$ )	$V_F$	0.84 0.72 0.57	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	0.1 15	mA

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

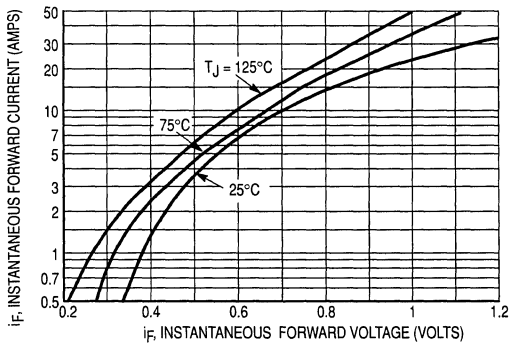


Figure 1. Typical Forward Voltage

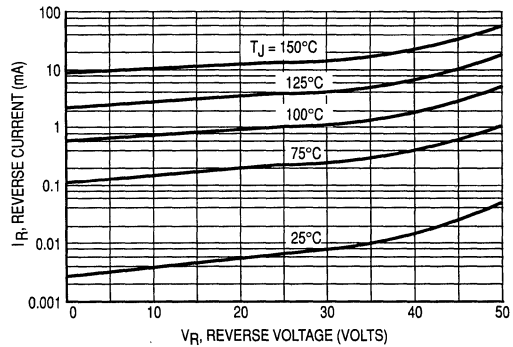
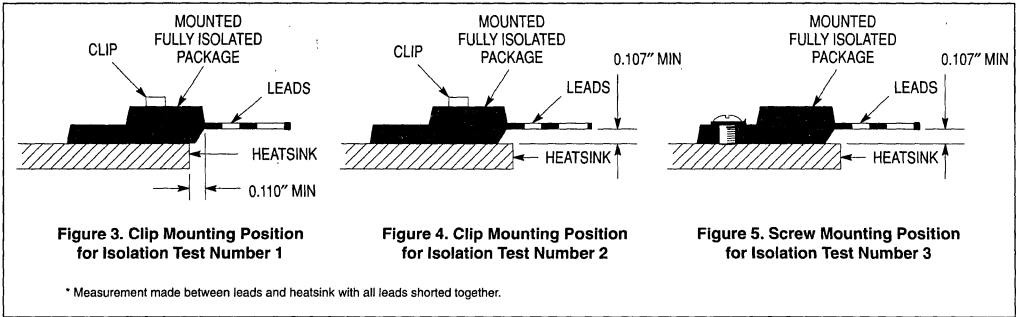


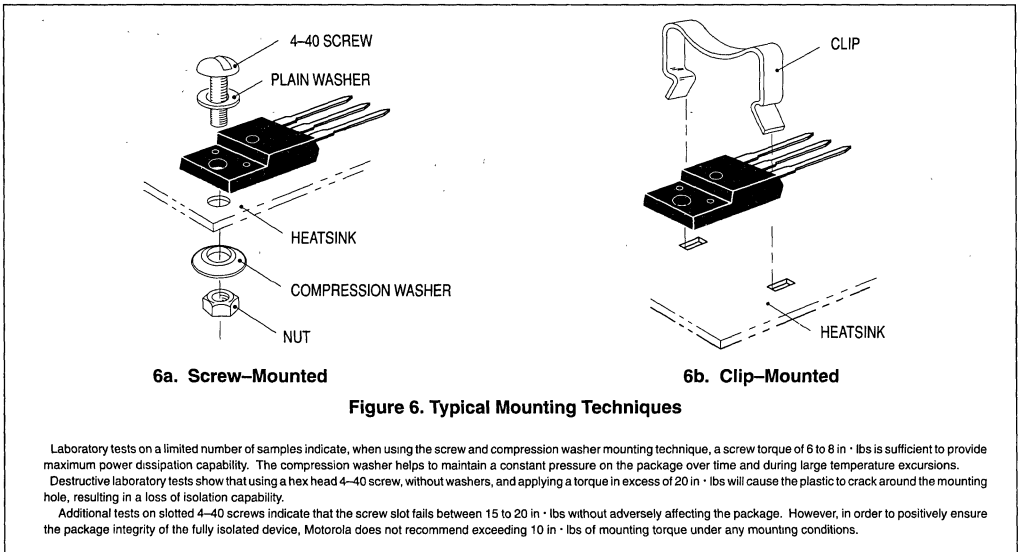
Figure 2. Typical Reverse Current

3





**MOUNTING INFORMATION\*\***



\*\*For more information about mounting power semiconductors see Application Note AN1040.

# SWITCHMODE™ Schottky Power Rectifiers

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

### Mechanical Characteristics

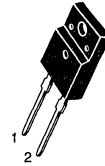
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1045



**MBRF1045**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIERS  
10 AMPERES  
45 VOLTS**



**CASE 221E-01  
ISOLATED TO-220**

3

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	Volts
Average Rectified Forward Current (Rated $V_R$ ), $T_C = 135^\circ\text{C}$	$I_{F(AV)}$	10	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 135^\circ\text{C}$	$I_{FRM}$	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	150	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz) Figure 6	$I_{RRM}$	1.0	Amp
Operating Junction and Storage Temperature	$T_J, T_{stg}$	- 65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000	V/ $\mu\text{s}$
RMS Isolation Voltage (t = 1 second, R.H. $\leq$ 30%, $T_A = 25^\circ\text{C}$ )(2)	Per Figure 8 Per Figure 9(1) Per Figure 10	$V_{iso1}$ $V_{iso2}$ $V_{iso3}$	4500 3500 1500 Volts

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.0	$^\circ\text{C}/\text{W}$
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	$T_L$	260	$^\circ\text{C}$

(1) UL Recognized mounting method is per Figure 9.

(2) Proper strike and creepage distance must be provided.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

**ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 20$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 10$ Amp, $T_C = 125^\circ\text{C}$ )	$V_F$	0.84 0.72 0.57	Volts
Maximum Instantaneous Reverse Current (3) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	0.1 15	mA

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

3

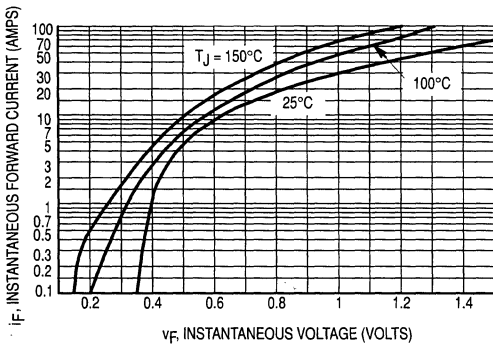


Figure 1. Maximum Forward Voltage

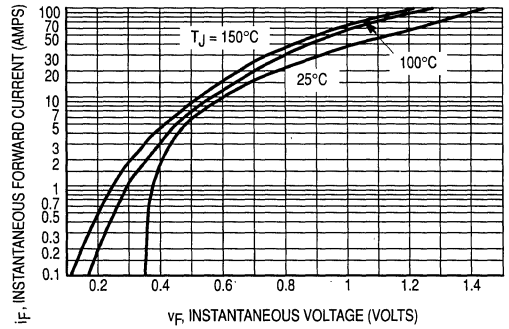


Figure 2. Typical Forward Voltage

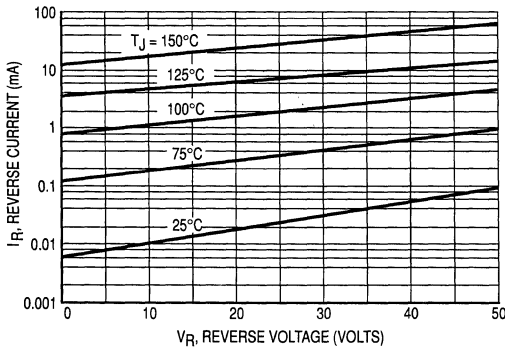


Figure 3. Maximum Reverse Current

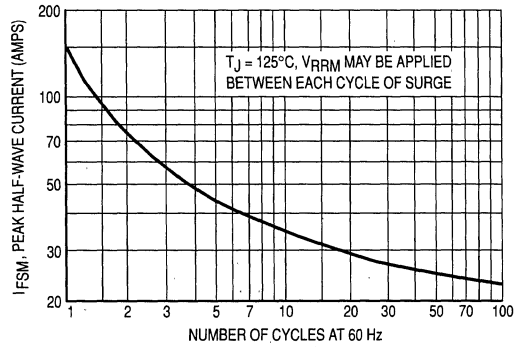


Figure 4. Maximum Surge Capability

# MBRF1045

## HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 5.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

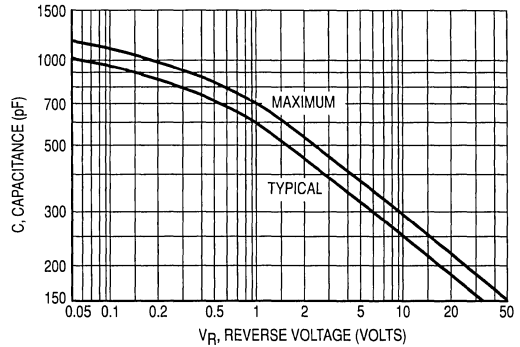


Figure 5. Capacitance

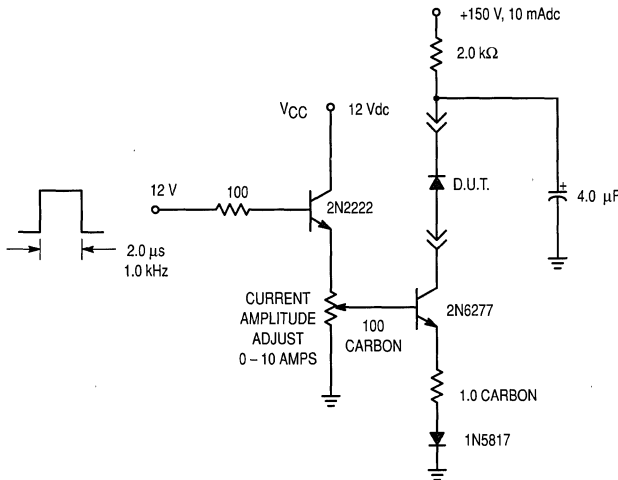
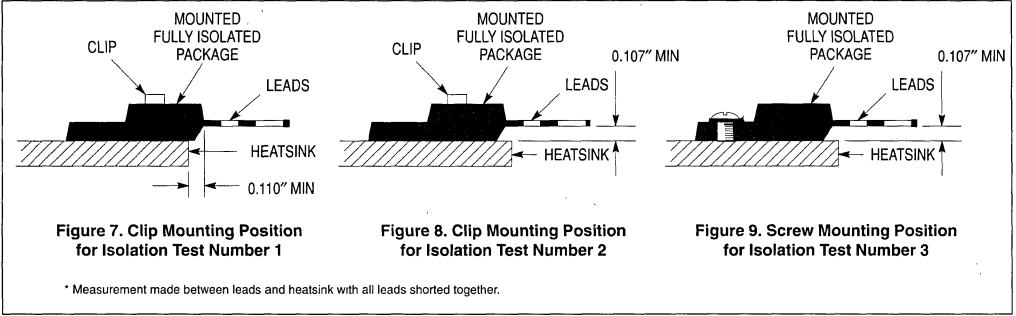


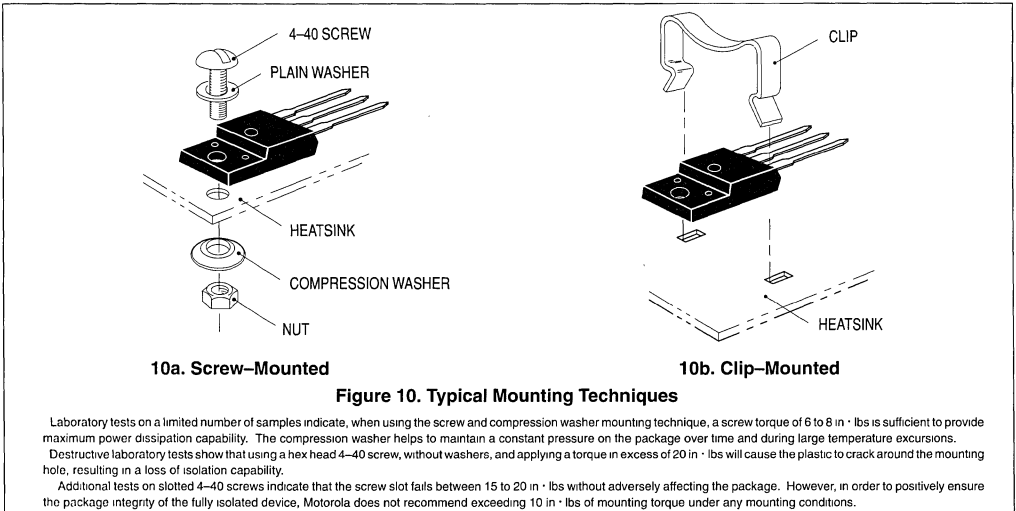
Figure 6. Test Circuit for  $dv/dt$  and Reverse Surge Current

TEST CONDITIONS FOR ISOLATION TESTS\*



3

MOUNTING INFORMATION\*\*



MBR3045PT is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected For Parallel Operation At Full Rating
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

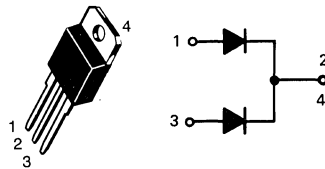
### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B3035, B3045

### SCHOTTKY BARRIER RECTIFIERS

**30 AMPERES**  
**35 to 45 VOLTS**

3



CASE 340D-01

### RATINGS

Rating	Symbol	Maximum	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	35	Volts
Working Peak Reverse Voltage	$V_{RWM}$	45	
DC Blocking Voltage	$V_R$		
Average Rectified Forward Current (Rated $V_R$ , $T_C = 105^\circ\text{C}$ )	$I_{F(AV)}$	30 15	Amps
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz)	$I_{FRM}$	30	Amps
Nonrepetitive Peak Surge Current (Surge Applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	200	Amps
Peak Repetitive Reverse Current, Per Diode (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 6	$I_{RRM}$	2.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS PER DIODE

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	40	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) ( $I_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 30$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 30$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.60 0.72 0.76	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	100 1.0	mA

(1) Pulse Test Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 2

FIGURE 1 — TYPICAL FORWARD VOLTAGE

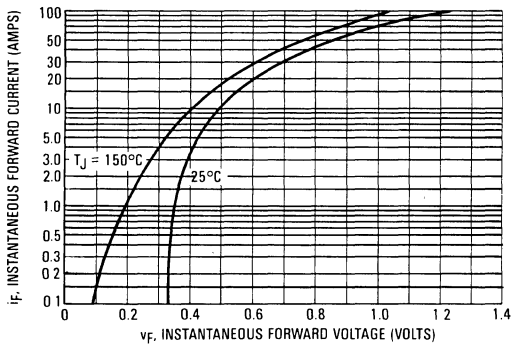


FIGURE 2 — TYPICAL REVERSE CURRENT

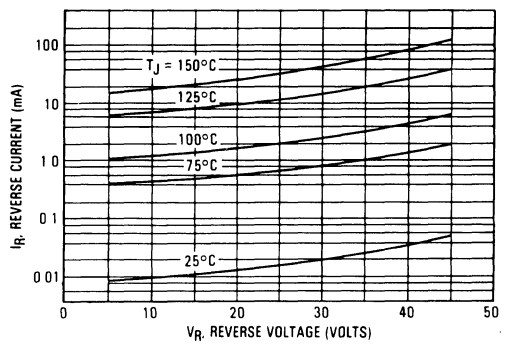


FIGURE 3 — CURRENT DERATING PER LEG

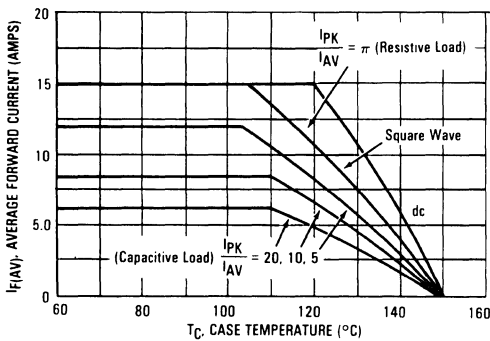


FIGURE 4 — FORWARD POWER DISSIPATION PER LEG

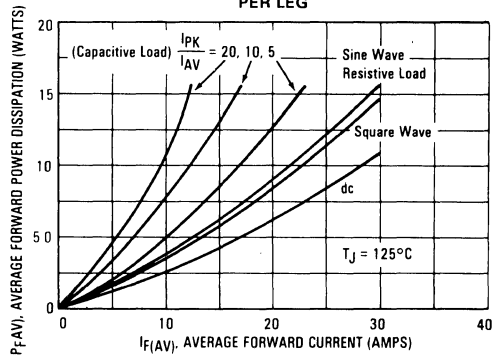


FIGURE 5 — CAPACITANCE

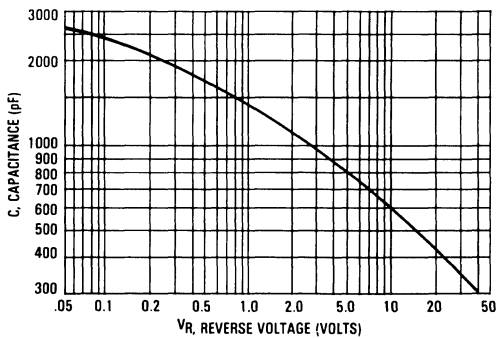
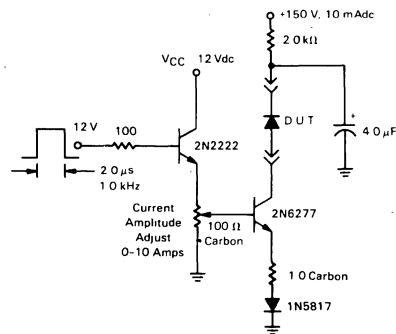


FIGURE 6 — TEST CIRCUIT FOR REPETITIVE REVERSE CURRENT



**SWITCHMODE  
Power Rectifier**

**MBR4045PT**

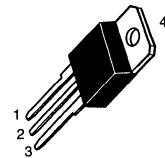
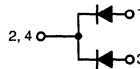
**SCHOTTKY BARRIER  
RECTIFIER  
40 AMPERES  
45 VOLTS**

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — Terminals 1 and 3 may be connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B4045



CASE 340D-01

**3**

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWV}$ $V_R$	45	Volt
Average Rectified Forward Current (Rated $V_R$ ) @ $T_C = 125^\circ\text{C}$	$I_{F(AV)}$ Total Device	20 40	Amp
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	$I_{FRM}$	40	Amp
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	400	Amp
Peak Repetitive Reverse Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	Amp
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ $\mu\text{s}$

**THERMAL CHARACTERISTICS, PER LEG**

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C/W}$
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**ELECTRICAL CHARACTERISTICS, PER LEG**

Instantaneous Forward Voltage (1) ( $i_F = 20$ Amps, $T_C = 25^\circ\text{C}$ ) ( $i_F = 20$ Amps, $T_C = 125^\circ\text{C}$ ) ( $i_F = 40$ Amps, $T_C = 25^\circ\text{C}$ ) ( $i_F = 40$ Amps, $T_C = 125^\circ\text{C}$ )	$v_F$	0.70 0.60 0.80 0.75	Volts
Instantaneous Reverse Current (1) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 100^\circ\text{C}$ )	$i_R$	1.0 50	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

Rev 2



# MBR4045PT

3

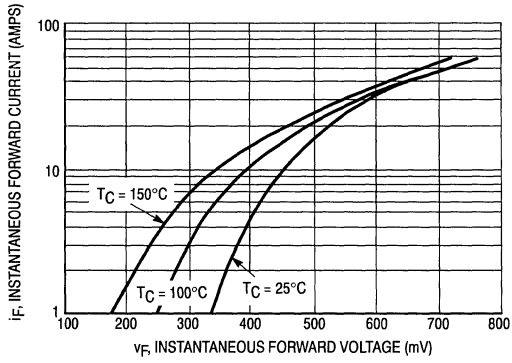


Figure 1. Typical Forward Voltage

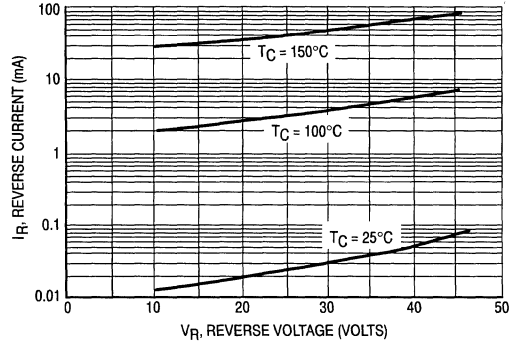


Figure 2. Typical Reverse Current

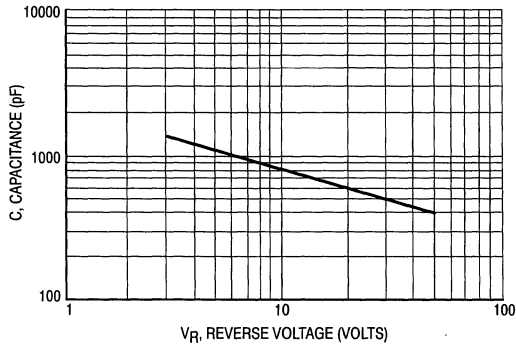


Figure 3. Typical Capacitance Per Leg

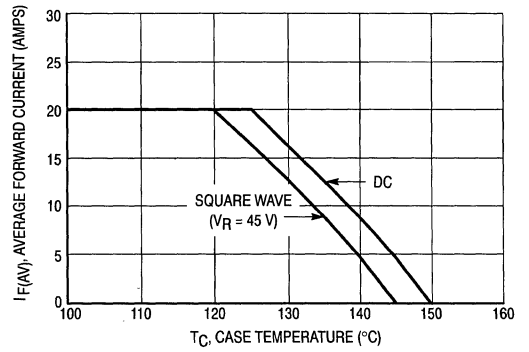


Figure 4. Current Derating Per Leg

**SWITCHMODE**  
**Power Rectifier**

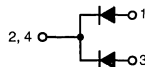
**MBR6045PT**

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

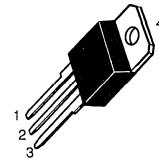
- Dual Diode Construction — Terminals 1 and 3 may be connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B6045



**SCHOTTKY BARRIER**  
**RECTIFIER**  
**60 AMPERES**  
**45 VOLTS**



CASE 340D-01

**3**

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWV}$ $V_R$	45	Volt
Average Rectified Forward Current (Rated $V_R$ ) @ $T_C = 125^\circ\text{C}$	$I_{F(AV)}$	30 60	Amp
Total Device			
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	$I_{FRM}$	60	Amp
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	500	Amp
Peak Repetitive Reverse Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	Amp
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ $\mu\text{s}$

**THERMAL CHARACTERISTICS, PER LEG**

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C/W}$
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**ELECTRICAL CHARACTERISTICS, PER LEG**

Instantaneous Forward Voltage (1) ( $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 30$ Amps, $T_C = 125^\circ\text{C}$ ) ( $I_F = 60$ Amps, $T_C = 25^\circ\text{C}$ )	$V_F$	0.62 0.55 0.75	Volts
Instantaneous Reverse Current (1) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 100^\circ\text{C}$ )	$i_R$	1.0 50	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

# MBR6045PT

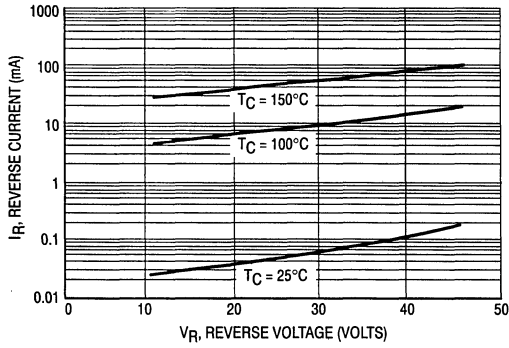


Figure 1. Typical Reverse Current

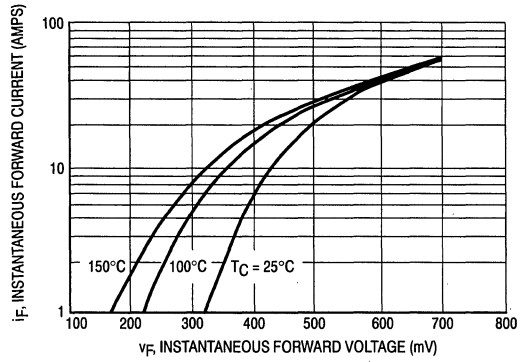


Figure 2. Typical Forward Voltage

# SWITCHMODE Power Rectifier

## MBR5025L

Motorola Preferred Device

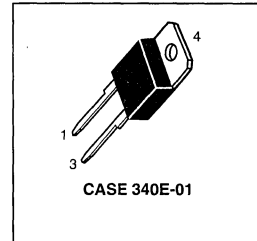
The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Very Low Forward Voltage Drop (Max 0.58 V @ 100°C)
- Guardring for Stress Protection and High dv/dt Capability (10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature
- Specially Designed for SWITCHMODE Power Supplies with Operating Frequency up to 300 kHz

**SCHOTTKY BARRIER  
RECTIFIER  
LOW  $v_F$   
50 AMPERES  
25 VOLTS**

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B5025L



3

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	25	Volts
Average Rectified Forward Current (Rated $V_F$ ) $T_C = 125^\circ\text{C}$	$I_F(AV)$	50	Amps
Peak Repetitive Forward Current (Rated $V_F$ , Square Wave, 20 kHz) $T_C = 90^\circ\text{C}$	$I_{FRM}$	150	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	300	Amps
Peak Repetitive Reverse Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ $\mu\text{s}$

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.75	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS

Instantaneous Forward Voltage (1) ( $I_F = 50$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 50$ Amps, $T_C = 100^\circ\text{C}$ ) ( $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$ )	$v_F$	0.62 0.58 0.54	Volts
Instantaneous Reverse Current (1) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 100^\circ\text{C}$ )	$i_R$	0.5 60	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value

3

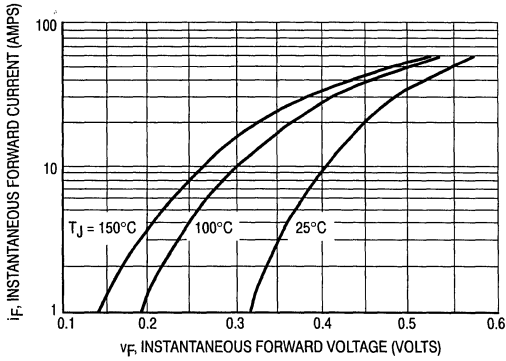


Figure 1. Typical Forward Voltage

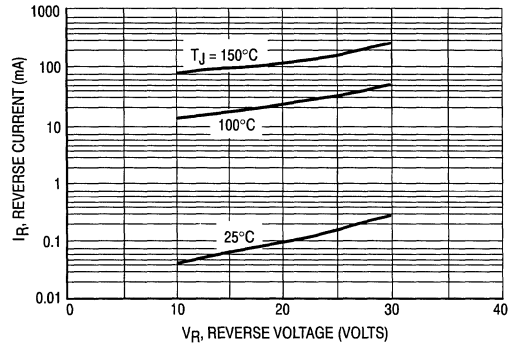


Figure 2. Typical Reverse Current

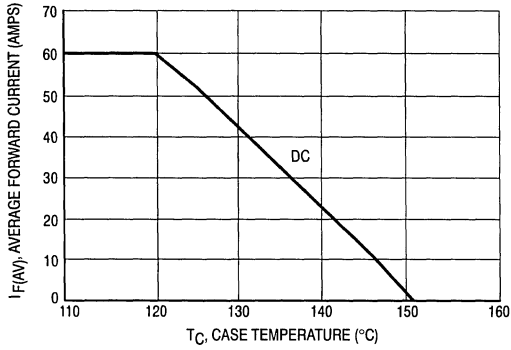


Figure 3. Current Derating, Case

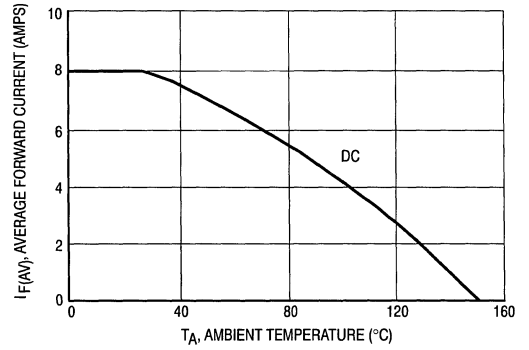


Figure 4. Current Derating, Ambient

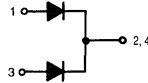
# Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected For Parallel Operation At Full Rating
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche
- Popular TO-247 Package

### Mechanical Characteristics:

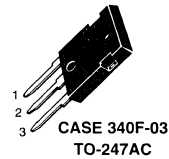
- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B3035, B3045



**MBR3035WT**  
**MBR3045WT**

MBR3045WT is a  
 Motorola Preferred Device

**SCHOTTKY BARRIER  
 RECTIFIERS**  
**30 AMPERES**  
**35-45 VOLTS**



**3**

### MAXIMUM RATINGS

Rating	Symbol	MBR		Unit
		3035WT	3045WT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWV}$ $V_R$	35	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 105^\circ\text{C}$	Per Device $I_{F(AV)}$ Per Diode	30	15	Amps
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz)	$I_{FRM}$	30		Amps
Nonrepetitive Peak Surge Current (Surge Applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	200		Amps
Peak Repetitive Reverse Current, Per Diode (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 6	$I_{RRM}$	2.0		Amps
Operating Junction Temperature	$T_J$	-65 to +150		$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175		$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175		$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000		$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS (Per Diode)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C}/\text{W}$
— Junction to Ambient	$R_{\theta JA}$	40	

### ELECTRICAL CHARACTERISTICS (Per Diode)

Instantaneous Forward Voltage (1) ( $I_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 30$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 30$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.6 0.72 0.76	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	100 1.0	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

# MBR3035WT, MBR3045WT

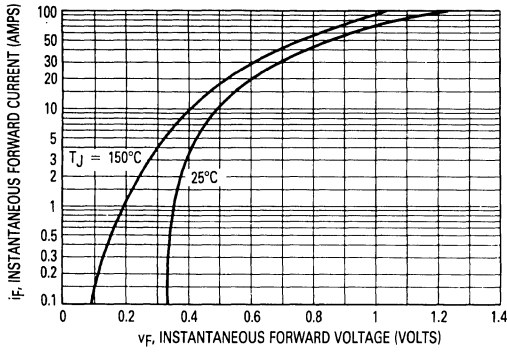


Figure 1. Typical Forward Voltage

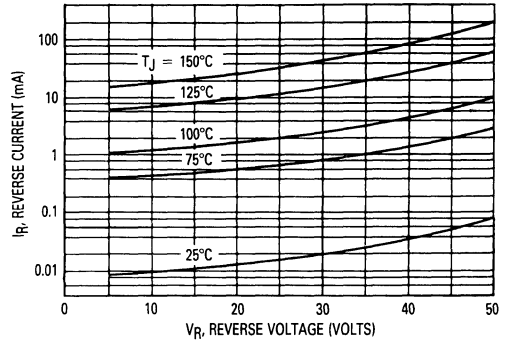


Figure 2. Typical Reverse Current

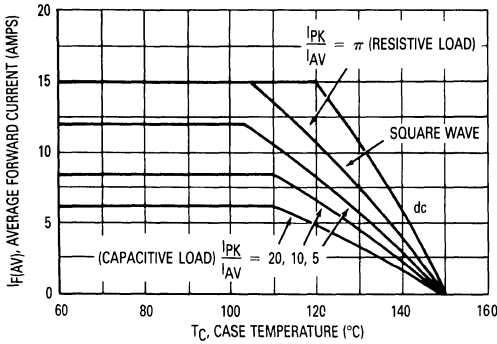


Figure 3. Current Derating (Per Leg)

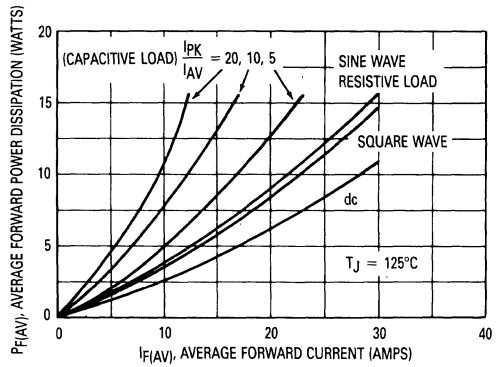


Figure 4. Forward Power Dissipation (Per Leg)

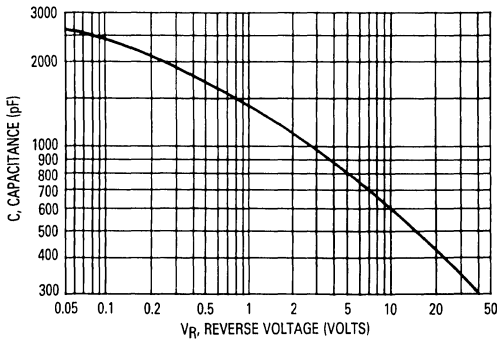


Figure 5. Capacitance

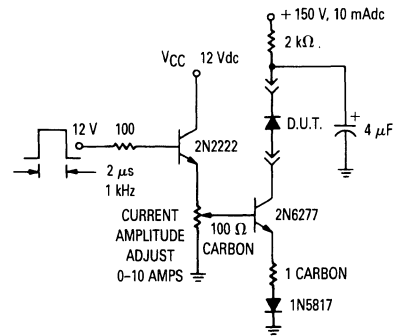


Figure 6. Test Circuit For Repetitive Reverse Current

3

## Advance Information

# SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle this state-of-the-art device is dedicated to the ORing function in paralleling power supply and has the following features:

- Dual Diode Construction — Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 15 Volt Blocking Voltage
- Very Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

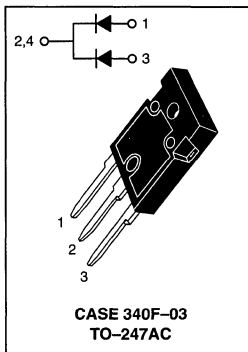
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: B4015L

## MBR4015LWT

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
40 AMPERES  
15 VOLTS**



3

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	15	Volt
Average Rectified Forward Current — Per Diode (Rated $V_R$ ) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	20 40	Amp
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	$I_{FRM}$	40	Amp
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	400	Amp
Peak Repetitive Reverse Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	Amp
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +150	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	150	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10000	V/ $\mu\text{s}$

### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JA}$	1.4 40	$^\circ\text{C}/\text{W}$
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Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1



# MBR4015LWT

## ELECTRICAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Instantaneous Forward Voltage (1) @ $I_F = 20$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 20$ Amps, $T_C = 125^\circ\text{C}$ @ $I_F = 40$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 40$ Amps, $T_C = 125^\circ\text{C}$	$V_F$	0.42 0.33 0.50 0.42	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 75^\circ\text{C}$	$I_R$	5.0 150	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle < 2.0%

# SWITCHMODE Schottky Power Rectifier

**MBR4045WT**

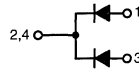
Motorola Preferred Device

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

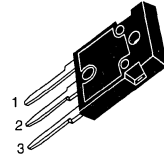
- Dual Diode Construction — Terminals 1 and 3 may be connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B4045



**SCHOTTKY BARRIER  
RECTIFIER  
40 AMPERES  
45 VOLTS**



**CASE 340F-03  
TO-247AC**

**3**

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	Volt
Average Rectified Forward Current (Rated $V_R$ ) @ $T_C = 125^\circ\text{C}$	$I_{F(AV)}$ Total Device	20 40	Amp
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	$I_{FRM}$	40	Amp
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	400	Amp
Peak Repetitive Reverse Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	Amp
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ $\mu\text{s}$

**THERMAL CHARACTERISTICS, PER LEG**

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C}/\text{W}$
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**ELECTRICAL CHARACTERISTICS, PER LEG**

Instantaneous Forward Voltage (1) ( $I_F = 20$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 20$ Amps, $T_C = 125^\circ\text{C}$ ) ( $I_F = 40$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 40$ Amps, $T_C = 125^\circ\text{C}$ )	$V_F$	0.70 0.60 0.80 0.75	Volts
Instantaneous Reverse Current (1) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 100^\circ\text{C}$ )	$I_R$	1.0 50	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

# MBR4045WT

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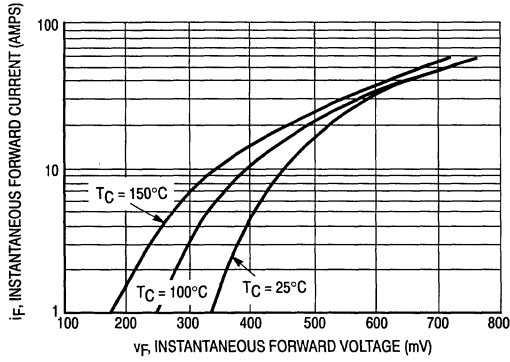


Figure 1. Typical Forward Voltage

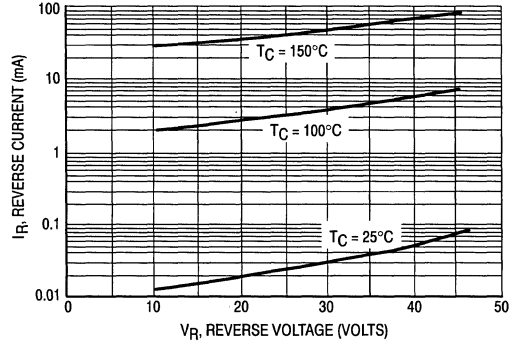


Figure 2. Typical Reverse Current

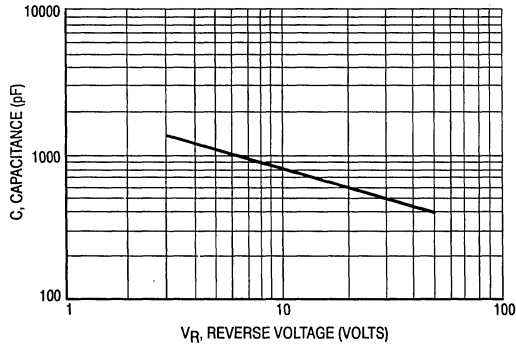


Figure 3. Typical Capacitance Per Leg

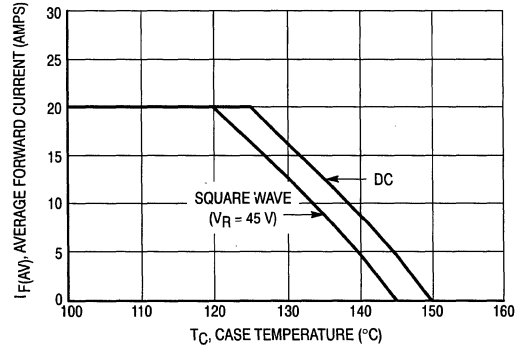


Figure 4. Current Derating Per Leg

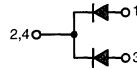
**SWITCHMODE  
Power Rectifier**

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — Terminals 1 and 3 may be connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- Guaranteed Reverse Avalanche
- 150°C Operating Junction Temperature

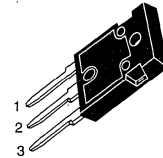
**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B6045



**MBR6045WT**

**SCHOTTKY BARRIER  
RECTIFIER  
60 AMPERES  
45 VOLTS**



**CASE 340F-03  
TO-247AC**

**3**

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	Volt
Average Rectified Forward Current (Rated $V_R$ ) @ $T_C = 125^\circ\text{C}$	$I_F(AV)$ Total Device	30 60	Amp
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	$I_{FRM}$	60	Amp
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	500	Amp
Peak Repetitive Reverse Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	Amp
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	$^\circ\text{C}$
Voltage Rate of Change	dv/dt	10,000	V/ $\mu\text{s}$

**THERMAL CHARACTERISTICS, PER LEG**

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C/W}$
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**ELECTRICAL CHARACTERISTICS, PER LEG**

Instantaneous Forward Voltage (1) ( $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 30$ Amps, $T_C = 125^\circ\text{C}$ ) ( $I_F = 60$ Amps, $T_C = 25^\circ\text{C}$ )	$V_F$	0.62 0.55 0.75	Volts
Instantaneous Reverse Current (1) (Rated DC Voltage, $T_C = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = 100^\circ\text{C}$ )	$i_R$	1.0 50	mA

(1) Pulse Test. Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

# MBR6045WT

3

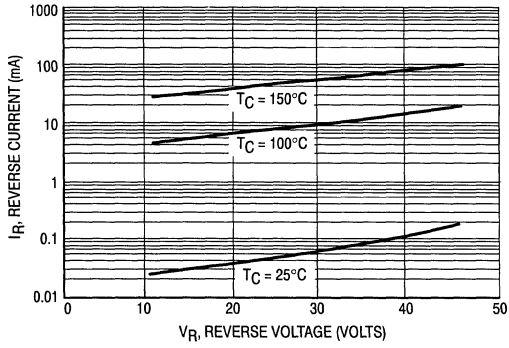


Figure 1. Typical Reverse Current

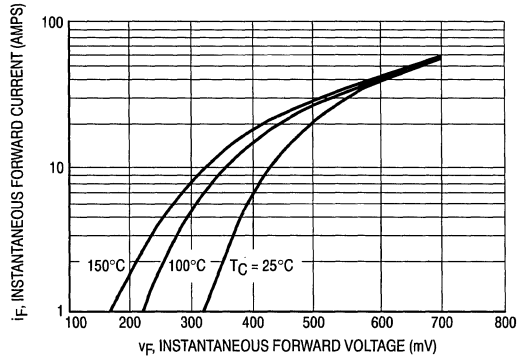


Figure 2. Typical Forward Voltage

1N5826 and 1N5828 are  
 Motorola Preferred Devices

*Designer's Data Sheet*  
**Power Rectifiers**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low  $v_F$
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- High Surge Capacity

**Mechanical Characteristics:**

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: 1N5826, 1N5827, 1N5828

Rating	Symbol	1N5826	1N5827	1N5828	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$				
Working Peak Reverse Voltage	$V_{RWM}$	20	30	40	Volts
DC Blocking Voltage	$V_R$				
Non-Repetitive Peak Reverse Voltage	$V_{RSM}$	24	36	48	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2 V_{R(dc)}, T_C = 85^\circ C$	$I_O$	← 15 →			Amp
Ambient Temperature Rated $V_{R(dc)}$ , $P_F(AV) = 0$ , $R_{\theta JA} = 5.0^\circ C/W$	$T_A$	95	90	85	$^\circ C$
Non-Repetitive Peak Surge Current (surge applied at rated load conditions, halfwave, single phase, 60 Hz)	$I_{FSM}$	← 500 (for 1 cycle) →			Amp
Operating and Storage Junction Temperature Range (Reverse voltage applied)	$T_J, T_{stg}$	← -65 to +125 →			$^\circ C$
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	← 150 →			$^\circ C$

**\*THERMAL CHARACTERISTICS**

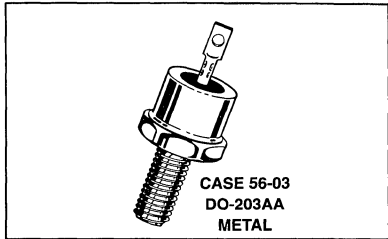
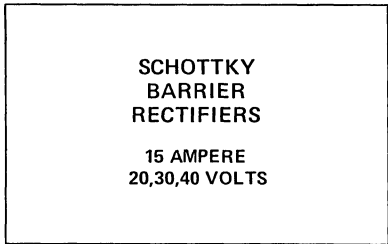
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.5	$^\circ C/W$

**\*ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ C$  unless otherwise noted.)

Characteristic	Symbol	1N5826	1N5827	1N5828	Unit
Maximum Instantaneous Forward Voltage (1)	$v_F$				Volts
( $i_F = 8.0$ Amp)		0.380	0.400	0.420	
( $i_F = 15$ Amp)		0.440	0.470	0.500	
( $i_F = 47.1$ Amp)		0.670	0.770	0.870	
Maximum Instantaneous Reverse Current @ rated dc Voltage (1)	$i_R$	10	10	10	mA
$T_C = 100^\circ C$		75	75	75	

\*Indicates JEDEC Registered Data.

(1) Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle = 2.0%.



## NOTE 1: DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.2  $V_{RWM}$ . Proper derating may be accomplished by use of equation (1):

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where

$T_{A(max)}$  = Maximum allowable ambient temperature

$T_{J(max)}$  = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest).

$P_{F(AV)}$  = Average forward power dissipation

$P_{R(AV)}$  = Average reverse power dissipation

$R_{\theta JA}$  = Junction-to-ambient thermal resistance

Figures 1, 2 and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_{J(max)} - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^\circ\text{C}$ , when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2 and

3 as a difference in the rate of change of the slope in the vicinity of  $115^\circ\text{C}$ . The data of Figures 1, 2 and 3 is based upon dc conditions. For use in common rectifier circuits, Table I indicates suggested factors for an equivalent dc voltage to use for conservative design; i.e.:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

Example: Find  $T_{A(max)}$  for 1N5828 operated in a 12-Volt dc supply using a bridge circuit with capacitive filter such that  $I_{DC} = 10 \text{ A}$  ( $I_{F(AV)} = 5 \text{ A}$ ),  $I_{(PK)}/I_{(AV)} = 20$ , Input Voltage = 10 V(rms),  $R_{\theta JA} = 5^\circ\text{C/W}$ .

Step 1: Find  $V_{R(equiv)}$ . Read F = 0.65 from Table I. ∴

$$V_{R(equiv)} = (1.41)(10)(0.65) = 9.18 \text{ V}$$

Step 2: Find  $T_R$  from Figure 3. Read  $T_R = 121^\circ\text{C}$  @  $V_R = 9.18$  &  $R_{\theta JA} = 5^\circ\text{C/W}$

Step 3: Find  $P_{F(AV)}$  from Figure 4. ∴ Read  $P_{F(AV)} = 10 \text{ W}$

$$\frac{I_{(PK)}}{I_{(AV)}} = 20 \text{ \& } I_{F(AV)} = 5 \text{ A}$$

Step 4: Find  $T_{A(max)}$  from equation (3).  $T_{A(max)} = 121 - (5)(10) = 71^\circ\text{C}$

\*\* Value given are for the 1N5828. Power is slightly lower for the other units because of their lower forward voltage.

TABLE I – VALUES FOR FACTOR F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped * †	
	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

\*Note that  $V_{R(PK)} \approx 2 V_{in(PK)}$

\*†Use line to center tap voltage for  $V_{in}$ .

FIGURE 1 – MAXIMUM REFERENCE TEMPERATURE – 1N5826

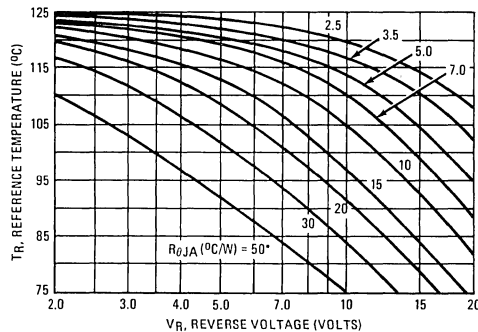


FIGURE 2 – MAXIMUM REFERENCE TEMPERATURE – 1N5827

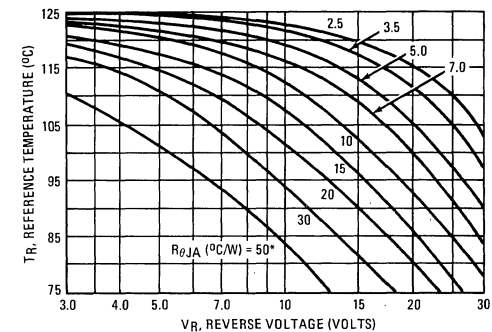


FIGURE 3 – MAXIMUM REFERENCE TEMPERATURE – 1N5828

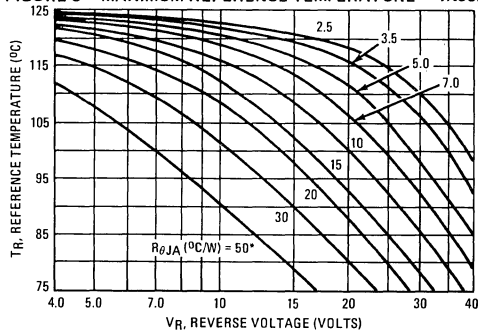
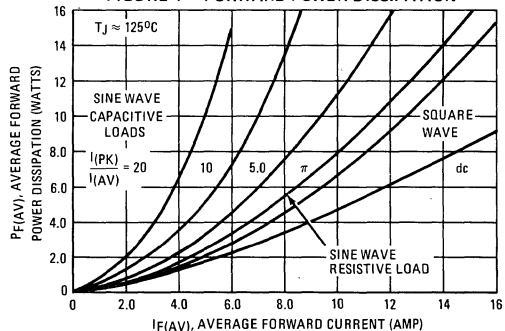


FIGURE 4 – FORWARD POWER DISSIPATION



\*No external heat sink.

FIGURE 5 – TYPICAL FORWARD VOLTAGE

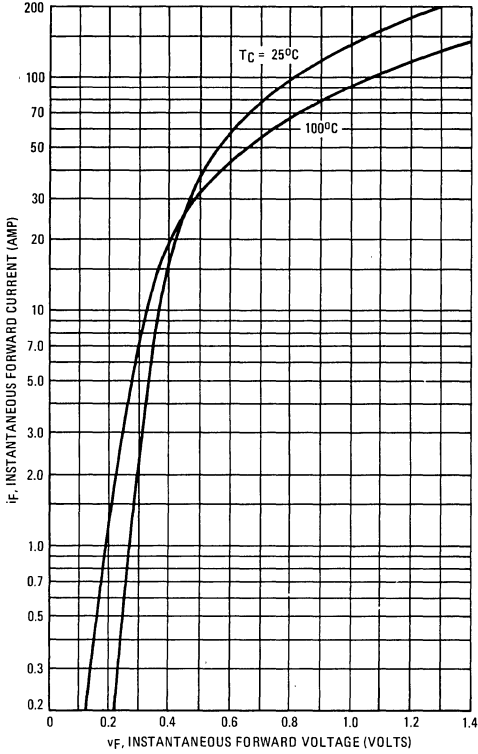


FIGURE 6 – MAXIMUM SURGE CAPABILITY

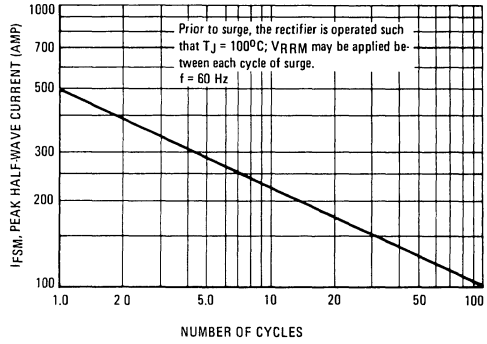


FIGURE 7 – CURRENT DERATING

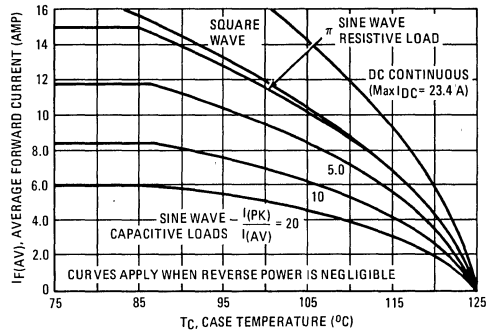
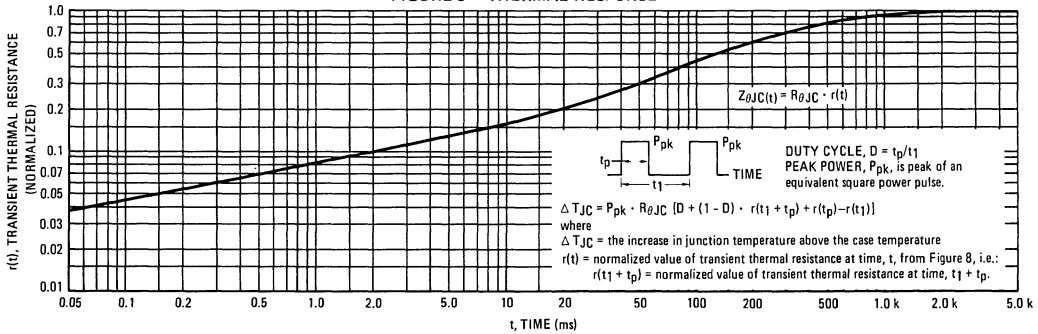


FIGURE 8 – THERMAL RESPONSE





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FIGURE 9 – NORMALIZED REVERSE CURRENT

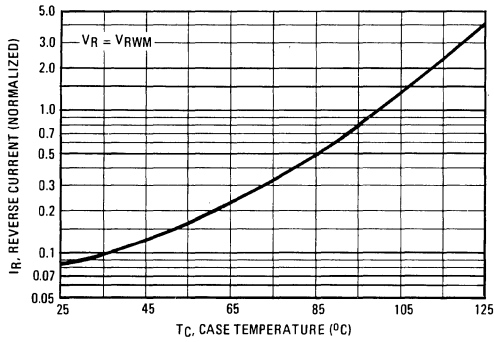


FIGURE 10 – TYPICAL REVERSE CURRENT

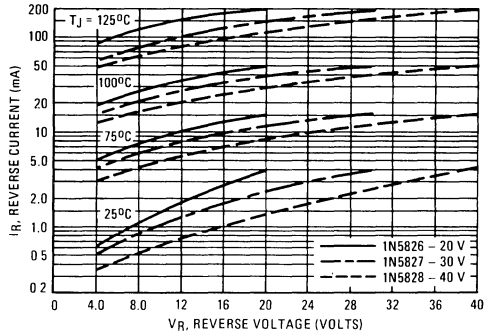
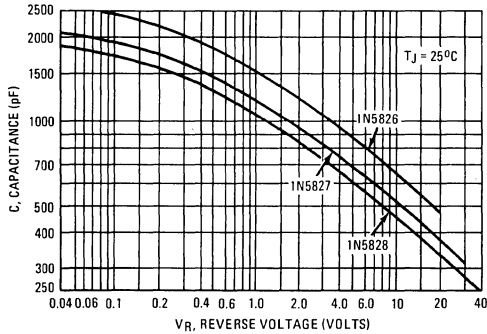


FIGURE 11 – CAPACITANCE



**NOTE 2 – HIGH FREQUENCY OPERATION**

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11).

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

## Designer's Data Sheet

# Switchmode Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low  $v_f$
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- High Surge Capacity

### Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: 1N5829, 1N5830, 1N5831

**1N5829**  
**1N5830**  
**1N5831**

1N5831 is a  
 Motorola Preferred Device

**25 AMPERE**  
**20, 30, 40 VOLTS**



CASE 56-03  
 DO-203AA  
 METAL

3

### MAXIMUM RATINGS

Rating	Symbol	*1N5829	*1N5830	*1N5831	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	30	40	Volts
Nonrepetitive Peak Reverse Voltage	$V_{RSM}$	24	36	48	Volts
Average Rectified Forward Current $V_{R(equiv)} \leq 0.2 V_{R(dc)}$ ; $T_C = 85^\circ C$	$I_O$	25			Amps
Ambient Temperature Rated $V_{R(dc)}$ ; $P_{F(AV)} = 0$ ; $R_{\theta JA} = 3.5^\circ C/W$	$T_A$	90	85	80	$^\circ C$
Nonrepetitive Peak Surge Current (surge applied at rated load conditions, halfwave, single phase, 60 Hz)	$I_{FSM}$	800 (for 1 cycle)			Amps
Operating and Storage Junction Temperature Range (Reverse voltage applied)	$T_J, T_{stg}$	-65 to +125			$^\circ C$
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	150			$^\circ C$

### THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.75	$^\circ C/W$

### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ C$ unless otherwise noted)

Characteristic	Symbol	*1N5829	*1N5830	*1N5831	Unit
Maximum Instantaneous Forward Voltage <sup>(1)</sup> ( $I_F = 10$ Amps) ( $I_F = 25$ Amps) ( $I_F = 78.5$ Amps)	$V_F$	0.360 0.440 0.720	0.370 0.460 0.770	0.380 0.480 0.820	Volts
Maximum Instantaneous Reverse Current @ Rated dc Voltage <sup>(1)</sup> ( $T_C = 100^\circ C$ )		20 150	20 150	20 150	mA

\*Indicates JEDEC Registered Data.

(1) Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle = 2%.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

**NOTE 1: DETERMINING MAXIMUM RATINGS**

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.2  $V_{RWM}$ . Proper derating may be accomplished by use of equation (1):

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where

$T_{A(max)}$  = Maximum allowable ambient temperature

$T_{J(max)}$  = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest).

$P_{F(AV)}$  = Average forward power dissipation

$P_{R(AV)}$  = Average reverse power dissipation

$R_{\theta JC}$  = Junction-to-ambient thermal resistance

Figures 1, 2 and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_{J(max)} - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^\circ\text{C}$ , when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2 and 3 as a difference in the rate of change of the slope in the vicinity of 115°C.

The data of Figures 1, 2 and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design; i.e.:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

Example: Find  $T_{A(max)}$  for 1N5831 operated in a 12-Volt dc supply using a bridge circuit with capacitive filter such that  $I_{DC} = 16 \text{ A}$  ( $I_{F(AV)} = 8 \text{ A}$ ),  $I_{(PK)}/I_{(AV)} = 20$ , Input Voltage = 10 V(rms),  $R_{\theta JA} = 5^\circ\text{C/W}$ .

Step 1: Find  $V_{R(equiv)}$ . Read  $F = 0.65$  from Table 1

$$V_{R(equiv)} = (1.41)(10)(0.65) = 9.18 \text{ V}$$

Step 2: Find  $T_R$  from Figure 3. Read  $T_R = 113^\circ\text{C}$  @  $V_R = 9.18$  &  $R_{\theta JA} = 5^\circ\text{C/W}$

Step 3: Find  $P_{F(AV)}$  from Figure 4.\*\* Read  $P_{F(AV)} = 12.8$

$$W @ \frac{I_{(PK)}}{I_{(AV)}} = 20 \text{ \& } I_{F(AV)} = 8 \text{ A}$$

Step 4: Find  $T_{A(max)}$  from equation (3).  $T_{A(max)} = 113 - (5)(12.8) = 49^\circ\text{C}$

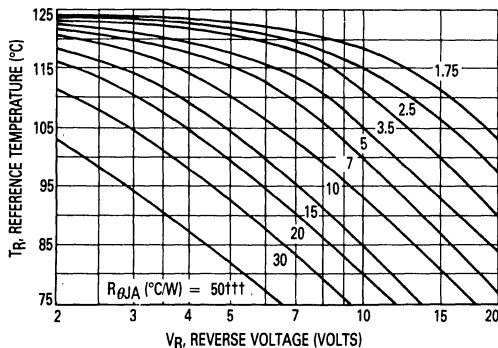
\*\*Value given are for the 1N5828. Power is slightly lower for the other units because of their lower forward voltage.

**Table 1. Values for Factor F**

Circuit Load	Half Wave		Full Wave, Bridge		Full Wave Center Tapped††	
	Resistive	Capacitive†	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

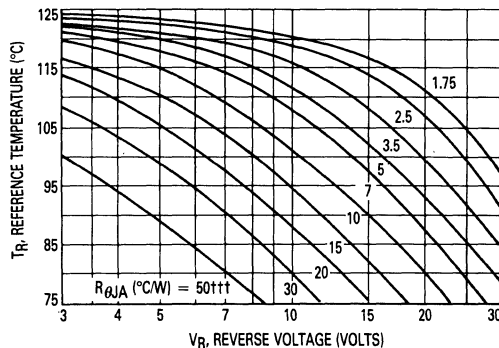
†Note that  $V_{R(PK)} \approx 2 V_{in(PK)}$

††Use line to center tape voltage for  $V_{in}$ .



**Figure 1. Maximum Reference Temperature — 1N5829**

†††NO EXTERNAL HEAT SINK



**Figure 2. Maximum Reference Temperature — 1N5830**

# 1N5829, 1N5830, 1N5831

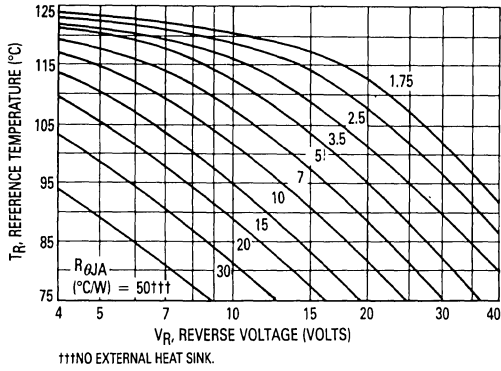


Figure 3. Maximum Reference Temperature — 1N5831

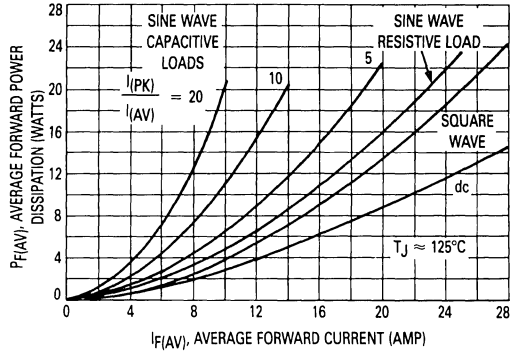


Figure 4. Forward Power Dissipation

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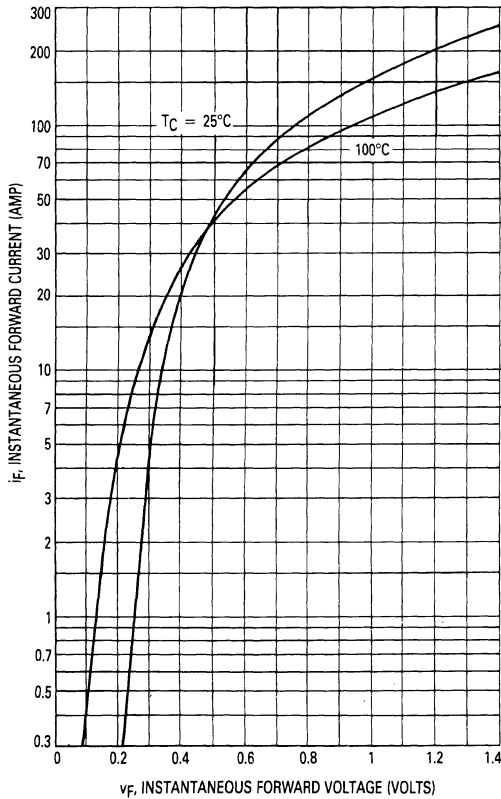


Figure 5. Typical Forward Voltage

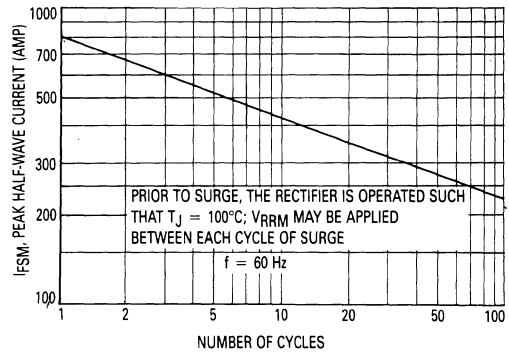


Figure 6. Maximum Surge Capability

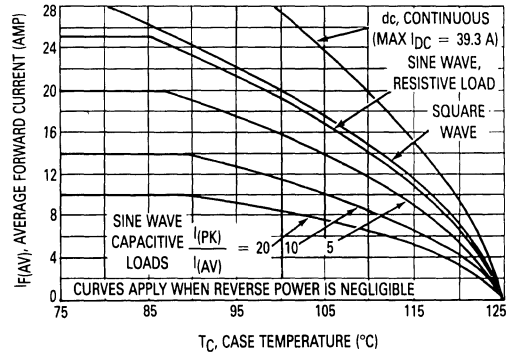


Figure 7. Current Derating

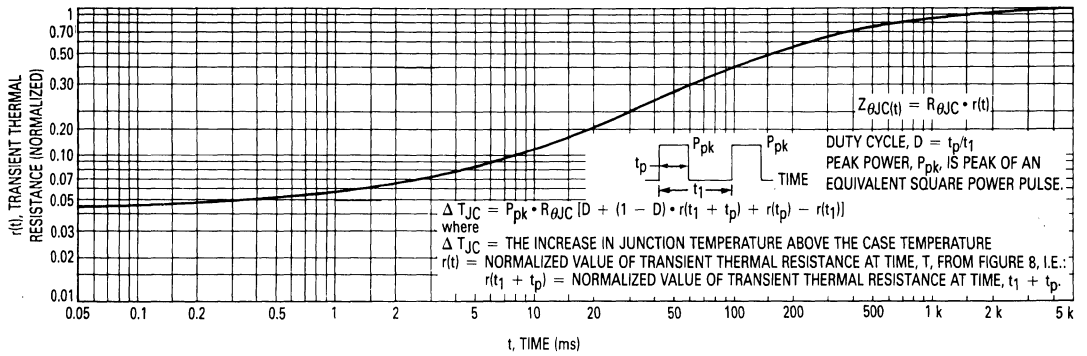


Figure 8. Thermal Response

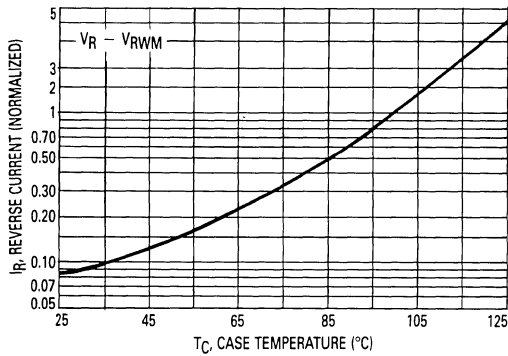


Figure 9. Normalized Reverse Current

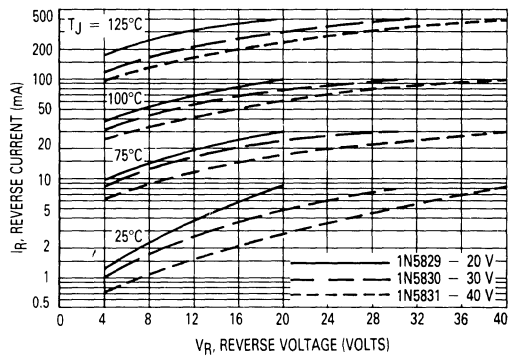


Figure 10. Typical Reverse Current

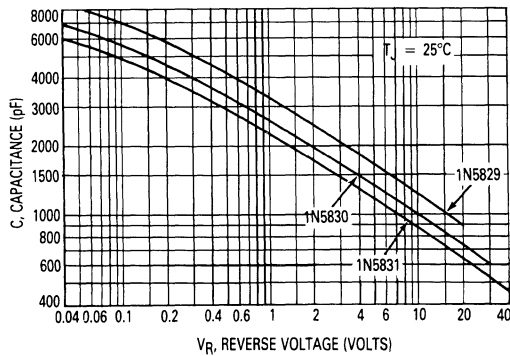


Figure 11. Capacitance

**NOTE 2 — HIGH FREQUENCY OPERATION**

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine

wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicate of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

**1N6095**  
**1N6096**  
**SD41**

1N6096 and SD41 are  
 Motorola Preferred Devices

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

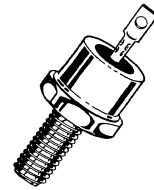
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature Capability
- Guaranteed Reverse Avalanche
- Mounting Torque: 15 in-lb max

### Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: 1N6095, 1N6096, SD41

### SCHOTTKY BARRIER RECTIFIERS

**25 and 30 AMPERES**  
**30 to 45 VOLTS**



**CASE 56-03**  
**DO-203AA**  
**METAL**

### MAXIMUM RATINGS

Rating	Symbol	1N6095*	1N6096*	SD41	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$			45	Volts
Working Peak Reverse Voltage	$V_{RWM}$	30	40	35	
DC Blocking Voltage	$V_R$			45	
Average Rectified Forward Current (Rated $V_R$ )	$I_O$	25 $T_C = 70^\circ\text{C}$	25 $T_C = 70^\circ\text{C}$	30 $T_C = 105^\circ\text{C}$	Amps
Case Temperature (Rated $V_R$ )	$T_C$	105	105	—	°C
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	400	400	600	Amp
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 10. (1)	$I_{RRM}$	2.0	2.0	2.0	Amps
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +125	-65 to +125	-55 to +150°C	°C
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	150	150	150	°C
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	10000	10000	V/ $\mu\text{s}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	1N6095*	1N6096*	SD41	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	← 2.0 →			°C/W

### ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	1N6095*	1N6096*	SD41	Unit
Maximum Instantaneous Forward Voltage (2) ( $i_F = 30$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 78.5$ Amp, $T_C = 70^\circ\text{C}$ )	$v_F$	— 0.86	— 0.86	0.55 —	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	250	250	125 @ $V_R = 35$ V	mA
Capacitance (100 kHz $\geq f \geq 1.0$ MHz)	$C_t$	6000 $V_R = 1.0$ V	6000 $V_R = 1.0$ V	2000 $V_R = 5.0$ V	pF

\*Indicates JEDEC Registered Data.

(1) Not JEDEC requirement, but a Motorola product capability.

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

FIGURE 1 — TYPICAL FORWARD VOLTAGE

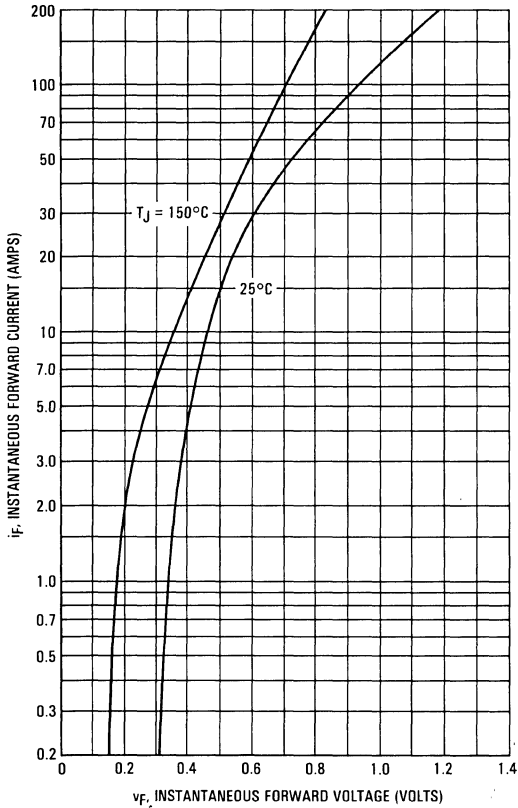


FIGURE 2 — TYPICAL REVERSE CURRENT

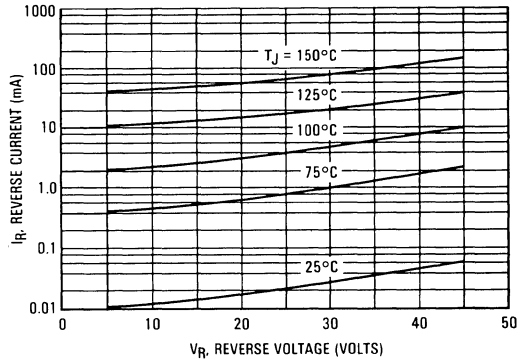
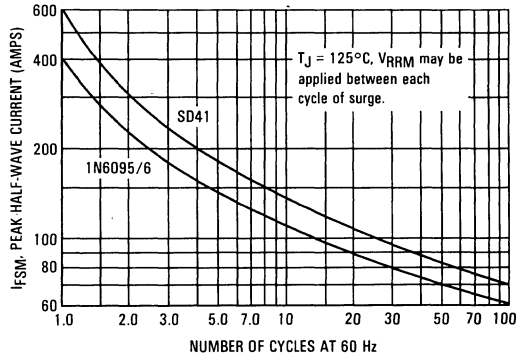


FIGURE 3 — MAXIMUM SURGE CAPABILITY



**HIGH FREQUENCY OPERATION**

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Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

FIGURE 4 — CAPACITANCE

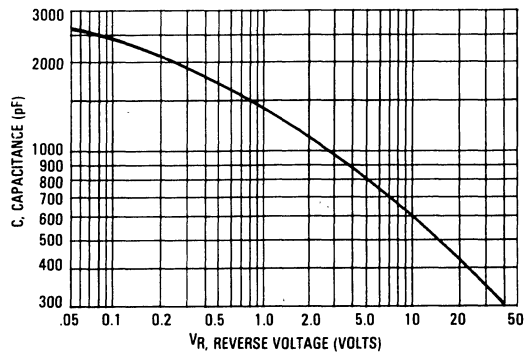




FIGURE 5 — SD41 CURRENT DERATING

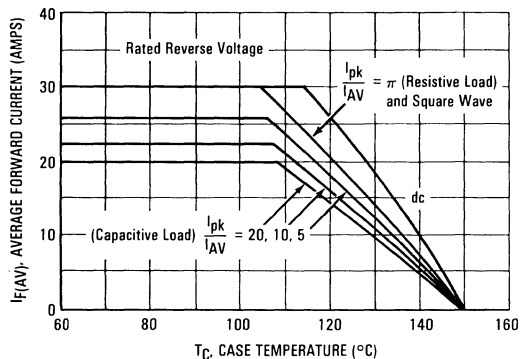


FIGURE 6 — 1N6095/6 CURRENT DERATING

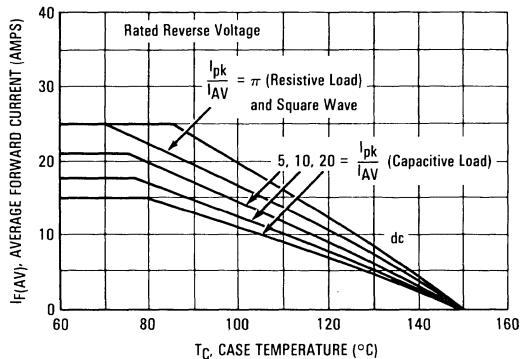


FIGURE 7 — FORWARD POWER DISSIPATION

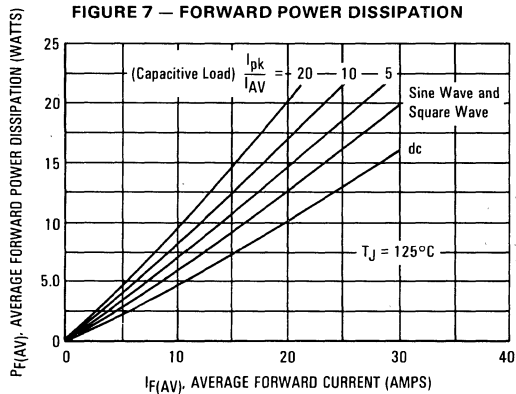
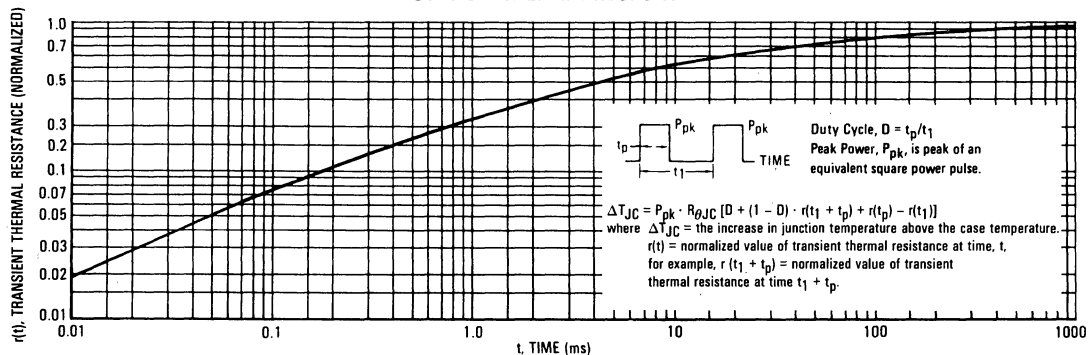
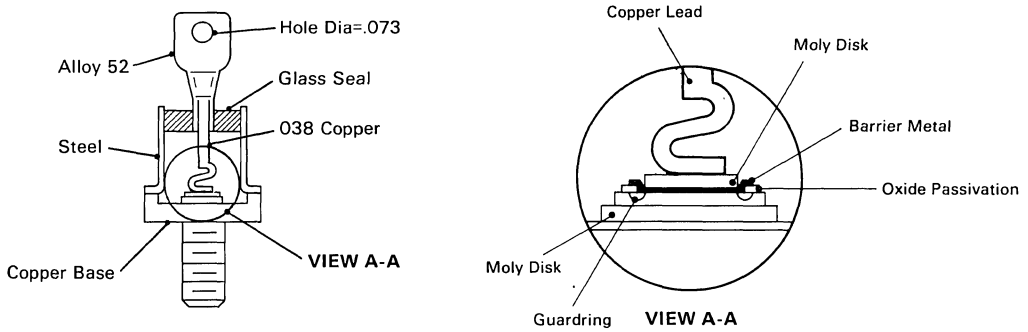


FIGURE 8 — THERMAL RESPONSE



# 1N6095, 1N6096, SD41

FIGURE 9 — SCHOTTKY RECTIFIER



3

Motorola builds quality and reliability into its Schottky Rectifiers.

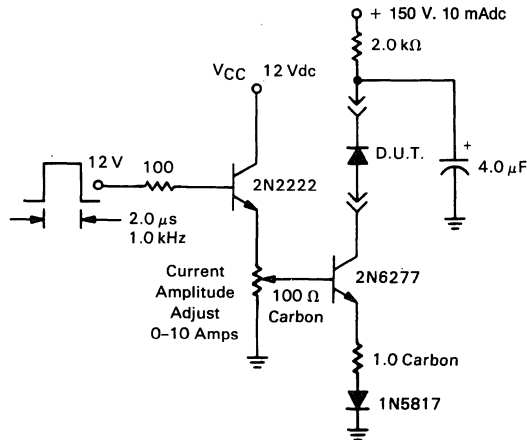
First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents  $dv/dt$  problems, so snubbers are not required. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead is also stress relieved. These two features

give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for  $dv/dt$  at 1,600 V/ $\mu$ s and reverse avalanche.

FIGURE 10 — TEST CIRCUIT FOR  $dv/dt$  AND REVERSE SURGE CURRENT



**MBR3520**  
**MBR3535**  
**MBR3545**

MBR3545 is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

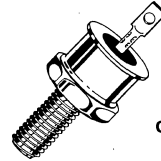
- Guardring for dv/dt Stress Protection
- Guaranteed Reverse Surge Current/Avalanche
- 150°C Operating Junction Temperature
- Mounting Torque: 15 in-lb max

### Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 45.6 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 15 lb-in max
- Shipped 25 units per rail
- Marking: B3520, B3535, B3545

### SCHOTTKY BARRIER RECTIFIERS

**35 AMPERES**  
**20 to 45 VOLTS**



**CASE 56-03**  
**DO-203AA**  
**METAL**

### MAXIMUM RATINGS

Rating	Symbol	MBR3520	MBR3535	MBR3545	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWV}$ $V_R$	20	35	45	Volts
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 110^\circ\text{C}$ )	$I_{FRM}$	70			Amps
Average Rectified Forward Current (Rated $V_R$ , $T_C = 110^\circ\text{C}$ )	$I_{F(AV)}$	35			Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 8	$I_{RRM}$	2.0			Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	600			Amps
Operating Junction Temperature	$T_J$	-65 to +150			$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175			$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000			V/ $\mu\text{s}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.3	1.5	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS PER DIODE

Characteristic	Symbol	Typ	Max	Unit
Instantaneous Forward Voltage (1) ( $I_F = 35$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 35$ Amp, $T_C = 25^\circ\text{C}$ ) ( $I_F = 70$ Amp, $T_C = 125^\circ\text{C}$ )	$V_F$	0.49 0.55 0.60	0.55 0.63 0.69	Volts
Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 125^\circ\text{C}$ ) (Rated Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	60 0.1	100 0.3	mA
Capacitance ( $V_R = 1.0$ Vdc, 100 kHz > f > 1.0 MHz, $T_C = 25^\circ\text{C}$ )	$C_t$	3000	3700	pF

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%

Rev 2

FIGURE 1 — MAXIMUM FORWARD VOLTAGE

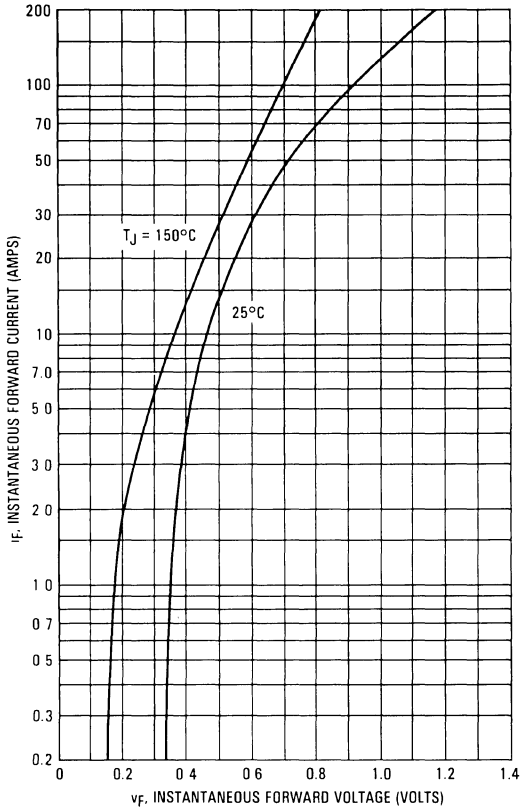


FIGURE 2 — MAXIMUM REVERSE CURRENT

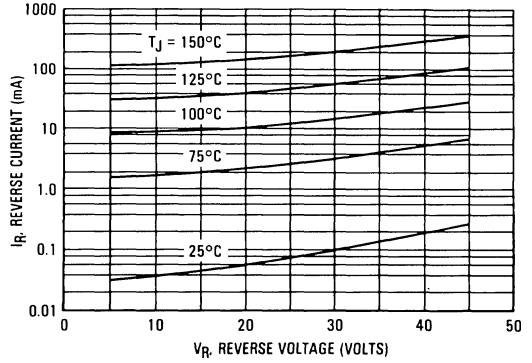


FIGURE 3 — MAXIMUM SURGE CAPABILITY

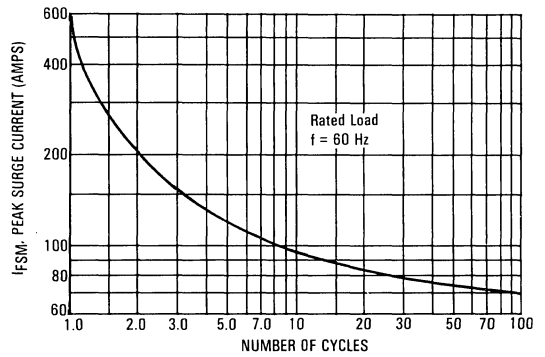


FIGURE 4 — CURRENT DERATING

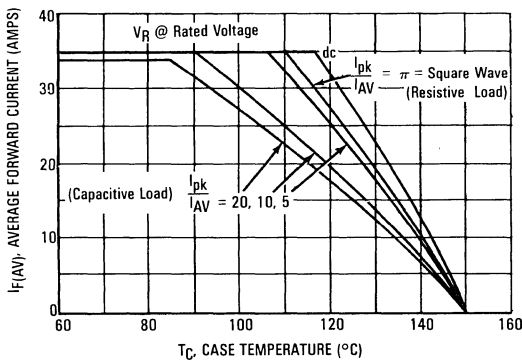


FIGURE 5 — POWER DISSIPATION

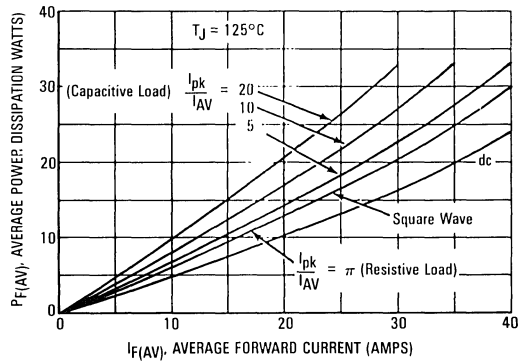
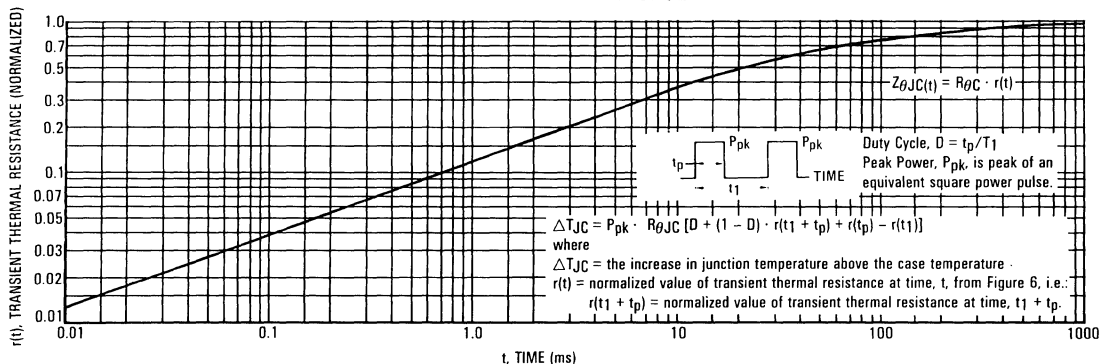


FIGURE 6 — THERMAL RESPONSE



HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 7.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

FIGURE 7 — CAPACITANCE

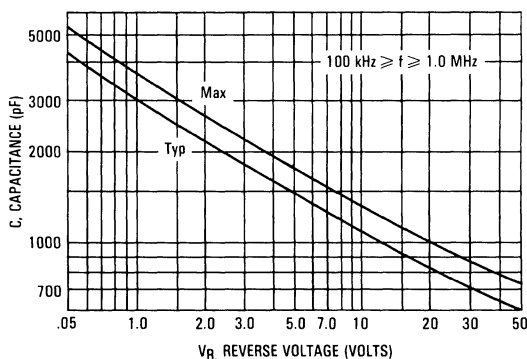


FIGURE 8 — TEST CIRCUIT FOR  $dv/dt$  AND REVERSE SURGE CURRENT

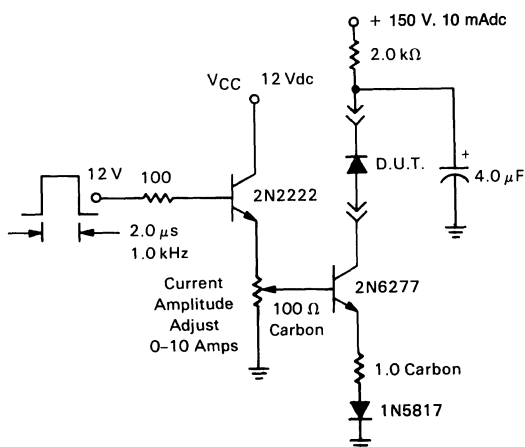
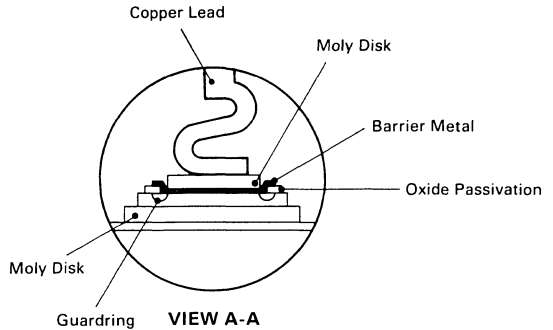
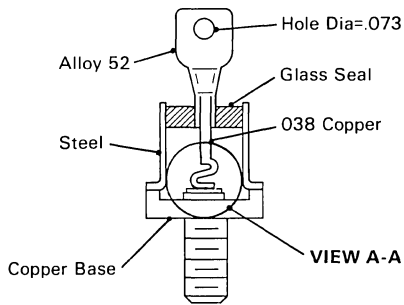


FIGURE 9 — SCHOTTKY RECTIFIER



Motorola builds quality and reliability into its Schottky Rectifiers. First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guarding prevents  $dv/dt$  problems, so snubbers are not mandatory. The guarding also operates like a zener to absorb over-voltage transients.

Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead is also stress-relieved to prevent damage during assembly. These two features give the

unit the capability of passing powered thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for  $dv/dt$  at  $1,600 V/\mu s$  and reverse avalanche. Devices are also 100% reverse scope tested for trace anomalies.

*Designer's Data Sheet*

**Switchmode Power Rectifier**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low  $v_f$
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- High Surge Capacity

**Mechanical Characteristics:**

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: 1N5832, 1N5833, 1N5834

**\*MAXIMUM RATINGS**

Rating	Symbol	1N5832	1N5833	1N5834	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	$V_{RSM}$	24	36	48	Volts
Average Rectified Forward Current $V_R(\text{equiv}) \leq 0.2 V_R(\text{dc}), T_C = 75^\circ\text{C}$	$I_O$	← 40 →			Amp
Ambient Temperature Rated $V_R(\text{dc}), P_F(AV) = 0,$ $R_{\theta JA} = 2.0^\circ\text{C/W}$	$T_A$	100	95	90	$^\circ\text{C}$
Non-Repetitive Peak Surge Current (surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	← 800 (for 1 cycle) →			Amp
Operating and Storage Junction Temperature Range (Reverse voltage applied)	$T_J, T_{stg}$	← -65 to +125 →			$^\circ\text{C}$
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	← 150 →			$^\circ\text{C}$

**\*THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C/W}$

**\*ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$  unless otherwise noted.)**

Characteristic	Symbol	1N5832	1N5833	1N5834	Unit
Maximum Instantaneous Forward Voltage (1) ( $i_F = 10$ Amp) ( $i_F = 40$ Amp) ( $i_F = 125$ Amp)	$v_F$	0.360 0.520 0.980	0.370 0.550 1.080	0.380 0.590 1.180	Volts
Maximum Instantaneous Reverse Current @ rated dc Voltage (1) $T_C = 100^\circ\text{C}$	$i_R$	20 150	20 150	20 150	mA

\*Indicates JEDEC Registered Data.

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%.

**SCHOTTKY  
 BARRIER  
 RECTIFIERS**

**40 AMPERE  
 20,30,40 VOLTS**



**CASE 257-01  
 DO-203AB  
 METAL**

# 1N5832 thru 1N5834

## NOTE 1: DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above  $0.2 V_{RWM}$ . Proper derating may be accomplished by use of equation (1):

$$T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \quad (1)$$

where

$T_{A(max)}$  = Maximum allowable ambient temperature

$T_{J(max)}$  = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest).

$P_{F(AV)}$  = Average forward power dissipation

$P_{R(AV)}$  = Average reverse power dissipation

$R_{\theta JC}$  = Junction-to-ambient thermal resistance

Figures 1, 2 and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_R = T_{J(max)} - R_{\theta JA} P_{R(AV)} \quad (2)$$

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_R - R_{\theta JA} P_{F(AV)} \quad (3)$$

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^\circ\text{C}$ , when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2 and

3 as a difference in the rate of change of the slope in the vicinity of  $115^\circ\text{C}$ . The data of Figures 1, 2 and 3 is based upon dc conditions. For use in common rectifier circuits, Table I indicates suggested factors for an equivalent dc voltage to use for conservative design; i.e.:

$$V_{R(equiv)} = V_{in(PK)} \times F \quad (4)$$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

Example: Find  $T_{A(max)}$  for 1N5834 operated in a 12-Volt dc supply using a bridge circuit with capacitive filter such that  $I_{DC} = 30 \text{ A}$  ( $I_{F(AV)} = 15 \text{ A}$ ),  $I_{(PK)}/I_{(AV)} = 10$ , Input Voltage = 10 V(rms),  $R_{\theta JA} = 3^\circ\text{C/W}$ .

Step 1: Find  $V_{R(equiv)}$ . Read  $F = 0.65$  from Table I.

$$V_{R(equiv)} = (10)(1.41)(0.65) = 9.18 \text{ V}$$

Step 2: Find  $T_R$  from Figure 3. Read  $T_R = 118^\circ\text{C}$  @  $V_R = 9.18 \text{ V}$  &  $R_{\theta JA} = 3^\circ\text{C/W}$

Step 3: Find  $P_{F(AV)}$  from Figure 4. †Read  $P_{F(AV)} = 20 \text{ W}$

$$\text{at } \frac{I_{(PK)}}{I_{(AV)}} = 10 \text{ \& } I_{F(AV)} = 15 \text{ A}$$

Step 4: Find  $T_{A(max)}$  from equation (3).  $T_{A(max)} = 118 - (3)(20) = 58^\circ\text{C}$

†Values given are for the 1N5834. Power is slightly lower for the other units because of their lower forward voltage.

TABLE I – VALUES FOR FACTOR F

Circuit Load	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped (1),(2)	
	Resistive	Capacitive (1)	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

(1) Note that  $V_{R(PK)} \approx 2 V_{in(PK)}$

(2) Use line to center tap voltage for  $V_{in}$ .

FIGURE 1 – MAXIMUM REFERENCE TEMPERATURE – 1N5832

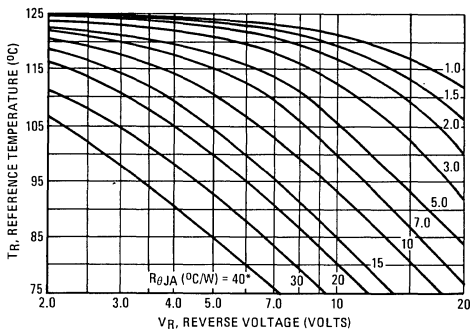


FIGURE 2 – MAXIMUM REFERENCE TEMPERATURE – 1N5833

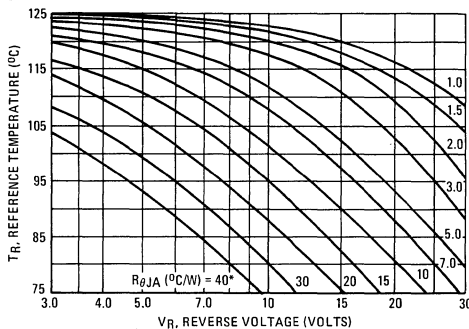


FIGURE 3 – MAXIMUM REFERENCE TEMPERATURE – 1N5834

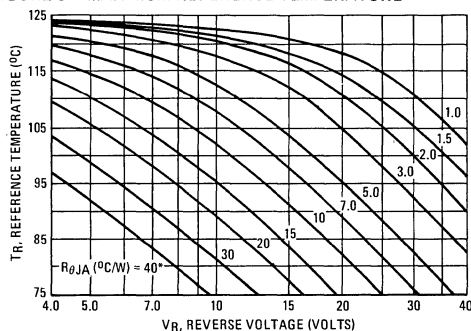
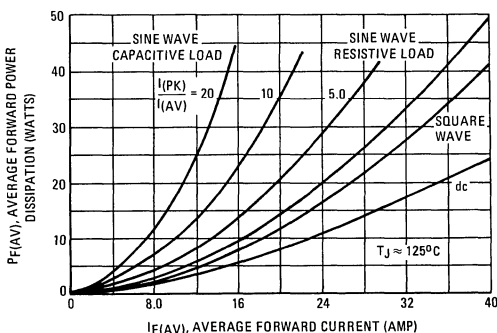


FIGURE 4 – FORWARD POWER DISSIPATION



\*No external heat sink.



FIGURE 5 – TYPICAL FORWARD VOLTAGE

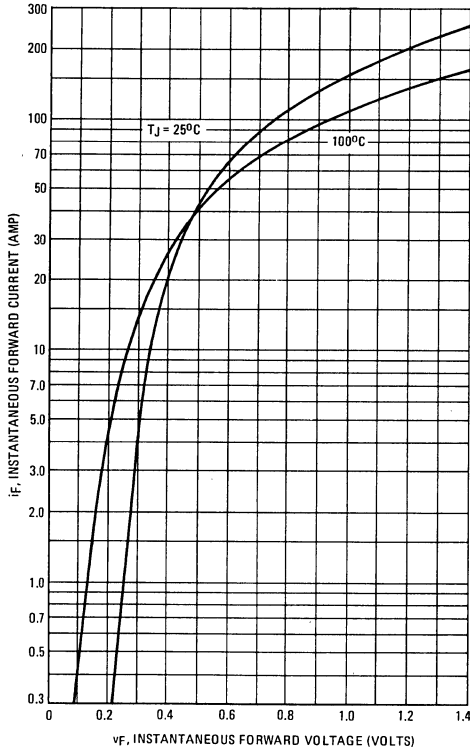


FIGURE 6 – MAXIMUM SURGE CAPABILITY

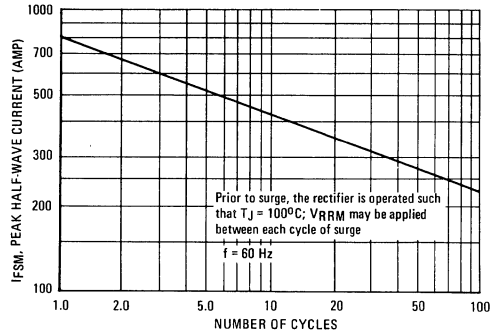


FIGURE 7 – CURRENT DERATING

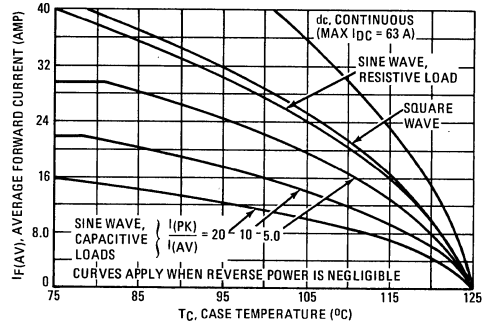
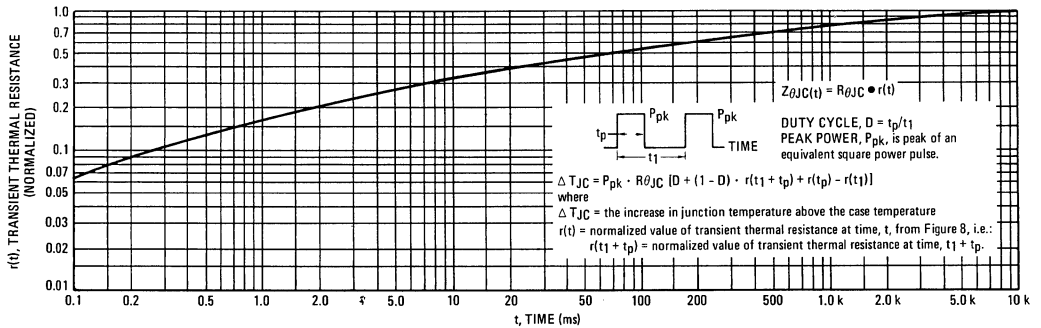


FIGURE 8 – THERMAL RESPONSE



# 1N5832 thru 1N5834

FIGURE 9 – NORMALIZED REVERSE CURRENT

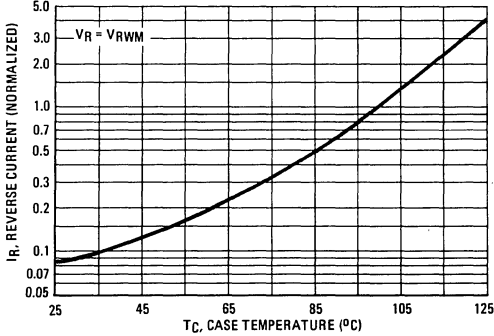


FIGURE 10 – TYPICAL REVERSE CURRENT

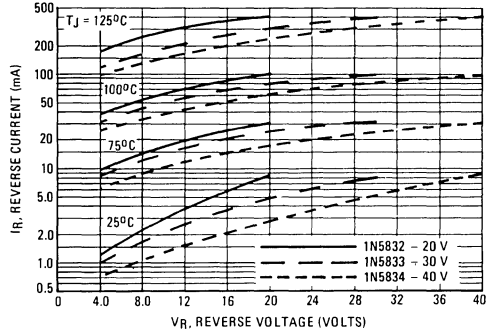
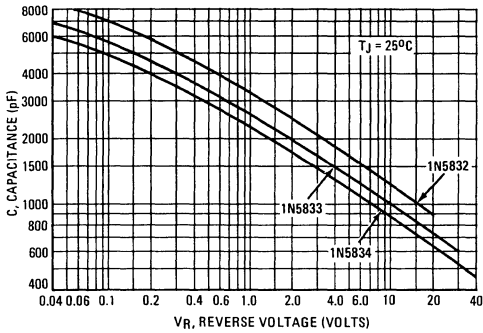


FIGURE 11 – CAPACITANCE



## NOTE 2: HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11).

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

## NOTE 3: SOLDER HEAT

The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.

3

# MOTOROLA SEMICONDUCTOR TECHNICAL DATA

## Switchmode Power Rectifiers

... using the platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Guaranteed Reverse Avalanche
- Extremely Low  $V_F$
- Low Stored Charge, Majority Carrier Conduction
- Guardring for Stress Protection
- Low Power Loss/High Efficiency
- 150°C Operating Junction Temperature Capability
- High Surge Capacity

### Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: 1N6097, 1N6098, SD51

### MAXIMUM RATINGS

Rating	Symbol	1N6097*	1N6098*	SD51	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	30	40	45 35 45	Volts
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz)	$I_{FRM}$	—	—	120 $T_C = 90^\circ\text{C}$	Amps
Average Rectified Forward Current (Rated $V_R$ )	$I_O$	50 $T_C = 70^\circ\text{C}$	50 $T_C = 70^\circ\text{C}$	—	Amps
Case Temperature (Rated $V_R$ )	$T_C$	115	115	—	$^\circ\text{C}$
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	800			Amps
Peak Repetitive Reverse Surge Current (2) (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 10.	$I_{RRM}$	2.0			Amps
Operating Junction Temperature Range (Reverse Voltage Applied)	$T_J$	-65 to +125	-65 to +125	-65 to +150	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-65 to +125	-65 to +125	-65 to +165	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	10000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	1N6097*	1N6098*	SD51	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.0			$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	1N6097*	1N6098*	SD51	Unit
Maximum Instantaneous Forward Voltage (2) ( $i_F = 157$ Amp, $T_C = 70^\circ\text{C}$ ) ( $i_F = 60$ Amp) ( $i_F = 60$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 120$ Amp, $T_C = 125^\circ\text{C}$ )	$V_F$	0.86 — — —	0.86 — — —	— 0.70 0.60 0.84	Volts
Maximum Instantaneous Reverse Current (2) (Rated Voltage, $T_C = 125^\circ\text{C}$ ) (Rated Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	250 —	250 —	200 50 ( $\omega$ ) $V_R = 35$ V	mA
DC Reverse Current (Rated Voltage, $T_C = 115^\circ\text{C}$ )	$I_R$	250	250	—	mA
Maximum Capacitance (100 kHz $\leq f \leq 1.0$ MHz)	$C_t$	7000 $V_R = 1.0$ Vdc	7000 $V_R = 1.0$ Vdc	4000 $V_R = 5.0$ Vdc	pF

\*Indicates JEDEC Registered Data.

(1) Not a JEDEC requirement, but of Motorola product capability.

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%.

# 1N6097 1N6098 SD51

1N6098 and SD51 are  
Motorola Preferred Devices

### SCHOTTKY BARRIER RECTIFIERS

60 AMPERES  
20 to 45 VOLTS



CASE 257-01  
DO-203AB  
METAL

3

# 1N6097, 1N6098, SD51

FIGURE 1 — TYPICAL FORWARD VOLTAGE

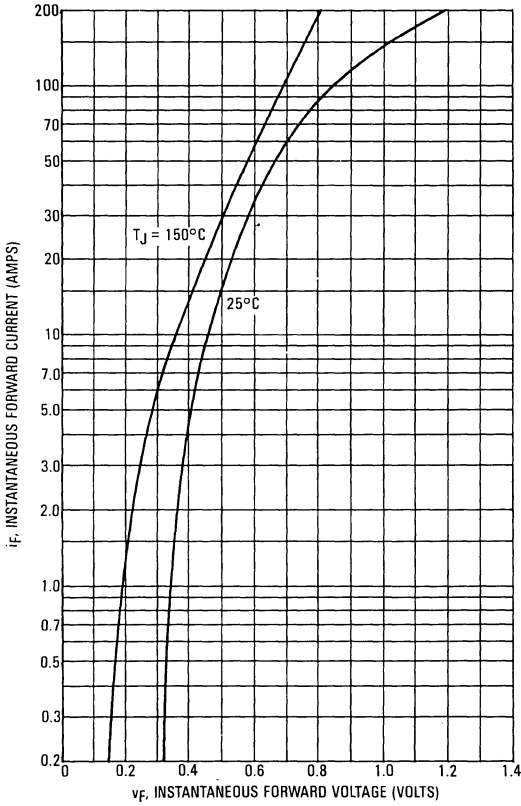


FIGURE 2 — TYPICAL REVERSE CURRENT

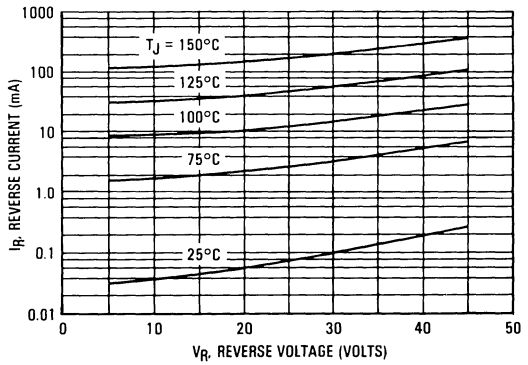


FIGURE 3 — TYPICAL SURGE CAPABILITY

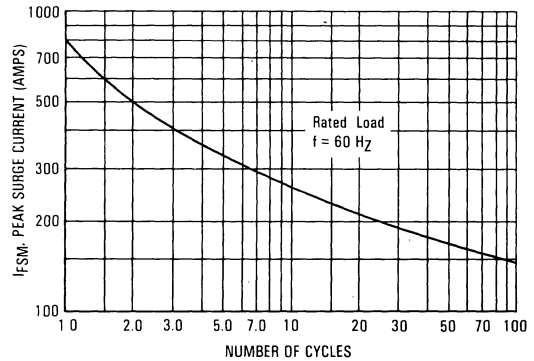
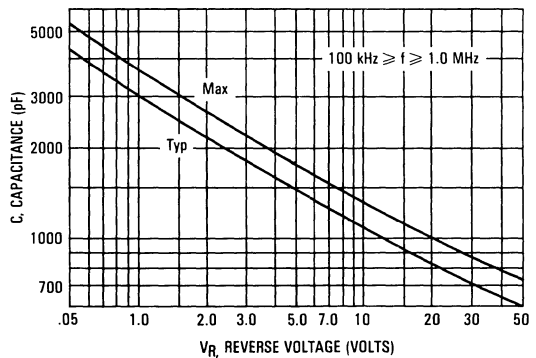


FIGURE 4 — CAPACITANCE

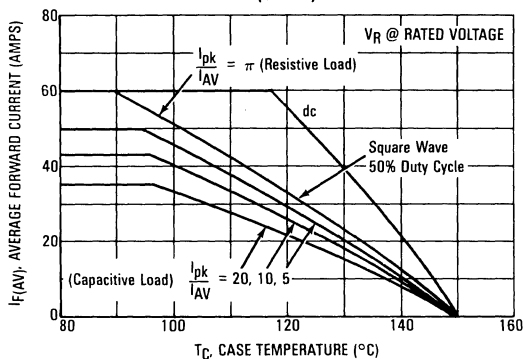


## NOTE 1 HIGH FREQUENCY OPERATION

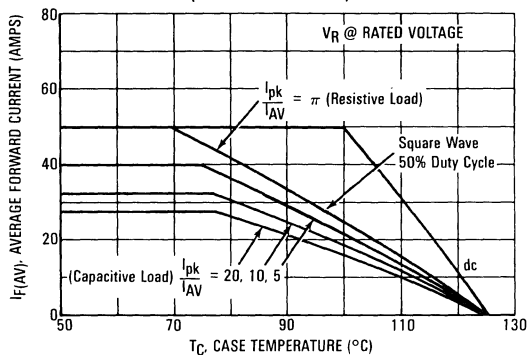
Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

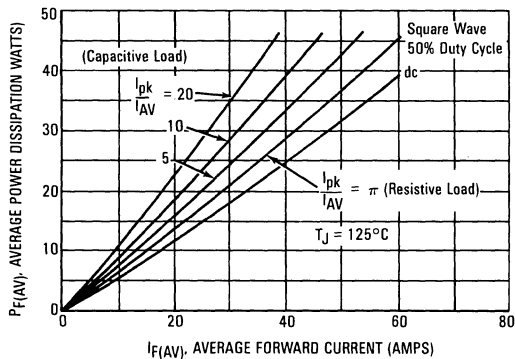
**FIGURE 5 — CURRENT DERATING (SD51)**



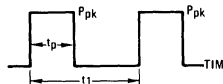
**FIGURE 6 — CURRENT DERATING (1N6097/1N6098)**



**FIGURE 7 — POWER DISSIPATION**



**NOTE 2**



DUTY CYCLE,  $D = t_p/t_1$   
PEAK POWER,  $P_{pk}$ , is peak of an equivalent square power pulse.

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:

The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of  $T_C$ , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

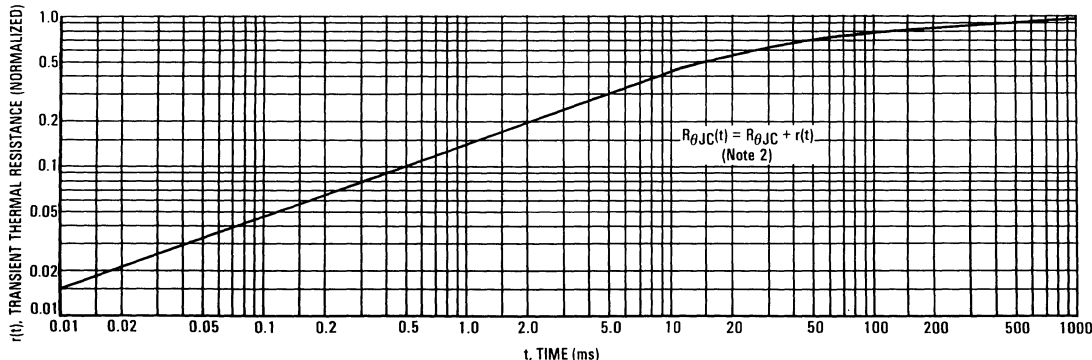
where  $\Delta T_{JC}$  is the increase in junction temperature above the case temperature. It may be determined by:

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t) - r(t_1)]$$

where  $r(t)$  = normalized value of transient thermal resistance at time,  $t$ , from Figure 8, i.e.:

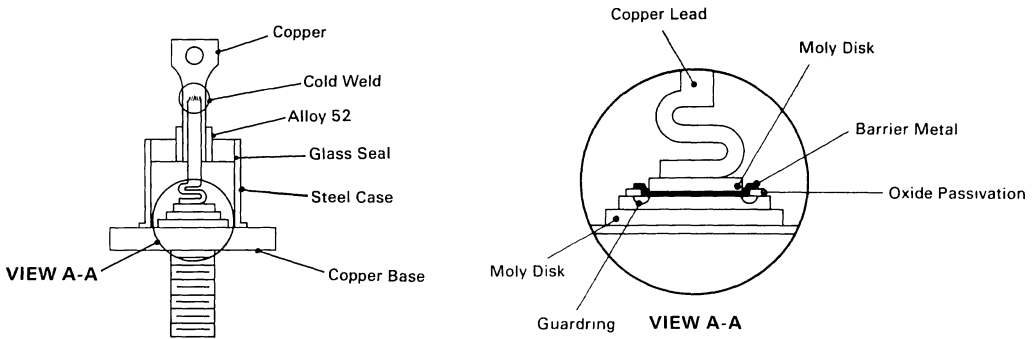
$$r(t_1 + t_p) = \text{normalized value of transient thermal resistance at time } t_1 + t_p.$$

**FIGURE 8 — THERMAL RESPONSE**



# 1N6097, 1N6098, SD51

FIGURE 9 — SCHOTTKY RECTIFIER



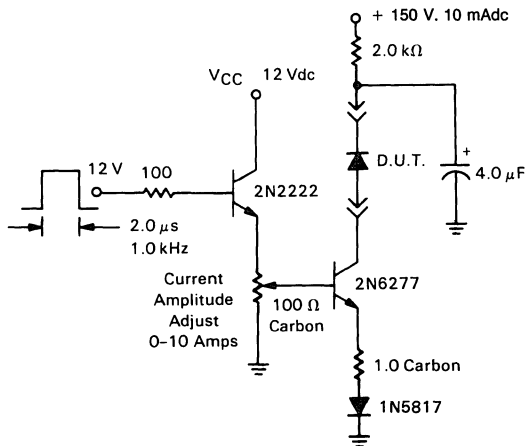
Motorola builds quality and reliability into its Schottky Rectifiers. First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents  $dv/dt$  problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead has a stress relief

feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for  $dv/dt$  at 1,600 V/ $\mu$ s and reverse avalanche.

FIGURE 10 — TEST CIRCUIT FOR  $dv/dt$  AND REVERSE SURGE CURRENT



# Switchmode Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Guaranteed Reverse Avalanche
- Guardring for dv/dt Stress Protection
- 175°C Operating Junction Temperature
- Extremely Low Forward Voltage

**Mechanical Characteristics:**

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B6015L, B6020L, B6025L, B6030L

**MBR6015L**  
**MBR6020L**  
**MBR6025L**  
**MBR6030L**

MBR6030L is a  
Motorola Preferred Device

**SCHOTTKY RECTIFIERS**  
**60 AMPERES**  
**15 TO 30 VOLTS**



CASE 257-01  
DO-203AB  
METAL

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	MBR6015L MBR6020L MBR6025L MBR6030L	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	15 20 25 30 Volts
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz) T <sub>C</sub> = 90°C	I <sub>FRM</sub>	150	Amps
Average Rectified Forward Current (Rated V <sub>R</sub> ) T <sub>C</sub> = 120°C	I <sub>O</sub>	60	Amps
Peak Repetitive Reverse Surge Current (2 μs, 1 kHz) See Figure 7	I <sub>RRM</sub>	2	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	10000	Amps
Operating Junction Temperature	T <sub>J</sub>	-65 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10000	V/μs

**THERMAL CHARACTERISTICS**

Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	0.8	°C/W
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**ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (1) (I <sub>F</sub> = 30 Amps, T <sub>C</sub> = 25°C) (I <sub>F</sub> = 60 Amps, T <sub>C</sub> = 25°C) (I <sub>F</sub> = 30 Amps, T <sub>C</sub> = 150°C) (I <sub>F</sub> = 60 Amps, T <sub>C</sub> = 150°C)	V <sub>F</sub>	0.42 0.48 0.30 0.38	Volts
Maximum Instantaneous Reverse Current (1) (Rated Voltage, T <sub>C</sub> = 25°C) (Rated Voltage, T <sub>C</sub> = 125°C)	i <sub>R</sub>	50 280	mA
Capacitance (V <sub>R</sub> = 1 Vdc, 100 kHz ≤ f ≤ 1 MHz)	C <sub>t</sub>	6000	pF

(1) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

# MBR6015L, MBR6020L, MBR6025L, MBR6030L

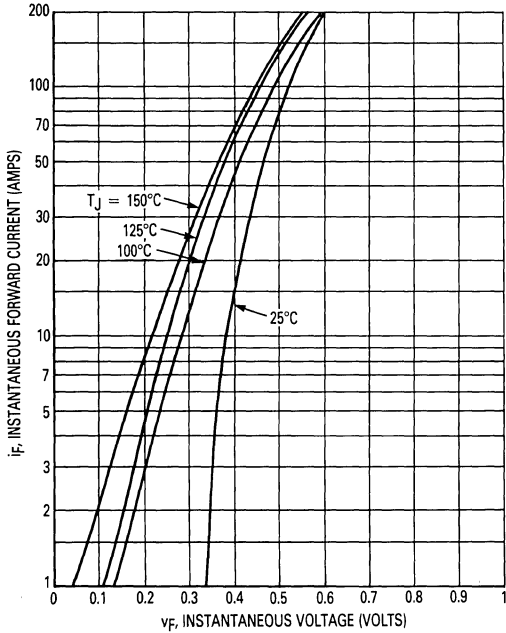


Figure 1. Typical Forward Voltage

## NOTE 1

### HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

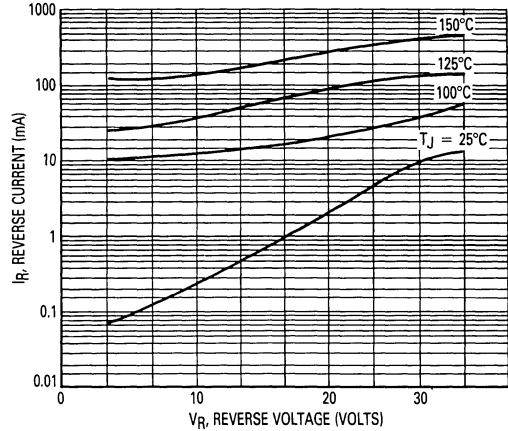


Figure 2. Typical Reverse Current\*

\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently below rated  $V_R$ .

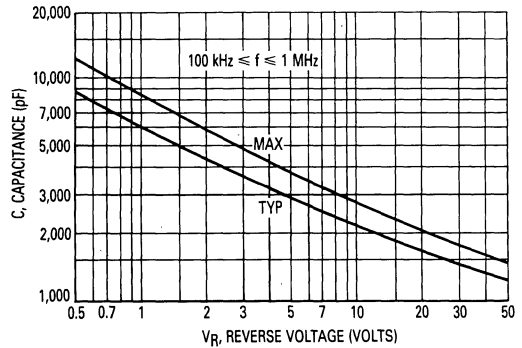


Figure 3. Capacitance

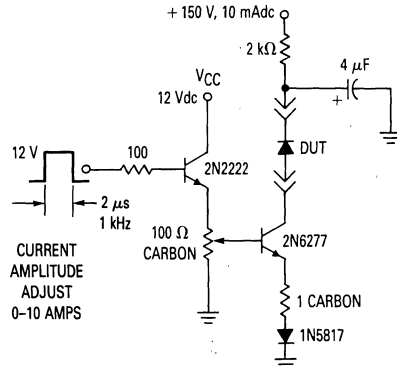


Figure 4. Test Circuit for  $dv/dt$  and Reverse Surge Current



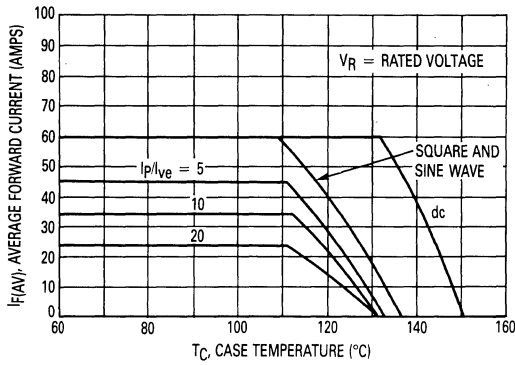


Figure 5. Forward Current Derating

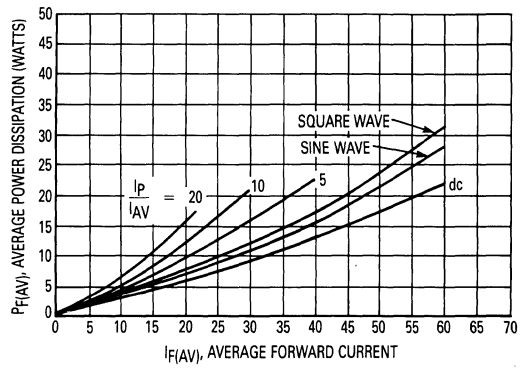
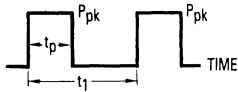


Figure 6. Power Dissipation

3

NOTE 2



DUTY CYCLE,  $D = t_p/t_1$   
 PEAK POWER,  $P_{pk}$ , IS PEAK OF AN  
 EQUIVALENT SQUARE POWER PULSE.

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:

The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated

in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of  $T_C$ , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

where  $\Delta T_{JC}$  is the increase in junction temperature above the case temperature. It may be determined by:

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$$

where

$r(t)$  = normalized value of transient thermal resistance at time,  $t$ , from Figure 7, i.e.:

$r(t_1 - t_p)$  = normalized value of transient thermal resistance at time  $t_1 + t_p$ .

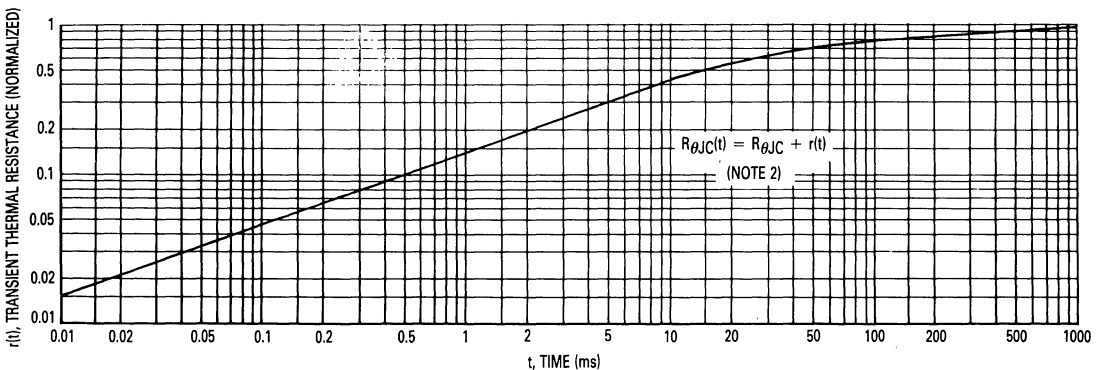
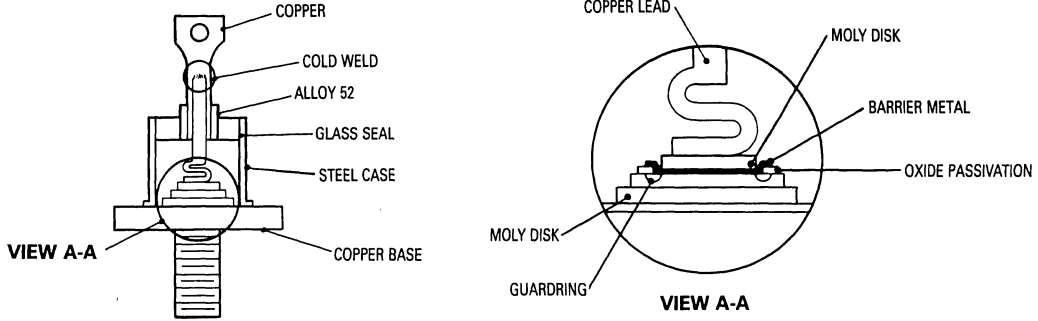


Figure 7. Thermal Response

# MBR6015L, MBR6020L, MBR6025L, MBR6030L



Motorola builds quality and reliability into its Schottky Rectifiers.

First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents  $dv/dt$  problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb overvoltage transients.

Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead

has a stress relief feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for  $dv/dt$  at  $1,600 \text{ V}/\mu\text{s}$  and reverse avalanche.

**Figure 8. Schottky Rectifier**

## Switchmode Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Guaranteed Reverse Avalanche
- Guarding for dv/dt Stress Protection
- 150°C Operating Junction Temperature
- Low Forward Voltage

### Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B6035, B6045

MBR6045 is a  
 Motorola Preferred Device

### SCHOTTKY RECTIFIERS

**60 AMPERES**  
**35 AND 45 VOLTS**



**CASE 257-01**  
**DO-203AB**  
**METAL**

### MAXIMUM RATINGS

Rating	Symbol	MBR6035	MBR6045	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWVM}$ $V_R$	35	45	Volts
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 100^\circ\text{C}$	$I_{FRM}$	120		Amps
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 100^\circ\text{C}$	$I_O$	60		Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 7	$I_{RRM}$	2.0		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	800		Amps
Operating Junction Temperature	$T_J$	-65 to +150		$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175		$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000		V/ $\mu\text{s}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.85	1.0	$^\circ\text{C}/\text{W}$

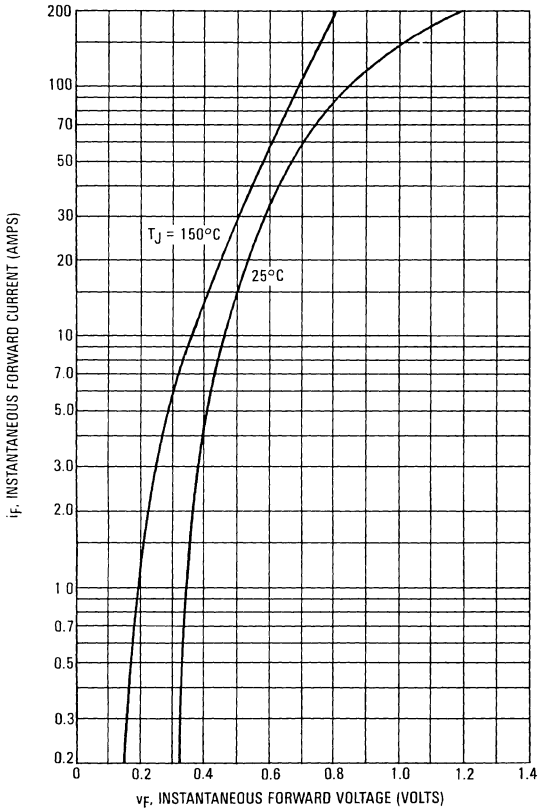
### ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Instantaneous Forward Voltage (1) ( $i_F = 60$ Amp, $T_C = 25^\circ\text{C}$ ) ( $i_F = 60$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 120$ Amp, $T_C = 125^\circ\text{C}$ )	$v_F$	0.65 0.57 0.70	0.70 0.60 0.76	Volts
Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 25^\circ\text{C}$ ) (Rated Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	0.1 55	0.3 100	mA
Capacitance ( $V_R = 1.0$ Vdc, 100 kHz $\leq$ 1.0 MHz)	$C_t$	3000	3700	pF

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%

# MBR6035, MBR6045

**FIGURE 1 — TYPICAL FORWARD VOLTAGE**

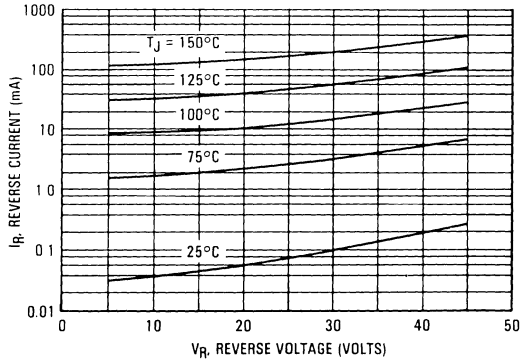


**NOTE 1  
HIGH FREQUENCY OPERATION**

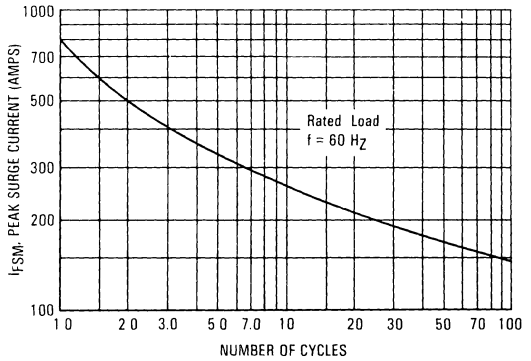
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Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

**FIGURE 2 — TYPICAL REVERSE CURRENT**



**FIGURE 3 — MAXIMUM SURGE CAPABILITY**



**FIGURE 4 — CAPACITANCE**

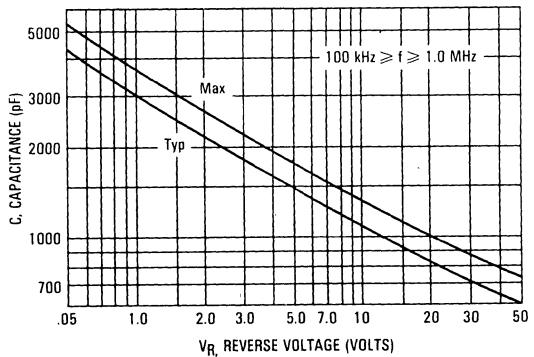


FIGURE 5 — FORWARD CURRENT DERATING

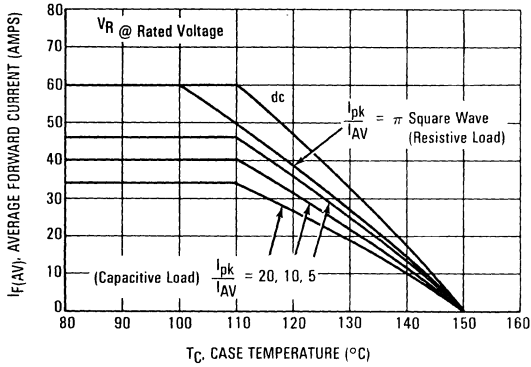
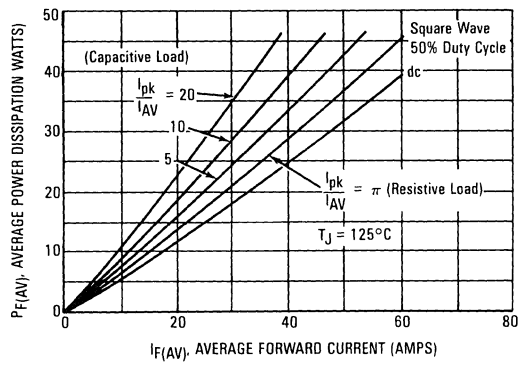
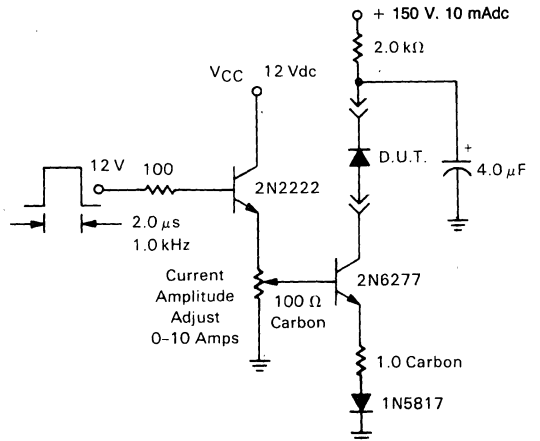


FIGURE 6 — POWER DISSIPATION

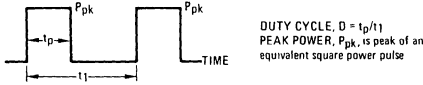


3

FIGURE 7 — TEST CIRCUIT FOR  $dv/dt$  AND REVERSE SURGE CURRENT



NOTE 2



To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:

The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of  $T_C$ , the junction temperature may be determined by:

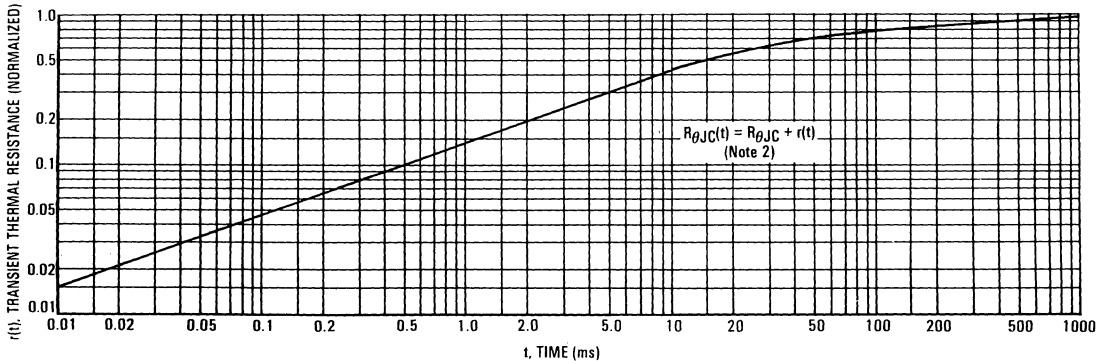
$$T_J = T_C + \Delta T_{JC}$$

where  $\Delta T_C$  is the increase in junction temperature above the case temperature. It may be determined by:

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1-D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$$

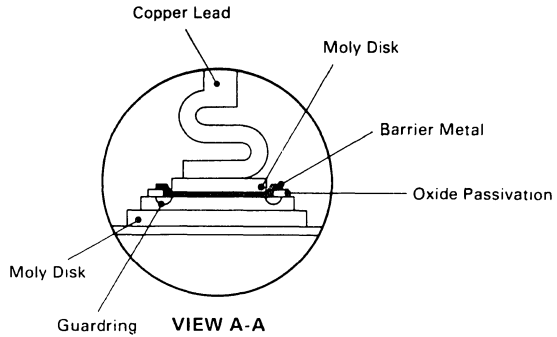
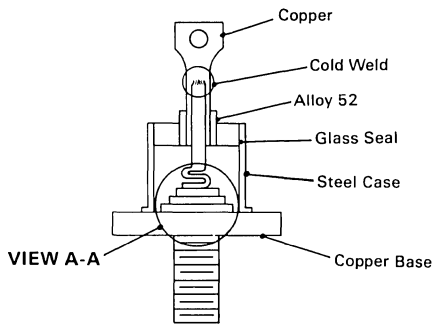
where  $r(t)$  = normalized value of transient thermal resistance at time,  $t$ , from Figure 8, i.e.:  
 $r(t_1 + t_p)$  = normalized value of transient thermal resistance at time  $t_1 + t_p$

FIGURE 8 — THERMAL RESPONSE



# MBR6035, MBR6045

FIGURE 9 — SCHOTTKY RECTIFIER



Motorola builds quality and reliability into its Schottky Rectifiers.

First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents  $dv/dt$  problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead has a stress relief

feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for  $dv/dt$  at 1,600 V/ $\mu$ s and reverse avalanche.

MBR6545 is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

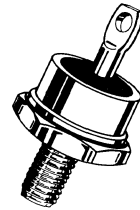
- Guaranteed Reverse Avalanche
- Guardring for dv/dt Stress Protection
- 175°C Operating Junction Temperature
- Low Forward Voltage

### Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B6535, B6545

### HIGH TEMPERATURE SCHOTTKY RECTIFIERS

**65 AMPERES**  
**35 and 45 VOLTS**



**CASE 257-01**  
**DO-203AB**  
**METAL**

### MAXIMUM RATINGS

Rating	Symbol	MBR6535	MBR6545	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	45	Volts
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 120^\circ\text{C}$	$I_{FRM}$	130	130	Amps
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 120^\circ\text{C}$	$I_O$	65	65	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 7	$I_{RRM}$	2.0	2.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	800	800	Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	10000	V/ $\mu\text{s}$

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	1.0	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 65$ Amp, $T_C = 25^\circ\text{C}$ ) ( $I_F = 65$ Amp, $T_C = 150^\circ\text{C}$ ) ( $I_F = 130$ Amp, $T_C = 150^\circ\text{C}$ )	$V_F$	0.78 0.62 0.73	0.78 0.62 0.73	Volts
Maximum Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 25^\circ\text{C}$ ) (Rated Voltage, $T_C = 150^\circ\text{C}$ )	$i_R$	0.07 125	0.07 125	mA
Capacitance ( $V_R = 1.0$ Vdc, 100 kHz $\leq f \leq 1.0$ MHz)	$C_t$	3700	3700	pF

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 1

# MBR6535, MBR6545

FIGURE 1 — TYPICAL FORWARD VOLTAGE

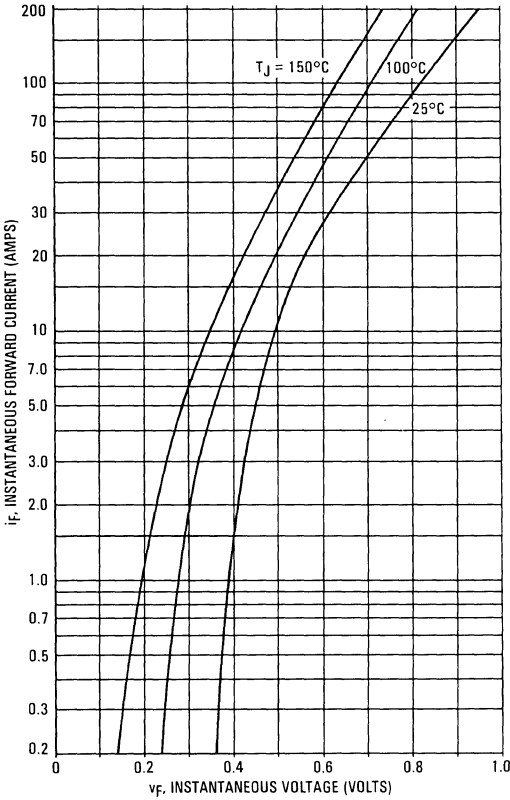


FIGURE 2 — TYPICAL REVERSE CURRENT

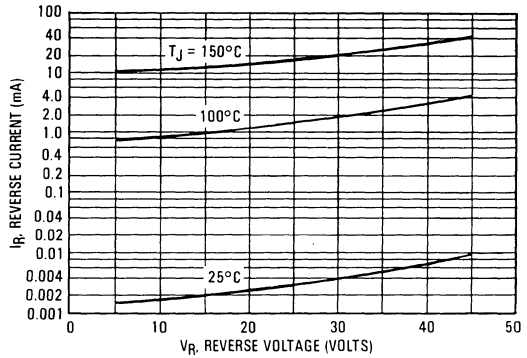
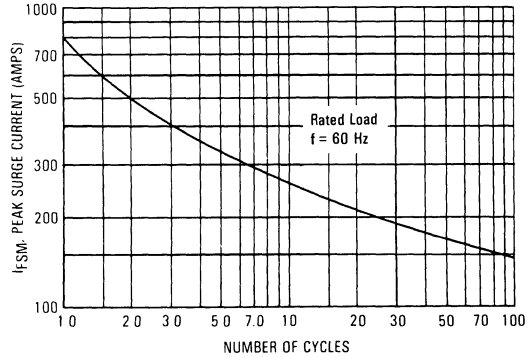


FIGURE 3 — MAXIMUM SURGE CAPABILITY



## NOTE 1 HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

FIGURE 4 — CAPACITANCE

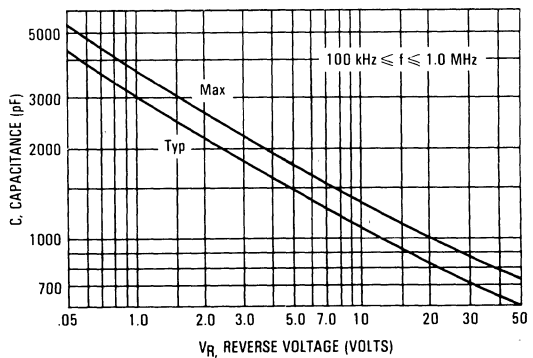




FIGURE 5 — FORWARD CURRENT DERATING

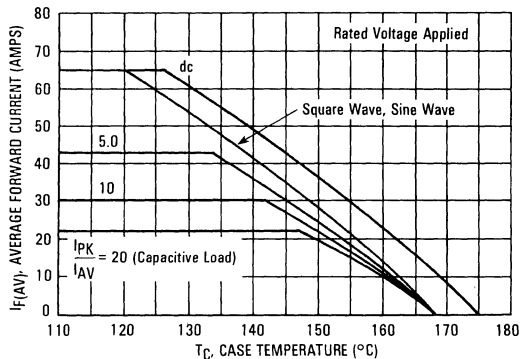
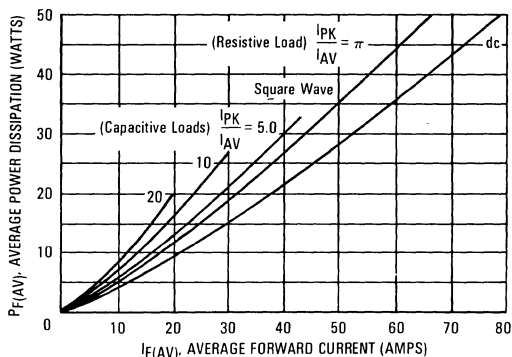


FIGURE 6 — POWER DISSIPATION



3

FIGURE 7 — TEST CIRCUIT FOR  $dv/dt$  AND REVERSE SURGE CURRENT

**NOTE 2**

DUTY CYCLE,  $D = t_p/t_1$   
 PEAK POWER,  $P_{pk}$ , is peak of an equivalent square power pulse

To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended. The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of  $T_C$ , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

where  $\Delta T_{JC}$  is the increase in junction temperature above the case temperature. It may be determined by

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$$

where  $r(t)$  = normalized value of transient thermal resistance at time,  $t$ , from Figure 8, i.e.:

$r(t_1 + t_p)$  = normalized value of transient thermal resistance at time  $t_1 + t_p$

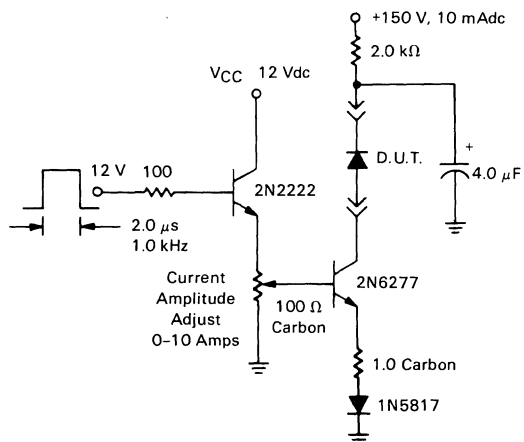
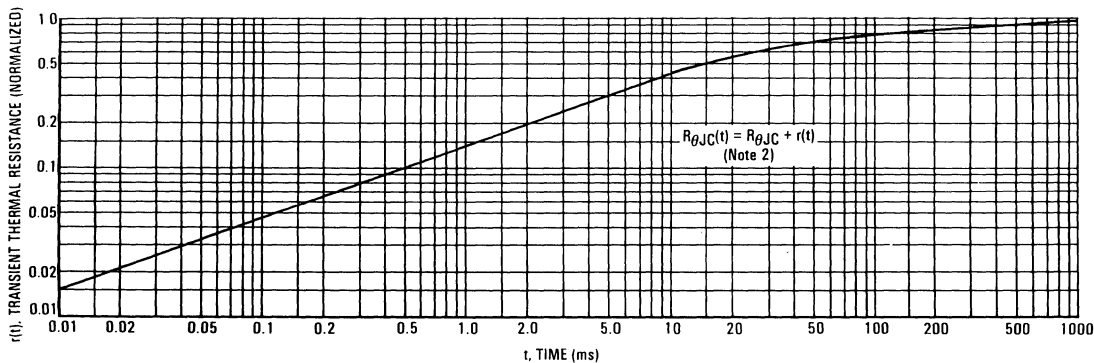
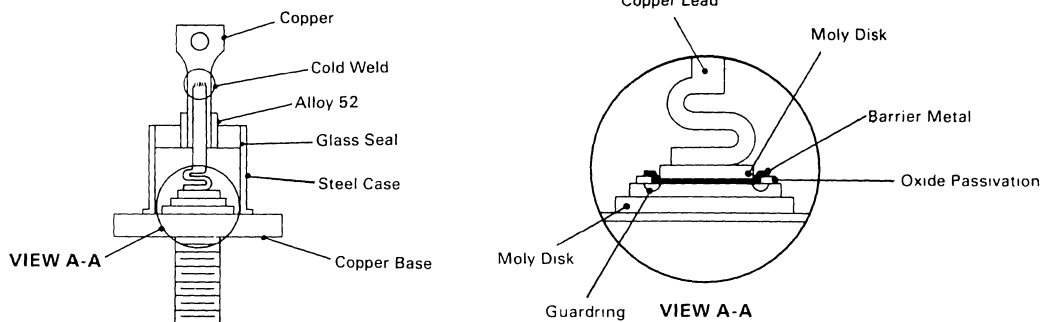


FIGURE 8 — THERMAL RESPONSE



# MBR6535, MBR6545

FIGURE 9 — SCHOTTKY RECTIFIER



Motorola builds quality and reliability into its Schottky Rectifiers.

First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents  $dv/dt$  problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead has a stress relief

feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for  $dv/dt$  at 1,600  $V/\mu s$  and reverse avalanche.

MBR7545 is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

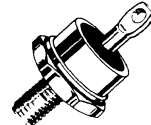
- Extremely Low  $v_f$
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- High Surge Capacity

### Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B7535, B7545

### SCHOTTKY BARRIER RECTIFIERS

**75 AMPERES**  
**35 AND 45 VOLTS**



CASE 257-01  
 DO-203AB  
 METAL

3

### MAXIMUM RATINGS

Rating	Symbol	MBR7535	MBR7545	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	45	Volts
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz)	$I_{FRM}$	150 $T_C = 90^\circ\text{C}$		Amp
Average Rectified Forward Current (Rated $V_R$ )	$I_O$	75 $T_C = 90^\circ\text{C}$		Amp
Non-repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	$I_{FSM}$	1000		Amp
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +150		$^\circ\text{C}$
Peak Operating Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175		$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000		$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS

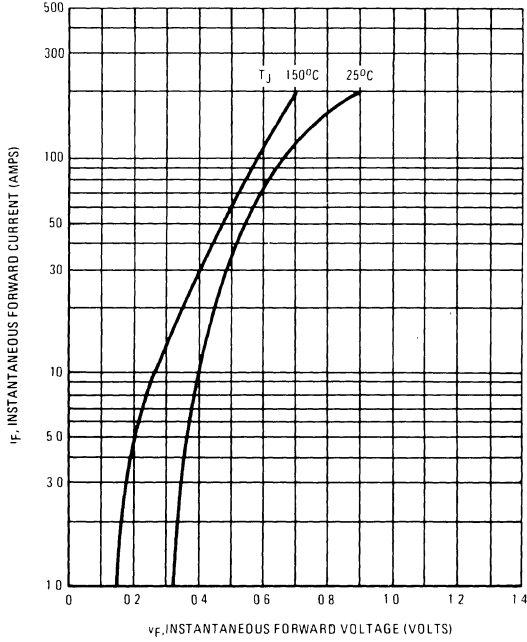
Rating	Symbol	MBR7535	MBR7545	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.8		$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	MBR7535	MBR7545	Unit
Maximum Instantaneous Forward Voltage (1) ( $i_F = 60$ Amp, $T_C = 125^\circ\text{C}$ ) ( $i_F = 220$ Amp, $T_C = 125^\circ\text{C}$ )	$v_F$	0.60 0.90		Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ )	$i_R$	150	250	mA
Capacitance ( $V_R = 5.0$ Vdc, $100$ kHz $\leq f \leq 1.0$ MHz)	$C_t$	4000		$\mu\text{F}$

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2.0%.

FIGURE 1 – TYPICAL FORWARD VOLTAGE



3

FIGURE 2 – CURRENT DERATING

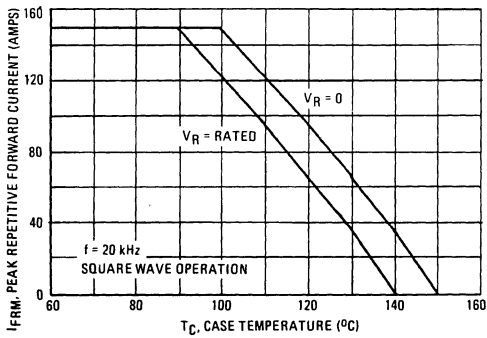
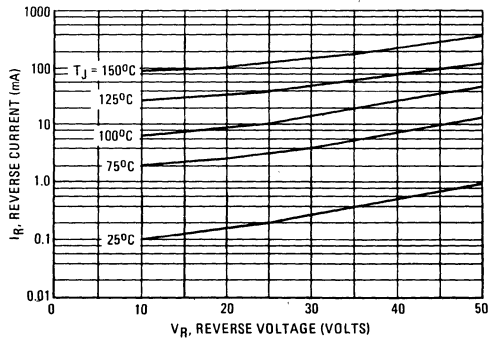


FIGURE 3 – TYPICAL REVERSE OPERATION



MBR8045 is a  
 Motorola Preferred Device

## Switchmode Power Rectifiers

... using a platinum barrier metal in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

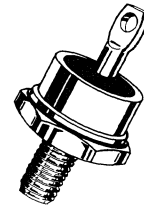
- Guaranteed Reverse Avalanche
- Guardring for  $dv/dt$  Stress Protection
- 175°C Operating Junction Temperature
- Low Forward Voltage

### Mechanical Characteristics:

- Case: Welded steel, hermetically sealed
- Weight: 17 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Solder Heat: The excellent heat transfer property of the heavy duty copper anode terminal which transmits heat away from the die requires that caution be used when attaching wires. Motorola suggests a heat sink be clamped between the eyelet and the body during any soldering operation.
- Stud Torque: 25 lb-in max
- Shipped 25 units per rail
- Marking: B8035, B8045

### SCHOTTKY RECTIFIERS

80 AMPERES  
 35 and 45 VOLTS



CASE 257-01  
 DO-203AB  
 METAL

### MAXIMUM RATINGS

Rating	Symbol	MBR8035	MBR8045	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	35	45	Volts
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 120^\circ\text{C}$	$I_{FRM}$	160	160	Amps
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 120^\circ\text{C}$	$I_O$	80	80	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 7	$I_{RRM}$	2.0	2.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	1000	1000	Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	1000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.80	0.80	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 80$ Amp, $T_C = 25^\circ\text{C}$ ) ( $I_F = 80$ Amp, $T_C = 150^\circ\text{C}$ ) ( $I_F = 160$ Amp, $T_C = 150^\circ\text{C}$ )	$V_F$	0.72 0.59 0.67	0.72 0.59 0.67	Volts
Maximum Instantaneous Reverse Current (1) (Rated Voltage, $T_C = 25^\circ\text{C}$ ) (Rated Voltage, $T_C = 150^\circ\text{C}$ )	$I_R$	1.0 150	1.0 150	mA
Capacitance ( $V_R = 1.0$ Vdc, 100 kHz $\leq f \leq 1.0$ MHz)	$C_t$	5000	5000	pF

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 1

FIGURE 1 — TYPICAL FORWARD VOLTAGE

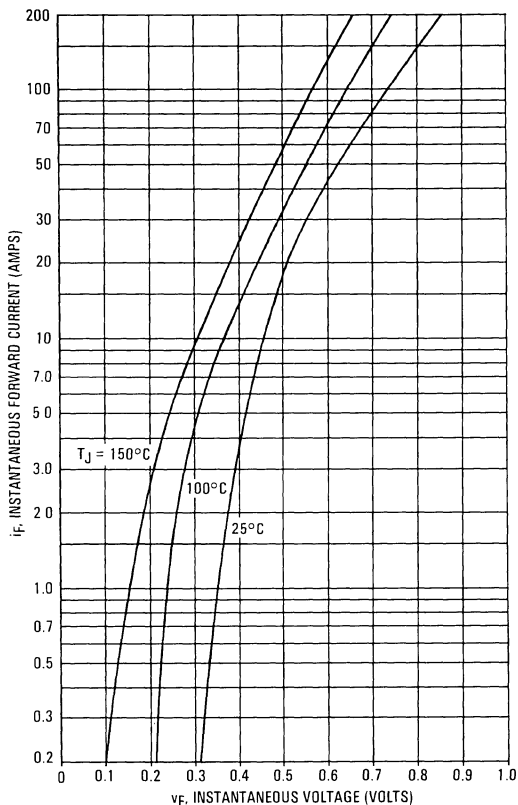


FIGURE 2 — TYPICAL REVERSE CURRENT

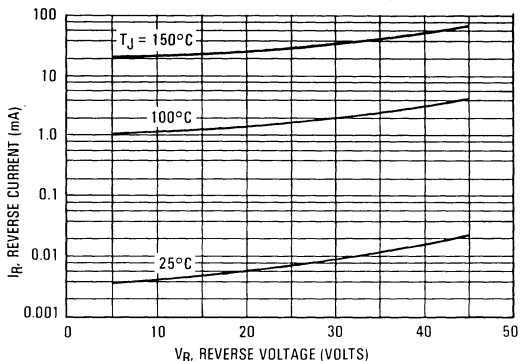
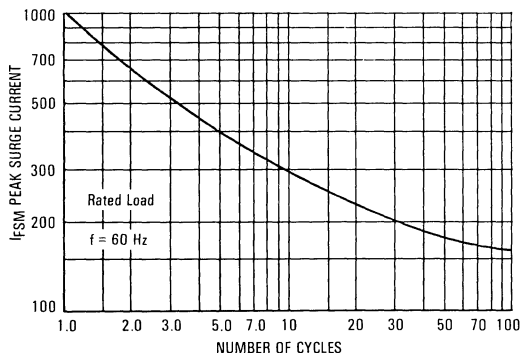


FIGURE 3 — MAXIMUM SURGE CAPABILITY



**NOTE 1  
HIGH FREQUENCY OPERATION**

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 4.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

FIGURE 4 — CAPACITANCE

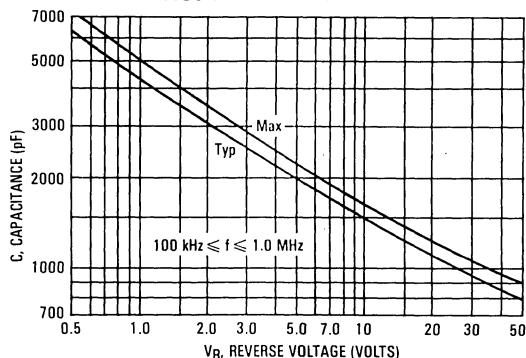


FIGURE 5 — FORWARD CURRENT DERATING

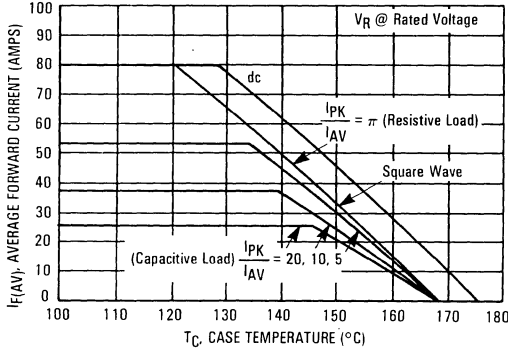
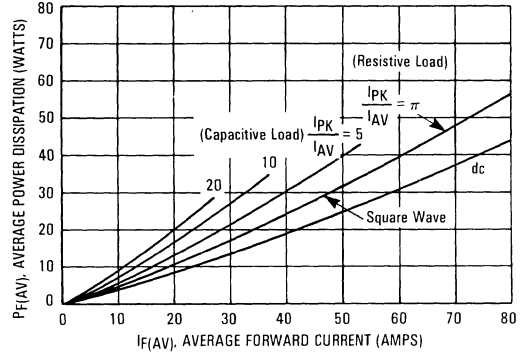
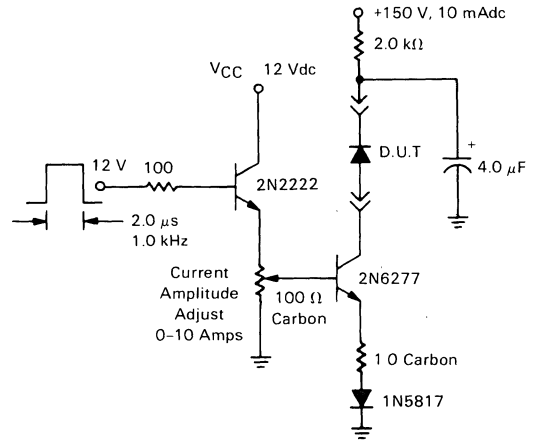


FIGURE 6 — POWER DISSIPATION

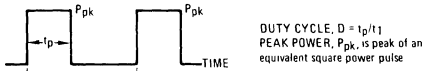


3

FIGURE 7 — TEST CIRCUIT FOR  $dv/dt$  AND REVERSE SURGE CURRENT



NOTE 2



To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended

The temperature of the case should be measured using a thermocouple placed on the case. The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of  $T_C$ , the junction temperature may be determined by:

$$T_J = T_C + \Delta T_{JC}$$

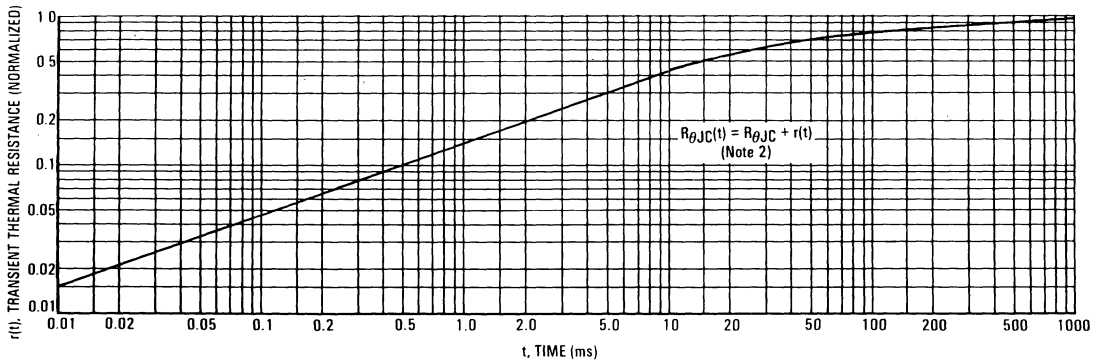
where  $\Delta T_{JC}$  is the increase in junction temperature above the case temperature. It may be determined by:

$$\Delta T_{JC} = P_{pk} \cdot R_{\theta JC} [D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1)]$$

where  $r(t)$  normalized value of transient thermal resistance at time,  $t$ , from Figure 8, i.e.:

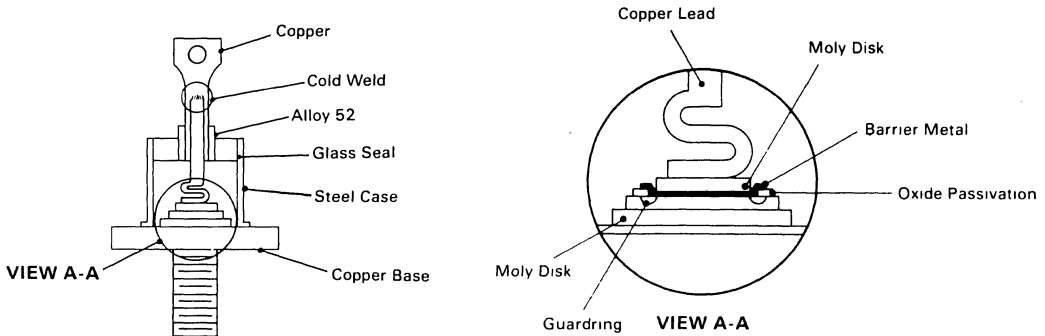
$$r(t_1 + t_p) \text{ normalized value of transient thermal resistance at time } t_1 + t_p$$

FIGURE 8 — THERMAL RESPONSE



# MBR8035, MBR8045

FIGURE 9 — SCHOTTKY RECTIFIER



Motorola builds quality and reliability into its Schottky Rectifiers.

First is the chip, which has an interface metal between the platinum-barrier metal and nickel-gold ohmic-contact metal to eliminate any possible interaction with the barrier. The indicated guardring prevents  $dv/dt$  problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. There are molybdenum disks which closely match the thermal coefficient of expansion of silicon on each side of the chip. The top copper lead has a stress relief

feature which protects the die during assembly. These two features give the unit the capability of passing stringent thermal fatigue tests for 5,000 cycles. The top copper lead provides a low resistance to current and therefore does not contribute to device heating; a heat sink should be used when attaching wires.

Third is the redundant electrical testing. The device is tested before assembly in "sandwich" form, with the chip between the moly disks. It is tested again after assembly. As part of the final electrical test, devices are 100% tested for  $dv/dt$  at  $1,600 V/\mu s$  and reverse avalanche.



MBR3045CT and SD241 are  
 Motorola Preferred Devices

## Switchmode Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

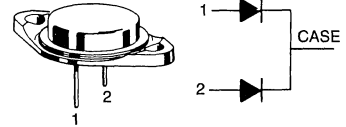
- Dual Diode Construction
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

### Mechanical Characteristics:

- Case: Copper slug header, welded steel can, hermetically sealed
- Weight: 18.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 100 units per foam tray
- Marking: MBR3045CT, SD241

### SCHOTTKY BARRIER RECTIFIERS

**30 AMPERES**  
**20 to 45 VOLTS**



**CASE 11-03**  
**TO-204AA**  
**METAL**

### MAXIMUM RATINGS

Rating	Symbol	MBR3045CT	SD241	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	45	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 105^\circ\text{C}$	$I_O$ Per Device Per Diode	30 15	30 15	Amps
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz)	$I_{FRM}$	30	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	400	400	Amps
Peak Repetitive Reverse Current, Per Diode (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 8	$I_{RRM}$	2.0	2.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	-65 to +175	$^\circ\text{C}$
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	175	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	10000	$\text{V}/\mu\text{s}$

### THERMAL CHARACTERISTICS PER DIODE

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.4	1.4	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS PER DIODE

Maximum Instantaneous Forward Voltage (1) ( $I_F = 10$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 20$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 30$ Amp, $T_C = 125^\circ\text{C}$ ) ( $I_F = 30$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	— 0.60 0.72 0.76	0.47 0.60 — —	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$I_R$	60 1.0	100 $V_R = 35$ V	mA
Capacitance	$C_t$	2000	2000	pF

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 2

FIGURE 1 — TYPICAL FORWARD VOLTAGE

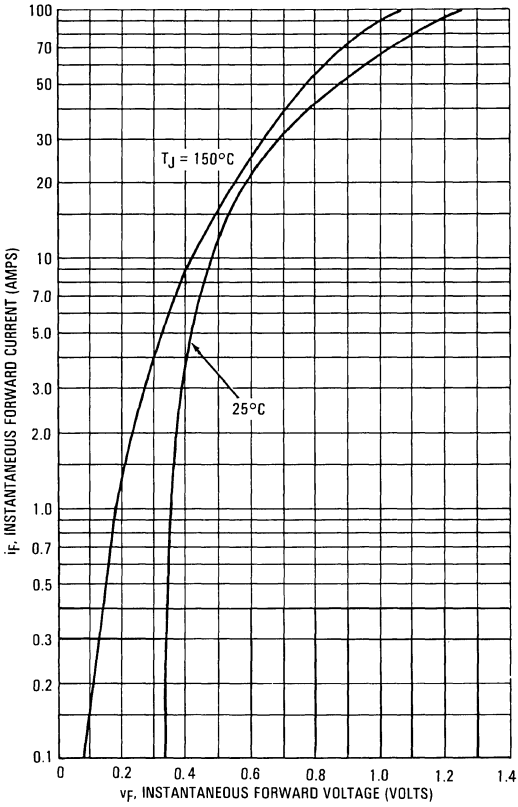


FIGURE 2 — TYPICAL REVERSE CURRENT

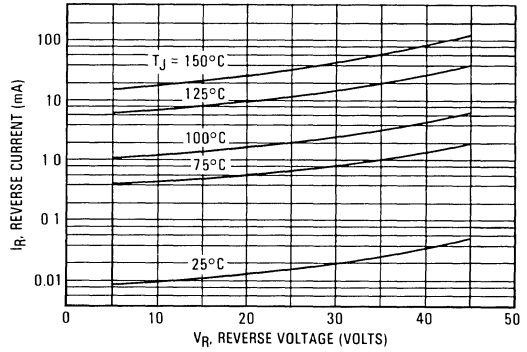


FIGURE 3 — MAXIMUM SURGE CAPABILITY

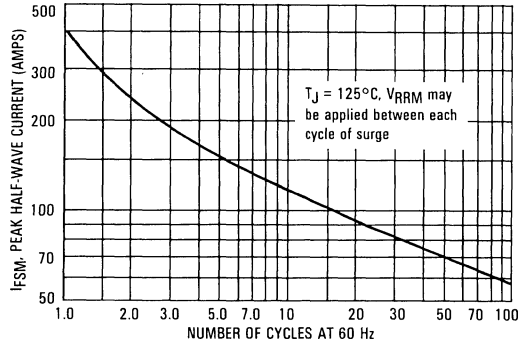


FIGURE 4 — CURRENT DERATING

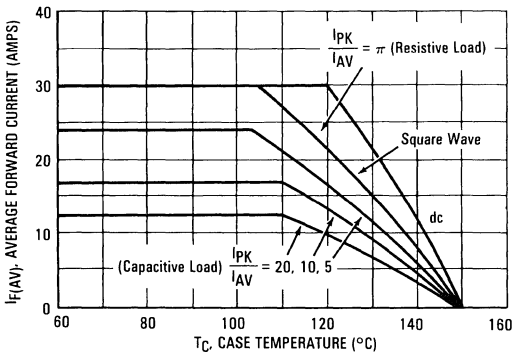


FIGURE 5 — FORWARD POWER DISSIPATION

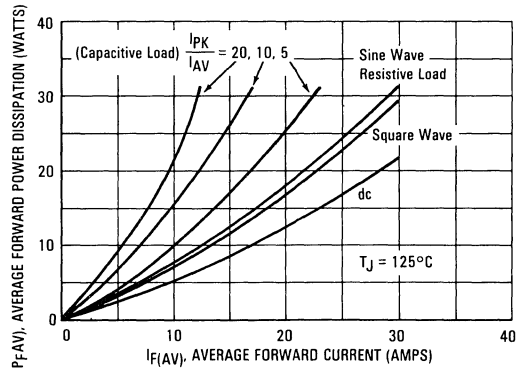
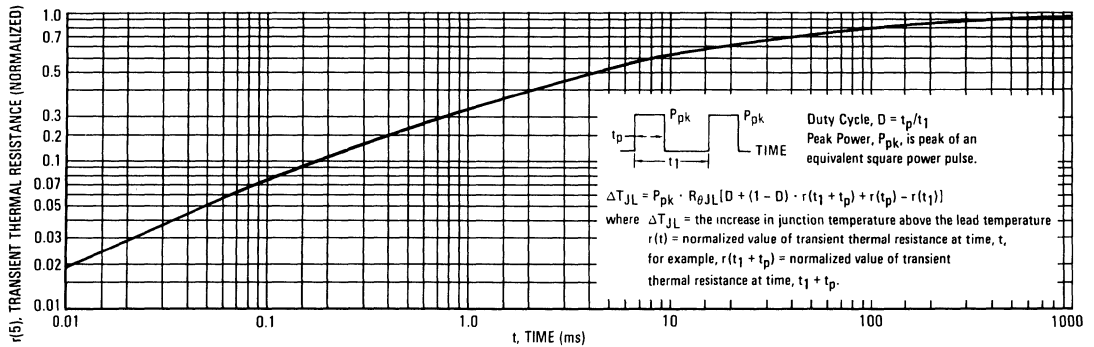


FIGURE 6 — THERMAL RESPONSE PER DIODE LEG



HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 7.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

FIGURE 7 — CAPACITANCE

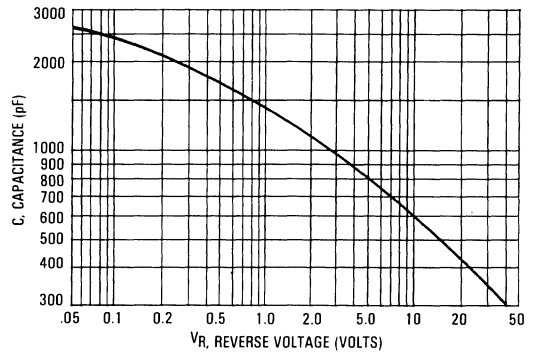
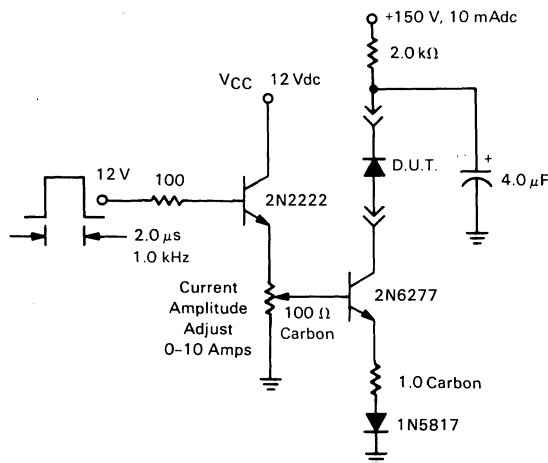


FIGURE 8 — TEST CIRCUIT FOR REPETITIVE REVERSE CURRENT



Product Preview  
**POWERTAP™ II**  
**SWITCHMODE™ Power Rectifier**

The SWITCHMODE Power Rectifier uses the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings

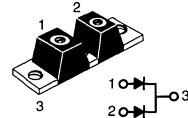
**Mechanical Characteristics**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb–in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B20030L

**MBRP20030CTL**

Motorola Preferred Device

**LOW V<sub>F</sub>**  
**SCHOTTKY BARRIER**  
**RECTIFIER**  
**200 AMPERES**  
**30 VOLTS**



**CASE 357C-03**  
**POWERTAP**

3

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>VRWM</sub> V <sub>R</sub>	30	Volts
Average Rectified Forward Current (At Rated V <sub>R</sub> ) T <sub>C</sub> = +125°C	I <sub>F(AV)</sub> Per Leg Per Device	100 200	Amps
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz) T <sub>C</sub> = +100°C	I <sub>FRM</sub>	200	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	1500	Amps
Peak Repetitive Reverse Surge Current (2 μs, 1 kHz)	I <sub>RRM</sub>	2	Amp
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	T <sub>J</sub>	-55 to +150	°C
Voltage Rate of Change (Rated V <sub>F</sub> )	dv/dt	10000	V/μs

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Case	R <sub>θJC</sub>	0.45	°C/W
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**ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (2) (I <sub>F</sub> = 200 Amps, T <sub>C</sub> = +25°C) (I <sub>F</sub> = 200 Amps, T <sub>C</sub> = +25°C)	V <sub>F</sub>	0.52 0.60	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, T <sub>C</sub> = +25°C)	I <sub>R</sub>	5	mA

(1) Rating applies when surface mounted on the minimum pad size recommended.

(2) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2%.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

*Preliminary Data Sheet*

**POWERTAP II**  
**SWITCHMODE Power Rectifiers**

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

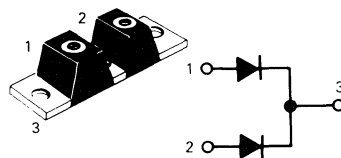
- Dual Diode Construction — May Be Paralleled For Higher Current Output
- Guardring For Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature

**Mechanical Characteristics:**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb–in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B20045T, B20060T

**SCHOTTKY BARRIER  
RECTIFIERS**

**200 AMPERES**  
**45 to 60 VOLTS**



**CASE 357C-03  
POWERTAP II**

3

**MAXIMUM RATINGS**

Rating	Symbol	MBRP20045CT	MBRP20060CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	60	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 140^\circ\text{C}$ Per Device Per Leg	$I_{F(AV)}$	200 100	200 100	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 140^\circ\text{C}$	$I_{FRM}$	200	200	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	1500	1500	Amps
Peak Repetitive Reverse Current, Per Leg (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 6	$I_{RRM}$	2.0	2.0	Amps
Operating Junction Temperature	$T_J$	-55 to +175	-55 to +175	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +150	-55 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	10000	$\text{V}/\mu\text{s}$

**THERMAL CHARACTERISTICS PER LEG**

Thermal Resistance — Junction to Case	$R_{\theta JC}$	0.6	0.6	$^\circ\text{C}/\text{W}$
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**ELECTRICAL CHARACTERISTICS PER LEG**

Instantaneous Forward Voltage (1) ( $I_F = 200$ Amp, $T_J = 25^\circ\text{C}$ ) ( $I_F = 200$ Amp, $T_J = 25^\circ\text{C}$ )	$V_F$	0.89 0.78	0.91 0.80	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$I_R$	50 0.5	50 0.5	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

*Preliminary Data Sheet*

**POWERTAP II**  
**SWITCHMODE Power Rectifiers**

... using the Schottky Barrier principle with a platinum barrier metal.  
 These state-of-the-art devices have the following features:

- Dual Diode Construction — May Be Paralleled For Higher Current Output
- Guardring For Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

**Mechanical Characteristics:**

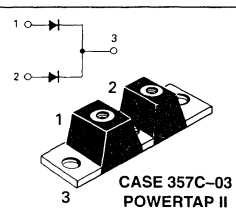
- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B30045T, B30060T

**MBRP30045CT**  
**MBRP30060CT**

Motorola Preferred Devices

**SCHOTTKY BARRIER**  
**RECTIFIERS**  
**300 AMPERES**  
**45 to 60 VOLTS**

**3**



**MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	45	Volts
Working Peak Reverse Voltage	$V_{RWM}$	60	
DC Blocking Voltage	$V_R$	60	
Average Rectified Forward Current (Rated $V_R$ , $T_C = 140^\circ\text{C}$ )	$I_{F(AV)}$	300 150	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 140^\circ\text{C}$	$I_{FRM}$	300	Amps
Nonrepetitive Peak Surge Current Per Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	2500	Amps
Peak Repetitive Reverse Current, Per Leg (2.0 $\mu\text{s}$ , 1.0 kHz) See Figure 6	$I_{RRM}$	2.0	Amps
Operating Junction Temperature	$T_J$	-55 to +175	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	$\text{V}/\mu\text{s}$

**THERMAL CHARACTERISTICS PER LEG**

Thermal Resistance — Junction to Case	$R_{\theta JC}$	0.45	$^\circ\text{C}/\text{W}$
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**ELECTRICAL CHARACTERISTICS PER LEG**

Instantaneous Forward Voltage (1) ( $i_F = 150$ Amp, $T_J = 25^\circ\text{C}$ ) ( $i_F = 300$ Amp, $T_J = 25^\circ\text{C}$ ) ( $i_F = 150$ Amp, $T_J = 25^\circ\text{C}$ ) ( $i_F = 300$ Amp, $T_J = 25^\circ\text{C}$ )	MBRP30045CT MBRP30045CT MBRP30060CT MBRP30060CT	$v_F$	0.70 0.82 0.79 0.89	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )		$I_R$	75 0.8	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

Product Preview

**POWERTAP™ II**  
**SWITCHMODE™ Power Rectifier**

The SWITCHMODE Power Rectifier uses the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction — May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings

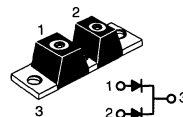
**Mechanical Characteristics**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25–40 lb–in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B60035L

**MBRP60035CTL**

Motorola Preferred Device

**LOW  $V_F$**   
**SCHOTTKY BARRIER**  
**RECTIFIER**  
**600 AMPERES**  
**35 VOLTS**



**CASE 357C-03**  
**POWERTAP**

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	35	Volts
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_R$		
Average Rectified Forward Current (At Rated $V_R$ ) $T_C = +100^\circ\text{C}$	$I_F(AV)$	300 600	Amps
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz) $T_C = +100^\circ\text{C}$	$I_{FRM}$	300	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	4000	Amps
Peak Repetitive Reverse Surge Current (2 $\mu\text{s}$ , 1 kHz)	$I_{RRM}$	2	Amp
Storage Temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	-55 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10000	$\text{V}/\mu\text{s}$

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Case	$R_{\theta JC}$	0.4	$^\circ\text{C}/\text{W}$
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**ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (2) ( $i_F = 300$ Amps, $T_C = +25^\circ\text{C}$ ) ( $i_F = 300$ Amps, $T_C = +100^\circ\text{C}$ )	$V_F$	0.57 0.50	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = +25^\circ\text{C}$ ) (Rated dc Voltage, $T_C = +100^\circ\text{C}$ )	$I_R$	10 250	mA


- (1) Rating applies when surface mounted on the minimum pad size recommended.  
(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

*Advance Information*  
**SWITCHMODE™ Schottky**  
**Power Rectifier**

... using the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

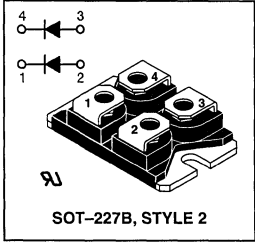
- 100 V Blocking Voltage, Low Forward Voltage Drop
- Double Rectifier Diodes Construction: May Be Paralleled for Higher Current Output up to 80 Amp
- Guardring Construction Guarantees Stress Protection, High dV/dt Capability (10 kV/μs) and Reverse Avalanche
- Very Low Internal Parasitic Inductance ( $\leq 5.0$  nH)
- Isolated Power Package (2500 Vac Insulation Rating)
- 175°C Operating Junction Temperature
-  — UL Recognized, File #E69369

**Mechanical Characteristics**

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: MBR240100V

**MBR240100V**

**SCHOTTKY BARRIER  
RECTIFIER  
80 AMPERES  
100 VOLTS**



**3**

**MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	100	Volts
Average Rectified Forward Current — Per Diode (Rated $V_C$ ) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	40 80	Amps
Peak Repetitive Forward Current, Per Diode (Rated $V_F$ , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	$I_{FRM}$	120	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	600	Amps
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	$I_{RRM}$	2.0	Amps
Operating Junction Temperature	$T_J$	-65 to 150	°C
Storage Temperature	$T_{stg}$	-65 to 150	°C
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	°C
Voltage Rate of Change	dV/dt	10000	V/μs
Package Insulation Rating (AC)	$V_{isol}$	2500	Volts



# MBR240100V

## THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Thermal Resistance, Junction to Case Per Diode Per Device	$R_{\theta JC}$	1.2 0.7	$^{\circ}C/W$

## ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) @ $i_F = 40$ Amps, $T_C = 25^{\circ}C$ @ $i_F = 40$ Amps, $T_C = 100^{\circ}C$ @ $i_F = 80$ Amps, $T_C = 100^{\circ}C$	$v_F$	0.95 0.80 0.90	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^{\circ}C$ @ Rated DC Voltage, $T_C = 100^{\circ}C$	$i_R$	0.1 20	mA

(1) Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle < 2.0%

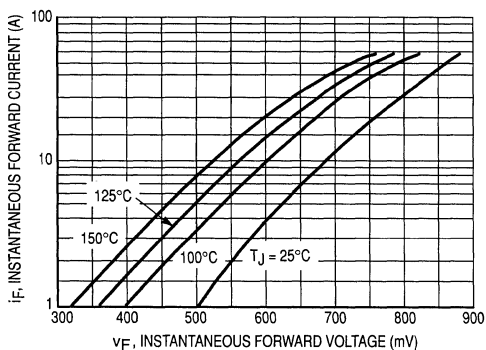


Figure 1. Typical Forward Voltage

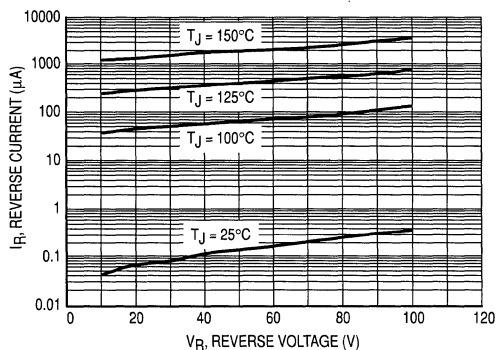



Figure 2. Typical Reverse Current

Advance Information  
**SWITCHMODE™ Schottky**  
**Power Rectifier**

... using the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

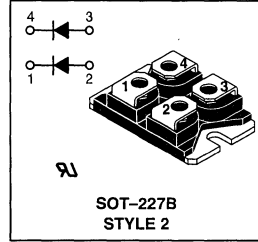
- 60 V Blocking Voltage, Low Forward Voltage Drop
- Double Rectifier Diodes Construction: May Be Paralleled for Higher Current Output up to 100 Amp
- Guardring Construction Guarantees Stress Protection, High dV/dt Capability (10 kV/μs) and Reverse Avalanche
- Very Low Internal Parasitic Inductance (≤ 5.0 nH)
- Isolated Power Package (2500 Vac Insulation Rating)
- 150°C Operating Junction Temperature
-  — UL Recognized, File #E69369

**Mechanical Characteristics**

- Case: Molded epoxy with isolated metal base
- Weight: 28 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: MBR25060V

**MBR25060V**

**SCHOTTKY BARRIER  
RECTIFIER  
100 AMPERES  
60 VOLTS**



**3**

**MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	60	Volts
Average Rectified Forward Current — Per Diode (Rated $V_R$ ) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_F(AV)$	50 100	Amps
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	$I_{FRM}$	150	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	800	Amps
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	$I_{RRM}$	2.0	Amps
Operating Junction Temperature	$T_J$	-65 to 150	°C
Storage Temperature	$T_{stg}$	-65 to 150	°C
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	°C
Voltage Rate of Change	dV/dt	10000	V/μs
Package Insulation Rating (AC)	$V_{isol}$	2500	Volts

**THERMAL CHARACTERISTICS**

Thermal Resistance, Junction to Case	Per Diode Per Device	$R_{\theta JC}$	1.2 0.7	°C/W
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**ELECTRICAL CHARACTERISTICS PER DIODE**

Instantaneous Forward Voltage (1) @ $i_F = 50$ Amps, $T_C = 25^\circ\text{C}$ @ $i_F = 50$ Amps, $T_C = 100^\circ\text{C}$	$v_F$	0.65 0.60	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	$i_R$	0.5 20	mA


(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle < 2.0%

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Rev 1

*Advance Information*  
**SWITCHMODE™ Schottky**  
**Power Rectifier**

... using the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- 45 V Blocking Voltage, Low Forward Voltage Drop
- Double Rectifier Diodes Construction: May Be Paralleled for Higher Current Output up to 160 Amp
- Guardring Construction Guarantees Stress Protection, High dV/dt Capability (10 kV/μs) and Reverse Avalanche
- Very Low Internal Parasitic Inductance ( $\leq 5.0$  nH)
- Isolated Power Package (2500 Vac Insulation Rating)
- 175°C Operating Junction Temperature
-  — UL Recognized, File #E69369

**Mechanical Characteristics**

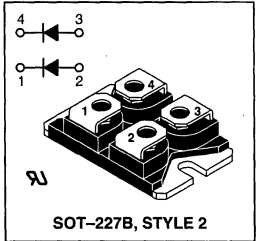
- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: MBR28045V

**MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	45	Volts
Average Rectified Forward Current — Per Diode (Rated $V_R$ ) @ $T_C = 125^\circ\text{C}$ — Per Device	$I_{F(AV)}$	80 160	Amps
Peak Repetitive Forward Current, Per Diode (Rated $V_R$ , Square Wave, 20 kHz) @ $T_C = 90^\circ\text{C}$	$I_{FRM}$	145	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	900	Amps
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	$I_{RRM}$	2.0	Amps
Operating Junction Temperature	$T_J$	-65 to 150	°C
Storage Temperature	$T_{stg}$	-65 to 150	°C
Peak Surge Junction Temperature (Forward Current Applied)	$T_{J(pk)}$	175	°C
Voltage Rate of Change	dV/dt	10000	V/μs
Package Insulation Rating (AC)	$V_{isol}$	2500	Volts

**MBR28045V**

**SCHOTTKY BARRIER  
RECTIFIER  
160 AMPERES  
45 VOLTS**



3

# MBR28045V

## THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Thermal Resistance, Junction to Case Per Diode Per Device	$R_{\theta JC}$	1.1 0.6	$^{\circ}C/W$

## ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) @ $i_F = 80$ Amps, $T_C = 25^{\circ}C$ @ $i_F = 80$ Amps, $T_C = 150^{\circ}C$ @ $i_F = 160$ Amps, $T_C = 25^{\circ}C$	$v_F$	0.8 0.69 1.0	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^{\circ}C$ @ Rated DC Voltage, $T_C = 100^{\circ}C$	$i_R$	1.0 80	mA

(1) Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle < 2.0%

3

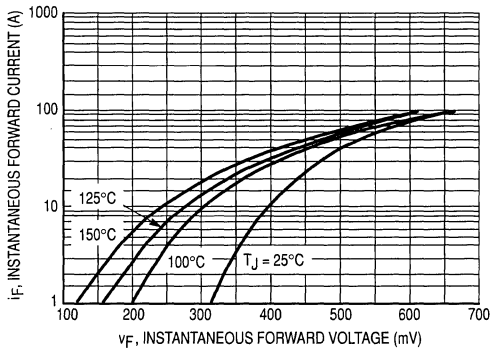


Figure 1. Typical Forward Voltage

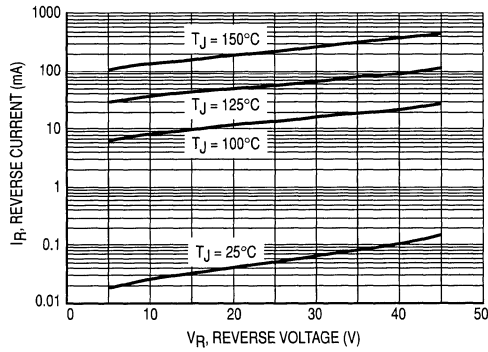


Figure 2. Typical Reverse Current

## Switchmode™ Power Rectifier

Using the Schottky Barrier principle with a proprietary barrier metal. These state-of-the-art devices have the following features:

- Guarding for Stress Protection
- Maximum Die Size
- 150°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured – Not Sheared

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units per Plastic Tube
- Available in 24 mm Tape and Reel, 800 Units per 13" Reel by Adding a "T4" Suffix to the Part Number
- Marking: B3030

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	30	V
Average Rectified Forward Current (At Rated $V_R$ ) $T_C = +134^\circ\text{C}$	Per Device $I_F(AV)$ Per Leg	30 15	A
Peak Repetitive Forward Current, Per Leg (At Rated $V_R$ , Square Wave, 20 kHz) $T_C = +137^\circ\text{C}$	$I_{FRM}$	30	A
Nonrepetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	$I_{FSM}$	200	A
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	A
Storage Temperature	$T_{stg}$	- 55 to +150	°C
Operating Junction Temperature	$T_J$	- 55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000	V/ $\mu\text{s}$
Reverse Energy (Unclamped Inductive Surge) (Inductance = 3 mH), $T_C = 25^\circ\text{C}$	W	100	mJ

### THERMAL CHARACTERISTICS

Thermal Resistance – Junction to Case	$R_{\theta JC}$	1.0	°C/W
Thermal Resistance – Junction to Ambient (1)	$R_{\theta JA}$	50	°C/W

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (2), per Leg ( $I_F = 15\text{ A}$ , $T_C = +25^\circ\text{C}$ ) ( $I_F = 15\text{ A}$ , $T_C = +150^\circ\text{C}$ ) ( $I_F = 30\text{ A}$ , $T_C = +25^\circ\text{C}$ ) ( $I_F = 30\text{ A}$ , $T_C = +150^\circ\text{C}$ )	$V_F$	0.54 0.47 0.67 0.66	V
Maximum Instantaneous Reverse Current (2), per Leg (Rated DC Voltage, $T_C = +25^\circ\text{C}$ ) (Reverse Voltage = 10 V, $T_C = +150^\circ\text{C}$ ) (Rate DC Voltage, $T_C = +150^\circ\text{C}$ )	$I_R$	0.6 46 145	mA

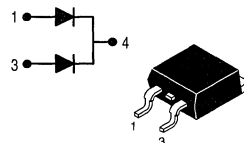
1. When mounted using minimum recommended pad size on FR-4 board.
2. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Preferred devices are Motorola recommended choices for future use and best overall value.

# MBRB3030CT

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
30 AMPERES  
30 VOLTS**



CASE 418B-02  
D<sup>2</sup>PAK

# MBRB3030CT

## Electrical Characteristics

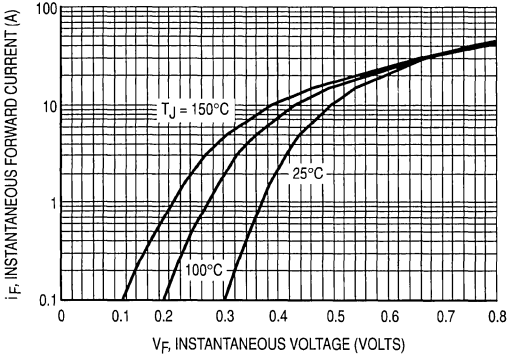


Figure 1. Maximum Forward Voltage, Per Leg

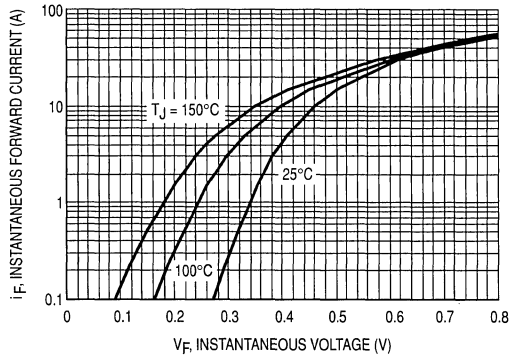


Figure 2. Typical Forward Voltage, Per Leg

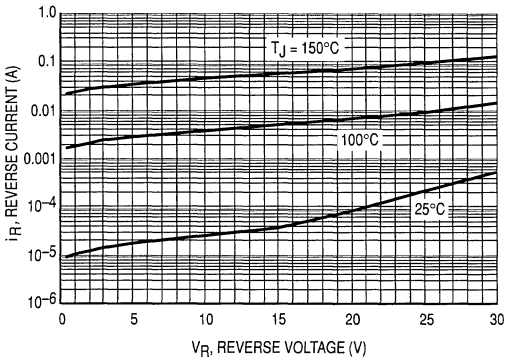


Figure 3. Maximum Reverse Current, Per Leg

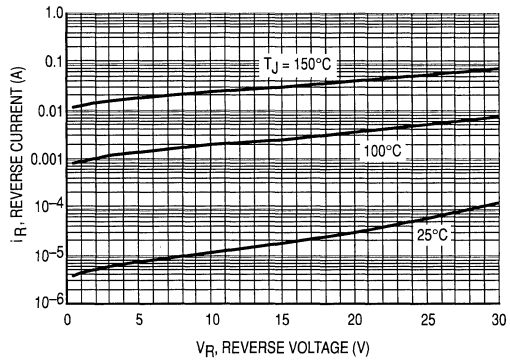


Figure 4. Typical Reverse Current, Per Leg

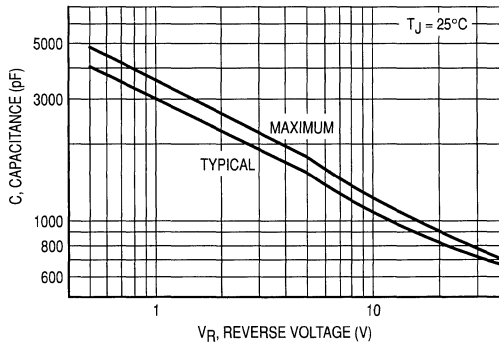


Figure 5. Capacitance

3

# MBRB3030CT

## Typical Characteristics

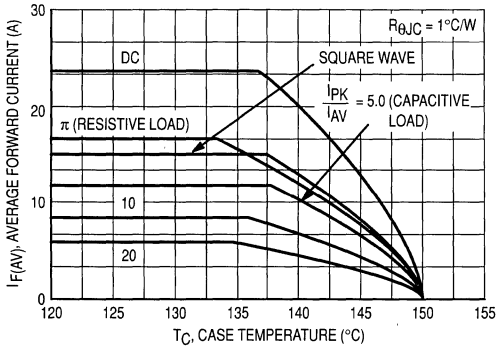


Figure 6. Current Derating, Infinite Heatsink

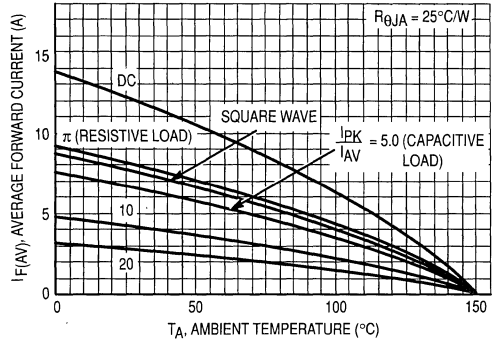


Figure 7. Current Derating

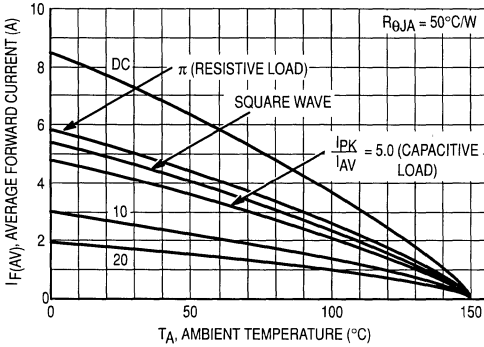


Figure 8. Current Derating, Free Air

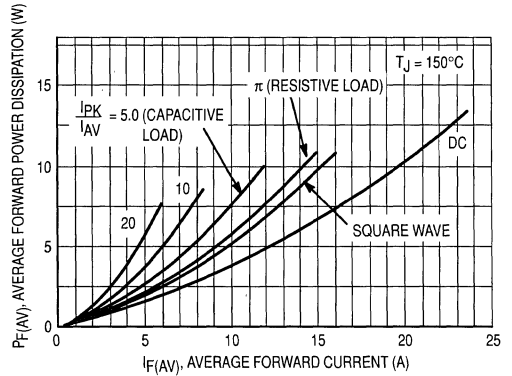


Figure 9. Forward Power Dissipation

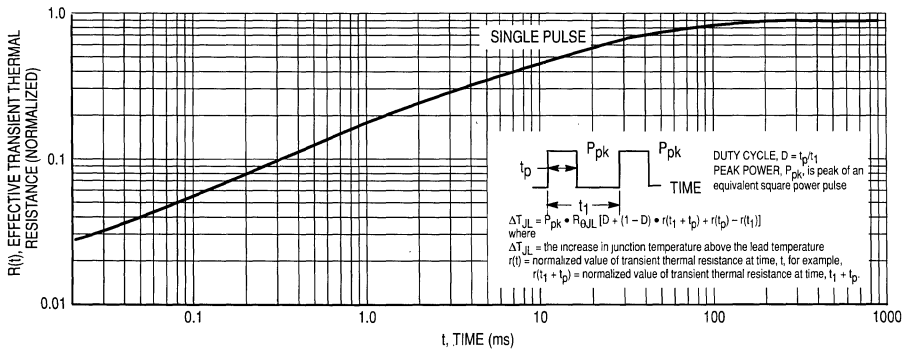


Figure 10. Thermal Response

## Switchmode Power Rectifier

Using the Schottky Barrier principle with a proprietary barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Maximum Die Size
- 150°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured – Not Sheared

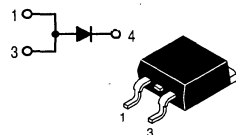
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.7 Grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
- Shipped 50 Units per Plastic Tube
- Available in 24 mm Tape and Reel, 800 Units per 13" Reel by Adding a "T4" Suffix to the Part Number
- Marking: B4030

**MBRB4030**

Motorola Preferred Device

**SCHOTTKY BARRIER  
RECTIFIER  
40 AMPERES  
30 VOLTS**



CASE 418B-02  
D2PAK

3

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	30	V
Average Rectified Forward Current (At Rated $V_R$ ) $T_C = +115^\circ\text{C}$ (1)	$I_{F(AV)}$	40	A
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz) $T_C = +112^\circ\text{C}$	$I_{FRM}$	80	A
Nonrepetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	$I_{FSM}$	300	A
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	A
Storage Temperature	$T_{stg}$	- 65 to +150	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	- 65 to +150	$^\circ\text{C}$
Voltage Rate of Change (Rated $V_R$ )	$dv/dt$	10,000	V/ $\mu\text{s}$
Reverse Energy (Unclamped Inductive Surge) (Inductance = 3 mH), $T_C = 25^\circ\text{C}$	W	600	mJ

### THERMAL CHARACTERISTICS

Thermal Resistance – Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C}/\text{W}$
Thermal Resistance – Junction to Ambient (2)	$R_{\theta JA}$	50	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1 and 3), per Device ( $I_F = 20\text{ A}$ , $T_C = +25^\circ\text{C}$ ) ( $I_F = 20\text{ A}$ , $T_C = +150^\circ\text{C}$ ) ( $I_F = 40\text{ A}$ , $T_C = +25^\circ\text{C}$ ) ( $I_F = 40\text{ A}$ , $T_C = +150^\circ\text{C}$ )	$V_F$	0.46 0.34 0.55 0.45	V
Maximum Instantaneous Reverse Current (3), per Device (Rated DC Voltage, $T_C = +25^\circ\text{C}$ ) (Rated DC Voltage, $T_C = +125^\circ\text{C}$ )	$I_R$	0.35 150	mA

### NOTES:

1. Rating applies when pins 1 and 3 are connected.
2. Rating applies when surface mounted on the minimum pad size recommended.
3. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Preferred devices are Motorola recommended choices for future use and best overall value.



Electrical Characteristics

3

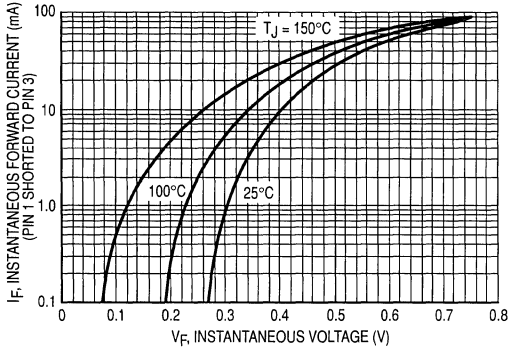


Figure 1. Maximum Forward Voltage

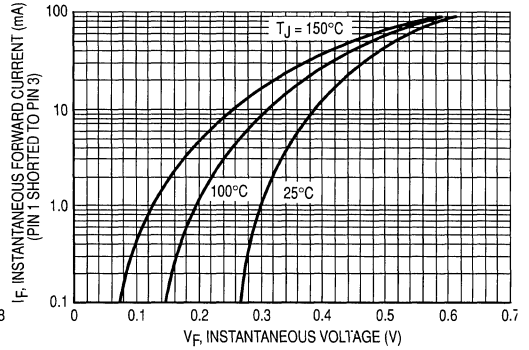


Figure 2. Typical Forward Voltage

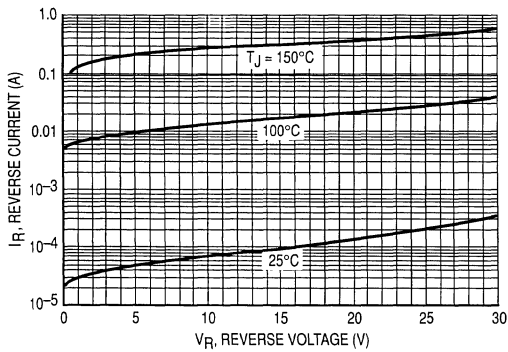


Figure 3. Maximum Reverse Current

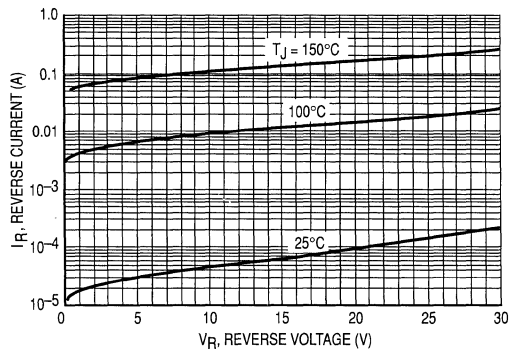


Figure 4. Typical Reverse Current

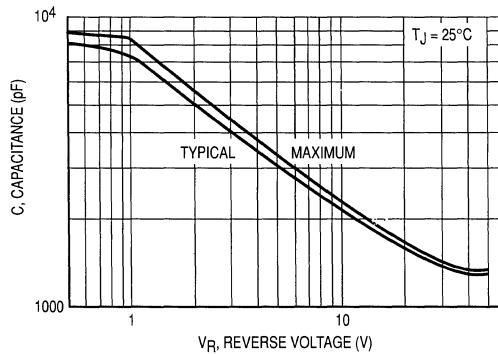


Figure 5. Maximum and Typical Capacitance

Electrical Characteristics

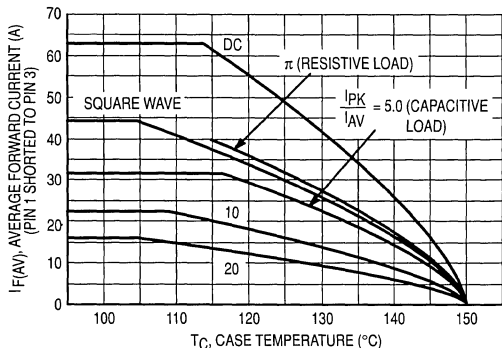


Figure 6. Current Derating, Infinite Heatsink

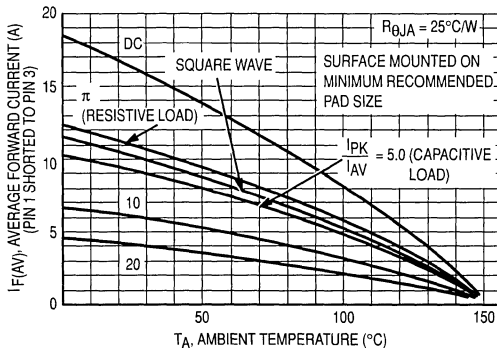


Figure 7. Current Derating

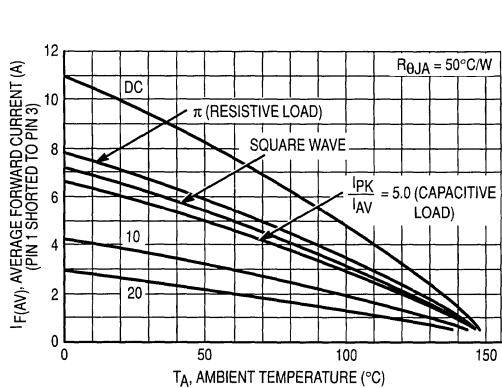


Figure 8. Current Derating, Free Air

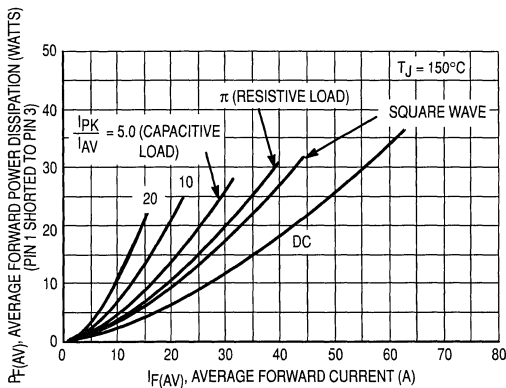


Figure 9. Forward Power Dissipation

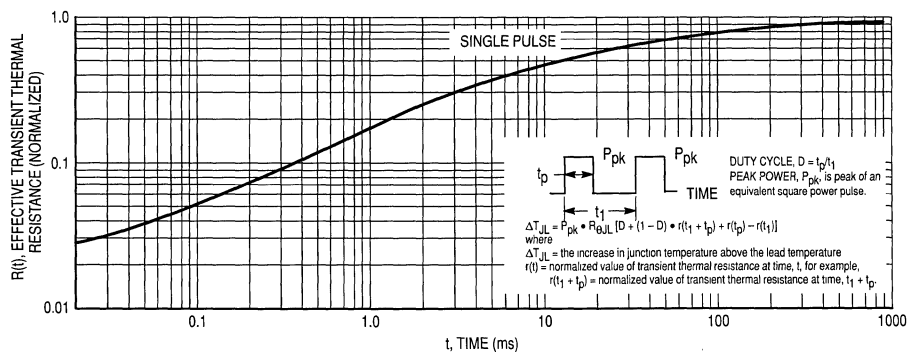


Figure 10. Thermal Response



# ***Section 4***

## **Ultrafast Data Sheets**

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## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 Volts Max @ 1.0 A,  $T_J = 150^\circ\text{C}$ )

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes:  $260^\circ\text{C}$  Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: U1D, U1J

**MURS120T3**  
**MURS160T3**

Motorola Preferred Devices

**ULTRAFAST RECTIFIERS**  
**1.0 AMPERE**  
**200–600 VOLTS**



CASE 403A-03

4

### MAXIMUM RATINGS

Rating	Symbol	MURS		Unit
		120T3	160T3	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	600	Volts
Average Rectified Forward Current	$I_{F(AV)}$	1.0 @ $T_L = 155^\circ\text{C}$ 2.0 @ $T_L = 145^\circ\text{C}$	1.0 @ $T_L = 150^\circ\text{C}$ 2.0 @ $T_L = 125^\circ\text{C}$	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	40	35	Amps
Operating Junction Temperature	$T_J$	–65 to +175		$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Lead ( $T_L = 25^\circ\text{C}$ )	$R_{\theta JL}$	13	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 1.0 \text{ A}$ , $T_J = 25^\circ\text{C}$ ) ( $I_F = 1.0 \text{ A}$ , $T_J = 150^\circ\text{C}$ )	$V_F$	0.875 0.71	1.25 1.05	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 150^\circ\text{C}$ )	$i_R$	2.0 50	5.0 150	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0 \text{ A}$ , $di/dt = 50 \text{ A}/\mu\text{s}$ ) ( $I_F = 0.5 \text{ A}$ , $i_R = 1.0 \text{ A}$ , $I_R$ to 0.25 A)	$t_{rr}$	35 25	75 50	ns
Maximum Forward Recovery Time ( $I_F = 1.0 \text{ A}$ , $di/dt = 100 \text{ A}/\mu\text{s}$ , Rec. to 1.0 V)	$t_{fr}$	25	50	ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 2

# MURS120T3, MURS160T3

MURS120T3

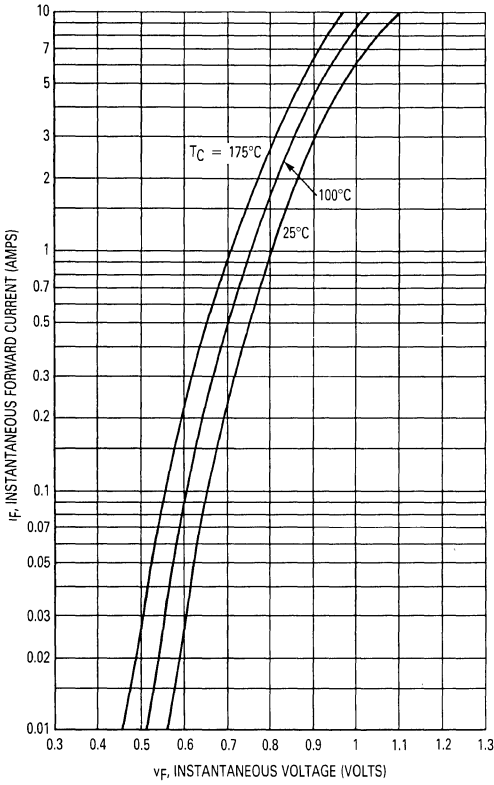


Figure 1. Typical Forward Voltage

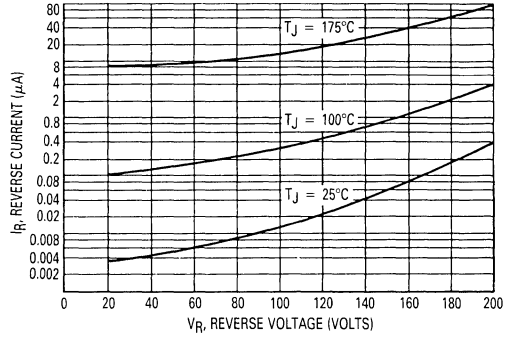


Figure 2. Typical Reverse Current\*

\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied  $V_R$  is sufficiently below rated  $V_R$ .

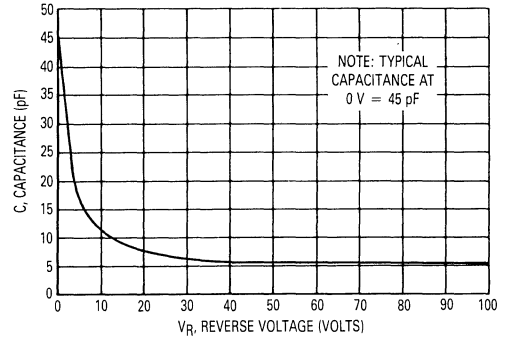


Figure 3. Typical Capacitance

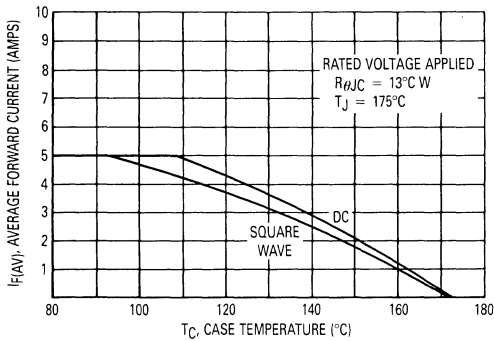


Figure 4. Current Derating, Case

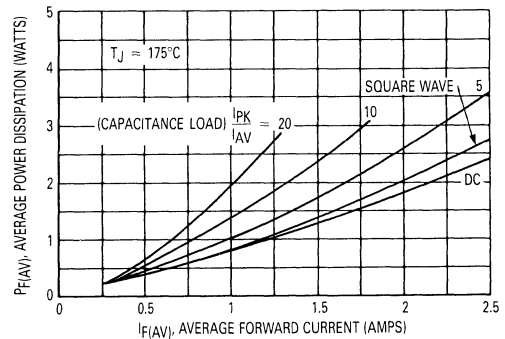


Figure 5. Power Dissipation

4

# MURS120T3, MURS160T3

## MURS160T3

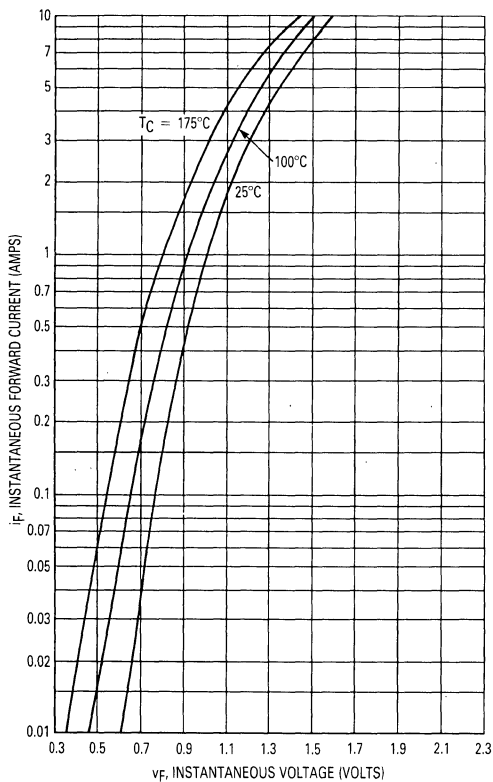


Figure 6. Typical Forward Voltage

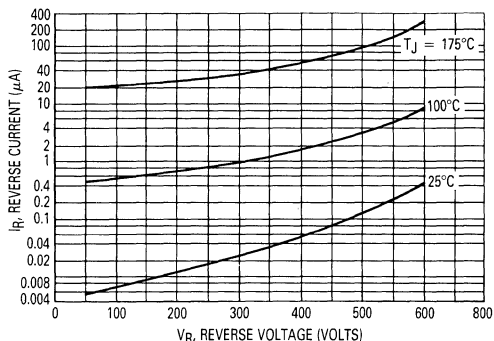


Figure 7. Typical Reverse Current\*

\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied  $V_R$  is sufficiently below rated  $V_R$ .

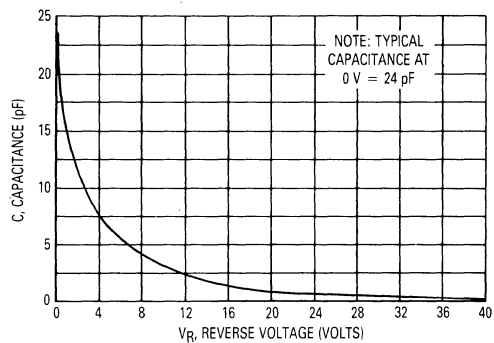


Figure 8. Typical Capacitance

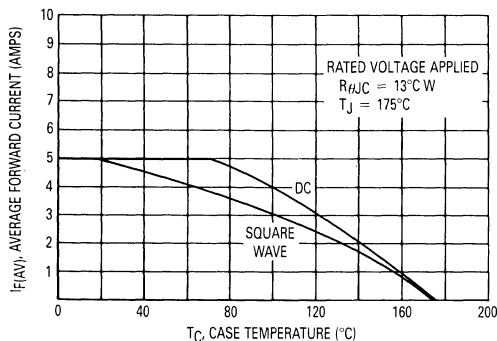


Figure 9. Current Derating, Case

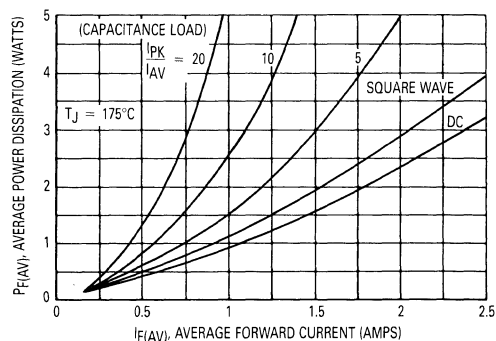


Figure 10. Power Dissipation

# Surface Mount Ultrafast Power Rectifiers

**MURS320T3**  
**MURS360T3**

Motorola Preferred Devices

... employing state-of-the-art epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 Volts Max @ 3.0 A, T<sub>J</sub> = 150°C)

**Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: U3D, U3J

**ULTRAFAST RECTIFIERS**  
**3.0 AMPERES**  
**200-600 VOLTS**



CASE 403-03

**4**

**MAXIMUM RATINGS**

Rating	Symbol	MURS		Unit
		320T3	360T3	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	600	Volts
Average Rectified Forward Current	I <sub>F(AV)</sub>	3.0 @ T <sub>L</sub> = 140°C 4.0 @ T <sub>L</sub> = 130°C	3.0 @ T <sub>L</sub> = 130°C 4.0 @ T <sub>L</sub> = 115°C	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	75		Amps
Operating Junction Temperature	T <sub>J</sub>	- 65 to + 175		°C

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Lead	R <sub>θJL</sub>	11	°C/W
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**ELECTRICAL CHARACTERISTICS**

Rating	Symbol	320T3	360T3	Unit
Maximum Instantaneous Forward Voltage (1) (I <sub>F</sub> = 3.0 A, T <sub>J</sub> = 25°C) (I <sub>F</sub> = 4.0 A, T <sub>J</sub> = 25°C) (I <sub>F</sub> = 3.0 A, T <sub>J</sub> = 150°C)	v <sub>F</sub>	0.875 0.89 0.71	1.25 1.28 1.05	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T <sub>J</sub> = 25°C) (Rated dc Voltage, T <sub>J</sub> = 150°C)	i <sub>R</sub>	5.0 15	10 250	μA
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 A, di/dt = 50 A/μs) (I <sub>F</sub> = 0.5 A, i <sub>R</sub> = 1.0 A, I <sub>REC</sub> to 0.25 A)	t <sub>rr</sub>	35 25	75 50	ns
Maximum Forward Recovery Time (I <sub>F</sub> = 1.0 A, di/dt = 100 A/μs, Recovery to 1.0 V)	t <sub>fr</sub>	25	50	ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%

Rev 2



# MURS320T3, MURS360T3

## MURS320T3

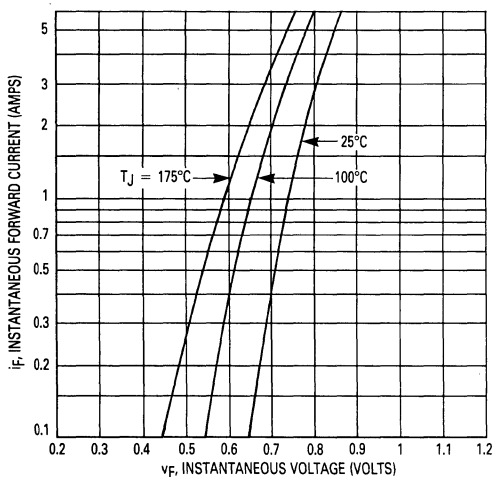


Figure 1. Typical Forward Voltage

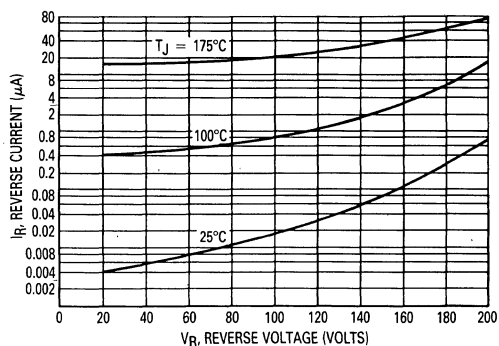


Figure 2. Typical Reverse Current\*

\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently below rated  $V_R$ .

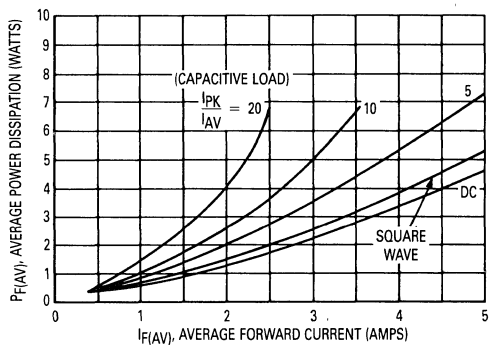


Figure 3. Power Dissipation

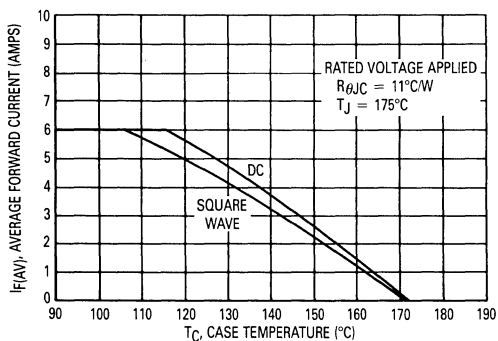


Figure 4. Current Derating (Case)

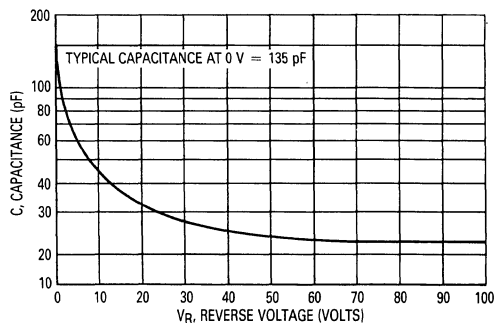


Figure 5. Typical Capacitance

# MURS320T3, MURS360T3

## MURS360T3

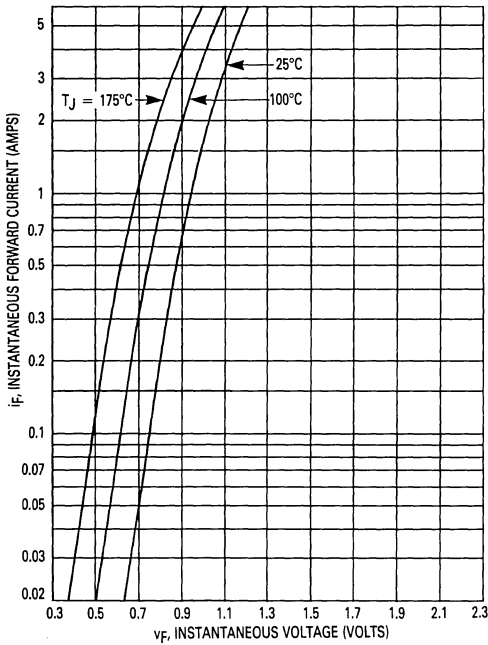


Figure 6. Typical Forward Voltage

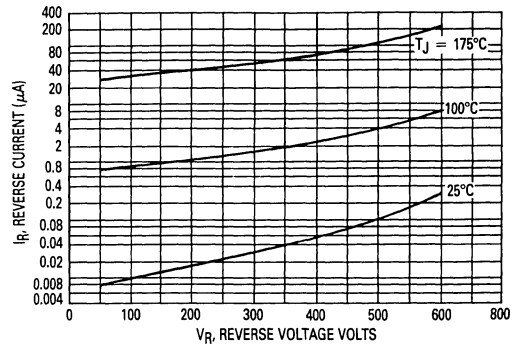


Figure 7. Typical Reverse Current\*

\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently below rated  $V_R$ .

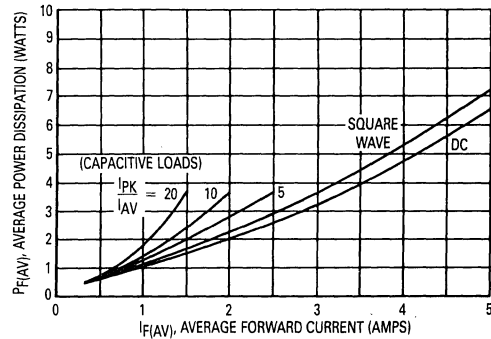


Figure 8. Power Dissipation

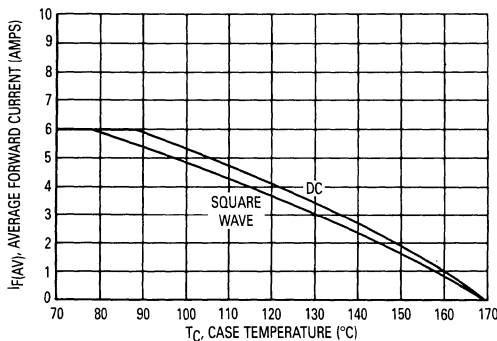


Figure 9. Current Derating (Case)

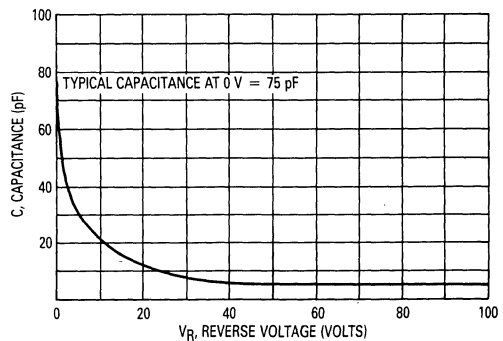


Figure 10. Typical Capacitance

## SWITCHMODE Power Rectifiers

### DPAK Surface Mount Package

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage

#### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: U320



**MURD320**

MURD320 is a  
 Motorola Preferred Device

**ULTRAFAST  
 RECTIFIERS  
 3 AMPERES  
 200 VOLTS**



#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	Volts
Average Rectified Forward Current ( $T_C = 158^\circ\text{C}$ , Rated $V_R$ )	$I_F(AV)$	3	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 158^\circ\text{C}$ )	$I_{FRM}$	6	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, 60 Hz)	$I_{FSM}$	75	Amps
Operating Junction and Storage Temperature	$T_J, T_{stg}$	-65 to +175	$^\circ\text{C}$

#### THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case Junction to Ambient (1)	$R_{\theta JC}$ $R_{\theta JA}$	6 80	$^\circ\text{C}/\text{W}$
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#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage Drop (2) ( $I_F = 3$ Amps, $T_J = 25^\circ\text{C}$ ) ( $I_F = 3$ Amps, $T_J = 125^\circ\text{C}$ )	$V_F$	0.95 0.75	Volts
Maximum Instantaneous Reverse Current (2) ( $T_J = 25^\circ\text{C}$ , Rated dc Voltage) ( $T_J = 125^\circ\text{C}$ , Rated dc Voltage)	$i_R$	5 500	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1$ Amp, $di/dt = 50$ Amps/ $\mu\text{s}$ , $V_R = 30$ V, $T_J = 25^\circ\text{C}$ ) ( $I_F = 0.5$ Amp, $i_R = 1$ Amp, $I_{REC} = 0.25$ A, $V_R = 30$ V, $T_J = 25^\circ\text{C}$ )	$t_{rr}$	35 25	ns

(1) Rating applies when surface mounted on the minimum pad sizes recommended.

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Rev 1

# MURD320

## TYPICAL CHARACTERISTICS

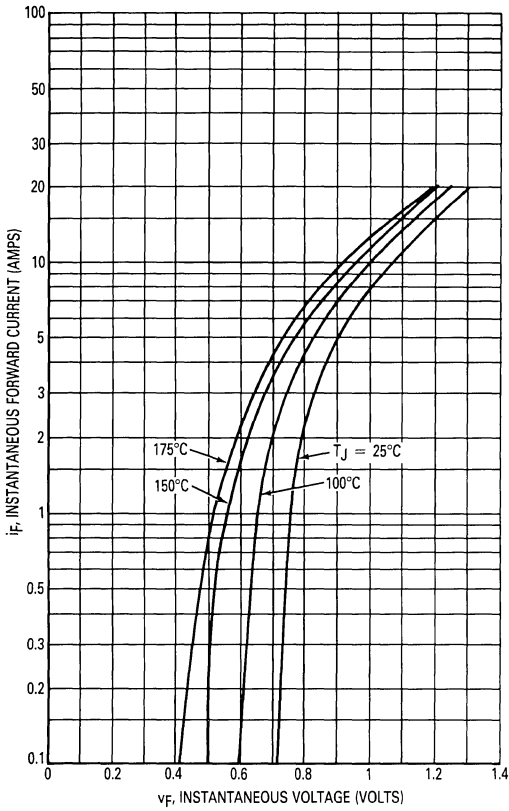
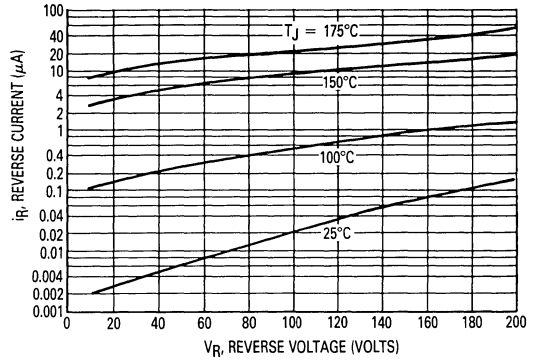


Figure 1. Typical Forward Voltage



\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if  $V_R$  is sufficient below rated  $V_R$ .

Figure 2. Typical Reverse Current\*

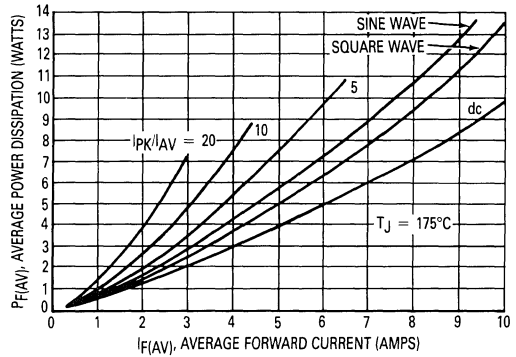


Figure 3. Average Power Dissipation

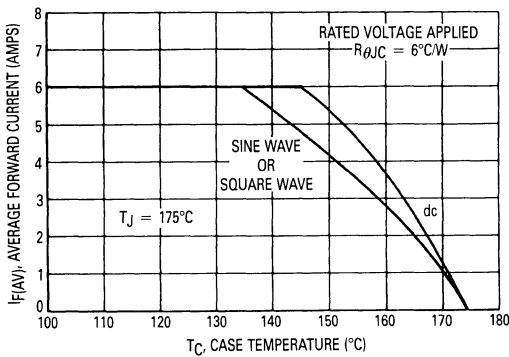


Figure 4. Current Derating, Case

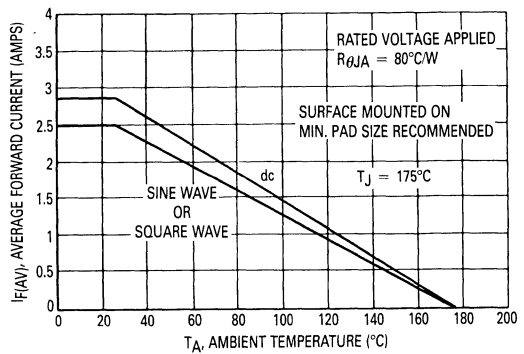
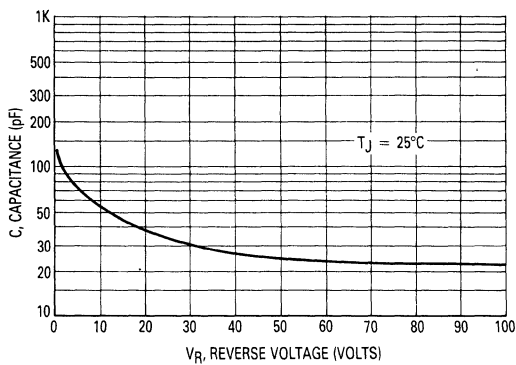


Figure 5. Current Derating, Ambient

4

# MURD320



**Figure 6. Typical Capacitance**

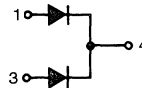
## SWITCHMODE Power Rectifiers DPAK Surface Mount Package

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage

### Mechanical Characteristics:

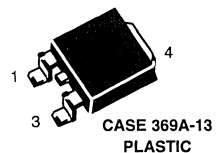
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: U620T



**MURD620CT**

MURD620CT is a  
 Motorola Preferred Device

**ULTRAFAST  
 RECTIFIERS  
 6 AMPERES  
 200 VOLTS**



4

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	Volts
Average Rectified Forward Voltage ( $T_C = 140^\circ\text{C}$ , Rated $V_R$ )	Per Diode $I_F(AV)$ Per Device	3 6	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 145^\circ\text{C}$ )	Per Diode $I_F$	6	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, 60 Hz)	$I_{FSM}$	50	Amps
Operating Junction and Storage Temperature	$T_J, T_{stg}$	-65 to +175	$^\circ\text{C}$

### THERMAL CHARACTERISTICS PER DIODE

Thermal Resistance, Junction to Case	$R_{\theta JC}$	9	$^\circ\text{C}/\text{W}$
Junction to Ambient (1)	$R_{\theta JA}$	80	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS PER DIODE

Maximum Instantaneous Forward Voltage Drop (2) $i_F = 3$ Amps, $T_C = 25^\circ\text{C}$ $i_F = 3$ Amps, $T_C = 125^\circ\text{C}$ $i_F = 6$ Amps, $T_C = 25^\circ\text{C}$ $i_F = 6$ Amps, $T_C = 125^\circ\text{C}$	$v_F$	1 0.96 1.2 1.13	Volts
Maximum Instantaneous Reverse Current (2) ( $T_J = 25^\circ\text{C}$ , Rated dc Voltage) ( $T_J = 125^\circ\text{C}$ , Rated dc Voltage)	$i_R$	5 250	$\mu\text{A}$
Maximum Reverse Recovery Time ( $i_F = 1$ Amp, $di/dt = 50$ Amps/ $\mu\text{s}$ , $V_R = 30$ V, $T_J = 25^\circ\text{C}$ ) ( $i_F = 0.5$ Amp, $i_R = 1$ Amp, $I_{REC} = 0.25$ A, $V_R = 30$ V, $T_J = 25^\circ\text{C}$ )	$t_{rr}$	35 25	ns

(1) Rating applies when surface mounted on the minimum pad sizes recommended.

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

Rev 1

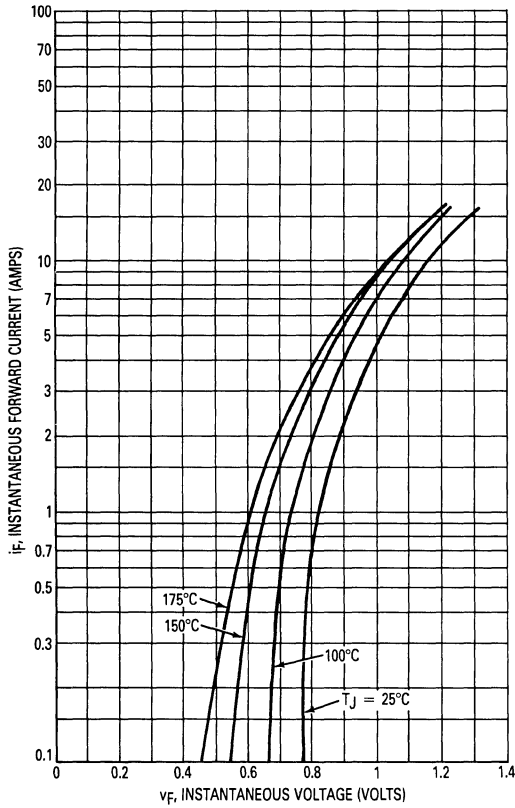
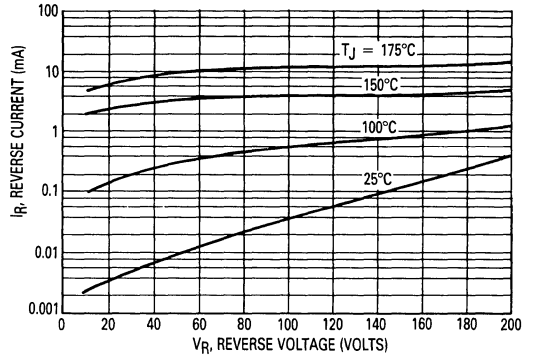


Figure 1. Typical Forward Voltage (Per Leg)



\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if  $V_R$  is sufficient below rated  $V_R$ .

Figure 2. Typical Leakage Current\* (Per Leg)

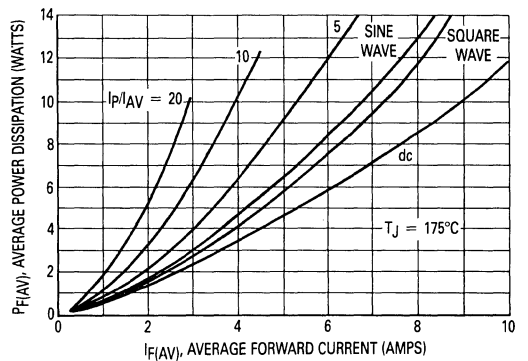


Figure 3. Average Power Dissipation (Per Leg)

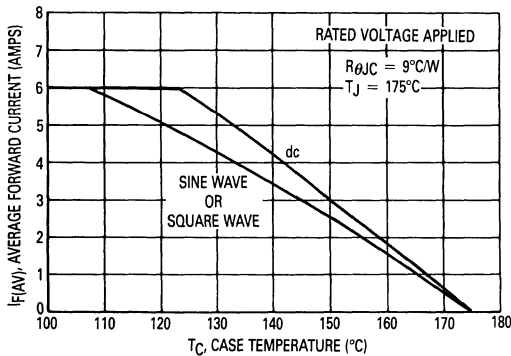


Figure 4. Current Derating, Case (Per Leg)

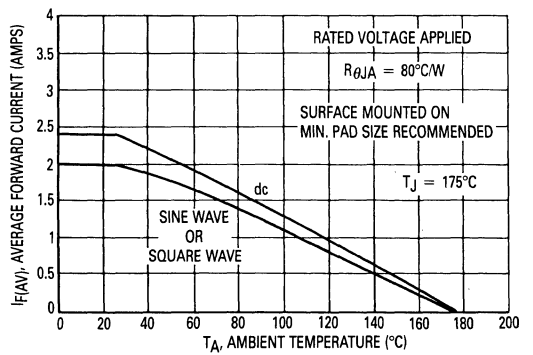
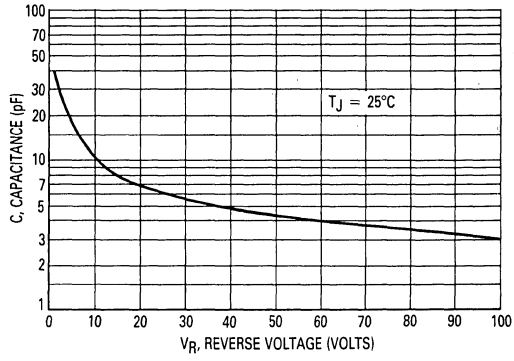


Figure 5. Current Derating, Ambient (Per Leg)

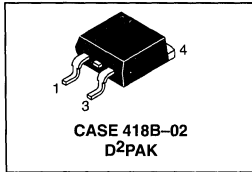
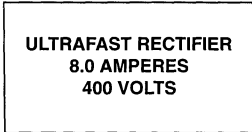
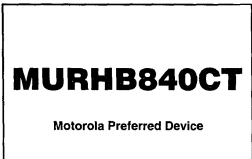
# MURD620CT



**Figure 6. Typical Capacitance (Per Leg)**

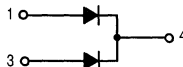


*Designer's™ Data Sheet*  
**SWITCHMODE™ Power Rectifiers**  
**D2PAK Power Surface Mount Package**



Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 28 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>0</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured — Not Sheared!
- Similar in Size to Industry Standard TO-220 Package



**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: UH840

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	400	Volts
Average Rectified Forward Current (Rated $V_R$ ), $T_C = 120^\circ\text{C}$	$I_{F(AV)}$	4.0 8.0	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 120^\circ\text{C}$	$I_{FM}$	8	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	100	Amps
Controlled Avalanche Energy	$W_{AVAL}$	20	mJ
Operating Junction Temperature and Storage Temperature	$T_J, T_{Stg}$	-65 to +175	°C

**THERMAL CHARACTERISTICS, PER LEG**

Maximum Thermal Resistance — Junction to Case	$R_{\theta JC}$	3.0	°C/W
— Junction to Ambient (1)	$R_{\theta JA}$	50	

(1) See Chapter 7 for mounting conditions

Preferred devices are Motorola recommended choices for future use and best overall value.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Rev 1

# MURHB840CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (2) ( $i_F = 4.0$ Amps, $T_C = 150^\circ\text{C}$ ) ( $i_F = 4.0$ Amps, $T_C = 25^\circ\text{C}$ )	$v_F$	1.9 2.2	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	500 10	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amps/ $\mu\text{s}$ )	$t_{rr}$	28	ns

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

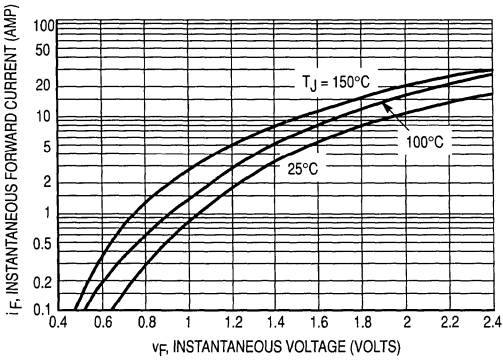


Figure 1. Typical Forward Voltage

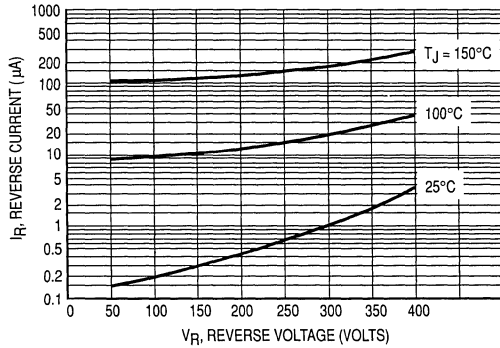


Figure 2. Typical Reverse Current, Per Leg

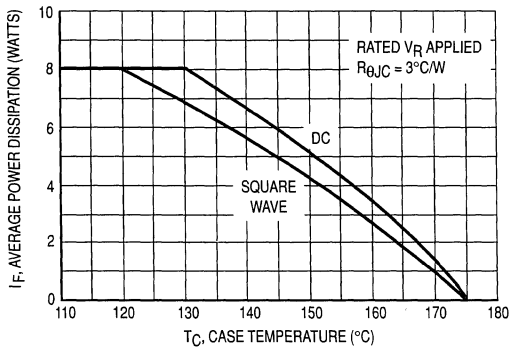


Figure 3. Current Derating, Case

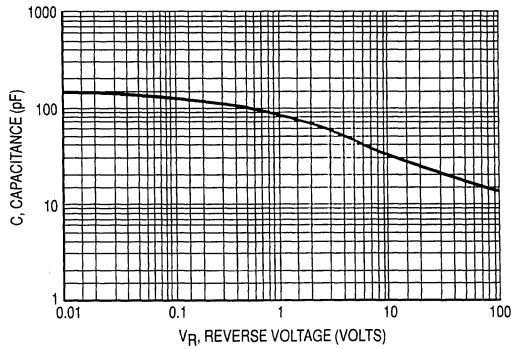


Figure 4. Typical Capacitance, Per Leg

4

# MURHB840CT

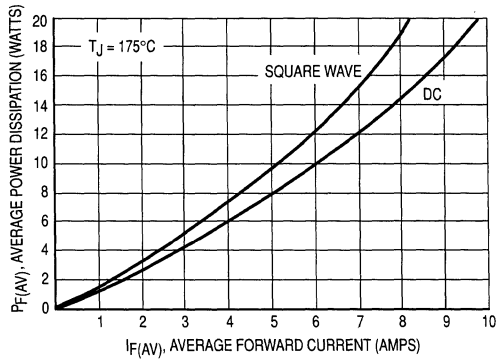


Figure 5. Forward Power Dissipation, Per Leg

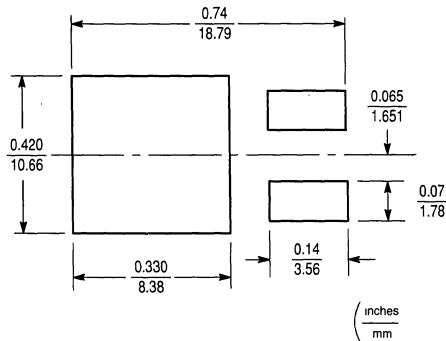
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## INFORMATION FOR USING THE D<sup>2</sup>PAK SURFACE MOUNT PACKAGE

### MINIMUM RECOMMENDED FOOTPRINT FOR SURFACE MOUNTED APPLICATIONS

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor packages must be the correct size to insure proper solder connection interface

between the board and the package. With the correct pad geometry, the packages will self align when subjected to a solder reflow process.



### D<sup>2</sup>PAK POWER DISSIPATION

The power dissipation of the D<sup>2</sup>PAK is a function of the drain pad size. This can vary from the minimum pad size for soldering to a pad size given for maximum power dissipation. Power dissipation for a surface mount device is determined by  $T_{J(max)}$ , the maximum rated junction temperature of the die,  $R_{\theta JA}$ , the thermal resistance from the device junction to ambient; and the operating temperature,  $T_A$ . Using the values provided on the data sheet for the D<sup>2</sup>PAK package,  $P_D$  can be calculated as follows:

$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

The values for the equation are found in the maximum ratings table on the data sheet. Substituting these values into

the equation for an ambient temperature  $T_A$  of 25°C, one can calculate the power dissipation of the device which in this case is 3.0 watts.

$$P_D = \frac{175^\circ\text{C} - 25^\circ\text{C}}{50^\circ\text{C/W}} = 3.0 \text{ watts}$$

The 50°C/W for the D<sup>2</sup>PAK package assumes the recommended drain pad area of 158K mil<sup>2</sup> on FR-4 glass epoxy printed circuit board to achieve a power dissipation of 3.0 watts using the footprint shown. Another alternative is to use a ceramic substrate or an aluminum core board such as Thermal Clad™. By using an aluminum core board material such as Thermal Clad, the power dissipation can be doubled using the same footprint.

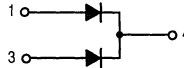
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- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured – Not Sheared!
- Similar in Size to Industrial Standard TO–220 Package

**Mechanical Characteristics**

- Case: Epoxy, Molded
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- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: U1620T



**MURB1620CT**  
Motorola Preferred Device

**ULTRAFAST RECTIFIERS**  
**16 AMPERES**  
**200 VOLTS**

**CASE 418B–02**  
**D<sup>2</sup>PAK**



**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	Volts
Average Rectified Forward Current Total Device, (Rated V <sub>R</sub> ), T <sub>C</sub> = 150°C	I <sub>F(AV)</sub>	8 16	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 150°C	I <sub>FM</sub>	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	Amps
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	– 65 to +175	°C

**THERMAL CHARACTERISTICS, PER LEG**

Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	3	°C/W
Maximum Thermal Resistance, Junction to Ambient <sup>(1)</sup>	R <sub>θJA</sub>	50	°C/W
Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T <sub>L</sub>	260	°C

(1) See Chapter 7 for Mounting Conditions.

Preferred devices are Motorola recommended choices for future use and best overall value.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves —representing boundaries on device characteristics — are given to facilitate "worst case" design.

# MURB1620CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (2) ( $i_F = 8$ Amp, $T_C = 150^\circ\text{C}$ ) ( $i_F = 8$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.895 0.975	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	250 5	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	35 25	ns

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

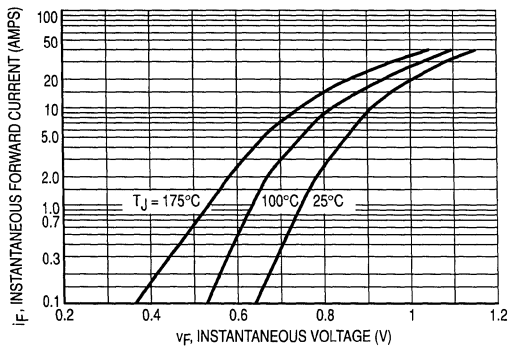


Figure 1. Typical Forward Voltage, Per Leg

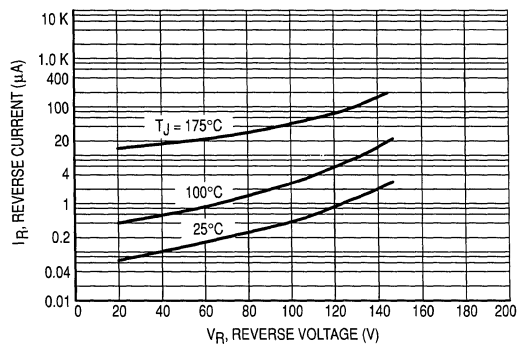


Figure 2. Typical Reverse Current, Per Leg\*

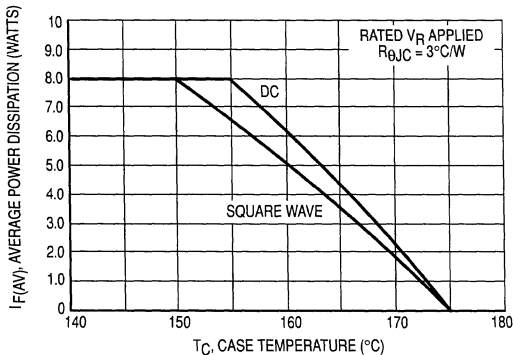


Figure 3. Current Derating Case, Per Leg

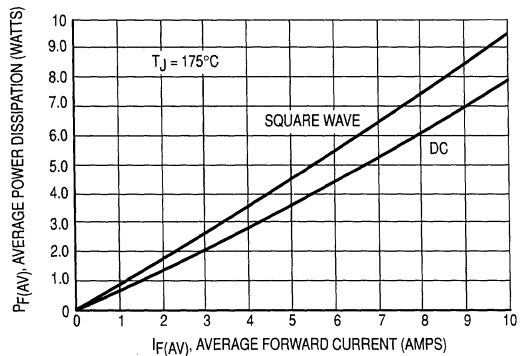


Figure 4. Power Dissipation, Per Leg

# MURB1620CT

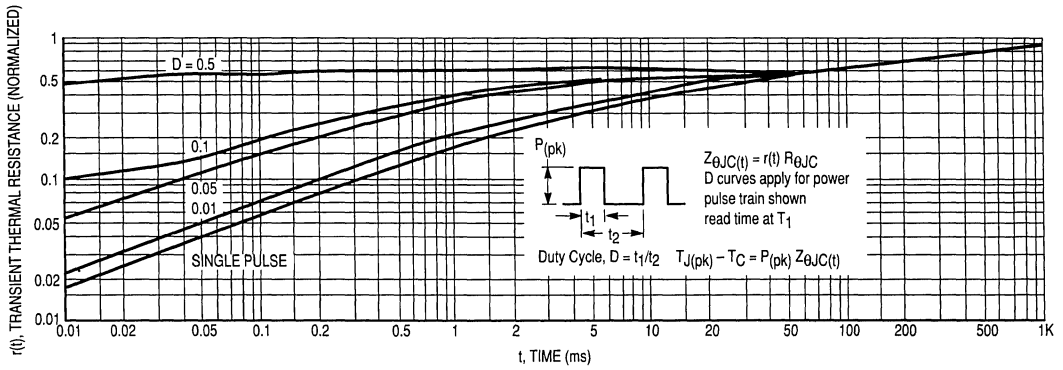


Figure 5. Thermal Response

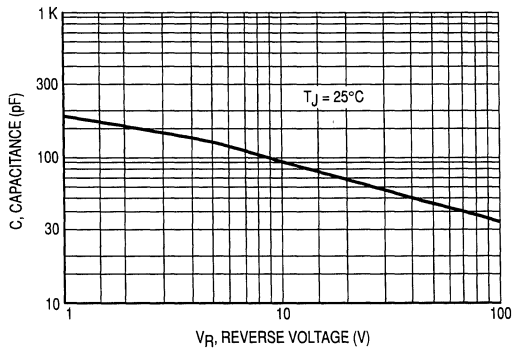


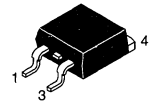
Figure 6. Typical Capacitance, Per Leg

*Designer's™ Data Sheet*  
**SWITCHMODE™ Power Rectifiers**  
**D2PAK Power Surface Mount Package**

**MURB1660CT**

Motorola Preferred Device

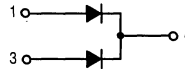
**ULTRAFAST RECTIFIERS**  
**16 AMPERES**  
**600 VOLTS**



**CASE 418B-02**  
**D2PAK**

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94,  $V_0 @ 1/8"$
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 V
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured – Not Sheared!
- Similar in Size to Industrial Standard TO-220 Package



**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: U1660T

4

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	600	Volts
Average Rectified Forward Current Total Device, (Rated $V_R$ ), $T_C = 150^\circ\text{C}$	$I_F(AV)$ Total Device	8 16	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	$I_{FM}$	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	100	Amps
Operating Junction and Storage Temperature	$T_J, T_{stg}$	- 65 to +175	$^\circ\text{C}$

**THERMAL CHARACTERISTICS, PER LEG**

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	2	$^\circ\text{C/W}$
Maximum Thermal Resistance, Junction to Ambient <sup>(1)</sup>	$R_{\theta JA}$	50	$^\circ\text{C/W}$
Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	$T_L$	260	$^\circ\text{C}$

(1) See Chapter 7 for Mounting Conditions

Preferred devices are Motorola recommended choices for future use and best overall value.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Rev 1

# MURB1660CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (2) ( $I_F = 8$ Amp, $T_C = 150^\circ\text{C}$ ) ( $I_F = 8$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (2) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	500 10	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	60 50	ns

(2) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

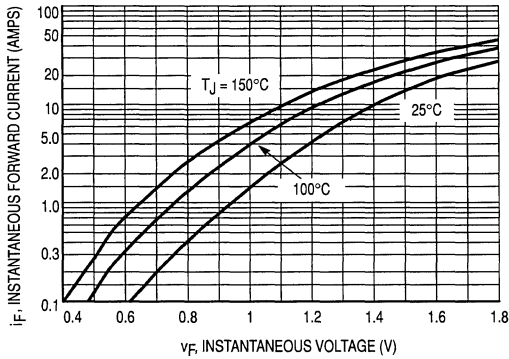


Figure 1. Typical Forward Voltage, Per Leg

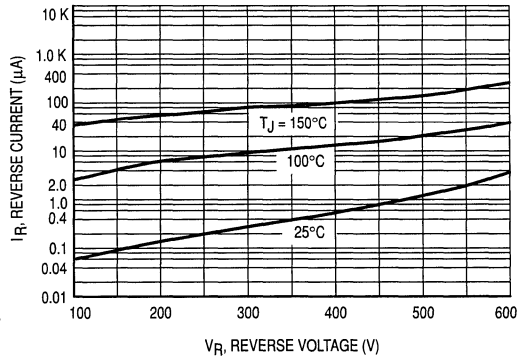


Figure 2. Typical Reverse Current, Per Leg

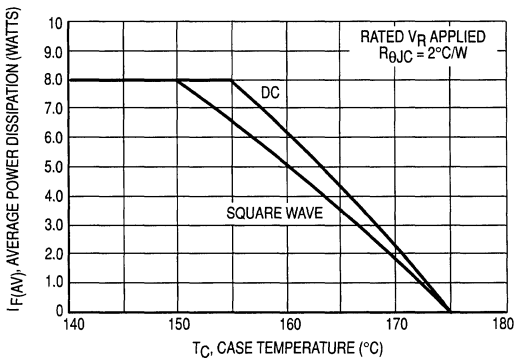


Figure 3. Current Derating, Case, Per Leg

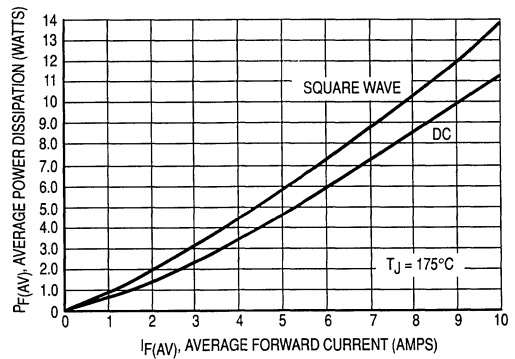


Figure 4. Power Dissipation, Per Leg



# MURB1660CT

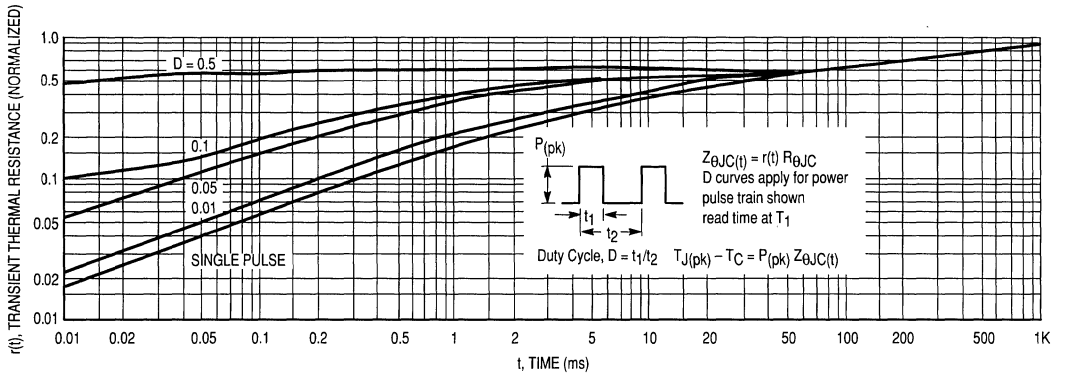


Figure 5. Thermal Response

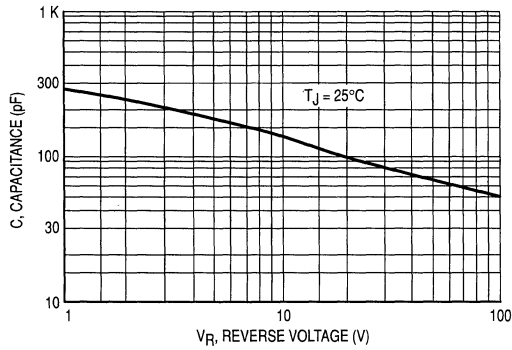
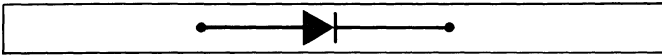


Figure 6. Typical Capacitance, Per Leg



**MUR120**  
**MUR140**  
**MUR160**

MUR120, MUR140 and MUR160 are  
 Motorola Preferred Devices

## Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

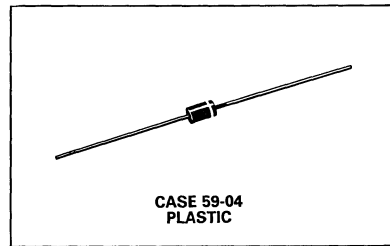
- Ultrafast 25, 50 and 75 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: U120, U140, U160

**ULTRAFAST**  
**RECTIFIERS**

**1.0 AMPERE**  
**200-400-600 VOLTS**



**4**

### MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		120	140	160	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	400	600	Volts
Average Rectified Forward Current (Square Wave Mounting Method #3 Per Note 1)	$I_F(AV)$	1.0 @ $T_A = 130^\circ\text{C}$	1.0 @ $T_A = 120^\circ\text{C}$		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	$I_{FSM}$	35			Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175			°C

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 1	°C/W
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### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 1.0$ Amp, $T_J = 150^\circ\text{C}$ ) ( $I_F = 1.0$ Amp, $T_J = 25^\circ\text{C}$ )	$V_F$	0.710 0.875	1.05 1.25	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	50 2.0	150 5.0	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ A)	$t_{rr}$	35 25	75 50	ns
Maximum Forward Recovery Time ( $I_F = 1.0$ A, $di/dt = 100$ A/ $\mu\text{s}$ , $I_{REC}$ to 1.0 V)	$t_{fr}$	25	50	ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

FIGURE 1 — TYPICAL FORWARD VOLTAGE

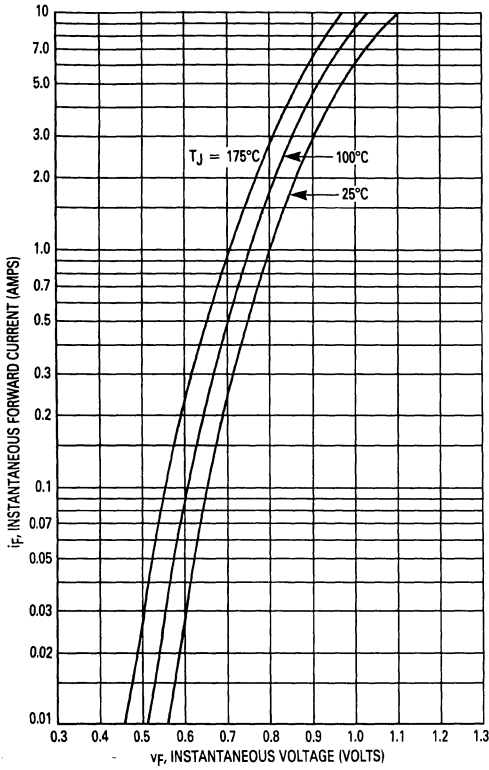


FIGURE 2 — TYPICAL REVERSE CURRENT\*

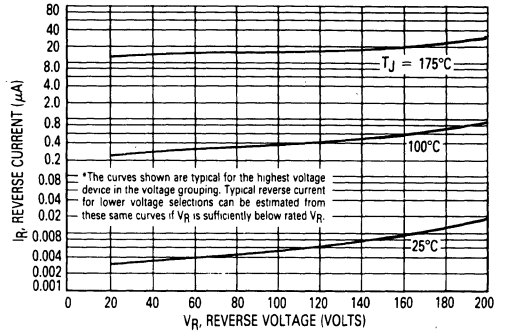


FIGURE 3 — CURRENT DERATING (MOUNTING METHOD #3 PER NOTE 1)

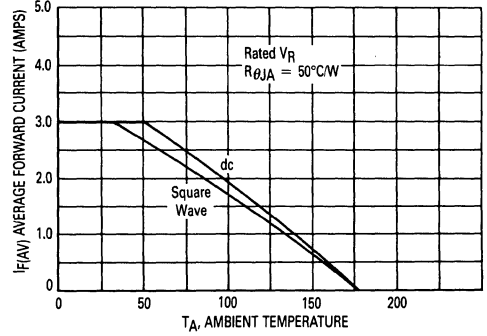


FIGURE 4 — POWER DISSIPATION

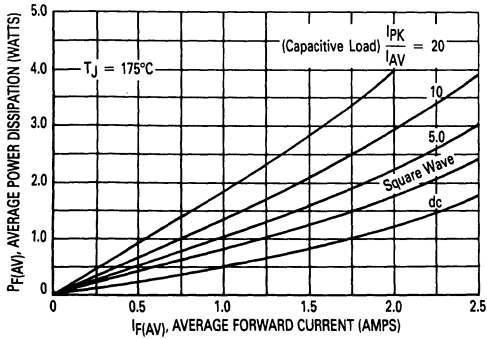
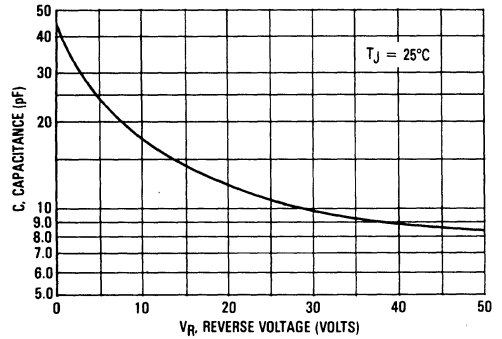


FIGURE 5 — TYPICAL CAPACITANCE



# MUR120, MUR140, MUR160

MUR140, MUR160

FIGURE 6 — TYPICAL FORWARD VOLTAGE

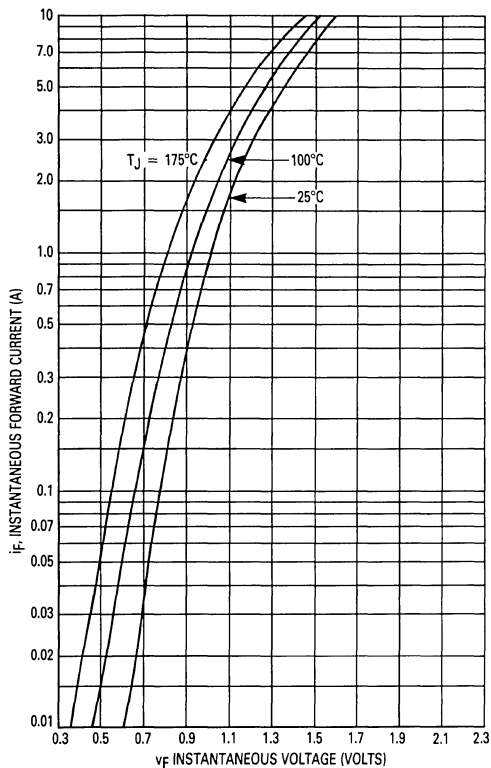


FIGURE 7 — TYPICAL REVERSE CURRENT\*

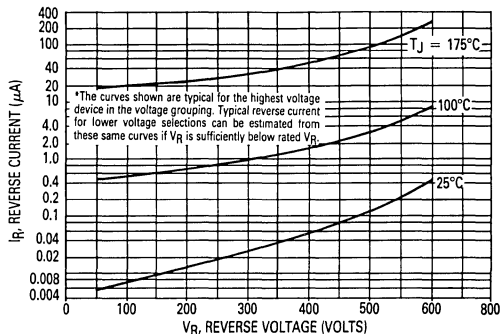


FIGURE 8 — CURRENT DERATING (MOUNTING METHOD #3 PER NOTE 1)

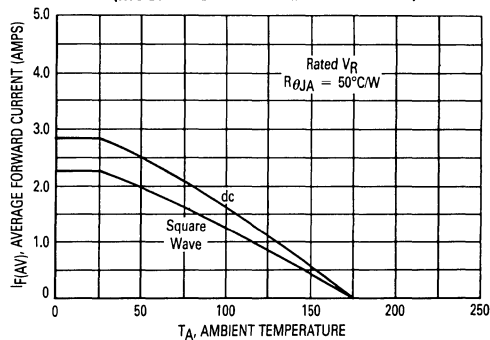


FIGURE 9 — POWER DISSIPATION

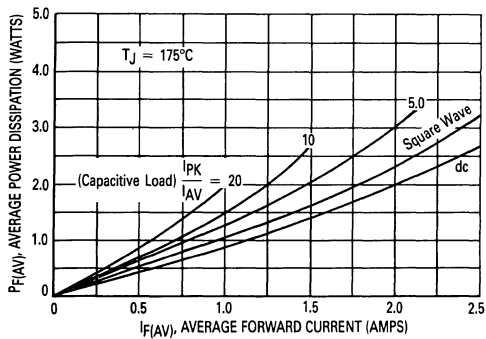
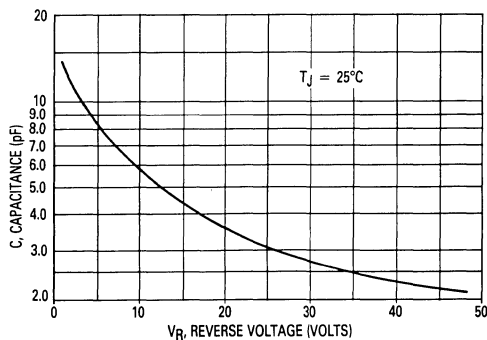


FIGURE 10 — TYPICAL CAPACITANCE



4

# MUR120, MUR140, MUR160

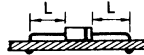
## NOTE 1 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

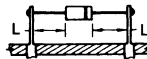
### TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

MOUNTING METHOD	$R_{\theta JA}$	LEAD LENGTH, L			UNITS
		1/8	1/4	1/2	
1		52	65	72	°C/W
2		67	80	87	°C/W
3		50			°C/W

#### MOUNTING METHOD 1

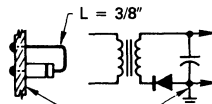


#### MOUNTING METHOD 2



Vector Pin Mounting

#### MOUNTING METHOD 3



Board Ground Plane

P.C. Board with  
1-1/2" x 1-1/2" Copper Surface

# SWITCHMODE Power Rectifiers

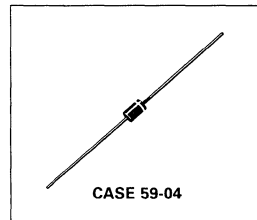
## Ultrafast "E" Series

### w/High Reverse Energy Capability

**MUR190E**  
**MUR1100E**

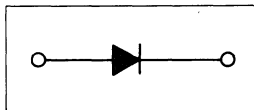
MUR1100E is a  
 Motorola Preferred Device

**ULTRAFAST**  
**RECTIFIERS**  
**1.0 AMPERE**  
**900-1000 VOLTS**



... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mJoules Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts



#### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: U190E, U1100E

#### MAXIMUM RATINGS

Rating	Symbol	MUR		Unit
		190E	1100E	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	900	1000	Volts
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 1)	$I_F(AV)$	1.0 @ $T_A = 95^\circ\text{C}$		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	35		Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175		°C

#### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 1	°C/W
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#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 1.0$ Amps, $T_J = 150^\circ\text{C}$ ) ( $I_F = 1.0$ Amps, $T_J = 25^\circ\text{C}$ )	$V_F$	1.50 1.75	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 100^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	600 10	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	100 75	ns
Maximum Forward Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 100$ Amp/ $\mu\text{s}$ , Recovery to 1.0 V)	$t_{fr}$	75	ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	$W_{AVAIL}$	10	mJ

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 1

# MUR190E, MUR1100E

## ELECTRICAL CHARACTERISTICS

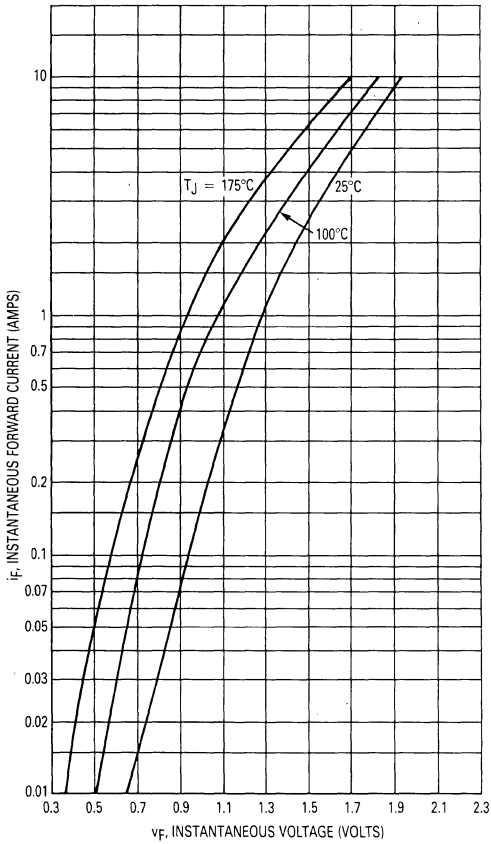


Figure 1. Typical Forward Voltage

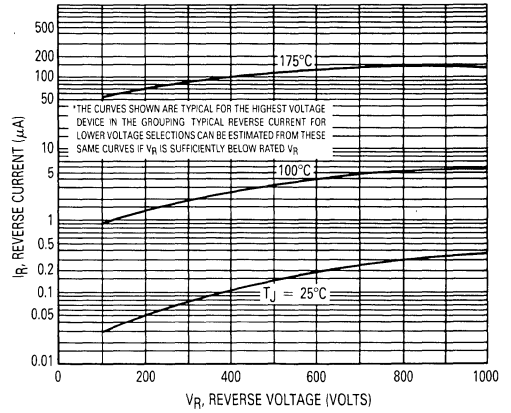


Figure 2. Typical Reverse Current\*

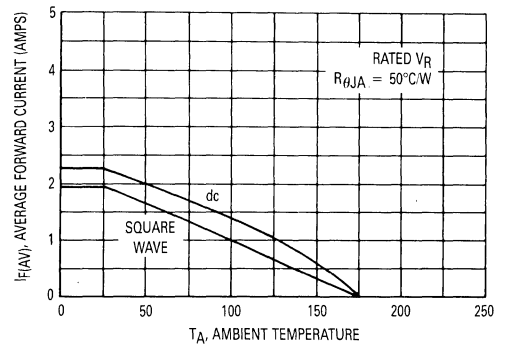


Figure 3. Current Derating (Mounting Method #3 Per Note 1)

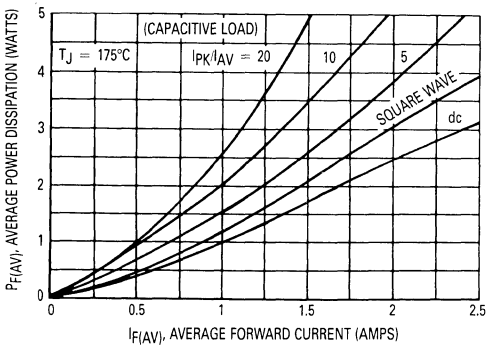


Figure 4. Power Dissipation

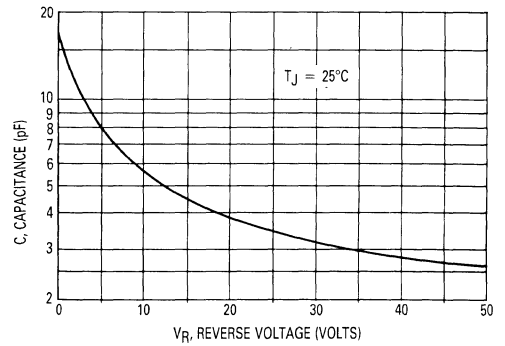


Figure 5. Typical Capacitance

# MUR190E, MUR1100E

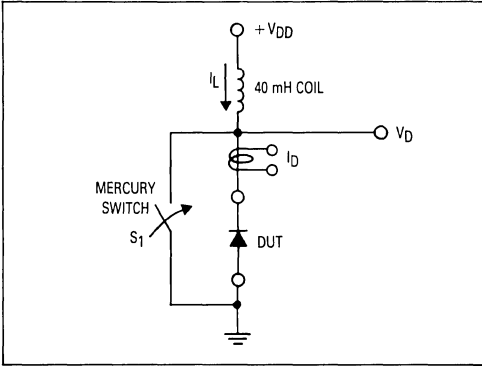


Figure 6. Test Circuit

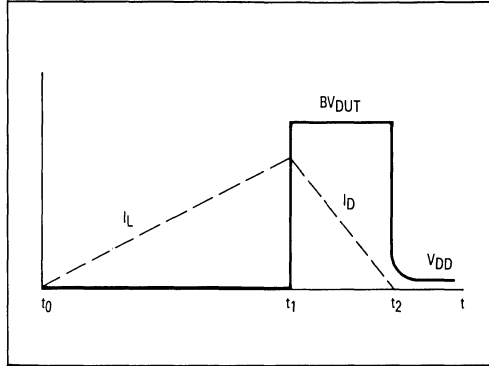


Figure 7. Current-Voltage Waveforms

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new "E" series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When  $S_1$  is closed at  $t_0$  the current in the inductor  $I_L$  ramps up linearly; and energy is stored in the coil. At  $t_1$  the switch is opened and the voltage across the diode under test begins to rise rapidly, due to  $di/dt$  effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at  $BV_{DUT}$  and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at  $t_2$ .

By solving the loop equation at the point in time when  $S_1$  is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the  $V_{DD}$  power supply while the diode is in breakdown (from  $t_1$  to  $t_2$ ) minus

any losses due to finite component resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the  $V_{DD}$  voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when  $S_1$  was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the information obtained for the MUR8100E (similar die construction as the MUR1100E Series) in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mjoules.

Although it is not recommended to design for this condition, the new "E" series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.

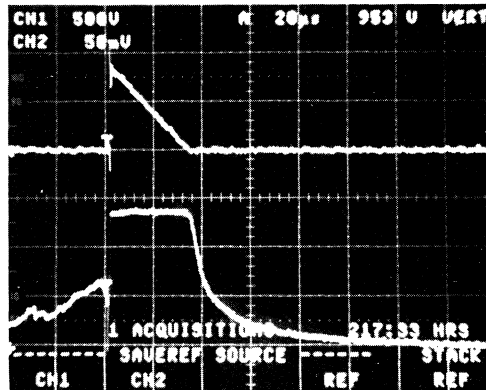
4

EQUATION (1):

$$W_{\text{AVAL}} \approx \frac{1}{2} L I_{\text{LPK}}^2 \left( \frac{BV_{\text{DUT}}}{(BV_{\text{DUT}} - V_{\text{DD}})} \right)$$

EQUATION (2):

$$W_{\text{AVAL}} \approx \frac{1}{2} L I_{\text{LPK}}^2$$



CHANNEL 2:

$I_L$   
0.5 AMPS/DIV.

CHANNEL 1:

$V_{DUT}$   
500 VOLTS/DIV.

TIME BASE:

20 μs/DIV.

Figure 8. Current-Voltage Waveforms



# MUR190E, MUR1100E

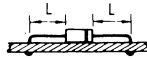
## Note 1. Ambient Mounting Data

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

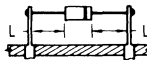
### TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

MOUNTING METHOD	LEAD LENGTH, L			UNITS	
	1/8	1/4	1/2		
1	$R_{\theta JA}$	52	65	72	$^{\circ}\text{C}/\text{W}$
2		67	80	87	$^{\circ}\text{C}/\text{W}$
3		50			$^{\circ}\text{C}/\text{W}$

#### MOUNTING METHOD 1

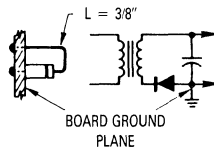


#### MOUNTING METHOD 2

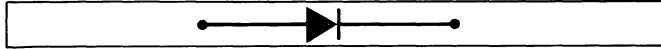


VECTOR PIN MOUNTING

#### MOUNTING METHOD 3



P.C. BOARD WITH  
1-1/2" x 1-1/2" COPPER SURFACE



MUR420 and MUR460  
are Motorola Preferred Devices

## Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: U420, U460

### ULTRAFAST RECTIFIERS

**4.0 AMPERES**  
**200–600 VOLTS**



**CASE 267-03**  
**PLASTIC**

### MAXIMUM RATINGS

Rating	Symbol	MUR		Unit
		420	460	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	600	Volts
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 1)	$I_{F(AV)}$	4.0 @ $T_A = 80^\circ\text{C}$	4.0 @ $T_A = 40^\circ\text{C}$	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	125	70	Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175		$^\circ\text{C}$

### THERMAL CHARACTERISTICS

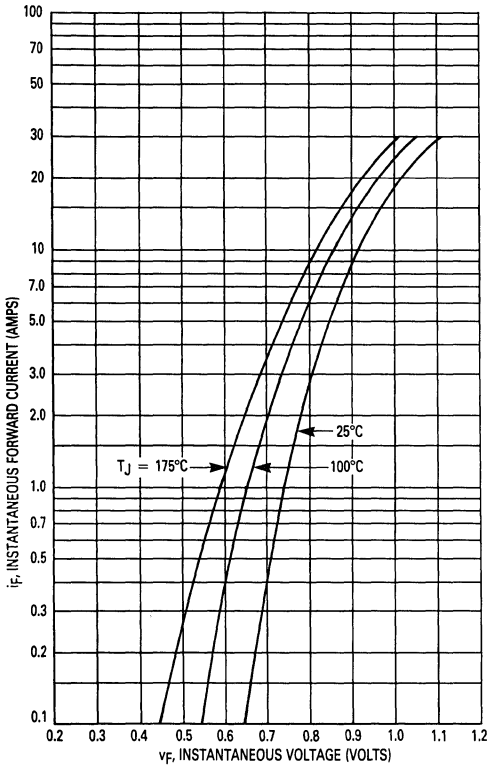
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 1	$^\circ\text{C/W}$
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### ELECTRICAL CHARACTERISTICS

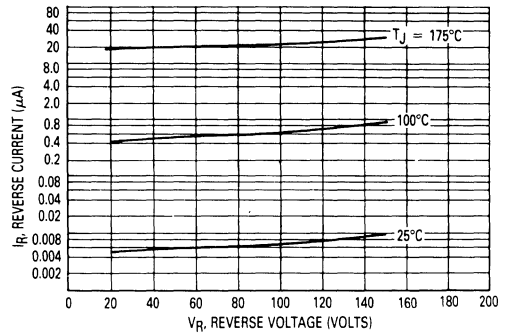
Maximum Instantaneous Forward Voltage (1) ( $I_F = 3.0$ Amp, $T_J = 150^\circ\text{C}$ ) ( $I_F = 3.0$ Amp, $T_J = 25^\circ\text{C}$ ) ( $I_F = 4.0$ Amp, $T_J = 25^\circ\text{C}$ )	$V_F$	0.710 0.875 0.890	1.05 1.25 1.28	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	150 5.0	250 10	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	35 25	75 50	ns
Maximum Forward Recovery Time ( $I_F = 1.0$ A, $di/dt = 100$ A/ $\mu\text{s}$ , Recovery to 1.0 V)	$t_{fr}$	25	50	ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

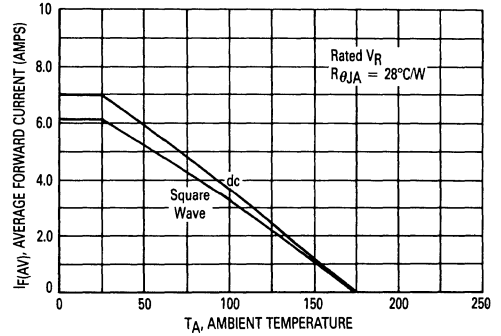
**FIGURE 1 — TYPICAL FORWARD VOLTAGE**



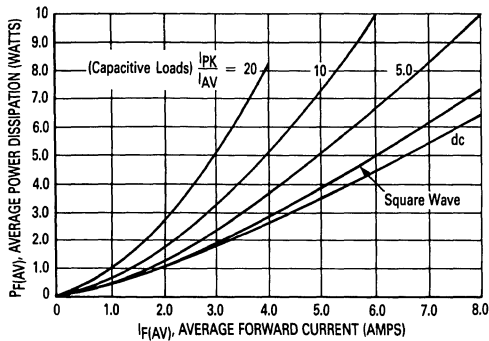
**FIGURE 2 — TYPICAL REVERSE CURRENT\***



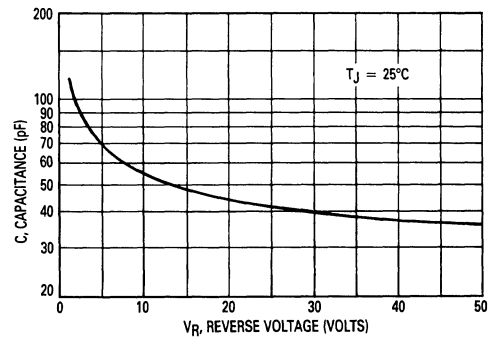
**FIGURE 3 — CURRENT DERATING (MOUNTING METHOD #3 PER NOTE 1)**



**FIGURE 4 — POWER DISSIPATION**



**FIGURE 5 — TYPICAL CAPACITANCE**



# MUR420, MUR460

MUR460

FIGURE 6 — TYPICAL FORWARD VOLTAGE

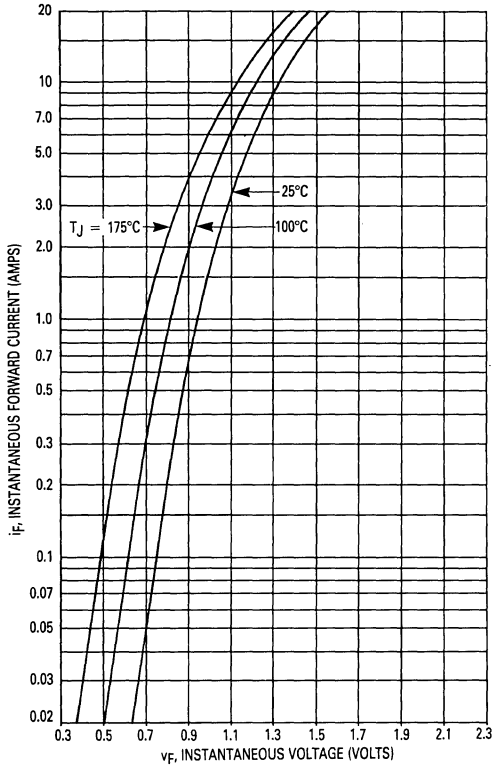


FIGURE 7 — TYPICAL REVERSE CURRENT\*

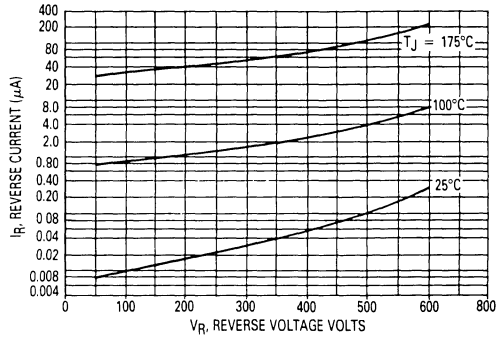


FIGURE 8 — CURRENT DERATING  
(MOUNTING METHOD #3 PER NOTE 1)

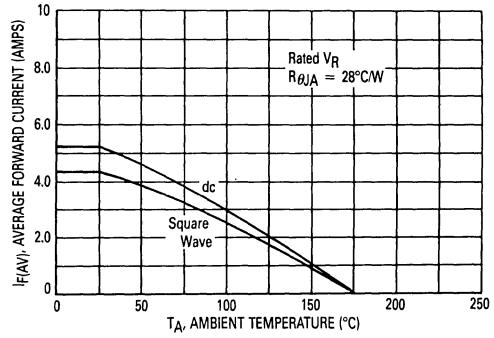


FIGURE 9 — POWER DISSIPATION

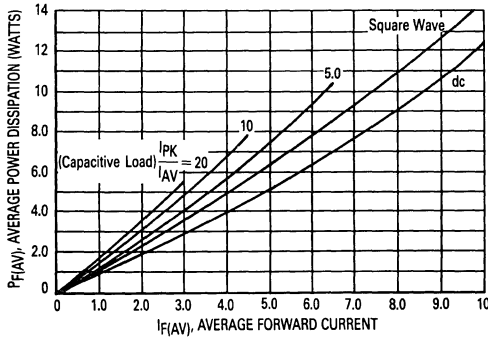
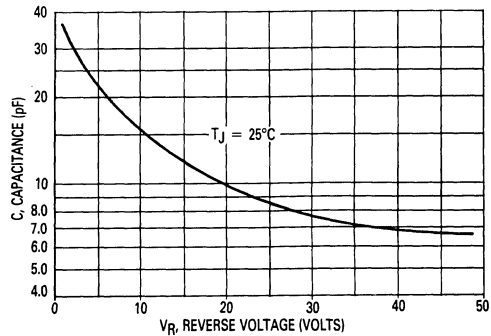


FIGURE 10 — TYPICAL CAPACITANCE



4

# MUR420, MUR460

## NOTE 1 — AMBIENT MOUNTING DATA

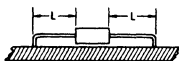
Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

### TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

MOUNTING METHOD		LEAD LENGTH, L (IN)				UNITS
		1/8	1/4	1/2	3/4	
1	$R_{\theta JA}$	50	51	53	55	$^{\circ}\text{C/W}$
2		58	59	61	63	$^{\circ}\text{C/W}$
3		28				$^{\circ}\text{C/W}$

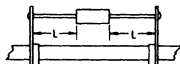
#### MOUNTING METHOD 1

P.C. Board Where Available Copper Surface area is small.



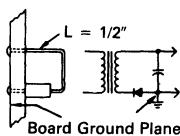
#### MOUNTING METHOD 2

Vector Push-In Terminals T-28



#### MOUNTING METHOD 3

P.C. Board with  
1-1/2" x 1-1/2" Copper Surface

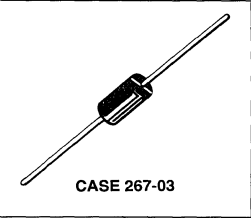


# Switchmode Power Rectifiers Ultrafast "E" Series w/High Reverse Energy Capability

**MUR490E**  
**MUR4100E**

MUR4100E is a  
 Motorola Preferred Device

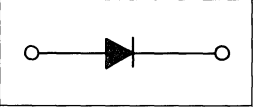
**ULTRAFAST  
 RECTIFIERS  
 4.0 AMPERES  
 900–1000 VOLTS**



**4**

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mJ Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts



**Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: U490E, U4100E

**MAXIMUM RATINGS**

Rating	Symbol	MUR490E	MUR4100E	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	900	1000	Volts
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 1)	$I_{F(AV)}$	4.0 @ $T_A = 35^\circ\text{C}$		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	70		Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175		°C

**THERMAL CHARACTERISTICS**

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	See Note 1	°C/W
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**ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (1) ( $I_F = 3.0$ Amps, $T_J = 150^\circ\text{C}$ ) ( $I_F = 3.0$ Amps, $T_J = 25^\circ\text{C}$ ) ( $I_F = 4.0$ Amps, $T_J = 25^\circ\text{C}$ )	$V_F$	1.53 1.75 1.85	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 100^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$i_R$	900 25	μA
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/μs) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	100 75	ns
Maximum Forward Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 100$ Amp/μs, Recovery to 1.0 V)	$t_{fr}$	75	ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	$W_{AVAIL}$	20	mJ

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%

# MUR490E, MUR4100E

## ELECTRICAL CHARACTERISTICS

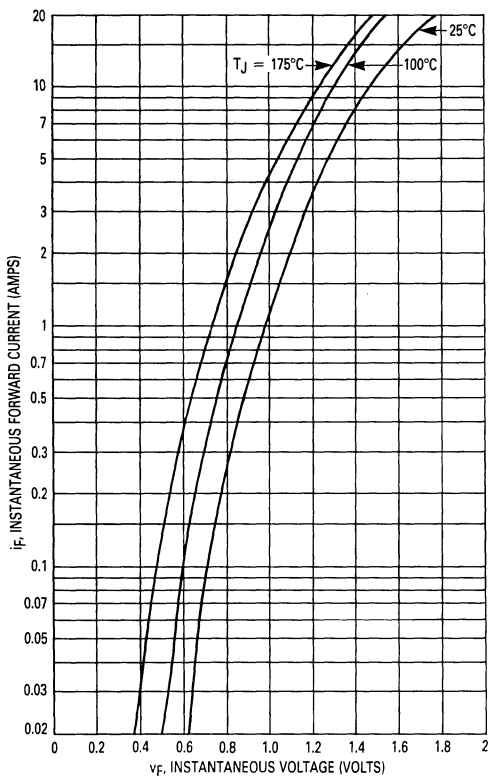


Figure 1. Typical Forward Voltage

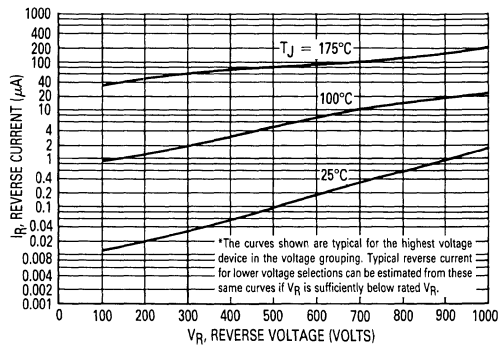


Figure 2. Typical Reverse Current\*

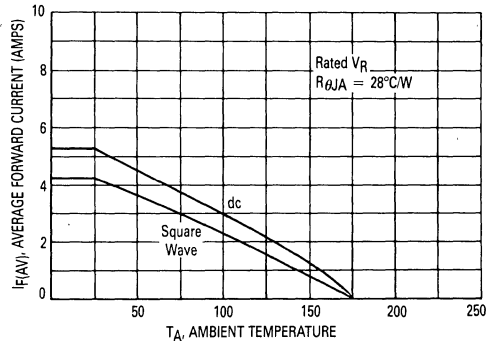


Figure 3. Current Derating  
(Mounting Method #3 Per Note 1)

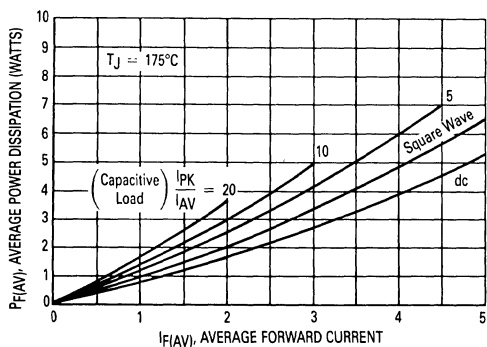


Figure 4. Power Dissipation

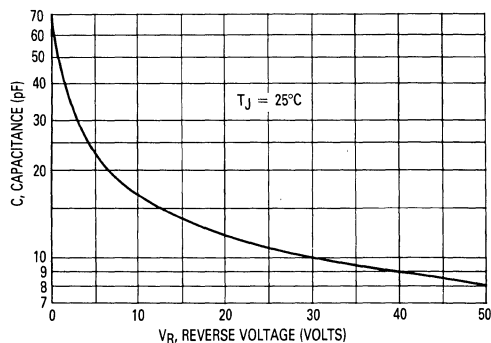


Figure 5. Typical Capacitance

# MUR490E, MUR4100E

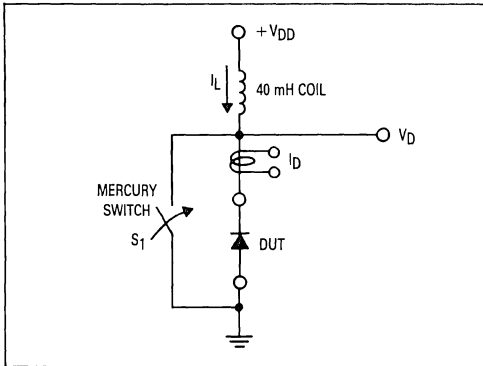


Figure 6. Test Circuit

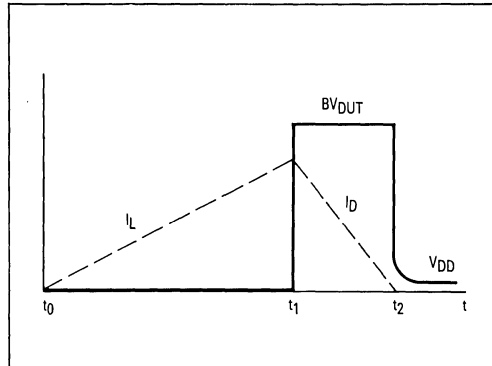


Figure 7. Current-Voltage Waveforms

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new "E" series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When  $S_1$  is closed at  $t_0$  the current in the inductor  $I_L$  ramps up linearly; and energy is stored in the coil. At  $t_1$  the switch is opened and the voltage across the diode under test begins to rise rapidly, due to  $di/dt$  effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at  $BV_{DUT}$  and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at  $t_2$ .

By solving the loop equation at the point in time when  $S_1$  is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the  $V_{DD}$  power supply while the diode is in breakdown (from  $t_1$  to  $t_2$ ) minus

any losses due to finite component resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the  $V_{DD}$  voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when  $S_1$  was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the information obtained for the MUR8100E (similar die construction as the MUR4100E Series) in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mJoules.

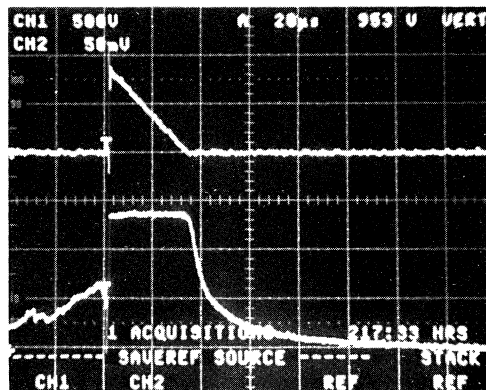
Although it is not recommended to design for this condition, the new "E" series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.

EQUATION (1):

$$W_{AVAL} \approx \frac{1}{2} L I_{LPK}^2 \left( \frac{BV_{DUT}}{BV_{DUT} - V_{DD}} \right)$$

EQUATION (2):

$$W_{AVAL} \approx \frac{1}{2} L I_{LPK}^2$$



CHANNEL 2:

$I_L$   
0.5 AMPS/DIV.

CHANNEL 1:

$V_{DUT}$   
500 VOLTS/DIV.

TIME BASE:  
20  $\mu$ s/DIV.

Figure 8. Current-Voltage Waveforms



# MUR490E, MUR4100E

## Note 1 — Ambient Mounting Data

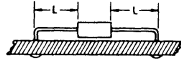
Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

### TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

MOUNTING METHOD	LEAD LENGTH, L (IN)				UNITS
	1/8	1/4	1/2	3/4	
1	50	51	53	55	°C/W
2	58	59	61	63	°C/W
3	28				°C/W

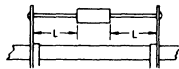
#### MOUNTING METHOD 1

P.C. Board Where Available Copper Surface area is small.



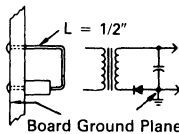
#### MOUNTING METHOD 2

Vector Push-In Terminals T-28



#### MOUNTING METHOD 3

P.C. Board with 1-1/2" x 1-1/2" Copper Surface



**MUR620CT**

Motorola Preferred Device

## Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

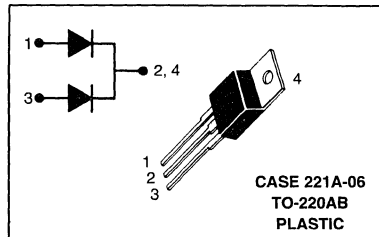
- Ultrafast 35 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U620

**ULTRAFAST  
RECTIFIERS**

**6 AMPERES  
200 VOLTS**



4

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	Volts
Average Rectified Forward Voltage (Rated $V_R$ ) $T_C = 130^\circ\text{C}$	Per Diode Total Device $I_{F(AV)}$	3.0 6.0	Amps
Peak Repetitive Forward Current Per Diode Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 130^\circ\text{C}$	$I_{FRM}$	6.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	75	Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175	$^\circ\text{C}$

### THERMAL CHARACTERISTICS PER DIODE LEG

Rating	Symbol	Typical	Maximum	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	5.0-6.0	7.0	$^\circ\text{C/W}$

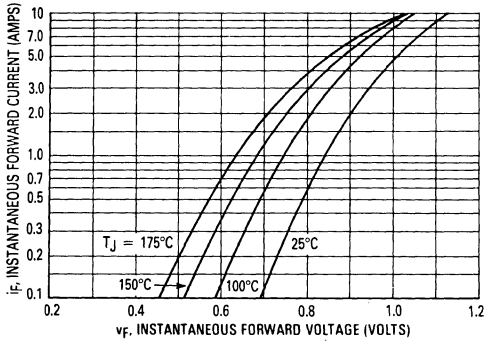
### ELECTRICAL CHARACTERISTICS PER DIODE LEG

Rating	Symbol	Typical	Maximum	Unit
Instantaneous Forward Voltage (1) ( $I_F = 3.0$ Amp, $T_C = 150^\circ\text{C}$ ) ( $I_F = 3.0$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	0.80 0.94	0.895 0.975	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	2.0-10 0.01-3.0	250 5.0	$\mu\text{A}$
Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ )	$t_{rr}$	20-30	35	ns

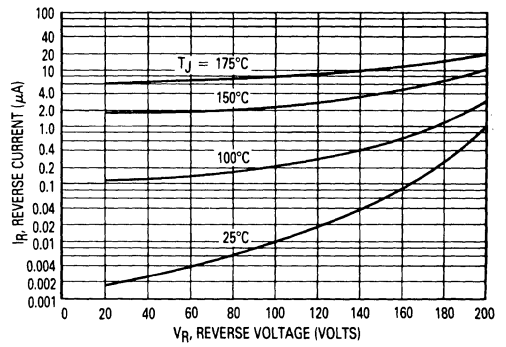
(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

Rev 1

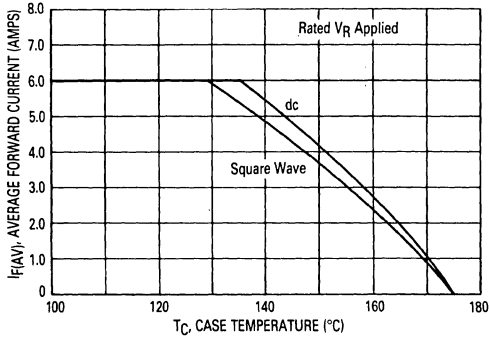
**FIGURE 1 — TYPICAL FORWARD VOLTAGE**



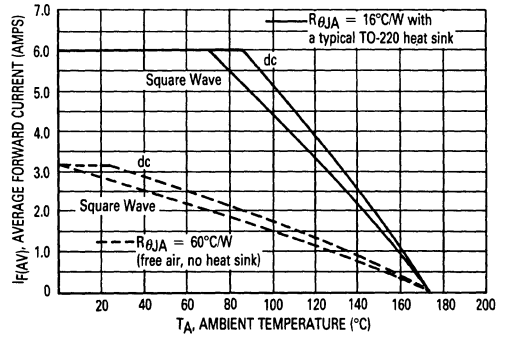
**FIGURE 2 — TYPICAL REVERSE CURRENT**



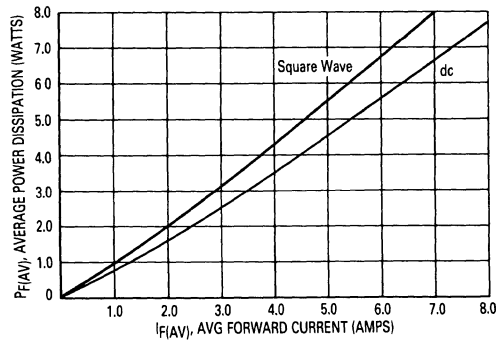
**FIGURE 3 — TOTAL DEVICE CURRENT DERATING, CASE**



**FIGURE 4 — TOTAL DEVICE CURRENT DERATING, AMBIENT**



**FIGURE 5 — POWER DISSIPATION**



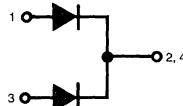
# Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 28 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 400 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

### Mechanical Characteristics:

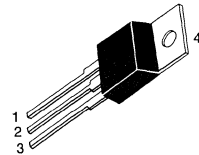
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: UH840



**MURH840CT**

Motorola Preferred Device

**ULTRAFAST RECTIFIER**  
**8.0 AMPERES**  
**400 VOLTS**



**CASE 221A-06**  
**TO-220AB**

4

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	400	Volts
Average Rectified Forward Current Total Device, (Rated $V_R$ ), $T_C = 120^\circ\text{C}$	Per Leg Total Device $I_{F(AV)}$	4.0 8.0	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 120^\circ\text{C}$	Per Diode Leg $I_{FM}$	16	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	100	Amps
Controlled Avalanche Energy	$W_{AVAIL}$	20	mJ
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175	°C

### THERMAL CHARACTERISTICS, PER DIODE LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	°C/W
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### ELECTRICAL CHARACTERISTICS, PER DIODE LEG

Maximum Instantaneous Forward Voltage (1) ( $I_F = 4.0$ Amps, $T_C = 150^\circ\text{C}$ ) ( $I_F = 4.0$ Amps, $T_C = 25^\circ\text{C}$ )	$v_F$	1.9 2.2	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	500 10	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amps/ $\mu\text{s}$ )	$t_{rr}$	28	ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq$  2.0%.

Rev 1

# MURH840CT

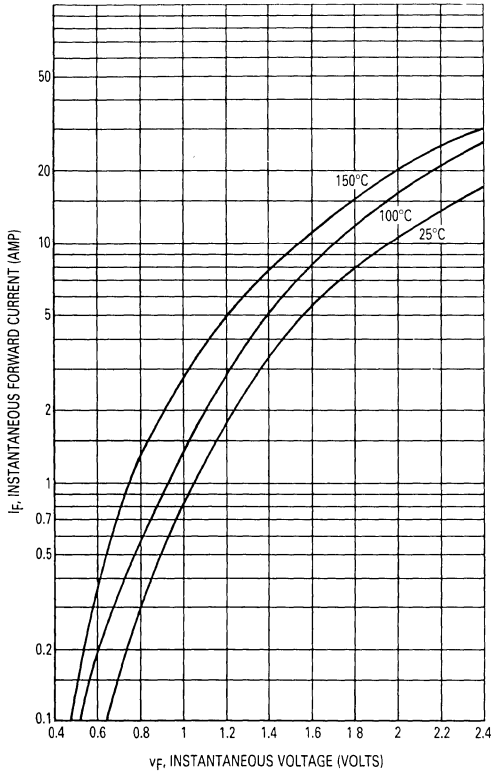


Figure 1. Typical Forward Voltage

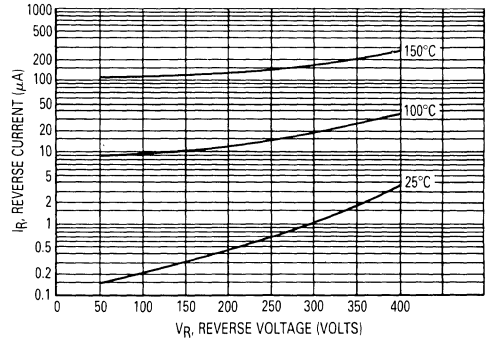


Figure 2. Typical Reverse Current, Per Leg

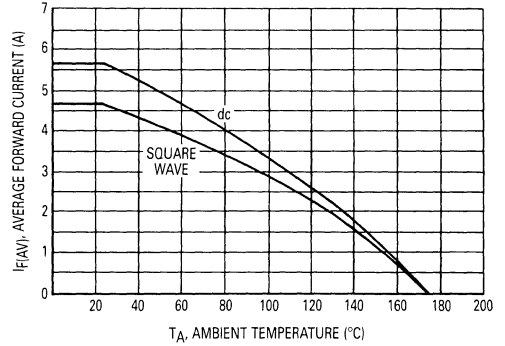


Figure 3. Forward Current Derating, Ambient, Per Leg

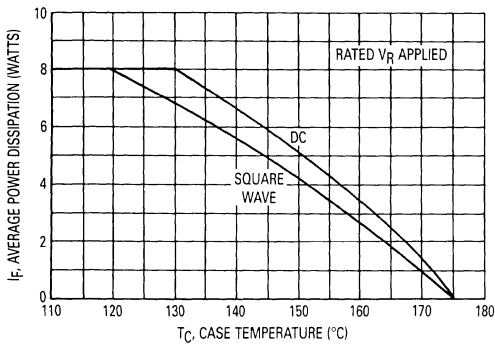


Figure 4. Current Derating, Case, Per Leg

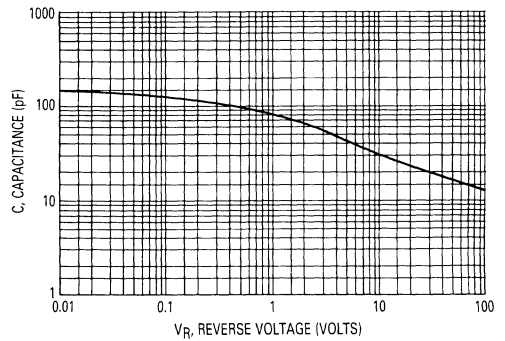


Figure 5. Typical Capacitance, Per Leg

# MURH840CT

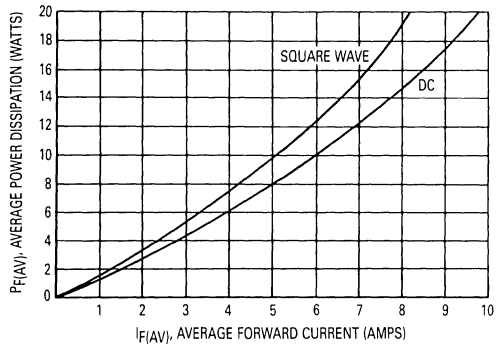


Figure 6. Forward Power Dissipation, Per Leg

*Designer's™ Data Sheet*  
**Switchmode™**  
**Power Rectifiers**

**MURH860CT**

Motorola Preferred Device

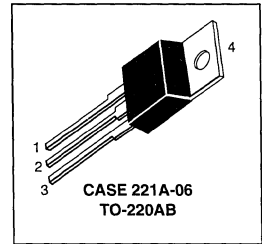
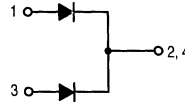
**ULTRAFAST RECTIFIER**  
**8.0 AMPERES**  
**600 VOLTS**

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V<sub>0</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: UH860



4

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	600	Volts
Average Rectified Forward Current Total Device, (Rated $V_R$ ), $T_C = 120^\circ\text{C}$	$I_{F(AV)}$ Total Device	4.0 8.0	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 120^\circ\text{C}$	$I_{FM}$	16	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	100	Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175	°C

**THERMAL CHARACTERISTICS, PER LEG**

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	°C/W
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**ELECTRICAL CHARACTERISTICS, PER LEG**

Maximum Instantaneous Forward Voltage (1) ( $I_F = 4.0$ Amps, $T_C = 150^\circ\text{C}$ ) ( $I_F = 4.0$ Amps, $T_C = 25^\circ\text{C}$ )	$v_F$	2.5 2.8	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	500 10	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amps/ $\mu\text{s}$ )	$t_{rr}$	35	ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq$  2.0%.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

**Preferred** devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MURH860CT

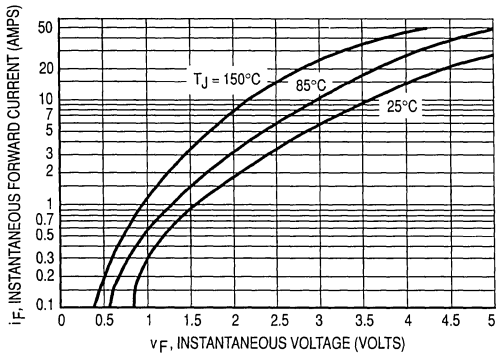


Figure 1. Typical Forward Voltage, Per Leg

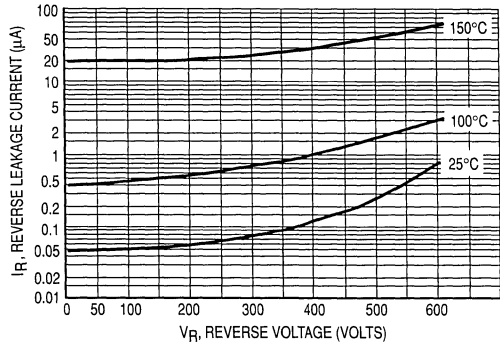


Figure 2. Typical Reverse Leakage Current, Per Leg

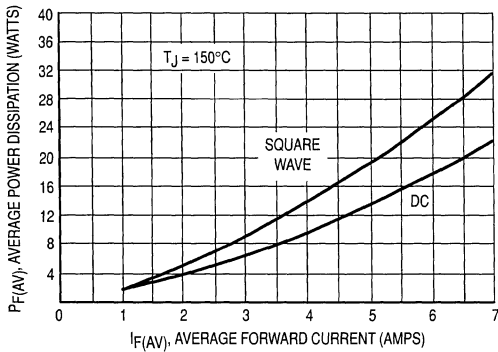


Figure 3. Typical Forward Dissipation, Per Leg

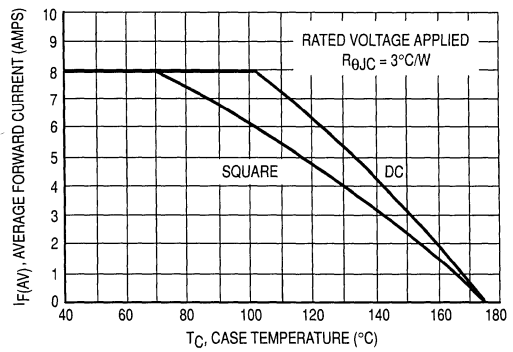


Figure 4. Typical Current Derating, Case, Per Leg

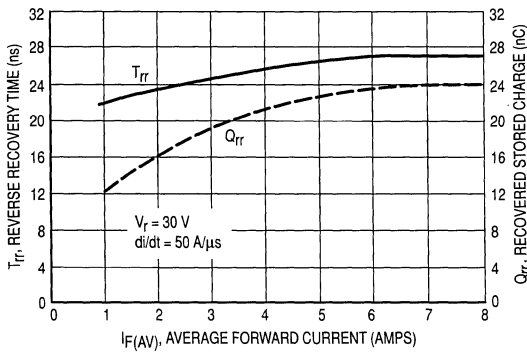


Figure 5. Typical Recovery Characteristics

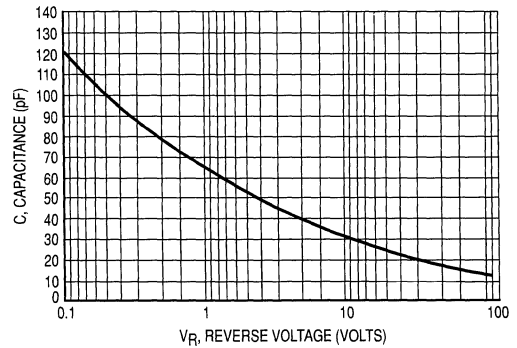


Figure 6. Typical Capacitance, Per Leg

4



Motorola Preferred Devices

## Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

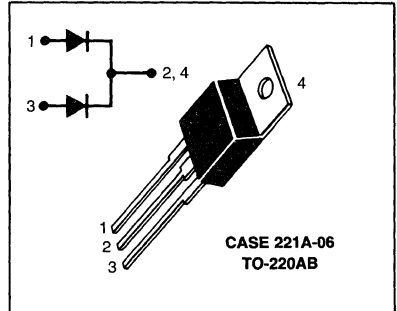
- Ultrafast 35 and 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94,  $V_0 @ 1/8''$
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1620, U1640, U1660

### ULTRAFAST RECTIFIERS

**8 AMPERES**  
**200–400–600 VOLTS**



### MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		1620CT	1640CT	1660CT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	400	600	Volts
Average Rectified Forward Current Total Device, (Rated $V_R$ ), $T_C = 150^\circ\text{C}$	$I_F(AV)$	8.0 16			Amps
Peak Rectified Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	$I_{FM}$	16			Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	100			Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175			°C

### THERMAL CHARACTERISTICS, PER DIODE LEG

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	2.0	°C/W
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### ELECTRICAL CHARACTERISTICS, PER DIODE LEG

Maximum Instantaneous Forward Voltage (1) ( $I_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$ ) ( $I_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	0.895 0.975	1.00 1.30	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	250 5.0	500 10		$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	35 25	60 50		ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 2

# MUR1620CT, MUR1640CT, MUR1660CT

MUR1620CT

FIGURE 1 — TYPICAL FORWARD VOLTAGE, PER LEG

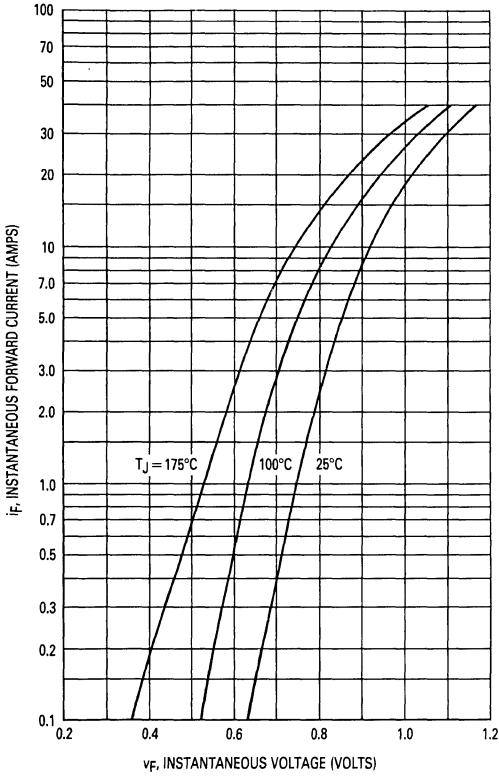


FIGURE 2 — TYPICAL REVERSE CURRENT, PER LEG\*

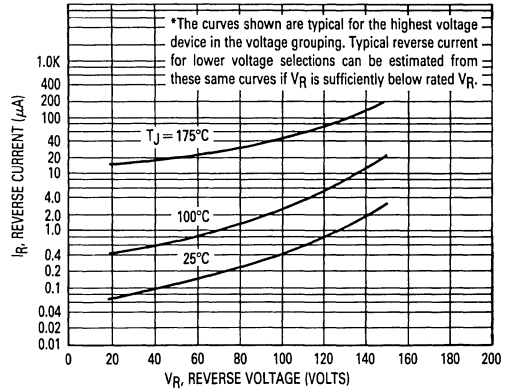


FIGURE 3 — CURRENT DERATING CASE, PER LEG

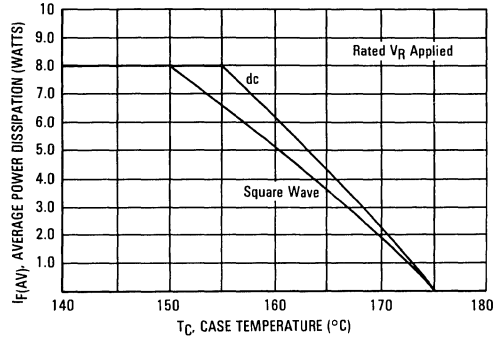


FIGURE 4 — CURRENT DERATING, AMBIENT, PER LEG

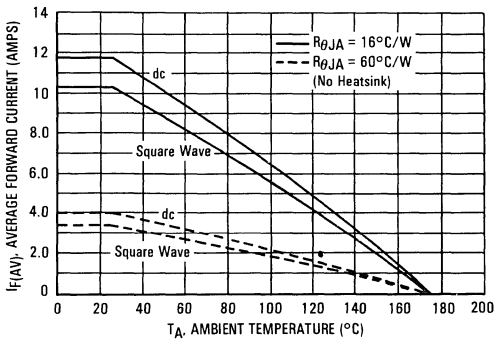
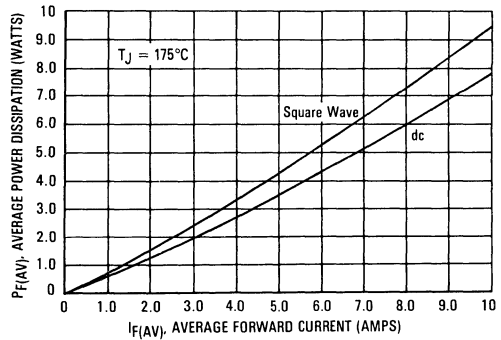


FIGURE 5 — POWER DISSIPATION, PER LEG



4

FIGURE 6 — TYPICAL FORWARD VOLTAGE, PER LEG

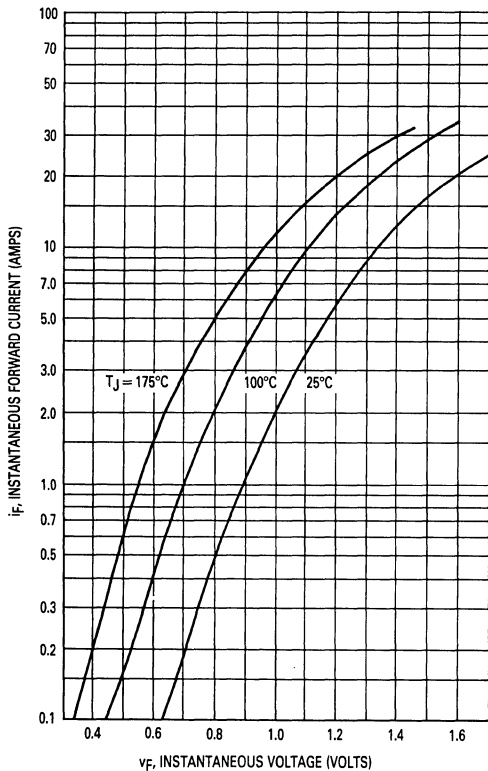


FIGURE 7 — TYPICAL REVERSE CURRENT, PER LEG\*

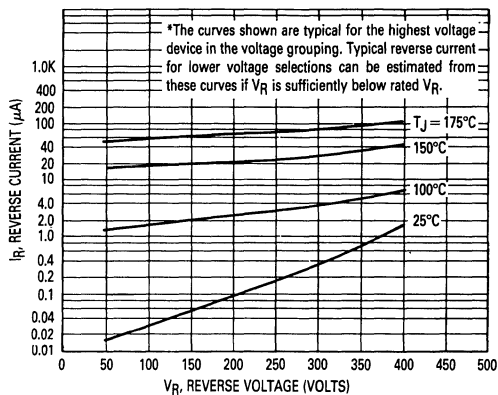


FIGURE 8 — CURRENT DERATING, CASE, PER LEG

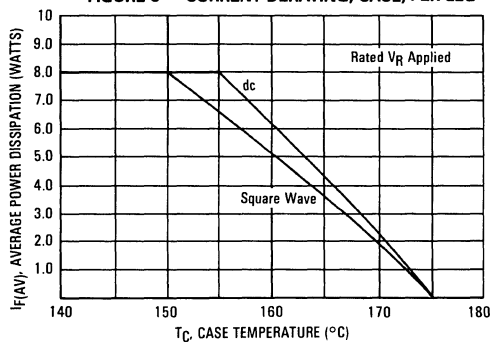


FIGURE 9 — CURRENT DERATING, AMBIENT, PER LEG

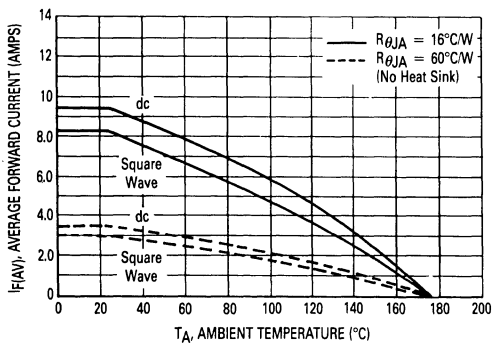
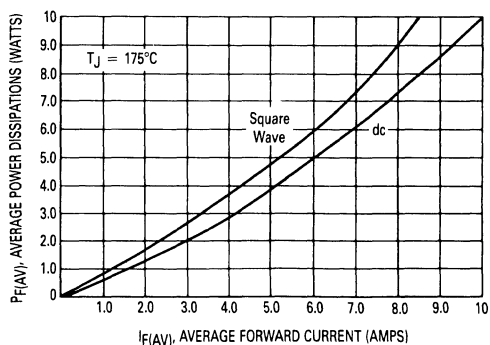


FIGURE 10 — POWER DISSIPATION, PER LEG



# MUR1620CT, MUR1640CT, MUR1660CT

MUR1660CT

FIGURE 11 — TYPICAL FORWARD VOLTAGE, PER LEG

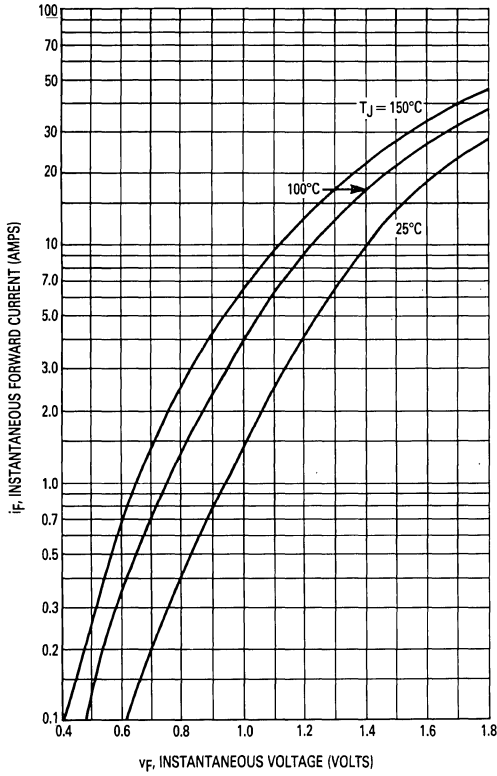


FIGURE 12 — TYPICAL REVERSE CURRENT, PER LEG\*

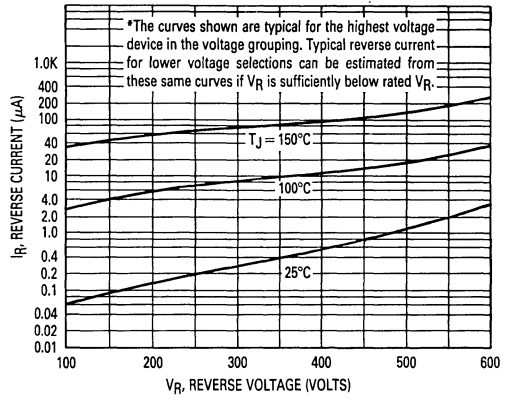


FIGURE 13 — CURRENT DERATING, CASE, PER LEG

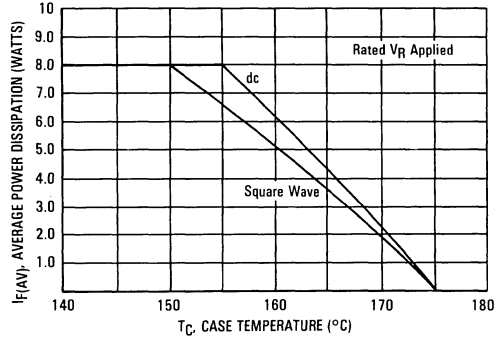


FIGURE 14 — CURRENT DERATING, AMBIENT, PER LEG

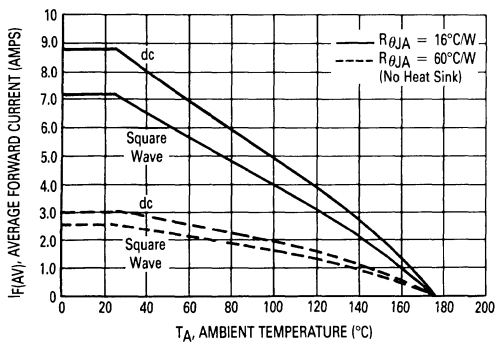
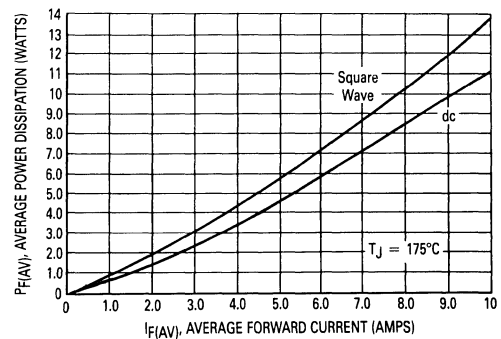


FIGURE 15 — POWER DISSIPATION, PER LEG



4

FIGURE 16 — THERMAL RESPONSE

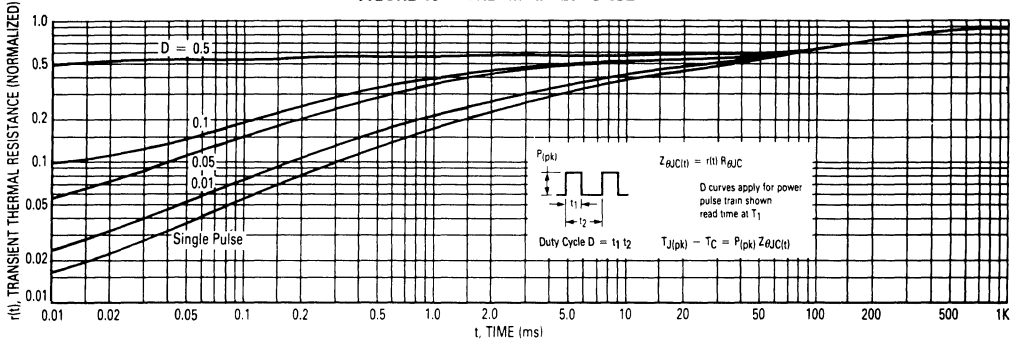
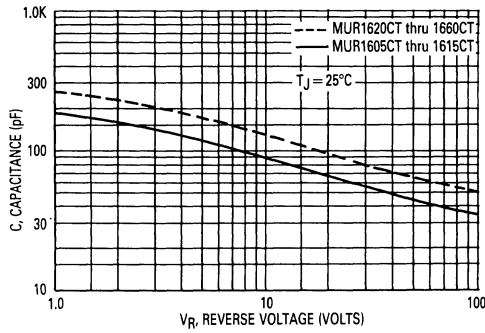


FIGURE 17 — TYPICAL CAPACITANCE, PER LEG



## Switchmode Dual Ultrafast Power Rectifiers

... designed for use in negative switching power supplies, inverters and as free wheeling diodes. Also, used in conjunction with common cathode dual Ultrafast Rectifiers, makes a single phase full-wave bridge. These state-of-the-art devices have the following features:

- Common Anode Dual Rectifier (8.0 A per Leg or 16 A per Package)
- Ultrafast 35 Nanosecond Reverse Recovery Times
- Exhibits Soft Recovery Characteristics
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- Complement to MUR1605CT Series of Common Cathode Devices

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1620R

### MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	Volts
Average Rectified Forward Voltage, (Rated V <sub>F</sub> ), T <sub>C</sub> = 160°C Per Leg Per Total Device	I <sub>F(AV)</sub>	8.0 16	Amps
Peak Repetitive Surge Current, Per Diode (Rated V <sub>F</sub> , Square Wave, 20 kHz) T <sub>C</sub> = 140°C	I <sub>FM</sub>	16	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	Amps
Operating Junction Temperature and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C

### THERMAL CHARACTERISTICS (Per Leg)

Thermal Resistance — Junction to Case	R <sub>θJC</sub>	2.0	°C/W
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### ELECTRICAL CHARACTERISTICS (Per Leg)

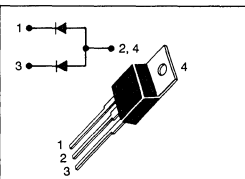
Maximum Instantaneous Forward Voltage (1) (I <sub>F</sub> = 8.0 Amp, T <sub>C</sub> = 25°C) (I <sub>F</sub> = 8.0 Amp, T <sub>C</sub> = 150°C)	V <sub>F</sub>	1.2 1.1	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T <sub>C</sub> = 25°C) (Rated dc Voltage, T <sub>C</sub> = 150°C)	i <sub>R</sub>	5.0 500	μA
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amp/μs) (I <sub>F</sub> = 0.5 Amp, di/dt = 100 Amp/μs)	t <sub>rr</sub>	85 35	ns

(1) Pulse Test: Pulse Width = 5.0 ms, Duty Cycle ≤ 10%.

**MUR1620CTR**

Motorola Preferred Device

**ULTRAFAST RECTIFIERS**  
**16 AMPERES**  
**200 VOLTS**



CASE 221A-06  
TO-220AB  
STYLE 7

# MUR1620CTR

4

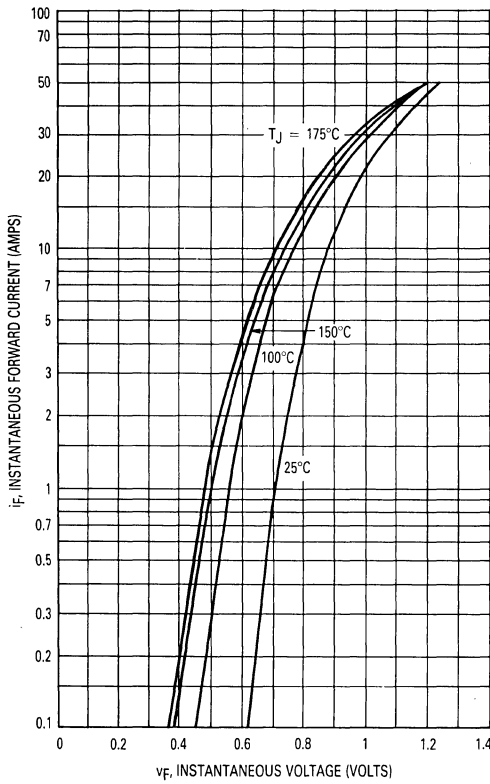


Figure 1. Typical Forward Voltage (Per Leg)

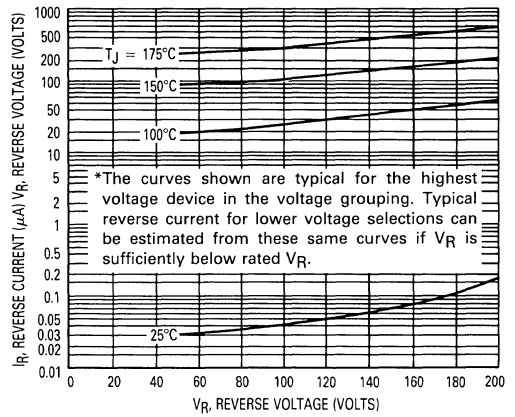


Figure 2. Typical Reverse Current\* (Per Leg)

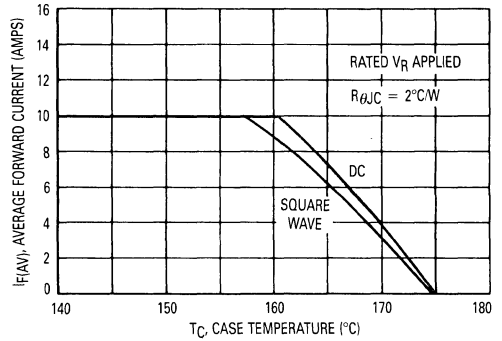


Figure 3. Current Derating, Case (Per Leg)

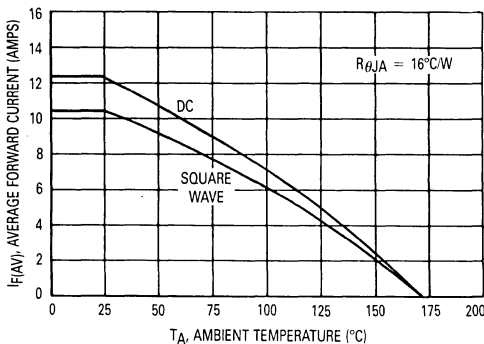


Figure 4. Current Derating, Ambient (Per Leg)

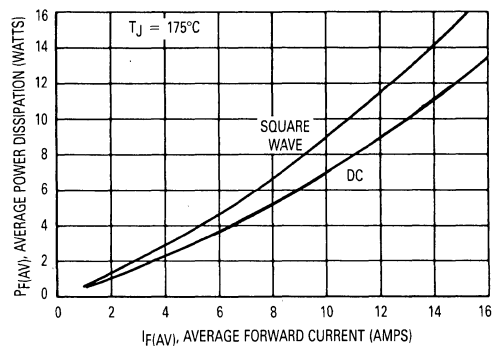


Figure 5. Power Dissipation (Per Leg)

# MUR1620CTR

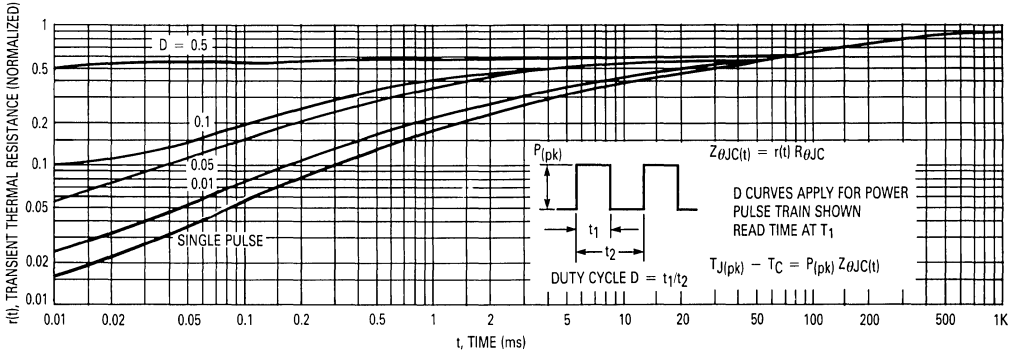


Figure 6. Thermal Response

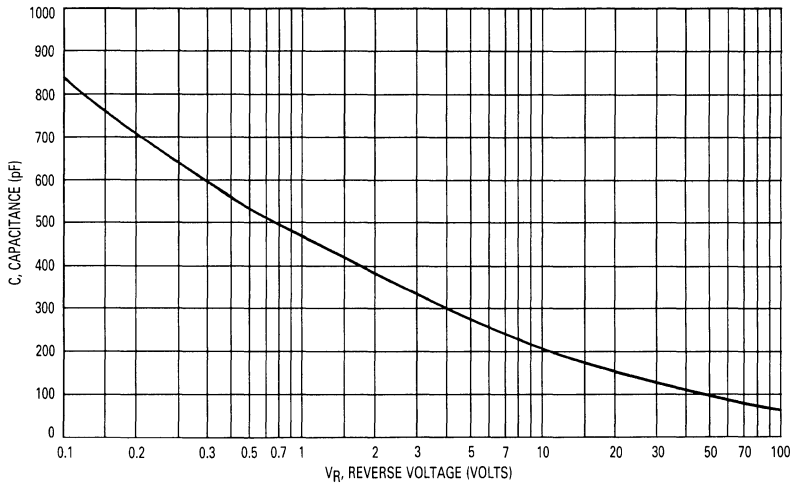


Figure 7. Typical Capacitance (Per Leg)

4



*Designer's™ Data Sheet*  
**SCANSWITCH™ Power Rectifier**  
**For Use As A Damper Diode**  
**In High and Very High Resolution Monitors**

**MUR5150E**

Motorola Preferred Device

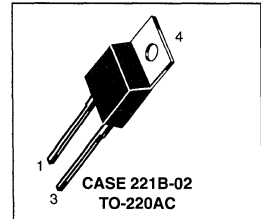
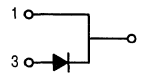
**SCANSWITCH  
RECTIFIER  
5.0 AMPERES  
1500 VOLTS**

The MUR5150E is a state-of-the-art Ultrafast Power Rectifier specifically designed for use as a damper diode in horizontal deflection circuits for high and very high resolution monitors. In these applications, the outstanding performance of the MUR5150E is fully realized when paired with the appropriate 1500V SCANSWITCH Bipolar Power Transistor.

- 1500 V Blocking Voltage
- 20 mJoules Avalanche Energy Guaranteed
- Peak Transient Overshoot Voltage Specified, 17 Volts (typical)
- Forward Recovery Time Specified, 175 ns (typical)
- Epoxy Meets UL94, V<sub>0</sub> at 1/8"

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U5150E



4

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	1500	Volts
Average Rectified Forward Current, (Rated V <sub>F</sub> ), T <sub>C</sub> = 100°C	I <sub>F(AV)</sub>	5.0	Amps
Peak Repetitive Forward Current, Per Leg (Rated V <sub>F</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 100°C	I <sub>FRM</sub>	10	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	Amps
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +125	°C
Controlled Avalanche Energy	W <sub>AVAIL</sub>	20	mJ

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Case	R <sub>θJC</sub>	2.0	°C/W
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**ELECTRICAL CHARACTERISTICS**

Rating	Symbol	Typ	Max	Units
Maximum Instantaneous Forward Voltage (1) (I <sub>F</sub> = 2.0 Amps, T <sub>J</sub> = 25°C) (I <sub>F</sub> = 5.0 Amps, T <sub>J</sub> = 25°C)	V <sub>F</sub>	1.7 2.0	2.0 2.4	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T <sub>J</sub> = 125°C) (Rated dc Voltage, T <sub>J</sub> = 25°C)	i <sub>R</sub>	100 10	500 50	μA
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amps, di/dt = 50 Amps/μs)	t <sub>rr</sub>	130	175	ns
Maximum Forward Recovery Time (I <sub>F</sub> = 6.5 Amps, di/dt = 12 Amps/μs)	t <sub>fr</sub>	175	225	ns
Peak Transient Overshoot Voltage	V <sub>RFM</sub>	17	20	Volts

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2%

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing bound limits on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MUR5150E

## TYPICAL ELECTRICAL CHARACTERISTICS

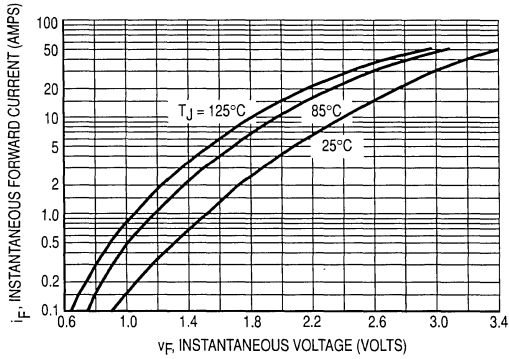


Figure 1. Typical Forward Voltage

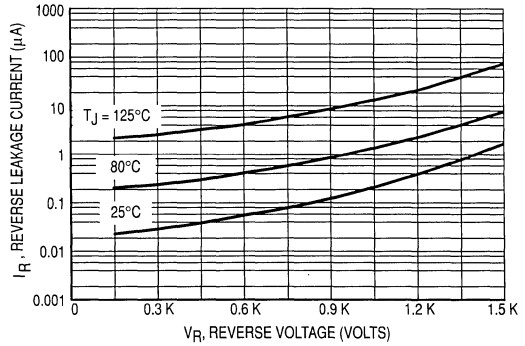


Figure 2. Typical Reverse Leakage Current

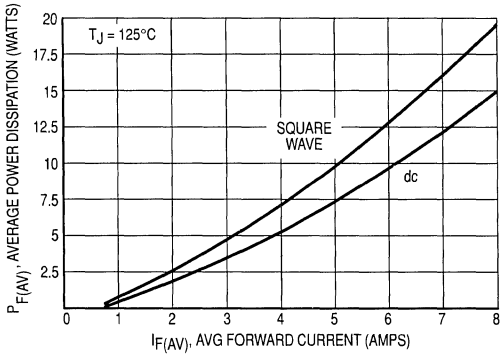


Figure 3. Forward Power Dissipation

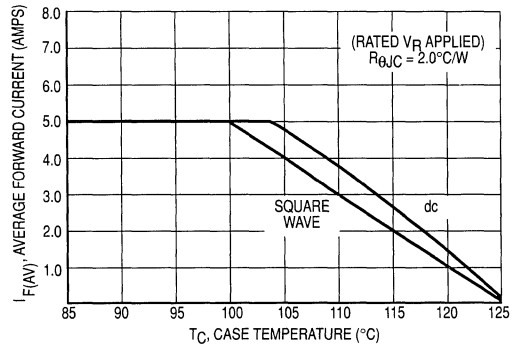


Figure 4. Current Derating Case

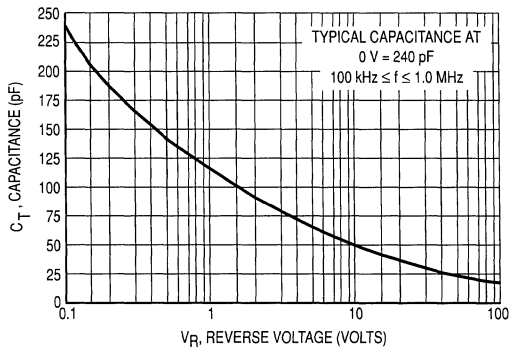


Figure 5. Typical Capacitance

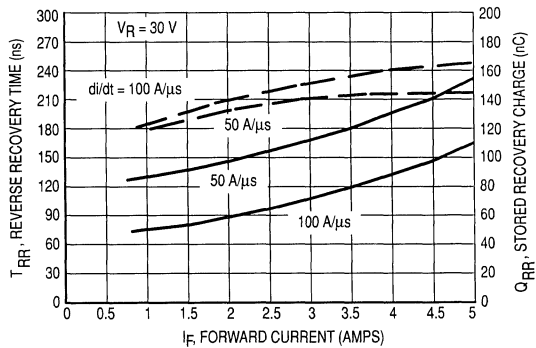


Figure 6. Typical Reverse Switching Characteristics



Motorola Preferred Devices

## Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

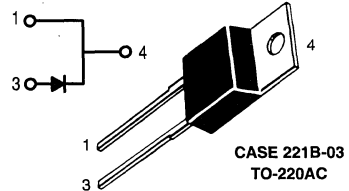
- Ultrafast 25, 50 and 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy meets UL94,  $V_O @ 1/8"$
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U820, U840, U860

### ULTRAFAST RECTIFIERS

**8 AMPERES**  
**200–400–600 VOLTS**



4

### MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		820	840	860	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	400	600	Volts
Average Rectified Forward Current Total Device, (Rated $V_R$ ), $T_C = 150^\circ\text{C}$	$I_{F(AV)}$	8.0			Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	$I_{FM}$	16			Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	100			Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175			$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	2.0	$^\circ\text{C/W}$
--	-----------------	-----	-----	--------------------

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$ ) ( $I_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	0.895 0.975	1.00 1.30	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ )	$I_R$	250 5.0	500 10		$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $I_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	35 25	60 50		ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

Rev 3

# MUR820, MUR840, MUR860

MUR820

FIGURE 1 — TYPICAL FORWARD VOLTAGE

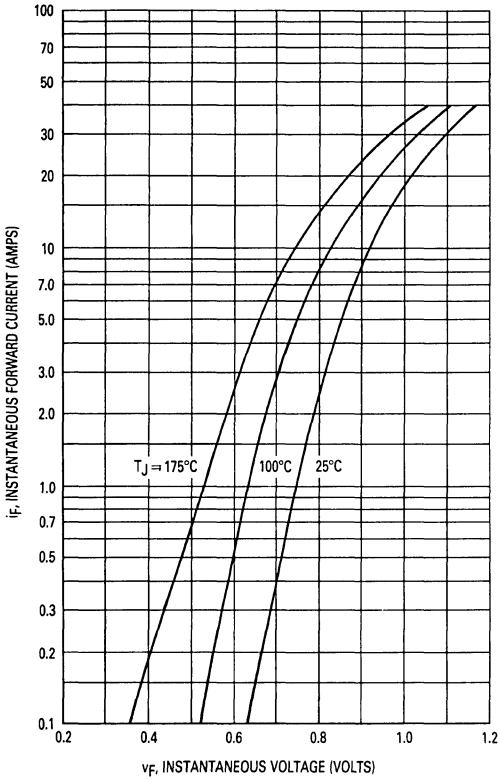


FIGURE 2 — TYPICAL REVERSE CURRENT\*

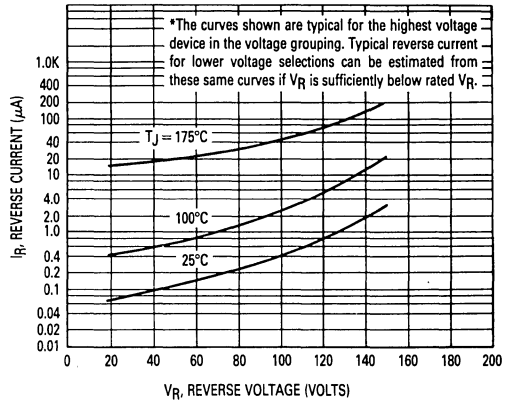


FIGURE 3 — CURRENT DERATING, CASE

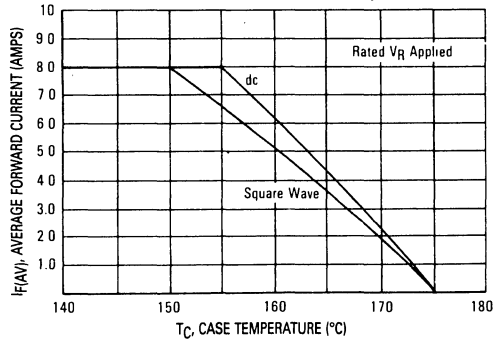


FIGURE 4 — CURRENT DERATING, AMBIENT

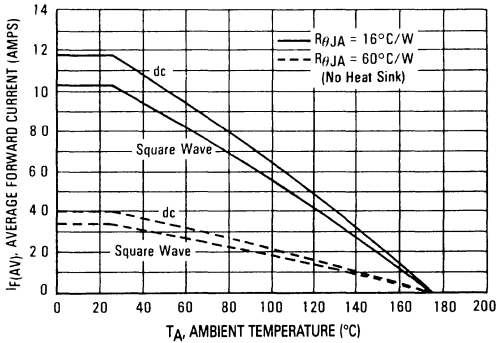


FIGURE 5 — POWER DISSIPATION

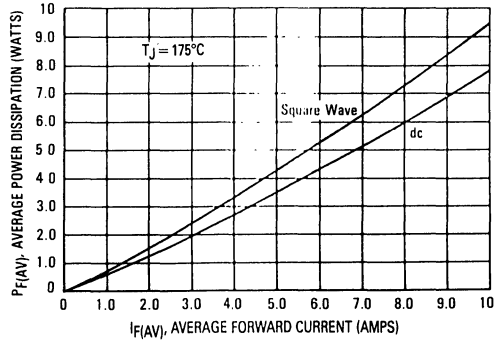


FIGURE 6 — TYPICAL FORWARD VOLTAGE

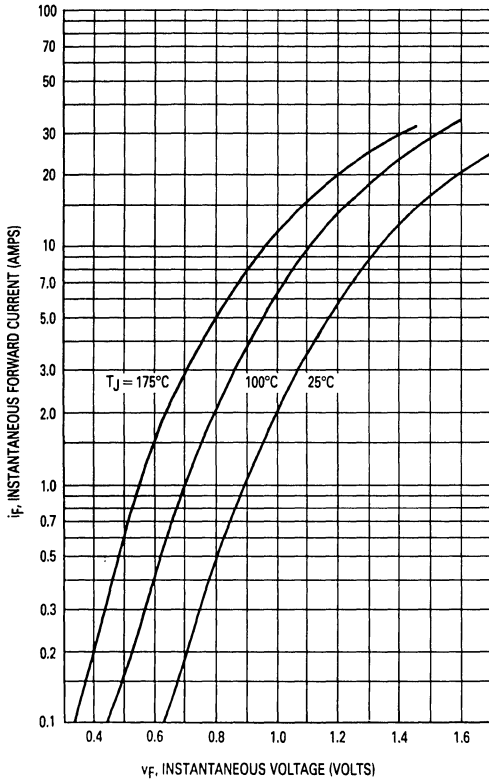


FIGURE 7 — TYPICAL REVERSE CURRENT\*

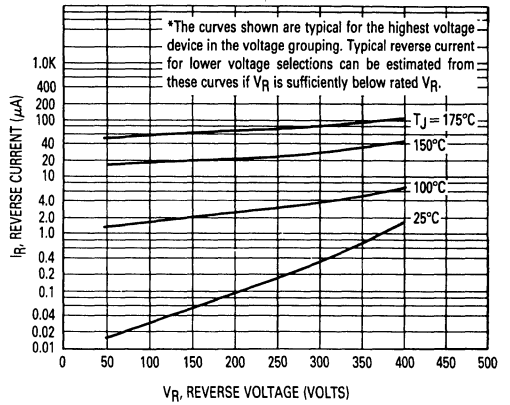


FIGURE 8 — CURRENT DERATING, CASE

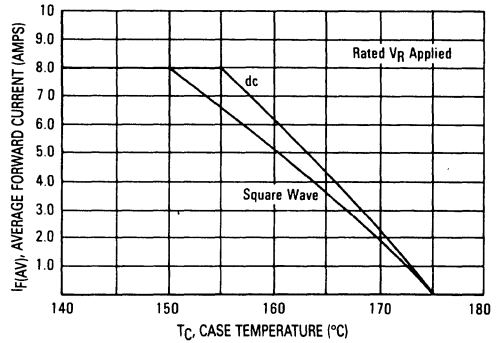


FIGURE 9 — CURRENT DERATING, AMBIENT

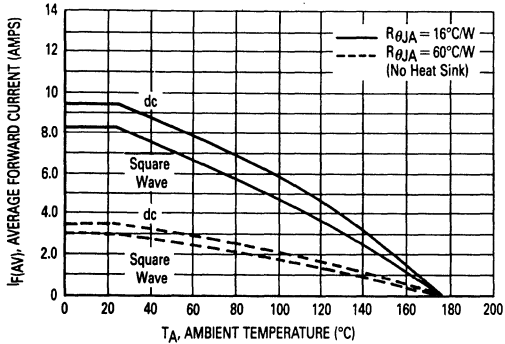


FIGURE 10 — POWER DISSIPATION

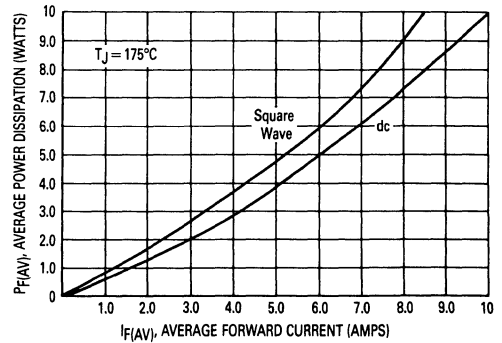


FIGURE 11 — TYPICAL FORWARD VOLTAGE

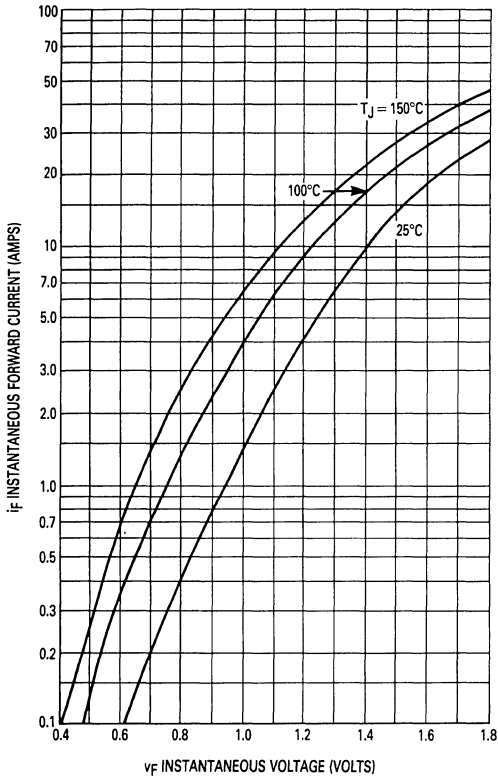


FIGURE 12 — TYPICAL REVERSE CURRENT\*

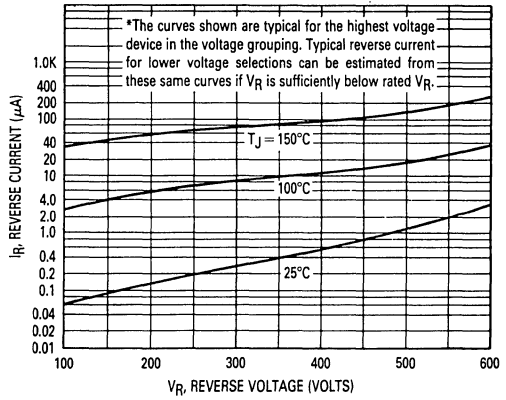


FIGURE 13 — CURRENT DERATING, CASE

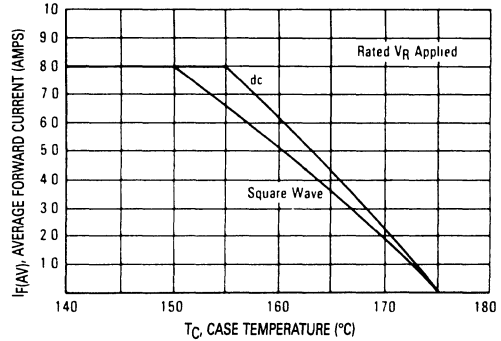


FIGURE 14 — CURRENT DERATING, AMBIENT

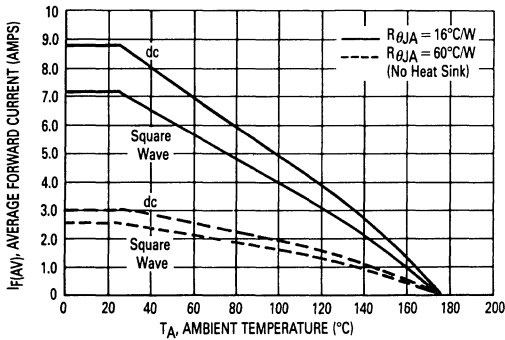
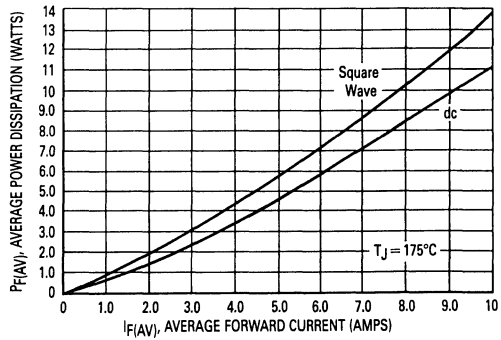


FIGURE 15 — POWER DISSIPATION



# MUR820, MUR840, MUR860

FIGURE 16 — THERMAL RESPONSE

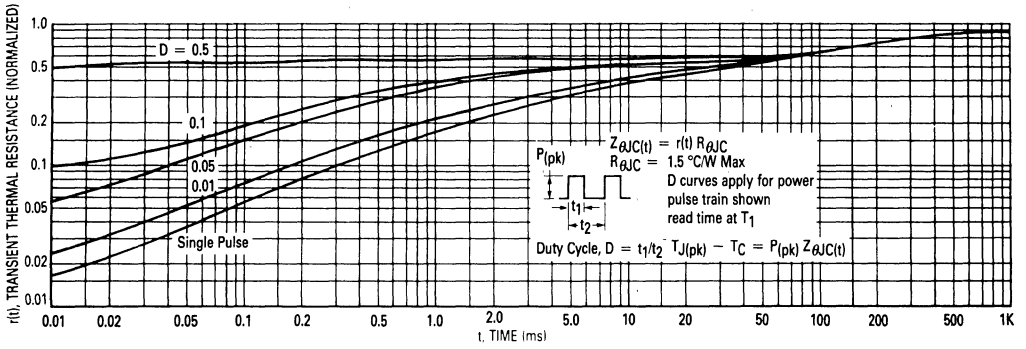
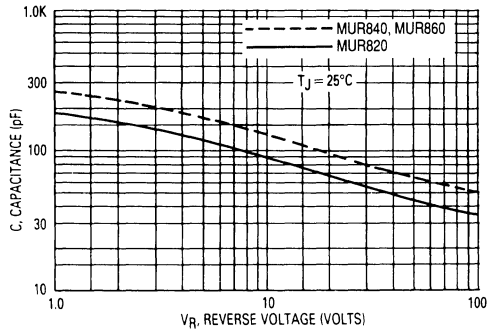


FIGURE 17 — TYPICAL CAPACITANCE



# Switchmode Power Rectifiers

## Ultrafast "E" Series

### w/High Reverse Energy Capability

**MUR890E**  
**MUR8100E**

MUR8100E is a  
 Motorola Preferred Device

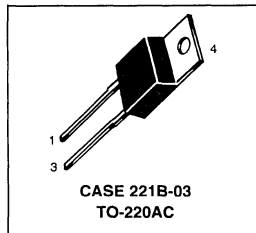
... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mJoules Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94,  $V_0 @ 1/8"$
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts

**ULTRAFAST**  
**RECTIFIERS**  
**8.0 AMPERES**  
**900-1000 VOLTS**

#### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U890E, U8100E



**4**

#### MAXIMUM RATINGS

Rating	Symbol	MUR		Unit
		890E	8100E	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	900	1000	Volts
Average Rectified Forward Current Total Device, (Rated $V_R$ ), $T_C = 150^\circ\text{C}$	$I_{F(AV)}$	8.0		Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	$I_{FM}$	16		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	100		Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175		$^\circ\text{C}$

#### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	$^\circ\text{C/W}$
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#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (1) ( $I_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$ ) ( $I_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	1.5 1.8	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 100^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	500 25	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	100 75	ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	$W_{AVAL}$	20	mJ

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .



# MUR890E, MUR8100E

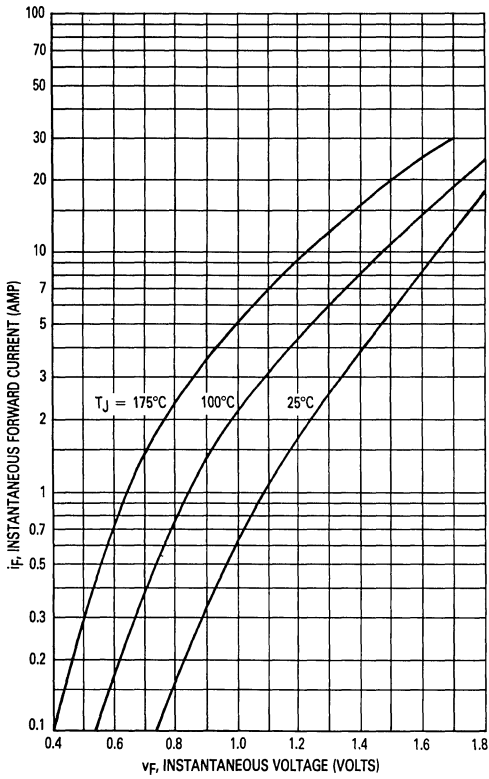


Figure 1. Typical Forward Voltage

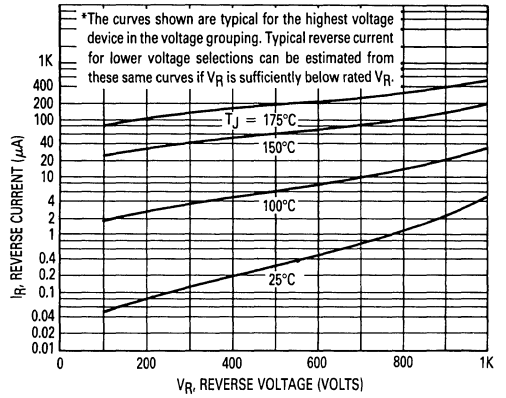


Figure 2. Typical Reverse Current\*

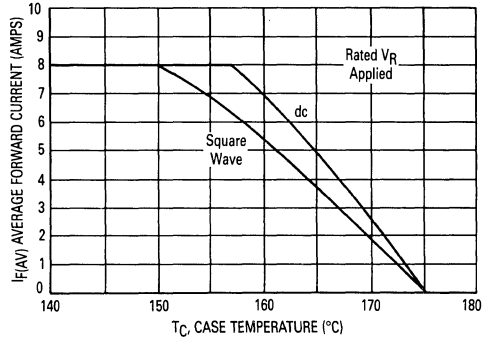


Figure 3. Current Derating, Case

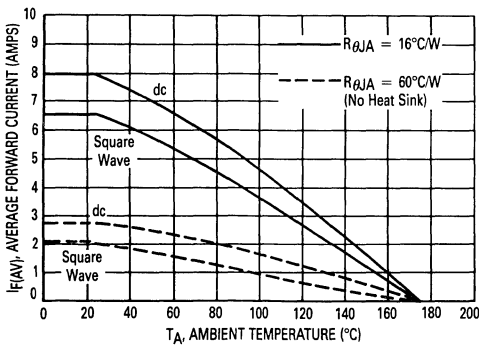


Figure 4. Current Derating, Ambient

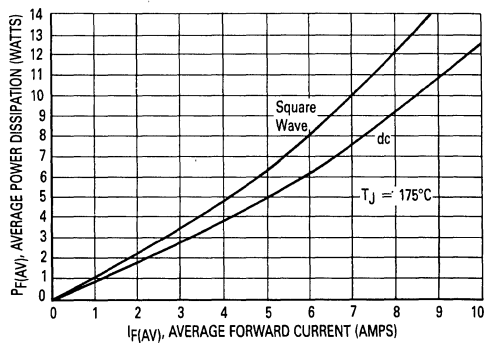


Figure 5. Power Dissipation

# MUR890E, MUR8100E

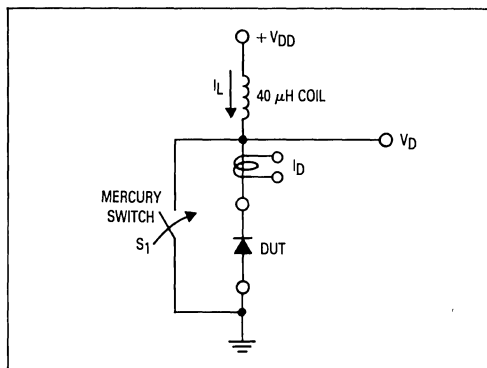


Figure 6. Test Circuit

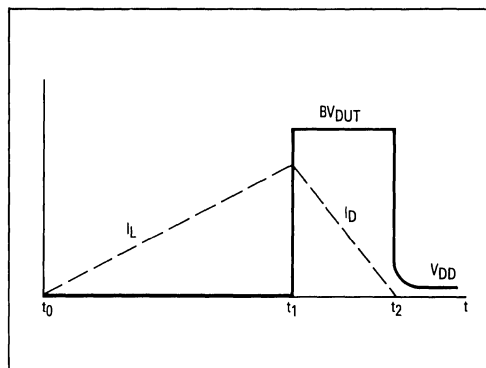


Figure 7. Current-Voltage Waveforms

4

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new "E" series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When  $S_1$  is closed at  $t_0$  the current in the inductor  $I_L$  ramps up linearly; and energy is stored in the coil. At  $t_1$  the switch is opened and the voltage across the diode under test begins to rise rapidly, due to  $di/dt$  effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at  $BV_{DUT}$  and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at  $t_2$ .

By solving the loop equation at the point in time when  $S_1$  is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the  $V_{DD}$  power supply while the diode is in breakdown (from  $t_1$  to  $t_2$ ) minus

any losses due to finite component resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the  $V_{DD}$  voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when  $S_1$  was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the MUR8100E in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mJoules.

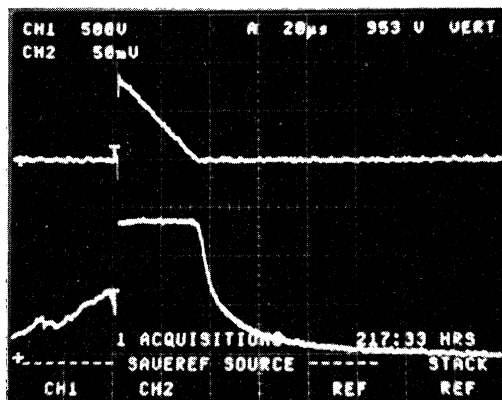
Although it is not recommended to design for this condition, the new "E" series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.

EQUATION (1):

$$W_{AVAIL} \approx \frac{1}{2} L I_{LPK}^2 \left( \frac{BV_{DUT}}{BV_{DUT} - V_{DD}} \right)$$

EQUATION (2):

$$W_{AVAIL} \approx \frac{1}{2} L I_{LPK}^2$$



CHANNEL 2:  
 $I_L$   
0.5 AMPS/DIV.

CHANNEL 1:  
 $V_{DUT}$   
500 VOLTS/DIV.

TIME BASE:  
20  $\mu$ s/DIV.

Figure 8. Current-Voltage Waveforms

# MUR890E, MUR8100E

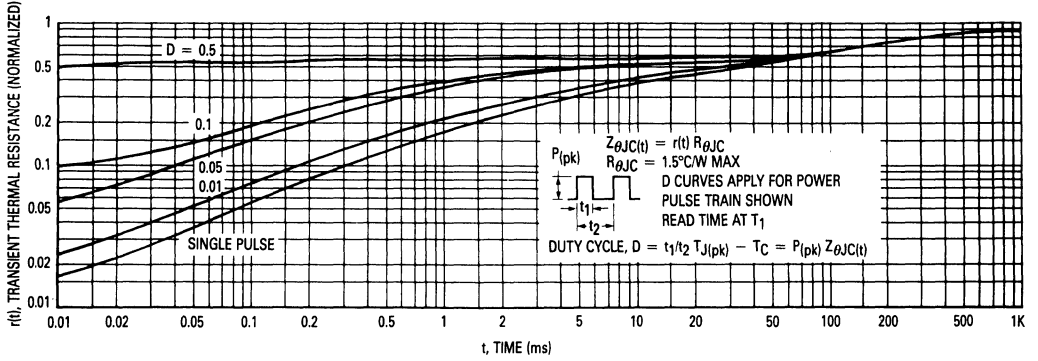


Figure 9. Thermal Response

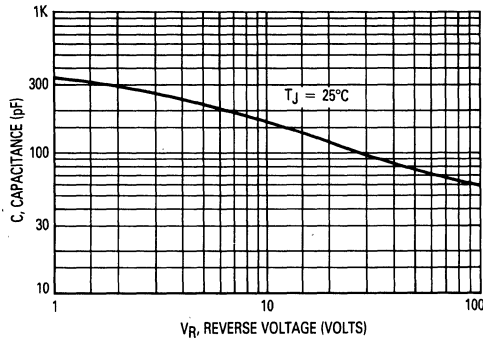


Figure 10. Typical Capacitance

# SCANSWITCH™

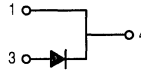
## Power Rectifier For High and Very High Resolution Monitors

This state-of-the-art power rectifier is specifically designed for use as a damper diode in horizontal deflection circuits for high and very high resolution monitors. In these applications, the outstanding performance of the MUR10120E is fully realized when paired with either the MJH16206 or MJF16206 monitor specific, 1200 volt bipolar power transistor.

- 1200 Volt Blocking Voltage
- 20 mJ Avalanche Energy (Guaranteed)
- 12 Volt (Typical) Peak Transient Overshoot Voltage
- 135 ns (Typical) Forward Recovery Time

### Mechanical Characteristics:

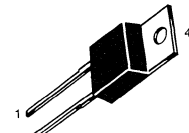
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U10120E



**MUR10120E**

Motorola Preferred Device

**SCANSWITCH  
RECTIFIER  
10 AMPERES  
1200 VOLTS**



CASE 221B-03  
(TO-220AC)  
STYLE 1

4

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	1200	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 125^\circ\text{C}$	$I_F(AV)$	10	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 125^\circ\text{C}$	$I_{FRM}$	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	$I_{FSM}$	100	Amps
Operating Junction Temperature	$T_J$	-65 to +125	°C
Controlled Avalanche Energy	$W_{AVAL}$	20	mJ

### THERMAL CHARACTERISTICS

Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	°C/W
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### ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Typ	Max	Unit
Maximum Instantaneous Forward Voltage (1) ( $I_F = 6.5$ Amps, $T_J = 125^\circ\text{C}$ ) ( $I_F = 6.5$ Amps, $T_J = 25^\circ\text{C}$ )	$v_F$	1.7 1.9	2.0 2.2	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_J = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_J = 125^\circ\text{C}$ )	$i_R$	25 750	100 1000	μA
Maximum Reverse Recovery Time ( $I_F = 1.0$ A, $di/dt = 50$ Amps/μs)	$t_{rr}$	150	175	ns
Maximum Forward Recovery Time ( $I_F = 6.5$ Amps, $di/dt = 12$ Amps/μs (As Measured on a Deflection Circuit))	$t_{fr}$	135	175	ns
Peak Transient Overshoot Voltage	$V_{RFM}$	12	14	Volts

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

Rev 1

# MUR10120E

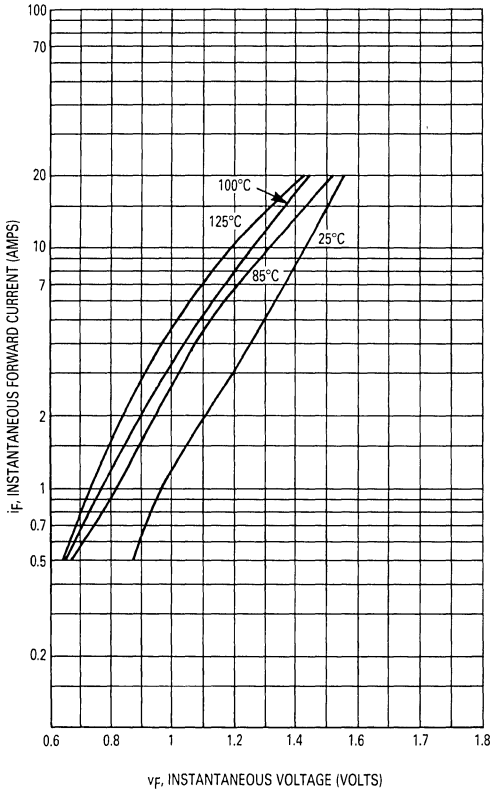


Figure 1. Typical Forward Voltage

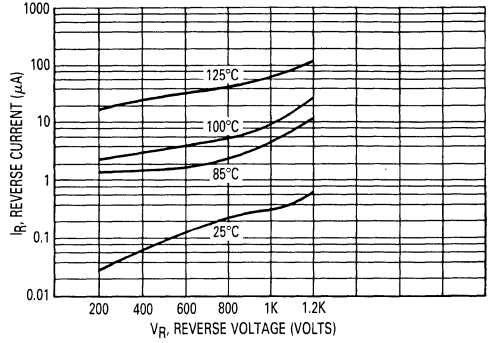


Figure 2. Typical Reverse Current

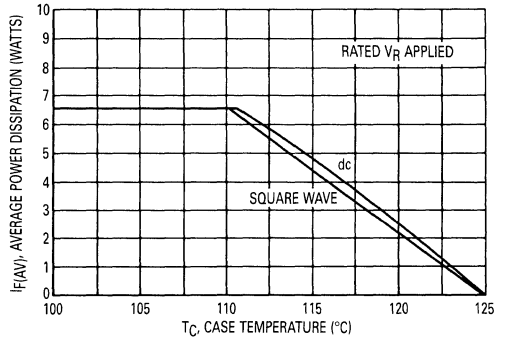


Figure 3. Current Derating, Case

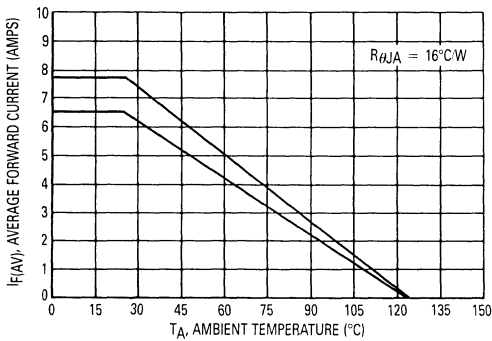


Figure 4. Current Derating, Ambient

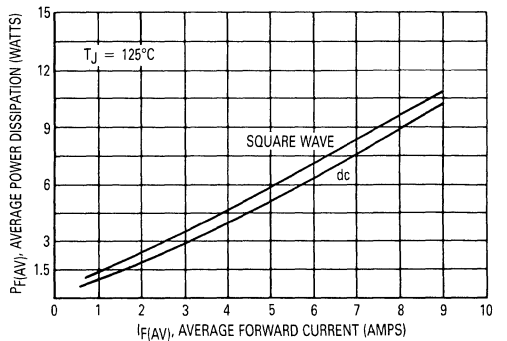


Figure 5. Power Dissipation

# MUR10120E

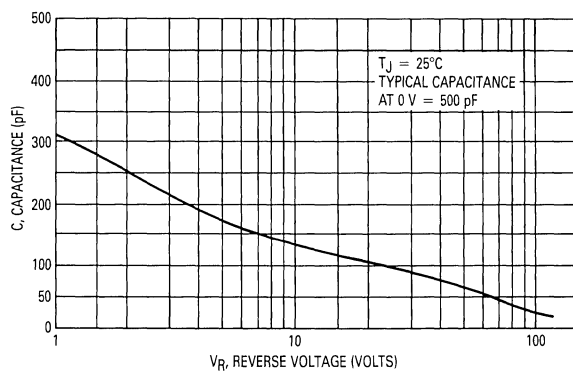


Figure 6. Typical Capacitance

Designer's™ Data Sheet

**SCANSWITCH™**

**Power Rectifier**

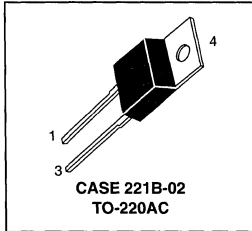
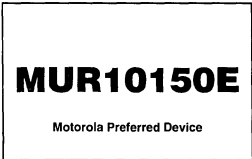
**For Use As A Damper Diode In High  
And Very High Resolution Monitors**

The MUR10150E is a state-of-the-art Power Rectifier specifically designed for use as a damper diode in horizontal deflection circuits for high and very high resolution monitors. In these applications, the outstanding performance of the MUR10150E is fully realized when paired with either the MJW16212 or MJF16212 monitor specific, 1500 V bipolar power transistor.

- 1500 V Blocking Voltage
- 20 mJ Avalanche Energy Guaranteed
- Peak Transient Overshoot Voltage Specified, 14 Volt (typical)
- Forward Recovery Time Specified, 135 ns (typical)
- Epoxy Meets UL94, V<sub>0</sub> at 1/8"

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U10150E



4

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	1500	Volts
Average Rectified Forward Current, (Rated V <sub>R</sub> ), T <sub>C</sub> = 125°C	I <sub>F(AV)</sub>	10	Amps
Peak Repetitive Forward Current, Per Leg (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 125°C	I <sub>FRM</sub>	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	Amps
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +125	°C
Controlled Avalanche Energy	W <sub>AVAIL</sub>	20	mJ

**THERMAL CHARACTERISTICS**

Thermal Resistance — Junction to Case	R <sub>θJC</sub>	2.0	°C/W
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**ELECTRICAL CHARACTERISTICS**

Rating	Symbol	Typ	Max	Unit
Maximum Instantaneous Forward Voltage (1) (I <sub>F</sub> = 6.5 Amps, T <sub>J</sub> = 125°C) (I <sub>F</sub> = 6.5 Amps, T <sub>J</sub> = 25°C)	V <sub>F</sub>	1.7 1.9	2.2 2.4	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T <sub>J</sub> = 125°C) (Rated dc Voltage, T <sub>J</sub> = 25°C)	i <sub>R</sub>	750 25	1000 100	μA
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>	150	175	ns
Maximum Forward Recovery Time (I <sub>F</sub> = 6.5 Amp, di/dt = 12 Amps/μs)	t <sub>fr</sub>	135	175	ns
Peak Transient Overshoot Voltage	V <sub>RFM</sub>	14	16	Volts

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2%.

**Designer's Data for "Worst Case" Conditions** — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

**Preferred** devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MUR10150E

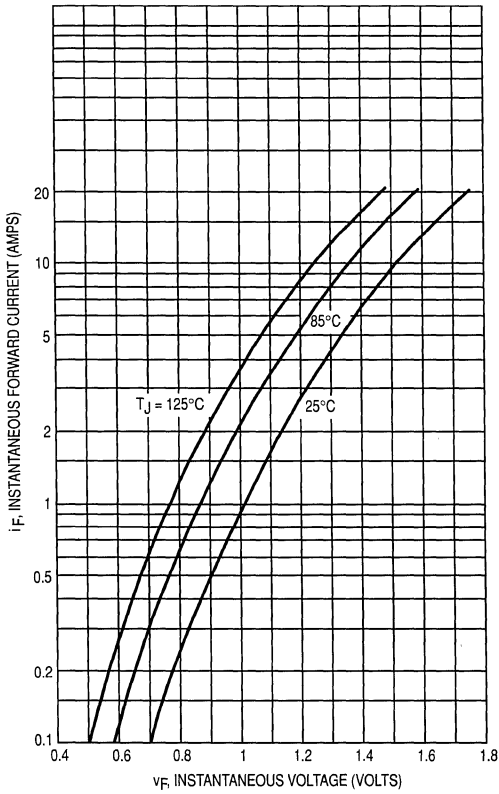


Figure 1. Typical Forward Voltage

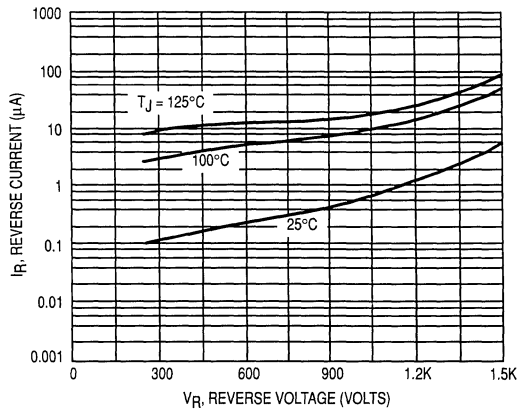


Figure 2. Typical Reverse Current

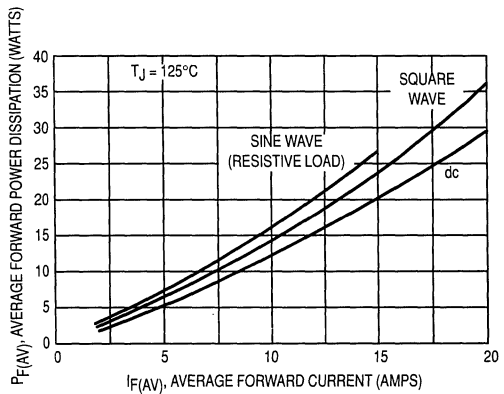


Figure 3. Forward Power Dissipation

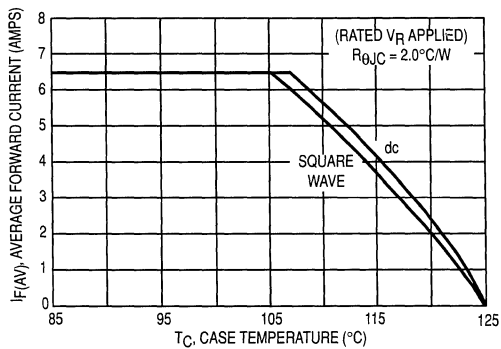


Figure 4. Current Derating Case

4



# MUR10150E

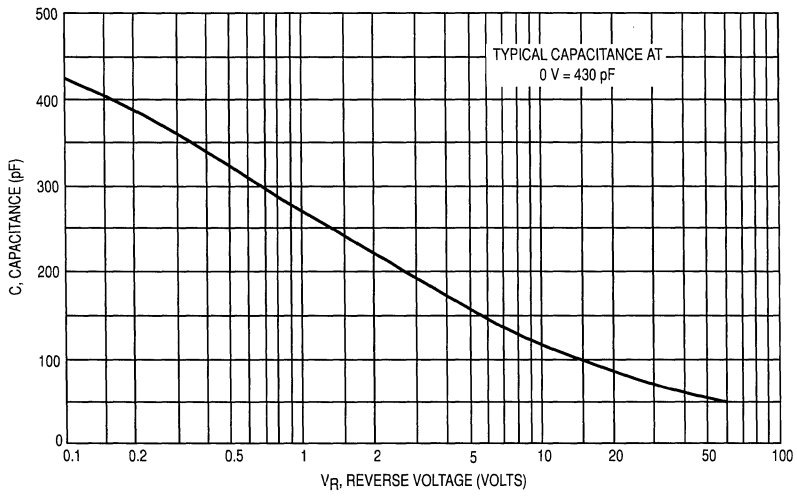


Figure 5. Typical Capacitance

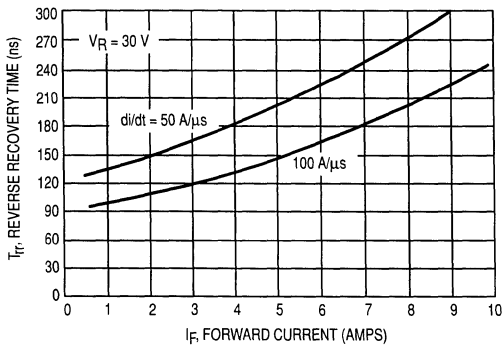


Figure 6. Typical Reverse Recovery Time

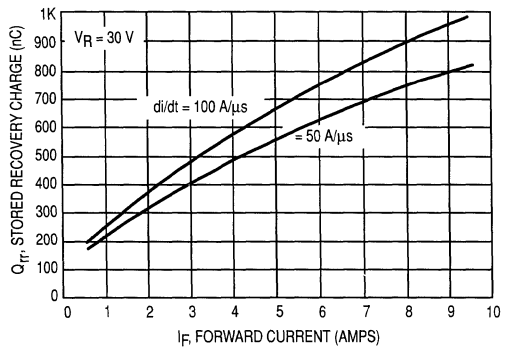


Figure 7. Typical Stored Recovery Charge

Motorola Preferred Devices



## Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

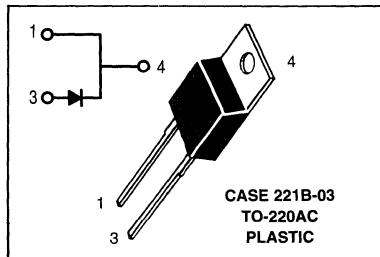
- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1520, U1540, U1560

### ULTRAFast RECTIFIERS

**15 AMPERES**  
**200-400-600 VOLTS**



**4**

### MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		1520	1540	1560	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	400	600	Volts
Average Rectified Forward Current (Rated $V_F$ )	$I_{F(AV)}$	15 @ $T_C = 150^\circ\text{C}$		15 @ $T_C = 145^\circ\text{C}$	Amps
Peak Rectified Forward Current (Rated $V_F$ , Square Wave, 20 kHz)	$I_{FRM}$	30 @ $T_C = 150^\circ\text{C}$		30 @ $T_C = 145^\circ\text{C}$	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	200	150		Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175			°C

### THERMAL CHARACTERISTICS

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	°C/W
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### ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	1520	1540	1560	Unit
Maximum Instantaneous Forward Voltage (1) ( $I_F = 15$ Amp, $T_C = 150^\circ\text{C}$ ) ( $I_F = 15$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	0.85 1.05	1.12 1.25	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$I_R$	500 10	500 10	1000 10	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ )	$t_{rr}$	35	60		ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

FIGURE 1 — TYPICAL FORWARD VOLTAGE

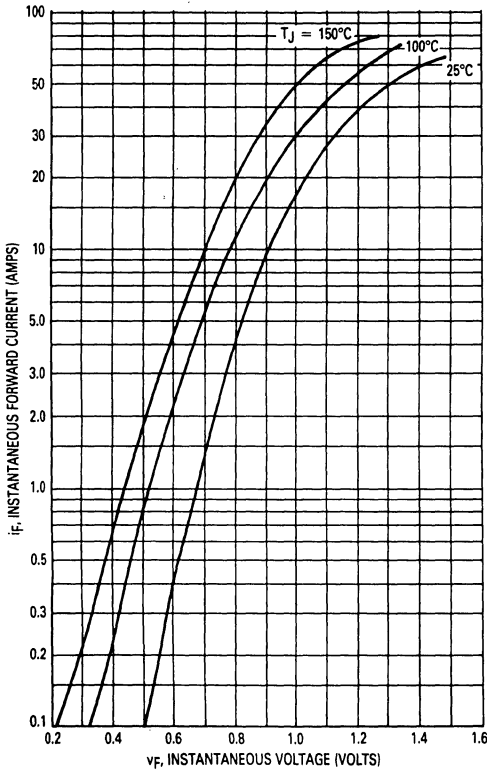


FIGURE 2 — TYPICAL REVERSE CURRENT

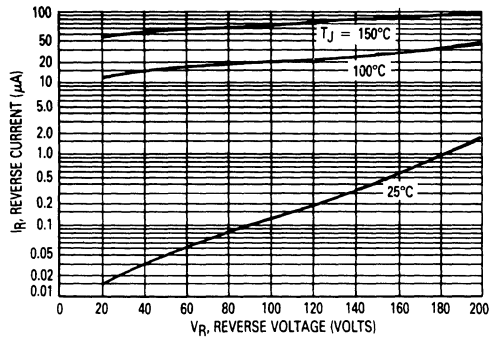


FIGURE 3 — CURRENT DERATING, CASE

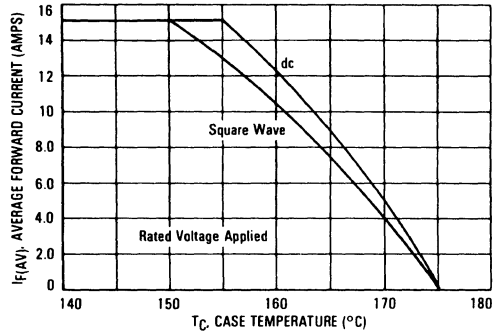


FIGURE 4 — CURRENT DERATING, AMBIENT

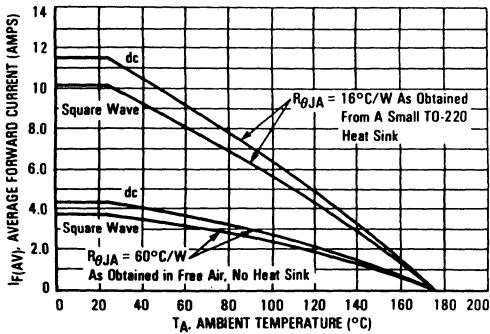


FIGURE 5 — POWER DISSIPATION

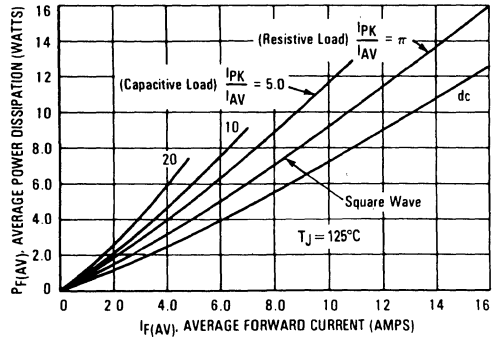


FIGURE 6 — TYPICAL FORWARD VOLTAGE

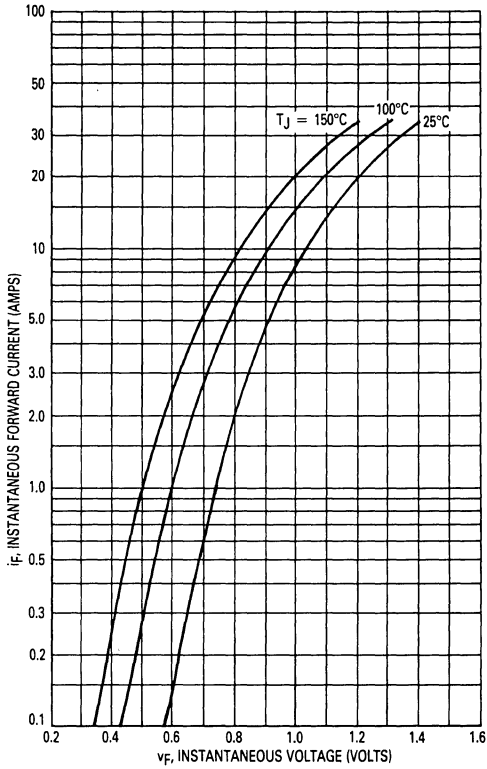


FIGURE 7 — TYPICAL REVERSE CURRENT

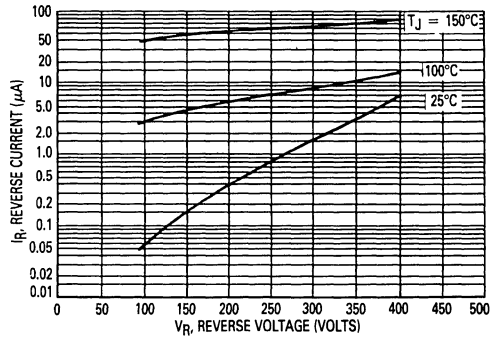


FIGURE 8 — CURRENT DERATING, CASE

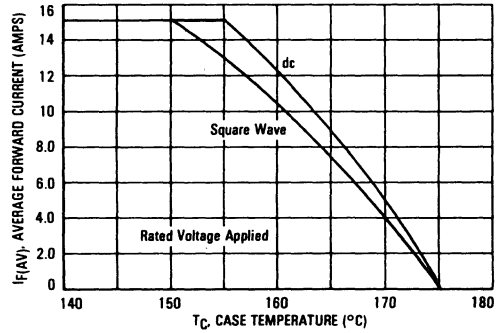


FIGURE 9 — CURRENT DERATING, AMBIENT

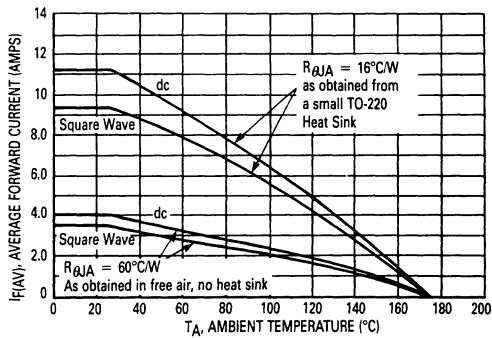


FIGURE 10 — POWER DISSIPATION

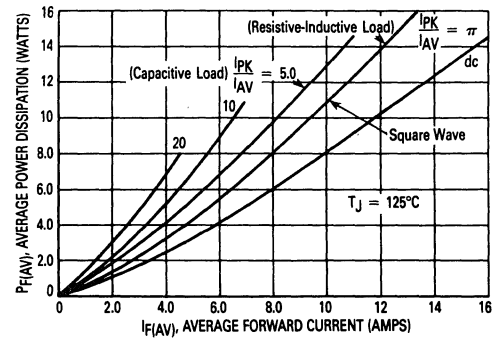


FIGURE 11 — TYPICAL FORWARD VOLTAGE

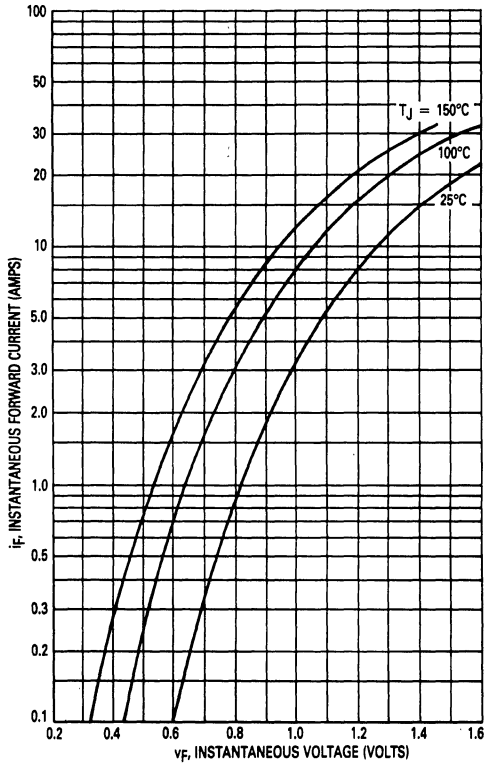


FIGURE 12 — TYPICAL REVERSE CURRENT

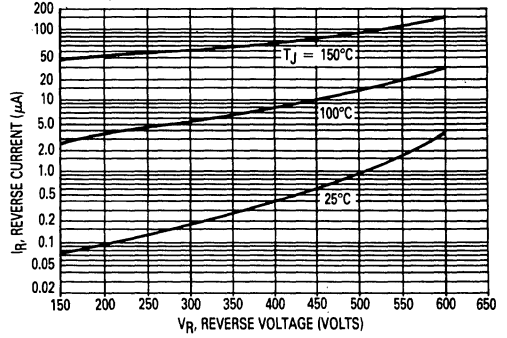


FIGURE 13 — CURRENT DERATING, CASE

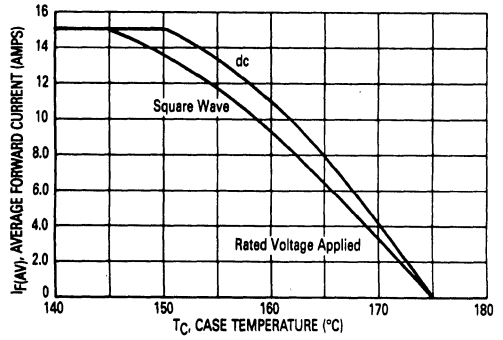


FIGURE 14 — CURRENT DERATING, AMBIENT

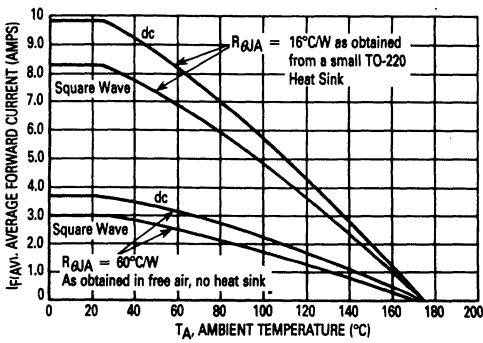


FIGURE 15 — POWER DISSIPATION

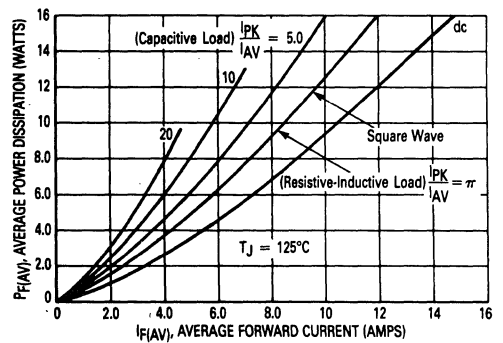


FIGURE 16 — THERMAL RESPONSE

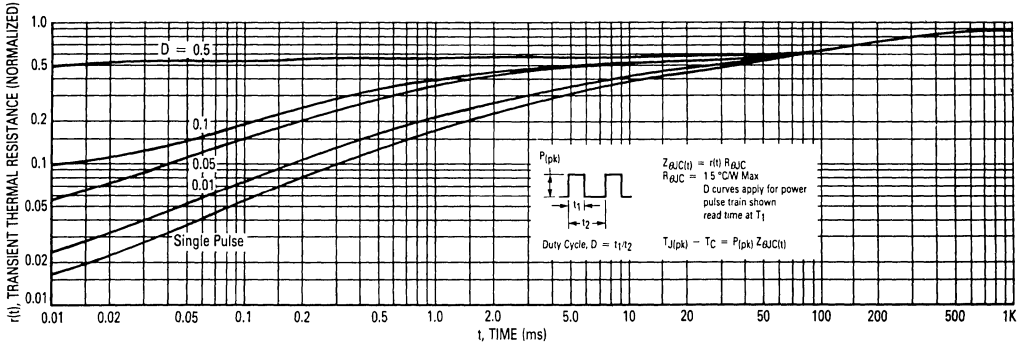
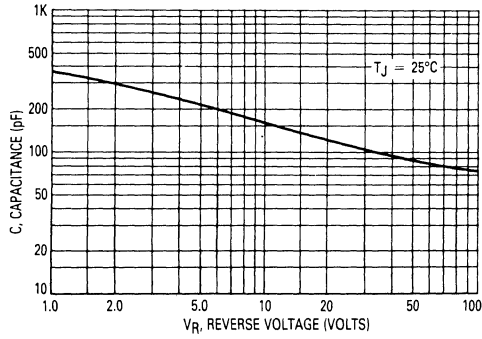


FIGURE 17 — TYPICAL CAPACITANCE



*Advance Information*  
**SWITCHMODE™**  
**Power Rectifiers**

**MURF820**

Motorola Preferred Device

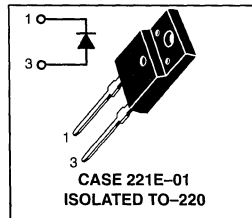
**ULTRAFAST RECTIFIERS**  
**8 AMPERES**  
**200 VOLTS**

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 ns Recovery Times
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U820



4

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> ), T <sub>C</sub> = 150°C	I <sub>F(AV)</sub>	8	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 150°C	I <sub>FM</sub>	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	Amps
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
RMS Isolation Voltage (t = 1 second, R.H. ≤ 30%, T <sub>A</sub> = 25°C)(2)	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub>	4500 3500 1500	Volts

**THERMAL CHARACTERISTICS**

Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	4.2	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 seconds	T <sub>L</sub>	260	°C

(1) UL Recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

This document contains information on a new product. Specifications and information are subject to change without notice.

**Preferred** devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MURF820

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$ ) ( $i_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	0.895 0.975	Volts
Maximum Instantaneous Reverse Current (3) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	250 5.0	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	35 25	ns

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

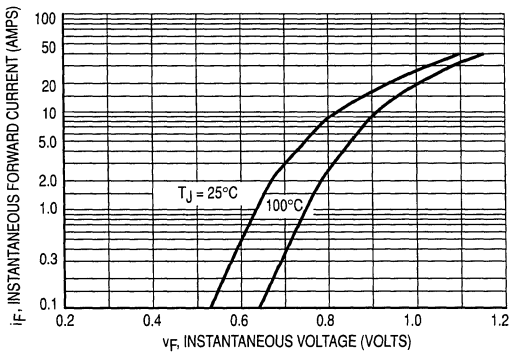


Figure 1. Typical Forward Voltage

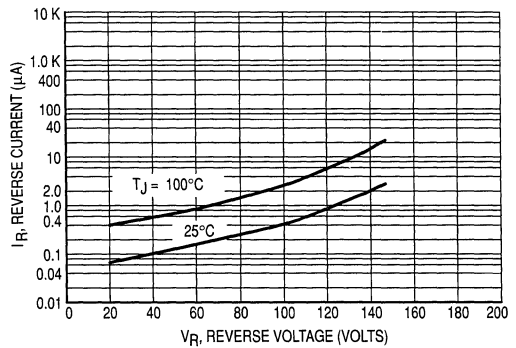
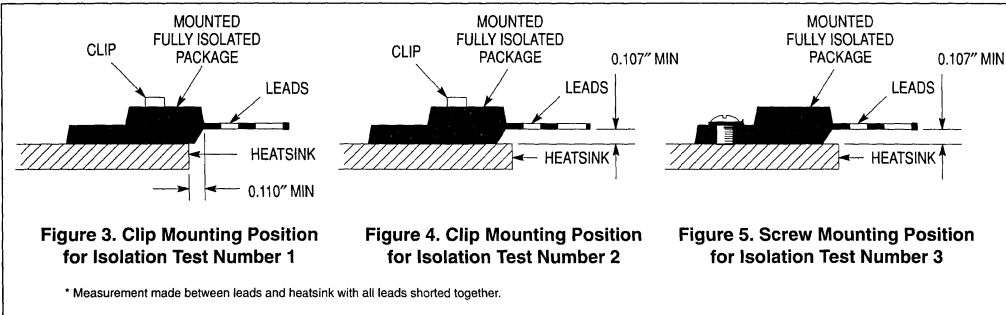


Figure 2. Typical Reverse Leakage Current\*

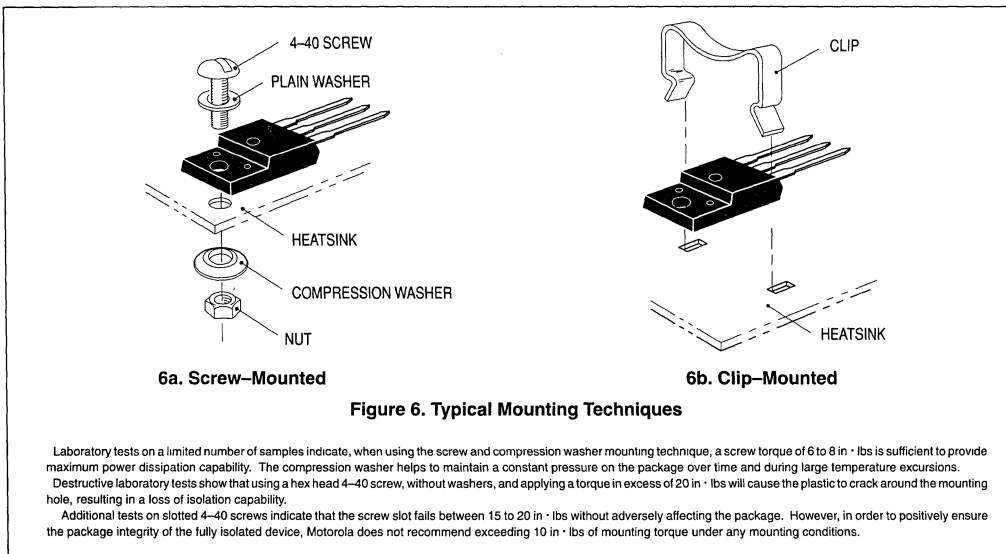


# MURF820

## TEST CONDITIONS FOR ISOLATION TESTS\*



## MOUNTING INFORMATION\*\*



\*\*For more information about mounting power semiconductors see Application Note AN1040.

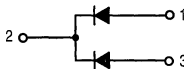
*Advance Information*  
**SWITCHMODE™**  
**Power Rectifiers**

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Times
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

**Mechanical Characteristics**

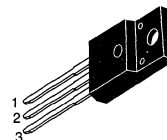
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1620



**MURF1620CT**

Motorola Preferred Device

**ULTRAFAST RECTIFIERS**  
**16 AMPERES**  
**and 200 VOLTS**



**CASE 221D-02**  
**ISOLATED TO-220**

**4**

**MAXIMUM RATINGS, PER LEG**

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	Volts	
Average Rectified Forward Current Total Device, (Rated $V_R$ ), $T_C = 150^\circ\text{C}$	$I_F(AV)$ Total Device	8 16	Amps	
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 150^\circ\text{C}$	$I_{FM}$	16	Amps	
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	100	Amps	
Operating Junction and Storage Temperature	$T_J, T_{stg}$	-65 to +150	°C	
RMS Isolation Voltage ( $t = 1$ second, R.H. $\leq 30\%$ , $T_A = 25^\circ\text{C}$ )(2)	Per Figure 3 Per Figure 4(1) Per Figure 5	$V_{iso1}$ $V_{iso2}$ $V_{iso3}$	4500 3500 1500	Volts

**THERMAL CHARACTERISTICS, PER LEG**

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.2	°C/W
Lead Temperature for Soldering Purposes: 1/8" from the Case for 5 seconds	$T_L$	260	°C

(1) UL Recognized mounting method is per Figure 4.

(2) Proper strike and creepage distance must be provided.

This document contains information on a new product. Specifications and information are subject to change without notice

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MURF1620CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$ ) ( $i_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	0.895 0.975	Volts
Maximum Instantaneous Reverse Current (3) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	250 5.0	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	35 25	ns

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

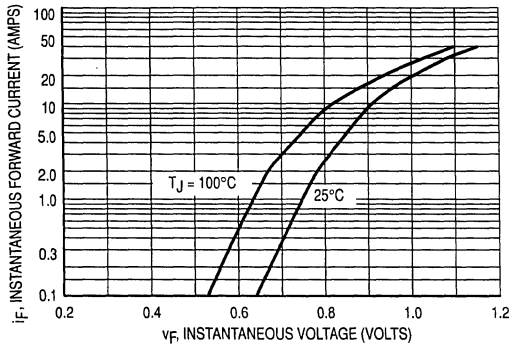


Figure 1. Typical Forward Voltage, Per Leg

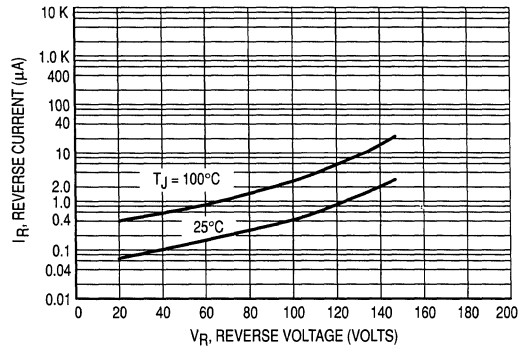
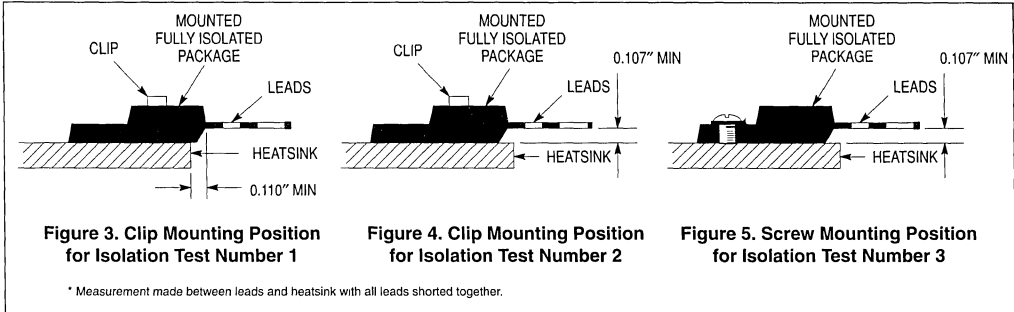


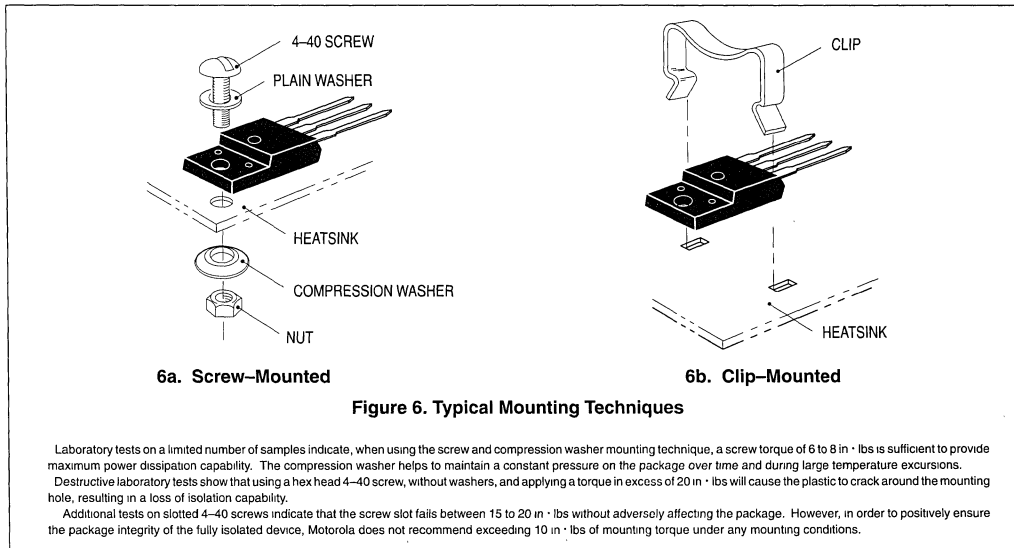
Figure 2. Typical Reverse Current, Per Leg\*

# MURF1620CT

## TEST CONDITIONS FOR ISOLATION TESTS\*



## MOUNTING INFORMATION\*\*



\*\*For more information about mounting power semiconductors see Application Note AN1040.

## Advance Information

# SWITCHMODE™

## Power Rectifiers

**MURF1660CT**

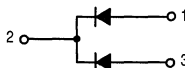
Motorola Preferred Device

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

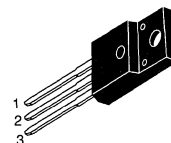
- Ultrafast 60 Nanosecond Recovery Times
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369(1)

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1660



**ULTRAFAST RECTIFIERS**  
**16 AMPERES**  
**600 VOLTS**



**CASE 221D-02**  
**ISOLATED TO-220**

4

### MAXIMUM RATINGS, PER LEG

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	Volts
Average Rectified Forward Current Total Device, (Rated V <sub>R</sub> ), T <sub>C</sub> = 150°C	I <sub>F(AV)</sub> Per Diode Per Device	8 16	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 150°C	I <sub>FM</sub>	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	Amps
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
RMS Isolation Voltage (t = 1 second, R.H. ≤ 30%, T <sub>A</sub> = 25°C)(2)	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub> Per Figure 3 Per Figure 4(1) Per Figure 5	4500 3500 1500	Volts

### THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	3.0	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	T <sub>L</sub>	260	°C

(1) UL Recognized mounting method is per Figure 4.

(2) Proper Strike and creepage distance must be provided.

This document contains information on a new product. Specifications and information herein are subject to change without notice.

**Preferred** devices are Motorola recommended choices for future use and best overall value.

Rev 1

# MURF1660CT

## ELECTRICAL CHARACTERISTICS, PER LEG

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (3) ( $i_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$ ) ( $i_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$ )	$v_F$	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (3) (Rated dc Voltage, $T_C = 150^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	500 10	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ ) ( $I_F = 0.5$ Amp, $i_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp)	$t_{rr}$	60 50	ns

(3) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

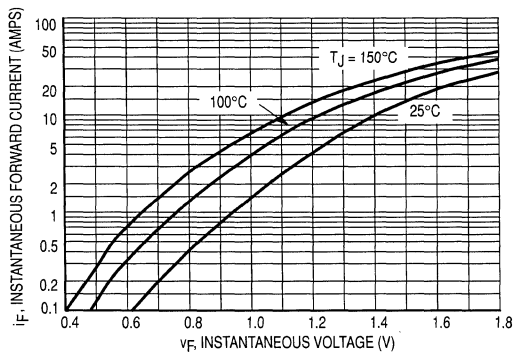


Figure 1. Typical Forward Voltage, Per Leg

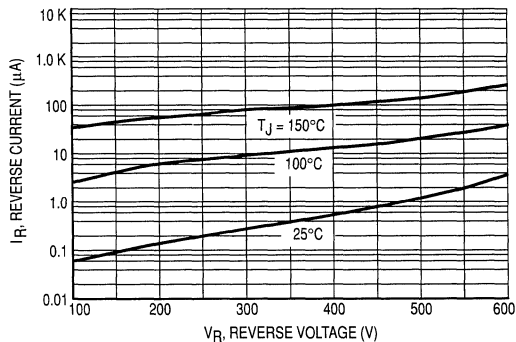
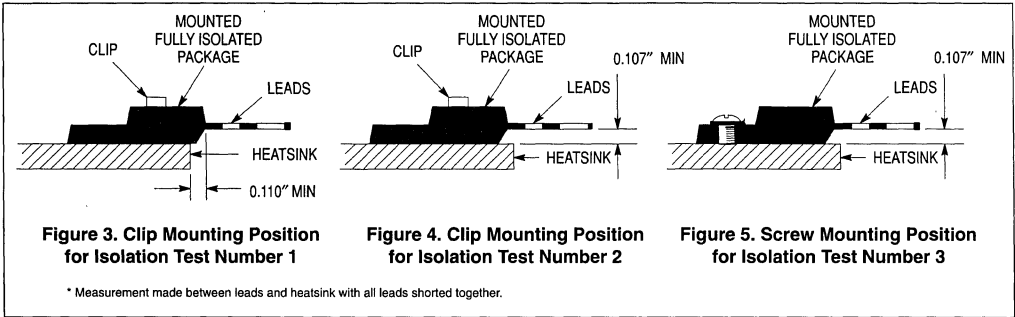


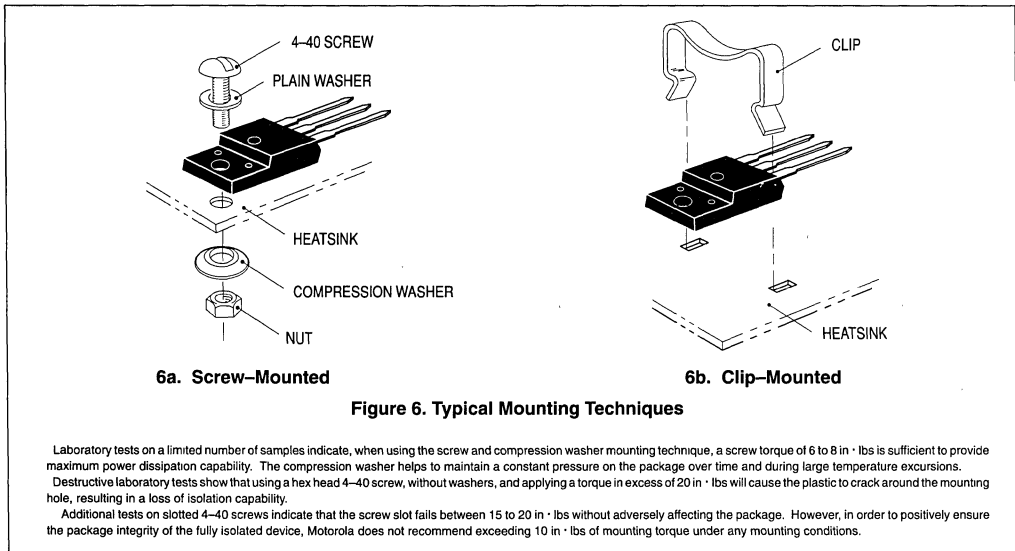
Figure 2. Typical Reverse Current, Per Leg\*

# MURF1660CT

## TEST CONDITIONS FOR ISOLATION TESTS\*



## MOUNTING INFORMATION\*\*



\*\*For more information about mounting power semiconductors see Application Note AN1040.

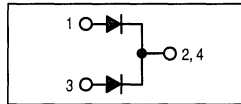
# Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-247 Package
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures
- Epoxy Meets UL94V-0 @ 1/8"
- High Temperature Glass Passivated Junction

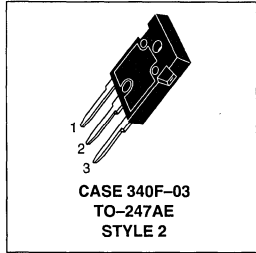
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: U3020, U3040, U3060



**MUR3020WT**  
**MUR3040WT**  
**MUR3060WT**  
Motorola preferred devices

**ULTRAFAST RECTIFIERS**  
**30 AMPERES**  
**200-400-600 VOLTS**



**4**

### MAXIMUM RATINGS, PER LEG

Rating	Symbol	MUR3020WT	MUR3040WT	MUR3060WT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	400	600	Volts
Average Rectified Forward Current @ 145°C Total Device	$I_F(AV)$		15 30		Amps
Peak Repetitive Surge Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 145^\circ C$ )	$I_{FM}$		30		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	$I_{FSM}$	200		150	
Operating Junction and Storage Temperature	$T_J, T_{stg}$		- 65 to +175		°C

### THERMAL CHARACTERISTICS, PER LEG

Maximum Thermal Resistance — Junction to Case — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JA}$		1.5 40		°C/W
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### ELECTRICAL CHARACTERISTICS, PER LEG

Maximum Instantaneous Forward Voltage (1) ( $I_F = 15$ Amp, $T_C = 150^\circ C$ ) ( $I_F = 15$ Amp, $T_C = 25^\circ C$ )	$V_F$	0.85 1.05	1.12 1.25	1.4 1.7	Volts
Maximum Instantaneous Reverse Current (1) (Rated DC Voltage, $T_J = 150^\circ C$ ) (Rated DC Voltage, $T_J = 25^\circ C$ )	$i_R$		500 10	1000 10	$\mu A$
Maximum Reverse Recovery Time ( $i_F = 1.0$ A, $di/dt = 50$ Amps/ $\mu s$ )	$t_{rr}$	35		60	ns

(1) Pulse Test: Pulse Width = 300  $\mu s$ , Duty Cycle  $\leq 2.0\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.



# MUR3020WT, MUR3040WT, MUR3060WT

## MUR3020WT

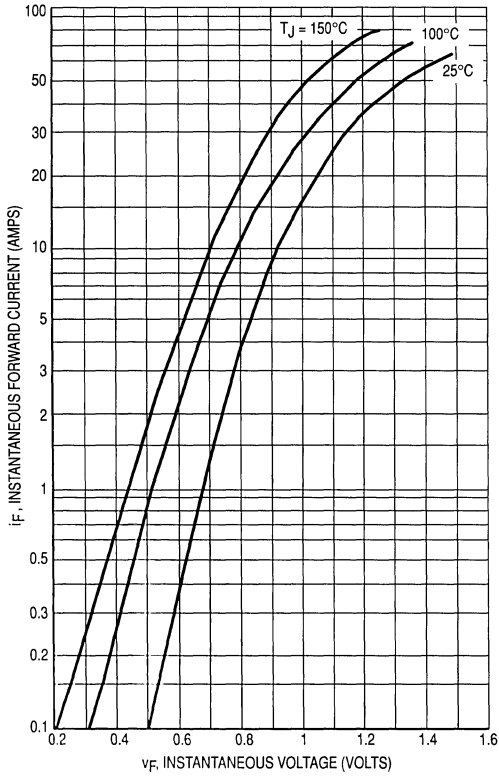


Figure 1. Typical Forward Voltage (Per Leg)

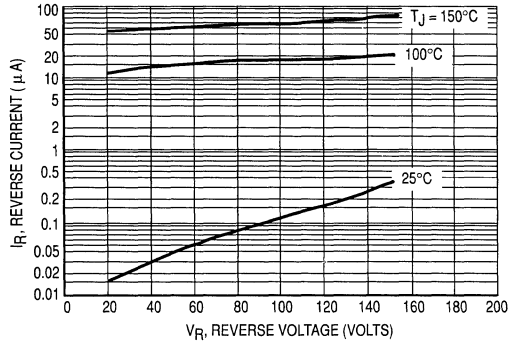


Figure 2. Typical Reverse Current (Per Leg)

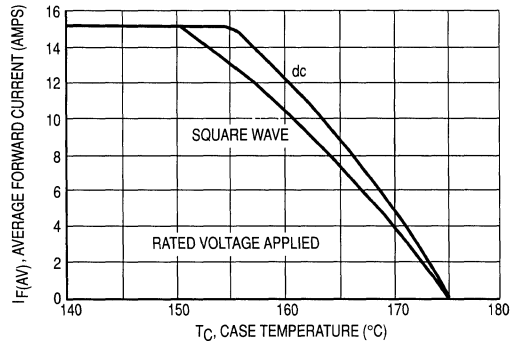


Figure 3. Current Derating, Case (Per Leg)

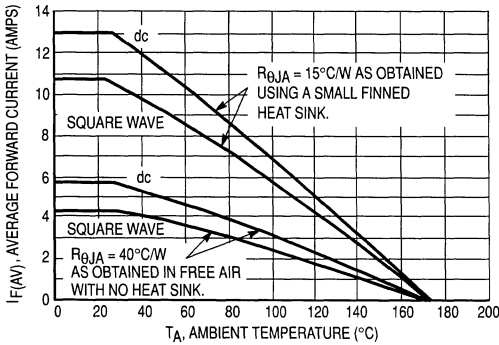


Figure 4. Current Derating, Ambient (Per Leg)

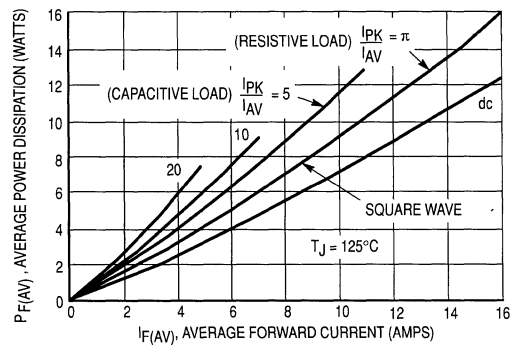


Figure 5. Power Dissipation (Per Leg)

# MUR3020WT, MUR3040WT, MUR3060WT

## MUR3040WT

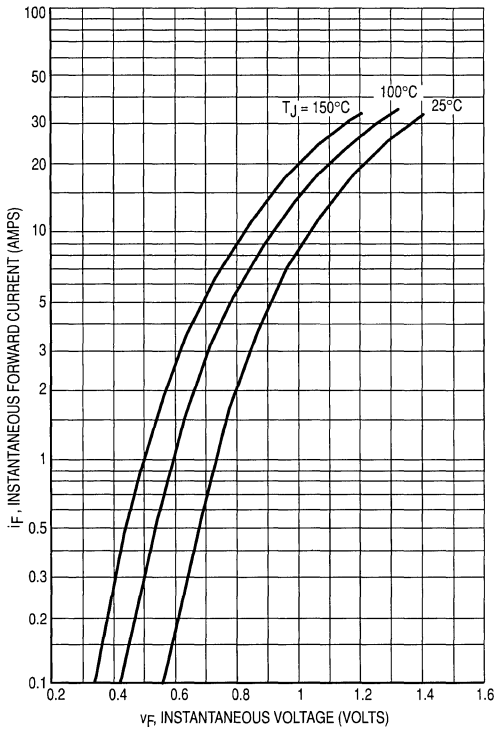


Figure 6. Typical Forward Voltage (Per Leg)

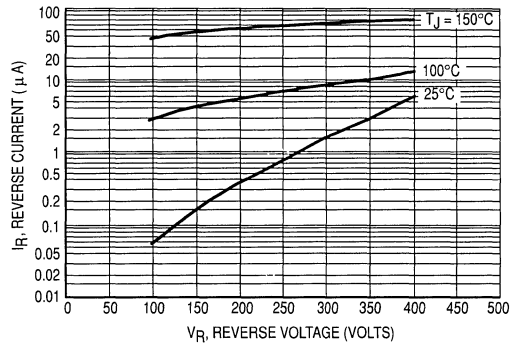


Figure 7. Typical Reverse Current (Per Leg)

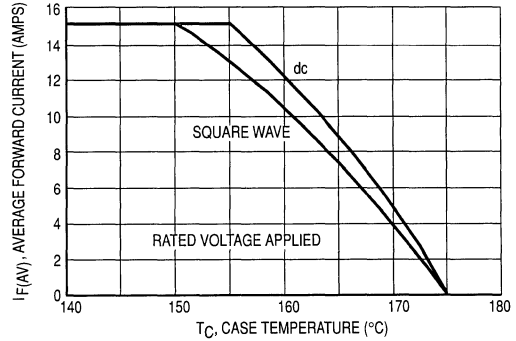


Figure 8. Current Derating, Case (Per Leg)

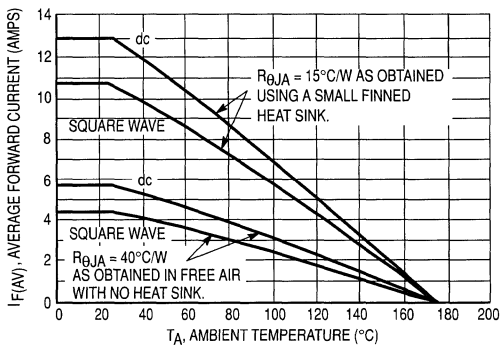


Figure 9. Current Derating, Ambient (Per Leg)

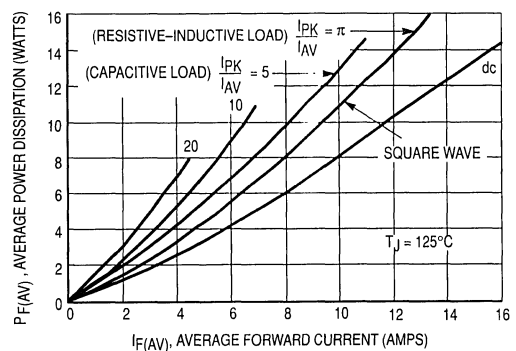


Figure 10. Power Dissipation (Per Leg)

4

# MUR3020WT, MUR3040WT, MUR3060WT

## MUR3060WT

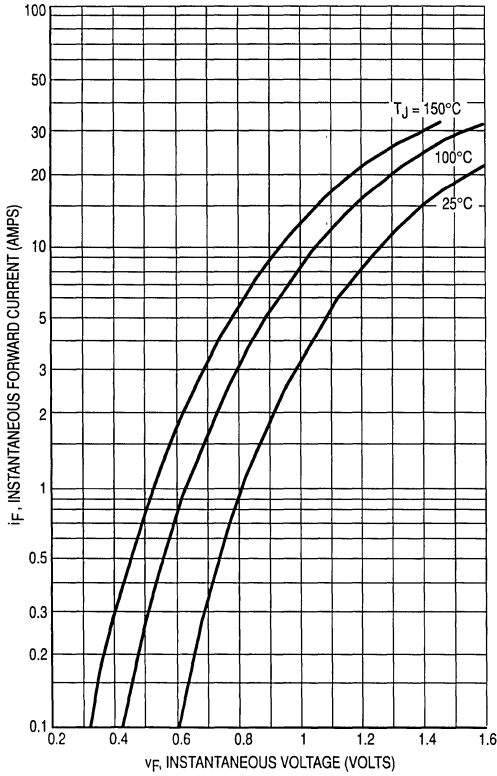


Figure 11. Typical Forward Voltage (Per Leg)

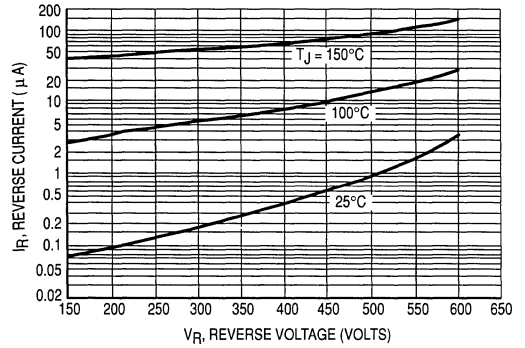


Figure 12. Typical Reverse Current (Per Leg)

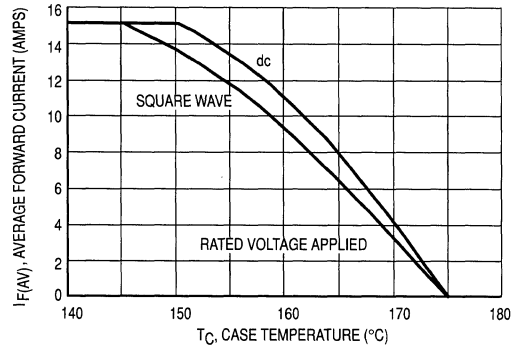


Figure 13. Current Derating, Case (Per Leg)

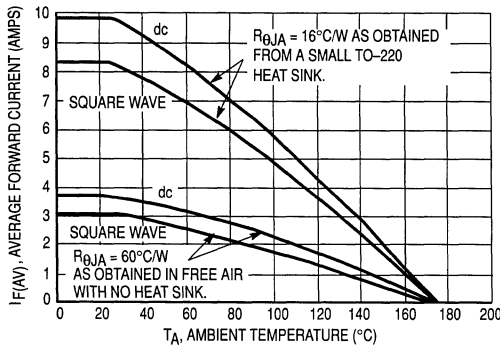


Figure 14. Current Derating, Ambient (Per Leg)

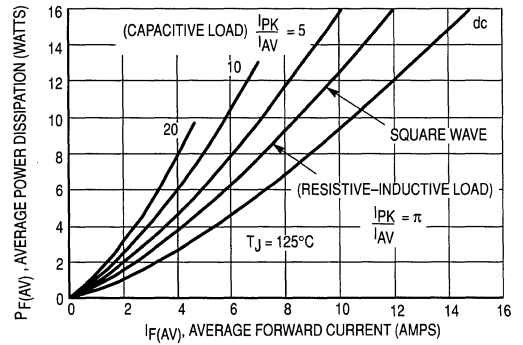


Figure 15. Power Dissipation (Per Leg)

# MUR3020WT, MUR3040WT, MUR3060WT

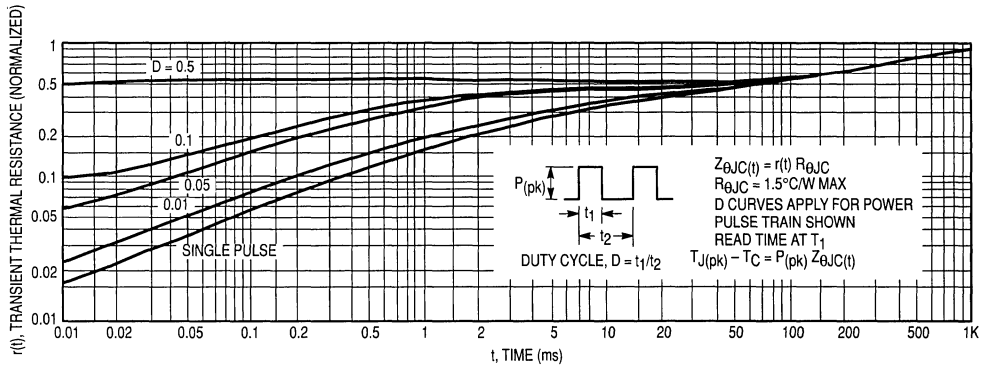


Figure 16. Thermal Response

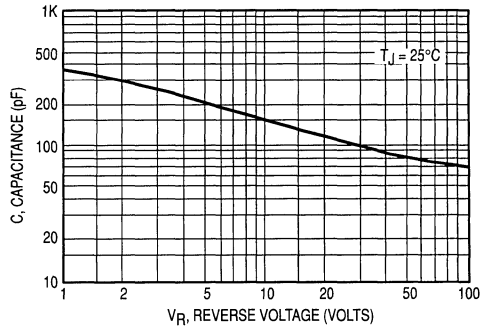


Figure 17. Typical Capacitance (Per Leg)

## Switchmode Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction

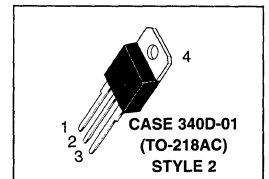
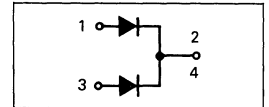
### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: U3020, U3040, U3060

**MUR3020PT**  
**MUR3040PT**  
**MUR3060PT**

MUR3020PT and MUR3060PT  
are Motorola Preferred Devices

**ULTRAFAST RECTIFIERS**  
**30 AMPERES**  
**200–400–600 VOLTS**



### MAXIMUM RATINGS

Rating	Symbol	MUR			Unit
		3020PT	3040PT	3060PT	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	400	600	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> ) Per Leg Per Device	I <sub>F(AV)</sub>	15 30	T <sub>C</sub> = 150°C	15 30	T <sub>C</sub> = 145°C Amps
Peak Rectified Forward Current, Per Leg (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 150°C	I <sub>FRM</sub>	30	@ T <sub>C</sub> = 150°C	30	@ T <sub>C</sub> = 145°C Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz) Per Leg	I <sub>FSM</sub>	200	150		Amps
Operating Junction Temperature and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175			°C

### THERMAL CHARACTERISTICS PER DIODE LEG

Maximum Thermal Resistance, Junction to Case Junction to Ambient	R <sub>θJC</sub> R <sub>θJA</sub>	1.5 40	°C/W
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### ELECTRICAL CHARACTERISTICS PER DIODE LEG

Maximum Instantaneous Forward Voltage (1) (I <sub>F</sub> = 15 Amps, T <sub>C</sub> = 150°C) (I <sub>F</sub> = 15 Amps, T <sub>C</sub> = 25°C)	V <sub>F</sub>	0.85 1.05	1.12 1.25	1.2 1.5	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, T <sub>C</sub> = 150°C) (Rated dc Voltage, T <sub>C</sub> = 25°C)	i <sub>R</sub>	500 10	1000 10		μA
Maximum Reverse Recovery Time (I <sub>F</sub> = 1 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>	35	60		ns

(1) Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2%

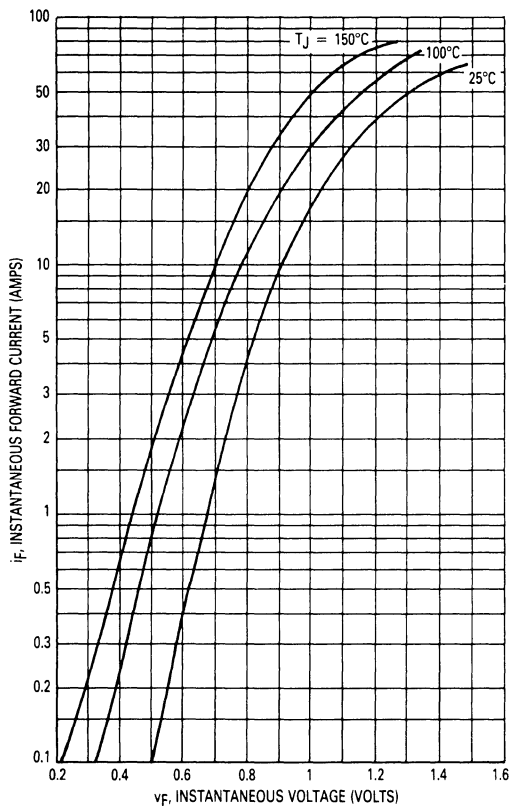


Figure 1. Typical Forward Voltage (Per Leg)

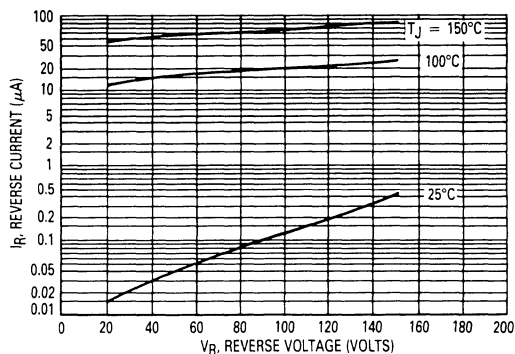


Figure 2. Typical Reverse Current (Per Leg)

4

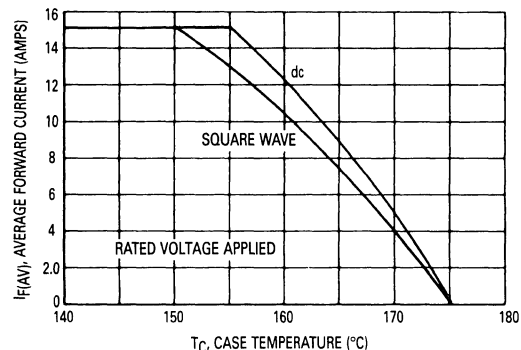


Figure 3. Current Derating, Case (Per Leg)

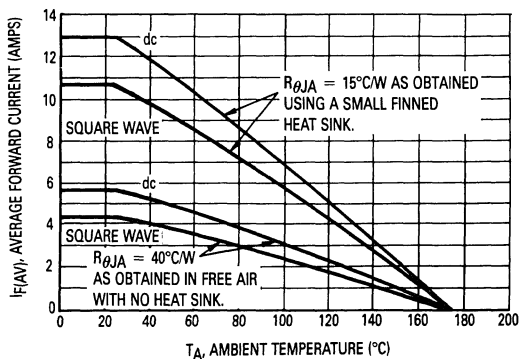


Figure 4. Current Derating, Ambient (Per Leg)

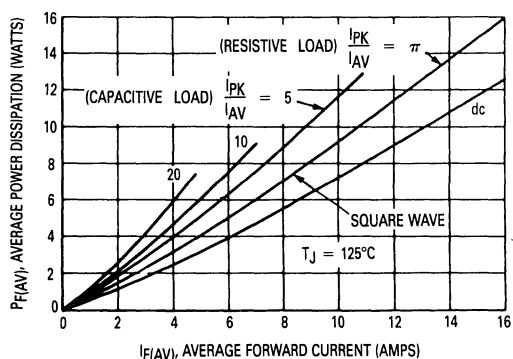


Figure 5. Power Dissipation (Per Leg)

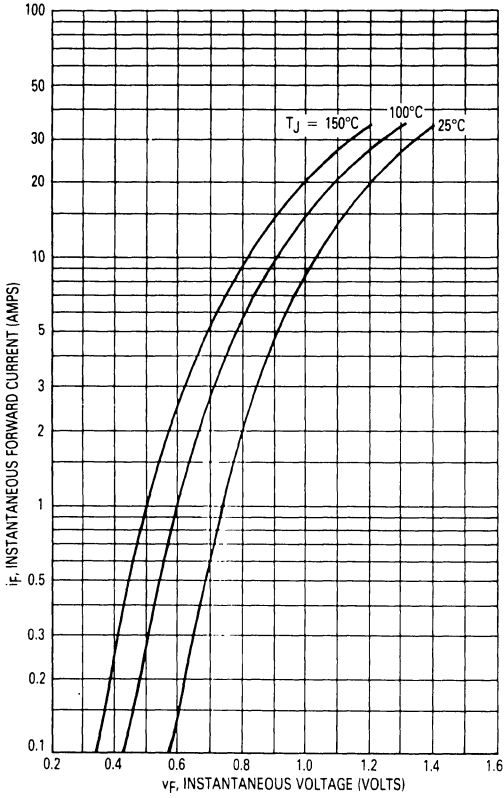


Figure 6. Typical Forward Voltage (Per Leg)

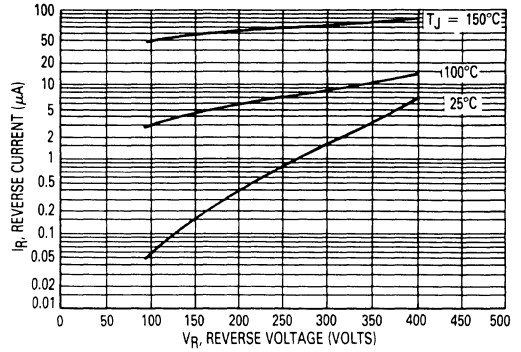


Figure 7. Typical Reverse Current (Per Leg)

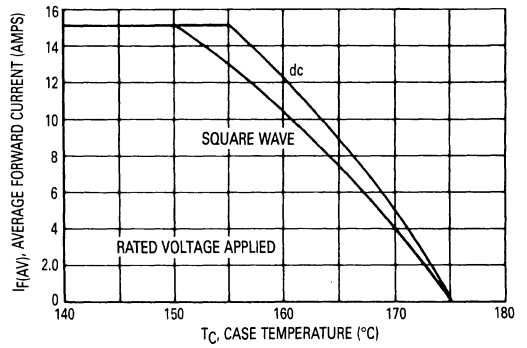


Figure 8. Current Derating, Case (Per Leg)

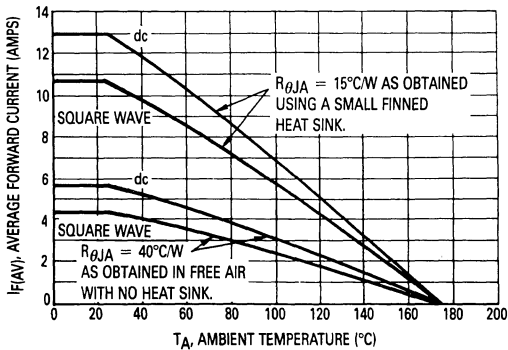


Figure 9. Current Derating, Ambient (Per Leg)

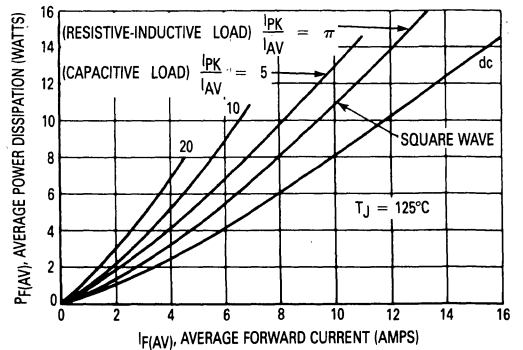


Figure 10. Power Dissipation (Per Leg)

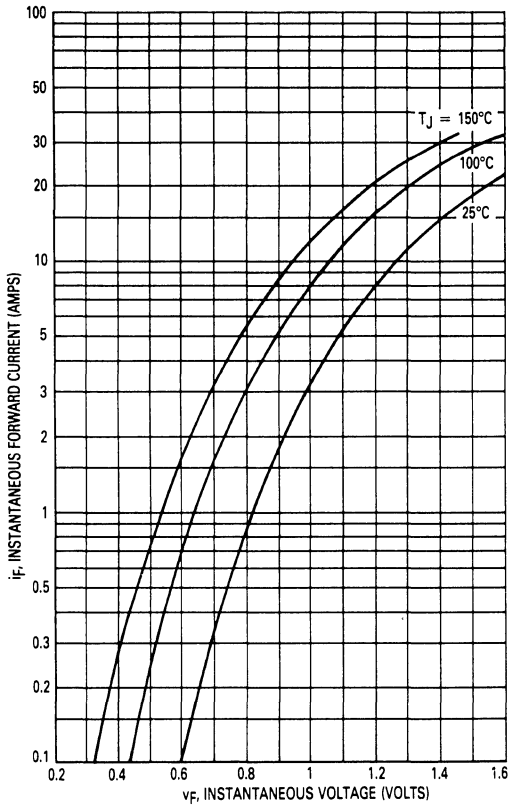


Figure 11. Typical Forward Voltage

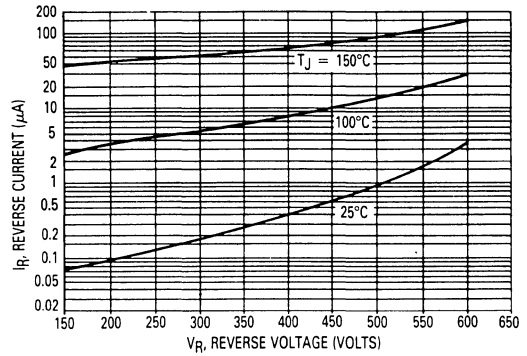


Figure 12. Typical Reverse Current

4

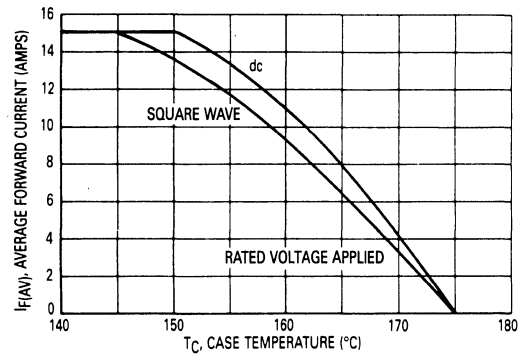


Figure 13. Current Derating, Case

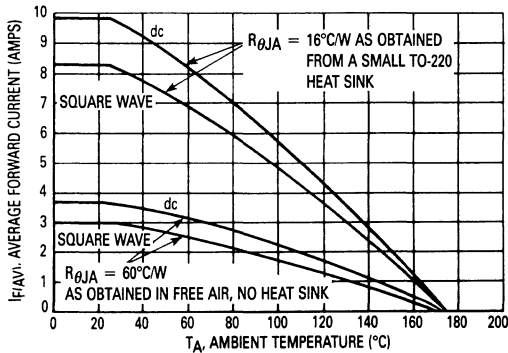


Figure 14. Current Derating, Ambient

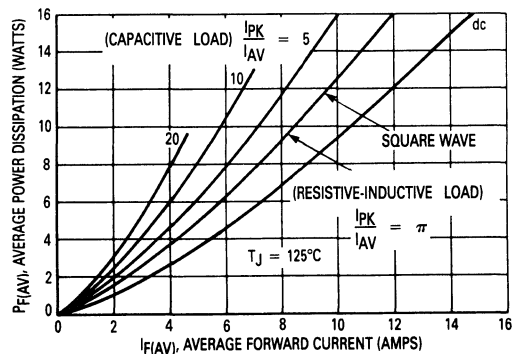


Figure 15. Power Dissipation



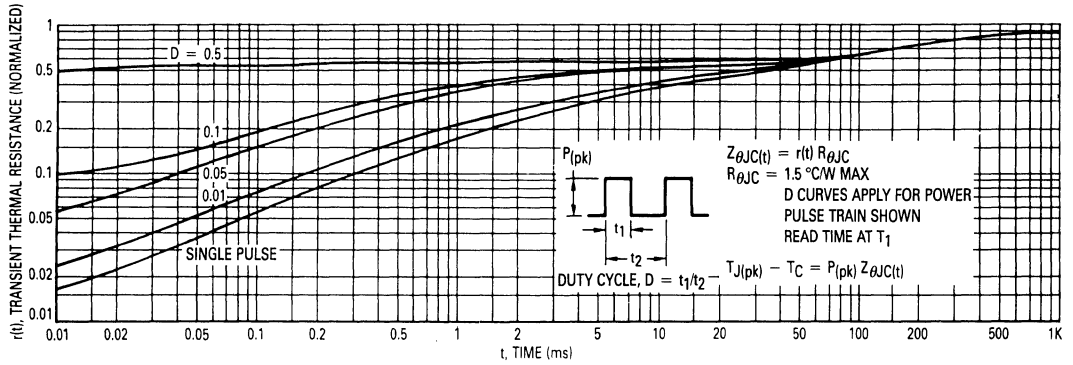


Figure 16. Thermal Response

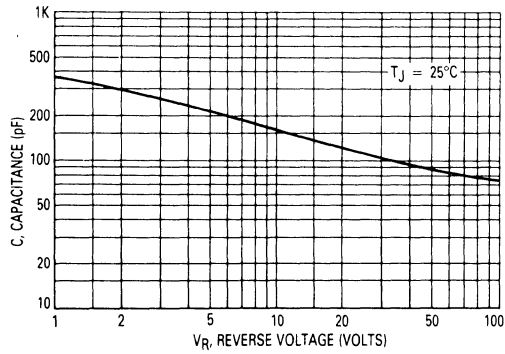


Figure 17. Typical Capacitance (Per Leg)

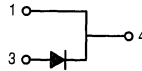
## SWITCHMODE Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 100 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 400 Volts
- Low Forward Voltage Drop
- High Temperature Glass Passivated Junction

### Mechanical Characteristics:

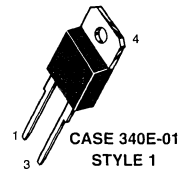
- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: U3040



**MUR3040**

Motorola Preferred Device

**ULTRAFAST RECTIFIERS**  
**30 AMPERES**  
**400 VOLTS**



4

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	400	Volts
Average Rectified Forward Current $T_C = 70^\circ\text{C}$	$I_{F(AV)}$	30	Amps
Peak Repetitive Forward Current (Rated $V_R$ Square Wave 20 kHz) $T_C = 150^\circ\text{C}$	$I_{FRM}$	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	300	Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C/W}$
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### ELECTRICAL CHARACTERISTICS

Instantaneous Forward Voltage ( $I_F = 30$ Amp, $T_C = 100^\circ\text{C}$ ) ( $I_F = 30$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	1.4 1.5	Volts
Instantaneous Reverse Current (Rated dc Voltage, $T_C = 100^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	6.0 35	mA $\mu\text{A}$
Reverse Recovery Time ( $I_F = 1.0$ Amp $di/dt = 15$ Amp/ $\mu\text{s}$ )	$t_{rr}$	100	ns

Rev 2

# MUR3040

## TYPICAL ELECTRICAL CHARACTERISTICS

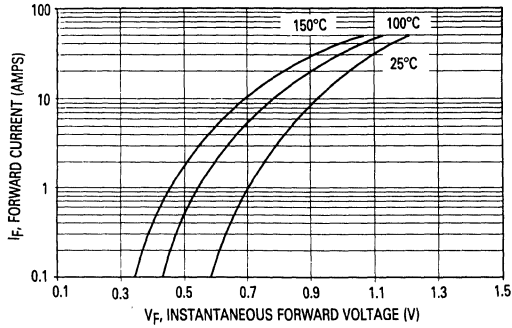


Figure 1. Typical Forward Voltage

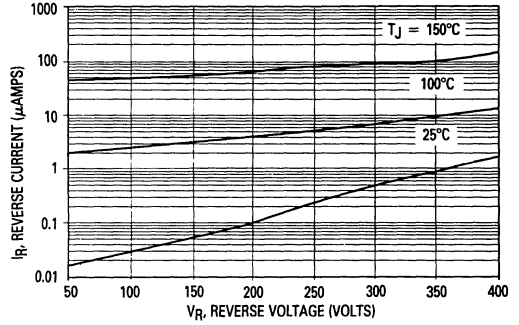


Figure 2. Typical Reverse Current

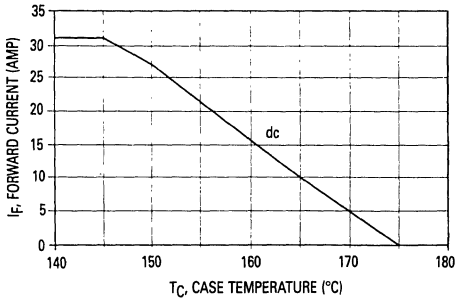


Figure 3. Current Derating, Case

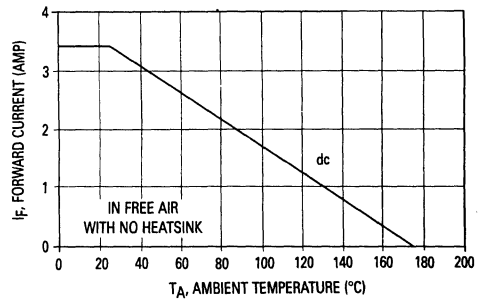


Figure 4. Current Derating, Ambient

*Advance Information*  
**SWITCHMODE™ Power Rectifier**

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 75 ns (Typ) Soft Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 800 Volts
- Low Forward Voltage Drop
- High Temperature Glass Passivated Junction

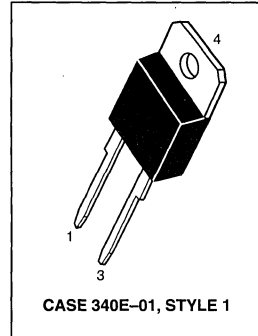
**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: U3080

**MUR3080**

Motorola Preferred Device

**ULTRAFAST RECTIFIERS**  
**30 AMPERES**  
**600-800 VOLTS**



**MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	800	Volts
Average Rectified Forward Current (Rated $V_R$ , $T_C = 70^\circ\text{C}$ )	$I_{F(AV)}$	30	Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 150^\circ\text{C}$	$I_{FRM}$	30	Amps
Non Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	300	Amps
Operating Junction Temperature	$T_J$	-65 to +175	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.0	$^\circ\text{C/W}$
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**ELECTRICAL CHARACTERISTICS (TYPICAL DATA)**

Instantaneous Forward Voltage (1) @ $I_F = 30$ Amps, $T_C = 25^\circ\text{C}$ @ $I_F = 30$ Amps, $T_C = 100^\circ\text{C}$	$V_F$	1.9 1.8	Volts
Instantaneous Reverse Current (1) @ Rated DC Voltage, $T_C = 25^\circ\text{C}$ @ Rated DC Voltage, $T_C = 100^\circ\text{C}$	$I_R$	100 5.0	$\mu\text{A}$ mA
Reverse Recovery Time $I_F = 1.0$ Amp, $V_R = 30$ V, $dI/dt = 50$ A/ $\mu\text{s}$	$t_{RR}$	110	ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 1

4

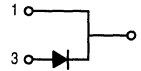
# SWITCHMODE Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 100 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 400 Volts
- Low Forward Voltage Drop
- High Temperature Glass Passivated Junction

**Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: U6040



**MUR6040**

Motorola Preferred Device

**ULTRAFAST RECTIFIERS**  
**60 AMPERES**  
**400 VOLTS**



4

**MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	400	Volts
Average Rectified Forward Current $T_C = 70^\circ\text{C}$	$I_F(AV)$	60	Amps
Peak Repetitive Forward Current (Rated $V_R$ Square Wave 20 kHz) $T_C = 150^\circ\text{C}$	$I_{FRM}$	60	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	600	Amps
Operating Junction Temperature and Storage Temperature	$T_J, T_{stg}$	-65 to +175	$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.8	$^\circ\text{C/W}$
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**ELECTRICAL CHARACTERISTICS**

Instantaneous Forward Voltage ( $I_F = 60$ Amp, $T_C = 100^\circ\text{C}$ ) ( $I_F = 60$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	1.4 1.5	Volts
Instantaneous Reverse Current (Rated dc Voltage, $T_C = 100^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$I_R$	10 60	mA $\mu\text{A}$
Reverse Recovery Time ( $I_F = 1.0$ Amp $di/dt = 15$ Amp/ $\mu\text{s}$ )	$t_{rr}$	100	ns

Rev 2

# MUR6040

## TYPICAL ELECTRICAL CHARACTERISTICS

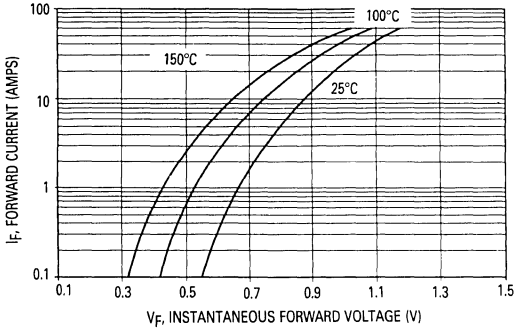


Figure 1. Typical Forward Voltage

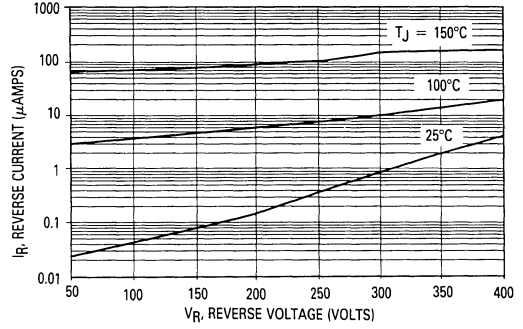


Figure 2. Typical Reverse Current

4

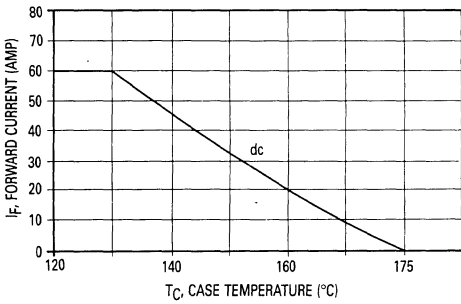


Figure 3. Current Derating, Case

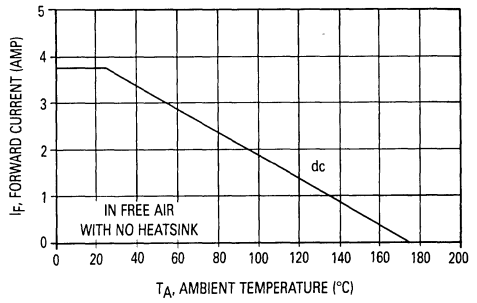



Figure 4. Current Derating, Ambient

## Ultrafast Power Rectifiers

Dual high voltage rectifiers ranging from 200 V to 400 V suited for Switch Mode Power Supplies and other power converters.

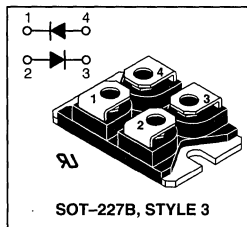
- Very Low Reverse Recovery Time
- Very Low Switching Losses
- Low Noise Turn-Off Switching
- Insulated Package:
  - Insulating voltage = 2500 V<sub>RMS</sub>
  - Capacitance = 45 pF
-  — UL Recognized, File #E69369

### Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: BYT230PIV-400M

**BYT230PIV-400M**

**ULTRAFAST  
RECTIFIERS  
60 AMPS  
400 VOLTS**



4

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	400	V
Average Rectified Current $T_C = 75^\circ\text{C}$	$I_{F(AV)}$ Per Device Per Diode	60 30	A
Peak Repetitive Forward Current, Per Diode $t_p < 10 \mu\text{s}$	$I_{FRM}$	500	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	350	A
Operating Junction Temperature	$T_J$	-40 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	Per Diode	$R_{\theta JC}$	1.5	$^\circ\text{C/W}$
	Per Device	$R_{\theta JC}$	0.8	
Coupling		$R_{\theta C}$	0.1	

### ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) $I_F = 30 \text{ A}, T_C = 25^\circ\text{C}$ $I_F = 30 \text{ A}, T_C = 100^\circ\text{C}$	$V_F$	1.5 1.4	V
Instantaneous Reverse Current (2) $V_R = 400 \text{ V}, T_C = 25^\circ\text{C}$ $V_R = 400 \text{ V}, T_C = 100^\circ\text{C}$	$I_R$	35 6	$\mu\text{A}$ mA

(1) Pulse Test: Pulse Width = 380  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$

(2) Pulse Test: Pulse Width = 5 ms, Duty Cycle  $< 2\%$

Rev 1

## BYT230PIV-400M

### RECOVERY CHARACTERISTICS

Test Conditions	Symbol	Typ	Max	Unit
$I_F = 1 \text{ A}$ , $V_R = 30 \text{ V}$ , $di_F/dt = -15 \text{ A}/\mu\text{s}$	$t_{rr}$	—	100	ns
$I_F = 0.5 \text{ A}$ , $I_R = 1 \text{ A}$ , $I_{rr} = 0.25 \text{ A}$		—	50	

### TURN-OFF SWITCHING CHARACTERISTICS (without series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$V_{CC} = 200 \text{ V}$ , $I_F = 30 \text{ A}$ , $T_J = 100^\circ\text{C}$ , $L_p < 0.05 \mu\text{H}$ (See Figure 11)	$t_{IRM}$	—	75	ns
$di_F/dt = -120 \text{ A}/\mu\text{s}$ $di_F/dt = -240 \text{ A}/\mu\text{s}$		50	—	
$di_F/dt = -120 \text{ A}/\mu\text{s}$ $di_F/dt = -240 \text{ A}/\mu\text{s}$	$I_{RM}$	—	9	A
		12	—	

### TURN-OFF OVERVOLTAGE COEFFICIENT (with series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$T_J = 100^\circ\text{C}$ , $V_{CC} = 60 \text{ V}$ , $I_F = I_{F(AV)}$ $di_F/dt = -30 \text{ A}/\mu\text{s}$ , $L_p = 1 \mu\text{H}$ (See Figure 12)	$C = \frac{V_{RP}}{V_{CC}}$	3.3	—	



# BYT230PIV-400M

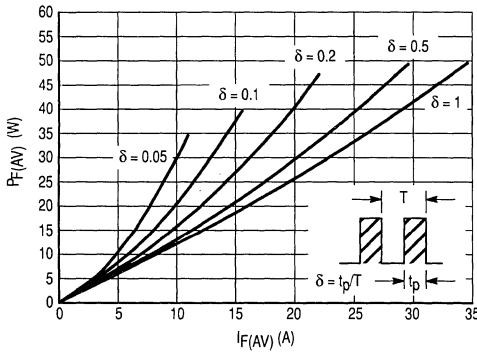


Figure 1. Low Frequency Power Losses versus Average Current

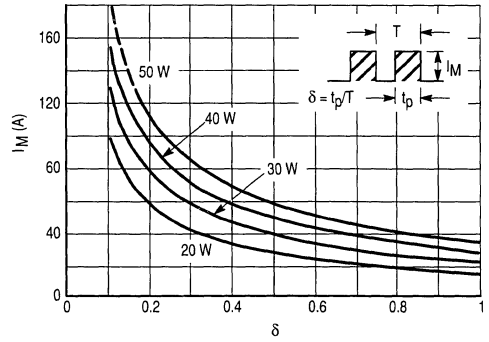


Figure 2. Peak Current versus Form Factor

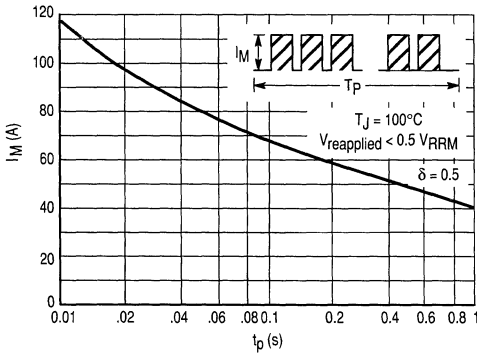


Figure 3. Non-Repetitive Peak Surge Current versus Overload Duration

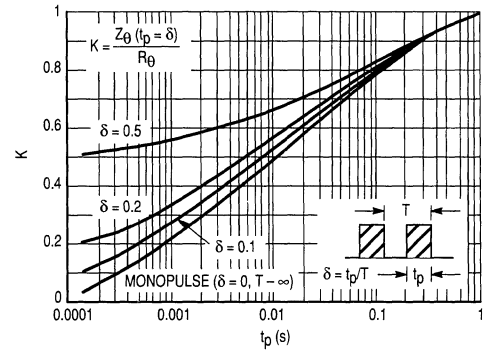


Figure 4. Relative Variation of Thermal Impedance Junction to Case versus Pulse Duration

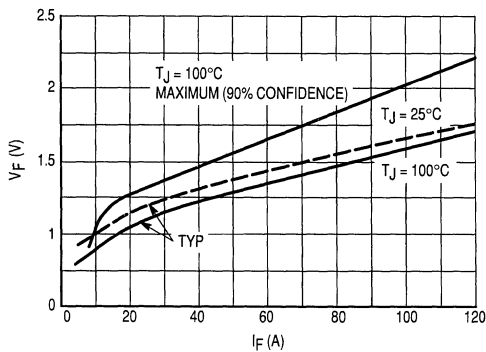


Figure 5. Voltage Drop versus Forward Current

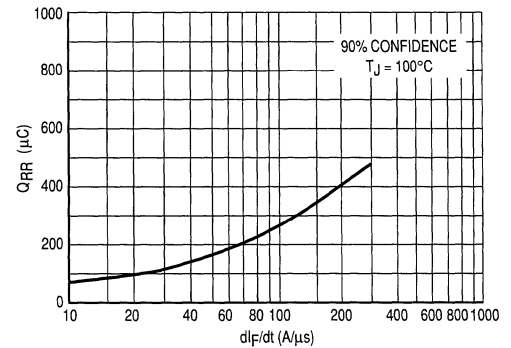


Figure 6. Recovery Charge versus  $di_F/dt$

# BYT230PIV-400M

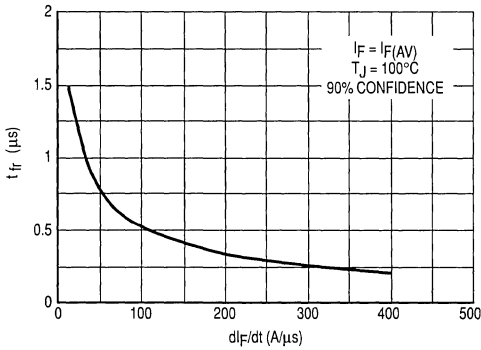


Figure 7. Recovery Time versus  $di_F/dt$

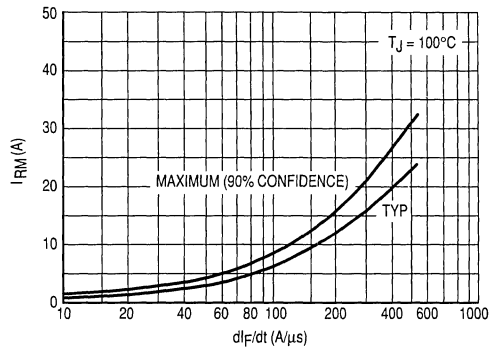


Figure 8. Peak Reverse Current versus  $di_F/dt$

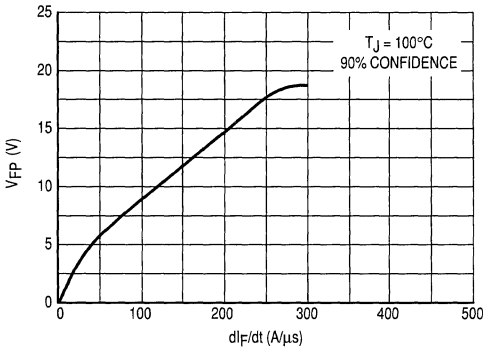


Figure 9. Peak Forward Voltage versus  $di_F/dt$

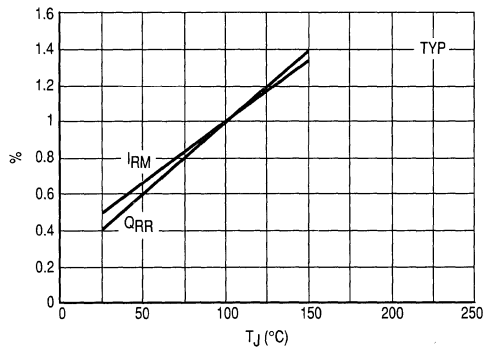


Figure 10. Dynamic Parameters versus Junction Temperature

4

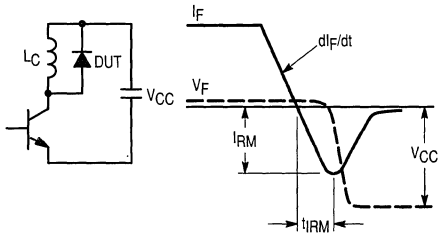


Figure 11. Turn-Off Switching Characteristics (Without series inductance)

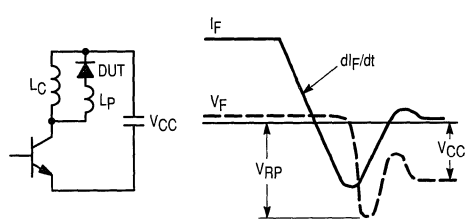



Figure 12. Turn-Off Switching Characteristics (With series inductance)

## Ultrafast Power Rectifiers

Dual high voltage rectifiers suited for Switchmode Power Supplies and other power converters.

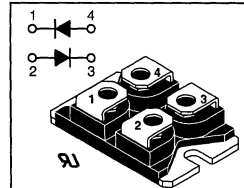
- Very Low Reverse Recovery Time
- Very Low Switching Losses
- Low Noise Turn-Off Switching
- Insulated Package:  
Insulating voltage = 2500 VRMS  
Capacitance = 45 pF
-  — UL Recognized, File #E69369

### Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: BYT230PIV-1000M

**BYT230PIV-1000M**

**ULTRAFAST  
RECTIFIERS  
60 AMPS  
1000 VOLTS**



**SOT-227B, STYLE 3**

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	1000	V
Average Rectified Current $T_C = 55^\circ\text{C}$	$I_F(\text{AV})$ Per Device Per Diode	60 30	A
Peak Repetitive Forward Current, Per Diode $t_p < 10 \mu\text{s}$	$I_{FRM}$	375	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	200	A
Operating Junction Temperature	$T_J$	-40 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case	Per Diode Per Device	$R_{\theta JC}$ $R_{\theta JC}$ $R_{\theta C}$	1.5 0.8 0.1	$^\circ\text{C/W}$
Coupling				

### ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) $I_F = 30 \text{ A}, T_C = 25^\circ\text{C}$ $I_F = 30 \text{ A}, T_C = 100^\circ\text{C}$	$V_F$	1.9 1.8	V
Instantaneous Reverse Current (2) $V_R = 1000 \text{ V}, T_C = 25^\circ\text{C}$ $V_R = 1000 \text{ V}, T_C = 100^\circ\text{C}$	$I_R$	100 5	$\mu\text{A}$ mA

(1) Pulse Test: Pulse Width = 380  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$

(2) Pulse Test: Pulse Width = 5 ms, Duty Cycle < 2%

# BYT230PIV-1000M

## RECOVERY CHARACTERISTICS

Test Conditions	Symbol	Typ	Max	Unit
$I_F = 1\text{ A}$ , $V_R = 30\text{ V}$ , $dI_F/dt = -15\text{ A}/\mu\text{s}$	$t_{rr}$	—	165	ns
$I_F = 0.5\text{ A}$ , $I_R = 1\text{ A}$ , $I_{rr} = 0.25\text{ A}$		—	70	

## TURN-OFF SWITCHING CHARACTERISTICS (without series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$V_{CC} = 200\text{ V}$ , $I_F = 30\text{ A}$ , $T_J = 100^\circ\text{C}$ , $L_p < 0.05\ \mu\text{H}$ (See Figure 11)	$t_{IRM}$	—	200	ns
$dI_F/dt = -120\text{ A}/\mu\text{s}$ $dI_F/dt = -240\text{ A}/\mu\text{s}$		120	—	
$dI_F/dt = -120\text{ A}/\mu\text{s}$ $dI_F/dt = -240\text{ A}/\mu\text{s}$	$I_{RM}$	—	19.5	A
		22	—	

## TURN-OFF OVERVOLTAGE COEFFICIENT (with series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$T_J = 100^\circ\text{C}$ , $V_{CC} = 200\text{ V}$ , $I_F = I_{F(AV)}$ $dI_F/dt = -30\text{ A}/\mu\text{s}$ , $L_p = 5\ \mu\text{H}$ (See Figure 12)	$C = \frac{V_{RP}}{V_{CC}}$	—	4.5	

# BYT230PIV-1000M

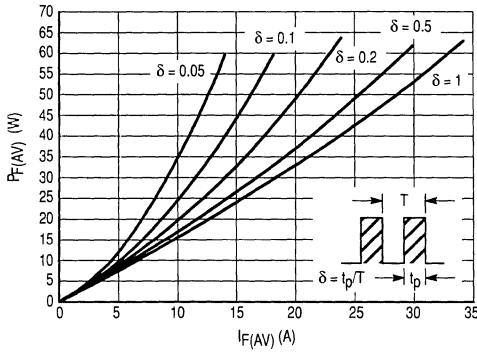


Figure 1. Low Frequency Power Losses versus Average Current

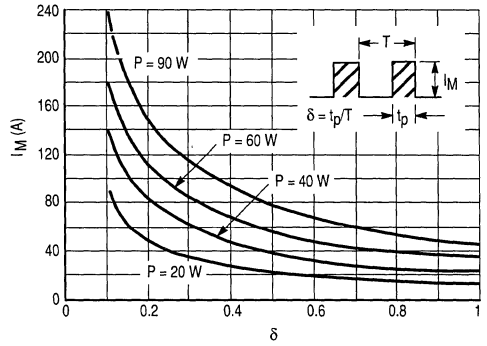


Figure 2. Peak Current versus Form Factor

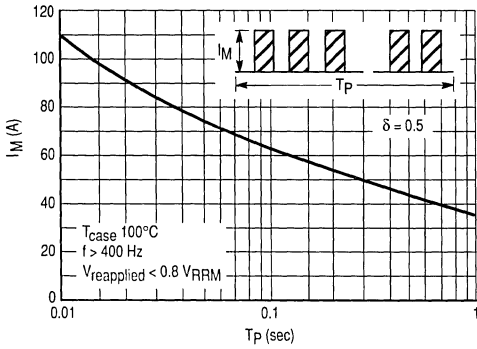


Figure 3. Non-Repetitive Peak Surge Current versus Overload Duration

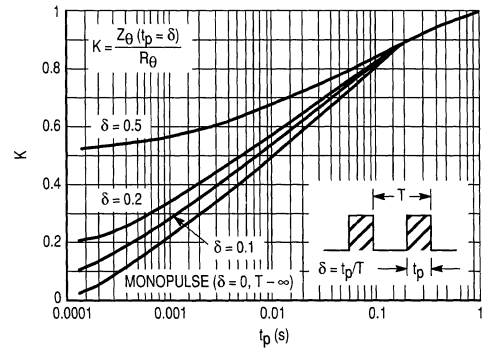


Figure 4. Relative Variation of Thermal Impedance Junction to Case versus Pulse Duration

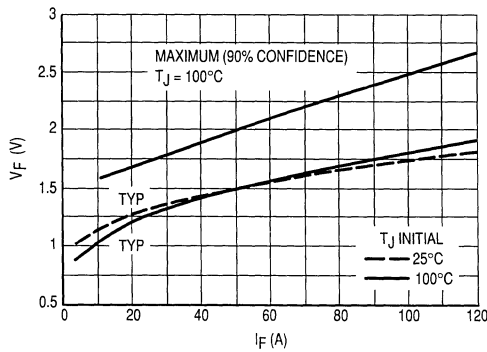


Figure 5. Voltage Drop versus Forward Current

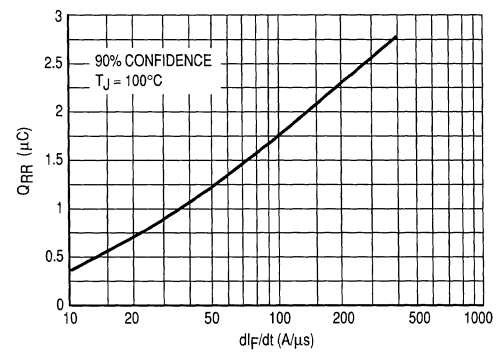


Figure 6. Recovery Charge versus  $di_F/dt$

# BYT230PIV-1000M

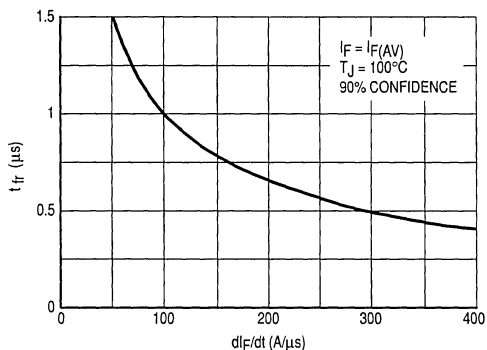


Figure 7. Recovery Time versus  $di_F/dt$

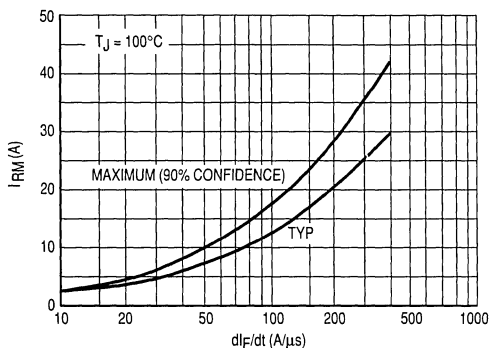


Figure 8. Peak Reverse Current versus  $di_F/dt$

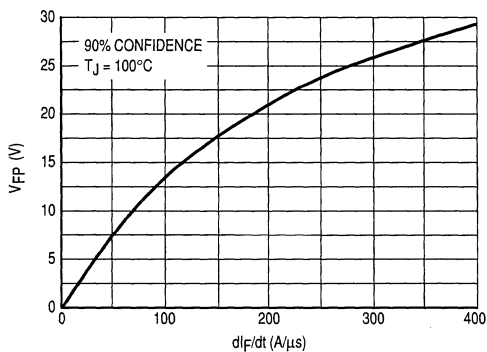


Figure 9. Peak Forward Voltage versus  $di_F/dt$

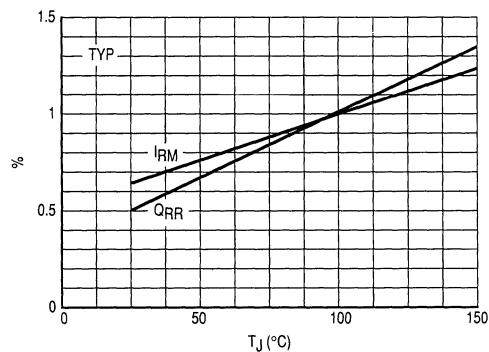


Figure 10. Dynamic Parameters versus Junction Temperature

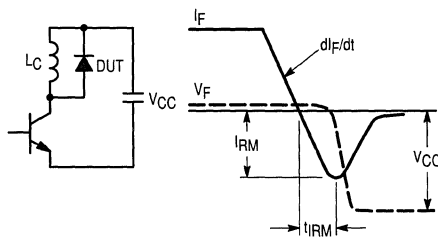


Figure 11. Turn-Off Switching Characteristics (Without series inductance)

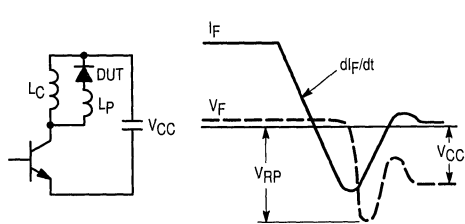



Figure 12. Turn-Off Switching Characteristics (With series inductance)

## Ultrafast Power Rectifiers

Dual high voltage rectifiers suited for Switchmode Power Supplies and other power converters.

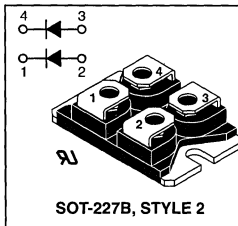
- Very Low Reverse Recovery Time
- Very Low Switching Losses
- Low Noise Turn-Off Switching
- Insulated Package:  
Insulating voltage = 2500 V<sub>RMS</sub>  
Capacitance = 45 pF
-  — UL Recognized, File #E69369

### Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: BYT261PIV-400M

**BYT261PIV-400M**

**ULTRAFAST  
RECTIFIERS  
120 AMPS  
400 VOLTS**



4

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	400	V
Average Rectified Current $T_C = 80^\circ\text{C}$	$I_F(\text{AV})$ Per Device Per Diode	120 60	A
Peak Repetitive Forward Current, Per Diode $t_p < 10 \mu\text{s}$	$I_{FRM}$	800	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	600	A
Operating Junction Temperature	$T_J$	-40 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case Coupling	Per Diode Per Device	$R_{\theta JC}$ $R_{\theta JC}$ $R_{\theta C}$	0.85 0.5 0.1	$^\circ\text{C}/\text{W}$
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### ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) $I_F = 60 \text{ A}, T_C = 25^\circ\text{C}$ $I_F = 60 \text{ A}, T_C = 100^\circ\text{C}$	$V_F$	1.5 1.4	V
Instantaneous Reverse Current (2) $V_R = 400 \text{ V}, T_C = 25^\circ\text{C}$ $V_R = 400 \text{ V}, T_C = 100^\circ\text{C}$	$I_R$	60 6	$\mu\text{A}$ mA

(1) Pulse Test: Pulse Width = 380  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$

(2) Pulse Test: Pulse Width = 5 ms, Duty Cycle < 2%

Rev 1

## BYT261PIV-400M

### RECOVERY CHARACTERISTICS

Test Conditions	Symbol	Typ	Max	Unit
$I_F = 1 \text{ A}$ , $V_R = 30 \text{ V}$ , $dI_F/dt = -15 \text{ A}/\mu\text{s}$	$t_{rr}$	—	100	ns
$I_F = 0.5 \text{ A}$ , $I_R = 1 \text{ A}$ , $I_{rr} = 0.25 \text{ A}$		—	50	

### TURN-OFF SWITCHING CHARACTERISTICS (without series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$V_{CC} = 200 \text{ V}$ , $I_F = 60 \text{ A}$ , $T_J = 100^\circ\text{C}$ , $L_P < 0.05 \mu\text{H}$ (See Figure 11)	$t_{IRM}$	—	75	ns
$dI_F/dt = -240 \text{ A}/\mu\text{s}$ $dI_F/dt = -480 \text{ A}/\mu\text{s}$		50	—	
$dI_F/dt = -240 \text{ A}/\mu\text{s}$ $dI_F/dt = -480 \text{ A}/\mu\text{s}$	$I_{RM}$	—	18	A
		24	—	

### TURN-OFF OVERVOLTAGE COEFFICIENT (with series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$T_J = 100^\circ\text{C}$ , $V_{CC} = 120 \text{ V}$ , $I_F = I_{F(AV)}$ $dI_F/dt = -60 \text{ A}/\mu\text{s}$ , $L_P = 0.8 \mu\text{H}$ (See Figure 12)	$C = \frac{V_{RP}}{V_{CC}}$	3.3	4	



# BYT261PIV-400M

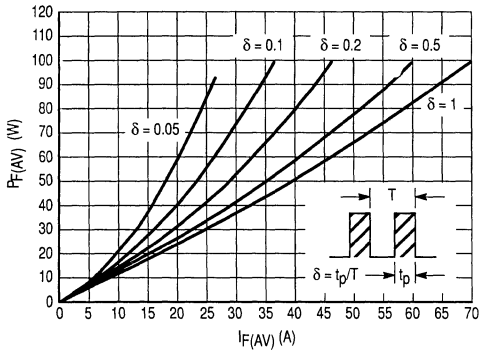


Figure 1. Low Frequency Power Losses versus Average Current

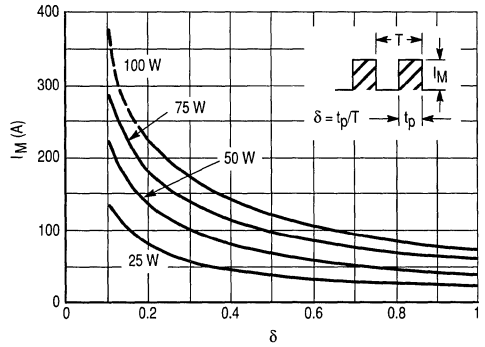


Figure 2. Peak Current versus Form Factor

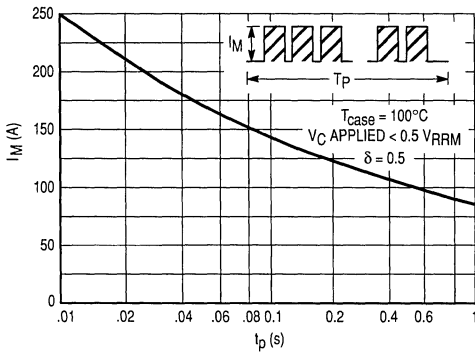


Figure 3. Non-Repetitive Peak Surge Current versus Overload Duration

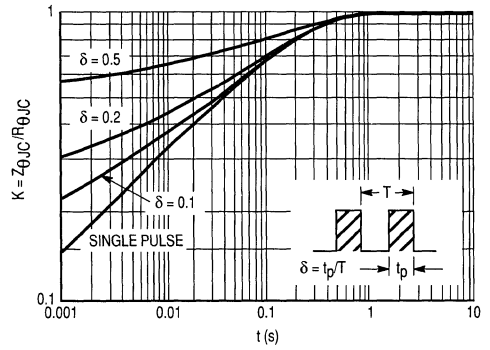


Figure 4. Relative Variation of Thermal Impedance Junction to Case versus Pulse Duration

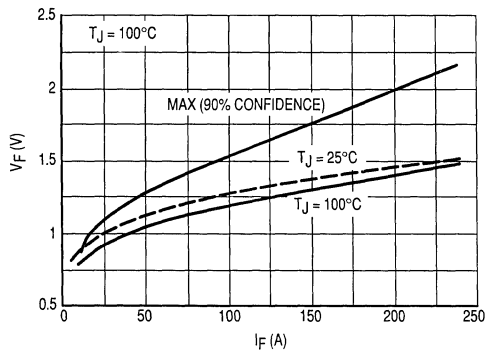


Figure 5. Voltage Drop versus Forward Current

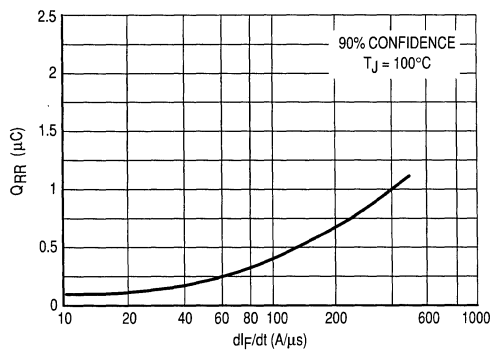


Figure 6. Recovery Charge versus  $dI_F/dt$

# BYT261PIV-400M

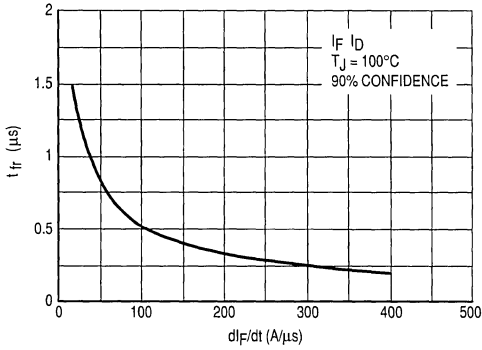


Figure 7. Recovery Time versus  $di_F/dt$

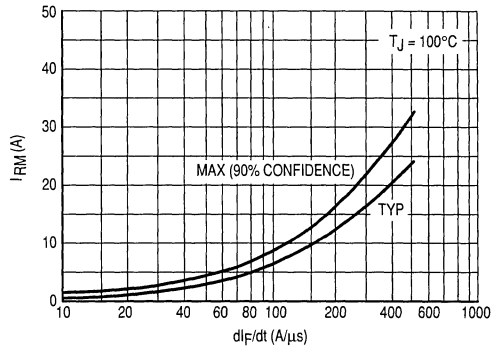


Figure 8. Peak Reverse Current versus  $di_F/dt$

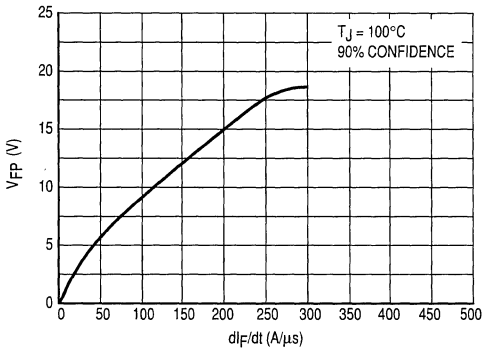


Figure 9. Peak Forward Voltage versus  $di_F/dt$

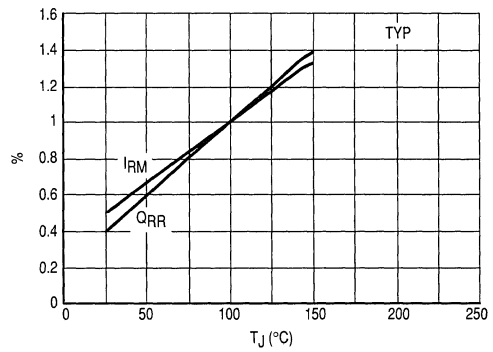


Figure 10. Dynamic Parameters versus Junction Temperature

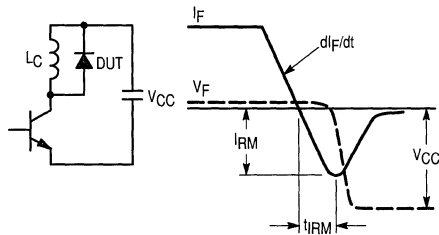


Figure 11. Turn-Off Switching Characteristics (Without series inductance)

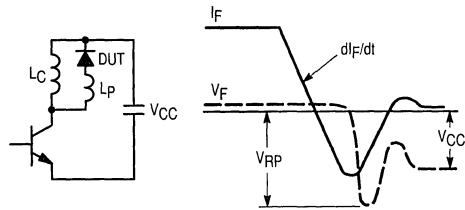



Figure 12. Turn-Off Switching Characteristics (With series inductance)

4

## Ultrafast Power Rectifiers

Dual high voltage rectifiers suited for Switchmode Power Supplies and other power converters.

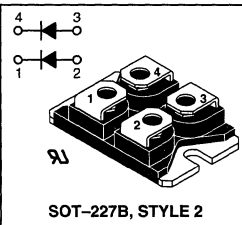
- Very Low Reverse Recovery Time
- Very Low Switching Losses
- Low Noise Turn-Off Switching
- Insulated Package:  
Insulating voltage = 2500 V<sub>RMS</sub>  
Capacitance = 45 pF
-  — UL Recognized, File #E69369

### Mechanical Characteristics

- Case: Molded epoxy with isolated metal base
- Weight: 28 g (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Shipped 10 units per plastic tube
- Marking: BYT261PIV-1000M

**BYT261PIV-1000M**

**ULTRAFAST  
RECTIFIERS  
120 AMPS  
1000 VOLTS**



4

### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	1000	V
Average Rectified Current $T_C = 60^\circ\text{C}$	$I_{F(AV)}$ Per Device Per Diode	120 60	A
Peak Repetitive Forward Current, Per Diode $t_p < 10 \mu\text{s}$	$I_{FRM}$	750	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	400	A
Operating Junction Temperature	$T_J$	-40 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-40 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction to Case Coupling	Per Diode Per Device	$R_{\theta JC}$ $R_{\theta JC}$ $R_{\theta C}$	1.1 0.6 0.1	$^\circ\text{C}/\text{W}$
--	-------------------------	--	-------------------	---------------------------

### ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (1) $I_F = 60 \text{ A}, T_C = 25^\circ\text{C}$ $I_F = 60 \text{ A}, T_C = 100^\circ\text{C}$	$V_F$	1.9 1.8	V
Instantaneous Reverse Current (2) $V_R = 1000 \text{ V}, T_C = 25^\circ\text{C}$ $V_R = 1000 \text{ V}, T_C = 100^\circ\text{C}$	$I_R$	100 6	$\mu\text{A}$ mA

(1) Pulse Test: Pulse Width = 380  $\mu\text{s}$ , Duty Cycle  $\leq 2\%$

(2) Pulse Test: Pulse Width = 5 ms, Duty Cycle  $< 2\%$

Rev 1

# BYT261PIV-1000M

## RECOVERY CHARACTERISTICS

Test Conditions	Symbol	Typ	Max	Unit
$I_F = 1\text{ A}$ , $V_R = 30\text{ V}$ , $dI_F/dt = -15\text{ A}/\mu\text{s}$ $I_F = 0.5\text{ A}$ , $I_R = 1\text{ A}$ , $I_{rr} = 0.25\text{ A}$	$t_{rr}$	—	170 70	ns

## TURN-OFF SWITCHING CHARACTERISTICS (without series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$V_{CC} = 200\text{ V}$ , $I_F = 60\text{ A}$ , $T_J = 100^\circ\text{C}$ , $L_p < 0.05\ \mu\text{H}$ (See Figure 11) $dI_F/dt = -240\text{ A}/\mu\text{s}$ $dI_F/dt = -480\text{ A}/\mu\text{s}$	$t_{IRM}$	— 120	200 —	ns
$dI_F/dt = -240\text{ A}/\mu\text{s}$ $dI_F/dt = -480\text{ A}/\mu\text{s}$	$I_{RM}$	— 44	40 —	A

## TURN-OFF OVERVOLTAGE COEFFICIENT (with series inductance)

Test Conditions	Symbol	Typ	Max	Unit
$T_J = 100^\circ\text{C}$ , $V_{CC} = 200\text{ V}$ , $I_F = I_F(AV)$ $dI_F/dt = -60\text{ A}/\mu\text{s}$ , $L_p = 2.5\ \mu\text{H}$ (See Figure 12)	$C = \frac{V_{RP}}{V_{CC}}$	3.3	4.5	

# BYT261PIV-1000M

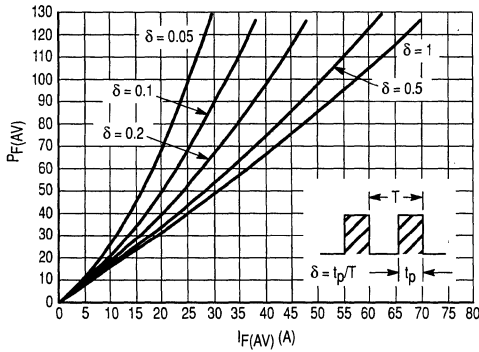


Figure 1. Low Frequency Power Losses versus Average Current

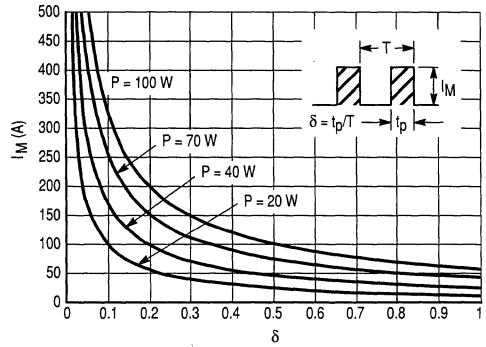


Figure 2. Peak Current versus Form Factor

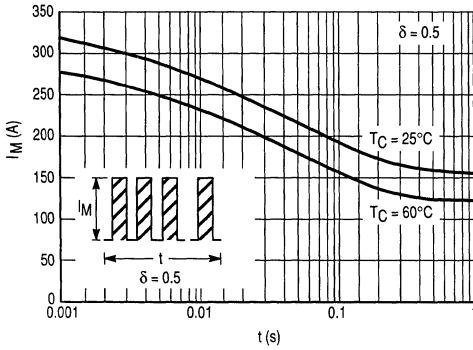


Figure 3. Non-Repetitive Peak Surge Current versus Overload Duration

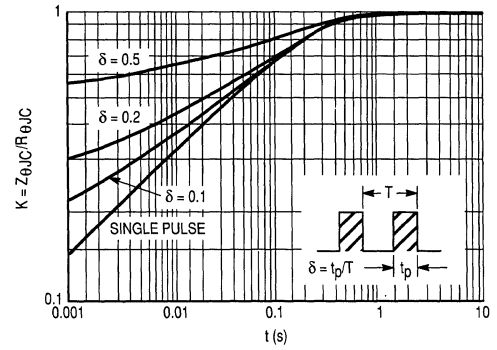


Figure 4. Relative Variation of Thermal Impedance Junction to Case versus Pulse Duration

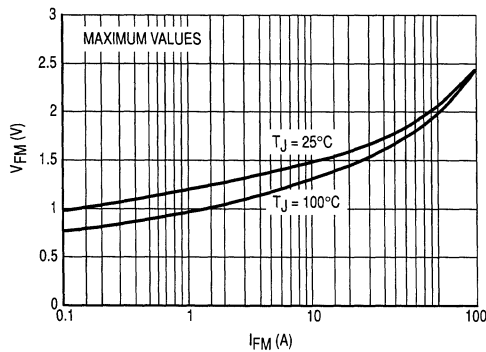


Figure 5. Voltage Drop versus Forward Current

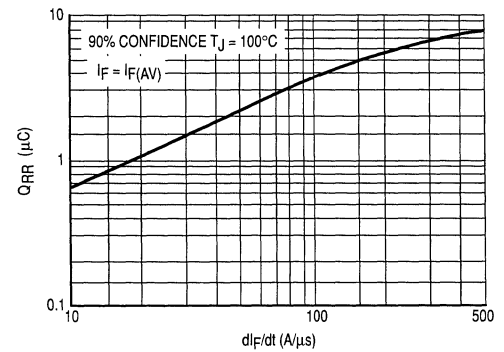


Figure 6. Recovery Charge versus  $dI_F/dt$

# BYT261PIV-1000M

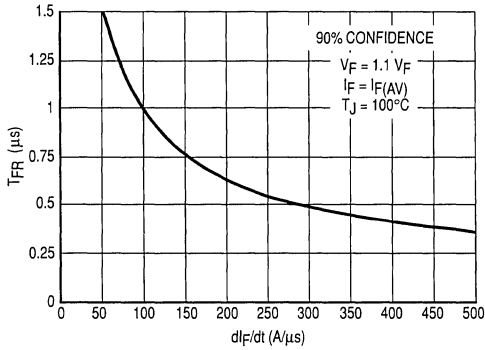


Figure 7. Recovery Time versus  $di_F/dt$

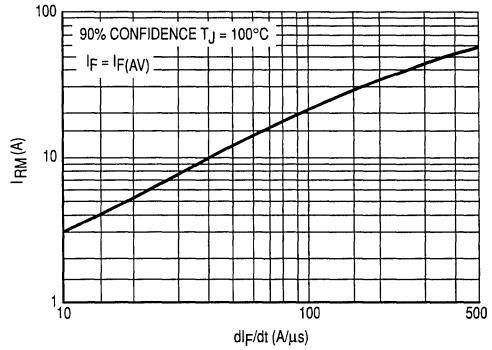


Figure 8. Peak Reverse Current versus  $di_F/dt$

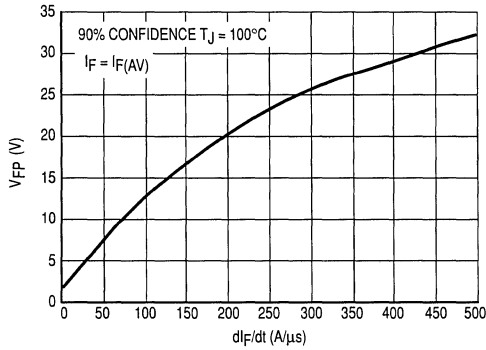


Figure 9. Peak Forward Voltage versus  $di_F/dt$

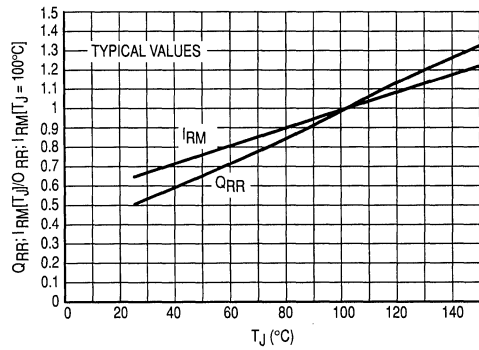


Figure 10. Dynamic Parameters versus Junction Temperature

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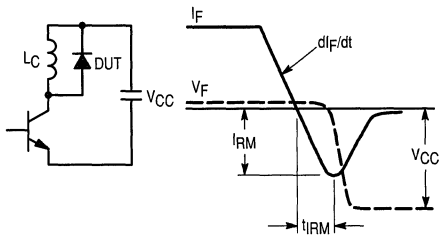


Figure 11. Turn-Off Switching Characteristics (Without series inductance)

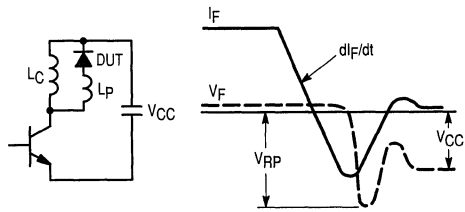


Figure 12. Turn-Off Switching Characteristics (With series inductance)

*Preliminary Data Sheet*

**POWERTAP II**  
**Ultrafast**  
**SWITCHMODE Power Rectifier**

... designed for use in switching power supplies, inverters, and as free wheeling diodes. This state-of-the-art device has the following features:

- Dual Diode Construction
- Low Leakage Current
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Labor Saving POWERTAP Package

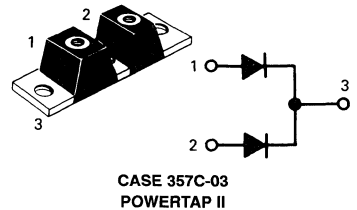
**Mechanical Characteristics:**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25 – 40 lb – in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: UP20020

Motorola Preferred Devices

**ULTRAFAST**  
**RECTIFIER**

**200 AMPERES**  
**200 – 400 VOLTS**



4

**MAXIMUM RATINGS**

Rating	Symbol	MURP20020CT	MURP20040CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	400	Volts
Average Rectified Forward Current (Rated $V_R$ )	Per Device $I_{F(AV)}$ Per Leg	200 ( $T_C = 130^\circ\text{C}$ ) 100 ( $T_C = 130^\circ\text{C}$ )	200 ( $T_C = 100^\circ\text{C}$ ) 100 ( $T_C = 100^\circ\text{C}$ )	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz), $T_C = 95^\circ\text{C}$	$I_{FRM}$	200	200	Amps
Nonrepetitive Peak Surge Current Per Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	800	800	Amps
Operating Junction Temperature	$T_J$	-55 to +175	-55 to +175	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-55 to +150	-55 to +150	$^\circ\text{C}$

**THERMAL CHARACTERISTICS PER LEG**

Rating	Symbol	Max		Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.45	0.45	$^\circ\text{C/W}$

**ELECTRICAL CHARACTERISTICS PER LEG**

Instantaneous Forward Voltage (1) ( $I_F = 100$ Amp, $T_C = +25^\circ\text{C}$ ) ( $I_F = 200$ Amp, $T_C = 25^\circ\text{C}$ ) ( $I_F = 100$ Amp, $T_C = 125^\circ\text{C}$ )	$V_F$	1.00 1.10 0.95	1.30 1.75 1.15	Volts
Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ )	$i_R$	1000 150	500 50	$\mu\text{A}$
Maximum Reverse Recovery Time ( $I_F = 1.0$ Amps, $di/dt = 50$ Amps/ $\mu\text{s}$ )	$t_{rr}$	50	75	ns

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

## ***Section 5***

# **Standard and Fast Recovery Data Sheets**

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# Axial-Lead Standard Recovery Rectifiers

This data sheet provides information on subminiature size, axial lead mounted rectifiers for general-purpose low-power applications.

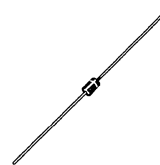
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N4001, 1N4002, 1N4003, 1N4004, 1N4005, 1N4006, 1N4007

**1N4001  
thru  
1N4007**

1N4004 and 1N4007 are Motorola Preferred Devices

**LEAD MOUNTED  
RECTIFIERS  
50-1000 VOLTS  
DIFFUSED JUNCTION**



CASE 59-03  
DO-41

### MAXIMUM RATINGS

Rating	Symbol	1N4001	1N4002	1N4003	1N4004	1N4005	1N4006	1N4007	Unit
*Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50	100	200	400	600	800	1000	Volts
*Non-Repetitive Peak Reverse Voltage (halfwave, single phase, 60 Hz)	$V_{RSM}$	60	120	240	480	720	1000	1200	Volts
*RMS Reverse Voltage	$V_R(RMS)$	35	70	140	280	420	560	700	Volts
*Average Rectified Forward Current (single phase, resistive load, 60 Hz, see Figure 8, $T_A = 75^\circ C$ )	$I_O$	1.0							Amp
*Non-Repetitive Peak Surge Current (surge applied at rated load conditions, see Figure 2)	$I_{FSM}$	30 (for 1 cycle)							Amp
Operating and Storage Junction Temperature Range	$T_J$ $T_{stg}$	- 65 to +175							$^\circ C$

### ELECTRICAL CHARACTERISTICS\*

Rating	Symbol	Typ	Max	Unit
Maximum Instantaneous Forward Voltage Drop ( $I_F = 1.0$ Amp, $T_J = 25^\circ C$ ) Figure 1	$v_F$	0.93	1.1	Volts
Maximum Full-Cycle Average Forward Voltage Drop ( $I_O = 1.0$ Amp, $T_L = 75^\circ C$ , 1 inch leads)	$V_F(AV)$	—	0.8	Volts
Maximum Reverse Current (rated dc voltage) ( $T_J = 25^\circ C$ ) ( $T_J = 100^\circ C$ )	$I_R$	0.05 1.0	10 50	$\mu A$
Maximum Full-Cycle Average Reverse Current ( $I_O = 1.0$ Amp, $T_L = 75^\circ C$ , 1 inch leads)	$I_R(AV)$	—	30	$\mu A$

\*Indicates JEDEC Registered Data

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 5

# Axial-Lead Fast-Recovery Rectifiers

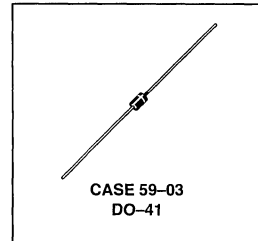
Axial-lead, fast-recovery rectifiers are designed for special applications such as dc power supplies, inverters, converters, ultrasonic systems, choppers, low RF interference and free wheeling diodes. A complete line of fast recovery rectifiers having typical recovery time of 150 nanoseconds providing high efficiency at frequencies to 250 kHz.

**Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N4933, 1N4934, 1N4935, 1N4936, 1N4937

**1N4933**  
**thru**  
**1N4937**  
1N4935 and 1N4937 are Motorola Preferred Devices

**FAST RECOVERY RECTIFIERS**  
**50–600 VOLTS**  
**1.0 AMPERE**



**MAXIMUM RATINGS (1)**

Rating	Symbol	1N4933	1N4934	1N4935	1N4936	1N4937	Unit
*Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50	100	200	400	600	Volts
*Non-Repetitive Peak Reverse Voltage RMS Reverse Voltage	$V_{RSM}$ $V_R(RMS)$	75 35	150 70	250 140	450 280	650 420	Volts
*Average Rectified Forward Current (Single phase, resistive load, $T_A = 75^\circ\text{C}$ ) (2)	$I_O$	1.0					Amp
*Non-Repetitive Peak Surge Current (Surge applied at rated load conditions)	$I_{FSM}$	30					Amps
Operating Junction Temperature Range Storage Temperature Range	$T_J$ $T_{stg}$	– 65 to +150 – 65 to +150					$^\circ\text{C}$

**THERMAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (Typical Printed Circuit Board Mounting)	$R_{\theta JC}$	65	$^\circ\text{C/W}$

\*Indicates JEDEC Registered Data for 1N4933 Series.  
(1) Ratings at 25°C ambient temperature unless otherwise specified.  
(2) Derate by 20% for capacitive loads.

Preferred devices are Motorola recommended choices for future use and best overall value.

# 1N4933 THRU 1N4937

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Instantaneous Forward Voltage ( $I_F = 3.14$ Amp, $T_J = 125^\circ\text{C}$ )	$V_F$	—	1.0	1.2	Volts
Forward Voltage ( $I_F = 1.0$ Amp, $T_A = 25^\circ\text{C}$ )	$V_F$	—	1.0	1.1	Volts
*Reverse Current (Rated dc Voltage) $T_A = 25^\circ\text{C}$ $T_A = 100^\circ\text{C}$	$I_R$	— —	1.0 50	5.0 100	$\mu\text{A}$

## \*REVERSE RECOVERY CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Recovery Time ( $I_F = 1.0$ Amp to $V_R = 30$ Vdc) ( $I_{FM} = 15$ Amp, $di/dt = 10$ A/ $\mu\text{s}$ )	$t_{rr}$	— —	150 175	200 300	ns
Reverse Recovery Current ( $I_F = 1.0$ Amp to $V_R = 30$ Vdc)	$I_{RM}(\text{REC})$	—	1.0	2.0	Amp

\*Indicates JEDEC Registered Data for 1N4933 Series.

# Axial-Lead Standard Recovery Rectifiers

Lead mounted standard recovery rectifiers are designed for use in power supplies and other applications having need of a device with the following features:

- High Current to Small Size
- High Surge Current Capability
- Low Forward Voltage Drop
- Void-Free Economical Plastic Package
- Available in Volume Quantities

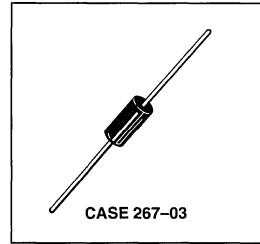
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N5400, 1N5401, 1N5402, 1N5404, 1N5406, 1N5407, 1N5408

**1N5400  
thru  
1N5408**

1N5404 and 1N5406 are Motorola Preferred Devices

**STANDARD  
RECOVERY RECTIFIERS  
50-1000 VOLTS  
3.0 AMPERE**



### MAXIMUM RATINGS

Rating	Symbol	1N5400	1N5401	1N5402	1N5404	1N5406	1N5407	1N5408	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50	100	200	400	600	800	1000	Volts
Non-repetitive Peak Reverse Voltage	$V_{RSM}$	100	200	300	525	800	1000	1200	Volts
Average Rectified Forward Current (Single Phase Resistive Load, 1/2" Leads, $T_L = 105^\circ\text{C}$ )	$I_O$	3.0							Amp
Non-repetitive Peak Surge Current (Surge Applied at Rated Load Conditions)	$I_{FSM}$	200 (one cycle)							Amp
Operating and Storage Junction Temperature Range	$T_J$ $T_{stg}$	- 65 to +170 - 65 to +175							$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Typ	Unit
Thermal Resistance, Junction to Ambient (PC Board Mount, 1/2" Leads)	$R_{\theta JA}$	53	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
*Instantaneous Forward Voltage (1) ( $I_F = 9.4$ Amp)	$V_F$	—	—	1.2	Volts
Average Reverse Current (1) DC Reverse Current (Rated dc Voltage, $T_L = 80^\circ\text{C}$ )	$I_{R(AV)}$ $I_R$	—	—	500 500	$\mu\text{A}$

\*JEDEC Registered Data.

(1) Measured in a single phase halfwave circuit such as shown in Figure 6.25 of EIA RS-282, November 1963. Operated at rated load conditions  $T_L = 80^\circ\text{C}$ ,  $I_O = 3.0$  A,  $V_F = V_{RWM}$ .

Preferred devices are Motorola recommended choices for future use and best overall value.

Ratings at 25°C ambient temperature unless otherwise specified.

60 Hz resistive or inductive loads.

For capacitive load, derate current by 20%.

Rev 2

# Axial Lead Fast Recovery Rectifiers

Axial lead mounted fast recovery power rectifiers are designed for special applications such as dc power supplies, inverters, converters, ultrasonic systems, choppers, low RF interference and free wheeling diodes. A complete line of fast recovery rectifiers having typical recovery time of 100 nanoseconds providing high efficiency at frequencies to 250 kHz.

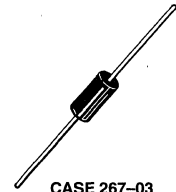
### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 5,000 per bag.
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: R850, R851, R852, R854, R856

**MR850**  
**MR851**  
**MR852**  
**MR854**  
**MR856**

MR852 and MR856 are Motorola Preferred Devices

**FAST RECOVERY  
POWER RECTIFIERS**  
**50-600 VOLTS**  
**3.0 AMPERES**



CASE 267-03

5

### MAXIMUM RATINGS

Rating	Symbol	MR850	MR851	MR852	MR854	MR856	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50	100	200	400	600	Volts
Non-Repetitive Peak Reverse Voltage	$V_{RSM}$	75	150	250	450	650	Volts
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	Volts
Average Rectified Forward Current (Single phase resistive load, $T_A = 80^\circ\text{C}$ )	$I_O$	3.0					Amp
Non-Repetitive Peak Surge Current (surge applied at rated load conditions)	$I_{FSM}$	100 (one cycle)					Amp
Operating and Storage Junction Temperature Range	$T_J$ , $T_{stg}$	- 65 to +125 - 65 to +150					$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (Recommended Printed Circuit Board Mounting, See Note 4, Page 5)	$R_{\theta JA}$	28	$^\circ\text{C/W}$

Preferred devices are Motorola recommended choices for future use and best overall value.

Rev 2

# MR850, MR851, MR852, MR854, MR856

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Forward Voltage ( $I_F = 3.0$ Amp, $T_J = 25^\circ\text{C}$ )	$V_F$	—	1.04	1.25	Volts
Reverse Current (rated dc voltage) $T_J = 25^\circ\text{C}$	$I_R$	—	2.0	10	$\mu\text{A}$
MR850		—	—	150	
MR851		—	60	150	
MR852		—	—	200	
MR854		—	—	250	
$T_J = 80^\circ\text{C}$		—	100	300	

## REVERSE RECOVERY CHARACTERISTICS

Characteristic	Symbol	Min	Typ	Max	Unit
Reverse Recovery Time ( $I_F = 1.0$ Amp to $V_R = 30$ Vdc, Figure 9) ( $I_F = 15$ Amp, $di/dt = 10$ A/ $\mu\text{s}$ , Figure 10)	$t_{rr}$	—	100 150	200 300	ns
Reverse Recovery Current ( $I_F = 1.0$ Amp to $V_R = 30$ Vdc, Figure 9)	$I_{RM}(\text{REC})$	—	—	2.0	Amp

**MR750**  
**MR751 MR752**  
**MR754 MR756**  
**MR758 MR760**

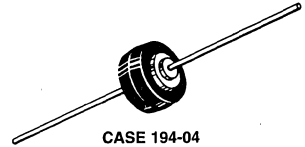
**Designers Data Sheet**

**High Current Lead Mounted Rectifiers**

- Current Capacity Comparable To Chassis Mounted Rectifiers
- Very High Surge Capacity
- Insulated Case
- Mechanical Characteristics:**
  - Case: Epoxy, Molded
  - Weight: 2.5 grams (approximately)
  - Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
  - Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
  - Polarity: cathode polarity band
  - Shipped 1000 units per plastic bag. Available Tape and Reeled, 800 units per reel by adding a "RL" suffix to the part number
  - Marking: R750, R751, R752, R754, R758, R760

MR754 and MR760 are  
 Motorola Preferred Devices

**HIGH CURRENT  
 LEAD MOUNTED  
 SILICON RECTIFIERS  
 50-1000 VOLTS  
 DIFFUSED JUNCTION**



**\*MAXIMUM RATINGS**

Characteristic	Symbol	MR750	MR751	MR752	MR754	MR756	MR758	MR760	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50	100	200	400	600	800	1000	Volts
Non-Repetitive Peak Reverse Voltage (halfwave, single phase, 60 Hz peak)	$V_{RSM}$	60	120	240	480	720	960	1200	Volts
RMS Reverse Voltage	$V_R(RMS)$	35	70	140	280	420	560	700	Volts
Average Rectified Forward Current (single phase, resistive load, 60 Hz) See Figures 5 and 6	$I_O$	$\longleftrightarrow$ 22 ( $T_L = 60^\circ C$ , 1/8" Lead Lengths) 6.0 ( $T_A = 60^\circ C$ , P.C. Board mounting) $\longleftrightarrow$							Amp
Non-Repetitive Peak Surge Current (surge applied at rated load conditions)	$I_{FSM}$	$\longleftrightarrow$ 400 (for 1 cycle) $\longleftrightarrow$							Amp
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	$\longleftrightarrow$ -65 to +175 $\longleftrightarrow$							$^\circ C$

**ELECTRICAL CHARACTERISTICS**

Characteristic and Conditions	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage Drop ( $I_F = 100$ Amp, $T_J = 25^\circ C$ )	$V_F$	1.25	Volts
Maximum Forward Voltage Drop ( $I_F = 6.0$ Amp, $T_A = 25^\circ C$ , 3/8" leads)	$V_F$	0.90	Volts
Maximum Reverse Current (rated dc voltage) $T_J = 25^\circ C$ $T_J = 100^\circ C$	$I_R$	25 1.0	$\mu A$ mA

Rev 2

5

# MR750, MR751, MR752, MR754, MR756, MR758, MR760

FIGURE 1 – FORWARD VOLTAGE

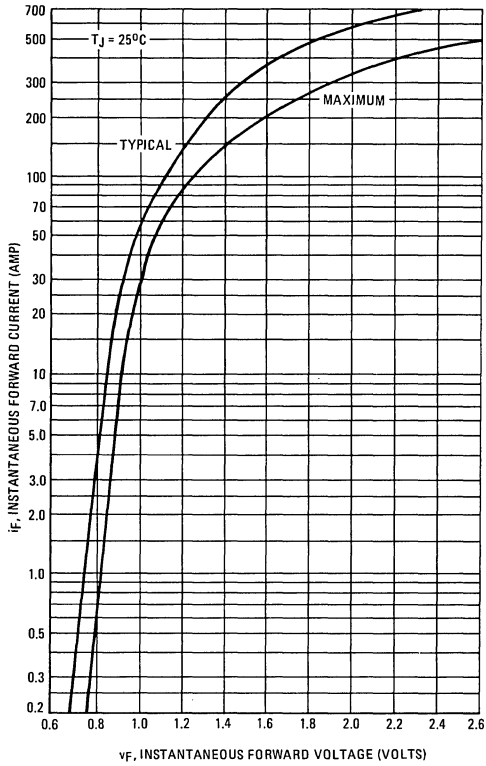


FIGURE 2 – MAXIMUM SURGE CAPABILITY

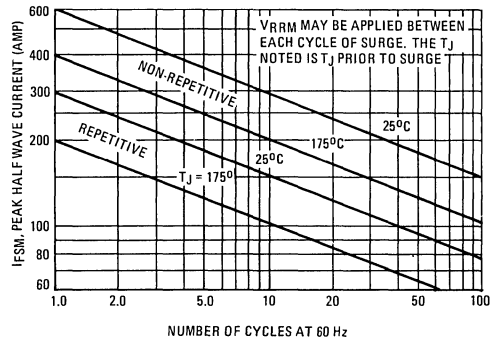
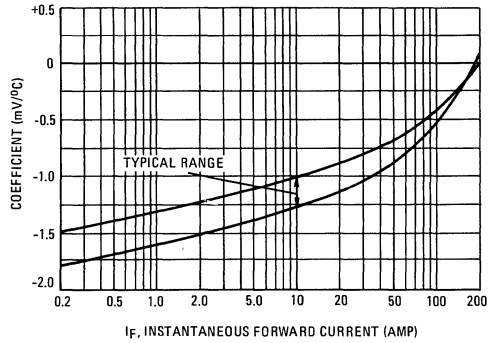
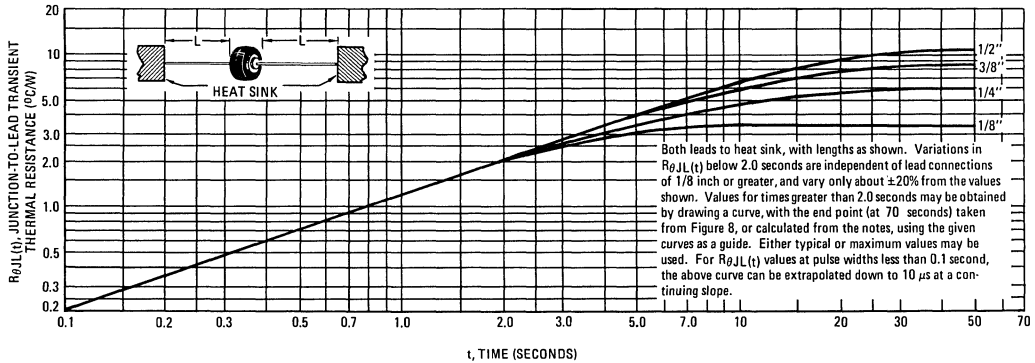


FIGURE 3 – FORWARD VOLTAGE TEMPERATURE COEFFICIENT



5

FIGURE 4 – TYPICAL TRANSIENT THERMAL RESISTANCE





# MR750, MR751, MR752, MR754, MR756, MR758, MR760

FIGURE 5 – MAXIMUM CURRENT RATINGS

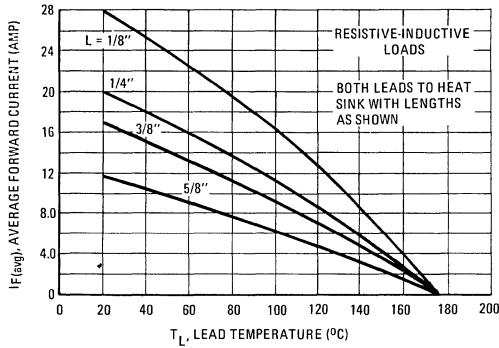


FIGURE 6 – MAXIMUM CURRENT RATINGS

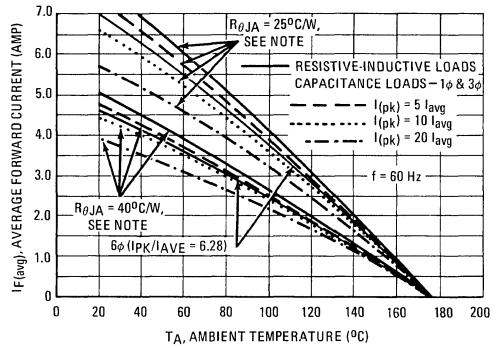
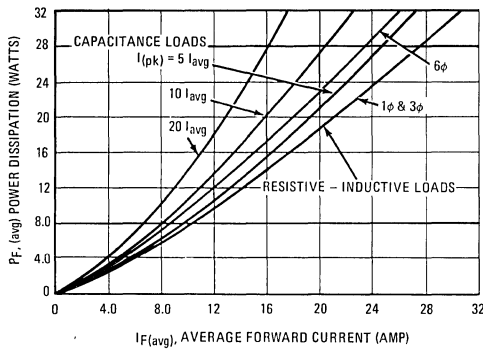
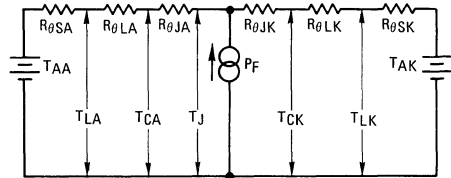


FIGURE 7 – POWER DISSIPATION



NOTES

Thermal Circuit Model  
(For Heat Conduction Through The Leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. Lowest values occur when one side of the rectifier is brought as close as possible to the heat sink as shown below. Terms in the model signify:

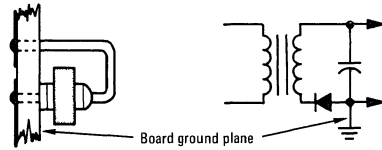
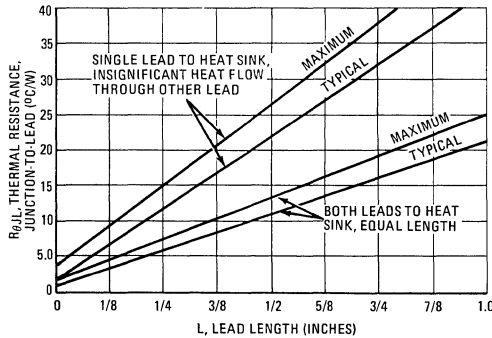
- $T_A$  = Ambient Temperature
  - $R_{θS}$  = Thermal Resistance, Heat Sink to Ambient
  - $T_L$  = Lead Temperature
  - $R_{θL}$  = Thermal Resistance, Lead to Heat Sink
  - $T_C$  = Case Temperature
  - $R_{θJ}$  = Thermal Resistance, Junction to Case
  - $T_J$  = Junction Temperature
  - $P_F$  = Power Dissipation
- (Subscripts A and K refer to anode and cathode sides respectively.)

Values for thermal resistance components are:  
 $R_{θL} = 40°C/W/IN$ . Typically and  $44°C/W/IN$  Maximum  
 $R_{θJ} = 2°C/W$  Typically and  $4°C/W$  Maximum

Since  $R_{θJ}$  is so low, measurements of the case temperature,  $T_C$ , will be approximately equal to junction temperature in practical lead mounted applications. When used as a 60 Hz rectifier, the slow thermal response holds  $T_J(PK)$  close to  $T_J(AVG)$ . Therefore maximum lead temperature may be found from  $T_L = 175° - R_{θJL} P_F$ .  $P_F$  may be found from Figure 7.

The recommended method of mounting to a P.C. board is shown on the sketch, where  $R_{θJA}$  is approximately  $25°C/W$  for a  $1-1/2" \times 1-1/2"$  copper surface area. Values of  $40°C/W$  are typical for mounting to terminal strips or P.C. boards where available surface area is small.

FIGURE 8 – STEADY STATE THERMAL RESISTANCE



TYPICAL DYNAMIC CHARACTERISTICS

FIGURE 9 – RECTIFICATION EFFICIENCY

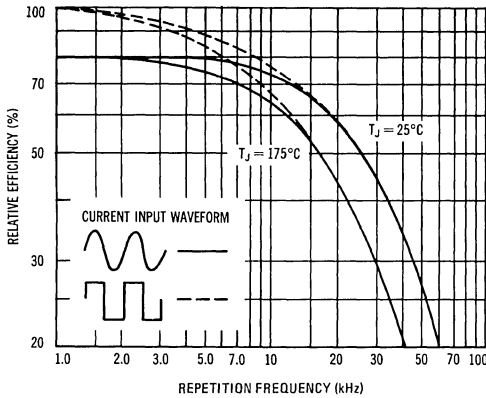


FIGURE 10 – REVERSE RECOVERY TIME

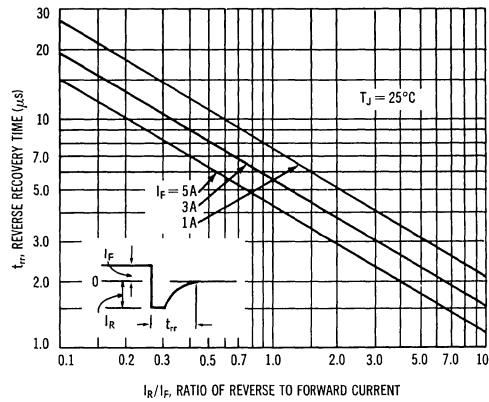


FIGURE 11 – JUNCTION CAPACITANCE

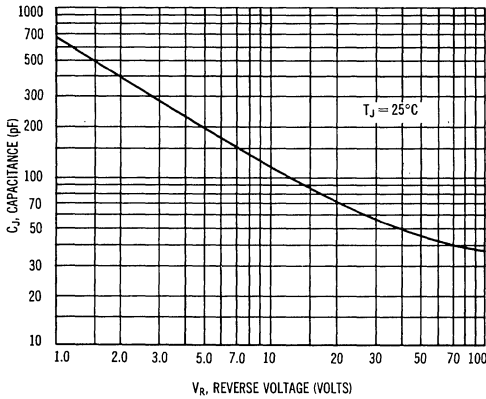


FIGURE 12 – FORWARD RECOVERY TIME

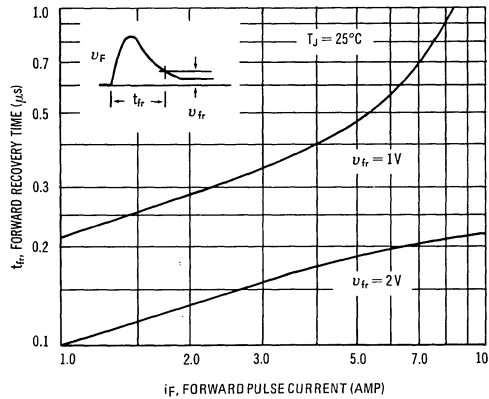
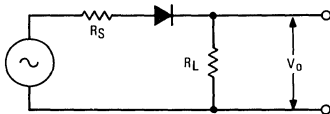


FIGURE 13 – SINGLE-PHASE HALF-WAVE RECTIFIER CIRCUIT



The rectification efficiency factor  $\sigma$  shown in Figure 9 was calculated using the formula:

$$\sigma = \frac{P(\text{dc})}{P(\text{rms})} = \frac{\frac{V_o^2(\text{dc})}{R_L}}{\frac{V_o^2(\text{rms})}{R_L}} \cdot 100\% = \frac{V_o^2(\text{dc})}{V_o^2(\text{ac}) + V_o^2(\text{dc})} \cdot 100\% \quad (1)$$

For a sine wave input  $V_m \sin(\omega t)$  to the diode, assumed lossless, the maximum theoretical efficiency factor becomes:

$$\sigma(\text{sine}) = \frac{V_m^2}{\pi^2 R_L} \cdot 100\% = \frac{4}{\pi^2} \cdot 100\% \approx 40.6\% \quad (2)$$

For a square wave input of amplitude  $V_m$ , the efficiency factor becomes:

$$\sigma(\text{square}) = \frac{V_m^2}{2R_L} \cdot 100\% = 50\% \quad (3)$$

(A full wave circuit has twice these efficiencies)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 10) becomes significant, resulting in an increasing ac voltage component across  $R_L$  which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor  $\sigma$ , as shown on Figure 9.

It should be emphasized that Figure 9 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of  $V_o$  with a true rms ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 9.

MR2504 and MR2510 are  
 Motorola Preferred Devices

## Medium-Current Silicon Rectifiers

... compact, highly efficient silicon rectifiers for medium-current applications requiring:

- High Current Surge — 400 Amperes @  $T_J = 175^\circ\text{C}$
- Peak Performance @ Elevated Temperature — 25 Amperes @  $T_C = 150^\circ\text{C}$
- Low Cost
- Compact, Molded Package — For Optimum Efficiency in a Small Case Configuration
- Available With a Single Lead Attached, Consult Factory

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.8 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminals are Readily Solderable
- Lead Temperature for Soldering Purposes: requires a custom temperature soldering profile
- Polarity: cathode polarity band
- Shipped 5000 units per box
- Marking: R2500, R2501, R2502, R2504, R2506, R2510

**MEDIUM-CURRENT**  
**SILICON RECTIFIERS**  
**50 – 1000 VOLTS**  
**25 AMPERES**  
**DIFFUSED JUNCTION**



CASE 193-04

5

### MAXIMUM RATINGS

Characteristic	Symbol	MR 2500	MR 2501	MR 2502	MR 2504	MR 2506	MR 2510	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50	100	200	400	600	1000	Volts
Non-Repetitive Peak Reverse Voltage (half wave, single phase, 60 Hz peak)	$V_{RSM}$	60	120	240	480	720	1200	Volts
Average Rectified Forward Current (Single phase, resistive load, 60 Hz, $T_C = 150^\circ\text{C}$ )	$I_O$	25						Amp
Non-Repetitive Peak Surge Current (surge applied @ rated load conditions, half wave, single phase, 60 Hz)	$I_{FSM}$	400 (for 1 cycle)						Amp
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +175						$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (Single Side Cooled)	$R_{\theta JC}$	1.0	$^\circ\text{C/W}$

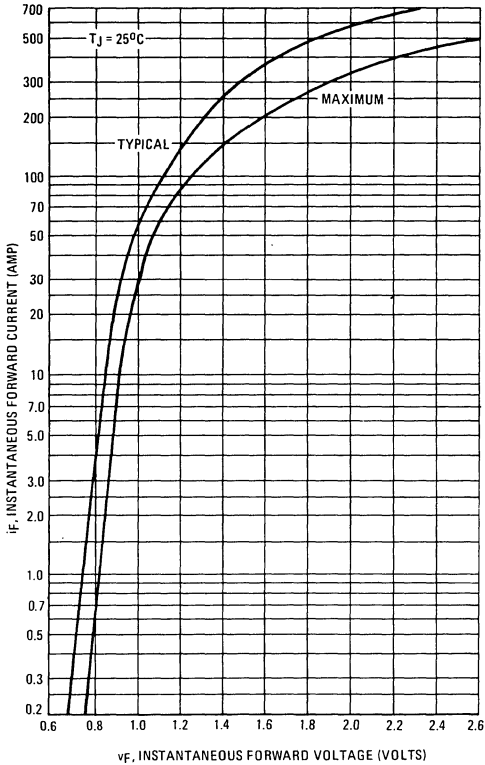
### ELECTRICAL CHARACTERISTICS

Characteristics and Conditions	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage ( $I_F = 78.5$ Amp, $T_C = 25^\circ\text{C}$ )	$V_F$	1.18	Volts
Maximum Reverse Current (rated dc voltage) $T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$	$I_R$	100 500	$\mu\text{A}$

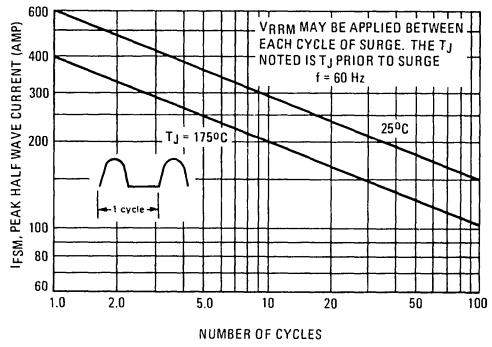
Rev 2

# MR2500 Series

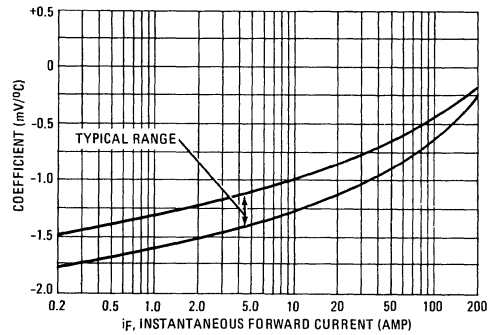
**FIGURE 1 – FORWARD VOLTAGE**



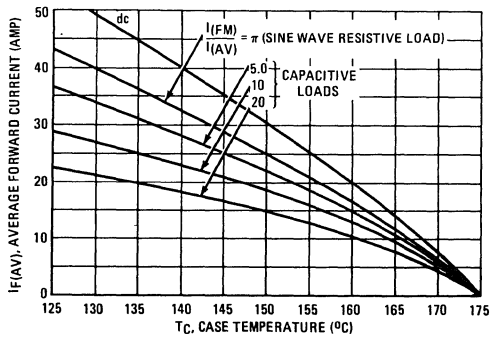
**FIGURE 2 – NON-REPETITIVE SURGE CURRENT**



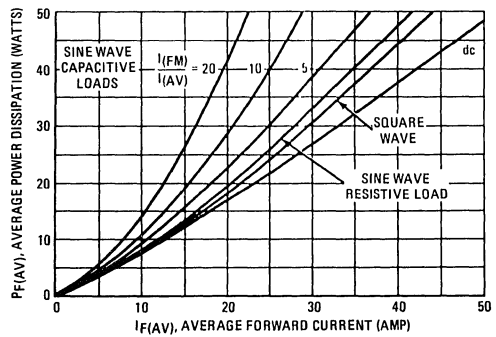
**FIGURE 3 – FORWARD VOLTAGE TEMPERATURE COEFFICIENT**



**FIGURE 4 – CURRENT DERATING**



**FIGURE 5 – FORWARD POWER DISSIPATION**



5

FIGURE 6 – THERMAL RESPONSE

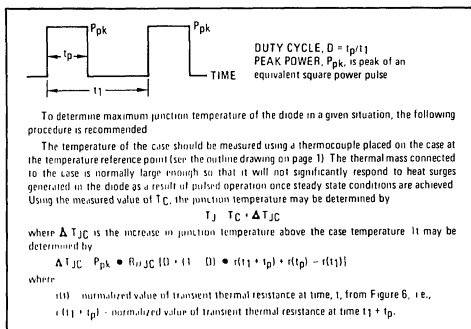
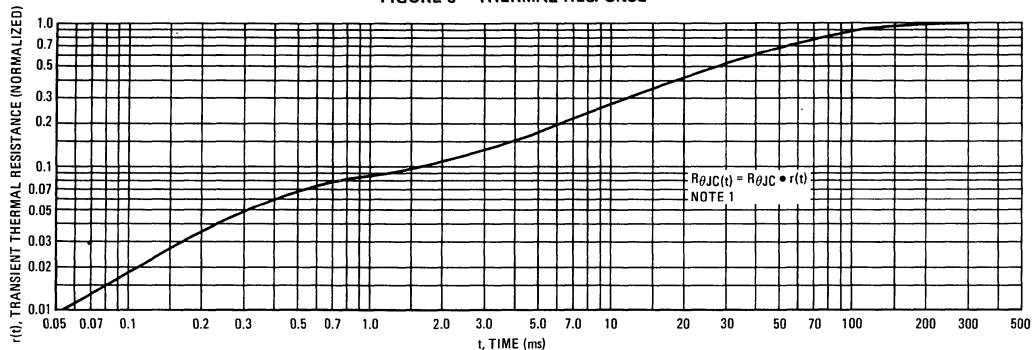


FIGURE 7 – CAPACITANCE

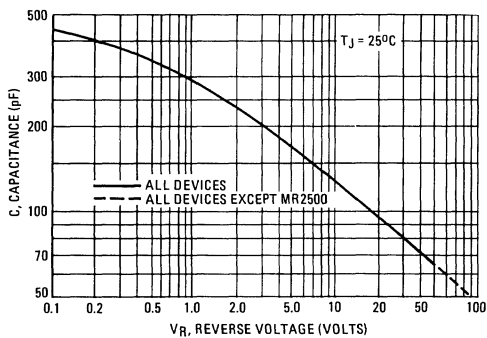


FIGURE 8 – FORWARD RECOVERY TIME

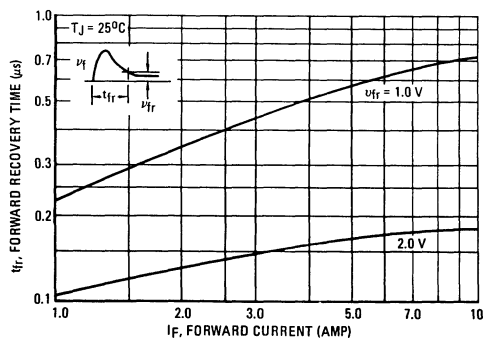
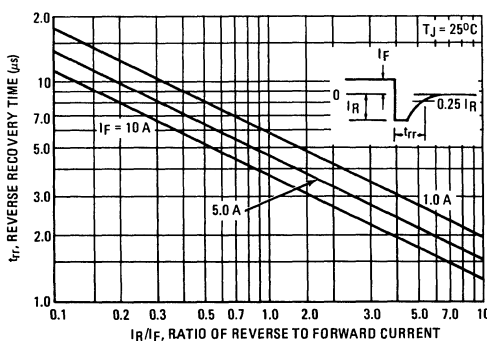
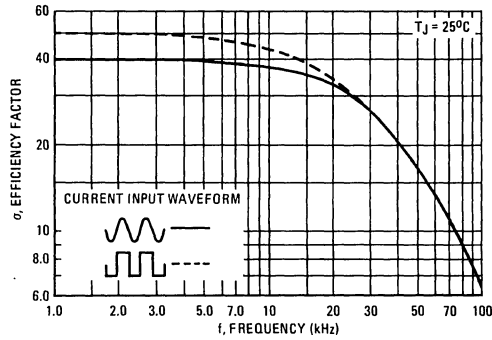


FIGURE 9 – REVERSE RECOVERY TIME



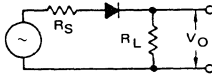
# MR2500 Series

FIGURE 10 – RECTIFICATION WAVEFORM EFFICIENCY



## RECTIFICATION EFFICIENCY NOTE

FIGURE 11 – SINGLE-PHASE HALF-WAVE RECTIFIER CIRCUIT



The rectification efficiency factor  $\sigma$  shown in Figure 10 was calculated using the formula:

$$\sigma = \frac{P_{dc}}{P_{rms}} = \frac{\frac{V_O^2(dc)}{R_L}}{\frac{V_O^2(rms)}{R_L}} \cdot 100\% = \frac{V_O^2(dc)}{V_O^2(ac) + V_O^2(dc)} \cdot 100\% \quad (1)$$

For a sine wave input  $V_m \sin(\omega t)$  to the diode, assume lossless, the maximum theoretical efficiency factor becomes:

$$\sigma_{(sine)} = \frac{\frac{V_m^2}{4R_L}}{\frac{V_m^2}{2R_L}} \cdot 100\% = \frac{4}{\pi^2} \cdot 100\% = 40.6\% \quad (2)$$

For a square wave input of amplitude  $V_m$ , the efficiency factor becomes:

$$\sigma_{(square)} = \frac{\frac{V_m^2}{R_L}}{\frac{V_m^2}{2R_L}} \cdot 100\% = 50\% \quad (3)$$

(A full wave circuit has twice these efficiencies)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 9) becomes significant, resulting in an increasing ac voltage component across  $R_L$  which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor  $\sigma$ , as shown on Figure 10.

It should be emphasized that Figure 10 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of  $V_O$  with a true rms ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 10.

## ASSEMBLY AND SOLDERING INFORMATION

There are *two basic areas* of consideration for successful implementation of button rectifiers:

1. Mounting and Handling
2. Soldering

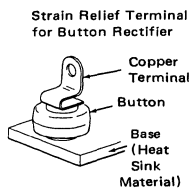
each should be carefully examined before attempting a finished assembly or mounting operation.

### MOUNTING AND HANDLING

The button rectifier lends itself to a multitude of assembly arrangements but one key consideration must *always* be included:

#### One Side of the Connections to the Button Must Be Flexible!

This stress relief to the button should also be chosen for maximum contact area to afford the best heat transfer — but not at the expense of flexibility. For an annealed copper terminal a thickness of 0.015" is suggested.



The base heat sink may be of various materials whose shape and size are a function of the individual application and the heat transfer requirements.

#### Common

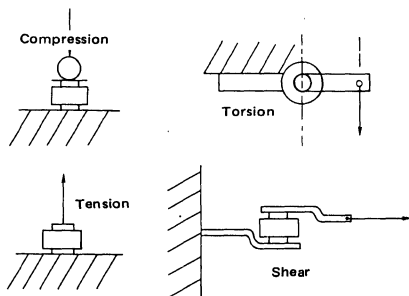
Materials	Advantages and Disadvantages	
Steel	Low Cost;	relatively low heat conductivity
Copper	High Cost;	high heat conductivity
Aluminum	Medium Cost;	medium heat conductivity
	Relatively expensive to plate and not all platers can process aluminum.	

Handling of the button during assembly must be relatively gentle to minimize sharp impact shocks and avoid nicking of the plastic. Improperly designed automatic handling equipment is the worst source of unnecessary shocks. Techniques for vacuum handling and spring loading should be investigated.

The mechanical stress limits for the button diode are as follows:

Compression	32 lbs.	142.3 Newton
Tension	32 lbs.	142.3 Newton
Torsion	6-inch lbs.	0.68 Newton-meters
Shear	55 lbs.	244.7 Newton

### MECHANICAL STRESS



Exceeding these recommended maximums can result in electrical degradation of the device.

### SOLDERING

The button rectifier is basically a semiconductor chip bonded between two nickel-plated copper heat sinks with an encapsulating material of thermal-setting silicone. The exposed metal areas are also tin plated to enhance solderability.

In the soldering process it is important that the temperature not exceed 250°C if device damage is to be avoided. Various solder alloys can be used for this operation but two types are recommended for best results:

1. 96.5% tin, 3.5% silver; Melting point is 221°C (this particular eutectic is used by Motorola for its button rectifier assemblies).
2. 63% tin, 37% lead; Melting point 183°C (eutectic).

Solder is available as preforms or paste. The paste contains both the metal and flux and can be dispensed rapidly. The solder preform requires the application of a flux to assure good wetting of the solder. The type of flux used depends upon the degree of cleaning to be accomplished and is a function of the metals involved. These fluxes range from a mild rosin to a strong acid; e.g., Nickel plating oxides are best removed by an acid base flux while an activated rosin flux may be sufficient for tin plated parts.

Since the button is relatively light-weight, there is a tendency for it to float when the solder becomes liquid. To prevent bad joints and misalignment it is suggested that a weighting or spring loaded fixture be employed. It is also important that severe thermal shock (either heating or cooling) be avoided as it may lead to damage of the die or encapsulant of the part.

Button holding fixtures for use during soldering may be of various materials. Stainless steel has a longer use life while black anodized aluminum is less expensive and will limit heat reflection and enhance absorption. The assembly volume will influence the choice of materials. Fixture dimension tolerances for locating the button must allow for expansion during soldering as well as allowing for button clearance.

### HEATING TECHNIQUES

The following four heating methods have their advantages and disadvantages depending on volume of buttons to be soldered.

1. **Belt Furnaces** readily handle large or small volumes and are adaptable to establishment of "on-line" assembly since a variable belt speed sets the run rate. Individual furnace zone controls make excellent temperature control possible.
2. **Flame Soldering** involves the directing of natural gas flame jets at the base of a heatsink as the heat-sink is indexed to various loading-heating-cooling-unloading positions. This is the most economical labor method of soldering large volumes. Flame soldering offers good temperature control but requires sophisticated temperature monitoring systems such as infrared.

## ASSEMBLY AND SOLDERING INFORMATION (continued)

3. **Ovens** are good for batch soldering and are production limited. There are handling problems because of slow cooling. Response time is load dependent, being a function of the watt rating of the oven and the mass of parts. Large ovens may not give an acceptable temperature gradient. Capital cost is low compared to belt furnaces and flame soldering.
4. **Hot Plates** are good for soldering small quantities of prototype devices. Temperature control is fair with overshoot common because of the exposed heating surface. Solder flow and positioning can be corrected during soldering since the assembly is exposed. Investment cost is very low.

Regardless of the heating method used, a soldering profile giving the time-temperature relationship of the particular method must be determined to assure proper soldering. Profiling must be performed on a scheduled basis to minimize poor soldering. The time-temperature relationship will change depending on the heating method used.

### SOLDER PROCESS EVALUATION

Characteristics to look for when setting up the soldering process:

- I **Overtemperature** is indicated by any one or all three of the following observations.
  1. Remelting of the solder inside the button rectifier shows the temperature has exceeded 285°C and is noted by "islands" of shiny solder and solder dewetting when a unit is broken apart.
  2. Cracked die inside the button may be observed by a moving reverse oscilloscope trace when pressure is applied to the unit.
  3. Cracked plastic may be caused by thermal shock as well as overtemperature so cooling rate should also be checked.
- II **Cold soldering** gives a grainy appearance and solder build-up without a smooth continuous solder fillet. The temperature must be adjusted until the proper solder fillet is obtained within the maximum temperature limits.
- III **Incomplete solder fillets** result from insufficient solder or parts not making proper contact.
- IV **Tilted buttons** can cause a void in the solder between the heatsink and button rectifier which will result in poor heat transfer during operation. An eight degree tilt is a suggested maximum value.
- V **Plating problems** require a knowledge of plating operations for complete understanding of observed deficiencies.

1. Peeling or plating separation is generally seen when a button is broken away for solder inspection. If heatsink or terminal base metal is present the plating is poor and must be corrected.
2. Thin plating allows the solder to penetrate through to the base metal and can give a poor connection. A suggested minimum plating thickness is 300 microinches.
3. Contaminated soldering surfaces may out-gas and cause non-wetting resulting in voids in the solder connection. The exact cause is not always readily apparent and can be because of:
  - (a) improper plating
  - (b) mishandling of parts
  - (c) improper and/or excessive storage time

### SOLDER PROCESS MONITORING

Continuous monitoring of the soldering process must be established to minimize potential problems. All parts used in the soldering operation should be sampled on a lot by lot basis by assembly of a controlled sample. Evaluate the control sample by break-apart tests to view the solder connections, by physical strength tests and by dimensional characteristics for part mating.

A shear test is a suggested way of testing the solder bond strength.

### POST SOLDERING OPERATION CONSIDERATIONS

After soldering, the completed assembly must be unloaded, washed and inspected.

**Unloading** must be done carefully to avoid unnecessary stress. Assembly fixtures should be cooled to room temperature so solder profiles are not affected.

**Washing** is mandatory if an acid flux is used because of its ionic and corrosive nature. Wash the assemblies in agitated hot water and detergent for three to five minutes. After washing; rinse, blow off excessive water and bake 30 minutes at 150°C to remove trapped moisture.

**Inspection** should be both electrical and physical. Any rejects can be reworked as required.

### SUMMARY

The Button Rectifier is an excellent building block for specialized applications. The prime example of its use is the output bridge of the automotive alternator where millions are used each year. Although the material presented here is not all inclusive, primary considerations for use are presented. For further information, contact the nearest Motorola Sales Office or franchised distributor.



## Complementary Medium Current Silicon Rectifiers

### For Linear Power Supply Applications

**MR4422CT**  
**MR4422CTR**

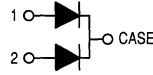
**POWER RECTIFIERS**  
**30 AMPERES**  
**100 VOLTS**

... using monolithic silicon technology for perfect matching of diodes in center tap configuration. These devices have the following features:

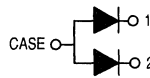
- Low Forward Voltage Drop
- Soft Reverse Recovery for Low Noise
- High Surge Current Capability
- 150°C Operating Junction Temperature
- Direct Replacement for Varo R711 and R711A

#### Mechanical Characteristics

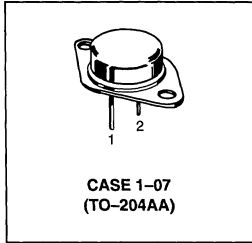
- Case: Welded Steel can, hermetically sealed
- Weight: 11 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 100 units per foam tray
- Marking: R4422T, R4422R



MR4422CT



MR4422CTR



#### MAXIMUM RATINGS (PER LEG)

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	100	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C = 125^\circ\text{C}$ Per Device	$I_{F(AV)}$	15 30	Amps
Peak Repetitive Forward Current, Per Diode Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 125^\circ\text{C}$	$I_{FRM}$	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	400	Amps
Peak Repetitive Reverse Surge Current (2.0 $\mu\text{s}$ , 1.0 kHz)	$I_{RRM}$	2.0	Amps
Operating Junction Temperature	$T_J$	-65 to +150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +175	$^\circ\text{C}$

#### THERMAL CHARACTERISTICS (PER LEG)

Thermal Resistance — Junction to Case	$R_{\theta JC}$	1.4	$^\circ\text{C/W}$
---------------------------------------	-----------------	-----	--------------------

#### ELECTRICAL CHARACTERISTICS (PER LEG)

Maximum Instantaneous Forward Voltage (1) ( $I_F = 15$ Amps, $T_C = 25^\circ\text{C}$ ) ( $I_F = 10$ Amps, $T_C = 125^\circ\text{C}$ )	$V_F$	1.2 1.1	Volts
Maximum Instantaneous Reverse Current (1) (Rated dc Voltage, $T_C = 25^\circ\text{C}$ ) (Rated dc Voltage, $T_C = 125^\circ\text{C}$ )	$I_R$	1.0 250	mA

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

Rev 1

## Advance Information

# Overtoltage Transient Suppressors

**MR2535L**  
**MR2535S**

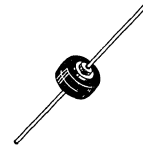
**MEDIUM CURRENT  
OVERTOLTAGE  
TRANSIENT  
SUPPRESSORS**

... designed for applications requiring a low voltage rectifier with reverse avalanche characteristics for use as reverse power transient suppressors. Developed to suppress transients in the automotive system, these devices operate in the forward mode as standard rectifiers or reverse mode as power avalanche rectifier and will protect electronic equipment from overvoltage conditions.

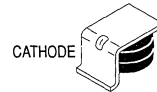
- Avalanche Voltage 24 to 32 Volts
- High Power Capability
- Economical
- Increased Capacity by Parallel Operation

### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 2.5 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: cathode polarity band
- MR2535L shipped 1000 units per plastic bag. Available Tape and Reeled, 800 units per reel by adding a "RL" suffix to the part number.
- MR2535S shipped pocket tape and reeled, 500 per 13" reel.
- Marking: MR2535L, MR2535S



CASE 194-04



CASE 421A-01

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	20	Volts
Repetitive Peak Reverse Surge Current (Time Constant = 10 ms, Duty Cycle $\leq$ 1%, $T_C = 25^\circ\text{C}$ ) (See Figure 1)	$I_{RSM}$	110	Amps
Average Rectified Forward Current (Single Phase, Resistive Load, 60 Hz, $T_C = 150^\circ\text{C}$ )	$I_O$	35	Amps
Non-Repetitive Peak Surge Current Surge Supplied at Rated Load Conditions Halfwave, Single Phase	$I_{FSM}$	600	Amps
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +175	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristic	Lead Length	Symbol	Max	Unit
Thermal Resistance, Junction to Lead @ Both Leads to Heat Sink, Equal Length	1/4"	$R_{\theta JL}$	7.5	$^\circ\text{C/W}$
	3/8"		10	
	1/2"		13	
Thermal Resistance Junction to Case		$R_{\theta JC}$	0.8*	$^\circ\text{C/W}$

\*Typical

This document contains information on a new product. Specifications and information herein are subject to change without notice.

Rev 2

# MR2535L, MR2535S

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Max	Unit
Instantaneous Forward Voltage (1) ( $I_F = 100$ Amps, $T_C = 25^\circ\text{C}$ )	$V_F$	—	1.1	Volts
Reverse Current ( $V_R = 20$ Vdc, $T_C = 25^\circ\text{C}$ )	$I_R$	—	200	nA dc
Breakdown Voltage (1) ( $I_R = 100$ mA dc, $T_C = 25^\circ\text{C}$ )	$V_{(BR)}$	24	32	Volts
Breakdown Voltage (1) ( $I_R = 90$ Amp, $T_C = 150^\circ\text{C}$ , $PW = 80 \mu\text{s}$ )	$V_{(BR)}$	—	40	Volts
Breakdown Voltage Temperature Coefficient	$V_{(BR)TC}$	—	0.096*	%/ $^\circ\text{C}$
Forward Voltage Temperature Coefficient @ $I_F = 10$ mA	$V_{FTC}$	—	2*	mV/ $^\circ\text{C}$

(1) Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .

\*Typical

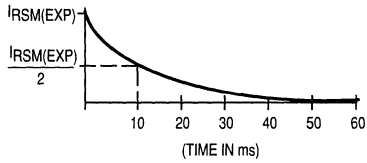


Figure 1. Surge Current Characteristics

## ***Section 6***

# **Tape and Reel/ Packaging Specifications**

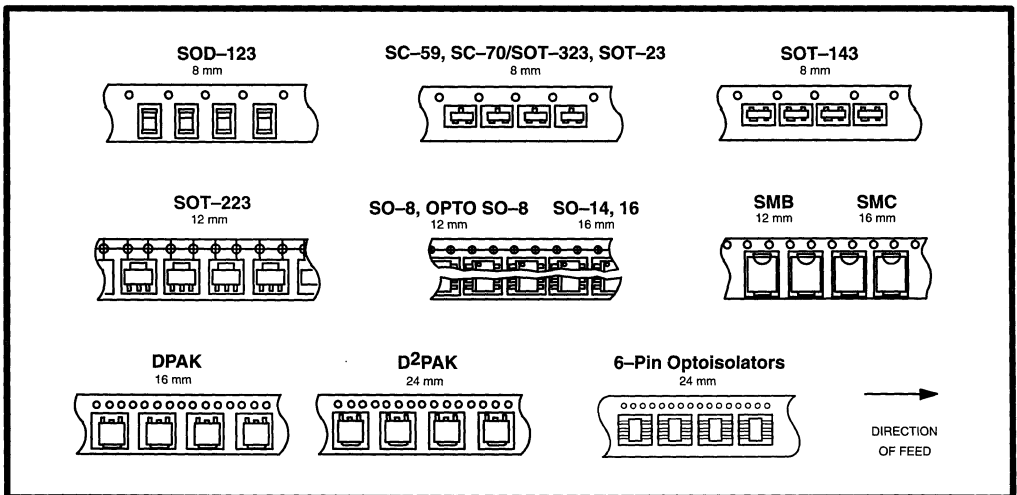
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# Tape and Reel Specifications and Packaging Specifications

Embossed Tape and Reel is used to facilitate automatic pick and place equipment feed requirements. The tape is used as the shipping container for various products and requires a minimum of handling. The antistatic/conductive tape provides a secure cavity for the product when sealed with the "peel-back" cover tape.

- Two Reel Sizes Available (7" and 13")
- Used for Automatic Pick and Place Feed Systems
- Minimizes Product Handling
- EIA 481, -1, -2
- SOD-123, SC-59, SC-70/SOT-323, SOT-23, SOT-143 in 8 mm Tape
- SO-8, OPTO SO-8, SOT-223, SMB in 12 mm Tape
- DPAK, SO-14, SO-16, SMC in 16 mm Tape
- D<sup>2</sup>PAK, 6-Pin Optoisolators in 24 mm Tape

Use the standard device title and add the required suffix as listed in the option table on the following page. Note that the individual reels have a finite number of devices depending on the type of product contained in the tape. Also note the minimum lot size is one full reel for each line item, and orders are required to be in increments of the single reel quantity.

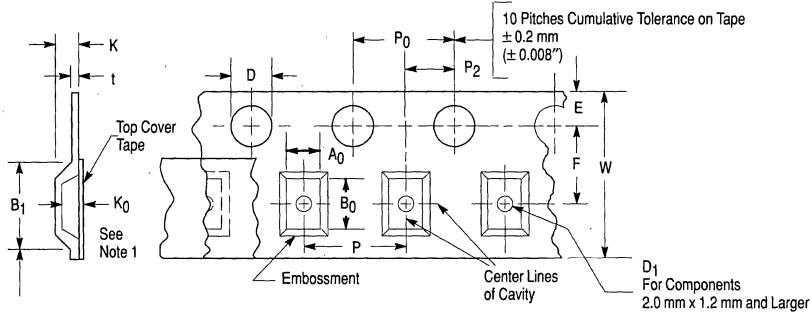


## EMBOSSED TAPE AND REEL ORDERING INFORMATION

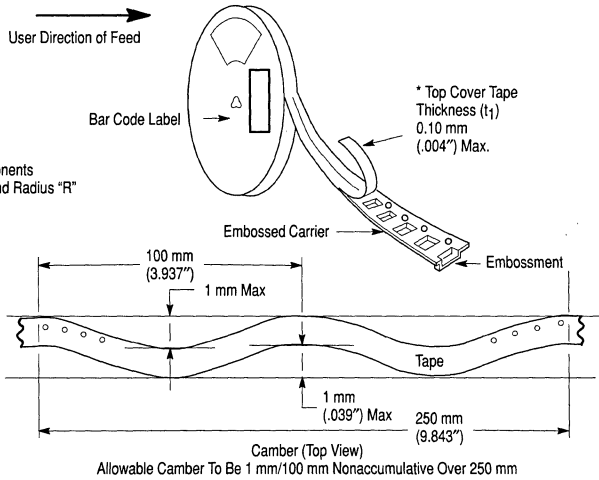
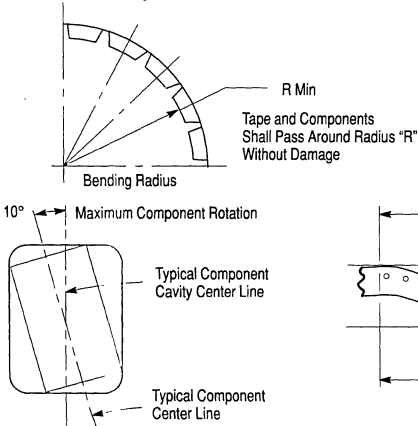
Package	Tape Width (mm)	Pitch mm (inch)	Reel Size mm (inch)	Devices Per Reel and Minimum Order Quantity	Device Suffix
DPAK	16	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T4
D <sup>2</sup> PAK	24	16.0 ± 0.1 (.630 ± .004)	330 (13)	800	T4
SC-59	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
SC-70/SOT-323	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)		10,000
SMB	12	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T3
SMC	16	8.0 ± 0.1 (.315 ± .004)	330 (13)	2,500	T3
SO-8, OPTO SO-8	12	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	12		330 (13)		2,500
SO-14	16	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	16		330 (13)		2,500
SO-16	16	8.0 ± 0.1 (.315 ± .004)	178 (7)	500	R1
	16		330 (13)		2,500
SOD-123	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)		10,000
SOT-23	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)		10,000
SOT-143	8	4.0 ± 0.1 (.157 ± .004)	178 (7)	3,000	T1
	8		330 (13)		10,000
SOT-223	12	8.0 ± 0.1 (.315 ± .004)	178 (7)	1,000	T1
	12		330 (13)		4,000
6-Pin Optoisolators	24	12.0 ± 0.1 (.472 ± .004)	330 (13)	1000	R2

# EMBOSSED TAPE AND REEL DATA FOR DISCRETES

## CARRIER TAPE SPECIFICATIONS



For Machine Reference Only  
Including Draft and RADII  
Concentric Around  $B_0$



### DIMENSIONS

Tape Size	$B_1$ Max	D	$D_1$	E	F	K	$P_0$	$P_2$	R Min	T Max	W Max
8 mm	4.55 mm (.179")	1.5 ± 0.1 mm -0.0 (.059 ± .004" -0.0)	1.0 Min (.039")	1.75 ± 0.1 mm (.069 ± .004")	3.5 ± 0.05 mm (.138 ± .002")	2.4 mm Max (.094")	4.0 ± 0.1 mm (.157 ± .004")	2.0 ± 0.1 mm (.079 ± .002")	25 mm (.98")	0.6 mm (.024")	8.3 mm (.327")
12 mm	8.2 mm (.323")		1.5 mm Min (.060")		5.5 ± 0.05 mm (.217 ± .002")	6.4 mm Max (.252")			30 mm (1.18")		12 ± .30 mm (.470 ± .012")
16 mm	12.1 mm (.476")				7.5 ± 0.10 mm (.295 ± .004")	7.9 mm Max (.311")					16.3 mm (.642")
24 mm	20.1 mm (.791")				11.5 ± 0.1 mm (.453 ± .004")	11.9 mm Max (.468")					24.3 mm (.957")

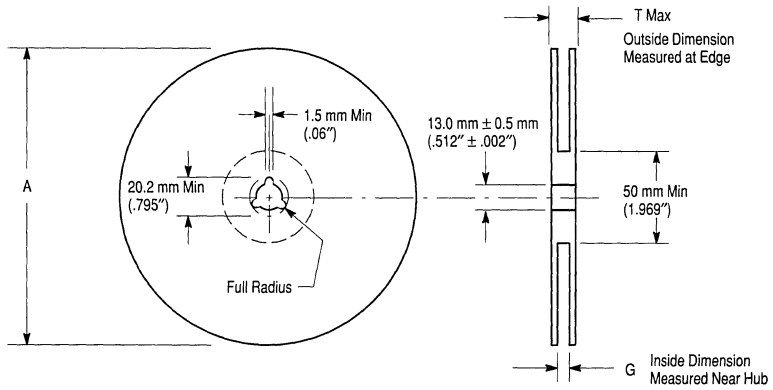
Metric dimensions govern — English are in parentheses for reference only.

NOTE 1:  $A_0$ ,  $B_0$ , and  $K_0$  are determined by component size. The clearance between the components and the cavity must be within .05 mm min. to .50 mm max., the component cannot rotate more than 10° within the determined cavity.

NOTE 2: If  $B_1$  exceeds 4.2 mm (.165) for 8 mm embossed tape, the tape may not feed through all tape feeders.

NOTE 3: Pitch information is contained in the Embossed Tape and Reel Ordering Information on pg. 6-3.

## EMBOSSED TAPE AND REEL DATA FOR DISCRETES



Size	A Max	G	T Max
8 mm	330 mm (12.992")	8.4 mm + 1.5 mm, -0.0 (.33" + .059", -0.00)	14.4 mm (.56")
12 mm	330 mm (12.992")	12.4 mm + 2.0 mm, -0.0 (.49" + .079", -0.00)	18.4 mm (.72")
16 mm	360 mm (14.173")	16.4 mm + 2.0 mm, -0.0 (.646" + .078", -0.00)	22.4 mm (.882")
24 mm	360 mm (14.173")	24.4 mm + 2.0 mm, -0.0 (.961" + .070", -0.00)	30.4 mm (1.197")

### Reel Dimensions

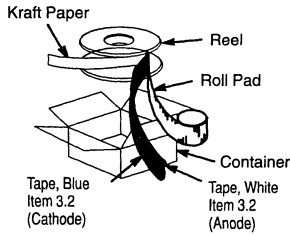
Metric Dimensions Govern — English are in parentheses for reference only



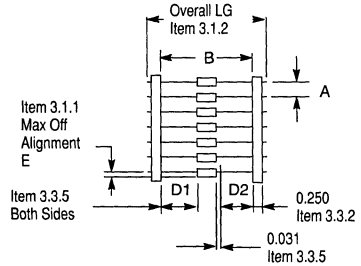
## LEAD TAPE PACKAGING STANDARDS FOR AXIAL-LEAD COMPONENTS

Case Type	Product Category	Device Title Suffix	MPQ Quantity Per Reel (Item 3.3.7)	Component Spacing A Dimension	Tape Spacing B Dimension	Reel Dimension C	Reel Dimension D (Max)	Max Off Alignment E
Case 17-02	Surmetic 40 & 600 Watt TVS	RL	4000	0.2 +/- 0.015	2.062 +/- 0.059	3	14	0.047
Case 41A-02	1500 Watt TVS	RL4	1500	0.4 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 51-02	DO-7 Glass (For Reference only)	RL	3000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 59-03	DO-41 Glass & DO-41 Surmetic 30	RL	6000	0.2 +/- 0.015	2.062 +/- 0.059	3	14	0.047
	Rectifier							
Case 59-04	500 Watt TVS	RL	5000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047
	Rectifier							
Case 194-04	110 Amp TVS (Automotive)	RL	800	0.4 +/- 0.02	1.875 +/- 0.059	3	14	0.047
	Rectifier							
Case 267-02	Rectifier	RL	1500	0.4 +/- 0.02	2.062 +/- 0.059	3	14	0.047
Case 299-02	DO-35 Glass	RL	5000	0.2 +/- 0.02	2.062 +/- 0.059	3	14	0.047

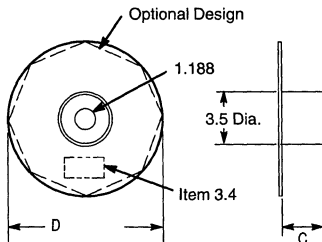
**Table 1. Packaging Details (all dimensions in inches)**



**Figure 1. Reel Packing**



**Figure 2. Component Spacing**



**Figure 3. Reel Dimensions**

## ***Section 7***

# **Surface Mount Information**

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## INFORMATION FOR USING SURFACE MOUNT PACKAGES

### RECOMMENDED FOOTPRINTS FOR SURFACE MOUNTED APPLICATIONS

Surface mount board layout is a critical portion of the total design. The footprint for the semiconductor packages must be the correct size to ensure proper solder connection interface between the board and the package. With the correct pad

geometry, the packages will self align when subjected to a solder reflow process.

#### POWER DISSIPATION FOR A SURFACE MOUNT DEVICE

The power dissipation for a surface mount device is a function of the drain/collector pad size. These can vary from the minimum pad size for soldering to a pad size given for maximum power dissipation. Power dissipation for a surface mount device is determined by  $T_{J(max)}$ , the maximum rated junction temperature of the die,  $R_{\theta JA}$ , the thermal resistance from the device junction to ambient, and the operating temperature,  $T_A$ . Using the values provided on the data sheet,  $P_D$  can be calculated as follows:

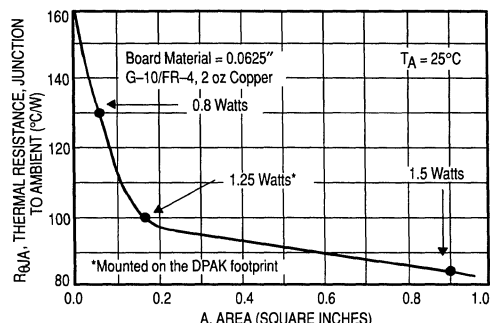
$$P_D = \frac{T_{J(max)} - T_A}{R_{\theta JA}}$$

The values for the equation are found in the maximum ratings table on the data sheet. Substituting these values into the equation for an ambient temperature  $T_A$  of 25°C, one can calculate the power dissipation of the device. For example, for a SOT-223 device,  $P_D$  is calculated as follows.

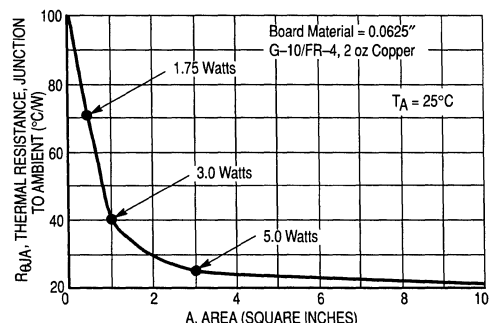
$$P_D = \frac{150^{\circ}\text{C} - 25^{\circ}\text{C}}{156^{\circ}\text{C/W}} = 800 \text{ milliwatts}$$

The 156°C/W for the SOT-223 package assumes the use of the recommended footprint on a glass epoxy printed circuit board to achieve a power dissipation of 800 milliwatts. There are other alternatives to achieving higher power dissipation from the surface mount packages. One is to increase the area of the drain/collector pad. By increasing the area of the drain/collector pad, the power dissipation can be increased. Although the power dissipation can almost be doubled with this method, area is taken up on the printed circuit board which can defeat the purpose of using surface mount technology. For example, a graph of  $R_{\theta JA}$  versus drain pad area is shown in Figures 1, 2 and 3.

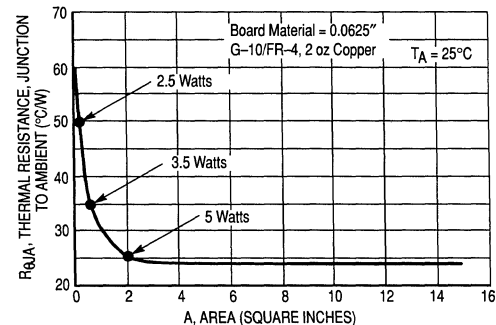
Another alternative would be to use a ceramic substrate or an aluminum core board such as Thermal Clad™. Using a board material such as Thermal Clad, an aluminum core board, the power dissipation can be doubled using the same footprint.



**Figure 1. Thermal Resistance versus Drain Pad Area for the SOT-223 Package (Typical)**



**Figure 2. Thermal Resistance versus Drain Pad Area for the DPAK Package (Typical)**



**Figure 3. Thermal Resistance versus Drain Pad Area for the D2PAK Package (Typical)**

## SOLDER STENCIL GUIDELINES

Prior to placing surface mount components onto a printed circuit board, solder paste must be applied to the pads. Solder stencils are used to screen the optimum amount. These stencils are typically 0.008 inches thick and may be made of brass or stainless steel. For packages such as the SC-59, SC-70/SOT-323, SOD-123, SOT-23, SOT-143, SOT-223, SO-8, SO-14, SO-16, and SMB/SMC diode packages, the stencil opening should be the same as the pad size or a 1:1 registration. This is not the case with the DPAK and D<sup>2</sup>PAK packages. If a 1:1 opening is used to screen solder onto the drain pad, misalignment and/or "tombstoning" may occur due to an excess of solder. For these two packages, the opening in the stencil for the paste should be approximately 50% of the tab area. The opening for the leads is still a 1:1 registration. Figure 4 shows a typical stencil for the DPAK and D<sup>2</sup>PAK packages. The pattern of the opening in the stencil for the

drain pad is not critical as long as it allows approximately 50% of the pad to be covered with paste.

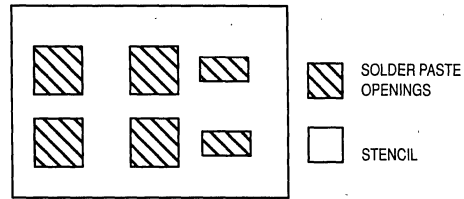


Figure 4. Typical Stencil for DPAK and D<sup>2</sup>PAK Packages

## SOLDERING PRECAUTIONS

The melting temperature of solder is higher than the rated temperature of the device. When the entire device is heated to a high temperature, failure to complete soldering within a short time could result in device failure. Therefore, the following items should always be observed in order to minimize the thermal stress to which the devices are subjected.

- Always preheat the device.
  - The delta temperature between the preheat and soldering should be 100°C or less.\*
  - When preheating and soldering, the temperature of the leads and the case must not exceed the maximum temperature ratings as shown on the data sheet. When using infrared heating with the reflow soldering method, the difference should be a maximum of 10°C.
  - The soldering temperature and time should not exceed 260°C for more than 10 seconds.
  - When shifting from preheating to soldering, the maximum temperature gradient shall be 5°C or less.
- After soldering has been completed, the device should be allowed to cool naturally for at least three minutes. Gradual cooling should be used since the use of forced cooling will increase the temperature gradient and will result in latent failure due to mechanical stress.
  - Mechanical stress or shock should not be applied during cooling.
- \* Soldering a device without preheating can cause excessive thermal shock and stress which can result in damage to the device.
- \* Due to shadowing and the inability to set the wave height to incorporate other surface mount components, the D<sup>2</sup>PAK is not recommended for wave soldering.

## TYPICAL SOLDER HEATING PROFILE

For any given circuit board, there will be a group of control settings that will give the desired heat pattern. The operator must set temperatures for several heating zones and a figure for belt speed. Taken together, these control settings make up a heating "profile" for that particular circuit board. On machines controlled by a computer, the computer remembers these profiles from one operating session to the next. Figure 5 shows a typical heating profile for use when soldering a surface mount device to a printed circuit board. This profile will vary among soldering systems, but it is a good starting point. Factors that can affect the profile include the type of soldering system in use, density and types of components on the board, type of solder used, and the type of board or substrate material being used. This profile shows temperature versus time. The line on the graph shows the actual temperature that might be

experienced on the surface of a test board at or near a central solder joint. The two profiles are based on a high density and a low density board. The Vitronics SMD310 convection/infrared reflow soldering system was used to generate this profile. The type of solder used was 62/36/2 Tin Lead Silver with a melting point between 177–189°C. When this type of furnace is used for solder reflow work, the circuit boards and solder joints tend to heat first. The components on the board are then heated by conduction. The circuit board, because it has a large surface area, absorbs the thermal energy more efficiently, then distributes this energy to the components. Because of this effect, the main body of a component may be up to 30 degrees cooler than the adjacent solder joints.

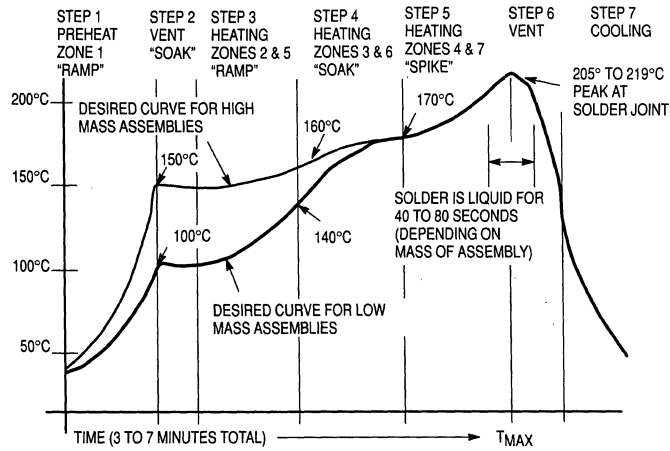
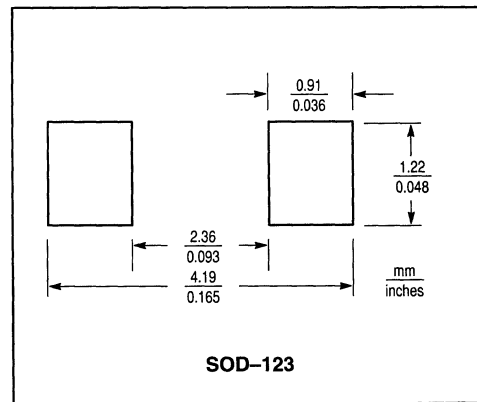
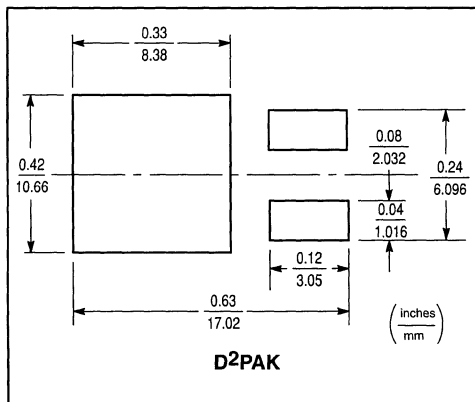
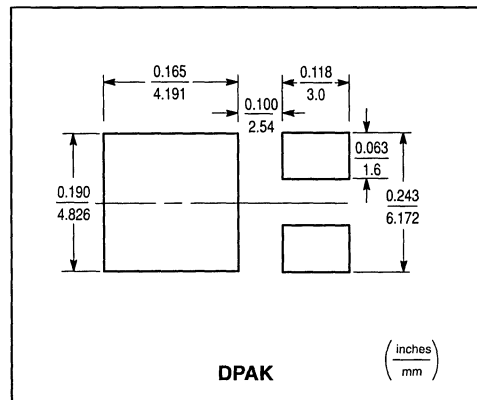
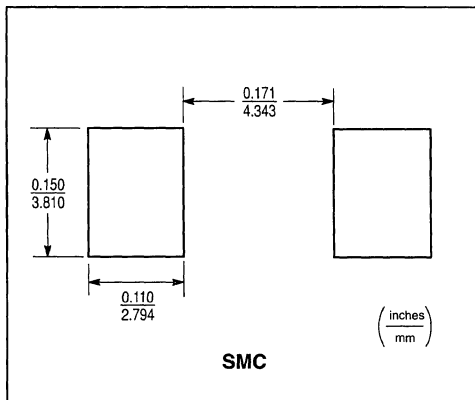
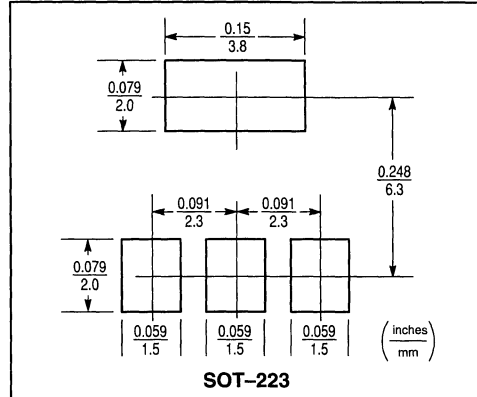
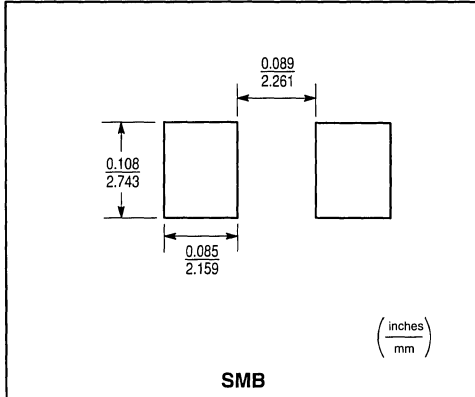


Figure 5. Typical Solder Heating Profile

# Footprints for Soldering





***Section 8***

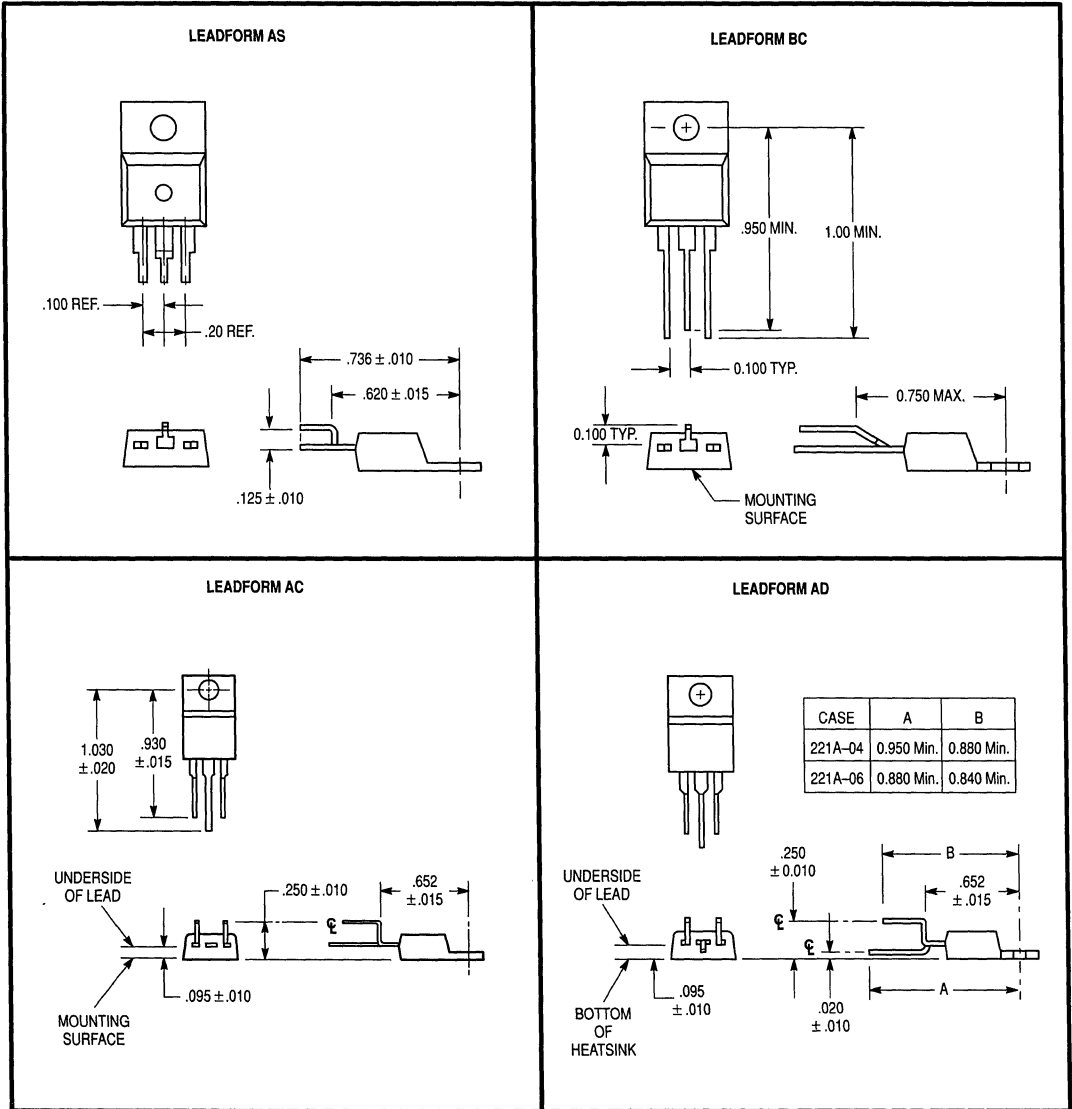
**TO-220 Leadform Information**

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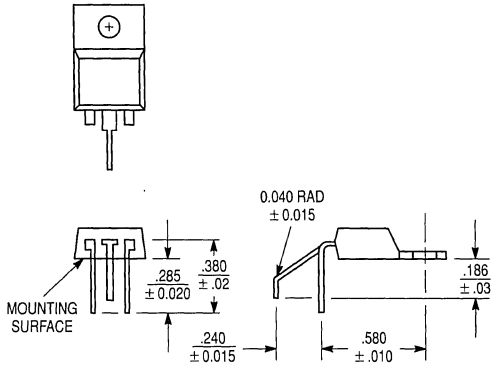
# Leadform Options — TO-220 (Case 221A)

- Leadform options require assignment of a special part number before ordering.
- Contact your local Motorola representative for special part number and pricing.
- 10,000 piece minimum quantity orders are required.
- Leadform orders are non-cancellable after processing.
- Leadforms apply to both Motorola Case 221A-04 and 221A-06 except as noted.

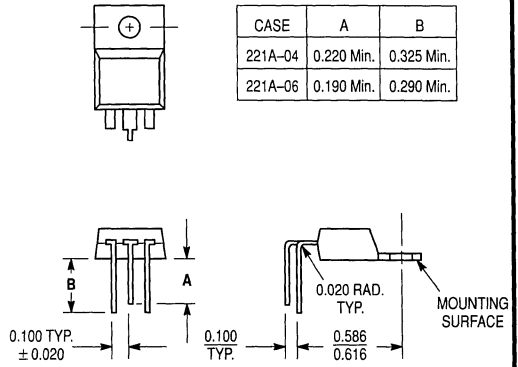


# TO-220 Leadform Options (continued)

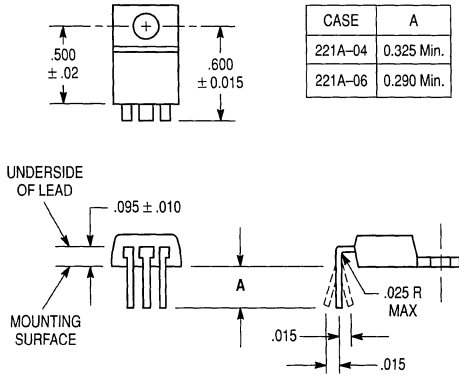
LEADFORM AN



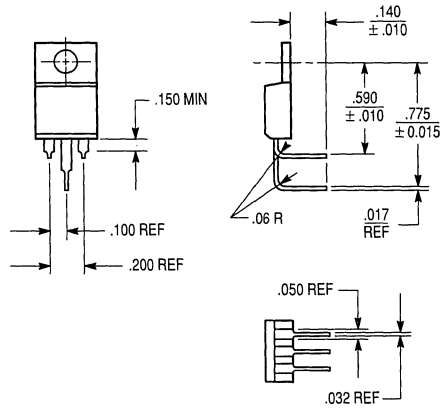
LEADFORM BA



LEADFORM BL

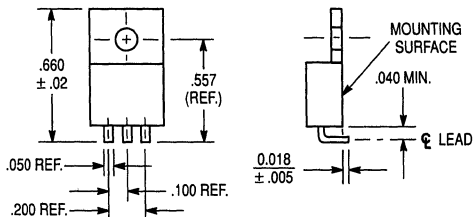


LEADFORM AK

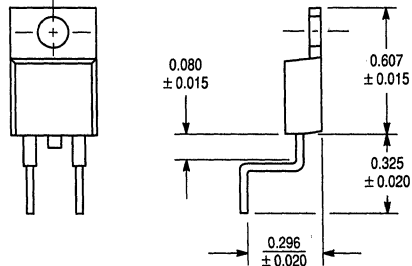


# TO-220 Leadform Options (continued)

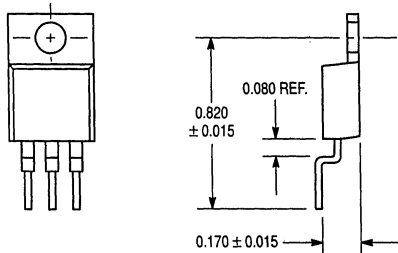
LEADFORM AF



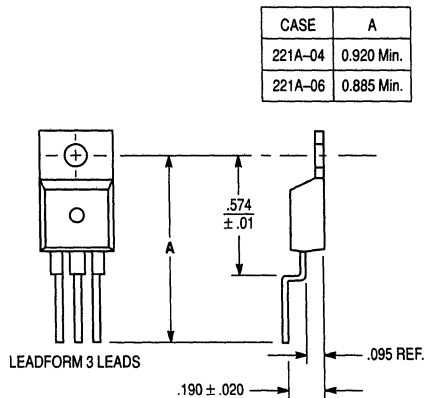
LEADFORM BS



LEADFORM BR

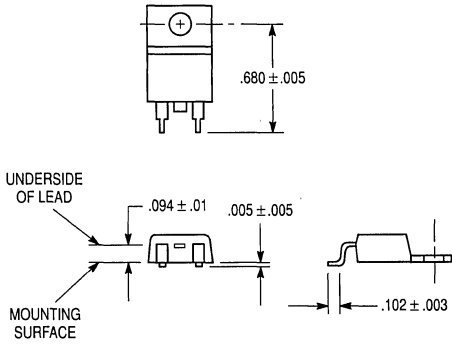


LEADFORM AU

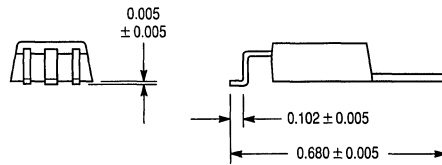


# TO-220 Leadform Options (continued)

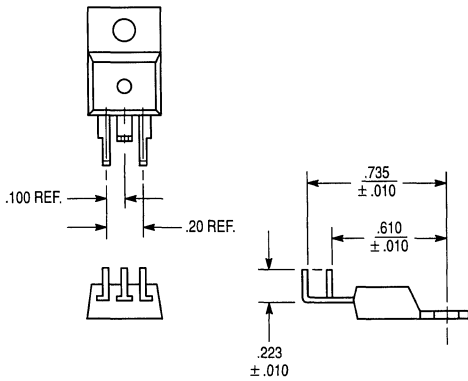
LEADFORM BU



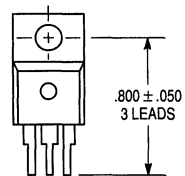
LEADFORM BV



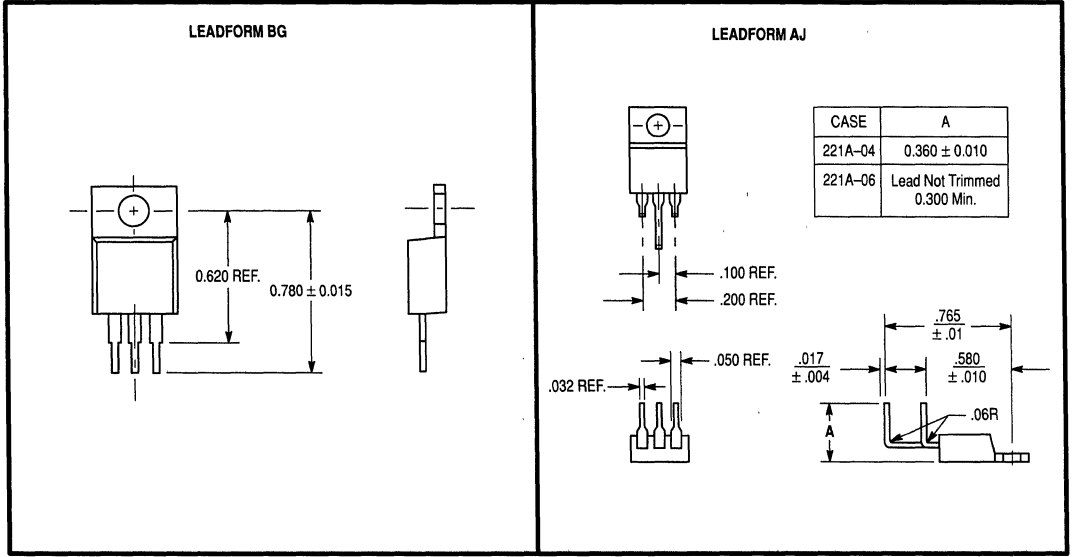
LEADFORM BD



LEADFORM DW



# TO-220 Leadform Options (continued)

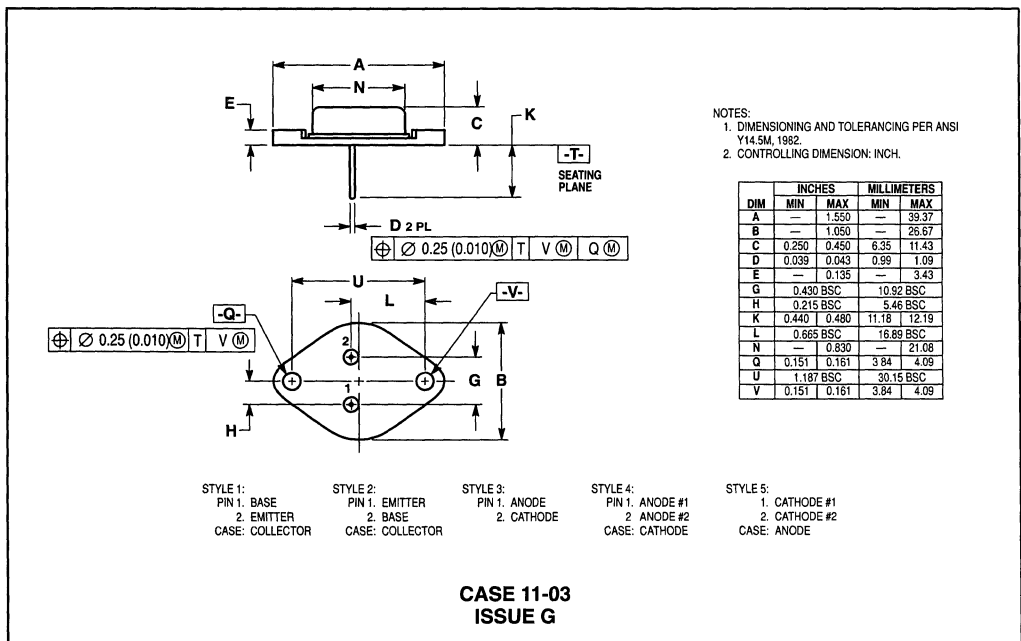
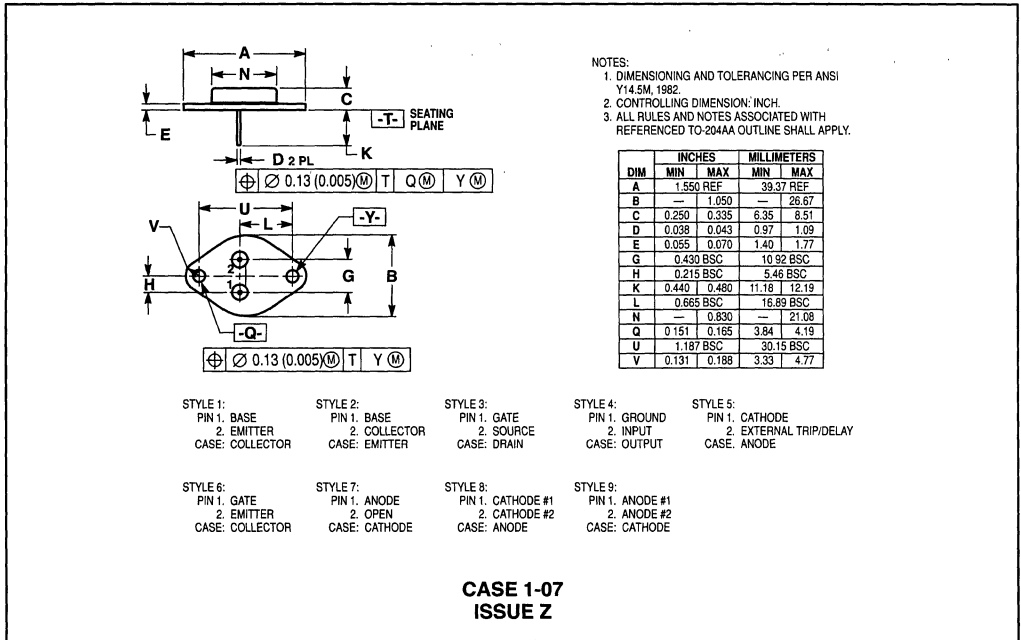


## ***Section 9***

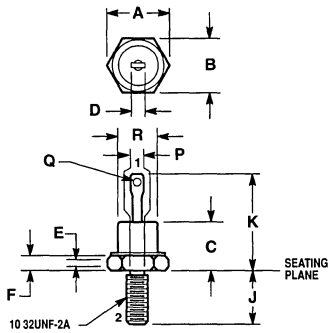
# **Package Outline Dimensions and Footprints**

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# Package Outline Dimensions and Footprints



**PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)**



- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

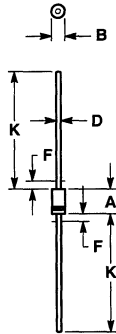
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.505	—	12.82
B	0.424	0.437	10.77	11.09
C	—	0.405	—	10.28
D	—	0.250	—	6.35
E	0.060	—	1.53	—
F	0.075	0.175	1.91	4.44
J	0.422	0.453	10.72	11.50
K	0.800	0.800	15.24	20.32
P	0.153	0.169	4.14	4.80
Q	0.060	0.095	1.53	2.41
R	0.265	0.424	6.74	10.76

STYLE 1:  
 TERM. 1. CATHODE  
 2. ANODE

STYLE 2:  
 TERM. 1. ANODE  
 2. CATHODE

STYLE 3:  
 TERM. 1. ANODE  
 2. ANODE

**CASE 56-03  
 (DO-4)  
 ISSUE G**



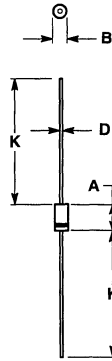
- NOTES:  
 1. POLARITY DENOTED BY CATHODE BAND.  
 2. LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.07	5.20	0.160	0.205
B	2.04	2.71	0.080	0.107
D	0.71	0.86	0.028	0.034
F	—	1.27	—	0.050
K	27.94	—	1.100	—

**CASE 59-03  
 (DO-41)  
 ISSUE M**



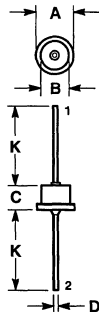
PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



- NOTES:  
 1. POLARITY DENOTED BY CATHODE BAND.  
 2. LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.97	6.60	0.235	0.260
B	2.79	3.05	0.110	0.120
D	0.76	0.86	0.030	0.034
K	27.94	—	1.100	—

**CASE 59-04  
 (DO-41)  
 ISSUE M**



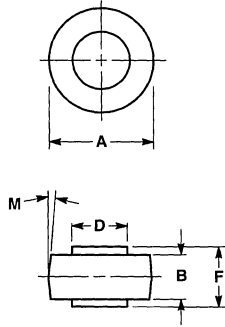
- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.450	—	11.43
B	—	0.350	—	8.89
C	—	0.300	—	7.62
D	0.046	0.056	1.17	1.42
K	0.980	—	24.90	—

- STYLE 1:  
 PIN 1, CATHODE  
 2, ANODE
- STYLE 2:  
 PIN 1, ANODE  
 2, CATHODE

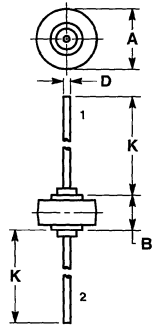
**CASE 60-01  
 ISSUE E**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.43	8.69	0.332	0.342
B	4.19	4.45	0.165	0.175
D	5.54	5.64	0.218	0.222
F	5.94	6.25	0.234	0.246
M	5° NOM		5° NOM	

CASE 193-04  
ISSUE J



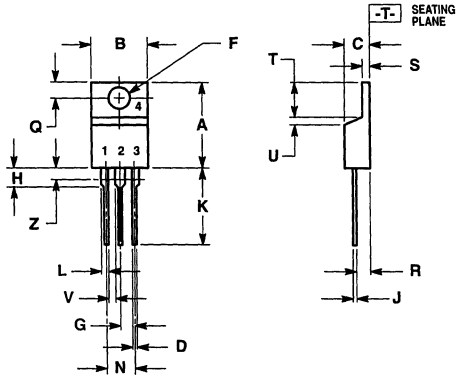
NOTES:  
1. CATHODE SYMBOL ON PACKAGE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.43	8.69	0.332	0.342
B	5.94	6.25	0.234	0.246
D	1.27	1.35	0.050	0.053
K	25.15	25.65	0.990	1.010

STYLE 1:  
PIN 1. CATHODE  
2. ANODE

CASE 194-04  
ISSUE F

**PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)**



- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.  
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.090	0.050	0.00	1.27
V	0.045	—	1.15	—
Z	—	0.080	—	2.04

- STYLE 1:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER  
 4. COLLECTOR

- STYLE 2:  
 PIN 1. BASE  
 2. EMITTER  
 3. COLLECTOR  
 4. EMITTER

- STYLE 3:  
 PIN 1. CATHODE  
 2. ANODE  
 3. GATE  
 4. ANODE

- STYLE 4:  
 PIN 1. MAIN TERMINAL 1  
 2. MAIN TERMINAL 2  
 3. GATE  
 4. MAIN TERMINAL 2

- STYLE 5:  
 PIN 1. GATE  
 2. DRAIN  
 3. SOURCE  
 4. DRAIN

- STYLE 6:  
 PIN 1. ANODE  
 2. CATHODE  
 3. ANODE  
 4. CATHODE

- STYLE 7:  
 PIN 1. CATHODE  
 2. ANODE  
 3. CATHODE  
 4. ANODE

- STYLE 8:  
 PIN 1. CATHODE  
 2. ANODE  
 3. EXTERNAL TRIP/DELAY  
 4. ANODE

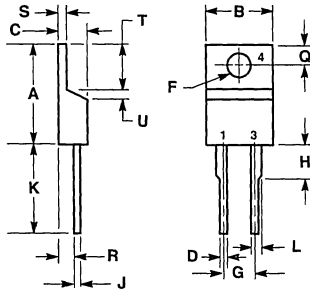
- STYLE 9:  
 PIN 1. GATE  
 2. COLLECTOR  
 3. EMITTER  
 4. COLLECTOR

- STYLE 10:  
 PIN 1. GATE  
 2. SOURCE  
 3. DRAIN  
 4. SOURCE

- STYLE 11:  
 PIN 1. DRAIN  
 2. SOURCE  
 3. GATE  
 4. SOURCE

**CASE 221A-06  
 (TO-220AB)  
 ISSUE Y**

**PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)**



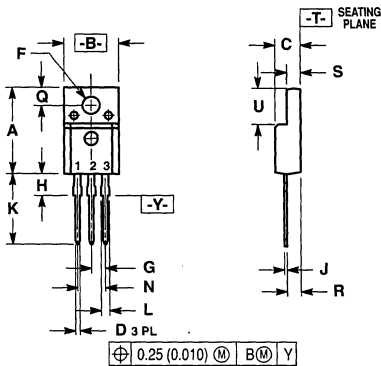
NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.595	0.620	15.11	15.75
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.82
D	0.025	0.025	0.64	0.64
F	0.142	0.147	3.61	3.73
G	0.190	0.210	4.83	5.33
H	0.110	0.130	2.79	3.30
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.14	1.39
T	0.235	0.255	5.97	6.48
U	0.000	0.050	0.00	1.27

STYLE 1:  
 PIN 1. CATHODE  
 2. N/A  
 3. ANODE  
 4. CATHODE

STYLE 2:  
 PIN 1. ANODE  
 2. N/A  
 3. CATHODE  
 4. ANODE

**CASE 221B-03  
 ISSUE B**



NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.621	0.629	15.78	15.97
B	0.394	0.402	10.01	10.21
C	0.181	0.189	4.60	4.80
D	0.020	0.034	0.67	0.86
F	0.121	0.129	3.03	3.27
G	0.100 BSC		2.54 BSC	
H	0.123	0.129	3.13	3.27
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
N	0.200 BSC		5.08 BSC	
Q	0.126	0.134	3.21	3.40
R	0.107	0.111	2.72	2.81
S	0.096	0.104	2.44	2.64
U	0.259	0.267	6.59	6.78

STYLE 1: PIN 1. GATE  
 2. DRAIN  
 3. SOURCE

STYLE 2: PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER

STYLE 3: PIN 1. ANODE  
 2. CATHODE  
 3. ANODE

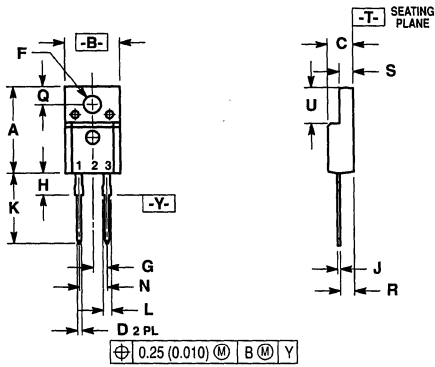
STYLE 4: PIN 1. CATHODE  
 2. ANODE  
 3. CATHODE

STYLE 5: PIN 1. CATHODE  
 2. ANODE  
 3. GATE

STYLE 6: PIN 1. MT 1  
 2. MT 2  
 3. GATE

**CASE 221D-02  
 ISSUE D**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)

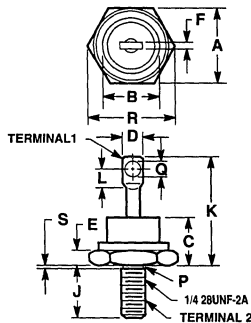


- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.621	0.629	15.78	15.97
B	0.394	0.402	10.01	10.21
C	0.181	0.189	4.60	4.80
D	0.026	0.034	0.67	0.86
F	0.121	0.129	3.08	3.27
G	0.100 BSC		2.54 BSC	
H	0.123	0.129	3.13	3.27
J	0.018	0.025	0.46	0.64
K	0.500	0.582	12.70	14.27
L	0.045	0.060	1.14	1.52
N	0.200 BSC		5.08 BSC	
Q	0.126	0.134	3.21	3.40
R	0.107	0.111	2.72	2.81
S	0.096	0.104	2.44	2.64
U	0.259	0.267	6.58	6.78

- STYLE 1:  
 PIN 1: CATHODE  
 2. N/A  
 3. ANODE

CASE 221E-01  
 ISSUE O



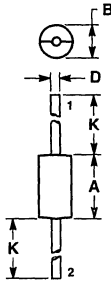
- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. DIMENSION P IS A DIAMETER.  
 3. CHAMFER OR UNDERCUT ON ONE OR BOTH ENDS OF HEXAGONAL BASE IS OPTIONAL.  
 4. ANGULAR ORIENTATION AND CONTOUR OF TERMINAL ONE IS OPTIONAL.  
 5. THREADS ARE PLATED.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	16.94	17.45	0.669	0.687
B	—	16.94	—	0.667
C	—	11.43	—	0.450
D	—	9.53	—	0.375
E	2.92	5.08	0.115	0.200
F	—	2.03	—	0.080
J	10.72	11.51	0.422	0.453
K	—	25.40	—	1.000
L	3.86	—	0.156	—
P	5.59	6.32	0.220	0.249
Q	3.56	4.45	0.140	0.175
R	—	20.16	—	0.794
S	—	2.26	—	0.089

- STYLE 1:  
 TERMINAL 1. CATHODE  
 2. ANODE (CASE)
- STYLE 2:  
 TERMINAL 1. ANODE  
 2. CATHODE (CASE)

CASE 257-01  
 ISSUE B

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)

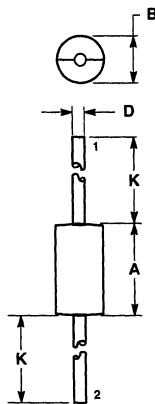


- NOTES:  
 1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	—	0.370	—	9.39
B	—	0.250	—	6.35
D	0.048	0.052	1.22	1.32
K	1.000	—	25.40	—

STYLE 1:  
 PIN 1. CATHODE  
 2. ANODE

**CASE 267-02  
 ISSUE B**



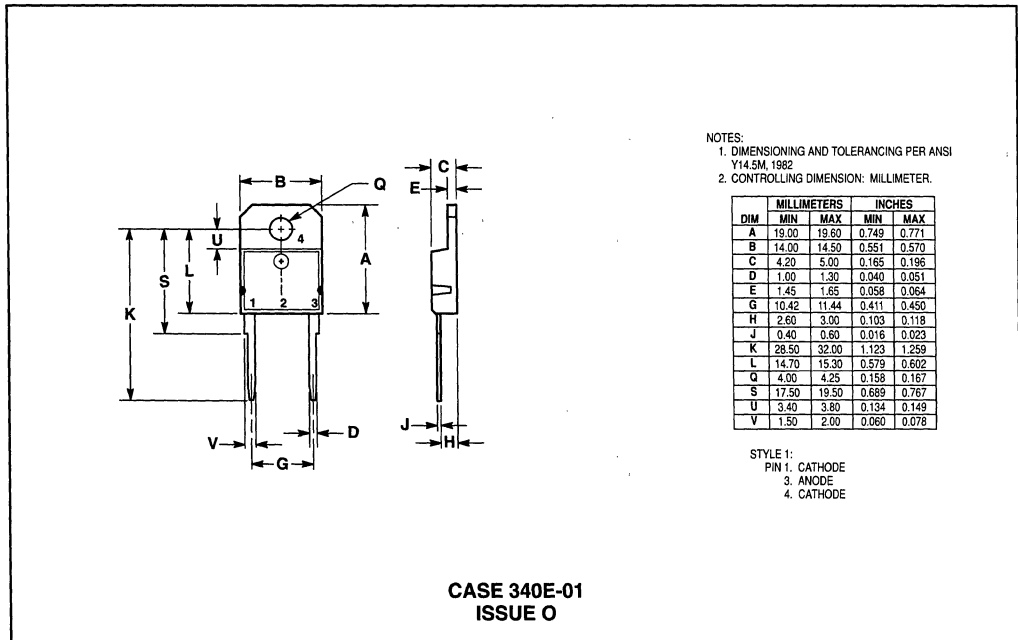
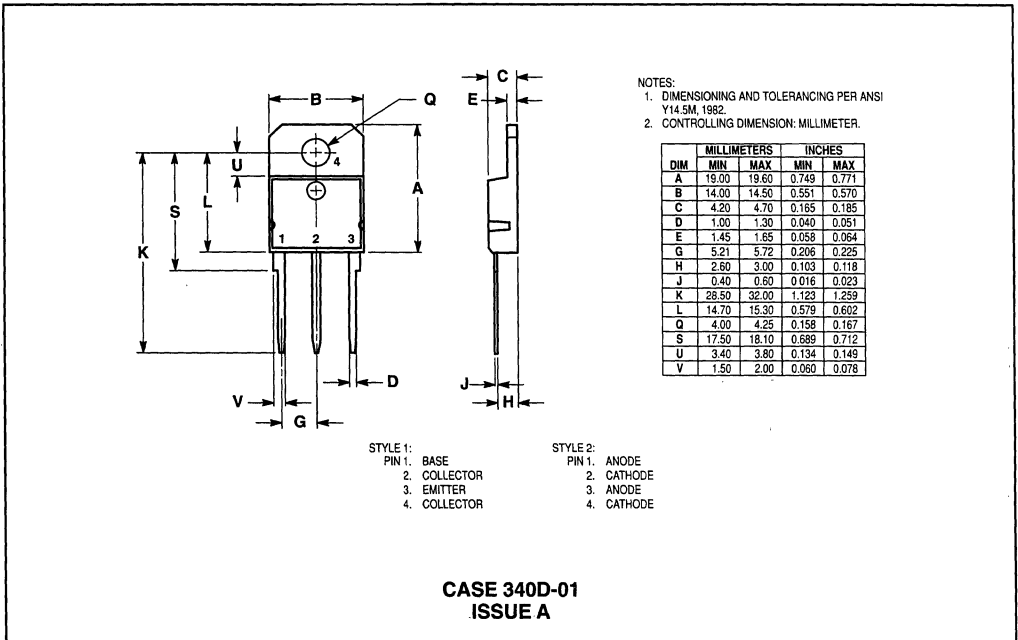
- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.370	0.380	9.40	9.65
B	0.190	0.210	4.83	5.33
D	0.048	0.052	1.22	1.32
K	1.000	—	25.40	—

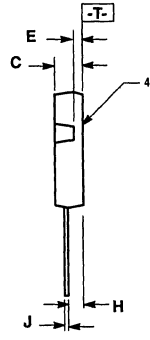
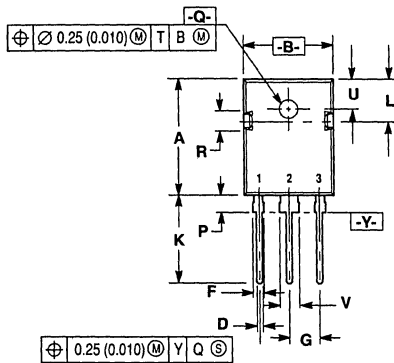
STYLE 1:  
 PIN 1. CATHODE  
 2. ANODE

**CASE 267-03  
 ISSUE C**

**PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)**



**PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)**



NOTES:  
 4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 5. CONTROLLING DIMENSION: MILLIMETER.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	20.40	20.90	0.803	0.823
B	15.44	15.95	0.608	0.628
C	4.70	5.21	0.185	0.205
D	1.09	1.30	0.043	0.051
E	1.50	1.63	0.059	0.064
F	1.80	2.18	0.071	0.086
G	5.45 BSC		0.215 BSC	
H	2.56	2.87	0.101	0.113
J	0.48	0.68	0.019	0.027
K	15.57	16.08	0.613	0.633
L	7.26	7.50	0.286	0.295
P	3.10	3.38	0.122	0.133
Q	3.50	3.70	0.138	0.145
R	3.30	3.80	0.130	0.150
U	5.30 BSC		0.209 BSC	
V	3.05	3.40	0.120	0.134

- |             |                |              |              |
|-------------|----------------|--------------|--------------|
| STYLE 1:    | STYLE 2:       | STYLE 3:     | STYLE 4:     |
| PIN 1. GATE | PIN 1. ANODE 1 | PIN 1. BASE  | PIN 1. GATE  |
| 2. DRAIN    | 2. CATHODE(S)  | 2. COLLECTOR | 2. COLLECTOR |
| 3. SOURCE   | 3. ANODE 2     | 3. EMITTER   | 3. EMITTER   |
| 4. DRAIN    | 4. CATHODE(S)  | 4. COLLECTOR | 4. COLLECTOR |

**CASE 340F-03  
 ISSUE E**

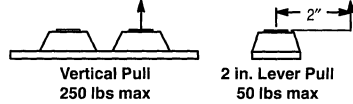


**PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)**

**MAXIMUM MECHANICAL RATINGS**

Terminal Penetration:	0.235 max
Terminal Torque:	25-40 in-lb max
Mounting Torque — Outside Holes:	30-40 in-lb max
Mounting Torque — Center Hole:	8-10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

**POWERTAP MECHANICAL DATA  
APPLIES OVER OPERATING TEMPERATURE**



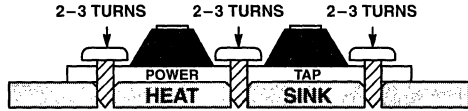
Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

**MOUNTING PROCEDURE**

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

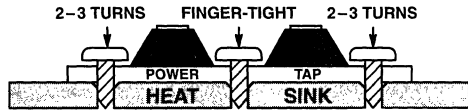
**STEP 1:**

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).



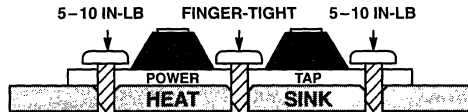
**STEP 2:**

Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.



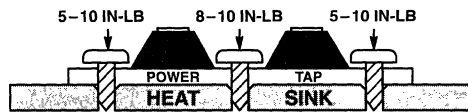
**STEP 3:**

Tighten each of the end bolts between 5 to 10 in-lb.



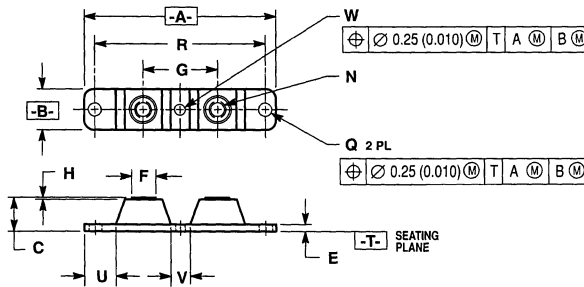
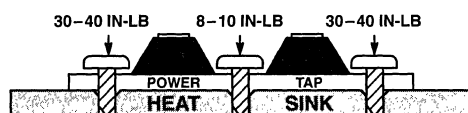
**STEP 4:**

Tighten the center bolt between 8 to 10 in-lb.



**STEP 5:**

Finally, tighten the end bolts between 30 to 40 in-lb.

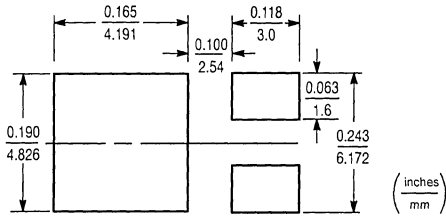


- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.  
 3. TERMINAL PENETRATION: 5.97 (0.235) MAXIMUM.

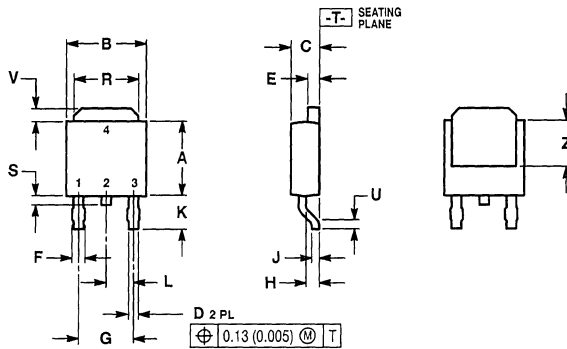
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	3.450	3.635	87.63	92.33
B	0.700	0.810	17.78	20.57
C	0.615	0.640	15.53	16.26
E	0.120	0.130	3.05	3.30
F	0.435	0.445	11.05	11.30
G	1.370	1.380	34.80	35.05
H	0.007	0.030	0.18	0.76
N	14-20UNC 2B	14-20UNC 2B		
Q	0.270	0.285	6.86	7.32
R	31.50 BSC	31.50 BSC		
U	0.600	0.630	15.24	16.00
V	0.330	0.375	8.39	9.52
W	0.170	0.190	4.32	4.82

**CASE 357C-03  
ISSUE C**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



**DPAK  
FOOTPRINT**



- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.235	0.250	5.97	6.35
B	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.180 BSC		4.58 BSC	
H	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090 BSC		2.29 BSC	
R	0.175	0.215	4.45	5.46
S	0.020	0.050	0.51	1.27
U	0.020	—	0.51	—
V	0.030	0.050	0.77	1.27
Z	0.138	—	3.51	—

- STYLE 1:  
 PIN 1. BASE  
 2. COLLECTOR  
 3. EMITTER  
 4. COLLECTOR

- STYLE 2:  
 PIN 1. GATE  
 2. DRAIN  
 3. SOURCE  
 4. DRAIN

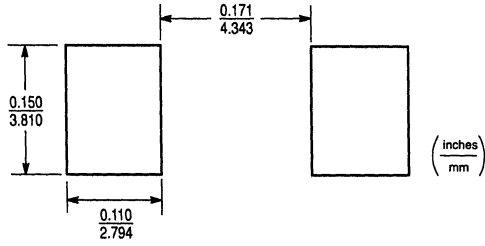
- STYLE 3:  
 PIN 1. ANODE  
 2. N/A  
 3. ANODE  
 4. CATHODE

- STYLE 4:  
 PIN 1. CATHODE  
 2. ANODE  
 3. GATE  
 4. ANODE

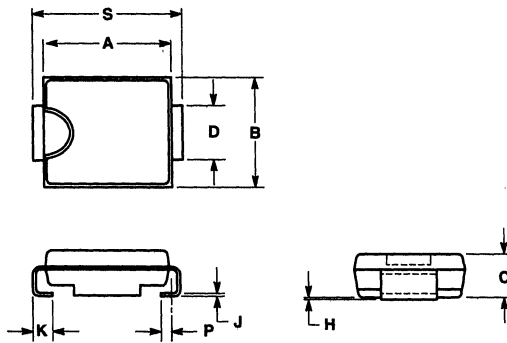
- STYLE 5:  
 PIN 1. GATE  
 2. ANODE  
 3. CATHODE  
 4. ANODE

**CASE 369A-13  
(DPAK)  
ISSUE W**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



SMC  
FOOTPRINT

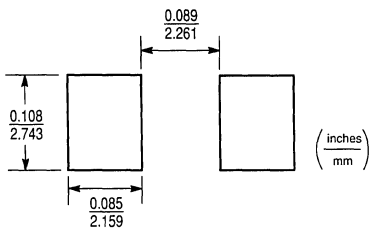


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

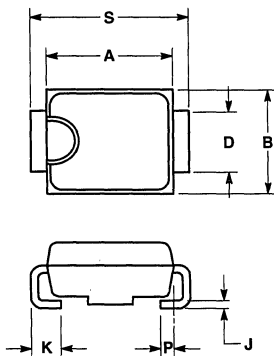
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.260	0.280	6.60	7.11
B	0.220	0.240	5.59	6.10
C	0.075	0.085	1.90	2.41
D	0.115	0.121	2.92	3.07
H	0.0020	0.0060	0.051	0.152
J	0.006	0.012	0.15	0.30
K	0.030	0.050	0.76	1.27
P	0.020	REF	0.51	REF
S	0.305	0.320	7.75	8.13

CASE 403-03  
(SMC)  
ISSUE B

**PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)**



**SMB  
FOOTPRINT**

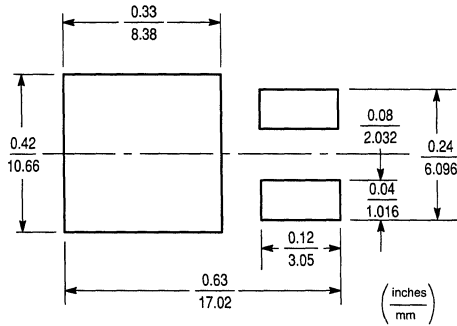


- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1992.  
 2. CONTROLLING DIMENSION: INCH.  
 3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

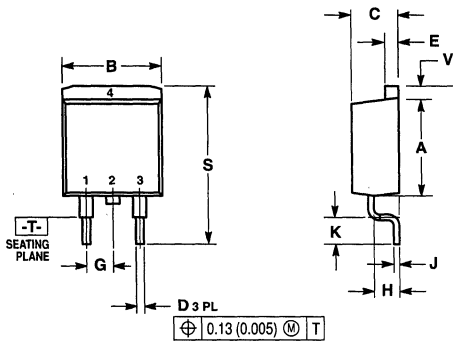
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.160	0.180	4.06	4.57
B	0.130	0.150	3.30	3.81
C	0.075	0.095	1.90	2.41
D	0.077	0.083	1.96	2.11
H	0.0020	0.0060	0.051	0.152
J	0.006	0.012	0.15	0.30
K	0.030	0.050	0.76	1.27
P	0.020 REF		0.51 REF	
S	0.205	0.220	5.21	5.59

**CASE 403A-03  
(SMB)  
ISSUE B**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



**D<sup>2</sup>PAK  
FOOTPRINT**



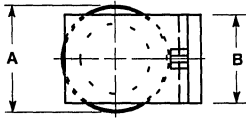
NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.340	0.380	8.64	9.65
B	0.380	0.405	9.65	10.29
C	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
G	0.100 BSC		2.54 BSC	
H	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
K	0.090	0.110	2.29	2.79
S	0.575	0.625	14.60	15.88
V	0.045	0.055	1.14	1.40

- |   |  |  |
|---|--|--|
| STYLE 1:<br>PIN 1. BASE<br>2. COLLECTOR<br>3. EMITTER<br>4. COLLECTOR | STYLE 2:<br>PIN 1. GATE<br>2. DRAIN<br>3. SOURCE<br>4. DRAIN | STYLE 3:<br>PIN 1. ANODE<br>2. N/A<br>3. ANODE<br>4. CATHODE |
|---|--|--|

**CASE 418B-02  
D<sup>2</sup>PAK  
ISSUE B**

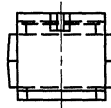
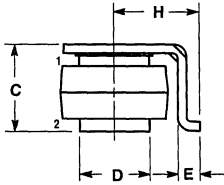
**PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)**



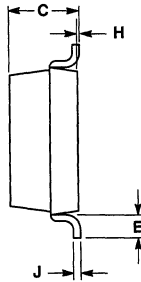
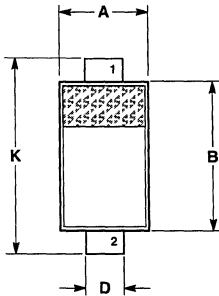
- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.330	0.342	8.38	8.69
B	0.270	0.090	6.86	7.37
C	0.275	0.290	6.99	7.37
D	0.218	0.223	5.54	5.66
E	0.060	0.060	1.52	2.03
H	0.255	0.275	6.48	6.98

- STYLE 1:  
 PIN 1: CATHODE  
 2: ANODE



**CASE 421A-01  
 ISSUE O**



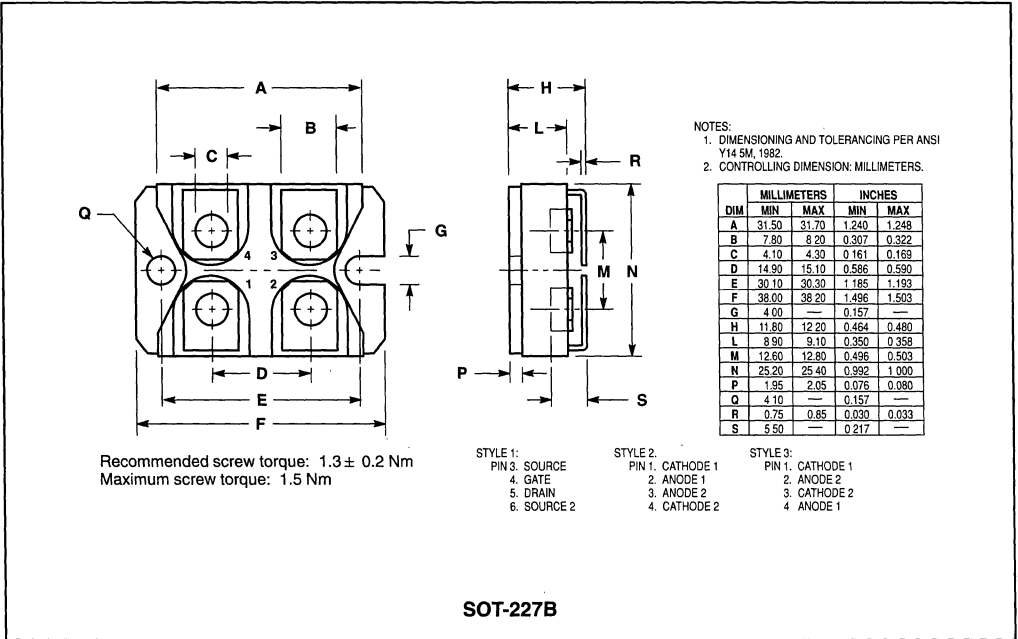
- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.055	0.071	1.40	1.80
B	0.100	0.112	2.55	2.85
C	0.037	0.053	0.95	1.35
D	0.020	0.028	0.50	0.70
E	0.010	—	0.25	—
H	0.000	0.004	0.00	0.10
J	—	0.006	—	0.15
K	0.140	0.152	3.55	3.85

- STYLE 1:  
 PIN 1: CATHODE  
 2: ANODE

**CASE 425-04  
 (SOD-123)  
 ISSUE C**

PACKAGE OUTLINE DIMENSIONS AND FOOTPRINTS (continued)



## ***Section 10***

# **AR598: Avalanche Capability of Today's Power Semiconductors**

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# AVALANCHE CAPABILITY OF TODAY'S POWER SEMICONDUCTORS

R Borrás, P Aloisi, D Shumate\*  
 MOTOROLA Semiconductors, France, USA\*  
 Paper published at the EPE Conference '93, Brighton 9/93.

**Abstract.** Power semiconductors are used to switch high currents in fractions of a second and therefore belong inherently to a world of voltage spikes. To avoid unnecessary breakdown voltage guardbands, new generations of semiconductors are now avalanche rugged and characterized in avalanche energy.

This characterization is often far from application conditions and thus quite useless to the designer. It is easy to verify that an energy rating is not the best approach to a ruggedness quantification because of avalanche energy fluctuations with test conditions.

A physical and thermal analysis of the failure mechanisms leads to a new characterization method generating easy-to-use data for safe designs. The short-term avalanche capability will be discussed with an insight of the different technologies developed to meet these new ruggedness requirements.

**Keywords.** Avalanche, breakdown, unclamped inductive switching energy, safe operating areas.

## INTRODUCTION

One obvious trend for new power electronic designs is to work at very high switching frequencies in order to reduce the volume and weight of all the capacitive and inductive elements. The consequence is that most applications today require switching very high currents in fractions of a microsecond and therefore generate  $L \times di/dt$  voltage spikes due to parasitic inductance. Unfortunately these undesirable voltage levels sometimes reach the breakdown voltage of power semiconductors that are not intended to be used in avalanche.

The necessity for avalanche rugged power semiconductors has clearly been perceived by many semiconductor manufacturers who have come up with avalanche-energy rated devices.

This paper will show the limits of an energy-based characterization model. It will concentrate on three different devices: Ultra Fast recovery Rectifiers, Schottky Barrier Rectifiers and MOSFETs. It will study their main failure mechanisms and show the technological improvements that guarantee an enhanced ruggedness.

This will lead to a new characterization that will help the designer choose correctly between overall cost and reliability.

## LIMITS OF AN AVALANCHE ENERGY CHARACTERIZATION

Practically all the characterizations are based on the following Unclamped Inductive Switching (UIS) test circuit (fig 1) :

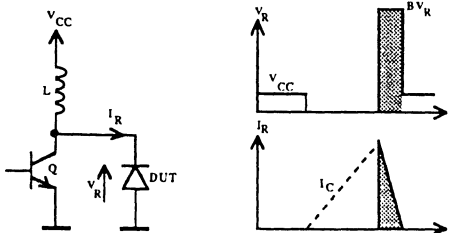


Figure 1. Standard UIS Characterization Circuit.

The energy is first stored in inductor L by turning on transistor Q for a period of time proportional to the peak current desired in the inductor. When Q is turned off, the inductor reverses its voltage and avalanches the Device Under Test until all its energy is transferred. The DUT can be a rectifier or a MOSFET (the gate should always be shorted to the source).

The standard characterization method consists in increasing the peak current in the inductor until the device fails. The energy that the device can sustain without failing becomes a figure of merit of the ruggedness to avalanche :

$$W_{aval} = 1/2 L I_{peak}^2 BV(DUT) / (BV(DUT) - V_{CC}) \quad [1]$$

The main limit of this method is that the energy level that causes a failure in the DUT is not a constant but a function of L and Vcc. This results of the fact that the avalanche duration is function of the current decay slope  $(BV(DUT)-V_{CC})/L$  :

**Table 1. Peak Current and Energy Causing Failures in a 1A, 1000V Ultra Fast Recovery Rectifier.**

Inductor Value :	10mH	50mH	100mH
Peak Current :	1.7A	0.9A	0.8A
Energy :	14mJ	20mJ	32mJ

Table 1 indicates that the failure is not caused by an energy (i.e. it is not independent of the avalanche duration) but rather by a current level that has to be derated versus time : the devices can sustain a low current for a long period of time (high energy) but at high avalanche currents they will fail after a few microseconds (low energy).

Therefore, unless the designer has a parasitic inductance of value L in his circuit, the standard characterization data will be useless, or worse, it might lead to an overestimate of the ruggedness of his application : because parasitic inductances are often an order of magnitude less than the test circuit inductance, the expected energy capability leads to excessive current levels.

The UIS test circuit is very easy to implement : the only important point is that the transistor has to have a breakdown voltage higher than the DUT. For low breakdown voltage devices, a MOSFET might be preferred to the bipolar transistor.

The advantages of using a MOSFET are multiple : it is a more rugged device, it is much easier to drive and its switching characteristics can be controlled by adding a resistor in series with the gate. It is mandatory to limit this switching speed to avoid having an avalanche energy measurement dependent on the gate drive (i.e. gate resistor and gate to source voltage values).

Anyhow, it is possible to generate very useful information with this UIS test circuit by varying the inductor value. It is also very important to present the data independently of the values of Vcc and L. One solution can be to plot the maximum peak current versus the avalanche duration (fig 2) :

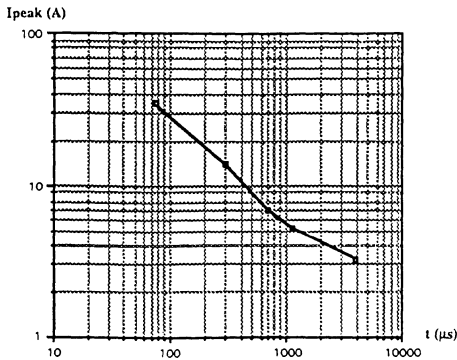


Figure 2. Maximum Peak Current versus Avalanche Duration for a 15A, 60V MOSFET in an UIS Test Circuit.

The advantage of this new graph is that the designer can easily calculate the safety margin of his application and he will not be misled by an energy value that depends on too many different parameters. If he knows the value of the parasitic inductance in his circuit he will be able to determine its maximum peak current.

For instance, let us assume that the designer uses the 15A, 60V MOSFET characterized in figure 2. This device sustains 500mJ with an inductor of 75mH according to equation [1]. Its typical breakdown voltage is 80V.

If the supply voltage V<sub>DD</sub> is 12V and the parasitic inductance L is 250μH, then the avalanche duration and maximum peak current are related by

$$I_{peak} = t (BV_{DSS} - V_{DD}) / L \quad [2]$$

This relationship can be added to figure 2 (see fig 3) :

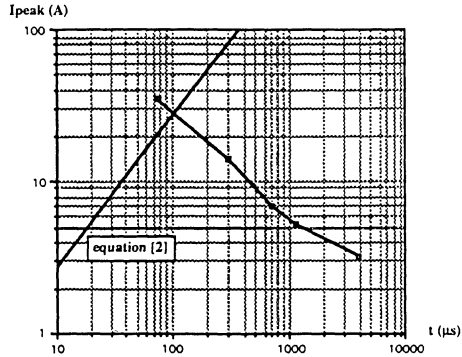


Figure 3. figure 2 + equation [2].

Thus the maximum peak current that can flow through the parasitic inductance L is approximately 28A instead of 58A that would have resulted of using equation [1].

## UNDERSTANDING THE FAILURE MECHANISMS

### Physical Approach

The following microscope photographs show the failure locations for an Ultra Fast Recovery Rectifier (UFR), a Schottky Barrier Rectifier (SBR) and a MOSFET :



Figure 4. 4A, 1000V UFR Avalanche Failure.

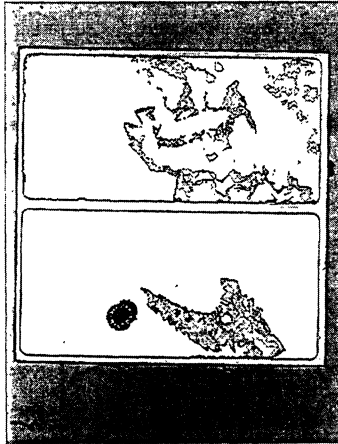


Figure 5. 25A, 35V SBR Avalanche Failure.

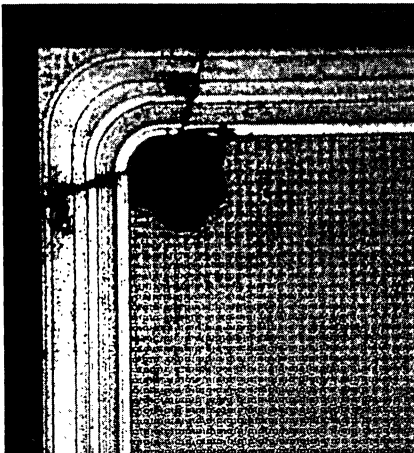


Figure 6. 20A, 500V MOSFET Avalanche Failure.

These photographs show that the failure is generally a punchthrough. The melt-through hole dimensions depend on the current level and avalanche duration.

A close look at the electrical characteristics of failed rectifiers on a curve tracer show three levels of degradation : low stressed diodes have a normal forward characteristic but show an unusual leakage current before entering breakdown as if they had a high-value resistor in parallel : this resistance can be explained by a small punchthrough. For medium degradation levels, the value of this pseudo-resistance decreases

and becomes visible in the forward characteristic of the diode. Finally, when the punchthrough reaches considerable dimensions, the device looks very similar to a low value resistor.

The failure does not always appear in the same region of the die. For instance, high voltage UFRs have their punch-through always located in a corner, MOSFETs often fail in the corners or on the sides whereas SBRs have randomly located failures.

### Thermal Approach

Transient thermal response graphs generated by a standard  $\Delta V_{DS}$  method show the junction temperature evolution for forward and avalanche constant current conduction in a MOSFET. These graphs (fig 7) prove that the silicon efficiency during avalanche and forward currents are similar.

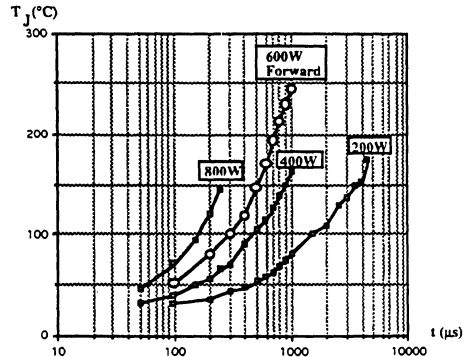


Figure 7. 15A, 60V MOSFET Transient Thermal Response for 800W, 400W, 200W Avalanche and 600W Forward Conduction.

Figure 7 can be used to generate a transient thermal resistance graph by plotting the temperature divided by the power : the four graphs should then normally match. Some slight differences show that the transient thermal resistance increases with the current level : i.e. the 800W curve (10A constant avalanche current) has a higher transient thermal resistance than the 200W (2.5A). Therefore the thermal efficiency in a MOSFET is not perfectly homogeneous versus the avalanche current.

A similar analysis on an UFR or an SBR shows poor thermal efficiency in avalanche. This can be shown by comparing the temperature rise after 1ms for forward and avalanche conduction pulses of same power (400W) :

MOSFET	$\Delta T_{direct}=160^{\circ}\text{C}$	$\Delta T_{avalanche}=180^{\circ}\text{C}$	ratio=0.9
UFR	$\Delta T_{direct}=120^{\circ}\text{C}$	$\Delta T_{avalanche}=175^{\circ}\text{C}$	ratio=0.7
SBR	$\Delta T_{direct}=100^{\circ}\text{C}$	$\Delta T_{avalanche}=150^{\circ}\text{C}$	ratio=0.7

### Electrical Approach

Considering the transient thermal responses of a device, it is possible to simulate the instantaneous junction temperature for any sort of power pulse.

Conducting this simulation on the data generated by the UIS test it is possible to show that all the parts fail when they reach a "critical temperature" (fig 8) :

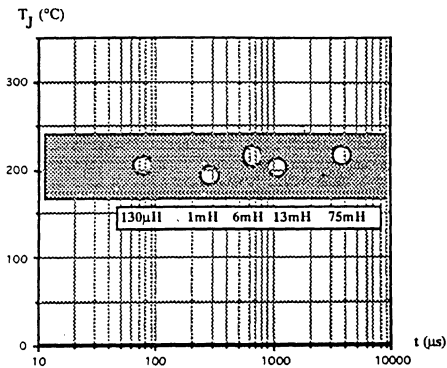


Figure 8. 15A, 60V MOSFET Failure Points and Critical Temperature for different Inductor Values.

At these critical temperatures the intrinsic carrier concentration,  $n_i$ , reaches levels close to those of the doping concentrations :

$$n_i \text{ is proportional to } T^{3/2} e^{-E_g / 2kT} \quad [3]$$

where  $T$  is the absolute temperature,  $E_g$  the energy bandgap and  $k$  is Boltzmann's constant.

At 200°C,  $n_i$  exceeds  $2 \cdot 10^{14} \text{ cm}^{-3}$  which corresponds to a 1000V material epitaxy concentration level. This means that when the junction temperature reaches 300°C, the rectifier looks more like a resistor than a diode. A local thermal runaway then generates a hot spot and a punchthrough as can be seen in figures 4, 5 and 6.

This failure analysis has shown that the failure mechanism is essentially thermal : the devices are heated by the  $BV_R \times I_R$  power dissipation. Unfortunately, this power does not remain constant because the UIS circuit generates a linear current decay and also the breakdown voltage varies with the current level and with the junction temperature.

In order to have a complete characterization of the device it is interesting to see how it reacts to a constant avalanche current and different ambient temperatures.

### NEW CHARACTERIZATION METHOD PROPOSAL

During the prototype phase, it is easier for the designer to measure the avalanche current and duration than the circuit's parasitic inductance. Therefore, the characterization should be based on easy to measure parameters. The failure analysis proves that the main cause of degradation is the inability to handle an excessive power (avalanche current  $I_R$  multiplied by breakdown voltage  $BV_R$ ). A proper characterization should present the maximum power capability versus time.

As the avalanche voltage varies only slightly with the current level, the proposed method is based on avalanching a

device at a constant current and presenting the maximum current capability versus time :

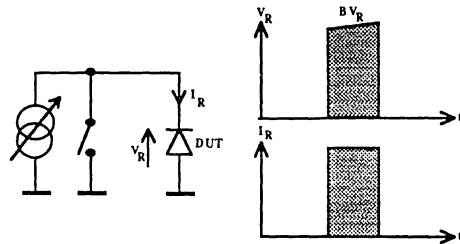


Figure 9. Constant Current Characterization Circuit.

Different test circuits similar to figure 9 have been proposed by Gauen (1) and Pshaenich (2). Some unexpected failures in MOSFETs suggest that the DUT should always be referenced to ground. Unlike UFRs and SBRs, MOSFETs react differently whether they are tied to ground or floating around a fluctuating voltage. Many floating transistors fail at very low stress levels probably due to capacitive coupled currents that turn-on the internal parasitic transistor.

The test circuit shown in figure 9 sets a constant avalanche current through the device until it fails, this duration can then be plotted for different current levels. This generates a graph similar to the UIS method, except that the current is constant instead of decreasing linearly.

This leads to the definition of a "Safe Avalanche Area" (fig 10) that will guarantee a short-term reliability if the device is used within this clearly defined area.

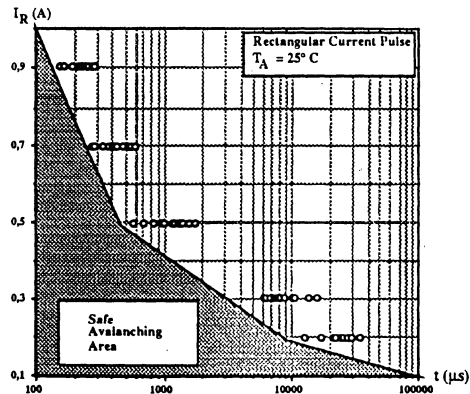


Figure 10. 1A, 30V SBR Safe Avalanche Area.

This graph gives the maximum avalanche duration for any value of avalanche current.

The Safe Avalanche Area is generated by taking a safety margin from the failure points. Another approach would be to dynamically measure the temperature as in figure 7 and generate an area defined by a maximum allowable junction temperature.

As the failure mechanism is related to a peak junction temperature, it is necessary to give Safe Avalanche Areas for different ambient temperatures (fig 11) :

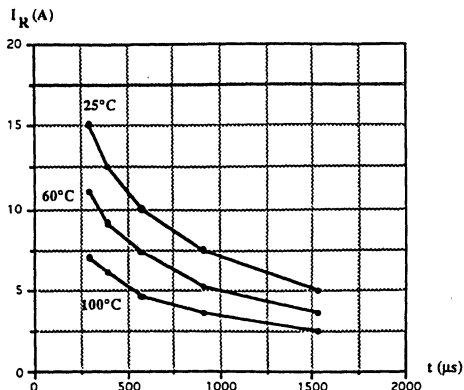


Figure 11. 25A, 35V SBR Safe Avalanche Areas for different ambient temperatures.

When the data in figures 10 and 11 is plotted on log/log axes instead of lin/log or lin/lin, an interesting feature appears (fig 12) :

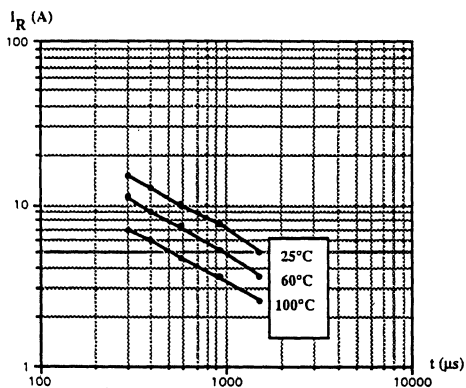


Figure 12. figure 12 on log/log axes.

Figure 12 shows a linear relationship between current and time on a log/log plot. This means that :

$$\begin{aligned} \text{so } \log(I_R) &= A \log(t) + B, \\ I_R &= k T^A \end{aligned} \quad [4]$$

where k is a constant function of the die size, the breakdown voltage and other parameters. Constant A can be extracted from figure 12 and similar figures for UFRs and MOSFETs :

$$I_R = k T^{-0.55} \quad [5]$$

Relation [5] is a consequence of heat propagation laws which explain that the temperature in a semiconductor rises proportionally to  $t^{0.5}$  (for a constant current pulse and as long as the temperature remains within the silicon die). This can be seen in any transient thermal resistance graph.

A standard thermal calculation shows that :

$$T_J = T_A + P_D R_{thJA}(t), \quad [6]$$

or

$$P_D = (T_J - T_A) / R_{thJA}(t)$$

where :

$T_J$ ,  $T_A$  are the junction and ambient temperatures,  
 $P_D$  is the power dissipation,  
 $R_{thJA}(t)$  is the transient thermal resistance.

Given a constant power pulse and for values of t less than 1ms, [6] is equivalent to :

$$I_R B \sqrt{t} = (T_J - T_A) / (k t^{0.5})$$

so

$$I_R = k t^{-0.5} \quad [7]$$

This relation is similar to [5]. For avalanche durations of less than 500μs the heat propagates within the silicon only. For longer durations the heat reaches the solder and the package so the propagation characteristics are modified. The devices heat faster or slower and therefore the  $I_R=f(t)$  slope changes. Empirical data shows that A in relation [4] remains within -0.5 to -0.6.

Relation [7] can also be expressed by :

$$I_R^2 t = k \quad (k:\text{constant}) \quad [7bis]$$

This rule of thumb works out much better than the, unfortunately too common,  $1/2 L I^2$  law.

For example, when applied to the example following figure 2 (which is UIS and not Constant Current generated) to determine the maximum peak current in a 250μH inductor and by choosing for instance the 9A,500μs point, relation [7bis] can be written :

$$9A^2 500\mu s = I_{peak}^2 100\mu s$$

This gives a conservative value of 20A instead of a real value of 28A whereas the  $1/2 L I^2$  method generates a catastrophic 58A value.

## TECHNOLOGY TRADEOFFS

### Ultra Fast Recovery Rectifiers

The UFR devices are based on a Mesa technology (fig 13) with a Phosphorus doped (n-type) substrate. The heavily doped N+ substrate is followed by a lighter N- epitaxial layer. The P+ is diffused into the epitaxy to form the P-N junction. The passivation follows the perimeter of the die.

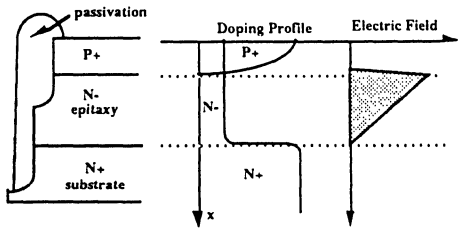


Figure 13. UFR Technology, Profile and Electric Field.

The epitaxy characteristics determine the major electrical parameters of the device. A designed experiment was conducted varying the epitaxy thickness and resistivity. The output responses were the forward voltage, the breakdown voltage, the leakage current and the avalanche capability. A wide range of epitaxy materials was chosen to determine the general trends for all the effects.

Although the results were predictable for the static parameters, the avalanche capability results were not.

A key issue is the electric field extension. If it terminates before the substrate the avalanche capability increases by increasing the epitaxy resistivity. If the field extends into the N+ region (reach-through) the avalanche capability is considerably reduced.

The avalanche capability is proportional to the die size and not to the perimeter. This confirms that the avalanche current is vertical and not only a surface or passivation related phenomenon.

The failures always occur in the corners where the electric field is most critical. These failures are essentially function of the thermal characteristics of the device when conducting avalanche currents. Therefore the avalanche capability decreases when the ambient temperature increases and the failures can normally be predicted by Safe Avalanche Areas such as figure 12.

Some unexpected defects though can radically degrade the avalanche capability. Defects in the epi such as pipes cause premature failures but can often be screened by a leakage current test that eliminates soft breakdown devices. Defects in the passivation can generate parasitic oscillations during breakdown.

#### Schottky Rectifiers

Due to P-N junction guard rings, SBR devices are very similar to UFRs when conducting avalanche currents. These rectifiers have very low breakdown voltages and therefore very thin epitaxy layers. This probably explains that the avalanche-related failures occur anywhere on the die surface: the thin N- region is relatively more heterogeneous with respect to avalanche capability and thermal dissipation than a thick UFR epitaxy.

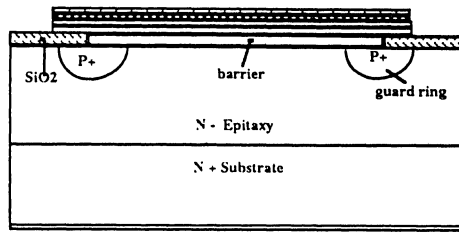


Figure 14. SBR Technology with P-N Guard Rings

#### MOSFETs

MOSFETs can also be compared to UFRs as long as the internal parasitic bipolar transistor (due to the P-tub) does not turn-on. The latest MOSFET generations reduce the P-resistance to avoid biasing this NPN.

While analyzing different constant current test circuits, it appeared that devices used in a floating configuration can have very poor avalanche capabilities.

Due to their cellular technology, MOSFETs conduct very efficiently avalanche currents. They can sustain avalanche power levels close to those of forward conduction ratings.

#### CONCLUSION

The necessity of characterizing the avalanche capability of power semiconductors has been explained. An analysis of the standard UIS test circuit has shown the limits of a characterization based on energy ratings. Throughout a discussion of the main failure mechanisms, a new thermal approach has been proposed to help designers set safety levels in their designs. This paper sets new standards for characterizing avalanche ruggedness.

#### Acknowledgements

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#### References

1. Gauen, K., 1987, "Specifying Power MOSFET Avalanche Stress Capability", *Power Technics Magazine*, January
2. Pshaenich, A., 1985, "Characterizing Overvoltage Transient Suppressors", *Power Conversion International*, June/July
3. Cherniak, S., "A Review of Transients and The Means of Suppression", MOTOROLA Application Note AN843
4. Wilhardt, J., "Transient Power Capability of Zener Diodes", MOTOROLA Application Note AN784







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